

PHILIPS

DATA
HANDBOOK



ELECTRONIC COMPONENTS
AND MATERIALS

SEMICONDUCTORS
AND
INTEGRATED CIRCUITS

PART 2

OCTOBER 1970

Low frequency transistors

Low frequency power transistors

Deflection transistors

Accessories



SEMICONDUCTORS AND INTEGRATED CIRCUITS

Part 2

October 1970

General

Low frequency transistors

Low frequency power transistors

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Accessories

DATA HANDBOOK SYSTEM

To provide you with a comprehensive source of information on electronic components, subassemblies and materials, our Data Handbook System is made up of three series of handbooks, each comprising several parts.

The three series, identified by the colours noted, are:

ELECTRON TUBES (9 parts)

BLUE

SEMICONDUCTORS AND INTEGRATED CIRCUITS (5 parts)

RED

COMPONENTS AND MATERIALS (5 parts)

GREEN

The several parts contain all pertinent data available at the time of publication, and each is revised and reissued annually; the contents of each series are summarized on the following pages.

We have made every effort to ensure that each series is as accurate, comprehensive and up-to-date as possible, and we hope you will find it to be a valuable source of reference. Where ratings or specifications quoted differ from those published in the preceding edition they will be pointed out by arrows. You will understand that we can not guarantee that all products listed in any one edition of the handbook will remain available, or that their specifications will not be changed, before the next edition is published. If you need confirmation that the published data about any of our products are the latest available, may we ask that you contact our representative. He is at your service and will be glad to answer your inquiries.

ELECTRON TUBES (BLUE SERIES)

This series consists of the following parts, issued on the dates indicated.

Part 1

January 1970

Transmitting tubes (Tetrodes, Pentodes)

Associated accessories

Part 2

February 1970

Tubes for microwave equipment

Part 3

March 1970

Special Quality tubes

Miscellaneous devices

Part 4

April 1970

Receiving tubes

Part 5

May 1970

Cathode-ray tubes

Photoconductive devices

Photo tubes

Associated accessories

Camera tubes

Part 6

June 1970

Photomultiplier tubes

Radiation counter tubes

Scintillators

Semiconductor radiation detectors

Photoscintillators

Neutron generator tubes

Associated accessories

Part 7

July 1970

Voltage stabilizing and reference tubes

Thyratrons

Counter, selector, and indicator tubes

Ignitrons

Trigger tubes

Industrial rectifying tubes

Switching diodes

High-voltage rectifying tubes

Part 8

August 1970

T.V. Picture tubes

Part 9

December 1969

Transmitting tubes (Triodes)

Associated accessories

Tubes for R.F. heating (Triodes)

August 1970

SEMICONDUCTORS AND INTEGRATED CIRCUITS (RED SERIES)

This series consists of the following parts, issued on the dates indicated.

Part 1 Diodes and Thyristors

September 1970

General
Signal diodes
Tunnel diodes
Variable capacitance diodes
Voltage regulator diodes

Rectifier diodes
Thyristors, diacs, triacs
Rectifier stacks
Accessories
Heatsinks

Part 2 Low frequency; Deflection

October 1970

General
Low frequency transistors (low power)
Low frequency power transistors

Deflection transistors
Accessories

Part 3 High frequency; Switching

November 1969

General
High frequency transistors

Switching transistors
Accessories

Part 4 Special types

December 1969

General
Transmitting transistors
Field effect transistors
Dual transistors

Diodes and transistors for thick-and
thin-film circuits
Photo devices
Accessories

Part 5 Integrated Circuits

February 1970

General
Digital integrated circuits
FC family; standard temperature range
FC family; extended temperature range
FD family
FJ family; standard temperature range

Linear integrated circuits

COMPONENTS AND MATERIALS (GREEN SERIES)

This series consists of the following parts, issued on the dates indicated.

Part 1 Circuit Blocks, Input/Output Devices

September 1970

Circuit blocks 100kHz Series
Circuit blocks 1-Series
Circuit blocks 10-Series
Circuit blocks 20-Series
Circuit blocks 40-Series
Counter modules 50-Series
Norbits 60-Series, 61-Series

Circuit blocks 90-Series
Circuit blocks for ferrite core
memory drive
Input/output devices

Part 2 Resistors, Capacitors

November 1969

Fixed resistors
Variable resistors
Non-linear resistors
Ceramic capacitors

Polycarbonate, paper, mica, polystyrene
capacitors
Electrolytic capacitors
Variable capacitors

Part 3 Radio, Audio, Television

January 1970

FM tuners
Coils
Piezoelectric ceramic resonators
and filters
Loudspeakers
Electronic organ assemblies

Television tuners
Components for black and white television
Components for colour television
Deflection assemblies for camera tubes
Audio and mains transformers

Part 4 Magnetic Materials, White Ceramics

March 1970

Ferrites for radio, audio
and television
Ferroxcube potcores and square cores
Microchokes

Ferroxcube transformer cores
Piezoxide
Permanent magnet materials

Part 5 Memory Products, Magnetic Heads, Quartz Crystals,

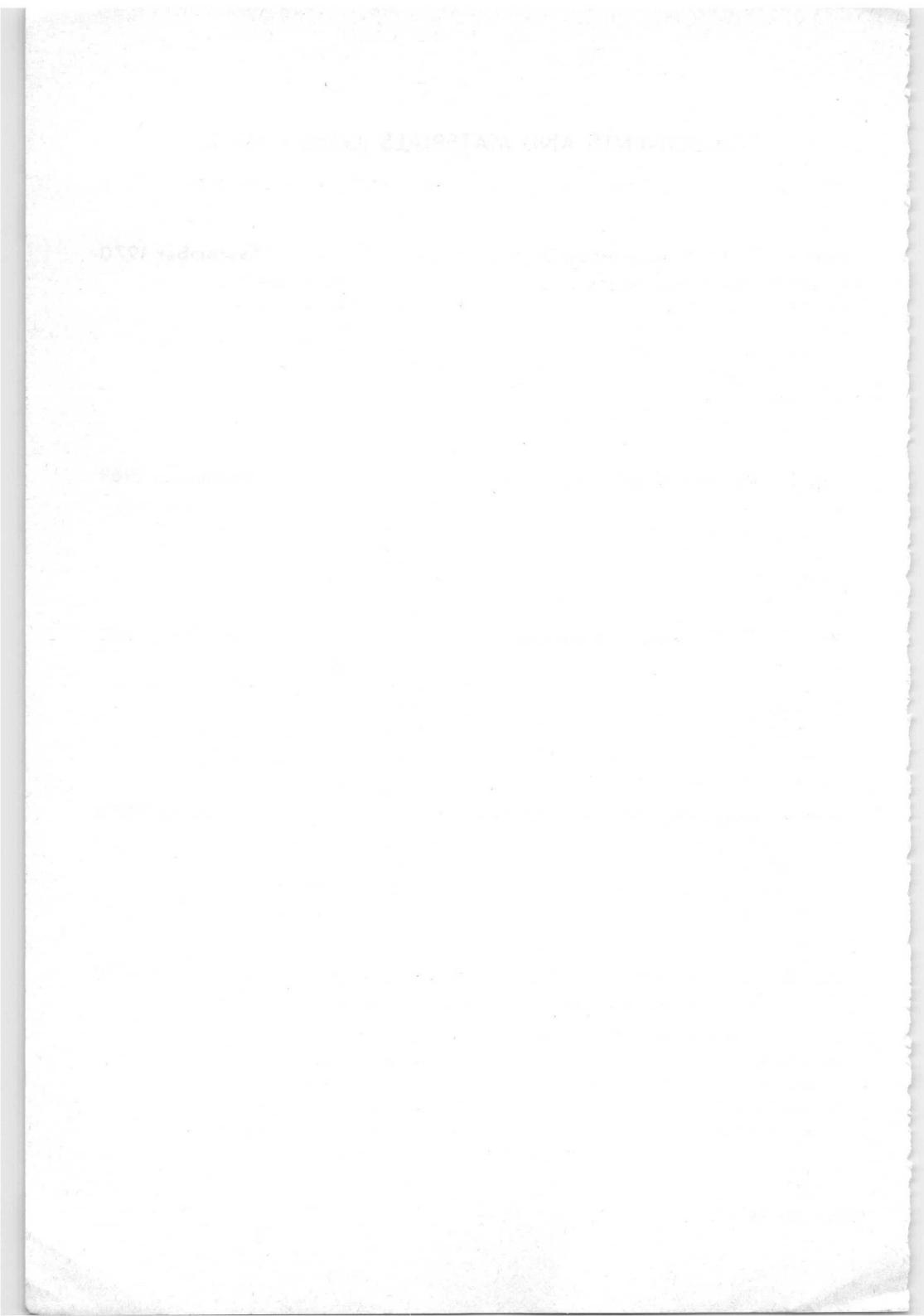
June 1970

Microwave Devices, Variable Transformers,

Electro-mechanical Components

Ferrite memory cores
Matrix planes, matrix stacks
Complete memories
Magnetic heads

Quartz crystal units, crystal filters
Isolators, circulators
Variable mains transformers
Electro-mechanical components

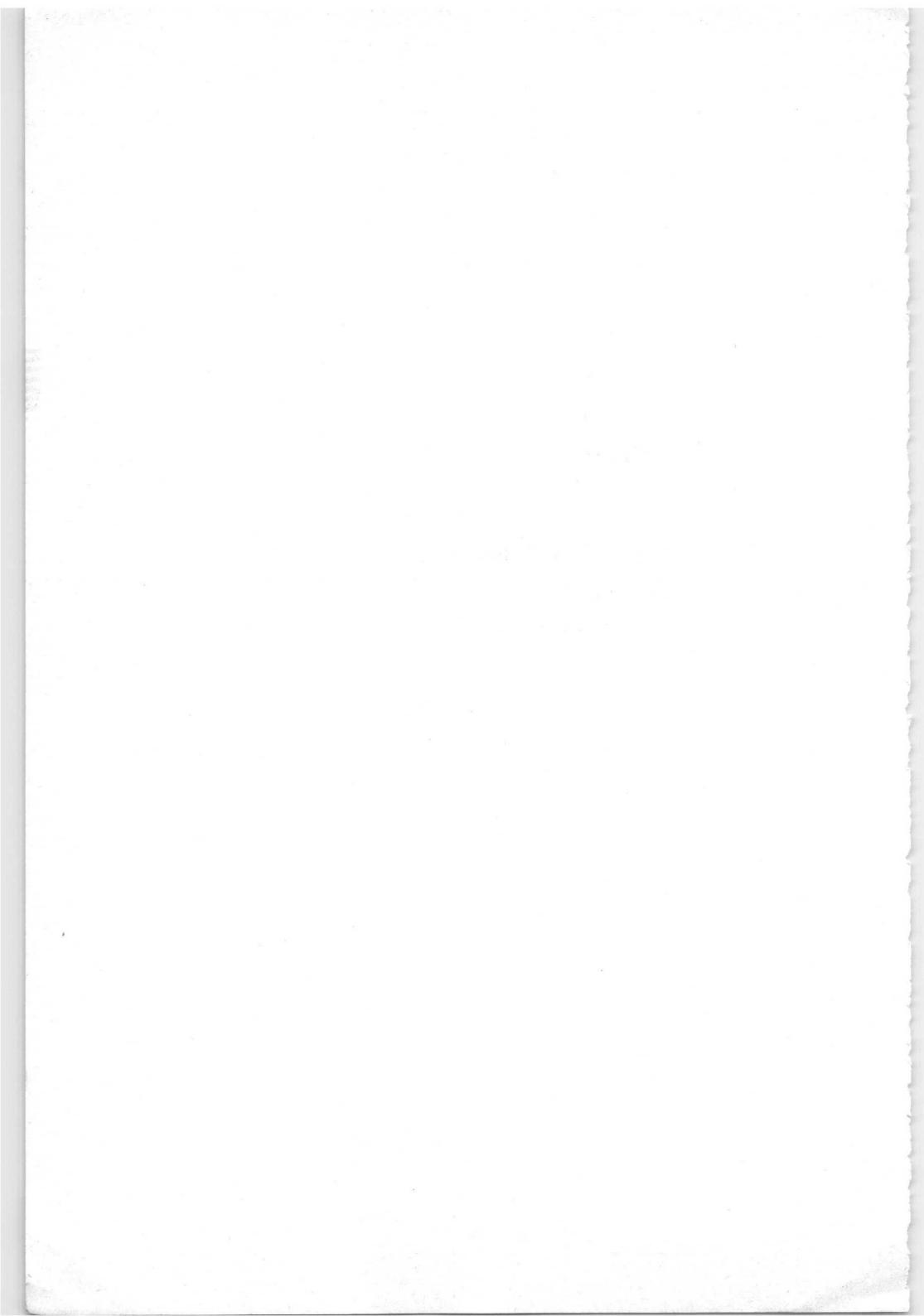


General

Type designation

Rating systems

Letter symbols



PRO ELECTRON TYPE DESIGNATION CODE FOR SEMICONDUCTOR DEVICES

This type designation code applies to discrete devices and to multiple devices ¹⁾

The type designation consists of:

TWO LETTERS FOLLOWED BY A SERIAL NUMBER

The first letter gives an indication of the material

- A Material with a band gap of 0.6 to 1.0 eV, such as germanium
- B Material with a band gap of 1.0 to 1.3 eV, such as silicon
- C Material with a band gap of 1.3 eV and more, such as gallium arsenide
- D Material with a band gap of less than 0.6 eV, such as indium antimonide
- R Compound material as employed in Hall generators and photoconductive cells

¹⁾ A multiple device is defined as a combination of similar or dissimilar active devices, contained in a common encapsulation that cannot be dismantled, and of which all electrodes of the individual devices are accessible from the outside.

Multiples of similar devices as well as multiples consisting of a main device and an auxiliary device are designated according to the code for discrete devices described above.

Multiples of dissimilar devices of other nature are designated by the second letter G.

TYPE DESIGNATION

The second letter indicates primarily the main application respectively main application and construction if a further differentiation is essential

- A Detection diode, switching diode, mixer diode
- B Variable capacitance diode
- C Transistor for a.f. applications ($R_{th\ j\ -mb} > 15\ ^\circ C/W$)
- D Power transistor for a.f. applications ($R_{th\ j\ -mb} \leq 15\ ^\circ C/W$)
- E Tunnel diode
- F Transistor for h.f. applications ($R_{th\ j\ -mb} > 15\ ^\circ C/W$)
- G Multiple of dissimilar devices (see note on page 1); Miscellaneous
- H Magnetic sensitive diode; Field probe
- K Hall generator in an open magnetic circuit, e.g. magnetogram or signal probe
- L Power transistor for h.f. applications ($R_{th\ j\ -mb} \leq 15\ ^\circ C/W$)
- M Hall generator in a closed electrically energised magnetic circuit, e.g. Hall modulator or multiplier
- P Radiation sensitive device¹⁾
- Q Radiation generating device
- R Electrically triggered controlling and switching device having a breakdown characteristic ($R_{th\ j\ -mb} > 15\ ^\circ C/W$)
- S Transistor for switching applications ($R_{th\ j\ -mb} > 15\ ^\circ C/W$)
- T Electrically, or by means of light, triggered controlling and switching power device having a breakdown characteristic ($R_{th\ j\ -mb} \leq 15\ ^\circ C/W$)¹⁾
- U Power transistor for switching applications ($R_{th\ j\ -mb} \leq 15\ ^\circ C/W$)
- X Multiplier diode, e.g. varactor, step recovery diode
- Y Rectifying diode, booster diode, efficiency diode¹⁾
- Z Voltage reference or voltage regulator diode¹⁾

1) For the type designation of a range see page 4.

The serial number consists of:

Three figures for semiconductor devices designed primarily for use in domestic equipment

One letter and two figures for semiconductor devices designed primarily for use in professional equipment

VERSION LETTER

A version letter can be used, for instance, for a diode with up-rated voltage, for a sub-division of a transistor type in different gain ranges, a low noise version of an existing transistor and for a diode, transistor, or thyristor with minor mechanical differences, such as finish of the leads, length of the leads etc. The letters never have a fixed meaning, the only exception being the letter R.

EXAMPLES

- AC187 Germanium low power a.f. transistor intended primarily for domestic equipment
BYX27 Silicon rectifying diode intended primarily for professional equipment

TYPE DESIGNATION FOR A RANGE OF SEMICONDUCTOR DEVICES

The type designation of a range of variants of:

- a) voltage reference or voltage regulator diodes (second letter Z)
- b) rectifying diodes (second letter Y)
- c) thyristors (second letter T)
- d) radiation detectors

distinctly belonging to one basic type may be qualified by a suffix part which is clearly separated from the basic part by a dash (-)

The basic part being the same for the whole range, is in accordance with the designation code for discrete devices.

The suffix part consists of:

- a) for voltage reference or voltage regulator diodes

one letter followed by the typical zener voltage and where appropriate the letter R¹⁾

The first letter indicates the nominal tolerance of the zener voltage in %

A	1%
B	2%
C	5%
D	10%
E	15%

The typical zener voltage is related to the nominal current rating for the whole range. The letter V is used to denote the decimal point when this occurs.

- b) for rectifying diodes

a number and where appropriate the letter R¹⁾

The number generally indicates the maximum repetitive peak reverse voltage

For controlled avalanche types it indicates the maximum crest working reverse voltage

- c) for thyristors

a number and where appropriate the letter R¹⁾

The number generally indicates either the maximum repetitive peak reverse voltage or the maximum repetitive peak off-state voltage, whichever is lower

For controlled avalanche types it indicates the maximum crest working reverse voltage

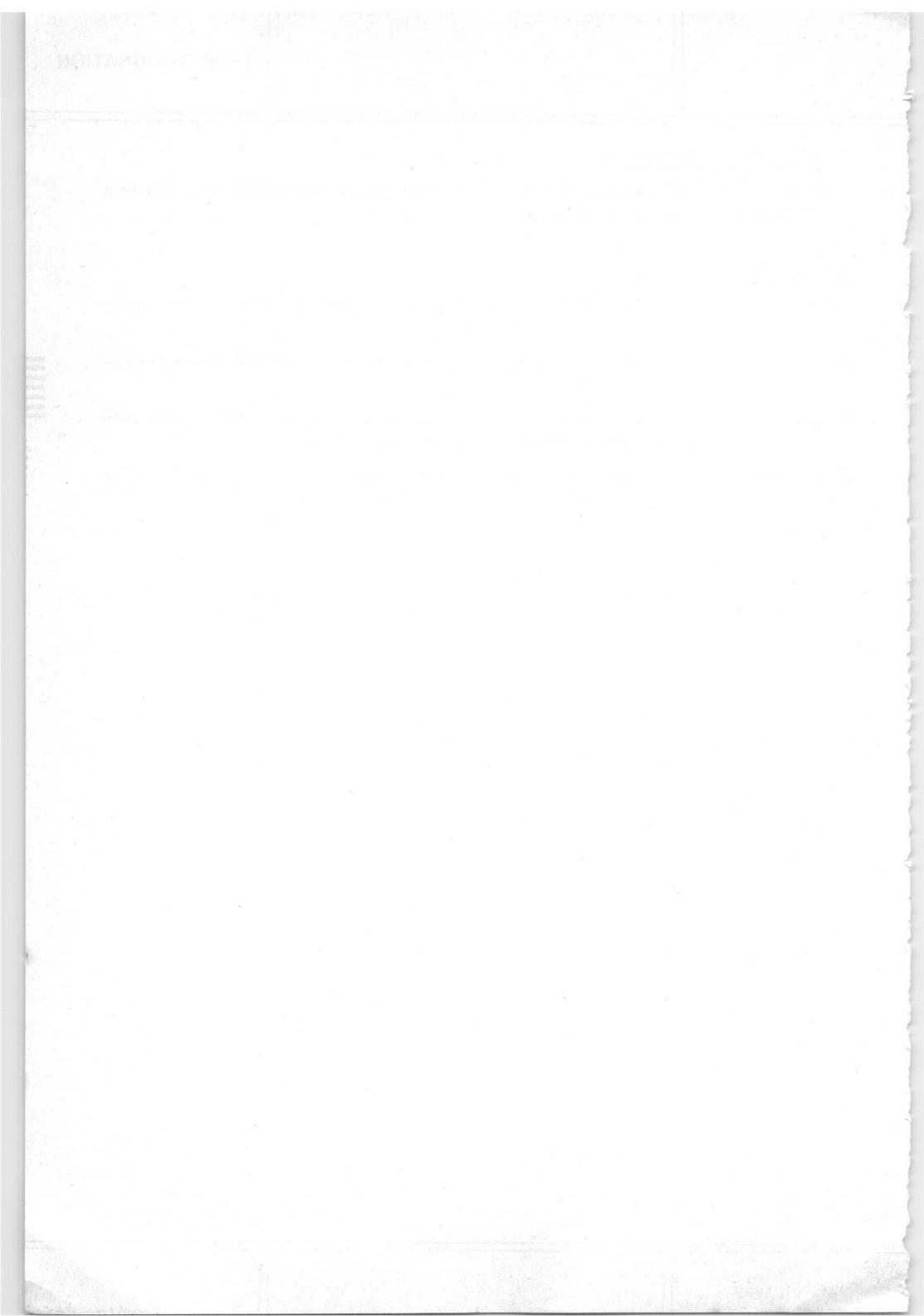
¹⁾ The letter R indicates reverse polarity (anode to stud). The normal polarity (cathode to stud) and symmetrical executions are not specially indicated.

d) for radiation detectors

a figure giving the depth of the depletion layer in μm and where appropriate a version letter if there are differences in resolution.

EXAMPLES

BZY88series	Range of silicon voltage regulator diodes for professional equipment
BZY88-C9V1	The particular type out of the range with a typical zener voltage of $9.1 \text{ V} \pm 5\%$
BYX13-1200	The particular normal polarity type out of the BYX13series with a maximum repetitive peak reverse voltage of 1200 V
BTX64-200R	The particular reverse polarity type out of the BTX64 thyristor range of which the lower maximum repetitive peak voltage is 200 V



RATING SYSTEMS

ACCORDING TO I.E.C. PUBLICATION 134

1. DEFINITIONS OF TERMS USED

- 1.1 Electronic device. An electronic tube or valve, transistor or other semiconductor device.

Note: This definition excludes inductors, capacitors, resistors and similar components.

- 1.2 Characteristic. A characteristic is an inherent and measurable property of a device. Such a property may be electrical, mechanical, thermal, hydraulic, electro-magnetic, or nuclear, and can be expressed as a value for stated or recognized conditions. A characteristic may also be a set of related values, usually shown in graphical form.

- 1.3 Bogey electronic device. An electronic device whose characteristics have the published nominal values for the type. A bogey electronic device for any particular application can be obtained by considering only those characteristics which are directly related to the application.

- 1.4 Rating. A value which establishes either a limiting capability or a limiting condition for an electronic device. It is determined for specified values of environment and operation, and may be stated in any suitable terms.

Note: Limiting conditions may be either maxima or minima.

- 1.5 Rating system. The set of principles upon which ratings are established and which determine their interpretation.

Note: The rating system indicates the division of responsibility between the device manufacturer and the circuit designer, with the object of ensuring that the working conditions do not exceed the ratings.

2. ABSOLUTE MAXIMUM RATING SYSTEM

Absolute maximum ratings are limiting values of operating and environmental conditions applicable to any electronic device of a specified type as defined by its published data, which should not be exceeded under the worst probable conditions.

These values are chosen by the device manufacturer to provide acceptable serviceability of the device, taking no responsibility for equipment variations, environmental variations, and the effects of changes in operating conditions due to variations in the characteristics of the device under consideration and of all other electronic devices in the equipment.

p.t.o.

The equipment manufacturer should design so that, initially and throughout life, no absolute maximum value for the intended service is exceeded with any device under the worst probable operating conditions with respect to supply voltage variation, equipment component variation, equipment control adjustment, load variations, signal variation, environmental conditions, and variations in characteristics of the device under consideration and of all other electronic devices in the equipment.

3. DESIGN MAXIMUM RATING SYSTEM

Design maximum ratings are limiting values of operating and environmental conditions applicable to a bogey electronic device of a specified type as defined by its published data, and should not be exceeded under the worst probable conditions.

These values are chosen by the device manufacturer to provide acceptable serviceability of the device, taking responsibility for the effects of changes in operating conditions due to variations in the characteristics of the electronic device under consideration.

The equipment manufacturer should design so that, initially and throughout life, no design maximum value for the intended service is exceeded with a bogey device under the worst probable operating conditions with respect to supply voltage variation, equipment component variation, variation in characteristics of all other devices in the equipment, equipment control adjustment, load variation, signal variation and environmental conditions.

4. DESIGN CENTRE RATING SYSTEM

Design centre ratings are limiting values of operating and environmental conditions applicable to a bogey electronic device of a specified type as defined by its published data, and should not be exceeded under normal conditions.

These values are chosen by the device manufacturer to provide acceptable serviceability of the device in average applications, taking responsibility for normal changes in operating conditions due to rated supply voltage variation, equipment component variation, equipment control adjustment, load variation, signal variation, environmental conditions, and variations in the characteristics of all electronic devices.

The equipment manufacturer should design so that, initially, no design centre value for the intended service is exceeded with a bogey electronic device in equipment operating at the stated normal supply voltage.

NOTE

It is common use to apply the Absolute Maximum System in semiconductor published data.

LETTER SYMBOLS



LETTER SYMBOLS FOR SEMICONDUCTOR DEVICES excluding rectifier diodes, thyristors and integrated circuits

This system is based on the Recommendations of the INTERNATIONAL ELECTROTECHNICAL COMMISSION as published in I.E.C. Publication 148.

QUANTITY SYMBOLS

1. Instantaneous values of current, voltage and power, which vary with time are represented by the appropriate lower case letter.

Examples: i , v , p

2. Maximum (peak), average, d.c. and root-mean-square values are represented by the appropriate upper case letter.

Examples: I , V , P

SUBSCRIPTS FOR QUANTITY SYMBOLS

1. Total values are indicated by upper case subscripts.

Examples: I_C , I_{CM} , $I_C(AV)$, i_C , V_{EB}

2. Values of varying components are indicated by lower case subscripts.

Examples: i_c , I_c , v_{eb} , V_{eb}

3. To distinguish between maximum (peak), average, d.c. and root-mean-square values, the following subscripts are added:

For maximum (peak) values : M or m

For average values : (AV) or (av) (only if it is necessary to distinguish between d.c. and average)

For d.c. values : no additional subscript

For root-mean-square values : (RMS) or (rms)

Examples: I_C , I_{cm} , $I_C(AV)$, $I_{c(rms)}$, $I_C(RMS)$

4. List of subscripts (examples, see figure 1)

A, a	= Anode terminal
K, k	= Cathode terminal
E, e	= Emitter terminal
B, b	= Base terminal or Substrate for MOS devices
C, c	= Collector terminal
D, d	= Drain terminal
(BR)	= Break-down
X, x	= Specified circuit
M, m	= Maximum (peak) value
(AV), (av)	= Average value
(RMS), (rms)	= R.M.S. value
F, f	= Forward
G, g	= Gate terminal
R, r	= As first subscript: Reverse. As second subscript: Repetitive
O, o	= As third subscript: The terminal not mentioned is open circuited
S, s	= As first or second subscript: Source terminal (for FETS only) = As second subscript: Non-repetitive (not for FETS) = As third subscript : Short circuit between the terminal not mentioned and the reference terminal
Z, z	= Zener. (Replaces R to indicate the actual zener voltage, current or power of voltage reference or voltage regulator diodes)

5. Examples of the application of the rules:

Figure 1 represents a transistor collector current, consisting of a direct current and a signal, as a function of time.

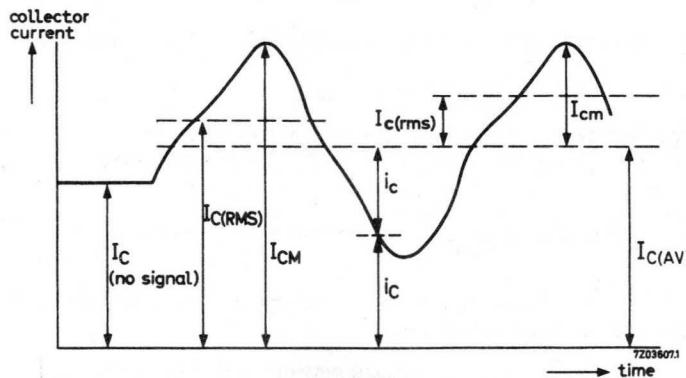


Fig.1

CONVENTIONS FOR SUBSCRIPT SEQUENCE1. Currents

For transistors the first subscript indicates the terminal carrying the current (conventional current flow from the external circuit into the terminal is positive)

For diodes a forward current (conventional current flow into the anode terminal) is represented by the subscript F or f; a reverse current (conventional current flow out of the anode terminal) is represented by the subscript R or r.

2. Voltages

For transistors normally, two subscripts are used to indicate the points between which the voltage is measured. The first subscript indicates one terminal point and the second the reference terminal.

Where there is no possibility of confusion, the second subscript may be omitted.

For diodes a forward voltage (anode positive with respect to cathode) is represented by the subscript F or f and a reverse voltage (anode negative with respect to cathode) by the subscript R or r.

3. Supply voltages

Supply voltages may be indicated by repeating the terminal subscript.

Examples: V_{EE} , V_{CC} , V_{BB}

The reference terminal may then be indicated by a third subscript.

Examples: V_{EEB} , V_{CCB} , V_{BBC}

4. In devices having more than one terminal of the same type, the terminal subscripts are modified by adding a number following the subscript and on the same line.

Example: V_{B2-E} voltage between second base and emitter

In multiple unit devices, the terminal subscripts are modified by a number preceding the terminal subscripts:

Example: V_{1B-2B} voltage between the base of the first unit and that of the second one.

ELECTRICAL PARAMETER SYMBOLS

1. The values of four pole matrix parameters or other resistances, impedances admittances, etc... inherent in the device, are represented by the lower case symbol with the appropriate subscripts.

Examples: h_{ib} , z_{fb} , y_{oc} , h_{FE}

2. The four pole matrix parameters of external circuits and of circuits in which the device forms only a part are represented by the upper case symbols with the appropriate subscripts.

Examples: H_i , Z_o , H_F , Y_R

SUBSCRIPTS FOR PARAMETER SYMBOLS

1. The static values of parameters are indicated by upper case subscripts.

Examples: h_{IB} , h_{FE}

Note The static value is the slope of the line from the origin to the operating point on the appropriate characteristic curve, i.e. the quotient of the appropriate electrical quantities at the operating point.

2. The small-signal values of parameters are indicated by lower case subscripts.

Examples: h_{ib} , z_{ob}

3. The first subscript, in matrix notation identifies the element of the four pole matrix.

i (for 11) = input
o (for 22) = output
f (for 21) = forward transfer
r (for 12) = reverse transfer

Examples: $V_1 = h_i I_1 + h_f V_2$
 $I_2 = h_f I_1 + h_o V_2$

Notes 1) The voltage and current symbols in matrix notation are indicated by a single digit subscript.

The subscript 1 = input; the subscript 2 = output

2) The voltages and currents in these equations may be complex quantities.

LETTER SYMBOLS

4. The second subscript identifies the circuit configuration.

e = common emitter

c = common collector

b = common base

j = common terminal, general

Examples: (common base)

$$I_1 = y_{ib} V_{1b} + y_{rb} V_{2b}$$

$$I_2 = y_{fb} V_{1b} + y_{ob} V_{2b}$$

When the common terminal is understood, the second subscript may be omitted.

5. If it is necessary to distinguish between real and imaginary parts of the four pole parameters, the following notations may be used.

$\text{Re}(h_{ib})$ etc.. for the real part

$\text{Im}(h_{ib})$ etc.. for the imaginary part

LIST OF LETTER SYMBOLS IN ALPHABETICAL ORDER

Letter symbol	Definition
B	Bandwidth
b_{ib} , b_{ie} , b_{is} , b_{fb} , b_{fe} , b_{fs} , b_{ob} , b_{oe} , b_{os} , b_{rb} , b_{re} , b_{rs}	See y parameters
C_c	Collector capacitance (emitter open-circuited to a.c. and d.c.)
C_d	Diode capacitance
C_e	Emitter capacitance (collector open-circuited to a.c. and d.c.)
C_{ib} , C_{ie} , C_{is} , C_{fb} C_{fe} , C_{fs} , C_{ob} , C_{oe} C_{os} , C_{rb} , C_{re} , C_{rs}	See y parameters
d	Distortion
F	Noise figure
f	Frequency
f_{hfb} , f_{hfe} , f_{yfe}	Cut-off frequency (frequency at which the parameter indicated by the subscript is 0.7 of its low frequency value)
f_T	Transition frequency (Gain-bandwidth product)
g_{ie} , g_{ib} , g_{oe} , g_{ob}	See y parameters
G_p	Power gain
G_S	Source conductance
G_{tr}	Transducer gain
G_{UM}	Maximum unilateralised power gain
G_V	Voltage gain

1) As an exception to the general rule for electrical parameters capacitances are represented by the upper-case letter.

LETTER SYMBOLS

Letter symbol	Definition
h_{FB} , h_{FC} , h_{FE}	D.C. current gain (static value of the forward current transfer ratio; output voltage held constant)
h_{fb} , h_{fc} , h_{fe}	Small-signal current gain (small-signal value of the forward current transfer ratio; output short-circuited to a.c.)
h_{IB} , h_{IC} , h_{IE}	Static value of the input resistance (output voltage held constant)
h_{ib} , h_{ic} , h_{ie}	Small-signal value of the input impedance (output short-circuited to a.c.)
h_{OB} , h_{OC} , h_{OE}	Static value of the output conductance (input current held constant)
h_{ob} , h_{oc} , h_{oe}	Small-signal value of the output admittance (input open-circuited to a.c.)
h_{RB} , h_{RC} , h_{RE}	Static value of the reverse voltage transfer ratio (input current held constant)
h_{rb} , h_{rc} , h_{re}	Small-signal value of the reverse voltage transfer ratio (input open-circuited to a.c.)
I_B , I_C , I_D , I_E , I_G , I_S	Total d.c. (or average) current
i_b , i_c , i_d , i_e , i_g , i_s	Varying component of the current
i_B , i_C , i_D , i_E , i_G , i_S	Instantaneous total value of the current
i_b , i_c , i_d , i_e , i_g , i_s	Instantaneous value of the varying component of the current
$I_{B(AV)}$, $I_{C(AV)}$, $I_{E(AV)}$	Total average current (to distinguish between average and d.c. if necessary)
I_{BEX} , I_{CEX}	Total base, respectively collector current under specified conditions. These symbols are commonly used in case of a reverse biased emitter junction
I_{BM} , I_{CM} , I_{EM}	Maximum (peak) value of the total current
I_{bm} , I_{cm} , I_{em}	Maximum (peak) value of the varying component of the current
I_{CBO}	Collector cut-off current (open emitter)
I_{CEO}	Collector cut-off current (open base)
I_{CBS} or I_{CES}	Collector cut-off current (emitter short-circuited to base)

Letter symbol	Definition
I_{DSS}	Drain current (source short-circuited to gate)
I_{EBO}	Emitter cut-off current (open collector)
I_F	Total forward current of a diode (d.c. or average)
i_F	Instantaneous total value of the forward current of a diode
$I_{F(AV)}$	Total average forward current of a diode (to distinguish between average and d.c. if necessary)
I_{FM}	Peak forward current of a diode
I_{GSS}	Gate cut-off current (source short-circuited to drain)
I_i, I_o	Input, respectively output current of a specified circuit
I_R	Total reverse (cut-off) current of a diode
i_R	Instantaneous total value of the reverse current of a diode
I_{RRM}	Repetitive peak reverse current of a diode
I_{RSM}	Non-repetitive peak reverse current of a diode
I_{SDS}	Source cut-off current (drain short-circuited to gate)
I_Z	Zener current (d.c. or average)
I_{ZM}	Peak zener current
I_{ZS}	Non-repetitive zener current
P_i, P_o	Input, respectively output power of a specified circuit
P_{tot}	Total power dissipation in the device
P_Z	Zener power dissipation
P_{ZM}	Peak zener power dissipation
P_{ZSM}	Non-repetitive peak zener power dissipation
Q_s	Reverse recovery charge

LETTER SYMBOLS

Letter symbol	Definition
r_D	Diode (internal) series resistance
r_{DS}	Drain-source resistance
r_{GS}	Gate-source resistance
R_L	Load resistance
R_S	Source resistance
R_{th}	Thermal resistance
$R_{th\ j-a}$	Thermal resistance from junction to ambient
$R_{th\ j-mb}$	Thermal resistance from junction to mounting base
$R_{th\ j-c}$	Thermal resistance from junction to case
$R_{th\ mb-h}$	Thermal resistance from mounting base to heatsink (contact thermal resistance)
r_z	Dynamic-slope resistance of a zener diode
S_z	Temperature coefficient of the operating voltage of a zener diode
T_{amb}	Ambient temperature
T_{case}	Case temperature
$t_d ; t_f$	Delay time; fall time
t_{fr}	Forward recovery time of a diode
T_j	Junction temperature
t_{off}	Turn-off time ($t_{off} = t_s + t_f$)
t_{on}	Turn-on time ($t_{on} = t_d + t_r$)
t_r	Rise time
t_{rr}	Reverse recovery time of a diode
t_s	Storage time
T_{stg}	Storage temperature
V_{BB}, V_{CC}, V_{EE}	Supply voltage
$V_{BE}, V_{CB}, V_{CE}, V_{EB}$	Total value of the voltage (d.c. or average)
$V_{be}, V_{cb}, V_{ce}, V_{eb}$	Varying component of the voltage
$v_{BE}, v_{CB}, v_{CE}, v_{EB}$	Instantaneous value of the total voltage
$v_{be}, v_{cb}, v_{ce}, v_{eb}$	Instantaneous value of the varying component of the voltage

Letter symbols	Definition
V_{BEfl}	Base-emitter floating voltage (open base)
V_{BEsat}	Saturation voltage at specified bottoming conditions
$V_{(BR)}$	Breakdown voltage
$V_{(BR)CBO}$, $V_{(BR)CEO}$, $V_{(BR)EBO}$	Breakdown voltage between the terminal indicated by the first subscript and the reference terminal (second subscript) when the third terminal is open circuited
$V_{(BR)CER}$	Collector-emitter breakdown voltage with a specified resistance between emitter and base
$V_{(BR)CES}$	Collector-emitter breakdown voltage with the emitter short circuited to the base
V_{CB0} , V_{CEO} , V_{DG0} , V_{EBO} , V_{GS0}	Voltage of the terminal indicated by the first subscript w.r.t. the reference terminal (second subscript) with the third terminal open circuited
V_{CBOM} , V_{CEOM}	Peak value of V_{CB0} , V_{CEO}
V_{CEK}	Knee voltage at specified conditions
V_{CER}	Collector-emitter voltage with a specified resistance between emitter and base
V_{CERM}	Peak value of V_{CER}
V_{CES}	Collector-emitter voltage with the emitter short circuited to the base
V_{CEsat}	Saturation voltage at specified bottoming conditions
$V_{CE.sust}$	Collector-emitter sustaining voltage under the condition, indicated by the third subscript
V_{CEX}	Collector-emitter voltage in a specified circuit.
	This symbol is commonly used to indicate a reverse biased emitter junction
V_{DSS}	Drain-source voltage with the source short-circuited to the gate
V_{EBfl}	Emitter-base floating voltage (open emitter)
V_F	Continuous forward voltage of a diode
V_{FM}	Peak forward voltage of a diode

LETTER SYMBOLS

Letter symbol	Definition
V_i, V_o	Input, respectively output voltage of a specified circuit
$V_{(P)GS}$	Gate-source cut-off voltage
V_R	Continuous reverse voltage of a diode
V_{RM}	Peak reverse voltage of a diode
V_{RSM}	Non-repetitive peak reverse voltage of a diode
V_Z	Operating voltage (zener voltage) of a zener diode
y_{ib}, y_{ie}, y_{is}	Input admittance
b_{ib}, b_{ie}, b_{is}	
g_{ib}, g_{ie}, g_{is}	Input conductance
C_{ib}, C_{ie}, C_{is}	Input capacitance
$\varphi_{ib}, \varphi_{ie}, \varphi_{is}$	Phase angle of input admittance
y_{fb}, y_{fe}, y_{fs}	Transfer admittance
b_{fb}, b_{fe}, b_{fs}	
g_{fb}, g_{fe}, g_{fs}	Transfer conductance
C_{fb}, C_{fe}, C_{fs}	Transfer capacitance
$\varphi_{fb}, \varphi_{fe}, \varphi_{fs}$	Phase angle of transfer admittance
y_{ob}, y_{oe}, y_{os}	Output admittance
b_{ob}, b_{oe}, b_{os}	
g_{ob}, g_{oe}, g_{os}	Output conductance
C_{ob}, C_{oe}, C_{os}	Output capacitance
$\varphi_{ob}, \varphi_{oe}, \varphi_{os}$	Phase angle of output admittance
y_{rb}, y_{re}, y_{rs}	Feedback admittance
b_{rb}, b_{re}, b_{rs}	
g_{rb}, g_{re}, g_{rs}	Feedback conductance
C_{rb}, C_{re}, C_{rs}	Feedback capacitance
$\varphi_{rb}, \varphi_{re}, \varphi_{rs}$	Phase angle of feedback admittance
Z_{th}	Transient thermal impedance

LETTER SYMBOLS

FOR RECTIFIER DIODES AND THYRISTORS

This system is based on the Recommendations of the INTERNATIONAL ELECTROTECHNICAL COMMISSION.

QUANTITY SYMBOLS

1. Instantaneous values of current, voltage and power, which vary with time are represented by the appropriate lower case letter.

Examples: i , v , p

2. Maximum (peak or crest), average, d. c. and root-mean-square values are represented by the appropriate upper case letter.

Examples: I , V , P

SUBSCRIPTS FOR QUANTITY SYMBOLS

1. Total values are indicated by upper case subscripts.
2. Values of varying components are indicated by lower case subscripts.
3. For power rectifier diodes and thyristors the terminals are not indicated in the subscripts, except for the gate-terminal of thyristors.
4. List of subscripts:

G, g	= Gate terminal
F, f	= Forward ¹⁾
D, d	= Forward off-state ¹⁾ ; non trigger (gate voltage or current)
T, t	= Forward on-state ¹⁾ ; trigger (gate voltage or current)
R, r	= As first subscript; Reverse As second subscript: Repetitive
$(AV), (av)$	= Average value
M, m	= Maximum (peak or crest) value
$(RMS), (rms)$	= R.M.S. value
(BR)	= Breakdown
(BO)	= Breakover
H	= Holding
L	= Latching
Q, q	= Turn-off
S, s	= As a second subscript: Non-repetitive
W	= Working

¹⁾ For the anode-cathode voltage of thyristors F is replaced either by D or by T, to distinguish between "off-state" (non triggered) and "on-state" (triggered).

1948-1950

1950-1951

1951-1952

1952-1953

1953-1954

1954-1955

1955-1956

1956-1957

1957-1958

1958-1959

1959-1960

1960-1961

1961-1962

1962-1963

1963-1964

1964-1965

1965-1966

1966-1967

1967-1968

1968-1969

1969-1970

1970-1971

1971-1972

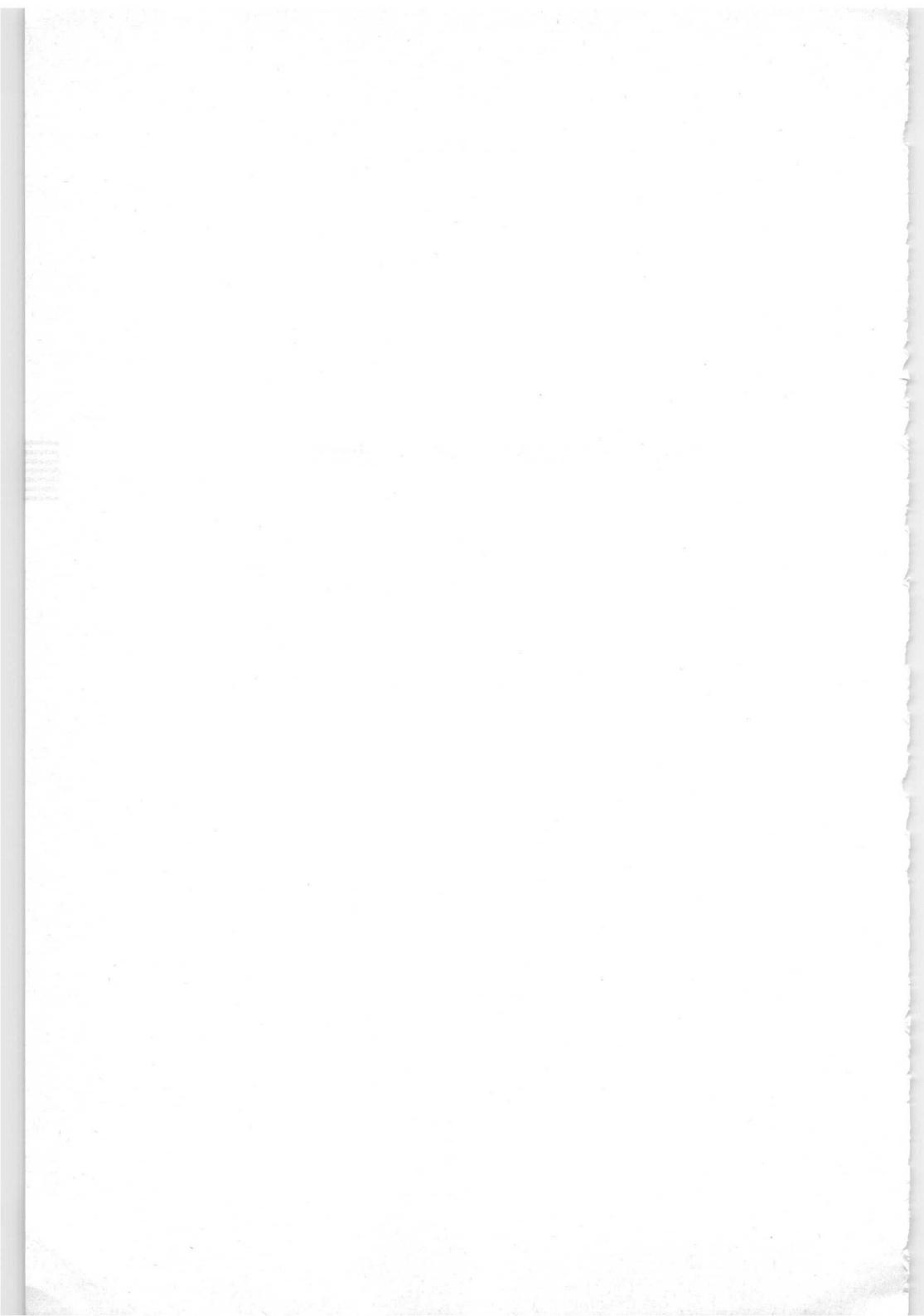
1972-1973

1973-1974

1974-1975

Low frequency transistors





GERMANIUM P-N-P TRANSISTOR

Low noise germanium transistor in all glass envelope for use as input stage of tape recorders with a speed of up to 19 cm/s.

RATINGS (Limiting values)

Collector-base voltage (open emitter)	$-V_{CBO}$	max. 15 V
Collector-emitter voltage with $R_{BE} < 1.5 \text{ k}\Omega$	$-V_{CER}$	max. 15 V
Collector current (peak value)	$-I_{CM}$	max. 10 mA
Total dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max. 80 mW
Junction temperature	T_j	max. 75 $^\circ\text{C}$

CHARACTERISTICS $T_j = 25^\circ\text{C}$

Small signal current gain

$-I_C = 0.3 \text{ mA}; -V_{CE} = 5 \text{ V}$ h_{fe} typ. 60
35 to 160

Cut-off frequency

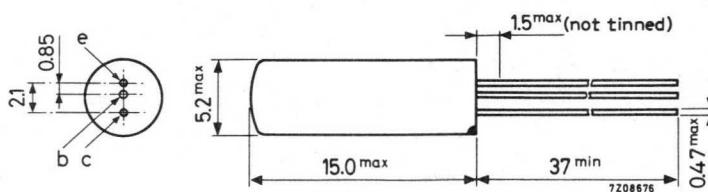
$I_E = 0.3 \text{ mA}; -V_{CB} = 5 \text{ V}$ f_{hfb} > 2 MHz

Noise figure at $f = 30 \text{ Hz to } 15 \text{ kHz}$

$I_E = 0.3 \text{ mA}; -V_{CB} = 5 \text{ V}; R_S = 1.5 \text{ k}\Omega$ F < 5 dB

MECHANICAL DATA

Dimensions in mm



The coloured dot indicates the collector.

FOR NEW DESIGN THE SUCCESSOR
TYPES BC179 AND BC159 ARE RECOMMENDED

1000A

NOTES ON THE MUSEUM

GERMANIUM ALLOY TRANSISTOR

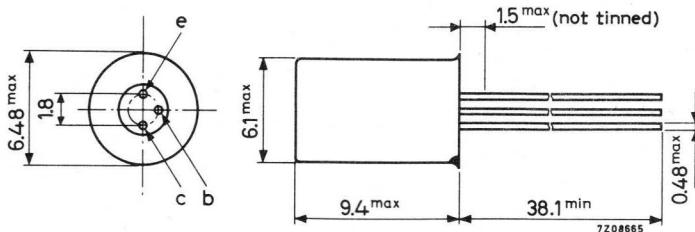
P-N-P transistor in a TO-1 metal envelope intended for use in pre-amplifier or driver stages.

QUICK REFERENCE DATA		
Collector-base voltage (open emitter)	$-V_{CBO}$	max. 32 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max. 12 V
Collector current (d.c.)	$-I_C$	max. 100 mA
Total power dissipation up to $T_{amb} = 45^\circ\text{C}$ with cooling fin No. 56227 on a heatsink of at least 12.5 cm^2	P_{tot}	max. 500 mW
Junction temperature	T_j	max. 90 $^\circ\text{C}$
D.C. current gain at $T_{amb} = 25^\circ\text{C}$ $-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$	h_{FE}	> 50 typ. 100
Small signal current gain at $T_{amb} = 25^\circ\text{C}$ $I_E = 2 \text{ mA}; -V_{CB} = 5 \text{ V}; f = 1 \text{ kHz}$	h_{fe}	typ. 125 80 to 170
Transition frequency $-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_T	typ. 1.7 MHz

MECHANICAL DATA

Dimensions in mm

TO-1



The coloured dot indicates the collector

Accessories available: 56200, 56208, 56209, 56210, 56226, 56227

RATINGS (Limiting values)¹⁾Voltages

Collector-base voltage (open emitter)	-V _{CBO}	max.	32	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	12	V
Collector-emitter voltage with R _{BE} < 1 kΩ	-V _{CER}	max.	32	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	10	V

Currents

Collector current (d.c.)	-I _C	max.	100	mA
Emitter current (peak value)	I _{EM}	max.	200	mA

Power dissipation

Total power dissipation up to T_{amb} = 45 °C
with cooling fin No. 56227 mounted on a
heatsink of at least 12.5 cm²

P_{tot} max. 500 mW

Temperatures

Storage temperature	T _{stg}	-55 to +90	°C
Junction temperature	T _j	max.	90 °C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a} = 0.3 °C/mW
From junction to ambient with cooling fin No. 56227 mounted on a heatsink of at least 12.5 cm ²	R _{th j-a} = 0.09 °C/mW

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_{amb} = 25^{\circ}\text{C}$ unless otherwise specifiedCollector cut-off current

$I_E = 0; -V_{CB} = 10 \text{ V}$	$-I_{CBO}$	<	10	μA
$I_E = 0; -V_{CB} = 32 \text{ V}; T_j = 75^{\circ}\text{C}$	$-I_{CBO}$	<	800	μA

Emitter cut-off current

$I_C = 0; -V_{EB} = 5 \text{ V}; T_j = 75^{\circ}\text{C}$	$-I_{EBO}$	<	550	μA
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Emitter-base voltage

$I_E = 2 \text{ mA}; -V_{CB} = 5 \text{ V}$	V_{EB}	typ.	105	mV
$I_E = 100 \text{ mA}; V_{CB} = 0$	V_{EB}	<	400	mV

D.C. current gain

$-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$	h_{FE}	>	50
		typ.	100
$-I_C = 50 \text{ mA}; V_{CB} = 0$	h_{FE}	typ.	95
$-I_C = 100 \text{ mA}; V_{CB} = 0$	h_{FE}	typ.	80

Collector capacitance at $f = 0.45 \text{ MHz}$

$I_E = I_e = 0; -V_{CB} = 5 \text{ V}$	C_c	typ.	40	pF
		<	50	pF

Feedback impedance at $f = 0.45 \text{ MHz}$

$-I_C = 1 \text{ mA}; -V_{CE} = 5 \text{ V}$	$ z_{rb} $	typ.	90	Ω
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Transition frequency

$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_T	>	1.3	MHz
		typ.	1.7	MHz

Cut-off frequency

$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_{hfe}	>	10	kHz
		typ.	17	kHz

Noise figure at $f = 1 \text{ kHz}$

$-I_C = 0.5 \text{ mA}; -V_{CE} = 5 \text{ V}; R_S = 500 \Omega$	F	typ.	4	dB
Bandwidth = 200 Hz		<	10	dB

CHARACTERISTICS (continued) $T_{amb} = 25^{\circ}\text{C}$ unless otherwise specifiedh parameters at $f = 1 \text{ kHz}$

$$-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$$

Input impedance

 h_{ie} typ. 1.7 k Ω
1.1 to 2.5 k Ω

Reverse voltage transfer

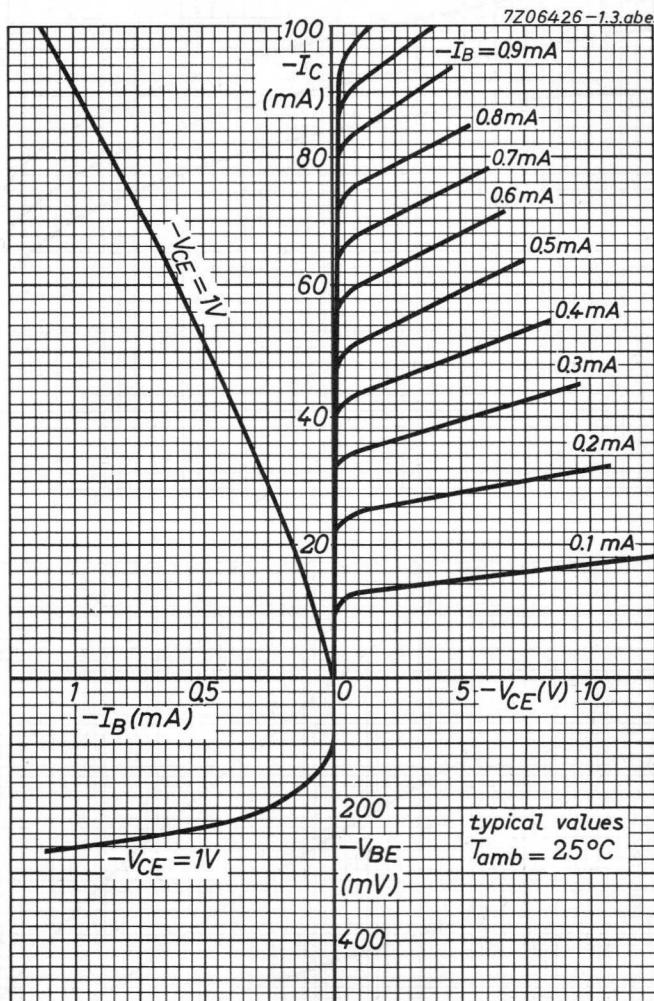
 h_{re} typ. 6.5 10^{-4}
< 8.5 10^{-4}

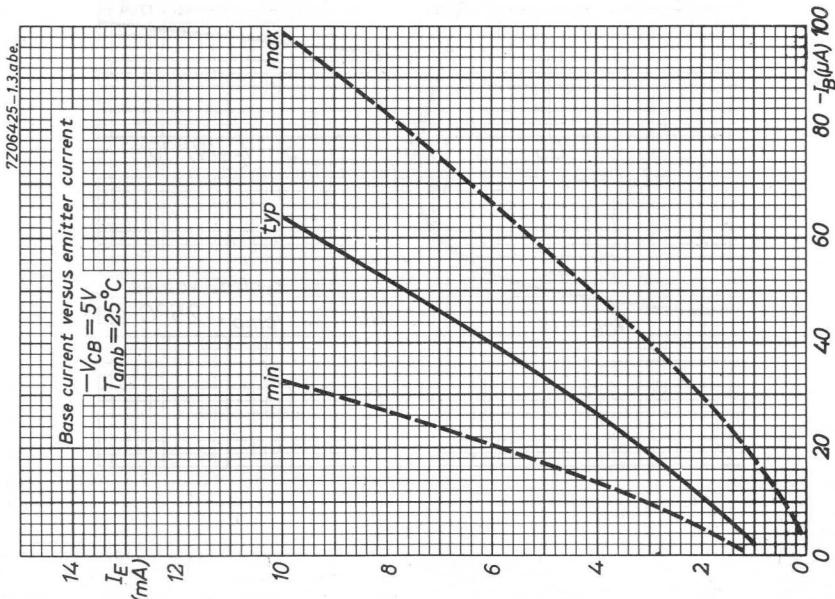
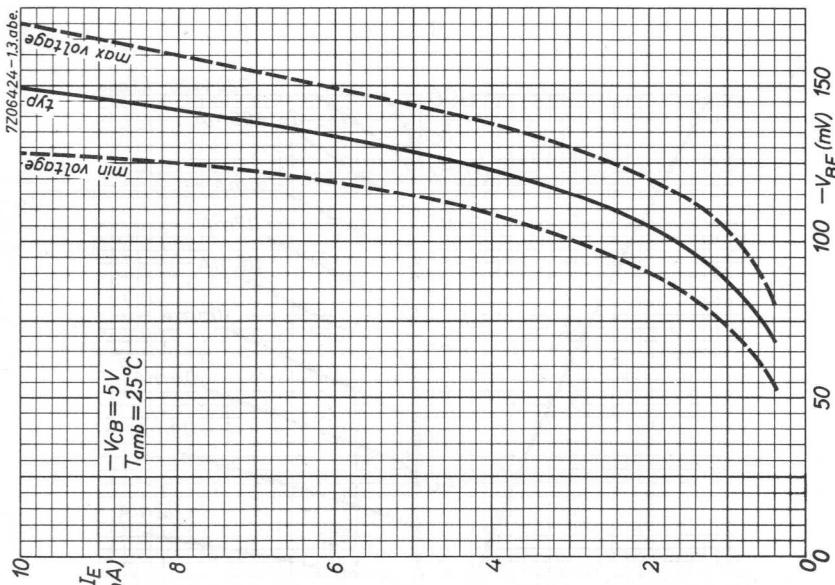
Small signal current gain

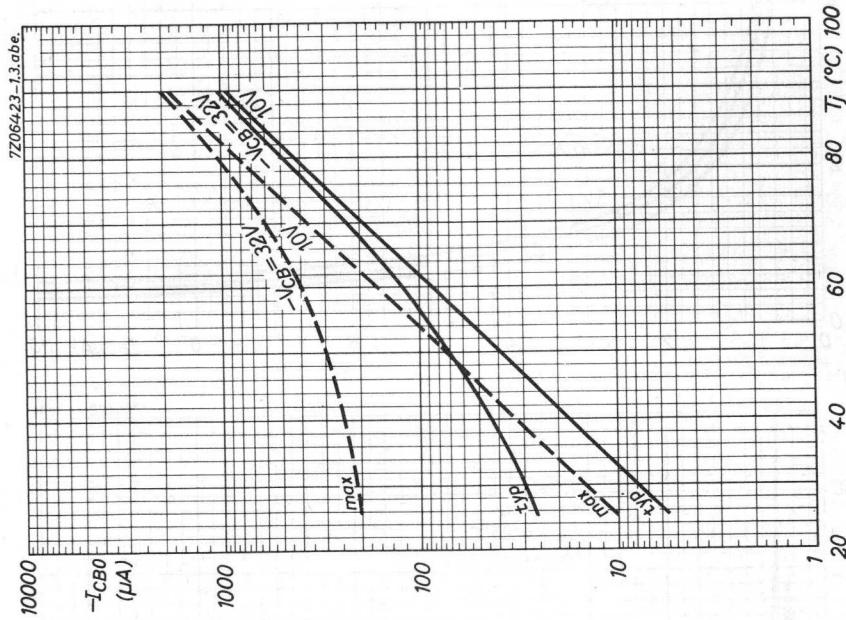
 h_{fe} typ. 125
80 to 170

Output admittance

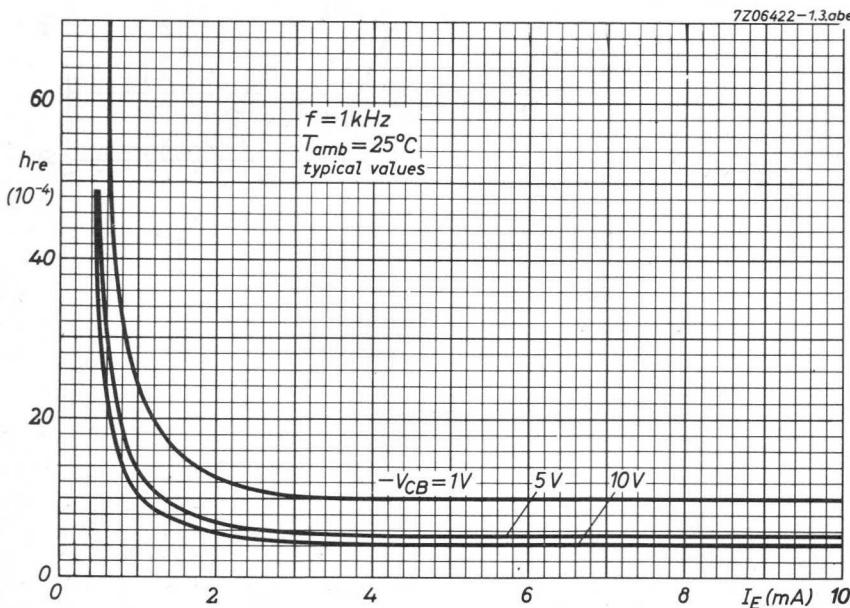
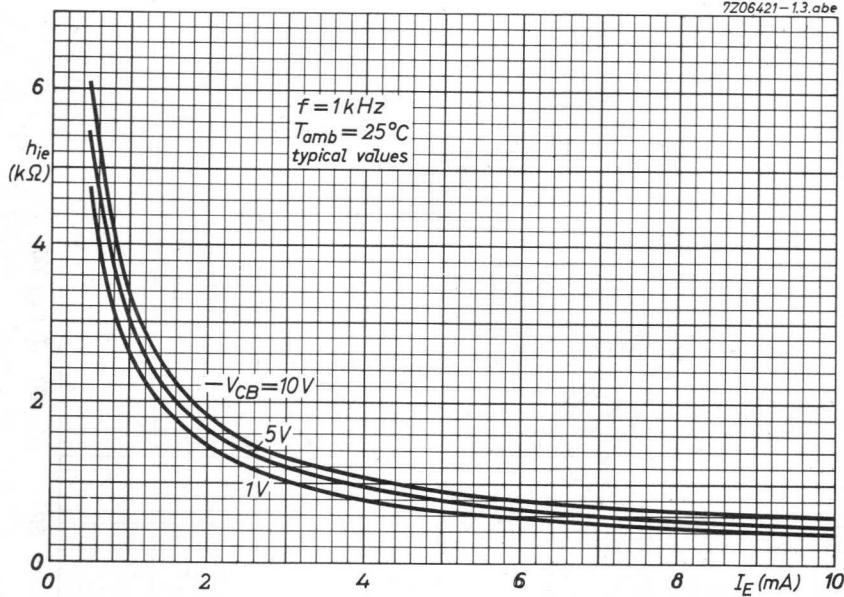
 h_{oe} typ. 80 $\mu\Omega^{-1}$
< 110 $\mu\Omega^{-1}$



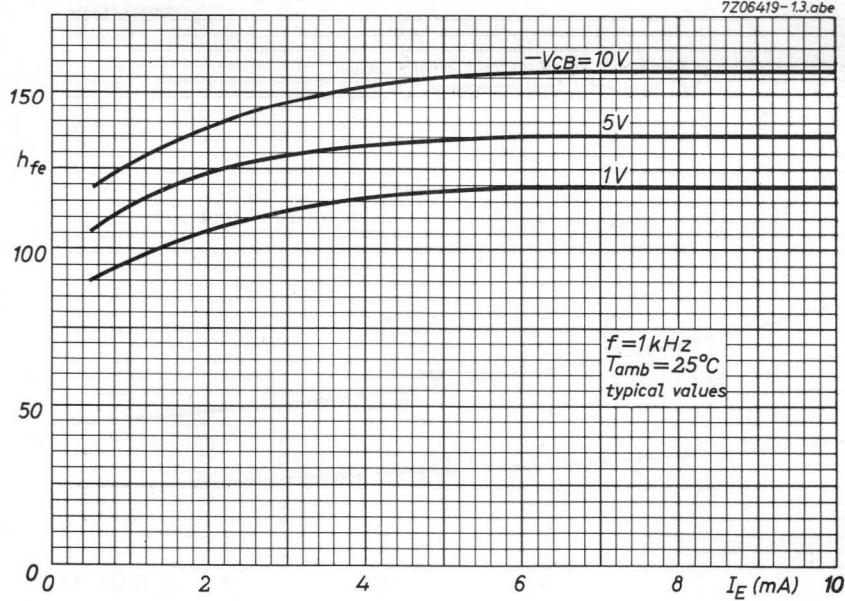




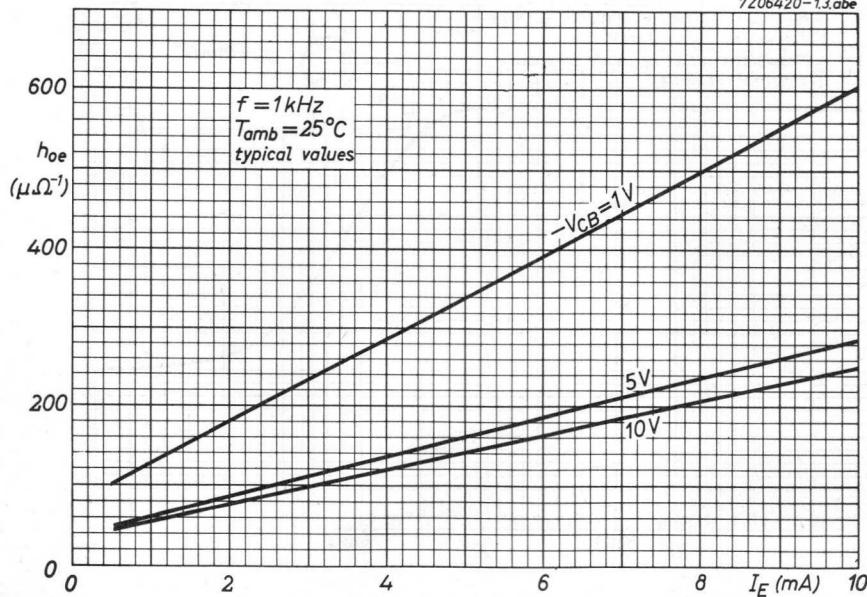
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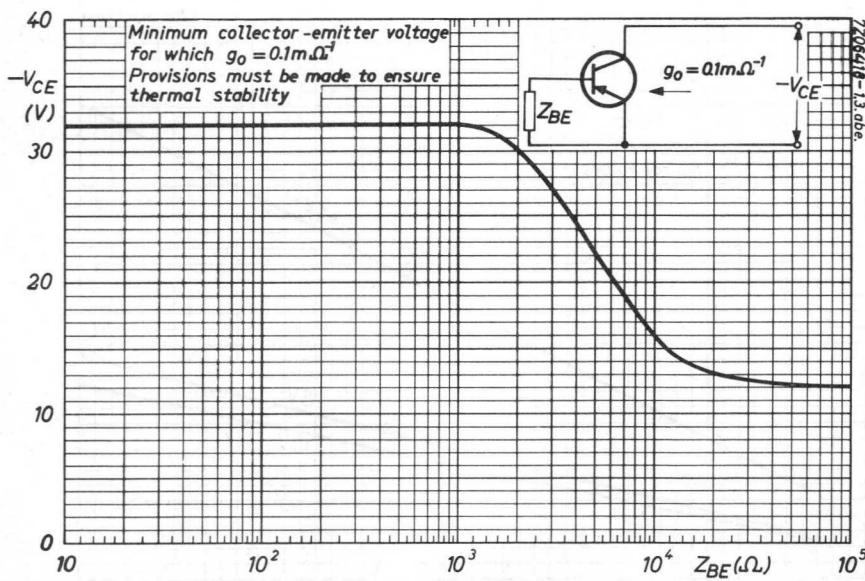
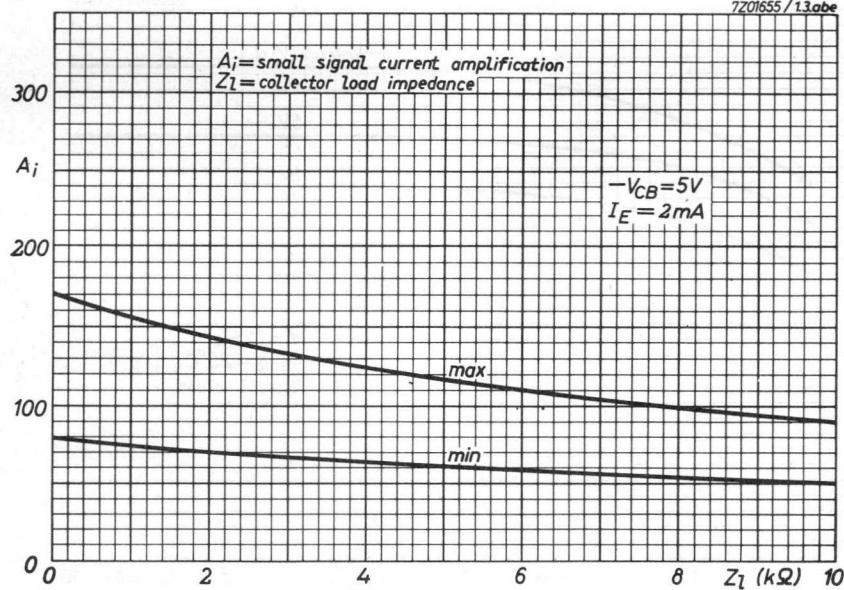


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7206420-1.3.abe





GERMANIUM ALLOY TRANSISTOR

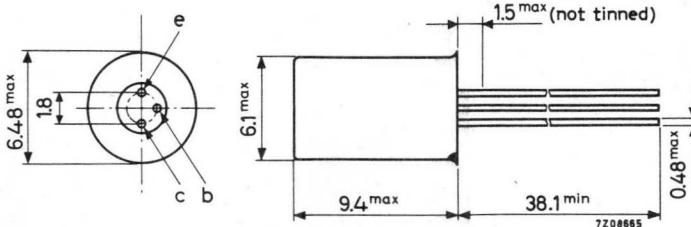
P-N-P transistor in a TO-1 metal envelope intended for use in pre-amplifier or driver stages.

QUICK REFERENCE DATA			
Collector-base voltage (open emitter)	$-V_{CBO}$	max.	32 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	12 V
Collector current (d.c.)	$-I_C$	max.	100 mA
Total power dissipation up to $T_{amb} = 45^\circ\text{C}$ with cooling fin No. 56227 on a heatsink of at least 12.5 cm^2	P_{tot}	max.	500 mW
Junction temperature	T_j	max.	90°C
D.C. current gain at $T_{amb} = 25^\circ\text{C}$ $-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$	h_{FE}	> typ.	65 140
Small signal current gain at $T_{amb} = 25^\circ\text{C}$ $I_E = 2 \text{ mA}; -V_{CB} = 5 \text{ V}; f = 1 \text{ kHz}$	h_{fe}	typ.	180 130 to 300
Transition frequency $-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_T	typ.	2.3 MHz

MECHANICAL DATA

TO-1

Dimensions in mm



The coloured dot indicates the collector

Accessories available: 56200, 56208, 56209, 56210, 56226, 56227

RATINGS (Limiting values) 1)Voltages

Collector-base voltage (open emitter)	-V _{CBO}	max.	32	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	12	V
Collector-emitter voltage with R _{BE} < 1 kΩ	-V _{CER}	max.	32	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	10	V

Currents

Collector current (d.c.)	-I _C	max.	100	mA
Emitter current (peak value)	I _{EM}	max.	200	mA

Power dissipation

Total power dissipation up to T _{amb} = 45 °C with cooling fin No. 56227 mounted on a heatsink of at least 12.5 cm ²	P _{tot}	max.	500	mW
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Temperatures

Storage temperature	T _{stg}	-55 to +90	°C
Junction temperature	T _j	max.	90 °C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	=	0.3	°C/mW
From junction to ambient with cooling fin No. 56227 mounted on a heatsink of at least 12.5 cm ²	R _{th j-a}	=	0.09	°C/mW

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_{amb} = 25^{\circ}\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; -V_{CB} = 10 \text{ V}$	$-I_{CBO}$	<	10	μA
$I_E = 0; -V_{CB} = 32 \text{ V}; T_j = 75^{\circ}\text{C}$	$-I_{CBO}$	<	800	μA

Emitter cut-off current

$I_C = 0; -V_{EB} = 5 \text{ V}; T_j = 75^{\circ}\text{C}$	$-I_{EBO}$	<	550	μA
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Emitter-base voltage

$I_E = 2 \text{ mA}; -V_{CB} = 5 \text{ V}$	V_{EB}	typ.	105	mV
$I_E = 100 \text{ mA}; V_{CB} = 0$	V_{EB}	<	400	mV

D.C. current gain

$-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$	h_{FE}	> typ.	65 140
$-I_C = 50 \text{ mA}; V_{CB} = 0$	h_{FE}	typ.	135
$-I_C = 100 \text{ mA}; V_{CB} = 0$	h_{FE}	typ.	105

Collector capacitance at $f = 0.45 \text{ MHz}$

$I_E = I_e = 0; -V_{CB} = 5 \text{ V}$	C_c	typ. <	40 50	pF
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Feedback impedance at $f = 0.45 \text{ MHz}$

$-I_C = 1 \text{ mA}; -V_{CE} = 5 \text{ V}$	$ z_{rb} $	typ.	90	Ω
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Transition frequency

$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_T	> typ.	1.7 2.3	MHz
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Cut-off frequency

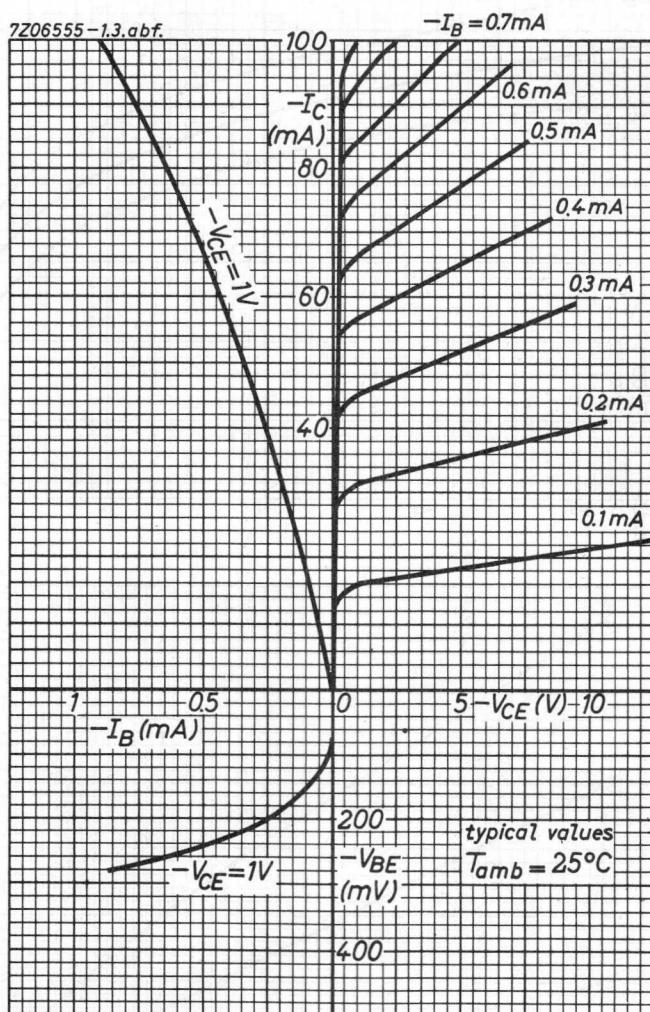
$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_{hfe}	> typ.	10 17	kHz
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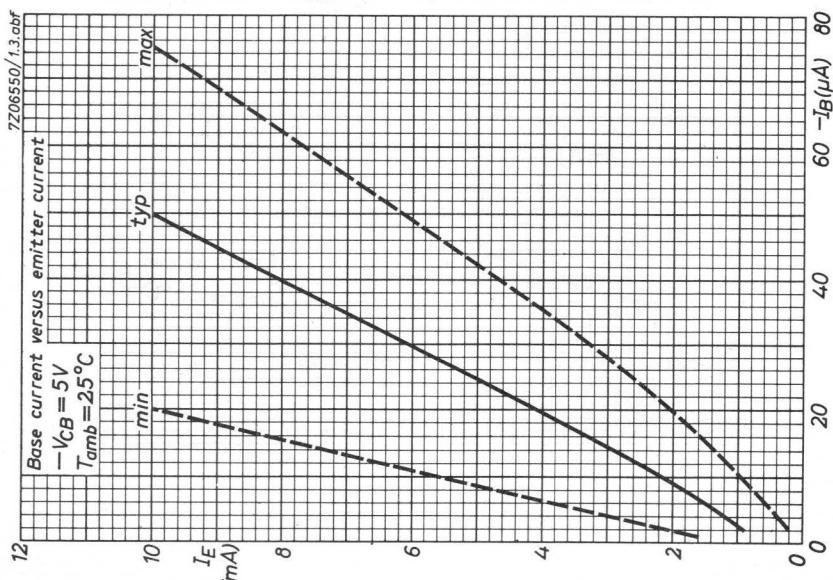
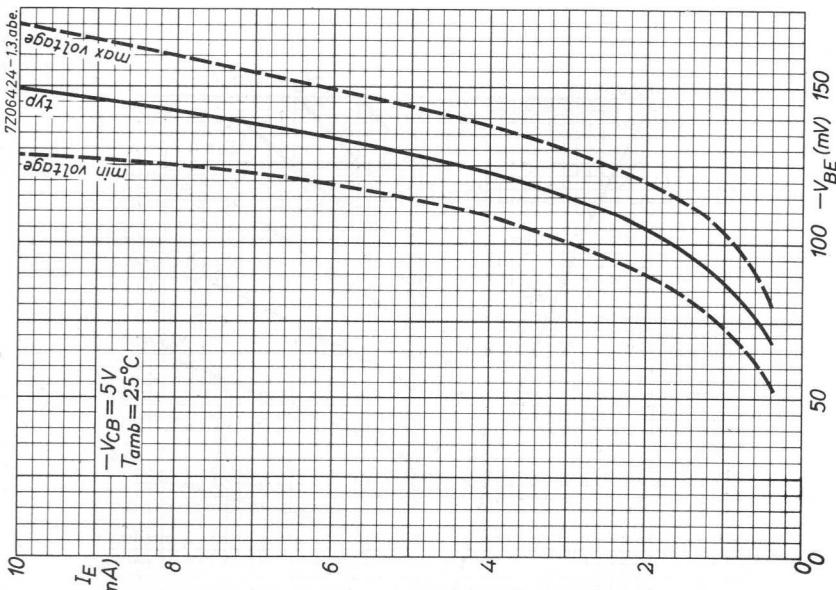
Noise figure at $f = 1 \text{ kHz}$

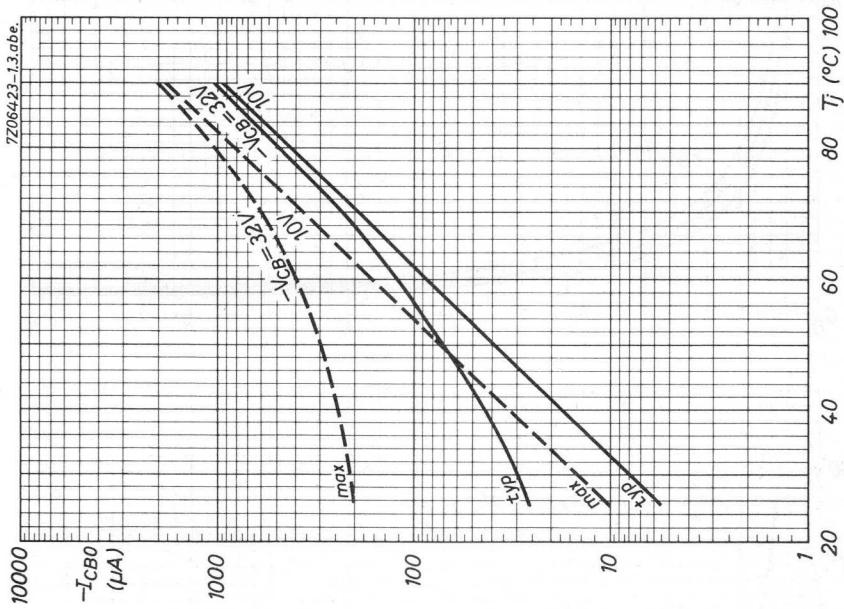
$-I_C = 0.5 \text{ mA}; -V_{CE} = 5 \text{ V}; R_S = 500 \Omega$ Bandwidth = 200 Hz	F	typ. <	4 10	dB
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CHARACTERISTICS (continued) $T_{amb} = 25^{\circ}\text{C}$ unless otherwise specifiedh parameters at $f = 1\text{ kHz}$ $-I_C = 2\text{ mA}; -V_{CE} = 5\text{ V}$

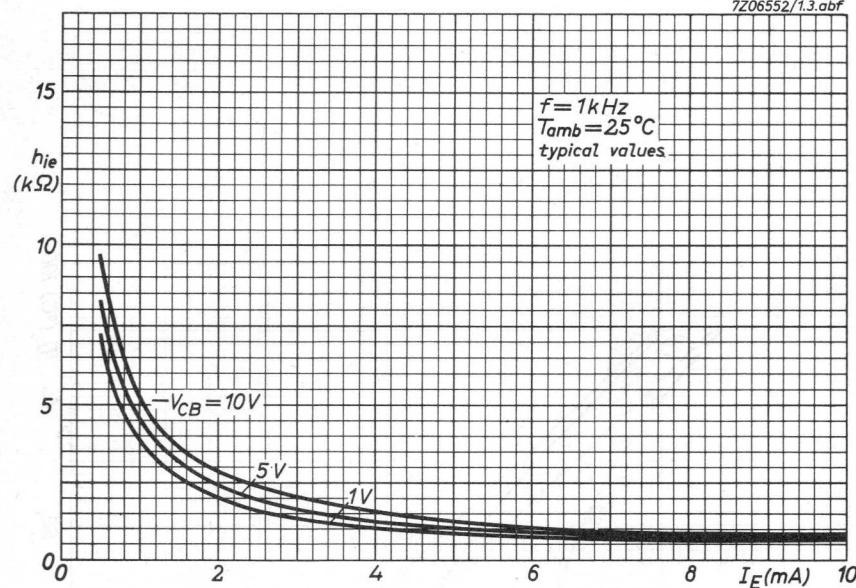
Input impedance	h_{ie}	typ.	2.4	$\text{k}\Omega$
			1.7 to 3.8	$\text{k}\Omega$
Reverse voltage transfer	h_{re}	typ.	8.0	10^{-4}
		<	13.0	10^{-4}
Small signal current gain	h_{fe}	typ.	180	
			130 to 300	
Output admittance	h_{oe}	typ.	100	$\mu\Omega^{-1}$
		<	170	$\mu\Omega^{-1}$



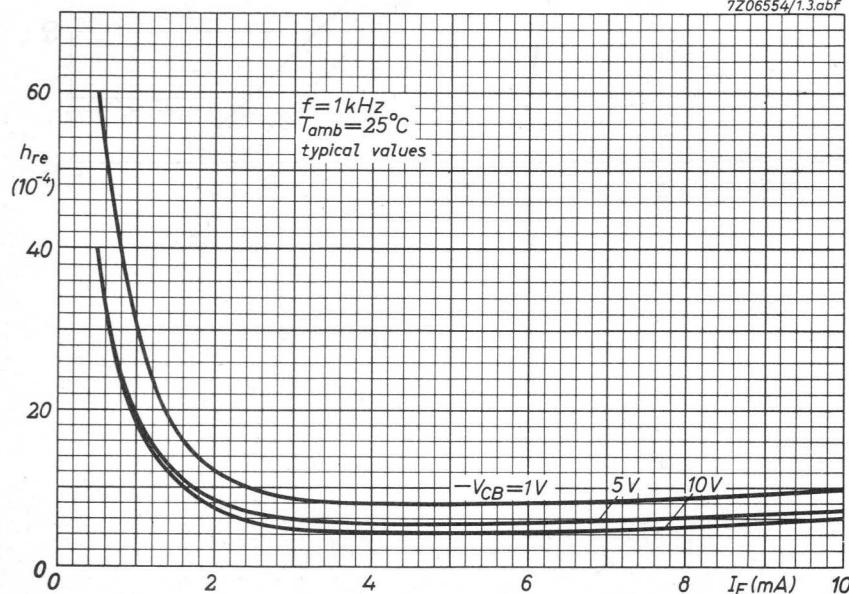


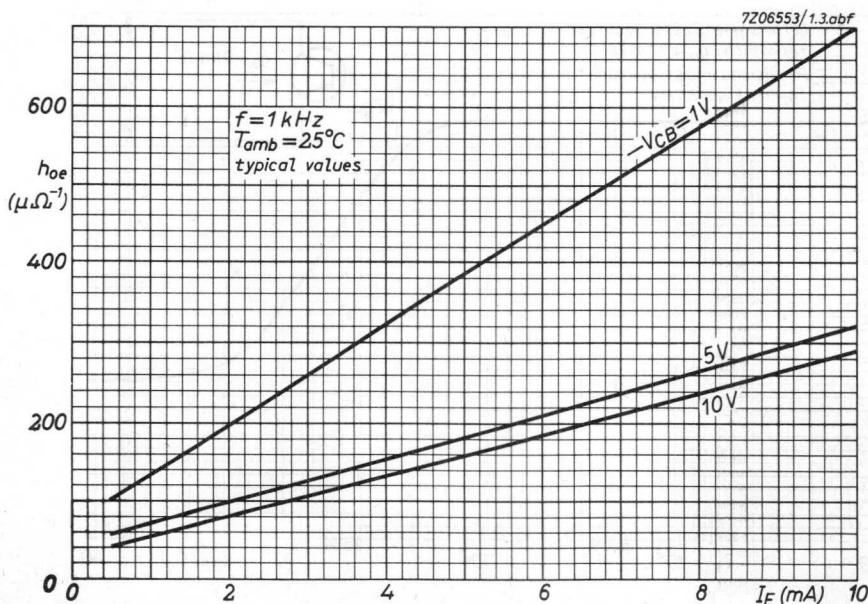
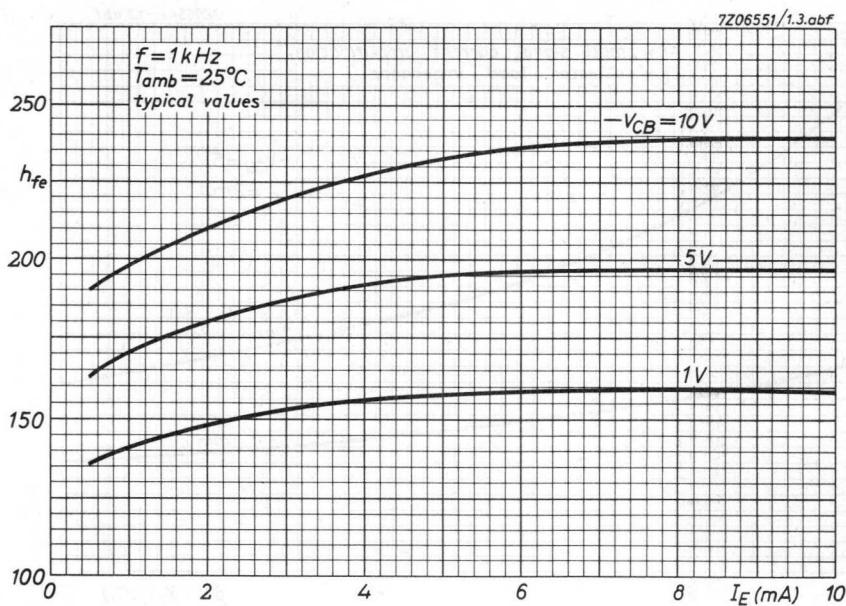


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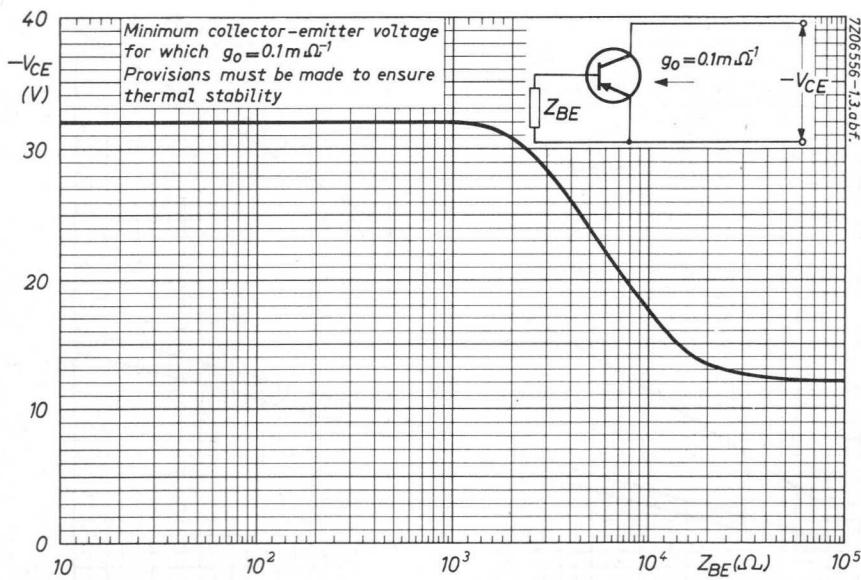
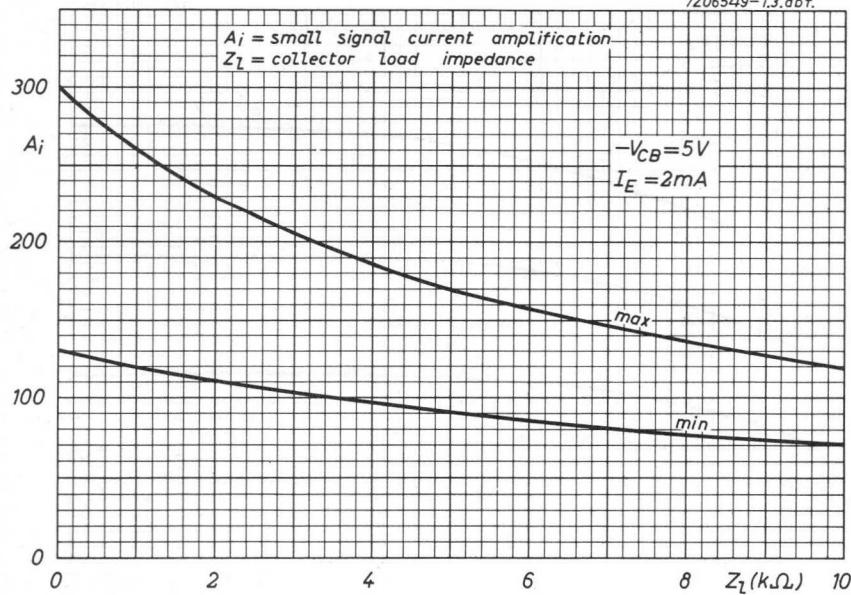


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7Z06549-1.3.abf.



GERMANIUM ALLOY TRANSISTORS

The AC127 is an n-p-n audio transistor in a TO-1 metal envelope.

The AC127 is intended for use together with the p-n-p transistors AC128 or AC132 as matched pair in class B output stages with complementary symmetry or in driver stages.

The AC127/01 is electrically equivalent to the AC127, constructed integrally with a heat conducting block, which gives better heat transfer.

The thermal resistance from junction to heatsink shows an improvement ($\approx 10^\circ\text{C/W}$) as compared with that obtained with the AC127 when using heat conducting clip 56227.

QUICK REFERENCE DATA

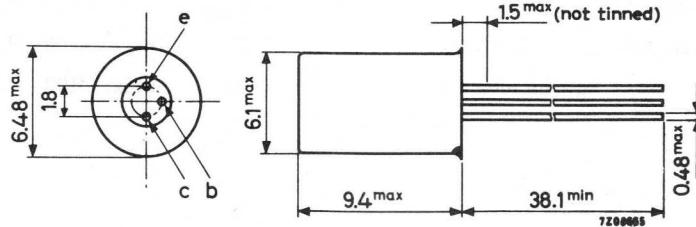
Collector-base voltage (open emitter)	V_{CBO}	max. 32 V
Collector-emitter voltage (open base)	V_{CEO}	max. 12 V
Collector current (d.c.)	I_C	max. 500 mA
Total power dissipation up to $T_{\text{amb}} = 45^\circ\text{C}$ with cooling fin on a heatsink of at least 12.5 cm^2	P_{tot}	max. 340 mW
Junction temperature (incidentally)	T_j	max. 100 $^\circ\text{C}$
D.C. current gain at $T_{\text{amb}} = 25^\circ\text{C}$ $I_C = 20 \text{ mA}; V_{\text{CB}} = 0$	h_{FE}	typ. 100
Transition frequency $I_C = 10 \text{ mA}; V_{\text{CB}} = 2 \text{ V}$	f_T	typ. 2.5 MHz

MECHANICAL DATA

Dimensions in mm

AC127

TO-1



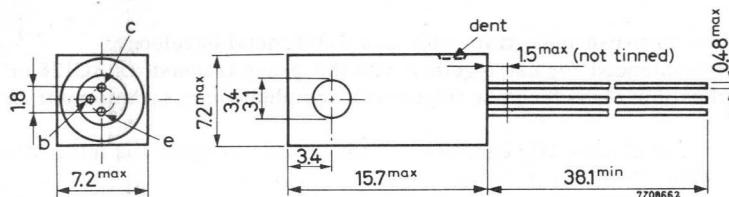
The coloured dot indicates the collector

Accessories available: 56200, 56208, 56209, 56210, 56226, 56227

MECHANICAL DATA (continued)

Dimensions in mm

AC127/01



The dent indicates the collector

RATINGS (Limiting values)¹⁾

Voltages

Collector-base voltage (open emitter)	V _{CBO}	max.	32	V
Collector-emitter voltage (open base)	V _{CEO}	max.	12	V
Collector-emitter voltage with R _{BE} < 70 Ω	V _{CER}	max.	32	V
Emitter-base voltage (open collector)	V _{EBO}	max.	10	V

Currents

Collector current (d.c.)	I _C	max.	500	mA
Base current (d.c.)	I _B	max.	25	mA

Power dissipation

Total power dissipation up to T _{amb} = 45 °C with cooling fin mounted on a heatsink of at least 12.5 cm ²	P _{tot}	max.	340	mW
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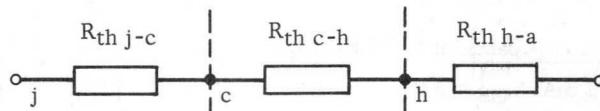
Temperatures

Storage temperature	T _{stg}	-55 to +90	°C	
Junction temperature: continuous	T _j	max.	90	°C
incidentally	T _j	max.	100	°C

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

THERMAL RESISTANCE

	AC127	AC127/01
From junction to ambient in free air		
without cooling clip	$R_{th\ j-a} = 370$	250 °C/W
with cooling clip 56227 on 1.5 mm blackened Al. heatsink of 12.5 cm ²	$R_{th\ j-a} = 160$	°C/W
with cooling clip 56227 on infinite heatsink	$R_{th\ j-a} = 125$	°C/W
From junction to case	$R_{th\ j-c} = 110$	115 °C/W



AC127 with clip 56227	110	15	°C/W
AC127/01	115	0.5	°C/W

CHARACTERISTICS

$T_{amb} = 25^\circ C$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 0.5 V$	I_{CBO}	<	10 μA
$I_E = 0; V_{CB} = 32 V; T_j = 75^\circ C$	I_{CBO}	<	1100 μA

Emitter cut-off current

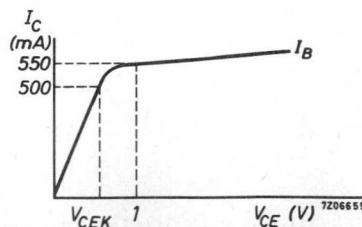
$I_C = 0; V_{EB} = 5 V; T_j = 75^\circ C$	I_{EBO}	<	550 μA
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Emitter-base voltage

$-I_E = 2 \text{ mA}; V_{CB} = 5 V$	$-V_{EB}$	typ.	120 mV
$-I_E = 500 \text{ mA}; V_{CB} = 0$	$-V_{EB}$	<	1200 mV

Knee voltage

$I_C = 500 \text{ mA}; I_B = \text{value for which}$			
$I_C = 550 \text{ mA at } V_{CE} = 1 V$	V_{CEK}	<	1 V



CHARACTERISTICS (continued)

T_{amb} = 25 °C unless otherwise specified

D.C. current gain

I _C = 20 mA; V _{CB} = 0	h _{FE}	typ.	100
I _C = 50 mA; V _{CB} = 0	h _{FE}	typ.	105
I _C = 200 mA; V _{CB} = 0	h _{FE}	typ.	90
I _C = 500 mA; V _{CB} = 0	h _{FE}	typ.	50

Collector capacitance at f = 0.45 MHz

I _E = I _e = 0; V _{CB} = 5 V	C _c	typ.	70 pF
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Feedback impedance at f = 0.45 MHz

I _C = 1 mA; V _{CE} = 5 V	z _{rb}	typ.	70 Ω
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Transition frequency

I _C = 10 mA; V _{CE} = 2 V	f _T	> typ.	1.5 2.5 MHz
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Cut-off frequency

I _C = 10 mA; V _{CE} = 2 V	f _{hfe}	> typ.	10 kHz 20 kHz
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Noise figure at f = 1 kHz

I _C = 0.5 mA; V _{CE} = 5 V; R _S = 500 Ω Bandwidth = 200 Hz	F	typ. <	4 dB 10 dB
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D.C. current gain ratio of
matched pair AC127/AC128

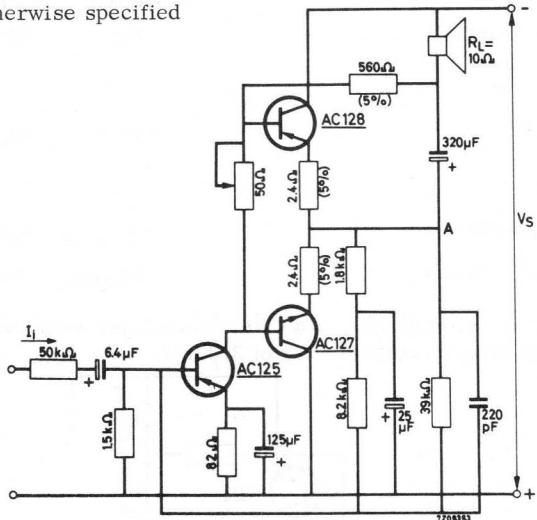
I _C = 300 mA; V _{CB} = 0 matched pair AC127/AC132	h _{FE1} /h _{FE2}	typ.	1.1
I _C = 50 mA; V _{CB} = 0	h _{FE1} /h _{FE2}	typ. <	1.1 1.25

APPLICATION INFORMATION

1. AC127/AC128 as matched pair in a class B amplifier with complementary symmetry delivering an output power of 550 mW.

Tolerance of resistors:

10% unless otherwise specified



Stable continuous operation is ensured up to an ambient temperature of 45°C, provided each transistor is mounted with a cooling fin type No. 56226.

OPERATING CHARACTERISTICS

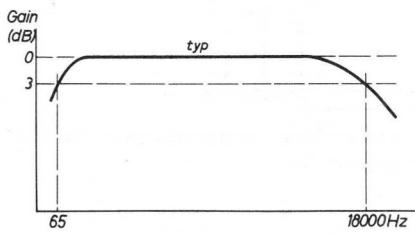
$T_{amb} = 25 \text{ }^{\circ}\text{C}$

Supply voltage

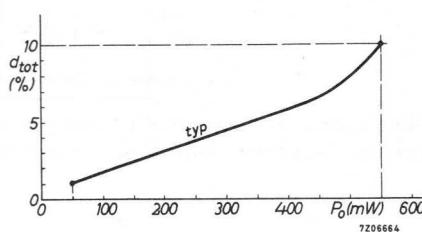
V_S = 9 V

Output power ($d_{tot} = 10\%$)

$P_0 > 500 \text{ mW}$
typ. 550 mW



Typical frequency response



Typical distortion as a function of output power

APPLICATION INFORMATION (continued)

Output stage

Emitter current (zero signal)	$ I_E $	=	3 mA
Collector current (peak value)	$ I_{CM} $	typ.	300 mA
Midtap voltage at point A	V _A	typ.	4.9 V

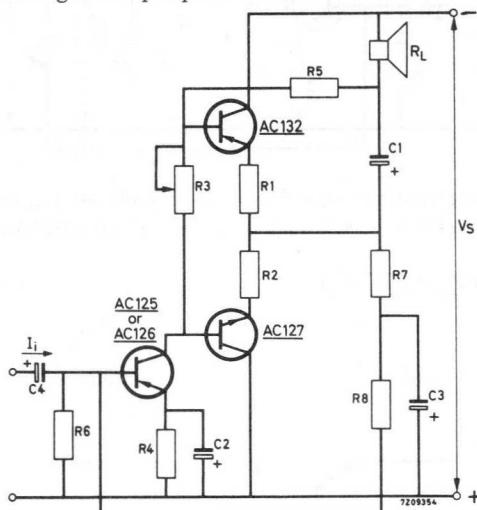
Driver stage

Collector current	-I _C	typ.	7 mA
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Sensitivity

Input current ($P_0 = 550$ mW)	I _{i(rms)}	typ.	120 μ A
Input current ($P_0 = 50$ mW)	I _{i(rms)}	typ.	35 μ A

2. AC127/AC132 as matched pair in a class B amplifier with complementary symmetry delivering an output power of 370 mW.

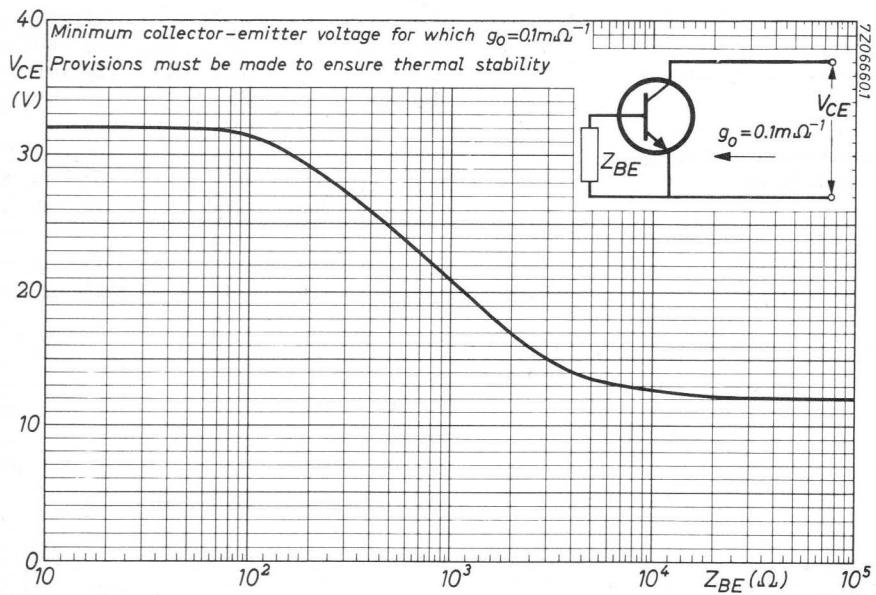
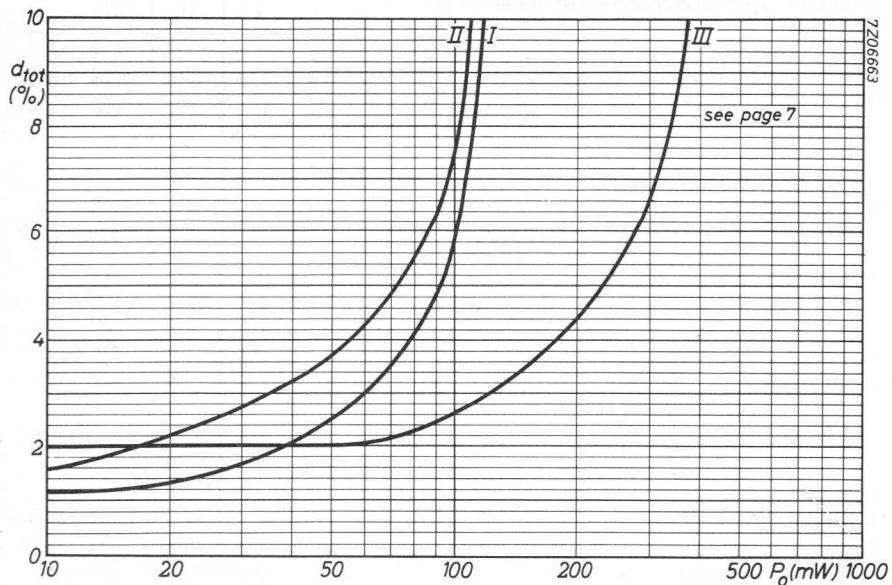


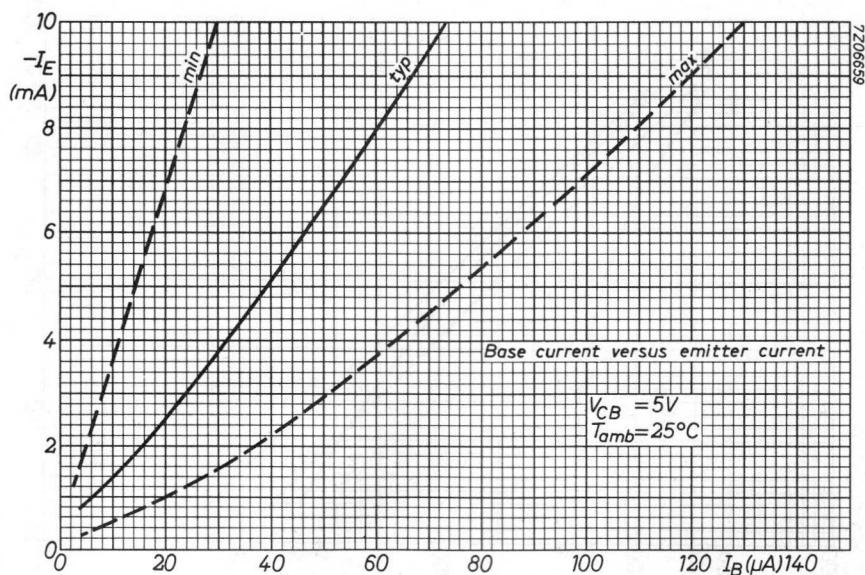
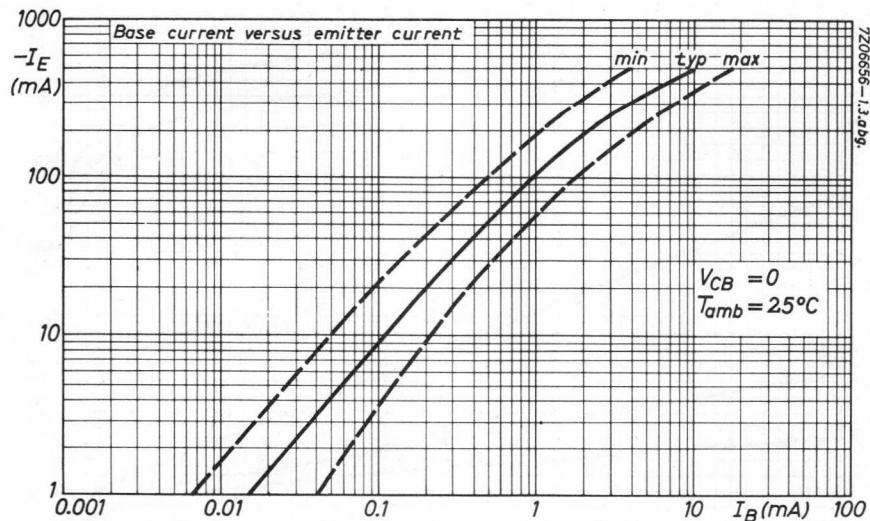
Stable continuous operation is ensured up to an ambient temperature of 45 °C, provided each transistor is mounted with a cooling fin.

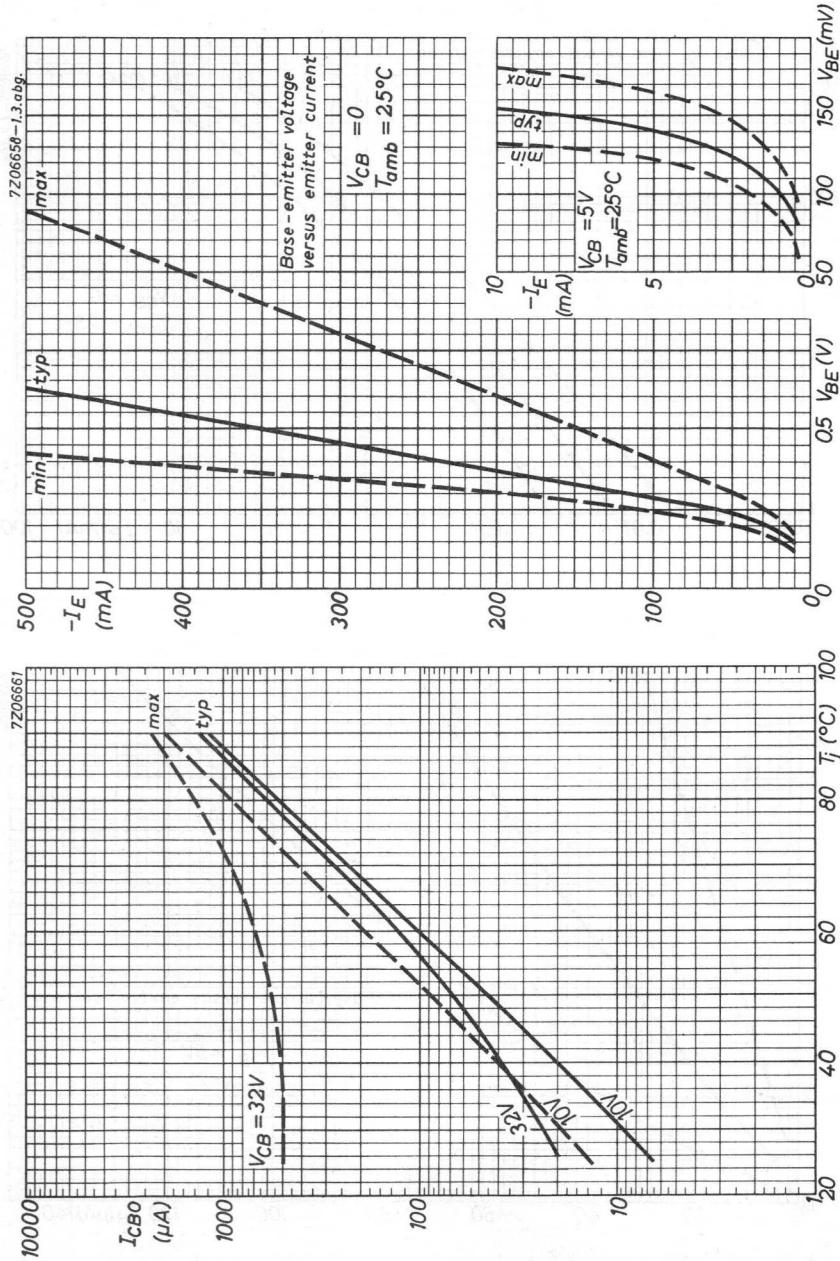
APPLICATION INFORMATION (continued)

		I	II	III
Supply voltage	V _S	= 6	9	9 V
Output power (at d = 10%)	P _O	typ. 115	110	370 mW
Distortion	d _{tot}	See page 8	100	300 mW
<u>Output stage</u>				
Emitter current (zero signal)	I _{E1}	= 2	2	2 mA
	-I _{E2}	= 2	2	2 mA
Emitter resistors	R ₁	= 3.3	4.7	3.9 Ω
	R ₂	= 3.3	4.7	3.9 Ω
Bias resistor	R ₃	< 100	250	50 Ω
Coupling capacitor	C ₁	= 200	64	320 μF
Load resistance	R _L	= 25	70	15 Ω
Collector current (peak value) at P _O max.	I _{CM}	typ. 90	50	200 mA
<u>Driver stage</u>				
Collector current	-I _C	typ. 2.7	1.2	7.6 mA
Emitter resistor	R ₄	= 180	680	82 Ω
Collector resistor	R ₅	= 910	3300	510 Ω
Bias resistors	R ₆	= 4.7	6.8	1.8 kΩ
	R ₇	= 3.9	4.7	2.2 kΩ
	R ₈	= 15	24	6.8 kΩ
Decoupling capacitors	C ₂	= 40	25	120 μF
	C ₃	= 25	25	25 μF
Coupling capacitor	C ₄	= 6.4	6.4	6.4 μF
Input current at P _O max. with AC125	I _{i(rms)}	typ. 20	10	55 μA
with AC126	I _{i(rms)}	typ. 15	8	40 μA
Input current at P _O = 50 mW with AC125	I _{i(rms)}	typ. 11.5	6	17 μA
with AC126	I _{i(rms)}	typ. 9	4.5	12.5 μA
Total harmonic distortion at P _O = 50 mW	d _{tot}	typ. 2.5	3.8	2.0 %

7706663







GERMANIUM ALLOY TRANSISTORS

The AC128 is a p-n-p audio transistor in a TO-1 metal envelope.

The AC128 is intended for use in class A or class B output stages with battery voltages up to 14 V and an output power of up to 4 W.

Type 2-AC128 consists of 2 transistors AC128 selected for operation in a low distortion class B amplifier.

The AC128/01 is electrically equivalent to the AC128, constructed integrally with a heat conducting block which gives better heat transfer.

The thermal resistance from junction to heatsink shows an improvement ($\approx 10^\circ\text{C}/\text{W}$) as compared with that obtained with the AC128 when using heat conducting clip 56227.

Type 2-AC128 and type 2-AC128/01 consist of 2 transistors AC128 and AC128/01 resp. selected for operation in a low distortion class B amplifier.

QUICK REFERENCE DATA

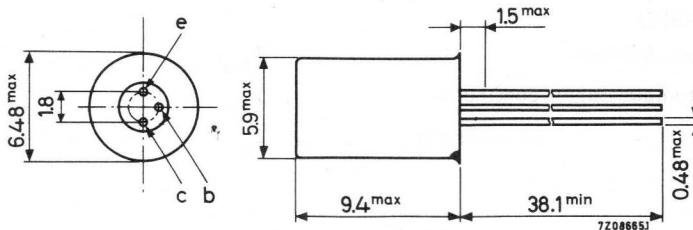
Collector-base voltage (open emitter)	$-V_{\text{CBO}}$	max. 32 V
Collector-emitter voltage (open base)	$-V_{\text{CEO}}$	max. 16 V
Collector current (d.c.)	$-I_C$	max. 1 A
Total power dissipation up to $T_{\text{amb}} = 20^\circ\text{C}$ with cooling fin 56227 on a blackened Al.heatsink of at least 12.5 cm^2	P_{tot}	max. 1 W
Junction temperature (incidentally)	T_j	max. 100°C
D.C. current gain at $T_{\text{amb}} = 25^\circ\text{C}$ $-I_C = 50 \text{ mA}; V_{\text{CB}} = 0$	h_{FE}	typ. 90 55 to 175
Transition frequency $-I_C = 10 \text{ mA}; -V_{\text{CE}} = 2 \text{ V}$	f_T	typ. 1.5 MHz

MECHANICAL DATA

Dimensions in mm

AC128

TO-1



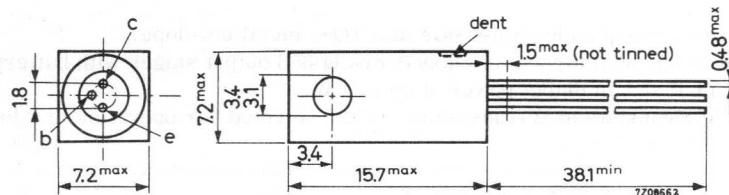
The coloured dot indicates the collector

Accessories available: 56200, 56208, 56209, 56210, 56226, 56227

MECHANICAL DATA (continued)

Dimensions in mm

AC128/01



The dent indicates the collector

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134).

Voltages

Collector-base voltage (open emitter)	-V _{CBO}	max.	32	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	16	V
Collector-emitter voltage with R _{BE} < 400 Ω	-V _{CER}	max.	32	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	10	V

Currents

Collector current (d.c.)	-I _C	max.	1000	mA
Collector current (peak value)	-I _{CM}	max.	2000	mA
Emitter current (peak value)	I _{EM}	max.	2000	mA

Power dissipation

Total power dissipation up to T _{amb} = 25 °C with cooling fin 56227 mounted on a blackened Al. heatsink of at least 12.5 cm ²	P _{tot}	max.	1000	mW
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Temperatures

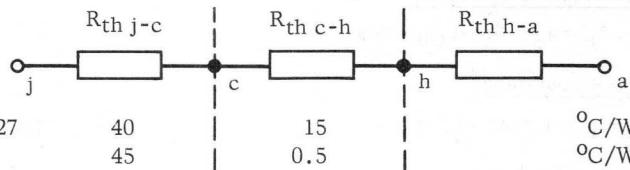
Storage temperature	T _{stg}	-55 to +100	°C	
Junction temperature: continuous	T _j	max.	90	°C
incidentally	T _j	max.	100	°C

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

THERMAL RESISTANCE

From junction to ambient in free air

	AC128	AC128/01
without cooling clip	$R_{th\ j-a} = 290$	180 °C/W
with cooling clip 56227	$R_{th\ j-a} = 140$	°C/W
with cooling clip 56227 on 1.5 mm blackened Al, heatsink of 12.5 cm ²	$R_{th\ j-a} = 80$	°C/W
with cooling clip 56227 on infinite heatsink	$R_{th\ j-a} = 55$	°C/W
From junction to case	$R_{th\ j-c} = 40$	45 °C/W



AC128 with clip 56227	40	°C/W
AC128/01	45	°C/W

CHARACTERISTICS

$T_{amb} = 25$ °C unless otherwise specified

Collector cut-off current

$I_E = 0; -V_{CB} = 10$ V	$-I_{CBO}$	<	10	μA
$I_E = 0; -V_{CB} = 32$ V	$-I_{CBO}$	<	200	μA

Emitter cut-off current

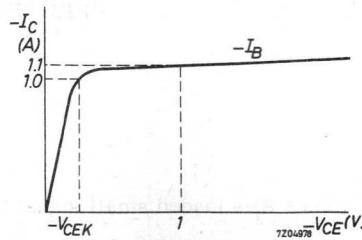
$I_C = 0; -V_{EB} = 10$ V	$-I_{EBO}$	<	200	μA
$I_C = 0; -V_{EB} = 5$ V; $T_j = 75$ °C	$-I_{EBO}$	<	500	μA

Emitter-base voltage

$I_E = 50$ mA; $V_{CB} = 0$	V_{EB}	<	300	mV
$I_E = 300$ mA; $V_{CB} = 0$	V_{EB}	<	450	mV

Knee voltage

$-I_C = 1$ A; $-I_B$ = value for which $-I_C = 1.1$ A at $-V_{CE} = 1$ V	$-V_{CEK}$	<	0.6	V
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CHARACTERISTICS (continued)

T_{amb} = 25 °C unless otherwise specified

D.C. current gain

-I _C = 50 mA; V _{CB} = 0	h _{FE}	typ. 90 55 to 175
-I _C = 300 mA; V _{CB} = 0	h _{FE}	typ. 90 60 to 175
-I _C = 1 A; V _{CB} = 0	h _{FE}	typ. 80 45 to 165

Collector capacitance

I _E = I _e = 0; -V _{CB} = 5 V	C _C	typ. 100 pF
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Base resistance

-I _C = 1 mA; -V _{CE} = 5 V	r _{bb'}	typ. 25 Ω
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Transition frequency

-I _C = 10 mA; -V _{CE} = 2 V	f _T	> 1.0 MHz typ. 1.5 MHz
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Cut-off frequency

-I _C = 10 mA; -V _{CE} = 2 V	f _{hfe}	> 10 kHz typ. 15 kHz
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Small signal current gain linearity

(see also page 10)	λ ₅₀₀	> 0.50 1) typ. 0.60 1)
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D.C. current gain ratio of matched pair AC127/AC128

I _C = 300 mA; V _{CB} = 0	h _{FE1} /h _{FE2}	typ. 1.1
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matched pair 2-AC128

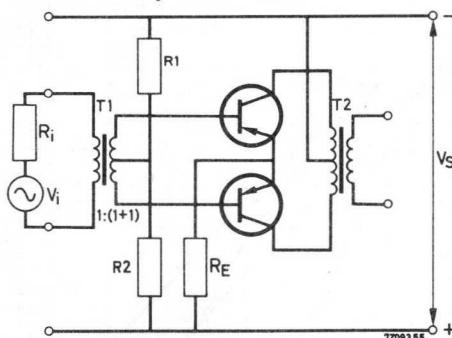
I _C = 50 mA; V _{CB} = 0	h _{FE1} /h _{FE2}	typ. 1.1 < 1.25
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I _C = 300 mA; V _{CB} = 0	h _{FE1} /h _{FE2}	typ. 1.1 < 1.25
--	------------------------------------	--------------------

1) λ₅₀₀ = $\frac{A_i \text{ at } 500 \text{ mA}}{A_i \text{ max}}$, where A_i = loaded small signal current amplification.

APPLICATION INFORMATION

Class B operation with matched pair 2-AC128



To provide stability the total resistance in the base circuit of each transistor should be less than $100\ \Omega$.

	V _S	=	6	9	9	V
Ambient temperature	T _{amb}	up to	55	55	45	°C
Emitter current (zero signal)	I _E	=	2x3	2x3	2x3	mA
Bias resistor 1)	R ₁	=	2.0	2.2	3.5 ²⁾	kΩ
Bias resistor 1)	R ₂	=	47	39	3) ³⁾	Ω
Common emitter resistor	R _E	=	2.2	3.9	1.5	Ω
Input (source) resistance	R _i	=	1.5	1.5	1.0	kΩ
Load resistance	R _{cc~}	=	65	98	62	Ω
Dissipation (two transistors) ⁴⁾	P _{tot}	typ.	2x0.425	2x0.65	2x1.05	W
Power delivered to transformer	P _O	typ.	0.75	1.1	1.9	W
Collector current (peak value)						
at P _O max	-I _{CM}	typ.	300	300	500	mA
Collector current at P _O max	-I _C	typ.	2x95	2x95	2x150	mA
Input voltage at P _O max	V _i	typ.	5.5	6.0	6.6 ⁵⁾	V
Total harmonic distortion						
at P _O max	d _{tot}	typ.	3.5	4.0	5.5	%
Input voltage at P _O = 50 mW	V _i	typ.	1.6	1.4	1.15 ⁵⁾	V
Total harmonic distortion						
at P _O = 50 mW	d _{tot}	typ.	2.0	2.0	2.5	%

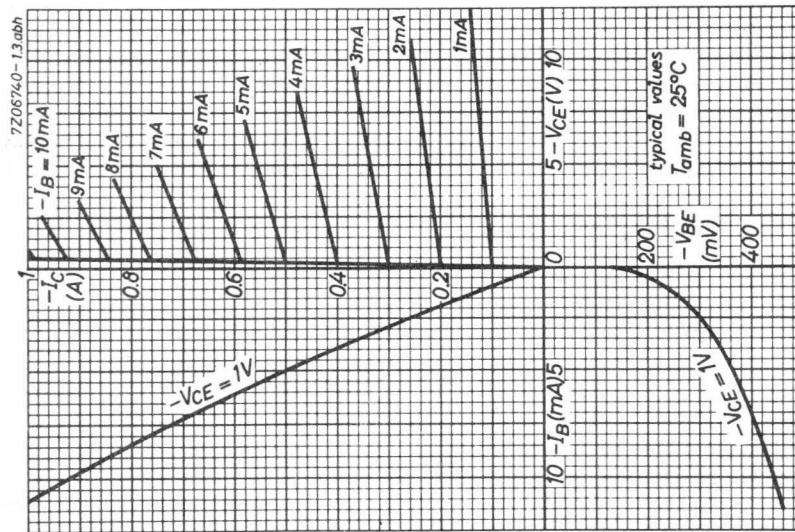
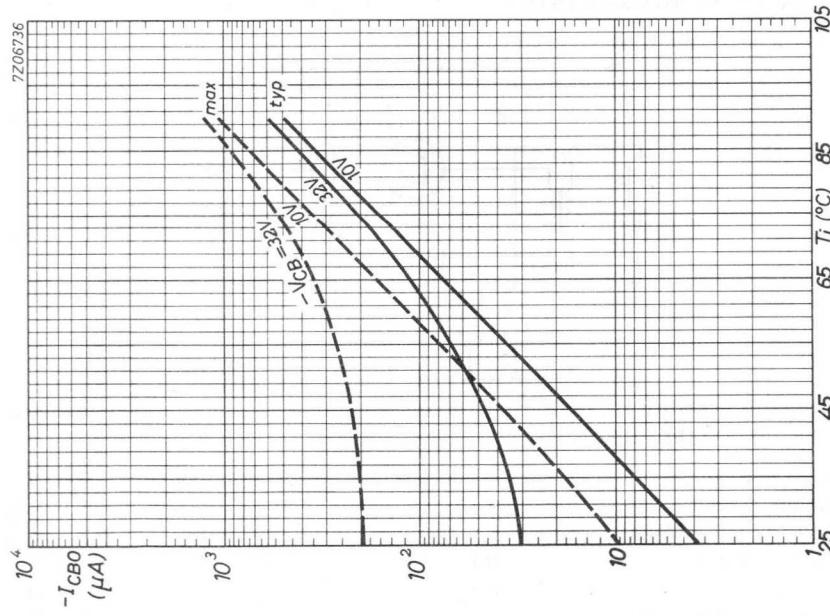
1) Tolerance of bias resistors: 5 %

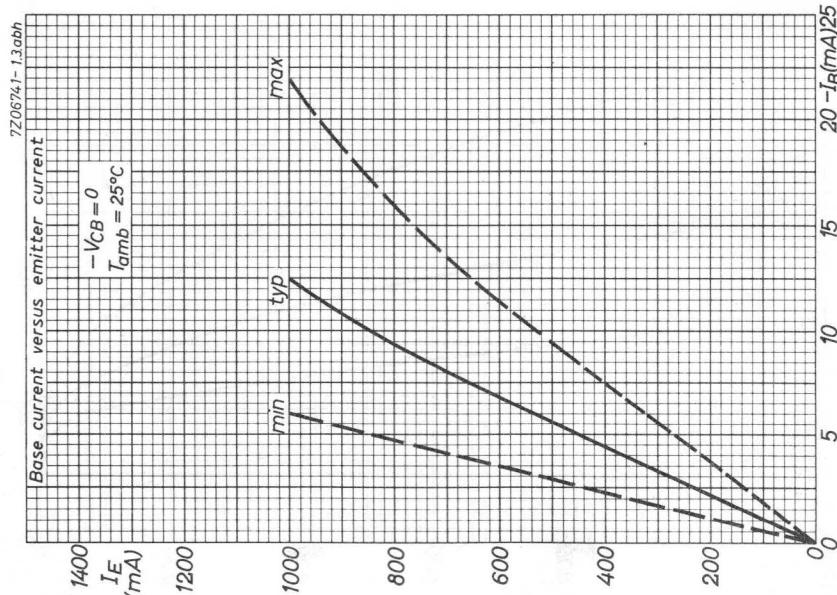
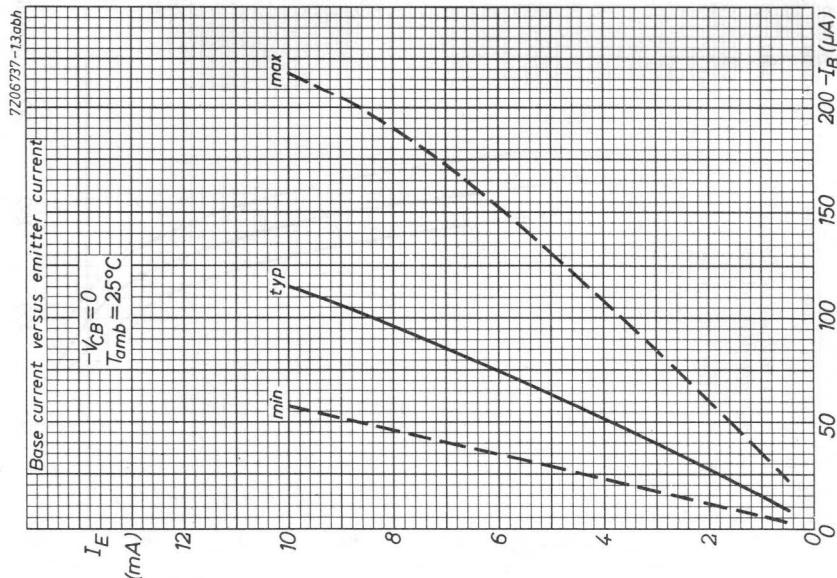
2) Variable resistor.

3) This resistance is composed of a $68\ \Omega$ resistor in parallel with a $130\ \Omega$ NTC resistor. Code number 2322 610 12131.

4) Mounted on cooling fin 56227 at T_{amb} up to $20\text{ }^{\circ}\text{C}$.

5) Losses in the driver transformer are not taken into account.

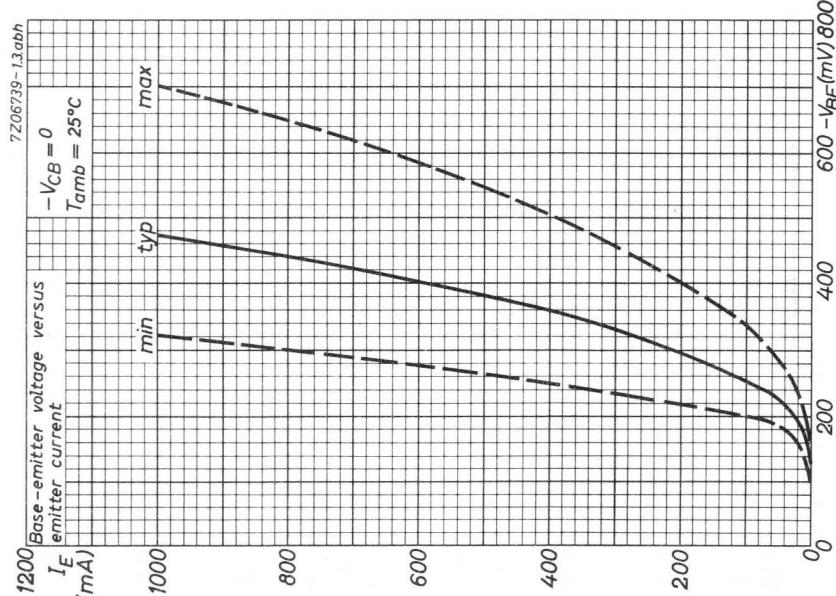
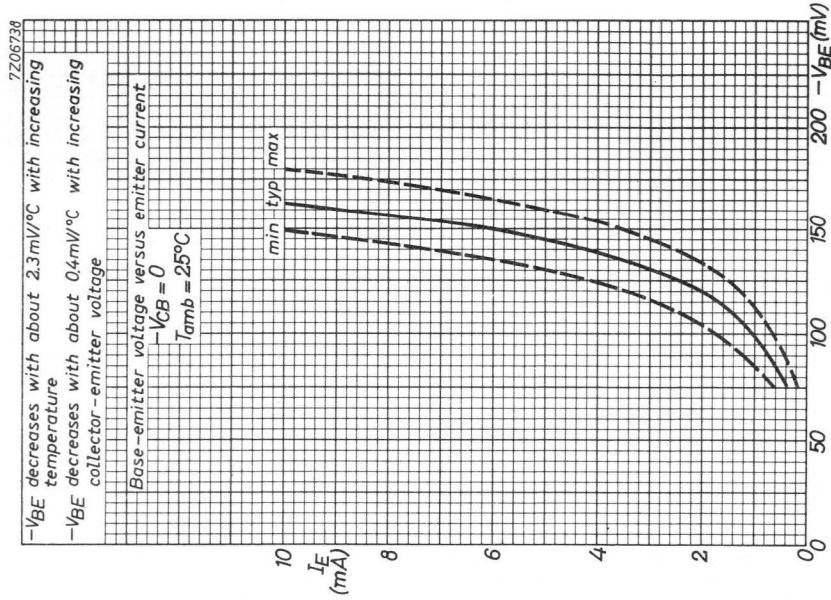


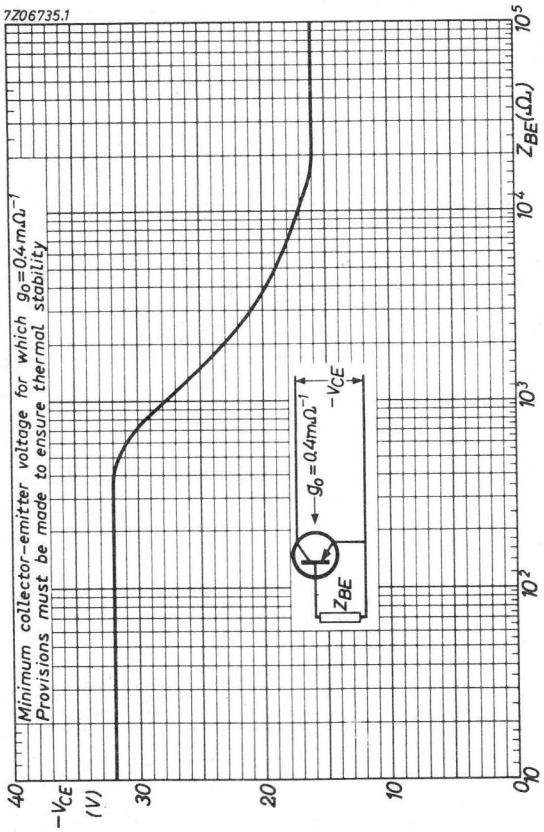


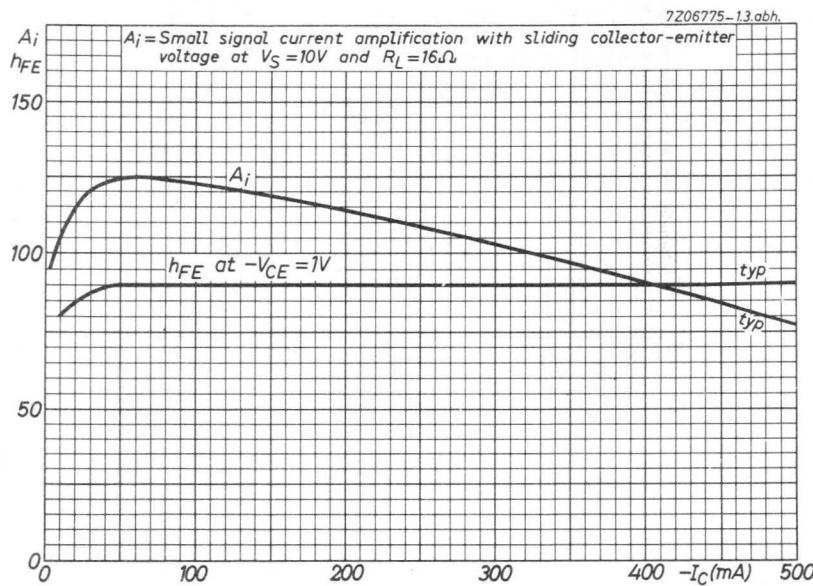
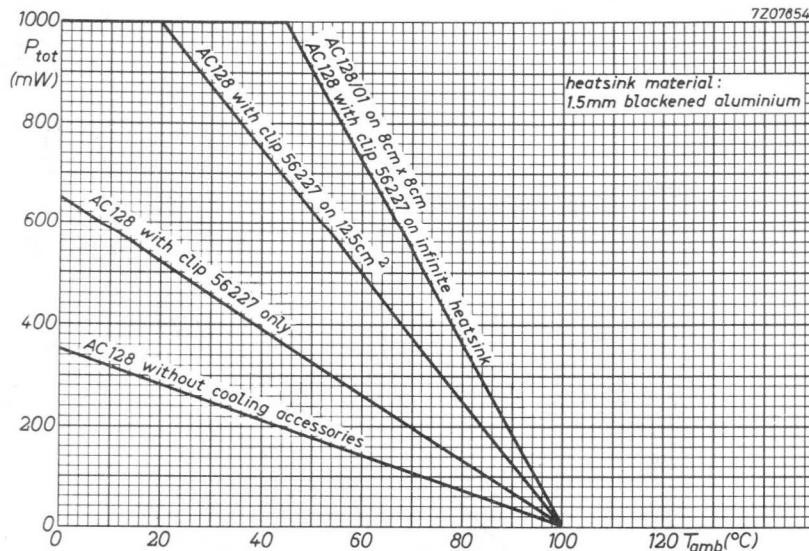
AC128 AC128/01

2-AC128

2-AC128/01







GERMANIUM ALLOY TRANSISTORS

The AC132 is a p-n-p audio transistor in a TO-1 metal envelope.

The AC132 is intended for use together with the n-p-n transistor AC127 as matched pair AC127/AC132 in class B output stages with complementary symmetry.

The 2-AC132 consists of 2 transistors AC132 selected for operation in class B output stages.

The AC132/01 is electrically equivalent to the AC132, constructed integrally with a heat conducting block which gives better heat transfer.

The thermal resistance from junction to heatsink shows an improvement ($\approx 10^\circ\text{C/W}$) as compared with that obtained with the AC132 when using heat conducting clip 56227.

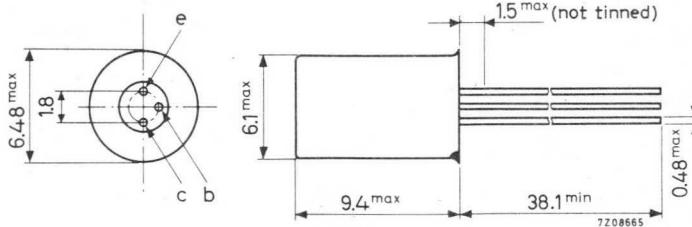
QUICK REFERENCE DATA		
Collector-base voltage (open emitter)	$-V_{\text{CBO}}$	max. 32 V
Collector-emitter voltage (open base)	$-V_{\text{CEO}}$	max. 12 V
Collector current (d.c.)	$-I_{\text{C}}$	max. 200 mA
Total power dissipation up to $T_{\text{amb}} = 45^\circ\text{C}$ with cooling fin on a heatsink of at least 12.5 cm ²	P_{tot}	max. 500 mW
Junction temperature	T_j	max. 90 $^\circ\text{C}$
D.C. current gain at $T_{\text{amb}} = 25^\circ\text{C}$ $-I_{\text{C}} = 20 \text{ mA}; V_{\text{CB}} = 0$	h_{FE}	typ. 135
Transition frequency $-I_{\text{C}} = 10 \text{ mA}; -V_{\text{CE}} = 2 \text{ V}$	f_T	typ. 2.0 MHz

MECHANICAL DATA

Dimensions in mm

AC132

TO-1



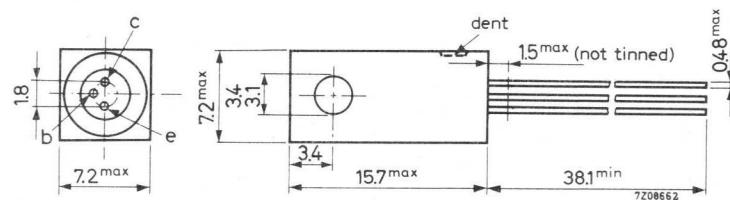
The coloured dot indicates the collector

Accessories available: 56200, 56208, 56209, 56210, 56226, 56227

MECHANICAL DATA (continued)

Dimensions in mm

AC132/01



The dent indicates the collector

RATINGS (Limiting values)¹⁾

Voltages

Collector-base voltage (open emitter)	-V _{CBO}	max.	32	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	12	V
Collector-emitter voltage with R _{BE} < 1 kΩ	-V _{CER}	max.	32	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	10	V

Currents

Collector current (d.c.)	-I _C	max.	200	mA
Emitter current (peak value)	I _{EM}	max.	200	mA

Power dissipation

Total power dissipation up to T _{amb} = 45 °C with cooling fin mounted on a heatsink of at least 12.5 cm ²	P _{tot}	max.	500	mW
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Temperatures

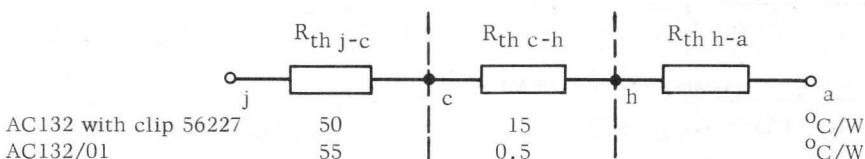
Storage temperature	T _{stg}	-55 to +90	°C	
Junction temperature	T _j	max.	90	°C

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

THERMAL RESISTANCE

From junction to ambient in free air

	AC132	AC132/01	
without cooling clip	$R_{th\ j-a}$ = 300	190	°C/W
with cooling clip 56227 on 1.5 mm blackened Al, heatsink of 12.5 cm ²	$R_{th\ j-a}$ = 90		°C/W
with cooling clip 56227 on infinite heatsink	$R_{th\ j-a}$ = 65		°C/W
From junction to case	$R_{th\ j-c}$ = 50	55	°C/W



CHARACTERISTICS

$T_{amb} = 25$ °C unless otherwise specified

Collector cut-off current

$I_E = 0$; $-V_{CB} = 0.5$ V $-I_{CBO}$ < 10 μ A

$I_E = 0$; $-V_{CB} = 32$ V; $T_j = 75$ °C $-I_{CBO}$ < 800 μ A

Emitter cut-off current

$I_C = 0$; $-V_{EB} = 5$ V; $T_j = 75$ °C $-I_{EBO}$ < 550 μ A

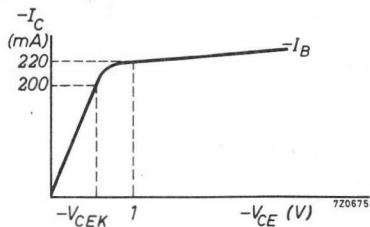
Emitter-base voltage

$I_E = 2$ mA; $-V_{CB} = 5$ V V_{EB} typ. 105 mV

$I_E = 200$ mA; $V_{CB} = 0$ V_{EB} < 550 mV

Knee voltage

$-I_C = 200$ mA; $-I_B$ = value for which
 $-I_C = 220$ mA at $-V_{CE} = 1$ V $-V_{CEK}$ < 350 mV



CHARACTERISTICS (continued) $T_{\text{amb}} = 25^{\circ}\text{C}$ unless otherwise specified

D.C. current gain

$-I_C = 20 \text{ mA}; V_{CB} = 0$	h_{FE}	typ.	135
$-I_C = 50 \text{ mA}; V_{CB} = 0$	h_{FE}	typ.	115
$-I_C = 200 \text{ mA}; V_{CB} = 0$	h_{FE}	typ.	70

Collector capacitance at $f = 0.45 \text{ MHz}$

$I_E = I_e = 0; -V_{CB} = 5 \text{ V}$	C_C	typ.	40 pF
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Feedback impedance at $f = 0.45 \text{ MHz}$

$-I_C = 1 \text{ mA}; -V_{CE} = 5 \text{ V}$	$ z_{rb} $	typ.	90 Ω
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Transition frequency

$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_T	>	1.3 MHz
		typ.	2.0 MHz

Cut-off frequency

$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_{hfe}	>	10 kHz
		typ.	17 kHz

Noise figure at $f = 1 \text{ kHz}$

$-I_C = 0.5 \text{ mA}; -V_{CE} = 5 \text{ V}; R_S = 500 \Omega$	F	typ.	4 dB
Bandwidth = 200 Hz		<	10 dB

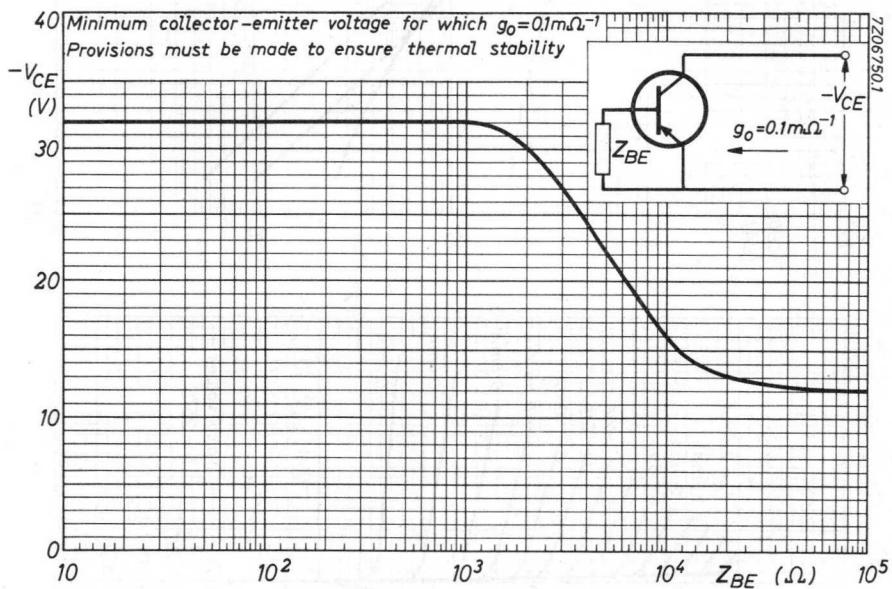
D.C. current gain ratio of
matched pair AC127/AC132

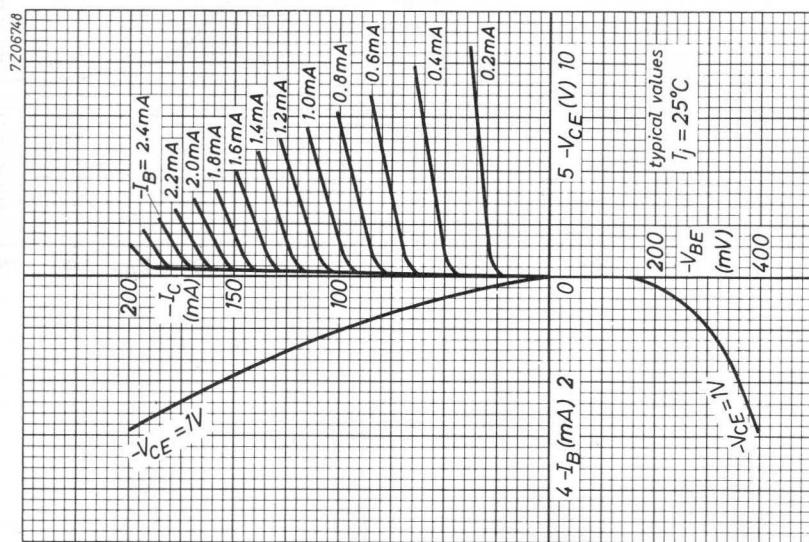
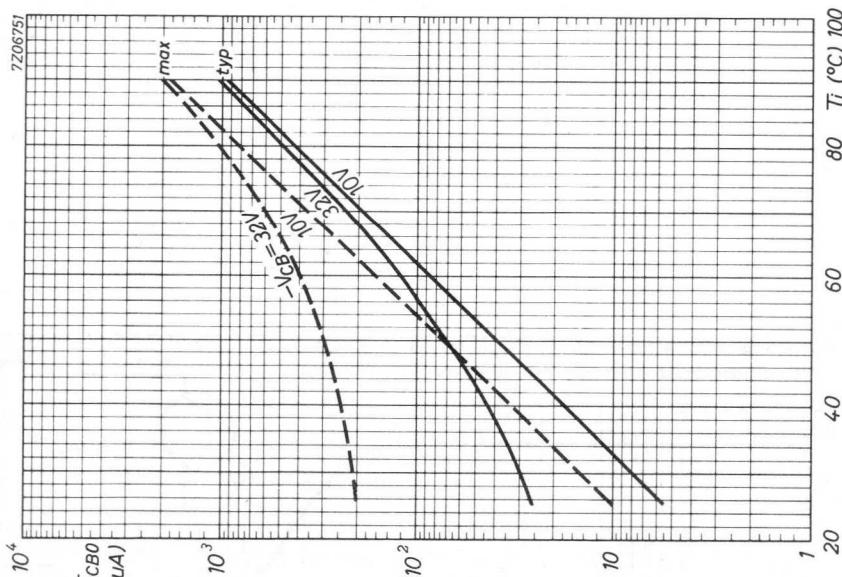
$ I_C = 50 \text{ mA}; V_{CB} = 0$	h_{FE1}/h_{FE2}	typ.	1.1
		<	1.25

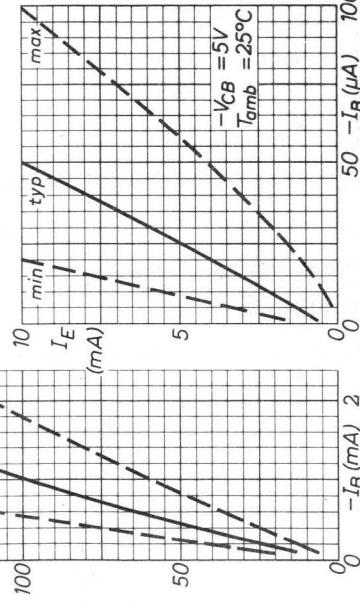
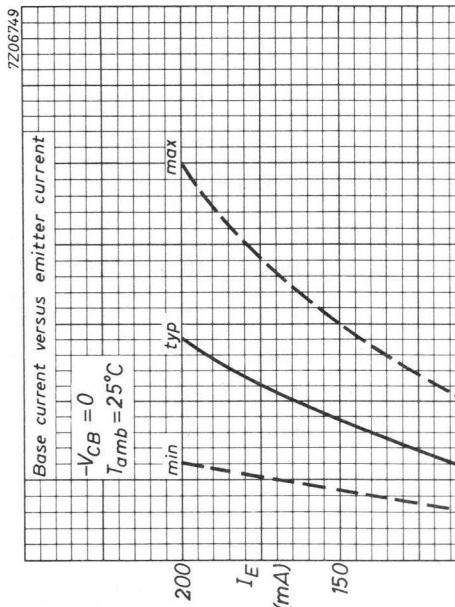
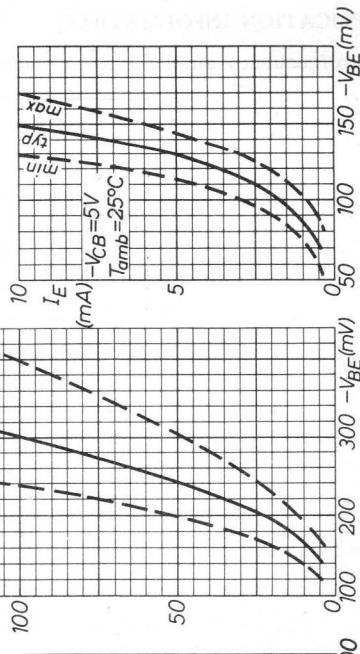
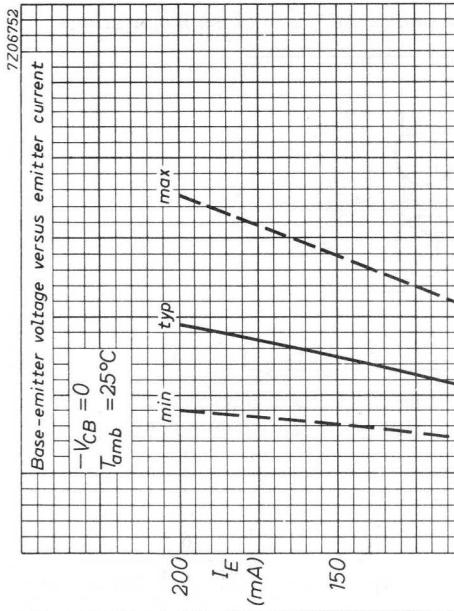
matched pair 2-AC132

$ I_C = 20 \text{ mA}; V_{CB} = 0$	h_{FE1}/h_{FE2}	typ.	1.1
		<	1.25

$ I_C = 200 \text{ mA}; V_{CB} = 0$	h_{FE1}/h_{FE2}	typ.	1.1
		<	1.25

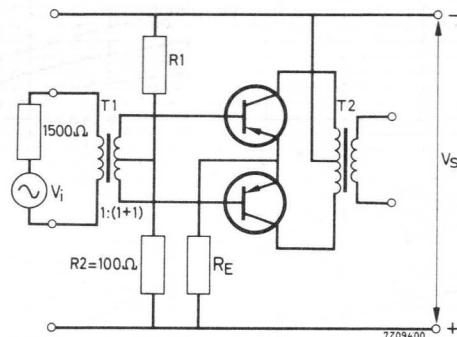






APPLICATION INFORMATION

Audio frequency amplifier with matched pair 2-AC132 in class B operation.



The transistors may be used without cooling fins or heatsinks.

Stable continuous operation is ensured at an ambient temperature of up to 45 °C.

CHARACTERISTICS $T_{amb} = 25 \text{ }^{\circ}\text{C}$

Supply voltage	V_S	=	6	9	V
Emitter current (zero signal)	I_E	=	2×1.5	2×1.5	mA
Bias resistor	R_1	=	5.6	6.8	kΩ
Common emitter resistor	R_E	=	5	14	Ω
Load resistance	$R_{CC\sim}$	=	160	292	Ω
Total power dissipation	P_{tot}	typ.	2×180	2×220	mW
Power delivered to transformer output	P_O	typ.	310	365	mW
Collector current (peak value) at P_O max	$-I_{CM}$	typ.	125	100	mA
Collector current at P_O max	$-I_C$	typ.	40	32	mA
Input voltage at P_O max	V_i	typ.	4	3.8	V
Total harmonic distortion at P_O max	d_{tot}	typ.	7	6	%
Input voltage at $P_O = 50 \text{ mW}$	V_i	typ.	1.40	1.35	V
Total harmonic distortion at $P_O = 50 \text{ mW}$	d_{tot}	typ.	2.5	3.0	%

GERMANIUM ALLOY TRANSISTOR

N-P-N transistor in a TO-1 metal envelope intended for use in low noise pre-amplifiers.

RATINGS Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	32	V
Collector-emitter voltage (open base)	V_{CEO}	max.	12	V
Collector-emitter voltage with $R_{BE} < 70\Omega$	V_{CER}	max.	32	V
Emitter-base voltage (open collector)	V_{EBO}	max.	10	V

Current

Collector current (d.c.)	I_C	max.	10	mA
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Power dissipation

Total power dissipation up to $T_{amb} = 25^\circ C$	P_{tot}	max.	200	mW
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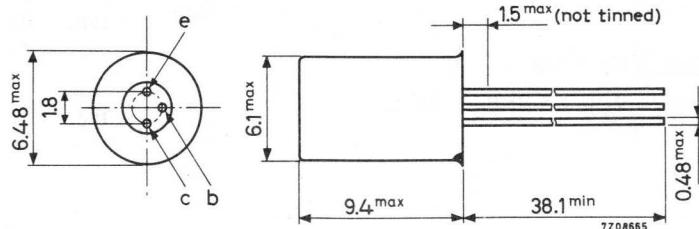
Temperatures

Storage temperature	T_{stg}	-55 to +90	$^\circ C$
Junction temperature: continuous	T_j	max.	90 $^\circ C$
incidentally	T_j	max.	100 $^\circ C$

MECHANICAL DATA

Dimensions in mm

TO-1



The coloured dot indicates the collector
Accessories available: 56200, 56208, 56209, 56210, 56226, 56227

FOR NEW DESIGN THE SUCCESSOR TYPES
BC109 OR BC149 ARE RECOMMENDED

THERMAL RESISTANCE

From junction to ambient in free air

$$R_{th\ j-a} = 0.37 \text{ } ^\circ\text{C/mW}$$

CHARACTERISTICS $T_j = 25 \text{ } ^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; V_{CB} = 10 \text{ V}$

$$I_{CBO} < 10 \mu\text{A}$$

 $I_E = 0; V_{CB} = 32 \text{ V}; T_j = 75 \text{ } ^\circ\text{C}$

$$I_{CBO} < 900 \mu\text{A}$$

Emitter cut-off current $I_C = 0; V_{EB} = 10 \text{ V}$

$$I_{EBO} < 200 \mu\text{A}$$

 $I_C = 0; V_{EB} = 5 \text{ V}; T_j = 75 \text{ } ^\circ\text{C}$

$$I_{EBO} < 550 \mu\text{A}$$

Small signal current gain at $f = 1 \text{ kHz}$ $I_C = 500 \mu\text{A}; V_{CE} = 5 \text{ V}$

$$h_{fe} \text{ typ. } 45 \text{ to } 110$$

Collector capacitance at $f = 0.45 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 5 \text{ V}$

$$C_C \text{ typ. } 70 \text{ pF}$$

Feedback impedance at $f = 0.45 \text{ MHz}$ $I_C = 1 \text{ mA}; V_{CE} = 5 \text{ V}$

$$|z_{rb}| \text{ typ. } 70 \Omega$$

Transition frequency $I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V}$

$$f_T \text{ typ. } 1.5 \text{ MHz}$$

$$\text{typ. } 2.5 \text{ MHz}$$

Cut-off frequency $I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V}$

$$f_{hfe} \text{ typ. } 10 \text{ kHz}$$

$$\text{typ. } 20 \text{ kHz}$$

Noise figure at $f = 1 \text{ kHz}$ $I_C = 0.5 \text{ mA}; V_{CE} = 5 \text{ V}; R_S = 500 \Omega$

$$F \text{ typ. } 3 \text{ dB}$$

Bandwidth = 200 Hz

$$< 4 \text{ dB}$$

GERMANIUM ALLOYED MEDIUM POWER TRANSISTORS

The AC187 is a n-p-n audio transistor in a TO-1 metal envelope.

The AC187 is primarily intended for use together with the p-n-p medium power transistor AC188 as matched pair AC187/AC188 in class B output stages with outputs up to about 3W.

The AC187/01 is electrically equivalent to the AC187, constructed integrally with a heat conducting block, which gives better heat transfer.

The thermal resistance from junction to heatsink shows an improvement ($\approx 10^{\circ}\text{C/W}$) as compared with that of the AC187 with heat conducting clip 56227.

The AC187/01 is also available as matched pair with the AC188/01.

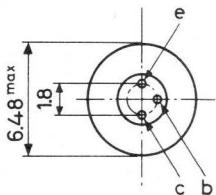
QUICK REFERENCE DATA

Collector-base voltage (open emitter)	V_{CBO}	max.	25	V
Collector-emitter voltage (open base)	V_{CEO}	max.	15	V
Collector current (peak value)	I_{CM}	max.	2	A
Total power dissipation up to $T_{\text{amb}} = 46^{\circ}\text{C}$	P_{tot}	max.	0.8	W
Junction temperature	T_j	max.	90	$^{\circ}\text{C}$
D.C. current gain at $T_j = 25^{\circ}\text{C}$				
$I_C = 300 \text{ mA}; V_{\text{CE}} = 1 \text{ V}$	h_{FE}	100 to 500		
Cut-off frequency				
$I_C = 10 \text{ mA}; V_{\text{CE}} = 2 \text{ V}$	f_{hfe}	typ.	20	kHz

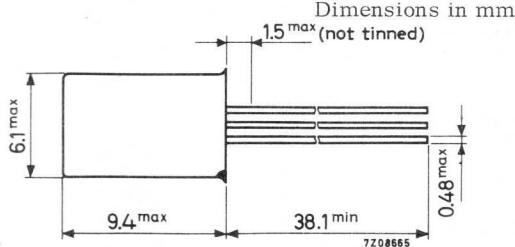
MECHANICAL DATA

AC187

TO-1



The coloured dot indicates the collector

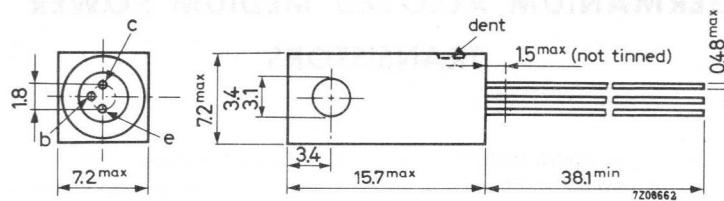


Accessories available: 56200; 56208; 56209; 56210; 56226; 56227

MECHANICAL DATA (continued)

Dimensions in mm

AC187 / 01



The dent indicates the collector

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	25	V
Collector-emitter voltage (open base)	V_{CEO}	max.	15	V
Collector-emitter voltage $I_C \leq 600 \text{ mA}; R_{BE} \leq 1 \Omega$	V_{CER}	max.	18	V
Emitter-base voltage (open collector)	V_{EBO}	max.	10	V

Currents

Collector current (d.c. or average over any 50 ms period)	I_C	max.	1	A
Collector current (peak value)	I_{CM}	max.	2	A

Power dissipation

Total power dissipation up to $T_{amb} = 46^{\circ}\text{C}$	P_{tot}	max.	0.8	W
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Temperatures

Storage temperature	T_{stg}	-55 to +75	$^{\circ}\text{C}$
Junction temperature	T_j	max.	90 $^{\circ}\text{C}$

1) The allowable peak power in class B speech and musical driven amplifiers is 1.1 W

THERMAL RESISTANCE

From junction to ambient in free air

without cooling clip

with cooling clip 56227

with cooling clip 56227 on

1.5mm blackened Al. heatsink of 12.5 cm^2

with cooling clip 56227 on infinite heatsink

AC187

AC187/01

$R_{\text{th j-a}} = 290$ $^{\circ}\text{C/W}$

$R_{\text{th j-a}} = 140$ $^{\circ}\text{C/W}$

70.5 $^{\circ}\text{C/W}$

55 $^{\circ}\text{C/W}$

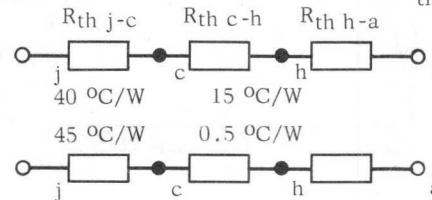
$R_{\text{th j-c}} = 40$ $^{\circ}\text{C/W}$

45 $^{\circ}\text{C/W}$

From junction to case

AC187 with

cooling clip 56227



AC187/01

CHARACTERISTICS

$T_j = 25$ $^{\circ}\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0$; $V_{CB} = 25$ V

I_{CBO} typ. 15 μA
 $<$ 100 μA

$I_E = 0$; $V_{CB} = 25$ V; $T_j = 90$ $^{\circ}\text{C}$

I_{CBO} typ. 2.5 mA

$-V_{BE} = 1.0$ V; $V_{CE} = 25$ V

I_{CEX} typ. 100 μA

Emitter cut-off current

$I_C = 0$; $V_{EB} = 10$ V

I_{EBO} typ. 15 μA
 $<$ 100 μA

$I_C = 0$; $V_{EB} = 10$ V; $T_j = 90$ $^{\circ}\text{C}$

I_{EBO} typ. 1.2 mA
 $<$ 2.5 mA

Base-emitter voltage

$I_C = 5$ mA; $V_{CE} = 10$ V

V_{BE} 95 to 135 mV

$I_C = 300$ mA; $V_{CE} = 1$ V

V_{BE} < 550 mV

Emitter-base floating voltage

$I_E = 0$; $V_{CB} = 25$ V; $T_j = 90$ $^{\circ}\text{C}$

V_{EBfl} < 400 mV

CHARACTERISTICS (continued)

$T_j = 25^\circ\text{C}$ unless otherwise specified

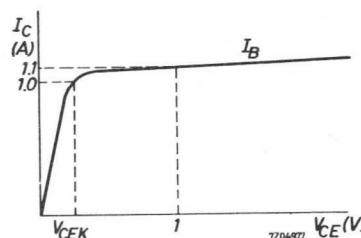
Knee voltage

$I_C = 1 \text{ A}; I_B = \text{value for which}$

$I_C = 1.1 \text{ A at } V_{CE} = 1 \text{ V}$

V_{CEK}

< 800 mV



D.C. current gain

$I_C = 5 \text{ mA}; V_{CE} = 10 \text{ V}$

h_{FE} > 70

$I_C = 300 \text{ mA}; V_{CE} = 1 \text{ V}$

h_{FE} typ. 200
100 to 500

$I_C = 1 \text{ A}; V_{CE} = 1 \text{ V}$

h_{FE} > 50

Collector capacitance at $f = 450 \text{ kHz}$

$I_E = I_e = 0; V_{CB} = 5 \text{ V}$

C_c typ. 150 pF
< 180 pF

Transition frequency

$I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V}$

f_T > 1 MHz
typ. 5 MHz

Cut-off frequency

$I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V}$

f_{hfe} typ. 20 kHz

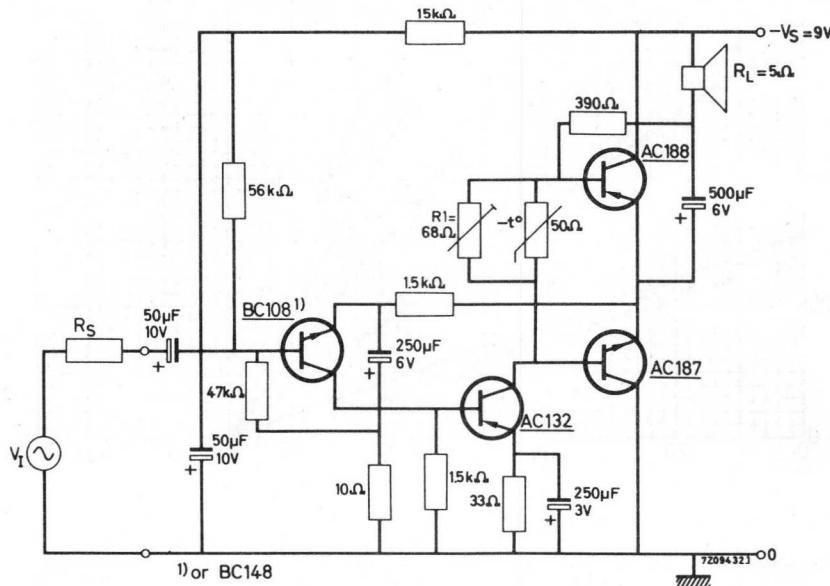
D.C. current gain ratio of
matched pairs/AC187/AC188;
AC187/01/AC188/01

$I_C = 500 \text{ mA}; V_{CE} = 1 \text{ V}$

h_{FE1}/h_{FE2} < 1.25

APPLICATION INFORMATION

1.5 W transformerless audio frequency amplifier with matched pair AC187/AC188 in complementary symmetry class B output stage up to $T_{amb} = 45^{\circ}\text{C}$.



Typical input requirements
for an output power of 50 mW

$$V_i(\text{rms}) = 4 \text{ mV}; I_i(\text{rms}) = 0.12 \mu\text{A}; \\ R_i = 33 \text{ k}\Omega$$

Typical input requirements
for an output power of 1.5 W

$$V_i(\text{rms}) = 22 \text{ mV}; I_i(\text{rms}) = 0.66 \mu\text{A}; \\ R_i = 33 \text{ k}\Omega$$

Typical bandwidth (3 dB); $R_S = 0$

$$B = 60 \text{ Hz to } 65 \text{ kHz}$$

Typical bandwidth (3 dB); $R_S = 50 \text{ k}\Omega$

$$B = 65 \text{ Hz to } 35 \text{ kHz}$$

Quiescent current

$$|I_{CQ}| = 5 \text{ mA, adjustable with } R_i$$

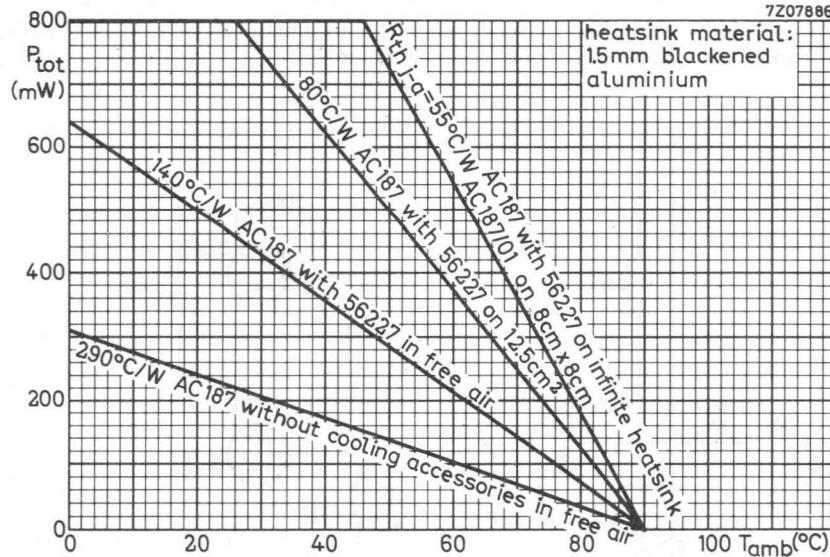
When using AC187 and AC188 each transistor should be mounted with cooling clip 56227 on 1.5 mm blackened Al. heatsink of 3 cm x 3 cm.

When using AC187/01 and AC188/01 each transistor should be mounted on 1.5 mm blackened Al. heatsink of 2.5 cm x 2.5 cm.

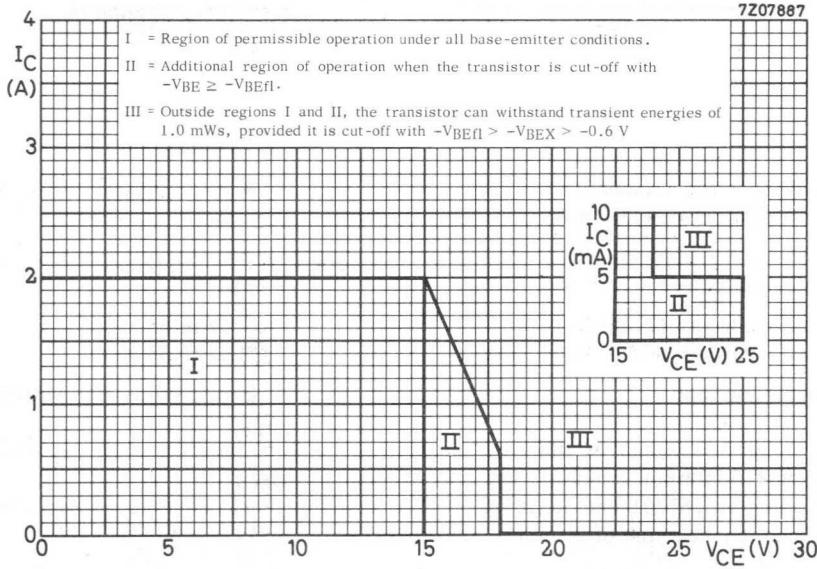
AC187 AC187/01

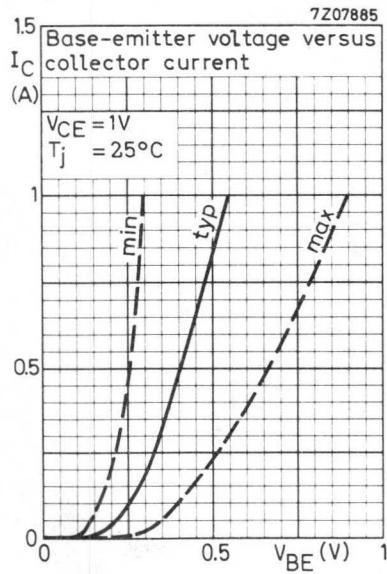
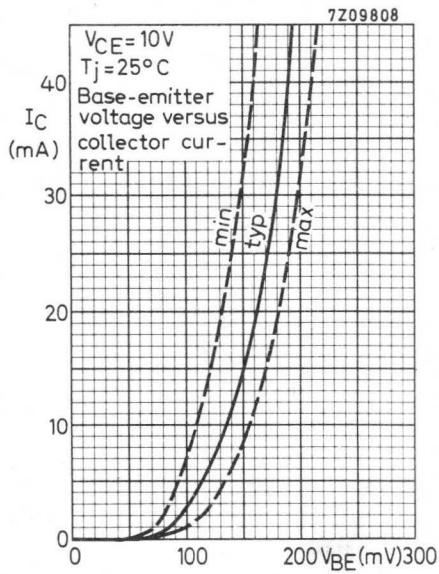
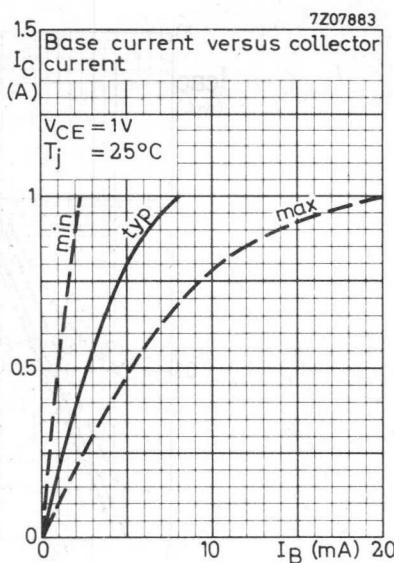
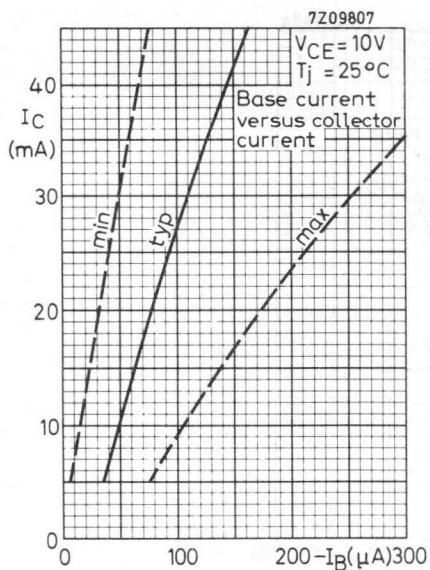
AC187/AC188

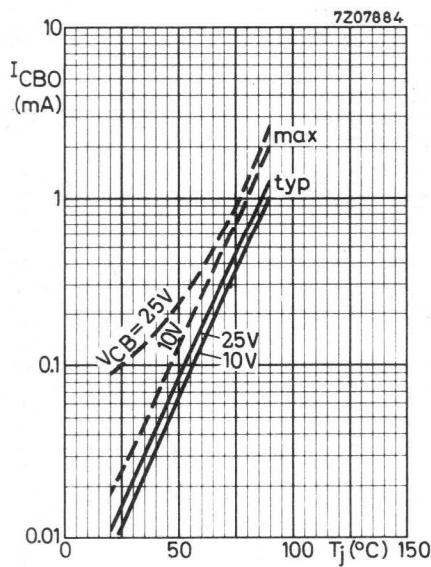
7Z07886



7Z07887







GERMANIUM ALLOYED MEDIUM POWER TRANSISTORS

The AC188 is a p-n-p audio transistor in a TO-1 metal envelope.

The AC188 is primarily intended for use as matched pair 2-AC188 or together with the n-p-n medium power transistor AC187 as matched pair AC187/AC188 in class B output stages with outputs up to about 3 W.

The AC188/01 is electrically equivalent to the AC188, constructed integrally with a heat conducting block, which gives better heat transfer.

The thermal resistance from junction to heatsink shows an improvement ($\approx 10 \text{ }^{\circ}\text{C/W}$) as compared with that of the AC188 with heat conducting clip 56227. The AC188/01 is also available as matched pair with the AC187/01 or as 2-AC188/01.

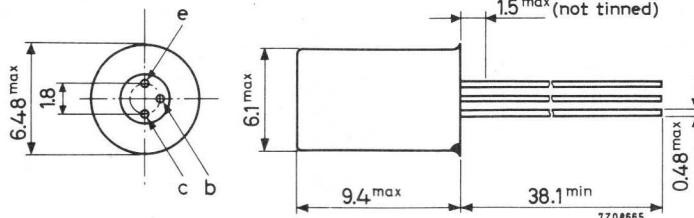
QUICK REFERENCE DATA

Collector-base voltage (open emitter)	$-V_{\text{CBO}}$	max.	25	V
Collector-emitter voltage (open base)	$-V_{\text{CEO}}$	max.	15	V
Collector current (peak value)	$-I_{\text{CM}}$	max.	2	A
Total power dissipation up to $T_{\text{amb}} = 46 \text{ }^{\circ}\text{C}$	P_{tot}	max.	0.8	W
Junction temperature	T_j	max.	90	$\text{ }^{\circ}\text{C}$
D.C. current gain at $T_j = 25 \text{ }^{\circ}\text{C}$				
$-I_C = 300 \text{ mA}; -V_{\text{CE}} = 1 \text{ V}$	h_{FE}		100 to 500	
Cut-off frequency				
$-I_C = 10 \text{ mA}; -V_{\text{CE}} = 2 \text{ V}$	f_{hfe}	typ.	10	kHz

MECHANICAL DATA

AC188

TO-1



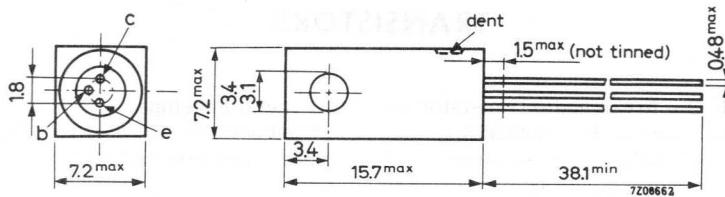
The coloured dot indicates
the collector

Accessories available: 56200; 56208; 56209; 56210; 56226; 56227

MECHANICAL DATA (continued)

Dimensions in mm

AC188/01



The dent indicates the collector

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter)	$-V_{CBO}$	max.	25	V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	15	V
Collector-emitter voltage $-I_C \leq 600 \text{ mA}; R_{BE} \leq 1 \Omega$	$-V_{CER}$	max.	18	V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	10	V

Currents

Collector current (d.c. or average over any 50 ms period)	$-I_C$	max.	1	A
Collector current (peak value)	$-I_{CM}$	max.	2	A

Power dissipation

Total power dissipation up to $T_{amb} = 46^\circ\text{C}$	P_{tot}	max.	0.8	W
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Temperatures

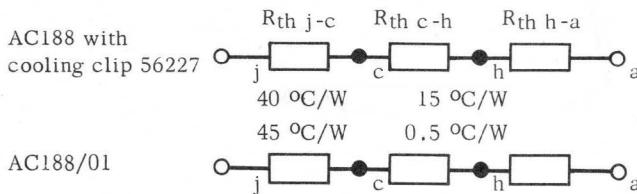
Storage temperature	T_{stg}	-55 to $+75$	$^\circ\text{C}$
Junction temperature	T_j	max.	90 $^\circ\text{C}$

1) The allowable peak power in class B speech and musical driven amplifiers is 1.1 W

THERMAL RESISTANCE

From junction to ambient in free air

	AC188	AC188/01
without cooling clip	$R_{th\ j-a} = 290$	180 °C/W
with cooling clip 56227	$R_{th\ j-a} = 140$	°C/W
with cooling clip 56227 on 1.5 mm Al blackened heatsink of 12.5 cm ²	$R_{th\ j-a} = 80$	70.5 °C/W
with cooling clip 56227 on infinite heatsink	$R_{th\ j-a} = 55$	°C/W
From junction to case	$R_{th\ j-c} = 40$	45 °C/W



CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; -V_{CB} = 25 \text{ V}$	$-I_{CBO}$	typ.	20	μA
$I_E = 0; -V_{CB} = 25 \text{ V}; T_j = 90^\circ\text{C}$	$-I_{CBO}$	<	200	μA
$+V_{BE} = 1.0 \text{ V}; -V_{CE} = 25 \text{ V}$	$-I_{CEX}$	<	1.4	mA

Emitter cut-off current

$I_C = 0; -V_{EB} = 10 \text{ V}$	$-I_{EBO}$	typ.	15	μA
$I_C = 0; -V_{EB} = 10 \text{ V}; T_j = 90^\circ\text{C}$	$-I_{EBO}$	<	200	μA

Base-emitter voltage

$-I_C = 5 \text{ mA}; -V_{CE} = 10 \text{ V}$	$-V_{BE}$	115 to 145	mV
$-I_C = 300 \text{ mA}; -V_{CE} = 1 \text{ V}$	$-V_{BE}$	<	450 mV

Emitter-base floating voltage

$I_E = 0; -V_{CB} = 25 \text{ V}; T_j = 90^\circ\text{C}$	$-V_{EBfl}$	<	400	mV
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CHARACTERISTICS (continued)

$T_j = 25^\circ\text{C}$ unless otherwise specified

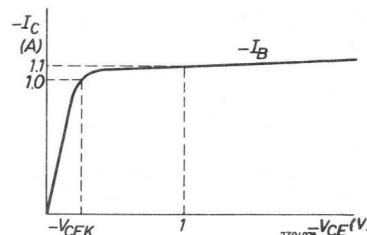
Knee voltage

$-I_C = 1 \text{ A}; -I_B = \text{value for which}$

$-I_C = 1.1 \text{ A at } -V_{CE} = 1 \text{ V}$

$-V_{CEK}$

< 600 mV



D.C. current gain

$-I_C = 5 \text{ mA}; -V_{CE} = 10 \text{ V}$

h_{FE}

> 70

$-I_C = 300 \text{ mA}; -V_{CE} = 1 \text{ V}$

h_{FE}

typ. 200
100 to 500

$-I_C = 1 \text{ A}; -V_{CE} = 1 \text{ V}$

h_{FE}

> 80

Collector capacitance at $f = 450 \text{ kHz}$

$I_E = I_e = 0; -V_{CB} = 5 \text{ V}$

C_c

typ. 90 pF
< 110 pF

Transition frequency

$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$

f_T

> 1 MHz
typ. 1.5 MHz

Cut-off frequency

$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$

f_{hfe}

typ. 10 kHz

D.C. current gain ratio of

matched pairs AC187/AC188; AC187/01/AC188/01

$|I_C| = 500 \text{ mA}; |V_{CE}| = 1 \text{ V}$

h_{FE1}/h_{FE2}

< 1.25

matched pairs 2-AC188; 2-AC188/01

$-I_C = 50 \text{ mA}; -V_{CE} = 1 \text{ V}$

h_{FE1}/h_{FE2}

< 1.25

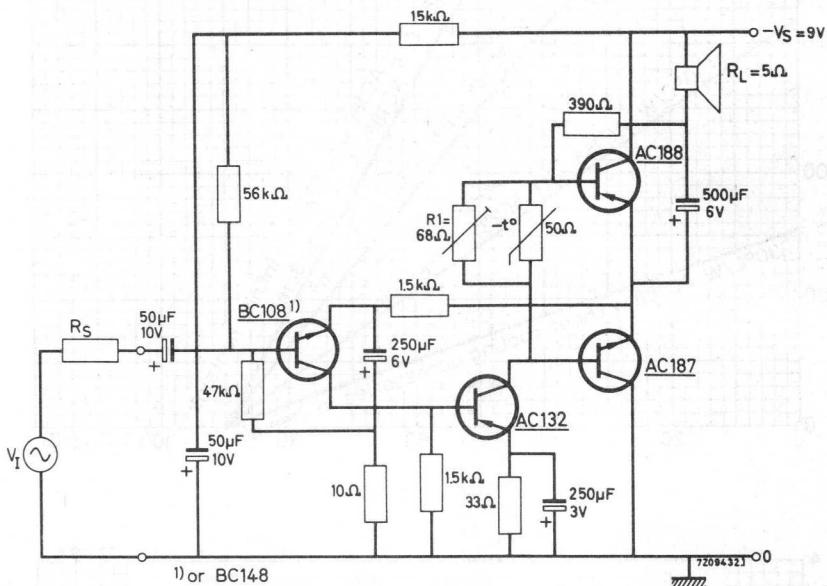
$-I_C = 500 \text{ mA}; -V_{CE} = 1 \text{ V}$

h_{FE1}/h_{FE2}

< 1.25

APPLICATION INFORMATION

1.5 W transformerless audio frequency amplifier with matched pair AC187/AC188 in complementary symmetry class B output stage up to $T_{amb} = 45^{\circ}\text{C}$



Typical input requirements
for an output power of 50 mW

$$V_i(\text{rms}) = 4 \text{ mV}; I_i(\text{rms}) = 0.12 \mu\text{A}; \\ R_i = 33 \text{ k}\Omega$$

Typical input requirements
for an output power of 1.5 W

$$V_i(\text{rms}) = 22 \text{ mV}; I_i(\text{rms}) = 0.66 \mu\text{A}; \\ R_i = 33 \text{ k}\Omega$$

Typical bandwidth (3 dB); $R_S = 0$

$$B = 60 \text{ Hz to } 65 \text{ kHz}$$

Typical bandwidth (3 dB); $R_S = 50 \text{ k}\Omega$

$$B = 65 \text{ Hz to } 35 \text{ kHz}$$

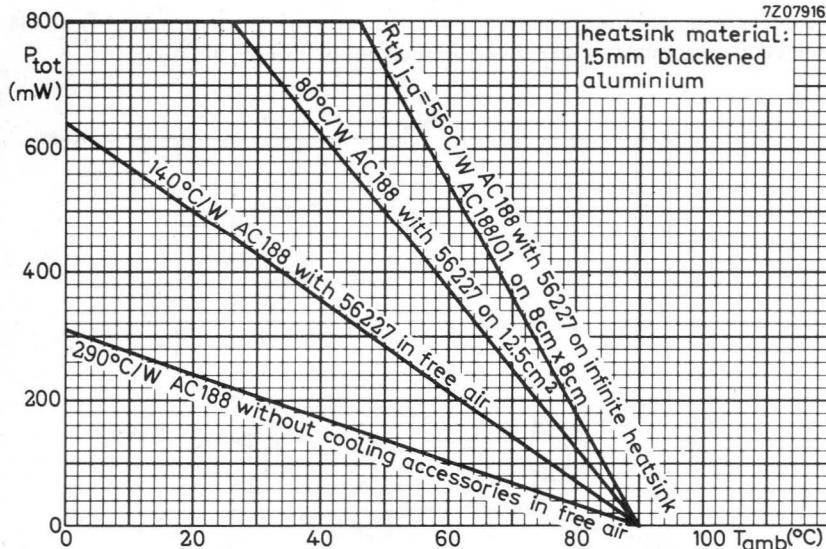
Quiescent current

$$|I_{CQ}| = 5 \text{ mA, adjustable with } R_1$$

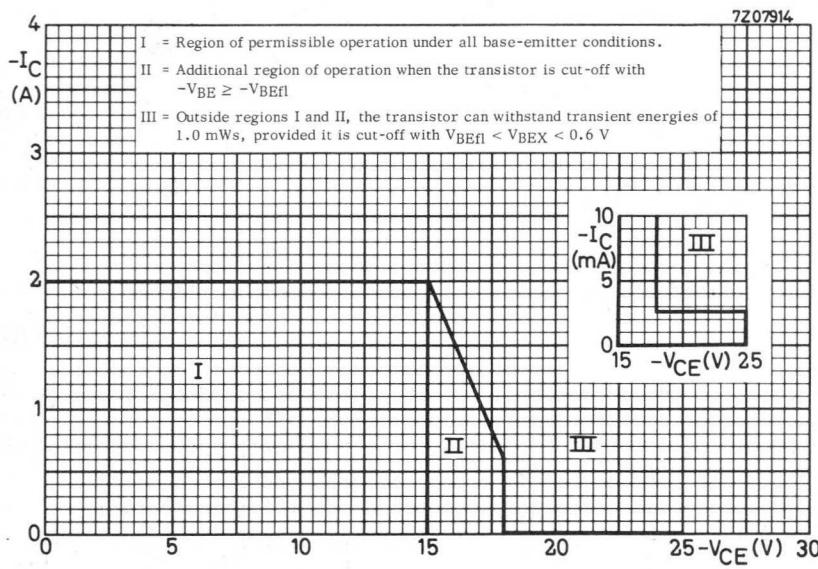
When using AC187 and AC188 each transistor should be mounted with cooling clip 56227 on 1.5 mm blackened Al. heatsink of 3 cm x 3 cm.

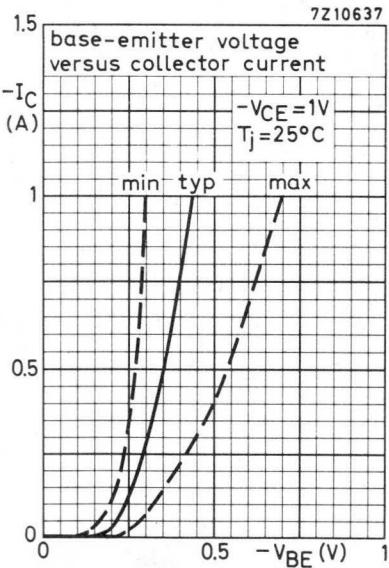
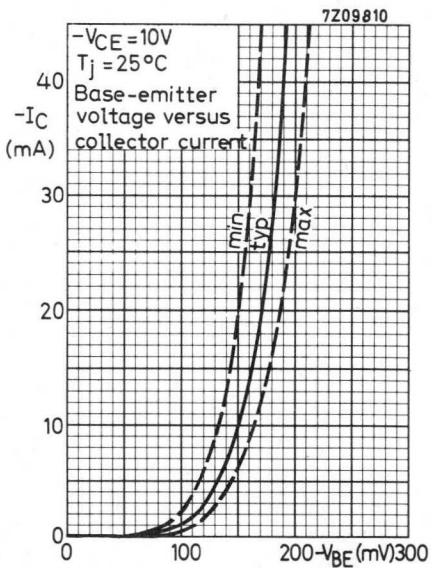
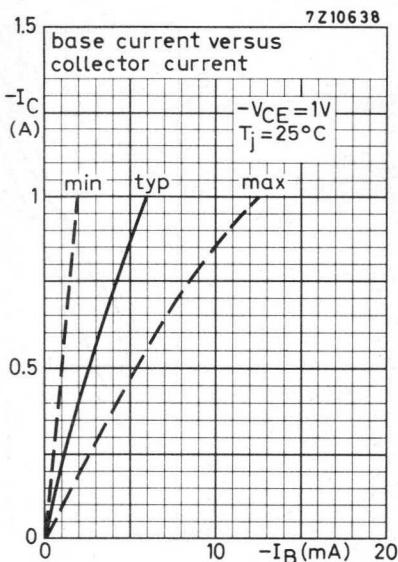
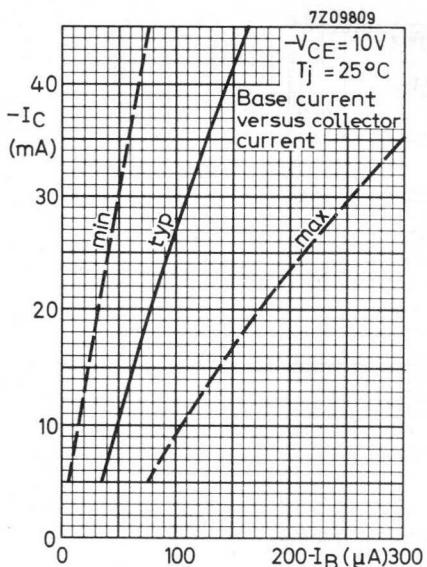
When using AC187/01 and AC188/01 each transistor should be mounted on 1.5 mm blackened Al. heatsink of 2.5 cm x 2.5 cm.

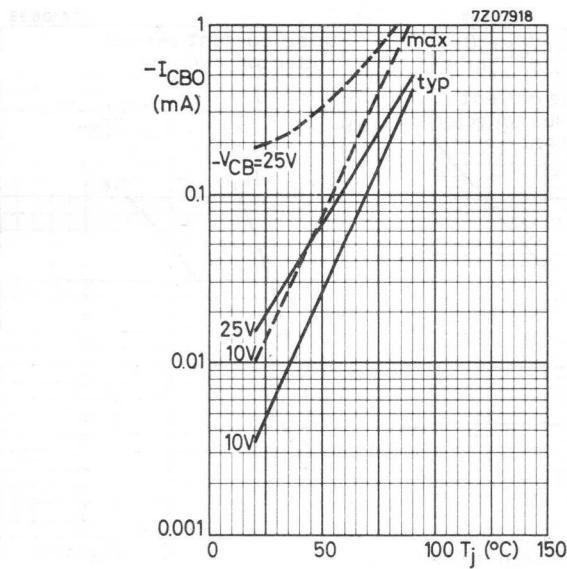
7Z07916



7Z07914







A.F. SILICON PLANAR EPITAXIAL TRANSISTORS

N-P-N transistors in a TO-18 metal envelope with the collector connected to the case; the same transistors are available in lock-fit encapsulation under the type numbers BC147 to BC149.

The BC107 is primarily intended for use in driver stages of audio amplifiers and in signal processing circuits of television receivers.

The BC108 is suitable for a multitude of low voltage applications e.g. driver stages or audio pre-amplifiers and in signal processing circuits of television receivers.

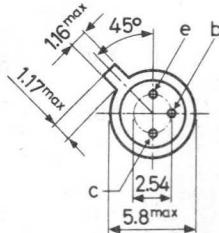
The BC109 is primarily intended for low noise input stages in tape recorders, hi-fi amplifiers and other audio frequency equipment.

QUICK REFERENCE DATA

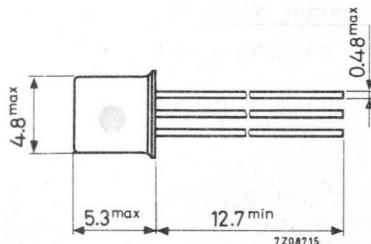
		BC107	BC108	BC109
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	max. 50	30	30 V
Collector-emitter voltage (open base)	V_{CEO}	max. 45	20	20 V
Collector current (peak value)	I_{CM}	max. 200	200	200 mA
Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max. 300	300	300 mW
Junction temperature	T_j	max. 175	175	175 $^\circ\text{C}$
Small signal current gain at $T_j = 25^\circ\text{C}$ $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}; f = 1 \text{ kHz}$	h_{fe}	$>$ 125 $<$ 500	125 900	240 900
Transition frequency at $f = 35 \text{ MHz}$ $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$	f_T	typ. 300	300	300 MHz
Noise figure at $R_S = 2 \text{ k}\Omega$ $I_C = 200 \mu\text{A}; V_{CE} = 5 \text{ V}$ $f = 30 \text{ Hz to } 15 \text{ kHz}$	F	typ. <		1.4 dB 4 dB
$f = 1 \text{ kHz}; B = 200 \text{ Hz}$	F	typ. 2	2	1.2 dB

MECHANICAL DATA

Collector connected
to case
TO-18



Dimensions in mm



Accessories available: 56246; 56263

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

			BC107	BC108	BC109	
Collector-base voltage (open emitter)	V_{CBO}	max.	50	30	30	V
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	max.	50	30	30	V
Collector-emitter voltage (open base)	V_{CEO}	max.	45	20	20	V
Emitter-base voltage (open collector)	V_{EBO}	max.	6	5	5	V

Currents

Collector current (d.c.)	I_C	max.	100	mA
Collector current (peak value)	I_{CM}	max.	200	mA
Emitter current (peak value)	$-I_{EM}$	max.	200	mA
Base current (peak value)	I_{BM}	max.	200	mA

Power dissipation

Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max.	300	mW
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Temperatures

Storage temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Junction temperature	T_j	max.	175 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to ambient in free air	$R_{th j-a}$	=	0.5	$^\circ\text{C}/\text{mW}$
From junction to case	$R_{th j-c}$	=	0.2	$^\circ\text{C}/\text{mW}$

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

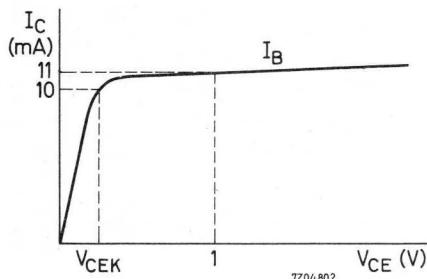
Collector cut-off current

$I_E = 0$; $V_{CB} = 20$ V; $T_j = 150^\circ\text{C}$	I_{CBO}	<	15	μA
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Base-emitter voltage¹⁾

$I_C = 2$ mA; $V_{CE} = 5$ V	V_{BE}	typ. 550 to	620	mV
$I_C = 10$ mA; $V_{CE} = 5$ V	V_{BE}	<	770	mV

¹⁾ V_{BE} decreases by about 2 mV/ $^\circ\text{C}$ with increasing temperature.

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedSaturation voltages¹⁾ $I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$ V_{CEsat} typ. 90 mV
 $< 250 \text{ mV}$ $I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$ V_{BEsat} typ. 700 mV
 V_{CEsat} typ. 200 mV
 $< 600 \text{ mV}$ V_{BEsat} typ. 900 mVKnee voltage $I_C = 10 \text{ mA}; I_B = \text{value for which}$
 $I_C = 11 \text{ mA at } V_{CE} = 1 \text{ V}$ V_{CEK} typ. 300 mV
 $< 600 \text{ mV}$ Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 10 \text{ V}$ C_c typ. 2.5 pF
 $< 4.5 \text{ pF}$ Emitter capacitance at $f = 1 \text{ MHz}$ $I_C = I_e = 0; V_{EB} = 0.5 \text{ V}$ C_e typ. 9 pFTransition frequency at $f = 35 \text{ MHz}$ $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$ f_T typ. 300 MHzSmall signal current gain at $f = 1 \text{ kHz}$ $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$

		BC107	BC108	BC109
h_{fe}	>	125	125	240
	<	500	900	900

Noise figure at $R_S = 2 \text{ k}\Omega$ $I_C = 200 \mu\text{A}; V_{CE} = 5 \text{ V}$

$f = 30 \text{ Hz to } 15 \text{ kHz}$	F	typ.	1.4 dB
		<	4 dB

 $f = 1 \text{ kHz}; B = 200 \text{ Hz}$

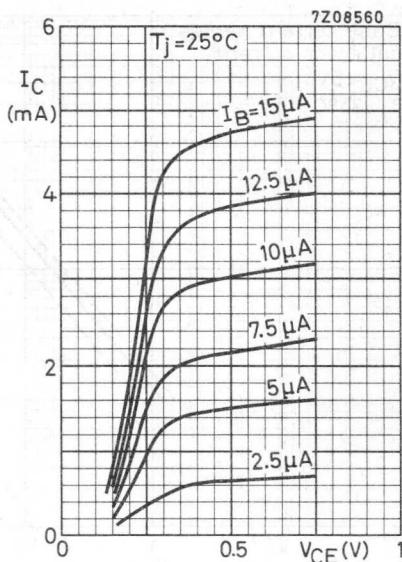
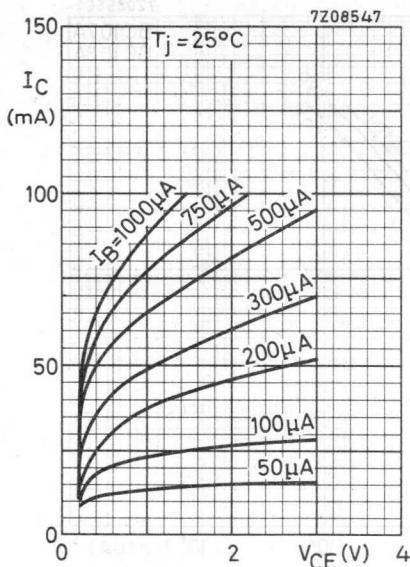
$f = 1 \text{ kHz}; B = 200 \text{ Hz}$	F	typ.	2	2	1.2 dB
		<	10	10	4 dB

¹⁾ V_{BEsat} decreases by about 1.7 mV/ $^\circ\text{C}$ with increasing temperature.

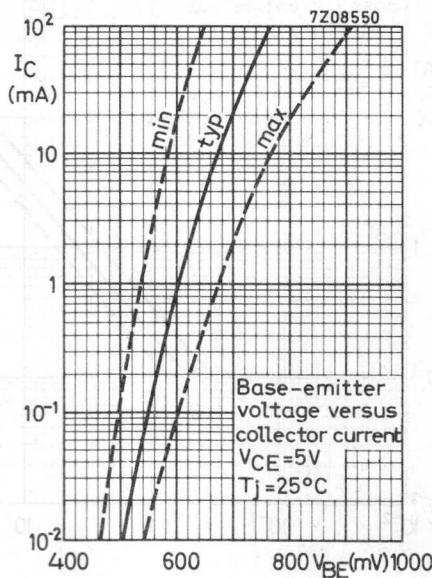
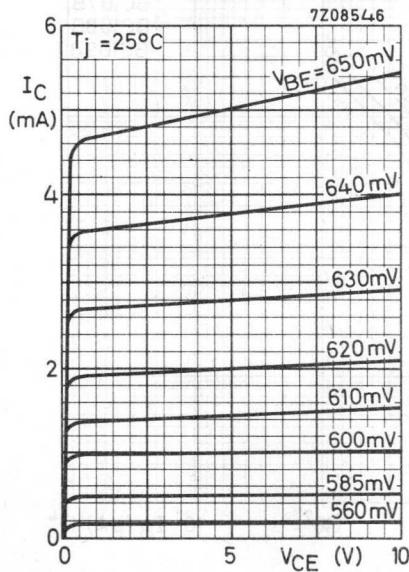
CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specified

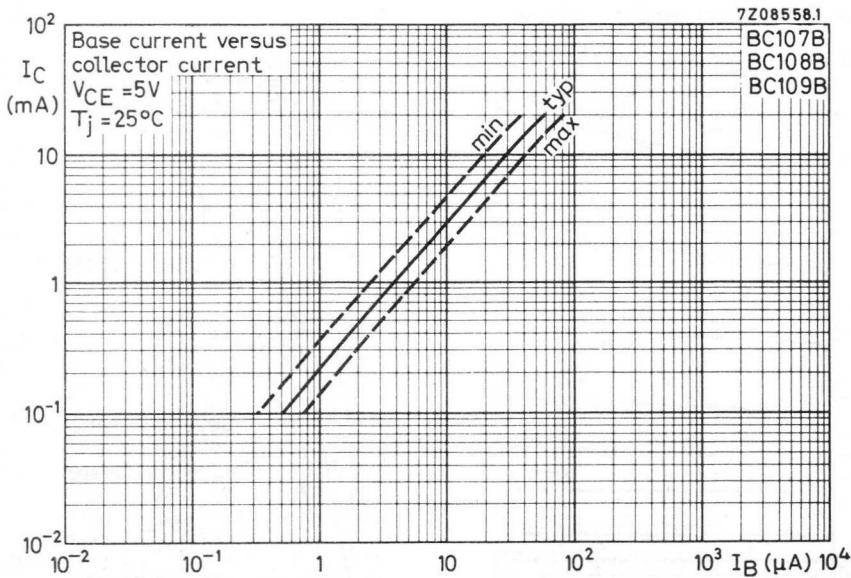
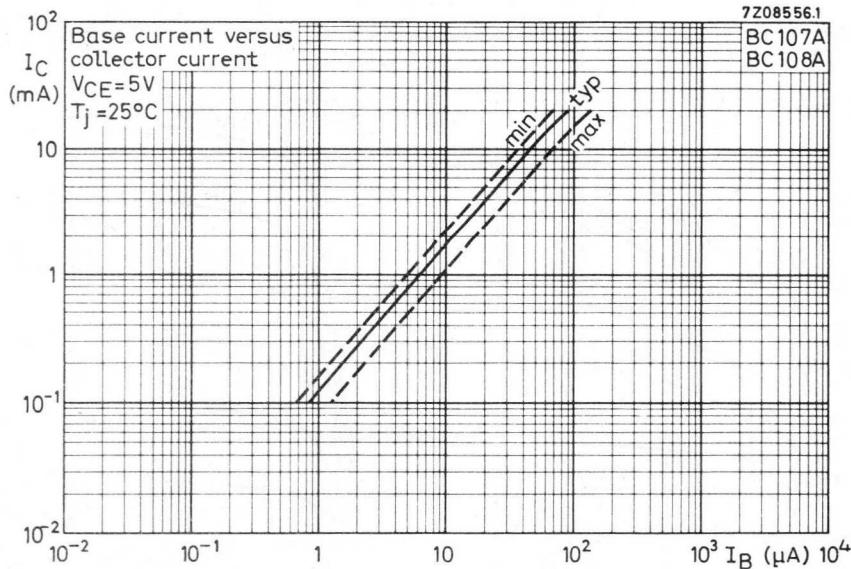
			BC107A	BC107B	BC108C
			BC108A	BC108B	BC109C
			BC109B		
<u>D.C. current gain</u>					
$I_C = 10 \mu\text{A}; V_{CE} = 5 \text{ V}$	h_{FE}	> typ.	40 150	100 270	
$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	h_{FE}	> typ. <	110 180 220	200 290 450	420 520 800
<u>h parameters at $f = 1 \text{ kHz}$ (common emitter)</u>					
$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$		>	1.6	3.2	6 $\text{k}\Omega$
Input impedance	h_{ie}	typ. <	2.7 4.5	4.5 8.5	8.7 $\text{k}\Omega$ 15 $\text{k}\Omega$
Reverse voltage transfer ratio	h_{re}	typ.	1.5	2	3 10^{-4}
Small signal current gain	h_{fe}	> typ. <	125 220 260	240 330 500	450 600 900
Output admittance	h_{oe}	typ. <	18 30	30 60	60 $\mu\Omega^{-1}$ 110 $\mu\Omega^{-1}$

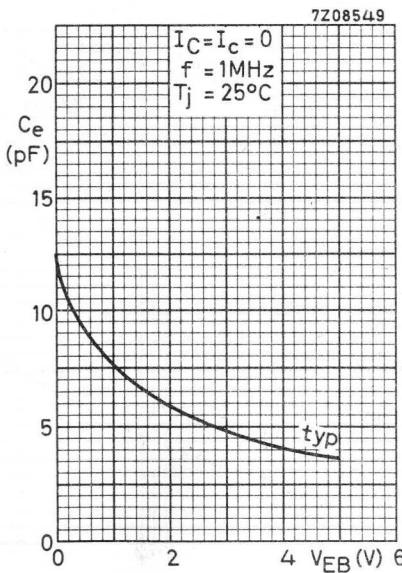
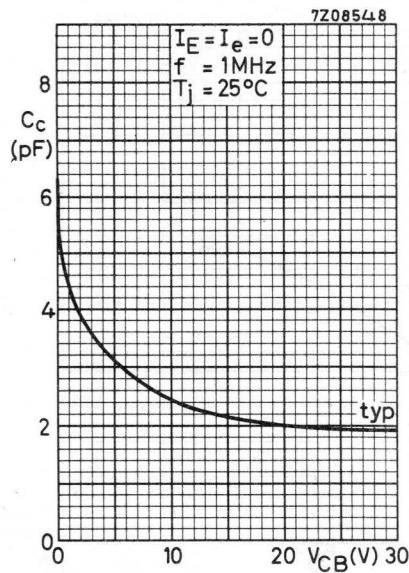
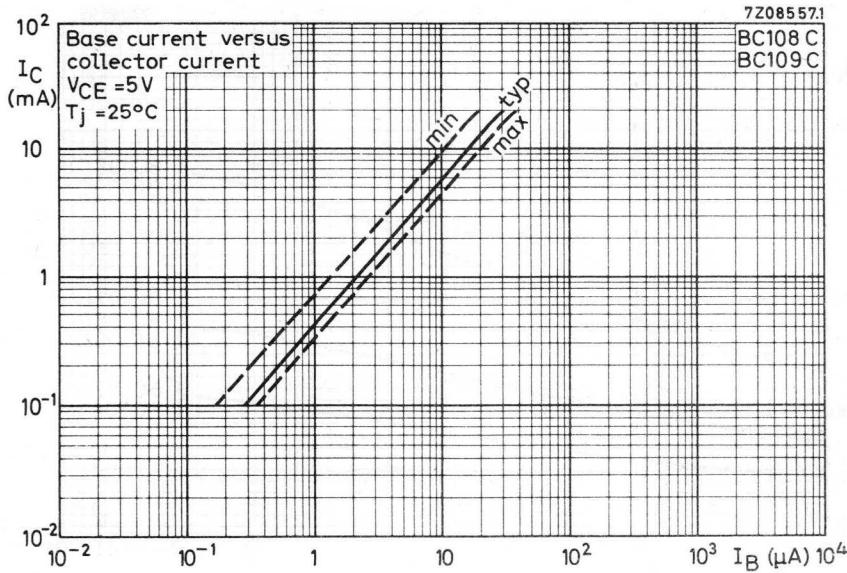
Typical behaviour of collector current versus collector-emitter voltage

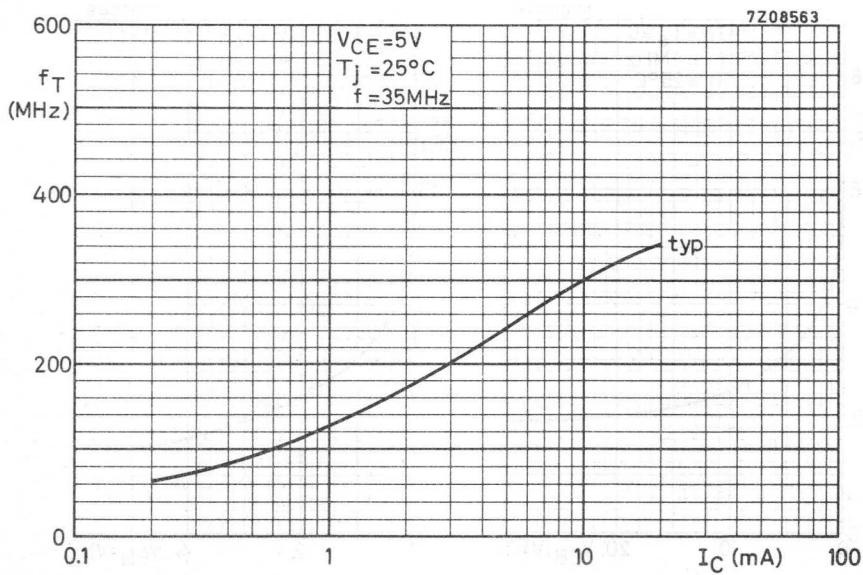
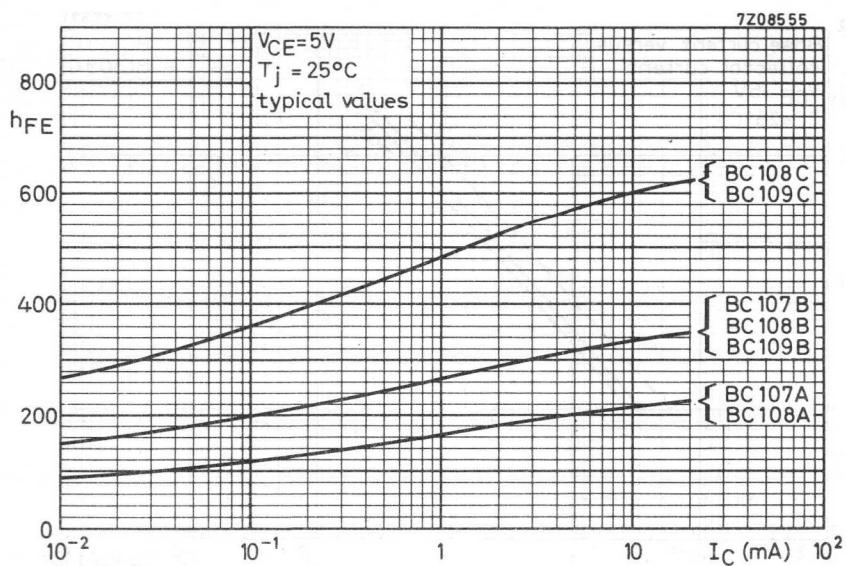


Typical behaviour of collector current versus collector-emitter voltage

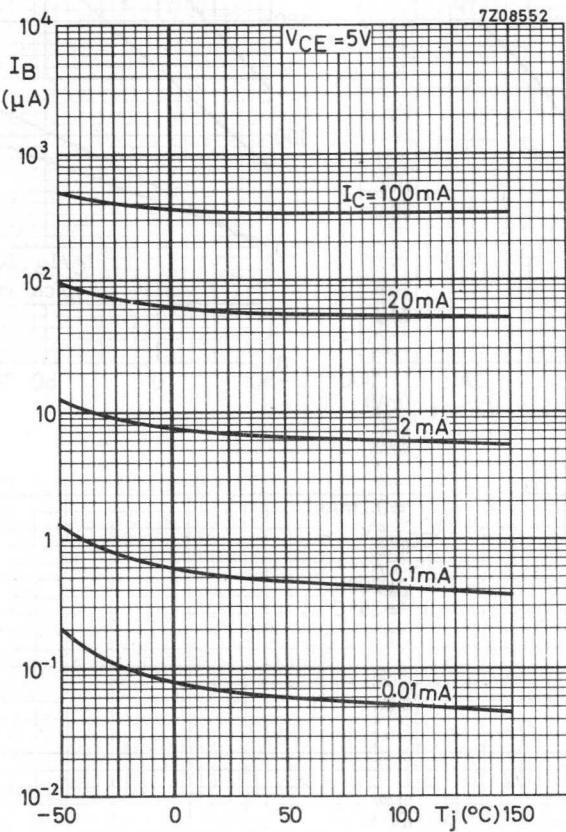




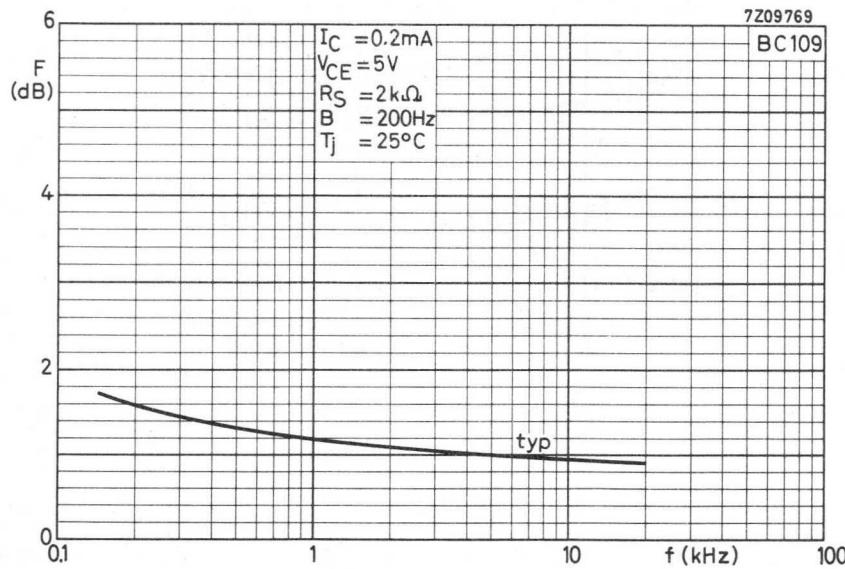
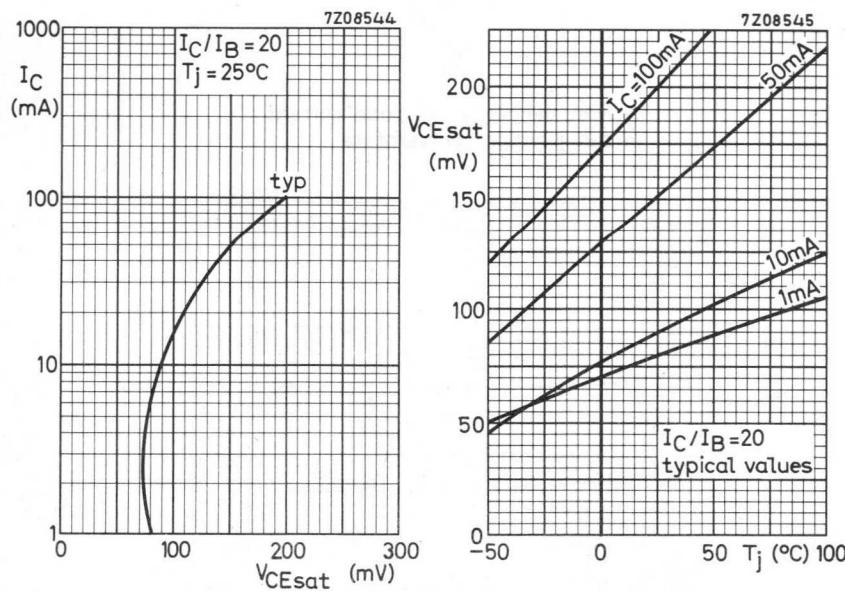




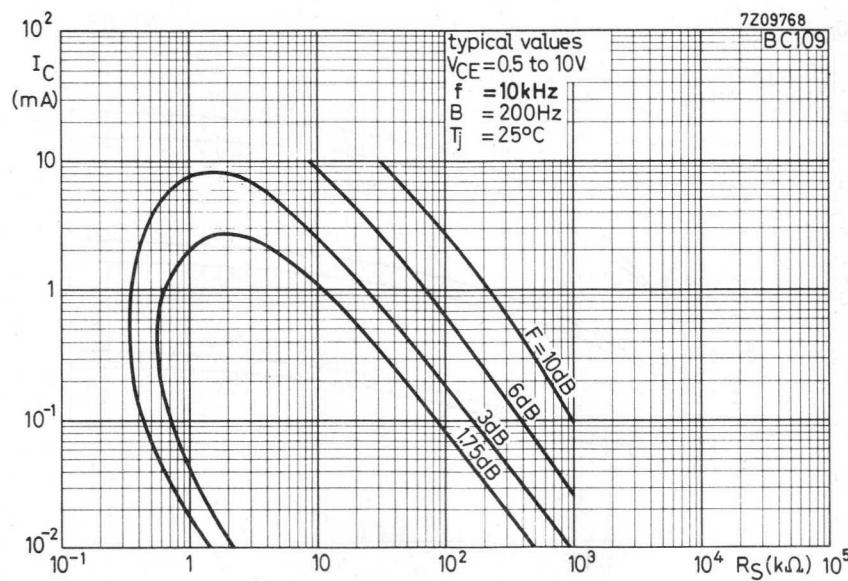
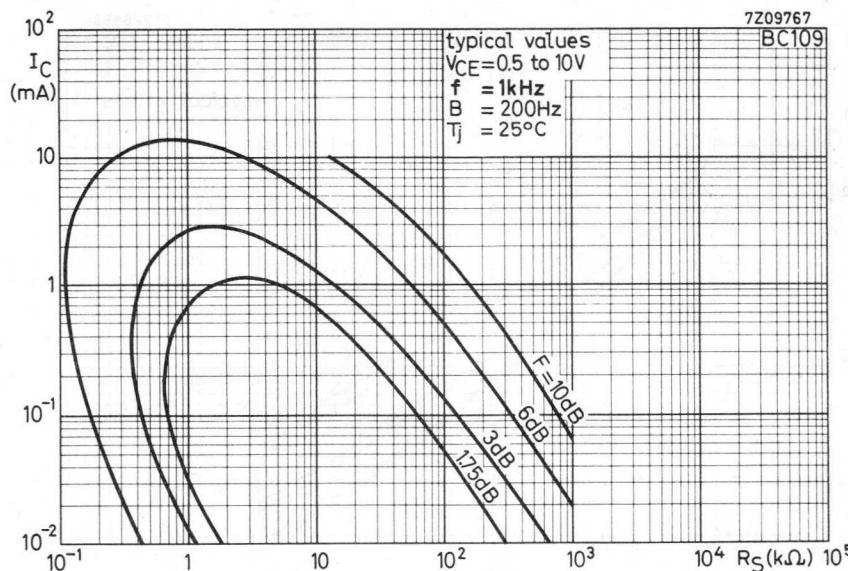
Typical behaviour of base current
versus junction temperature



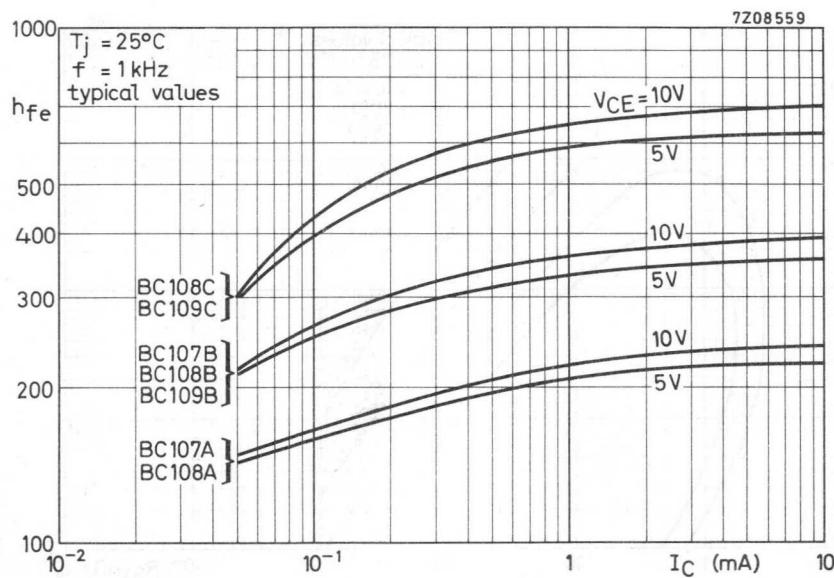
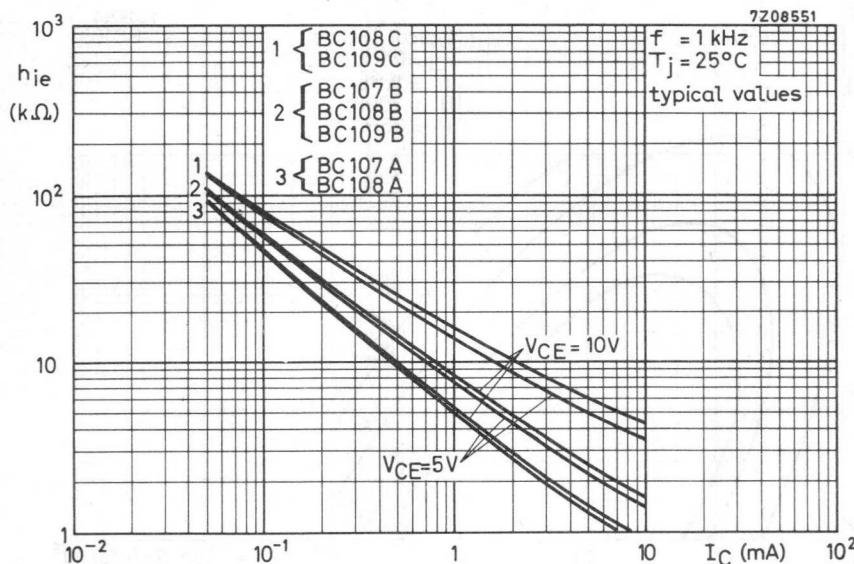
BC107 to 109

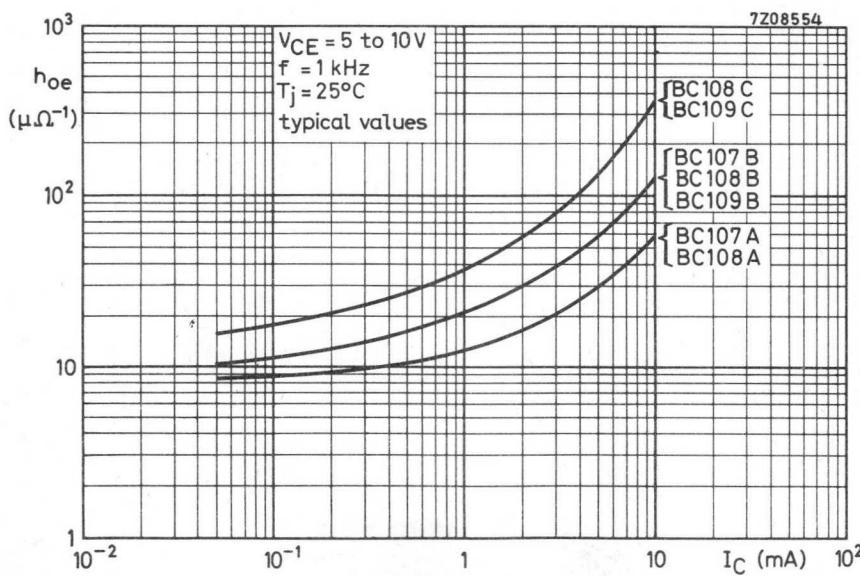
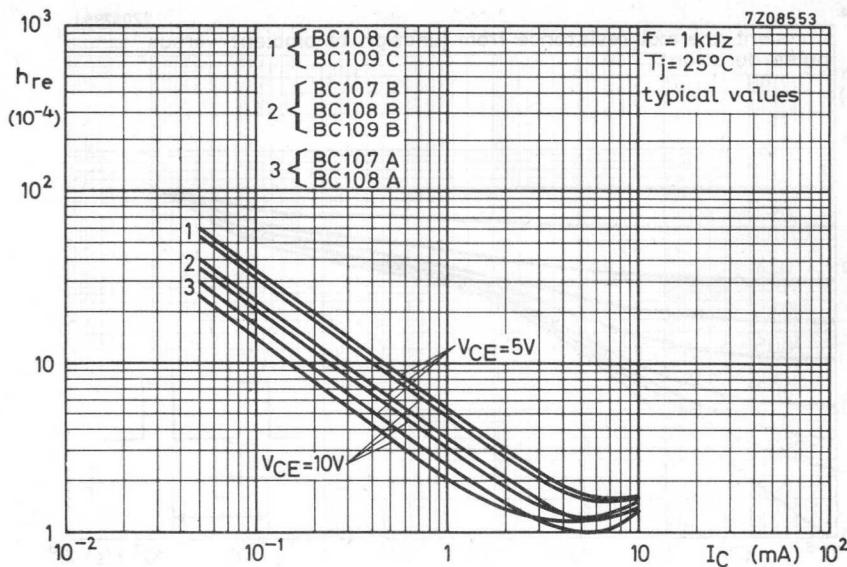


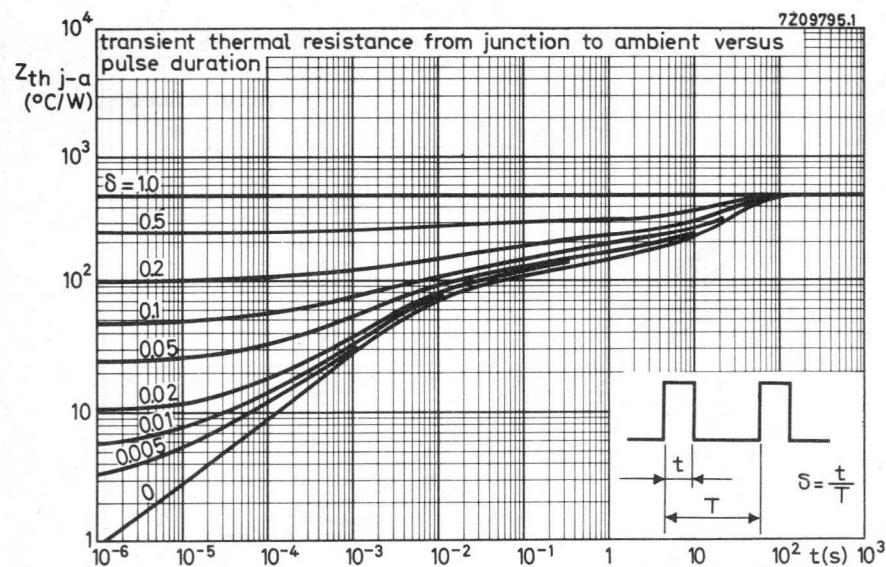
Curves of constant noise figure



BC107 to 109





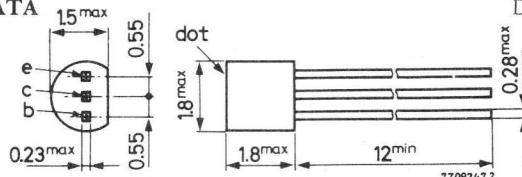


SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a microminiature plastic envelope. The BC146 is designed for hearing aids, watches and other equipment where small size is of paramount importance.

QUICK REFERENCE DATA					
		red	yellow	green	
Collector-base voltage (open emitter)	V _{CBO} max.	20	20	20	V
Collector-emitter voltage (open base)	V _{CCEO} max.	20	20	20	V
Collector current (d.c.)	I _C max.	50	50	50	mA
Total power dissipation up to T _{amb} = 45 °C	P _{tot} max.	50	50	50	mW
Junction temperature	T _j max.	125	125	125	°C
D.C. current gain I _C = 0.2 mA; V _{CE} = 0.5 V	h _{FE}	> 80 < 200	140 350	280 550	
Noise figure at R _S = 2 kΩ I _C = 0.2 mA; V _{CE} = 5 V Bandwidth: f = 30 Hz to 15 kHz	F typ.	2	1.5	2	dB
	F <	-	4	-	dB

MECHANICAL DATA



Dimensions in mm

MOUNTING INSTRUCTIONS

To avoid damaging the transistor, welded or soldered connections must be made with care; the following general recommendations should be observed:

1. The temperature of the soldering iron must be less than 250 °C and the soldering time less than 3 seconds at a lead length of not less than 1.5 mm.
2. To keep the heat capacity low, the smallest possible amount of solder should be used.
3. If the plastic capsule of the transistor makes contact with any other structure, care must be taken that its temperature never exceeds 125 °C.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	20	V
Collector-emitter voltage (open base)	V_{CEO}	max.	20	V
Emitter-base voltage (open collector)	V_{EBO}	max.	4	V

Currents

Collector current (d.c.)	I_C	max.	50	mA
Collector current (peak value)	I_{CM}	max.	50	mA

Power dissipation

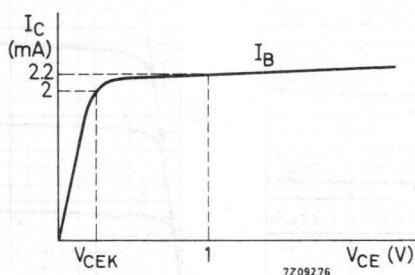
Total power dissipation up to $T_{amb} = 45^\circ\text{C}$	P_{tot}	max.	50	mW
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Temperatures

→ Storage temperature	T_{stg}	-65 to +125	$^\circ\text{C}$
Junction temperature	T_j	max.	125 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to ambient in free air	$R_{th \ j-a}$	=	1.6	$^\circ\text{C}/\text{mW}$
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CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedBase-emitter voltage $I_C = 0.2 \text{ mA}; V_{CE} = 0.5 \text{ V}$ V_{BE} typ. 570 mV $I_C = 2 \text{ mA}; V_{CE} = 1 \text{ V}$ V_{BE} typ. 630 mVKnee voltage $I_C = 2 \text{ mA}; I_B = \text{value for which}$
 $I_C = 2.2 \text{ mA at } V_{CE} = 1 \text{ V}$ V_{CEK} typ. 180 mVCollector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 5 \text{ V}$ C_c typ. 4 pFTransition frequency $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$ f_T typ. 150 MHzD.C. current gain $I_C = 0.2 \text{ mA}; V_{CE} = 0.5 \text{ V}$

	red	yellow	green
h_{FE} typ.	115	220	380
h_{FE} 80 to 200	140 to 350	280 to 550	

 $I_C = 2 \text{ mA}; V_{CE} = 1 \text{ V}$

h_{FE}	>	100	140	280

Noise figure $I_C = 0.2 \text{ mA}; V_{CE} = 5 \text{ V};$

	red	yellow	green
h_{FE} typ.	115	220	380
h_{FE} 80 to 200	140 to 350	280 to 550	

 $R_S = 2 \text{ k}\Omega$

	red	yellow	green
h_{FE} typ.	115	220	380
h_{FE} 80 to 200	140 to 350	280 to 550	

Bandwidth: $f = 30 \text{ Hz to } 15 \text{ kHz}$

	red	yellow	green
h_{FE} typ.	115	220	380
h_{FE} 80 to 200	140 to 350	280 to 550	

 h parameters at $f = 1 \text{ kHz}$ $I_C = 0.2 \text{ mA}; V_{CE} = 0.5 \text{ V}$

	red	yellow	green
h_{ie} typ.	20	30	45
h_{re} typ.	15	25	40
h_{fe} typ.	130	220	380
h_{oe} typ.	15	20	35

Input impedance

	red	yellow	green
h_{ie} typ.	20	30	45
h_{re} typ.	15	25	40
h_{fe} typ.	130	220	380
h_{oe} typ.	15	20	35

Reverse voltage transfer ratio

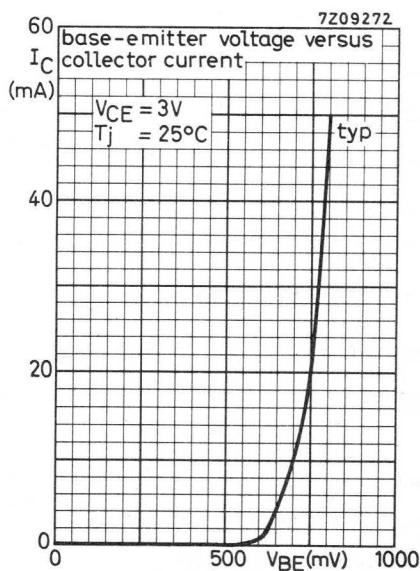
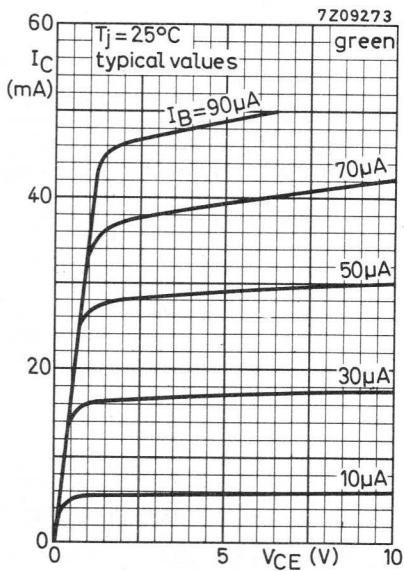
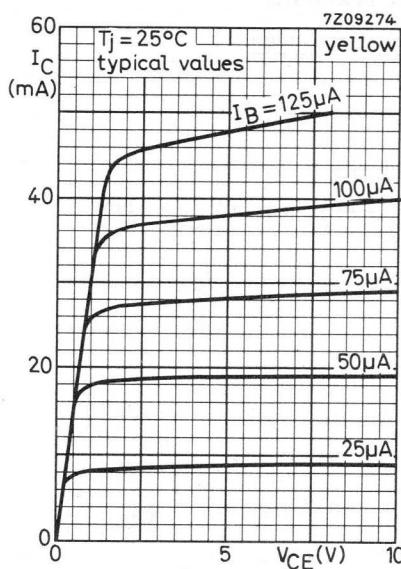
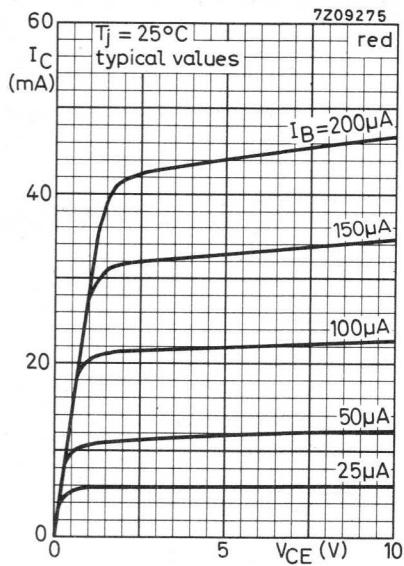
	red	yellow	green
h_{re} typ.	15	25	40
h_{fe} typ.	130	220	380
h_{oe} typ.	15	20	35

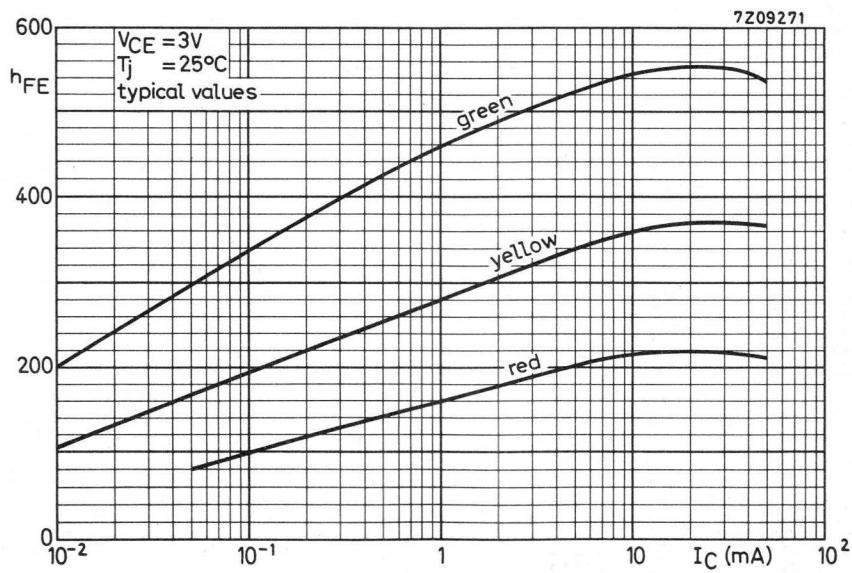
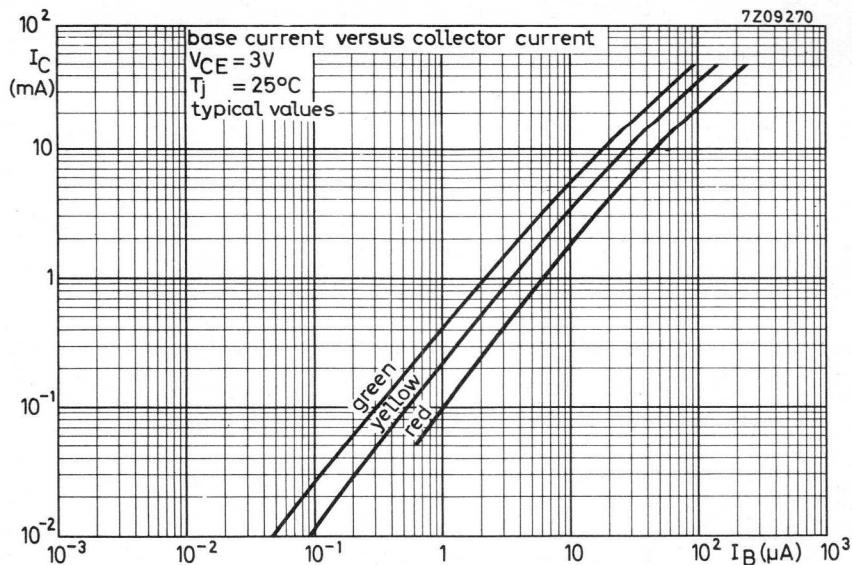
Small signal current gain

	red	yellow	green
h_{fe} typ.	130	220	380
h_{oe} typ.	15	20	35

Output admittance

	red	yellow	green
h_{oe} typ.	15	20	35





A.F. SILICON PLANAR EPITAXIAL TRANSISTORS

N-P-N transistors in a plastic envelope with stiff, self-locking pins suitable for use with standard printed boards.

The BC147 is primarily intended for use in driver stages of audio amplifiers and in signal processing circuits of television receivers.

The BC148 is suitable for a multitude of low voltage applications e.g. driver stages or audio pre-amplifiers and in signal processing circuits of television receivers.

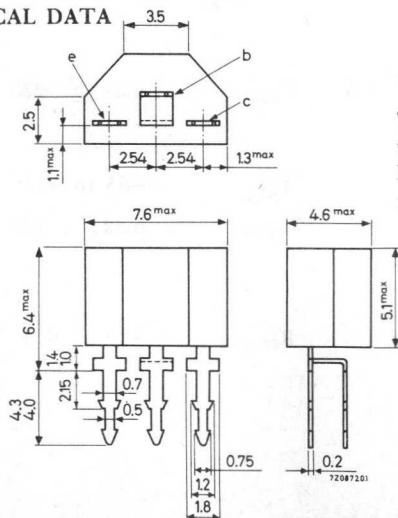
The BC149 is primarily intended for low noise input stages in tape recorders, hi-fi amplifiers and other audio frequency equipment.

QUICK REFERENCE DATA

		BC147	BC148	BC149
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	max. 50	30	30 V
Collector-emitter voltage (open base)	V_{CEO}	max. 45	20	20 V
Collector current (peak value)	I_{CM}	max. 200	200	200 mA
Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max. 250	250	250 mW
Junction temperature	T_j	max. 125	125	125 $^\circ\text{C}$
Small signal current gain at $T_j = 25^\circ\text{C}$ $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}; f = 1 \text{ kHz}$	h_{fe}	> 125 < 500	125 900	240 900
Transition frequency at $f = 35 \text{ MHz}$ $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$	f_T	typ. 300	300	300 MHz
Noise figure at $R_S = 2 \text{ k}\Omega$ $I_C = 200 \mu\text{A}; V_{CE} = 5 \text{ V}$	F	typ. <		1.4 dB 4 dB
$f = 30 \text{ Hz to } 15 \text{ kHz}$	F	typ. 2	2	1.2 dB
$f = 1 \text{ kHz}; B = 200 \text{ Hz}$				

MECHANICAL DATA

Dimensions in mm



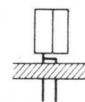
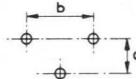
The envelope fulfils the accelerated damp heat test described in IEC publication 68-2 (test D, severity IV, 6 cycles)

MOUNTING INSTRUCTIONS

1. Thickness of printed board: max. 1.1 mm
Hole diameter 0.77 to 0.83 mm



2. Thickness of printed board: max. 1.7 mm
Hole diameter 1.25 to 1.35 mm

Bore plan

a = 2.49 to 2.59 mm

b = 5.03 to 5.13 mm

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)Voltages

		BC147	BC148	BC149
Collector-base voltage (open emitter)	V _{CBO}	max. 50	30	30 V
Collector-emitter voltage ($V_{BE} = 0$)	V _{CES}	max. 50	30	30 V
Collector-emitter voltage (open base)	V _{CEO}	max. 45	20	20 V
Emitter-base voltage (open collector)	V _{EBO}	max. 6	5	5 V

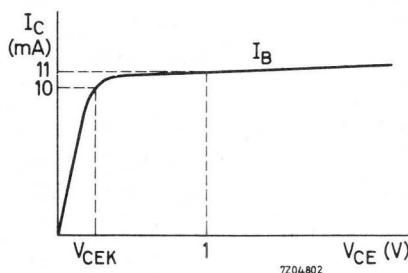
Currents

Collector current (d.c.)	I _C	max. 100	mA
Collector current (peak value)	I _{CM}	max. 200	mA
Emitter current (peak value)	-I _{EM}	max. 200	mA
Base current (peak value)	I _{BM}	max. 200	mA

Power dissipationTotal power dissipation up to $T_{amb} = 25^{\circ}\text{C}$ P_{tot} max. 250 mWTemperatures

Storage temperature	T _{stg}	-65 to +125	°C
Junction temperature	T _j	max. 125	°C

THERMAL RESISTANCEFrom junction to ambient in free air R_{th j-a} = 0.4 °C/mW

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; V_{CB} = 20 \text{ V}; T_j = 125^\circ\text{C}$ $I_{CBO} < 5 \mu\text{A}$ Base-emitter voltage¹⁾ $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$ V_{BE} typ. 620 mV
550 to 700 mV $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$ V_{BE} < 770 mVSaturation voltages²⁾ $I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$ V_{CEsat} typ. 90 mV
< 250 mV V_{BESat} typ. 700 mV $I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$ V_{CEsat} typ. 200 mV
< 600 mV V_{BESat} typ. 900 mVKnee voltage $I_C = 10 \text{ mA}; I_B = \text{value for which}$ V_{CEK} typ. 300 mV
< 600 mV $I_C = 11 \text{ mA at } V_{CE} = 1 \text{ V}$ Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 10 \text{ V}$ C_C typ. 2.5 pF
< 4.5 pFEmitter capacitance at $f = 1 \text{ MHz}$ $I_C = I_e = 0; V_{EB} = 0.5 \text{ V}$ C_e typ. 9 pFTransition frequency at $f = 35 \text{ MHz}$ $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$ f_T typ. 300 MHz1) V_{BE} decreases by about 2 mV/ $^\circ\text{C}$ with increasing temperature.2) V_{BESat} decreases by about 1.7 mV/ $^\circ\text{C}$ with increasing temperature.

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedSmall signal current gain at $f = 1 \text{ kHz}$ $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$

			BC147	BC148	BC149
	h_{fe}	>	125	125	240
		<	500	900	900

Noise figure at $R_S = 2 \text{ k}\Omega$ $I_C = 200 \mu\text{A}; V_{CE} = 5 \text{ V}$ $f = 30 \text{ Hz to } 15 \text{ kHz}$

F	typ.			1.4 dB
	<			4 dB
F	typ.	2	2	1.2 dB
	<	10	10	4 dB

D.C. current gain $I_C = 10 \mu\text{A}; V_{CE} = 5 \text{ V}$

		BC147A	BC147B	BC148C
		BC148A	BC148B	BC149C
	h_{FE}	typ. 90	150	270
		> 110	200	420

 $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$

h_{FE}	typ. 180	290	520
	< 220	450	800

h parameters at $f = 1 \text{ kHz}$ (common emitter) $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$

Input impedance

h_{ie}	typ. 1.6	3.2	6 $\text{k}\Omega$
	typ. 2.7	4.5	8.7 $\text{k}\Omega$
	< 4.5	8.5	15 $\text{k}\Omega$

Reverse voltage transfer ratio

h_{re}	typ. 1.5	2	$3 \cdot 10^{-4}$
	> 125	240	450

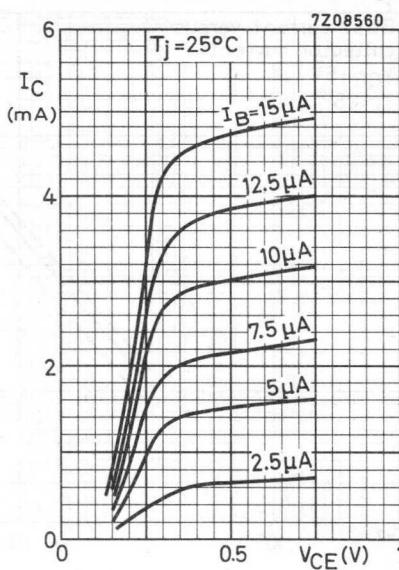
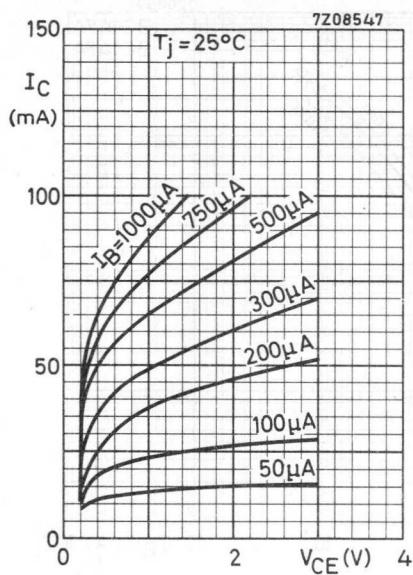
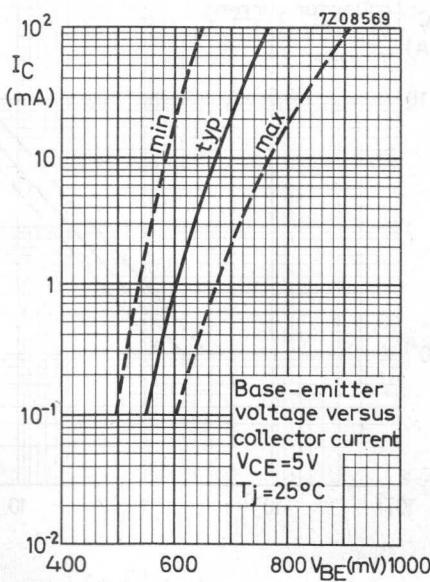
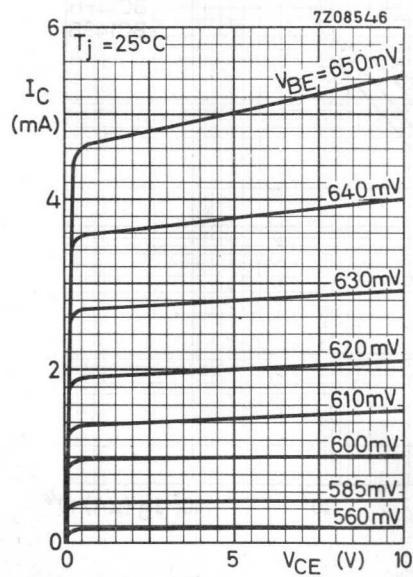
Small signal current gain

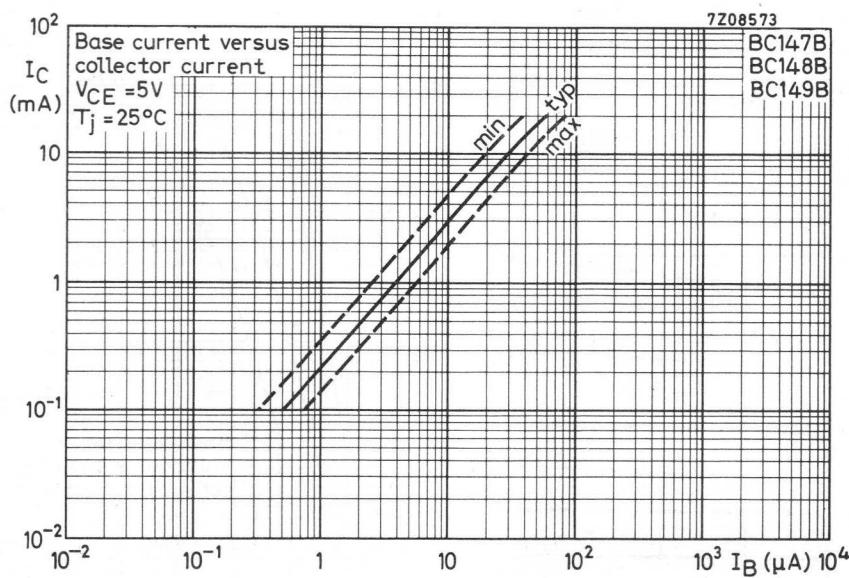
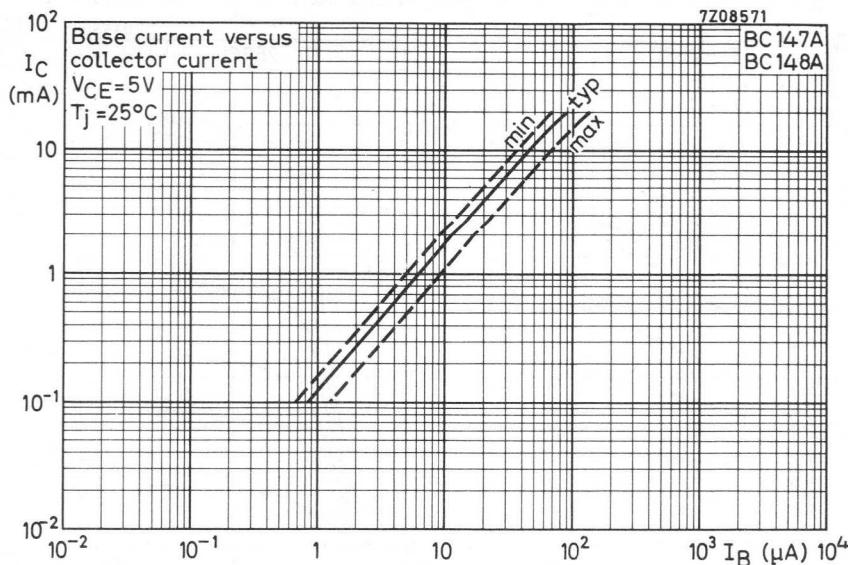
h_{fe}	typ. 220	330	600
	< 260	500	900

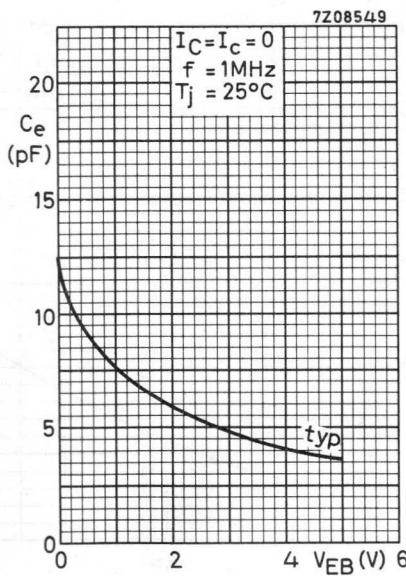
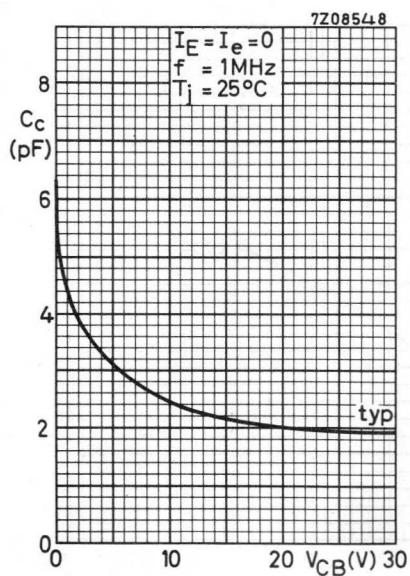
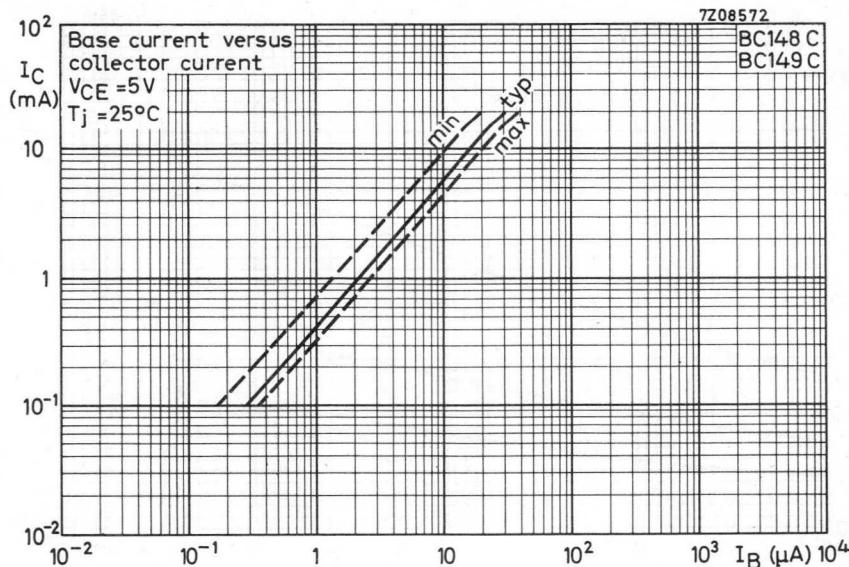
Output admittance

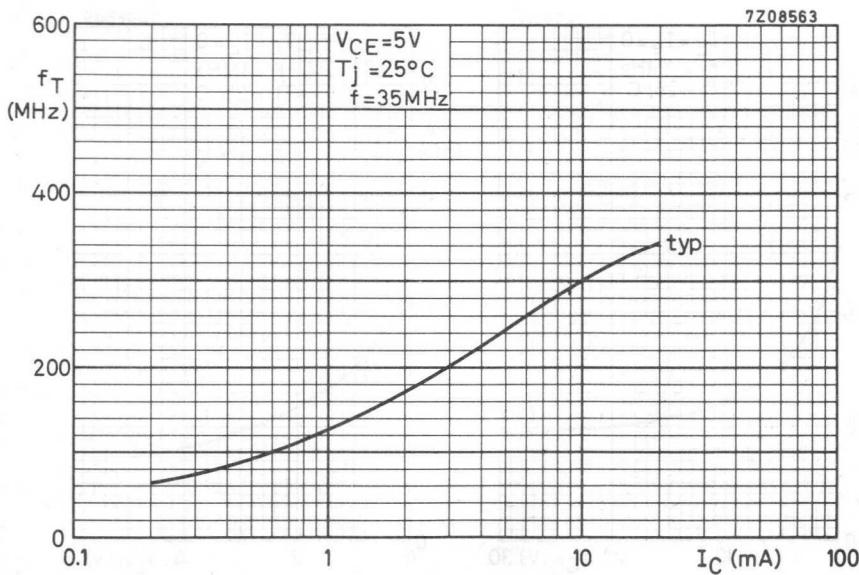
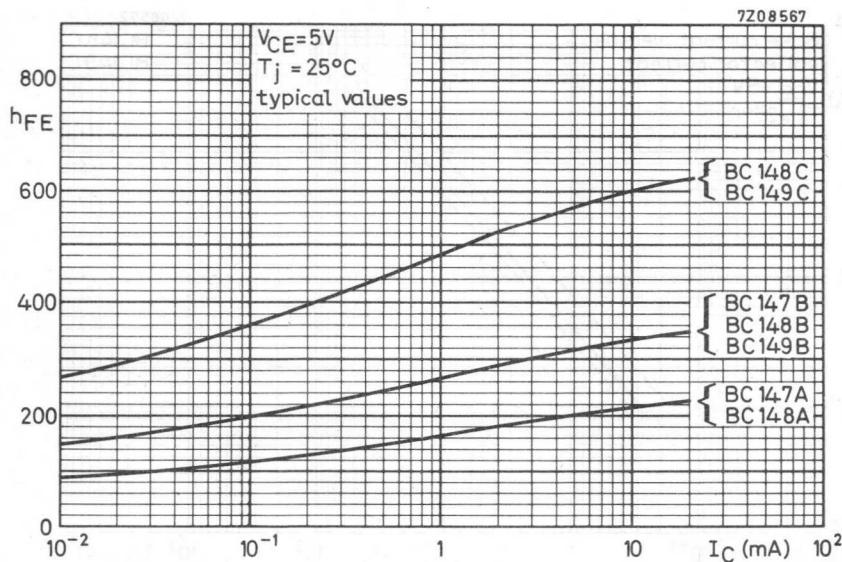
h_{oe}	typ. 18	30	$60 \mu\Omega^{-1}$
	< 30	60	$110 \mu\Omega^{-1}$

Typical behaviour of collector current versus collector-emitter voltage

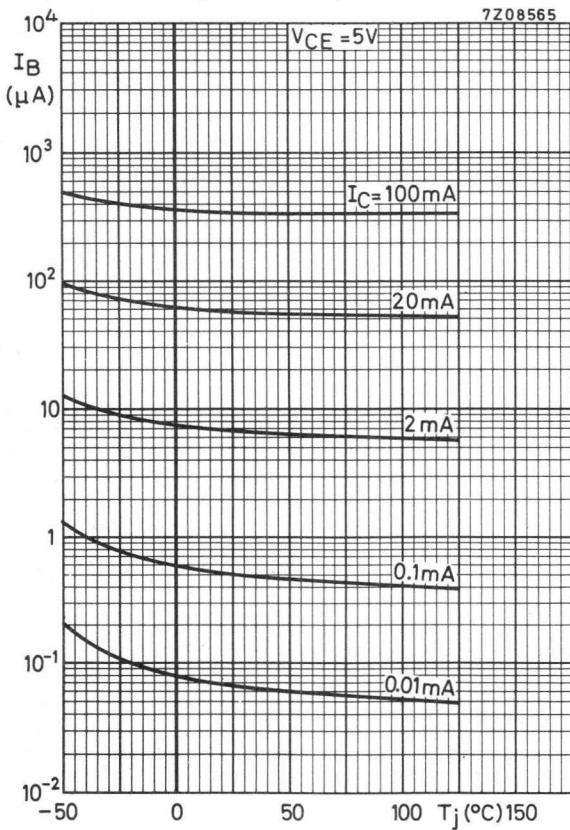
Typical behaviour of collector current
versus collector-emitter voltage

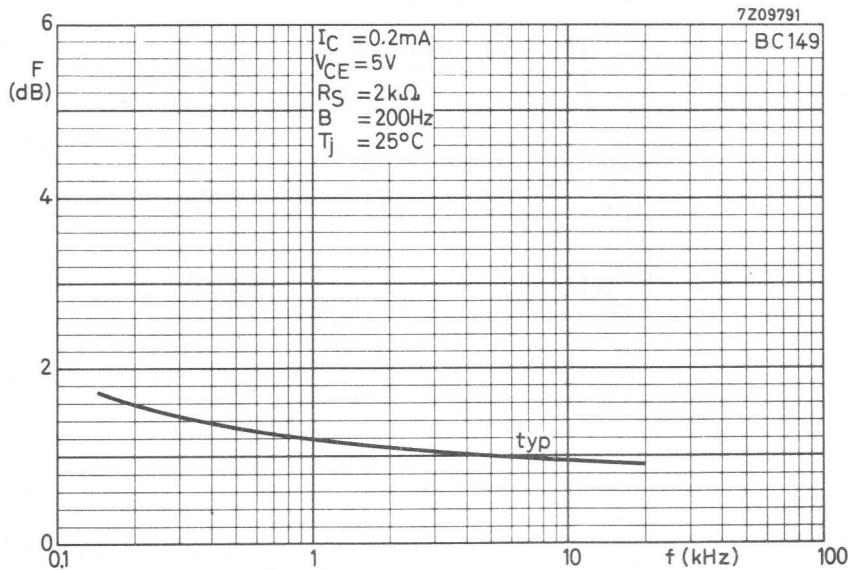
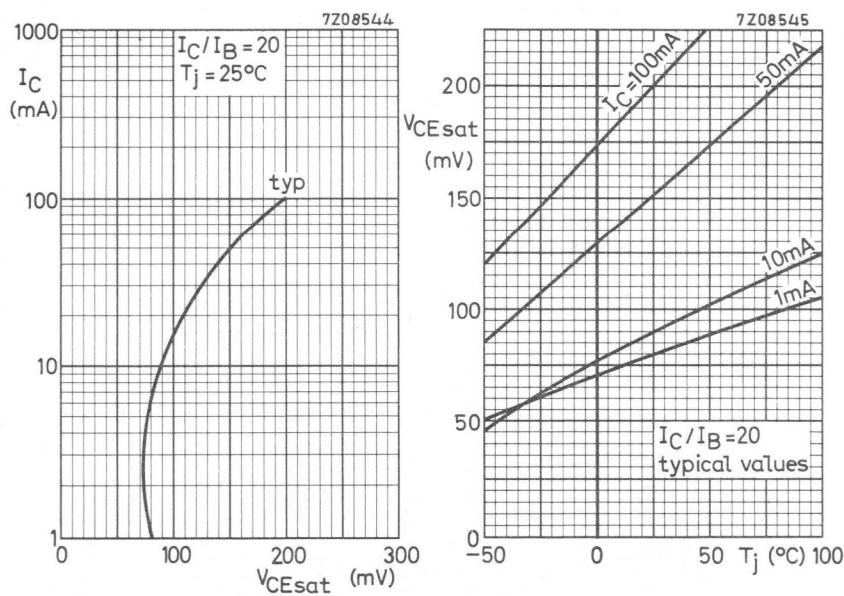




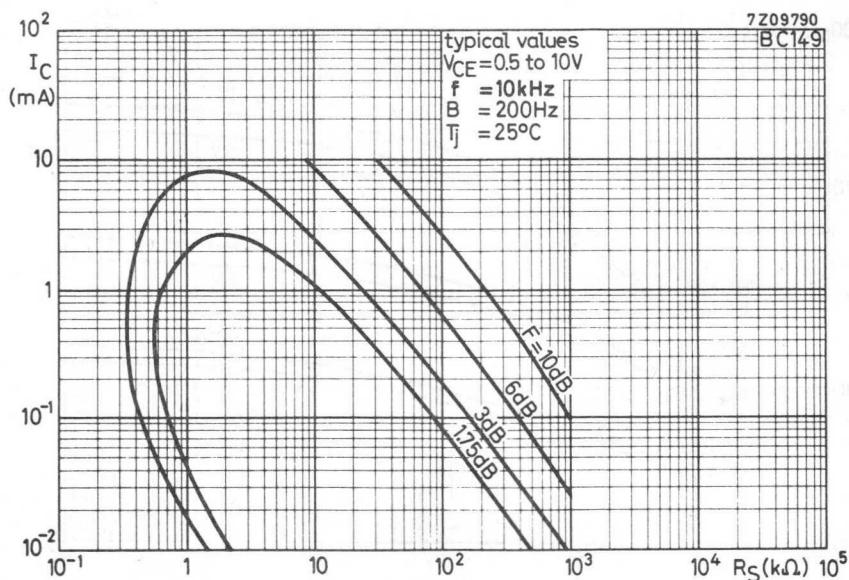
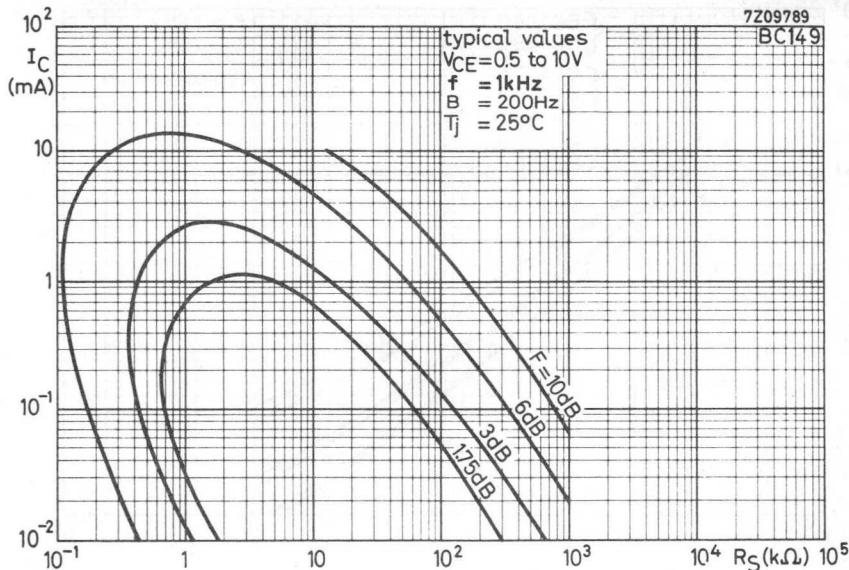


Typical behaviour of base current
versus junction temperature

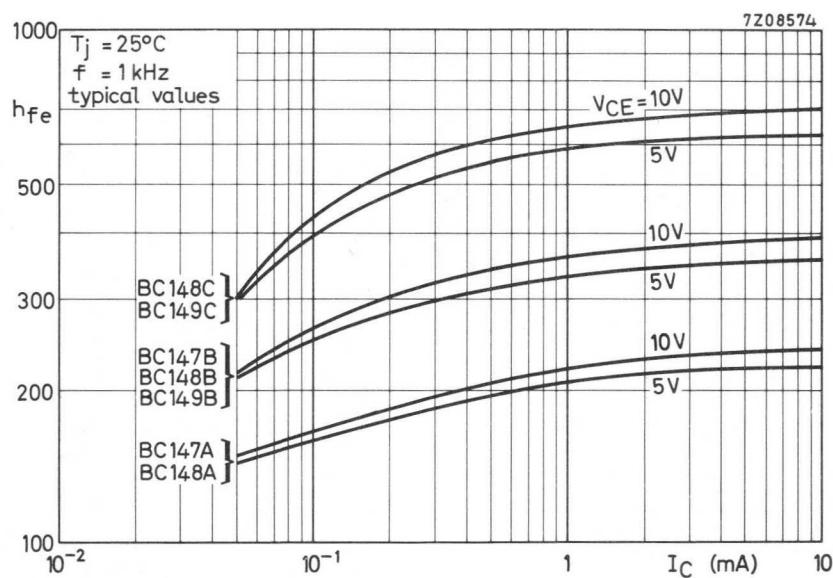
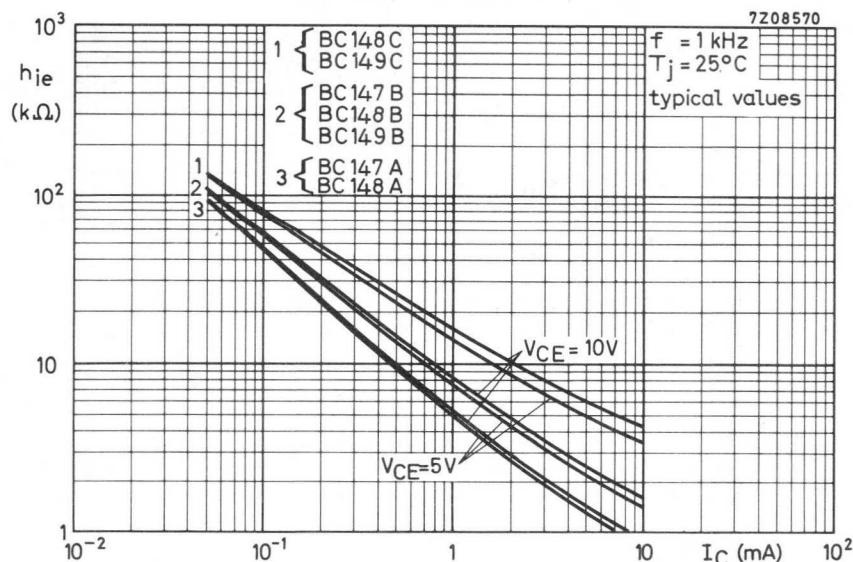


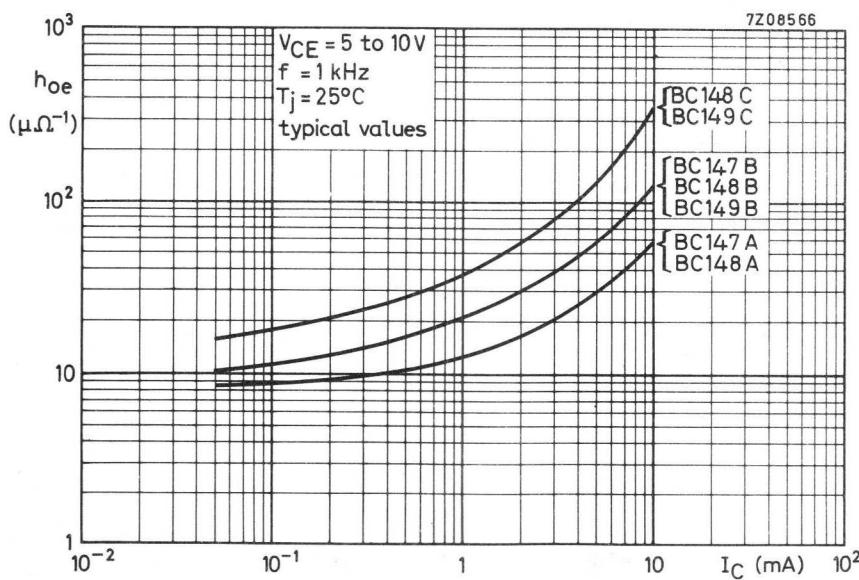
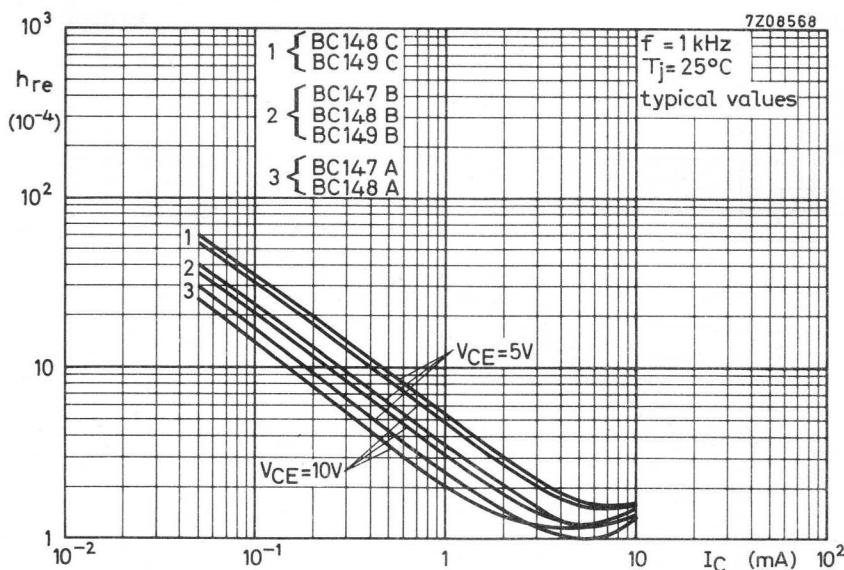


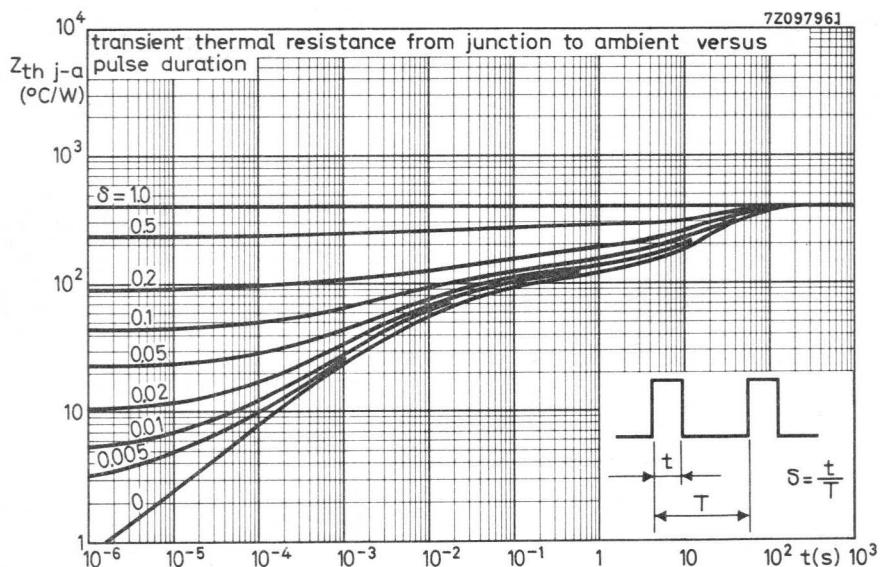
Curves of constant noise figure



BC147 to 149







A.F. SILICON PLANAR EPITAXIAL TRANSISTORS

P-N-P transistors in a plastic envelope with stiff self-locking pins suitable for use with standard printed boards.

The BC157 is a high voltage type and primarily intended for use in driver stages of audio amplifiers and in signal processing circuits of television receivers.

The BC158 is suitable for a multitude of low voltage applications e.g. driver stages or audio pre-amplifiers and in signal processing circuits of television receivers.

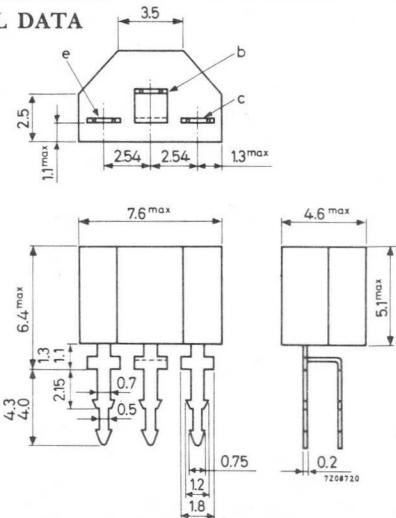
The BC159 is primarily intended for low noise input stages in tape recorders, hi-fi amplifiers and other audio frequency equipment.

QUICK REFERENCE DATA

		BC157	BC158	BC159	V
Collector-emitter voltage ($+V_{BE} = 1$ V)	$-V_{CEX}$	max. 50	30	25	
Collector-emitter voltage (open base)	$-V_{CEO}$	max. 45	25	20	V
Collector current (peak value)	$-I_{CM}$	max. 200	200	200	mA
Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max. 250	250	250	mW
Junction temperature	T_j	max. 125	125	125	$^\circ\text{C}$
Small signal current gain at $T_j = 25^\circ\text{C}$	h_{fe}	> 75	75	125	
$-I_C = 2$ mA; $-V_{CE} = 5$ V; $f = 1$ kHz		< 260	500	500	
Transition frequency at $f = 35$ MHz	f_T	typ. 150	150	150	MHz
$-I_C = 10$ mA; $-V_{CE} = 5$ V					
Noise figure at $R_S = 2$ k Ω					
$-I_C = 200$ μA ; $-V_{CE} = 5$ V					
$f = 30$ Hz to 15 kHz	F	typ.			1.2 dB
$f = 1$ kHz; $B = 200$ Hz	F	^	10	10	4 dB
					4 dB

MECHANICAL DATA

Dimensions in mm

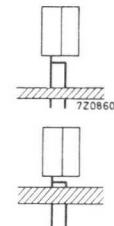


The envelope fulfils the accelerated damp heat test described in IEC publication 68-2 (test D, severity IV, 6 cycles).

BC157 to 159

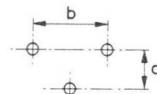
MOUNTING INSTRUCTIONS

1. Thickness of printed board: max. 1.1 mm
Hole diameter 0.77 to 0.83 mm



2. Thickness of printed board: max. 1.7 mm
Hole diameter 1.25 to 1.35 mm

Bore plan



$$a = 2.49 \text{ to } 2.59 \text{ mm}$$

$$b = 5.03 \text{ to } 5.13 \text{ mm}$$

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

		BC157	BC158	BC159
Collector-base voltage (open emitter)	-V _{CBO}	max. 50	30	25 V
Collector-emitter voltage (+V _{BE} = 1 V)	-V _{CEX}	max. 50	30	25 V
Collector-emitter voltage (open base)	-V _{CEO}	max. 45	25	20 V
Emitter-base voltage (open collector)	-V _{EBO}	max. 5	5	5 V

Currents

Collector current (d.c.)	-I _C	max.	100	mA
Collector current (peak value)	-I _{CM}	max.	200	mA
Emitter current (peak value)	I _{EM}	max.	200	mA

Power dissipation

Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max.	250	mW
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Temperatures

Storage temperature	T _{stg}	-65 to +125	°C
Junction temperature	T _j	max.	125 °C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	=	0.4	°C/mW
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CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current

$I_E = 0; -V_{CB} = 20 \text{ V}; T_j = 25^\circ\text{C}$
 $T_j = 125^\circ\text{C}$

$-I_{CBO}$	typ.	1	nA
<	100	nA	
$-I_{CBO}$	<	4	μA

Base-emitter voltage 1)

$-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$

$-V_{BE}$	typ.	650	mV
600 to 750			mV

Saturation voltages

$-I_C = 10 \text{ mA}; -I_B = 0.5 \text{ mA}$

$-V_{CEsat}$	typ.	75	mV
<	300	mV	

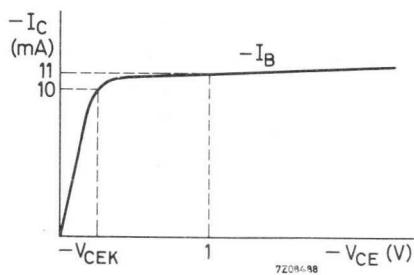
$-I_C = 100 \text{ mA}; -I_B = 5 \text{ mA}$

$-V_{BEsat}$	typ.	700	mV
$-V_{CEsat}$	typ.	250	mV
$-V_{BESat}$	typ.	850	mV

Knee voltage

$-I_C = 10 \text{ mA}; -I_B = \text{value for which}$
 $-I_C = 11 \text{ mA at } -V_{CE} = 1 \text{ V}$

$-V_{CEK}$	typ.	250	mV
<	600	mV	

Collector capacitance at f = 1 MHz

$I_E = I_e = 0; -V_{CB} = 10 \text{ V}$

C_C typ. 4.5 pF

Transition frequency at f = 35 MHz

$-I_C = 10 \text{ mA}; -V_{CE} = 5 \text{ V}$

f_T typ. 150 MHz

1) $-V_{BE}$ decreases by about 2 mV/ $^\circ\text{C}$ with increasing temperature.

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedSmall signal current gain at $f = 1 \text{ kHz}$ $-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$

		BC157	BC158	BC159
	h_{fe}	> 75 < 260	75 500	125 500

Noise figure at $R_S = 2 \text{ k}\Omega$ $-I_C = 200 \mu\text{A}; -V_{CE} = 5 \text{ V}$ $f = 30 \text{ Hz to } 15 \text{ kHz}$

F	typ. <	1.2 4	dB dB
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 $f = 1 \text{ kHz}; B = 200 \text{ Hz}$

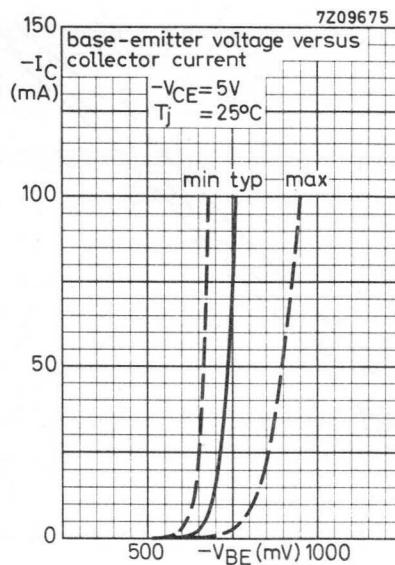
F	typ. <	2 10	2 10	1 4	dB dB
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D.C. current gain $-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$

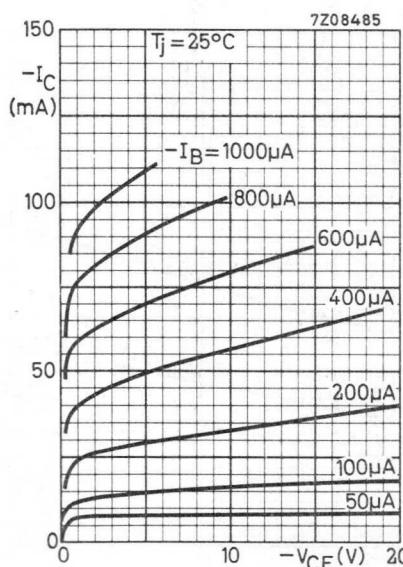
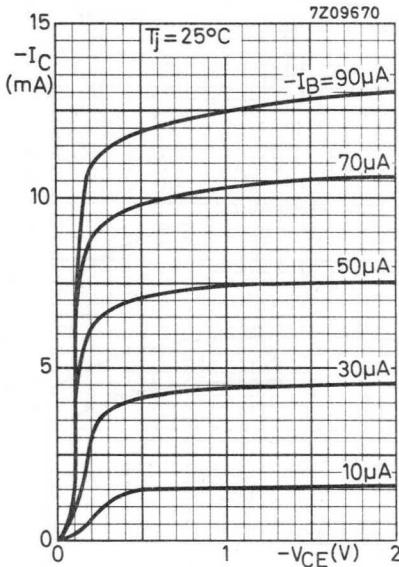
	BC157	BC158A BC159A	BC158B BC159B
h_{FE}	typ. 140	180	290

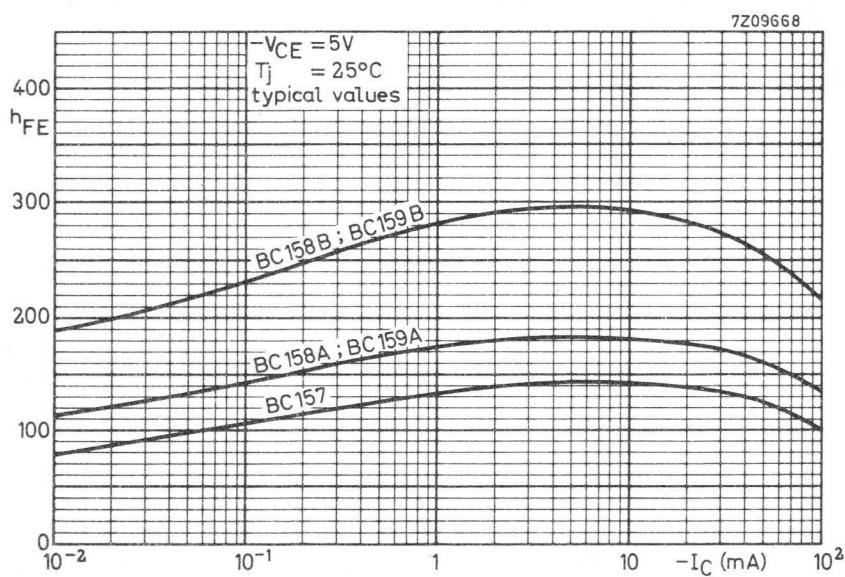
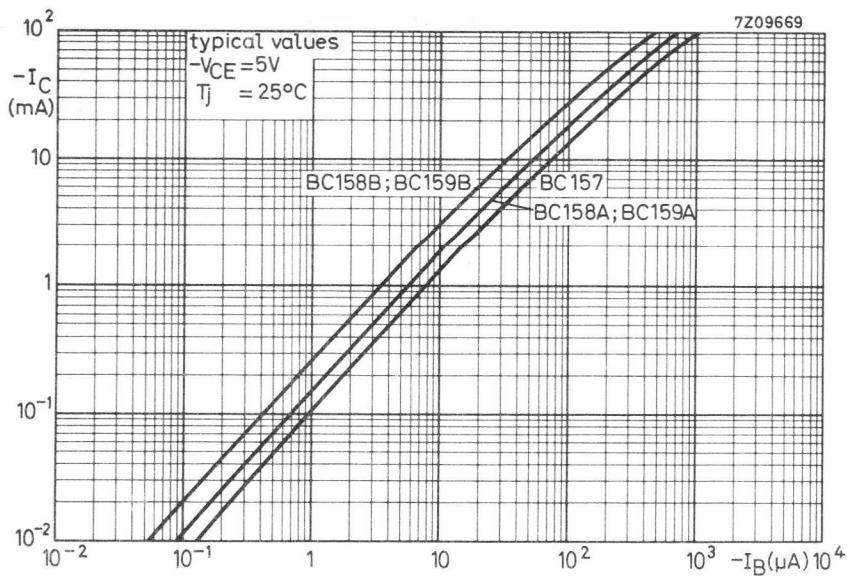
Small signal current gain at $f = 1 \text{ kHz}$ $-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$

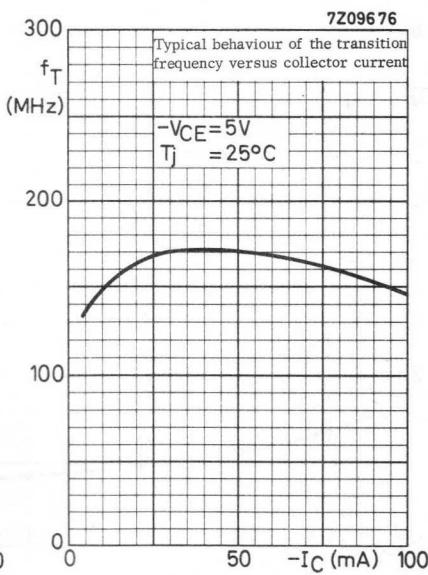
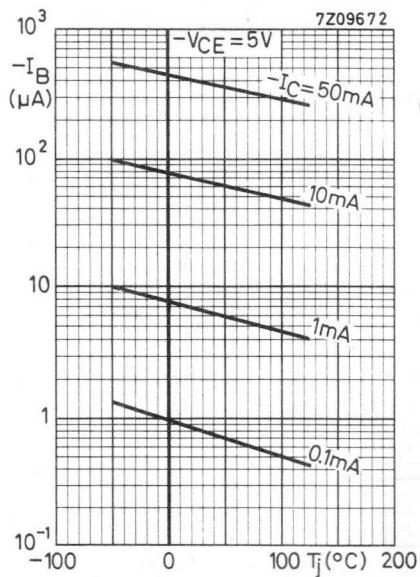
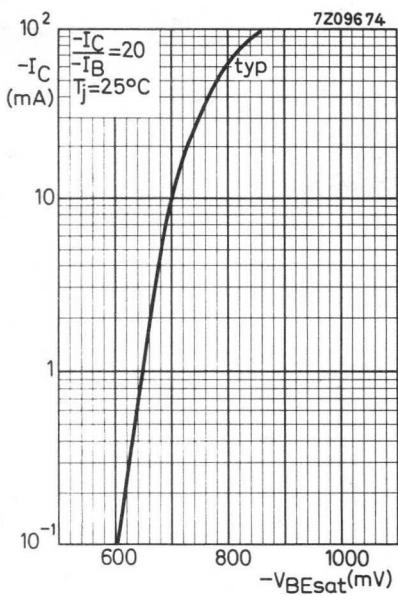
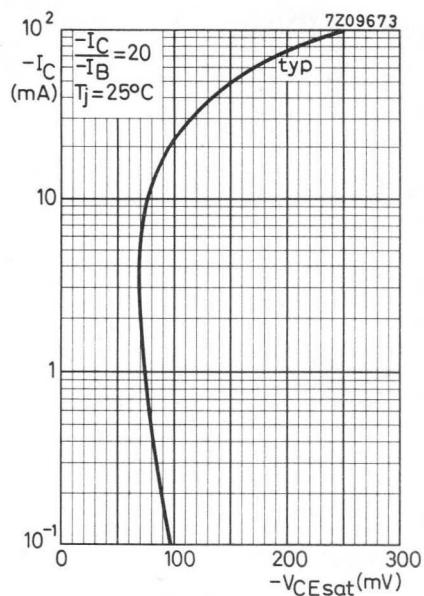
h_{fe}	> <	75 260	125 260	240 500
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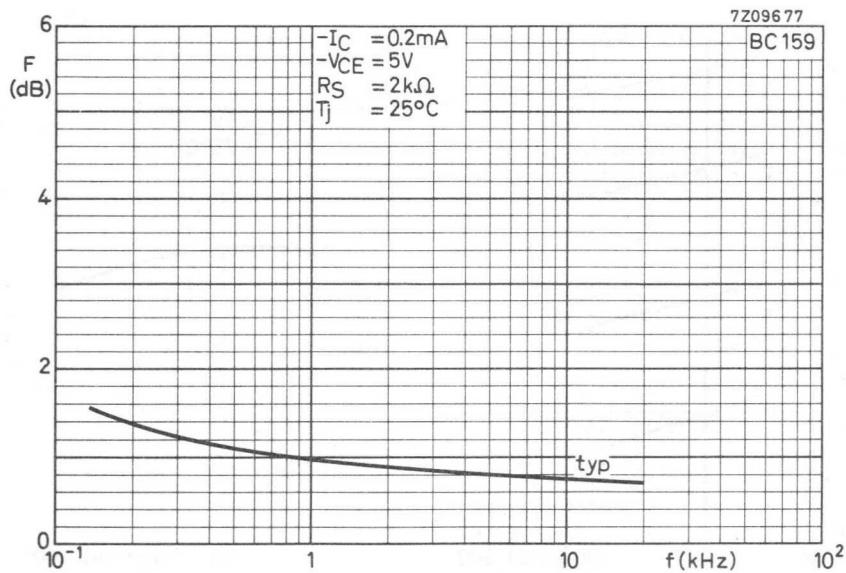
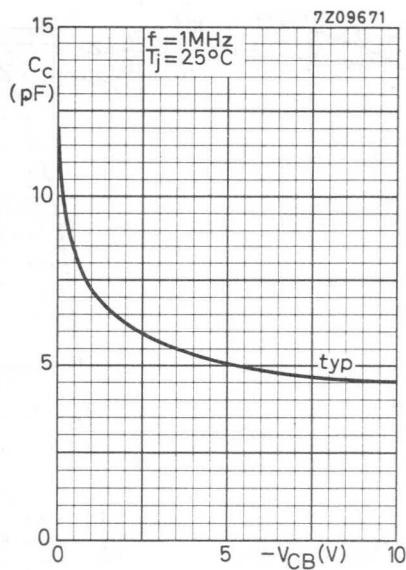
Typical behaviour of collector current versus collector-emitter voltage



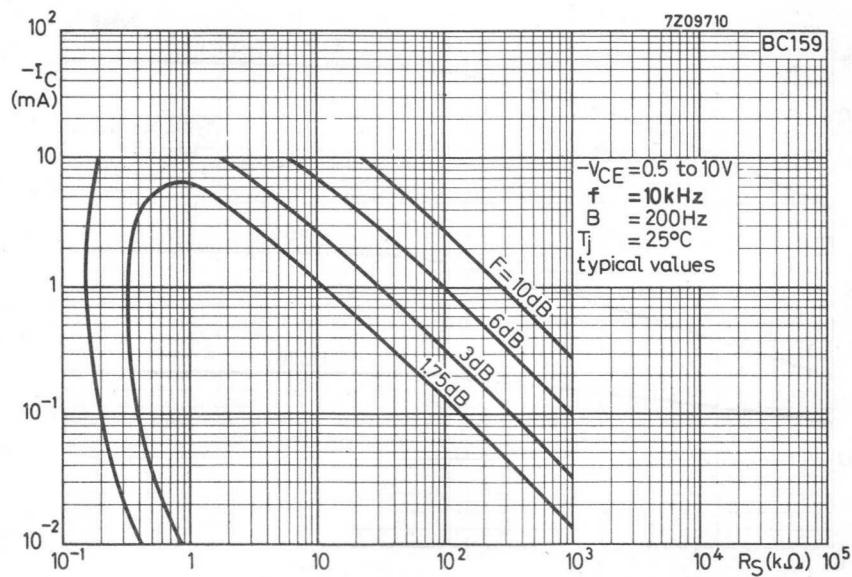
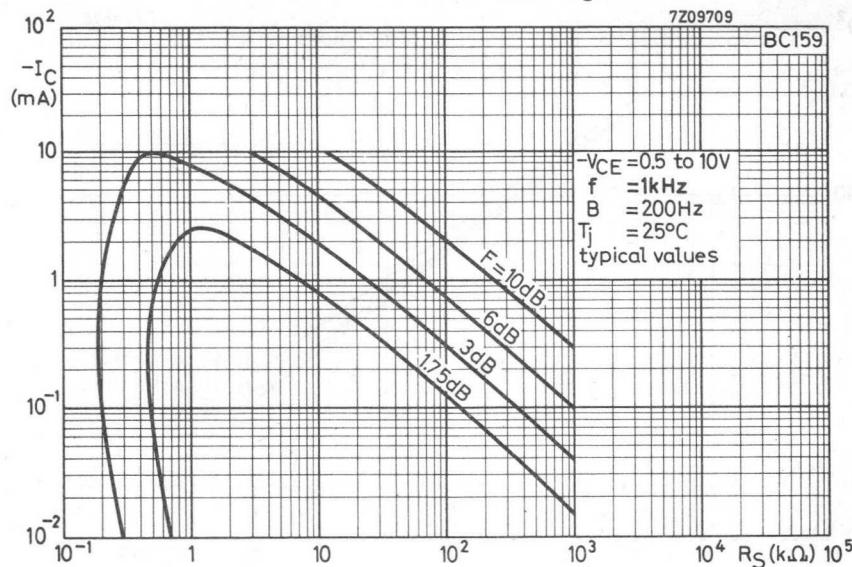


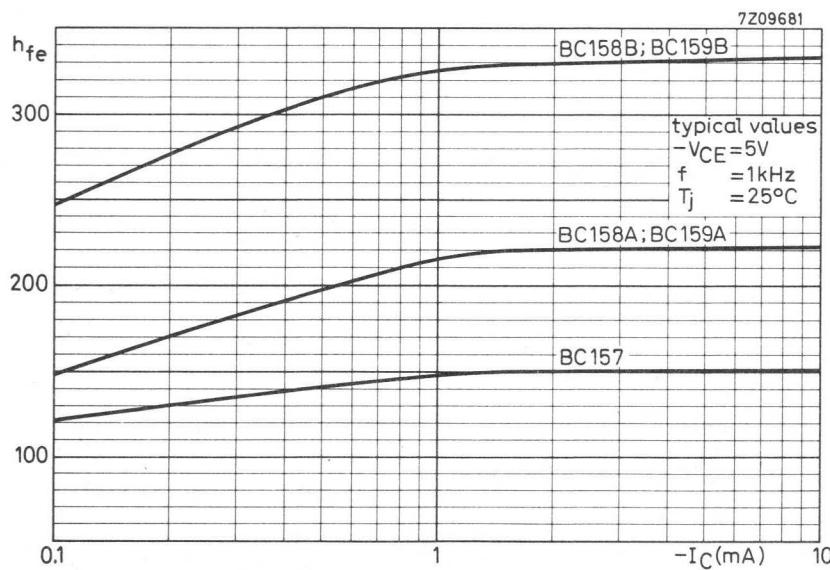
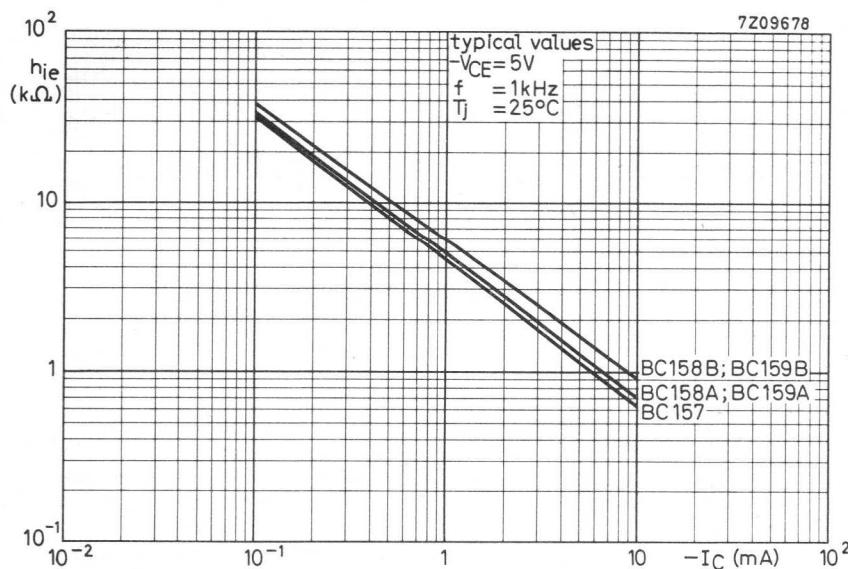


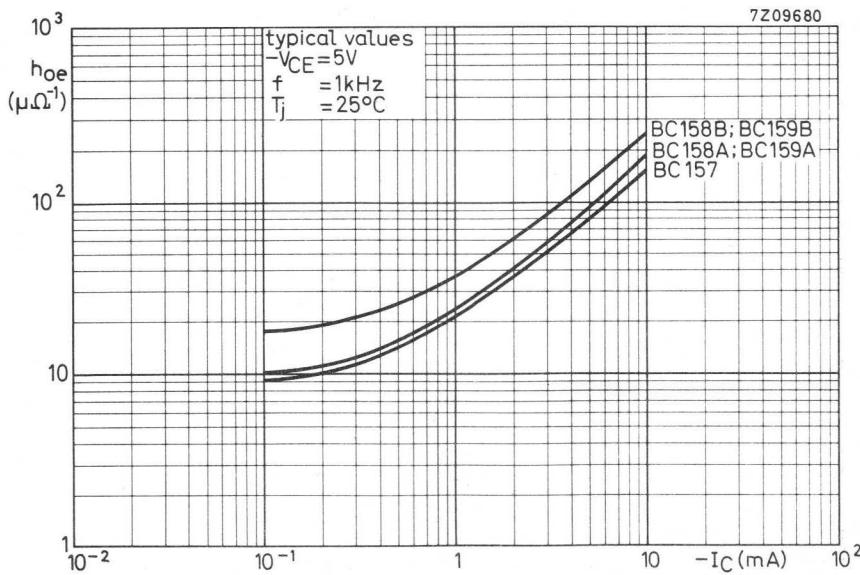
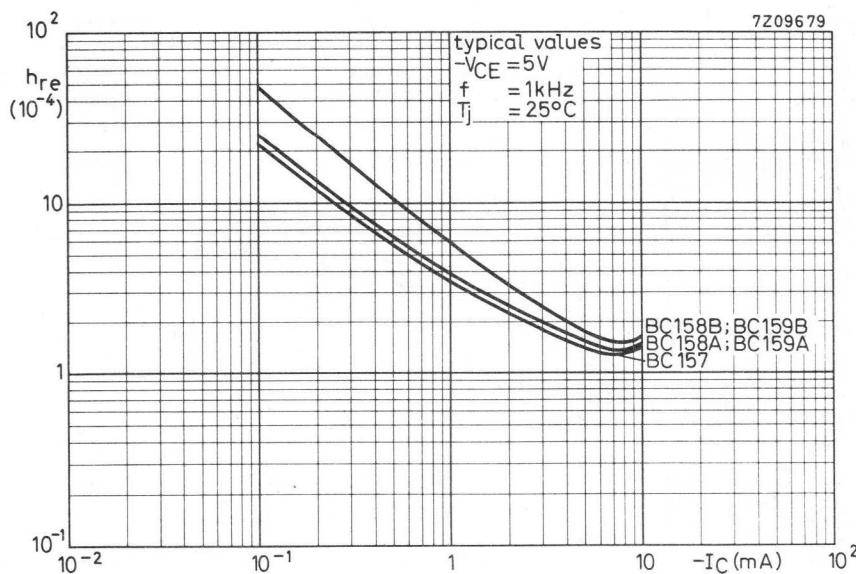
Typical behaviour of base current versus junction temperature

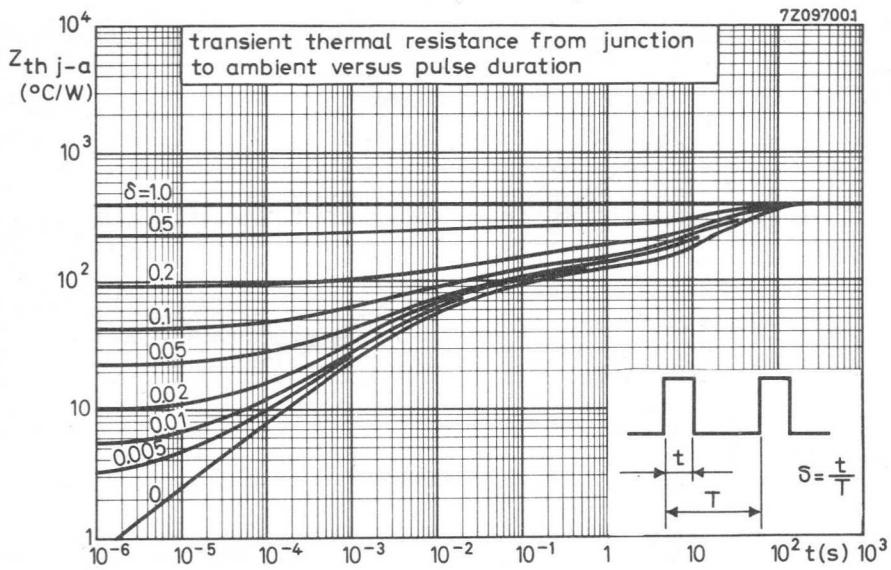


Curves of constant noise figure









A.F. SILICON PLANAR EPITAXIAL TRANSISTORS

P-N-P transistors in a TO-18 metal envelope with the collector connected to the case. The BC177 is a high voltage type and primarily intended for use in driver stages of audio amplifiers and in signal processing circuits of television receivers.

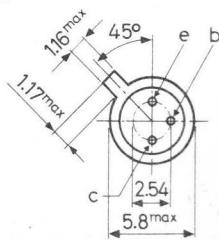
The BC178 is suitable for a multitude of low voltage applications e.g. driver stages or audio pre-amplifiers and in signal processing circuits of television receivers. The BC179 is primarily intended for low noise input stages in tape recorders, hi-fi amplifiers and other audio frequency equipment.

Moreover they are intended as complementary types for the BC107, BC108 and BC109.

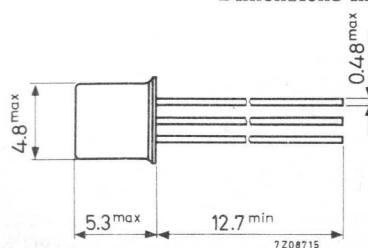
QUICK REFERENCE DATA				
		BC177	BC178	BC179
Collector-emitter voltage ($+V_{BE} = 1$ V)	$-V_{CEX}$ max.	50	30	25 V
Collector-emitter voltage (open base)	$-V_{CEO}$ max.	45	25	20 V
Collector current (peak value)	$-I_{CM}$ max.	200	200	200 mA
Total power dissipation up to $T_{amb} = 25$ °C	P_{tot} max.	300	300	300 mW
Junction temperature	T_j max.	175	175	175 °C
Small signal current gain at $T_j = 25$ °C				
$-I_C = 2$ mA; $-V_{CE} = 5$ V; $f = 1$ kHz	h_{fe}	$>$ 75 $<$ 260	75 500	125 500
Transition frequency at $f = 35$ MHz				
$-I_C = 10$ mA; $-V_{CE} = 5$ V	f_T typ.	150	150	150 MHz
Noise figure at $R_S = 2$ kΩ				
$-I_C = 200$ µA; $-V_{CE} = 5$ V	F	typ. \wedge		1.2 dB 4 dB
$f = 30$ Hz to 15 kHz	F	$<$	10	10
$f = 1$ kHz; $B = 200$ Hz				4 dB

MECHANICAL DATA

TO-18
Collector connected
to case



Dimensions in mm



Accessories available: 56246, 56263

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134).

Voltages

		BC177	BC178	BC179
Collector-base voltage (open emitter)	-V _{CBO}	max. 50	30	25 V
Collector-emitter voltage ($+V_{BE} = 1$ V)	-V _{CEx}	max. 50	30	25 V
Collector-emitter voltage (open base)	-V _{CEO}	max. 45	25	20 V
Emitter-base voltage (open collector)	-V _{EBO}	max. 5	5	5 V

Currents

Collector current (d.c.)	-I _C	max.	100 mA
Collector current (peak value)	-I _{CM}	max.	200 mA
Emitter current (peak value)	I _{EM}	max.	200 mA

Power dissipation

Total power dissipation up to $T_{amb} = 25$ °C	P _{tot}	max.	300 mW
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Temperatures

Storage temperature	T _{stg}	-65 to +175	°C
Junction temperature	T _j	max.	175 °C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	=	0.5 °C/mW
From junction to case	R _{th j-c}	=	0.2 °C/mW

CHARACTERISTICS

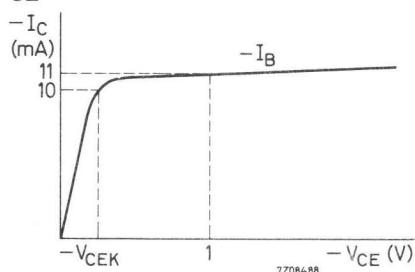
Collector cut-off current

$I_E = 0$; $-V_{CB} = 20$ V; $T_j = 25$ °C	-I _{CBO}	typ. <	1 nA
$T_j = 150$ °C	-I _{CBO}	<	10 μA

Base-emitter voltage ¹⁾

$-I_C = 2$ mA; $-V_{CE} = 5$ V; $T_j = 25$ °C	-V _{BE}	typ. 650 mV
		600 to 750 mV

¹⁾ $-V_{BE}$ decreases by about 2 mV/°C with increasing temperature.

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedSaturation voltages $-I_C = 10 \text{ mA}; -I_B = 0.5 \text{ mA}$ $-V_{CEsat}$ typ. 75 mV
 $< 300 \text{ mV}$ $-V_{BEsat}$ typ. 700 mV $-I_C = 100 \text{ mA}; -I_B = 5 \text{ mA}$ $-V_{CEsat}$ typ. 250 mV
 $-V_{BEsat}$ typ. 850 mVKnee voltage $-I_C = 10 \text{ mA}; -I_B = \text{value for which}$ $-V_{CEK}$ typ. 250 mV
 $< 600 \text{ mV}$ $-I_C = 11 \text{ mA at } -V_{CE} = 1 \text{ V}$ Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; -V_{CB} = 10 \text{ V}$ C_C typ. 4.0 pFTransition frequency at $f = 35 \text{ MHz}$ $-I_C = 10 \text{ mA}; -V_{CE} = 5 \text{ V}$ f_T typ. 150 MHzSmall signal current gain at $f = 1 \text{ kHz}$ $-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$

		BC177	BC178	BC179
$-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$	h_{fe}	> 75	75	125
		< 260	500	500

Noise figure at $R_S = 2 \text{ k}\Omega$ $-I_C = 200 \mu\text{A}; -V_{CE} = 5 \text{ V}$ $f = 30 \text{ Hz to } 15 \text{ kHz}$

$f = 30 \text{ Hz to } 15 \text{ kHz}$	F	typ. <	1.2 dB 4 dB
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 $f = 1 \text{ kHz}; B = 200 \text{ Hz}$

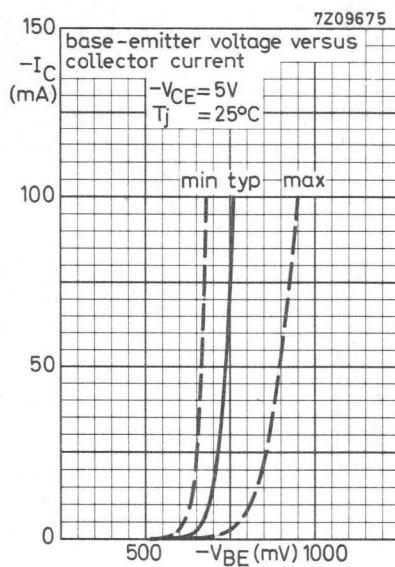
$f = 1 \text{ kHz}; B = 200 \text{ Hz}$	F	typ. < 10	2 dB 10 dB
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CHARACTERISTICS (continued)D.C. current gain $-I_C = 2 \text{ mA}$; $-V_{CE} = 5 \text{ V}$

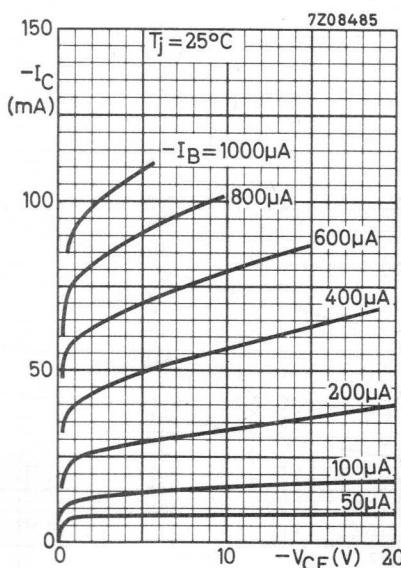
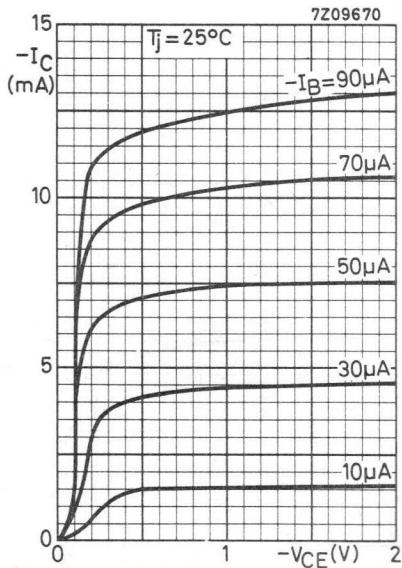
	BC177	BC178A BC179A	BC178B BC179B
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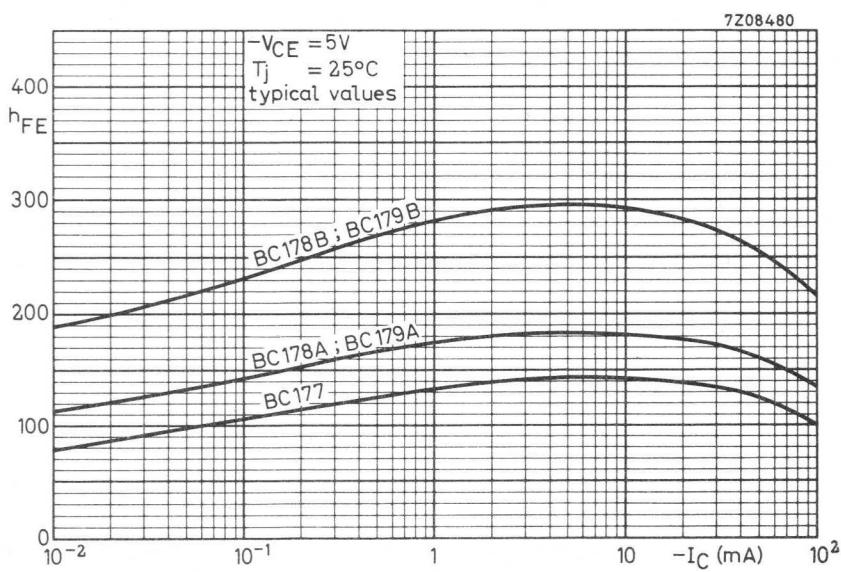
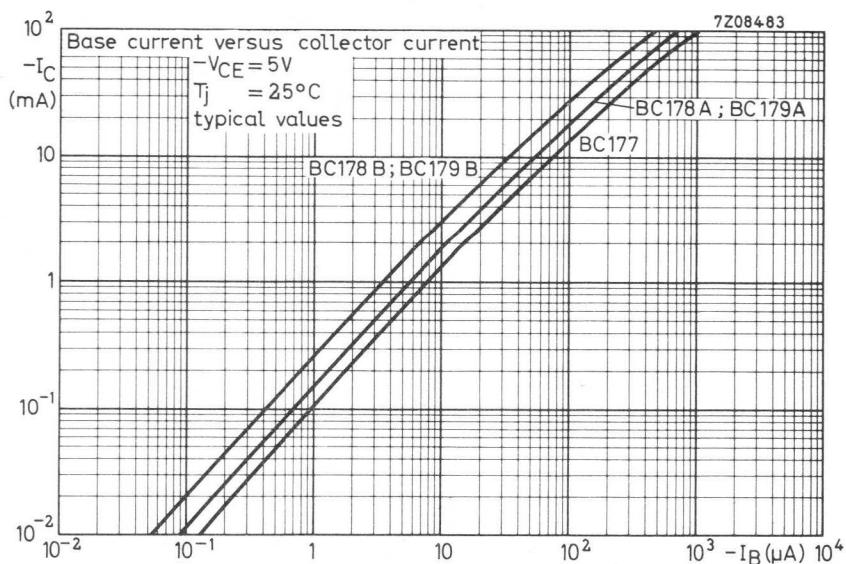
h_{FE} typ. 140 180 290Small signal current gain at f = 1 kHz $-I_C = 2 \text{ mA}$; $-V_{CE} = 5 \text{ V}$

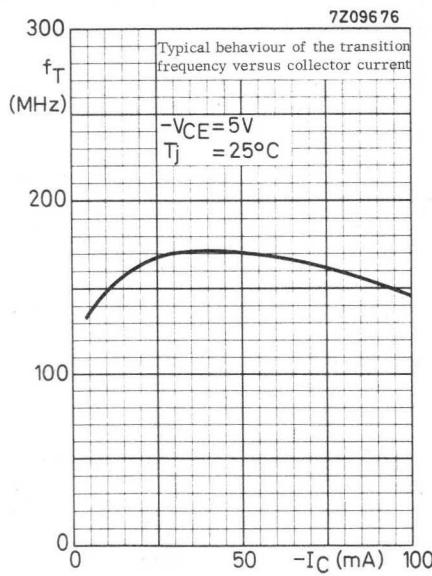
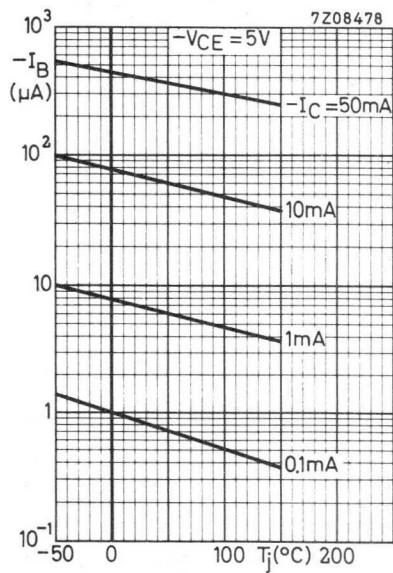
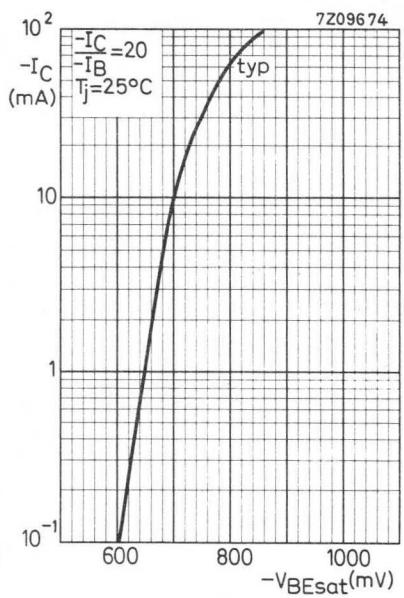
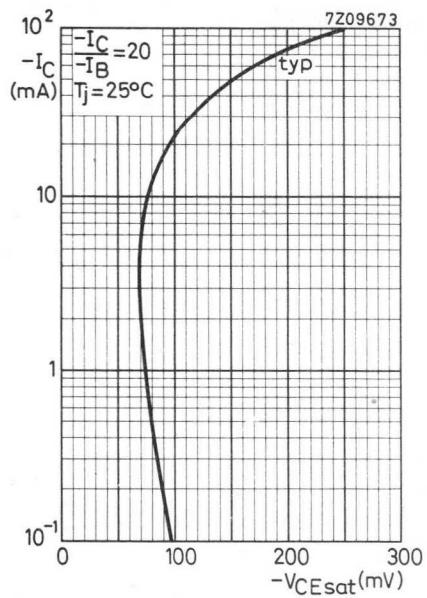
h _{fe}	> 75	125	240
	< 260	260	500



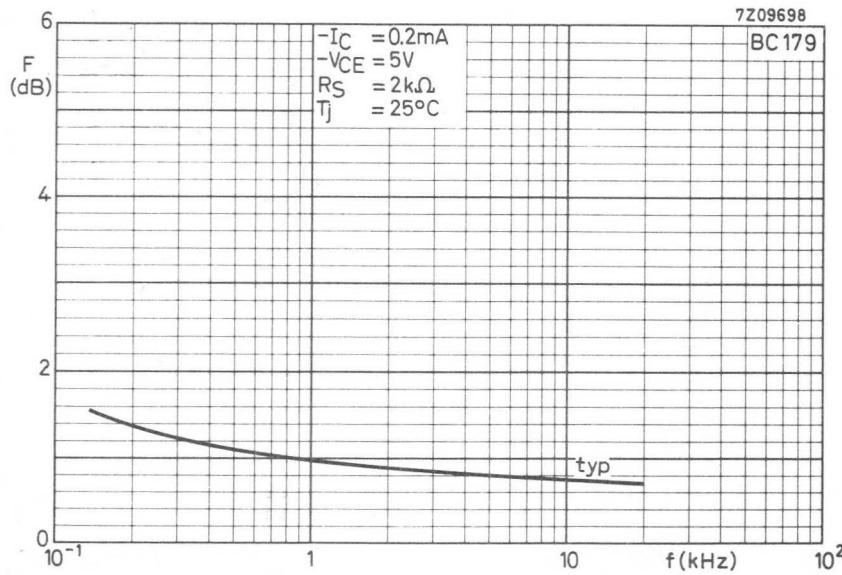
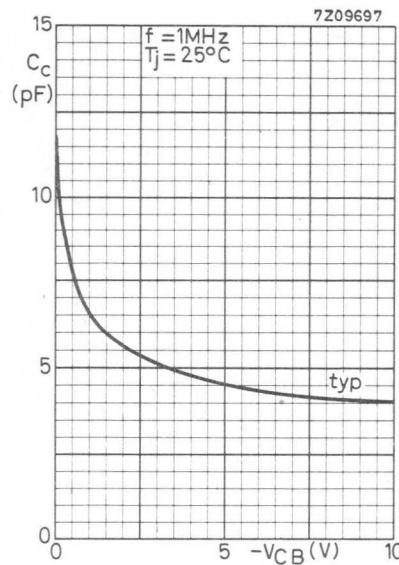
Typical behaviour of collector current versus collector-emitter voltage



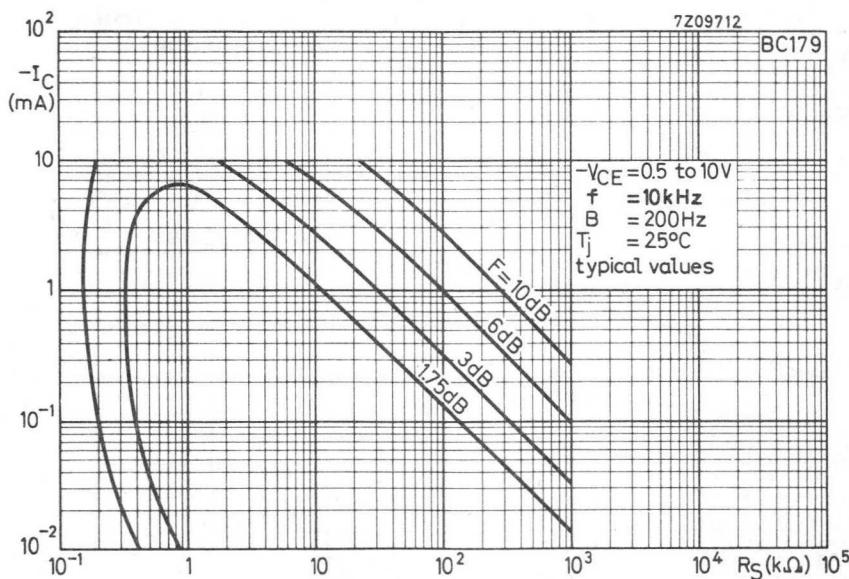
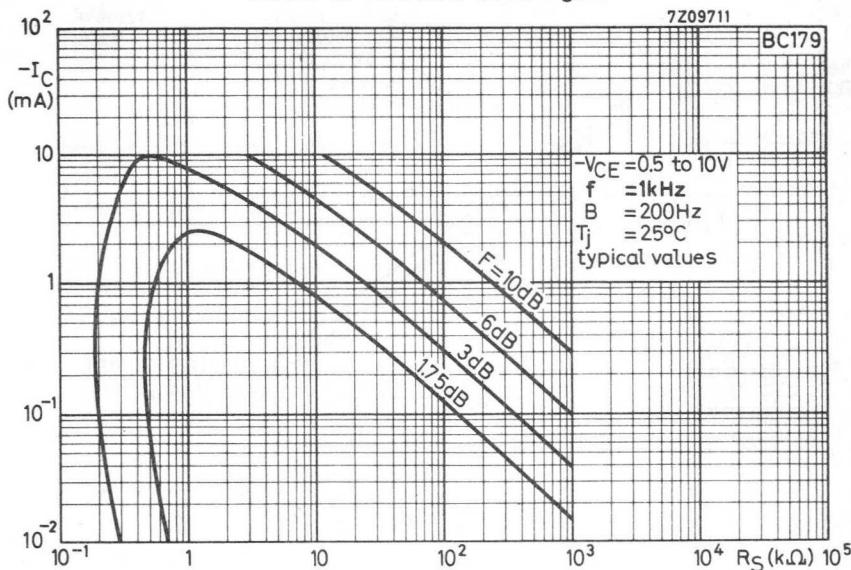




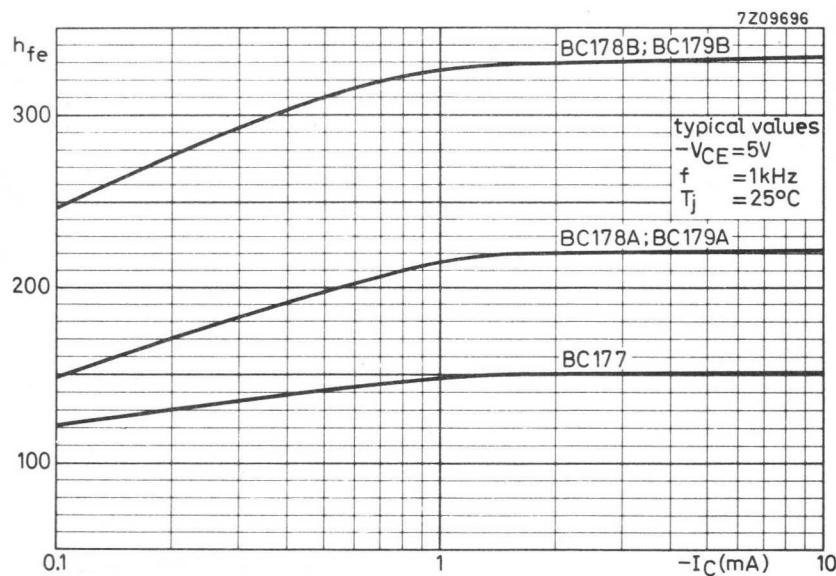
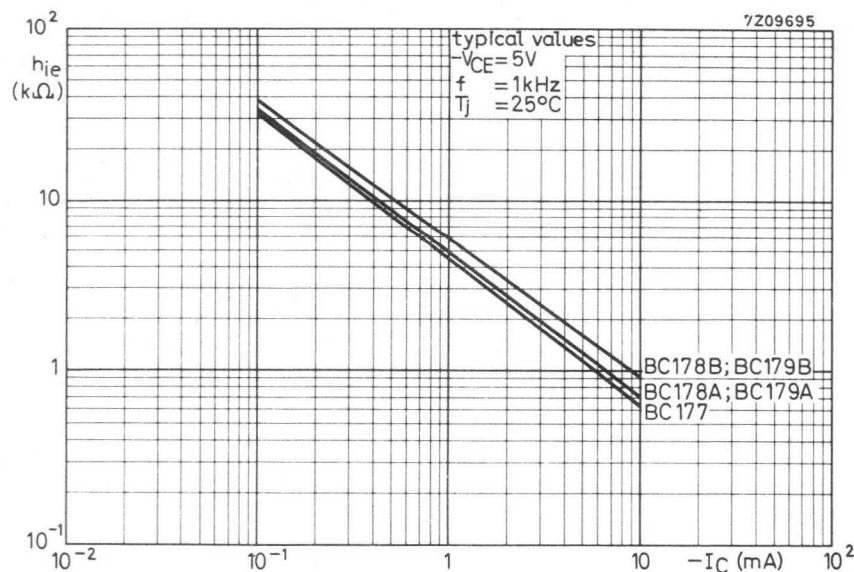
Typical behaviour of base current versus junction temperature

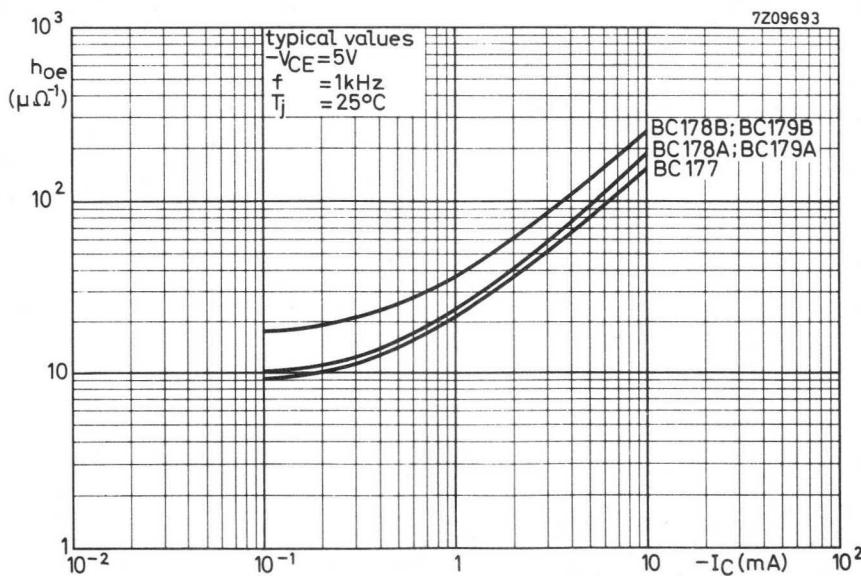
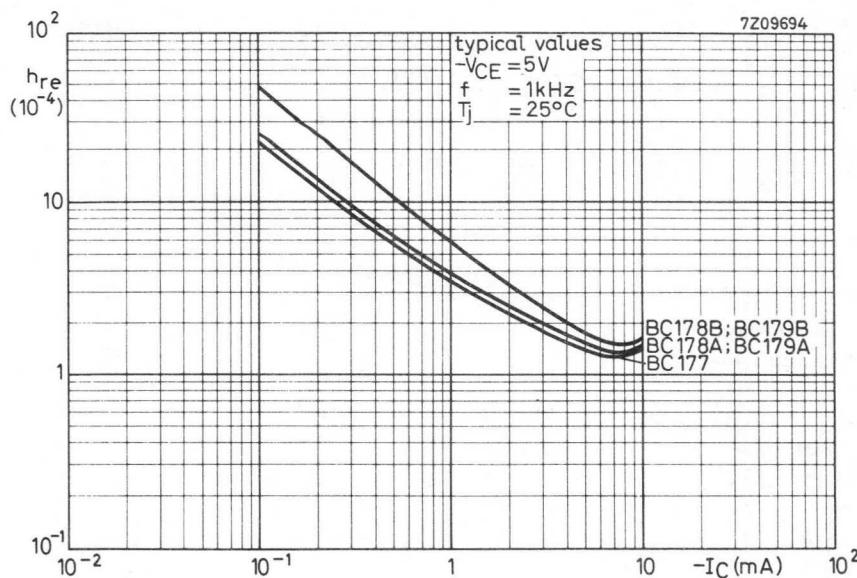


Curves of constant noise figure

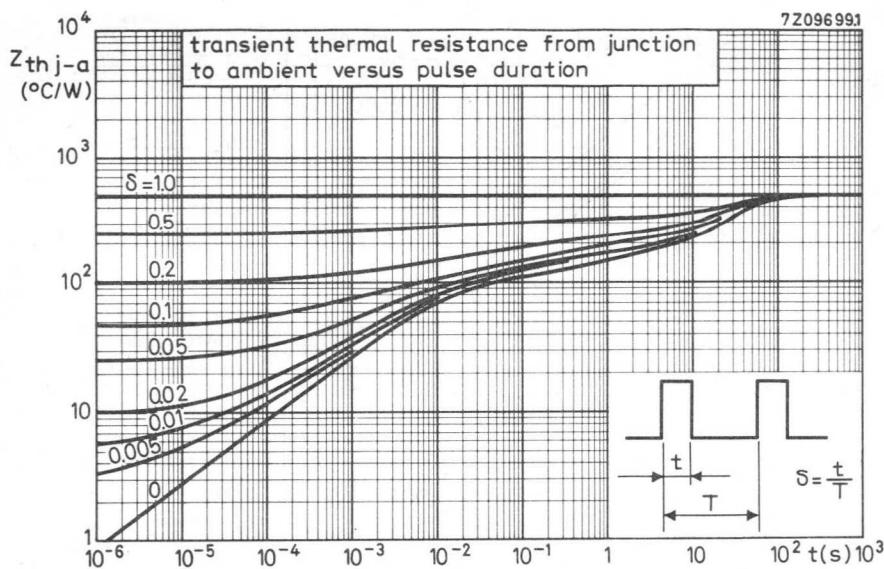


BC177 to 179





72096991



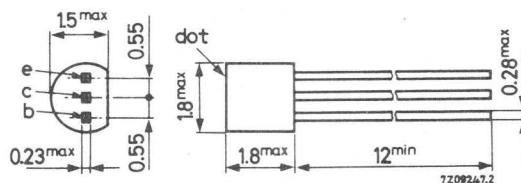
SILICON PLANAR EPITAXIAL TRANSISTOR

P-N-P transistor in a microminiature plastic envelope. The transistor is designed for use in hearing aids, watches and other equipment where small size is of paramount importance.

QUICK REFERENCE DATA					
			red	yellow	green
Collector-base voltage (open emitter)	-V _{CBO}	max.	20	20	20
Collector-emitter voltage (open base)	-V _{CEO}	max.	20	20	20
Collector current (d.c.)	-I _C	max.	50	50	50
Total power dissipation up to T _{amb} = 45 °C	P _{tot}	max.	50	50	50
Junction temperature	T _j	max.	125	125	125
D.C. current gain at T _j = 25 °C -I _C = 0.2 mA; -V _{CE} = 0.5 V	h _{FE}	> <	50 105	85 200	165 400
Noise figure at R _S = 2 kΩ -I _C = 0.2 mA; -V _{CE} = 5 V Bandwidth: f = 30 Hz to 15 kHz	F	typ. <	2 -	1.5 4	2 dB - dB

MECHANICAL DATA

Dimensions in mm



Coloured dot on top of the blue body

MOUNTING INSTRUCTIONS

To avoid damaging the transistor, welded or soldered connections must be made with care; the following general recommendations should be observed:

1. The temperature of the soldering iron must be less than 250 °C and the soldering time less than 3 seconds at a lead length of not less than 1.5 mm.
2. To keep the heat capacity low, the smallest possible amount of solder should be used.
3. If the plastic capsule of the transistor makes contact with any other structure, care must be taken that its temperature never exceeds 125 °C.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter)	-V _{CBO}	max.	20	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	20	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	5	V

Currents

Collector current (d.c.)	-I _C	max.	50	mA
Collector current (peak value)	-I _{CM}	max.	50	mA

Power dissipation

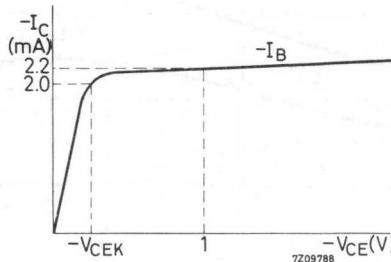
Total power dissipation up to T _{amb} = 45 °C	P _{tot}	max.	50	mW
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Temperatures

Storage temperature	T _{stg}	-65 to +125	°C
Junction temperature	T _j	max.	125 °C

THERMAL RESISTANCE

$$\text{From junction to ambient in free air} \quad R_{\text{th j-a}} = 1.6 \text{ °C/mW}$$

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; -V_{CB} = 20 \text{ V}$ $-I_{CBO} < 100 \text{ nA}$ $I_E = 0; -V_{CB} = 20 \text{ V}; T_j = 125^\circ\text{C}$ $-I_{CBO} < 1 \mu\text{A}$ Base-emitter voltage $-I_C = 0.2 \text{ mA}; -V_{CE} = 0.5 \text{ V}$ $-V_{BE} \text{ typ. } 580 \text{ mV}$ $-I_C = 2 \text{ mA}; -V_{CE} = 1 \text{ V}$ $-V_{BE} \text{ typ. } 650 \text{ mV}$ Knee voltage $-I_C = 2 \text{ mA}; -I_B = \text{value for which}$ $-V_{CEK} \text{ typ. } 200 \text{ mV}$ $-I_C = 2.2 \text{ mA at } -V_{CE} = 1 \text{ V}$ Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; -V_{CB} = 5 \text{ V}$ $C_C \text{ typ. } 5 \text{ pF}$ Transition frequency at $f = 100 \text{ MHz}$ $-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$ $f_T \text{ typ. } 90 \text{ MHz}$ D.C. current gain $-I_C = 0.2 \text{ mA}; -V_{CE} = 0.5 \text{ V}$

	red	yellow	green
typ. 75	140	250	
50 to 105	85 to 200	165 to 400	

 $-I_C = 2 \text{ mA}; -V_{CE} = 1 \text{ V}$

hFE	> 60	100	175
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h parameters at $f = 1 \text{ kHz}$ $-I_C = 0.2 \text{ mA}; -V_{CE} = 0.5 \text{ V}$

hie	typ. 12	15	20 kΩ
hre	typ. 13	25	40 10 ⁻⁴
hfe	typ. 75	140	250
hoe	typ. 13	18	33 μΩ ⁻¹

Input impedance

hie	typ. 12	15	20 kΩ
hre	typ. 13	25	40 10 ⁻⁴
hfe	typ. 75	140	250
hoe	typ. 13	18	33 μΩ ⁻¹

Reverse voltage transfer ratio

hre	typ. 13	25	40 10 ⁻⁴
hfe	typ. 75	140	250
hoe	typ. 13	18	33 μΩ ⁻¹

Small signal current gain

hfe	typ. 75	140	250
hoe	typ. 13	18	33 μΩ ⁻¹

Output admittance

hoe	typ. 13	18	33 μΩ ⁻¹

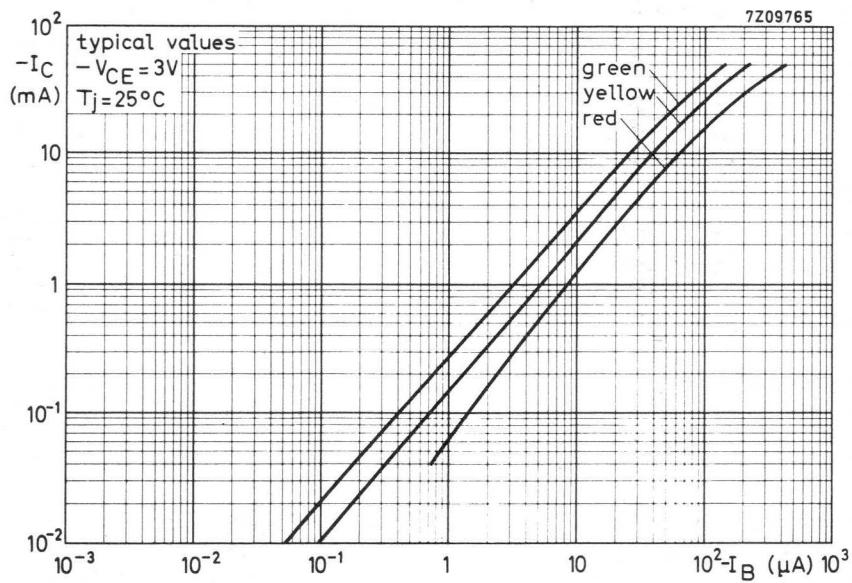
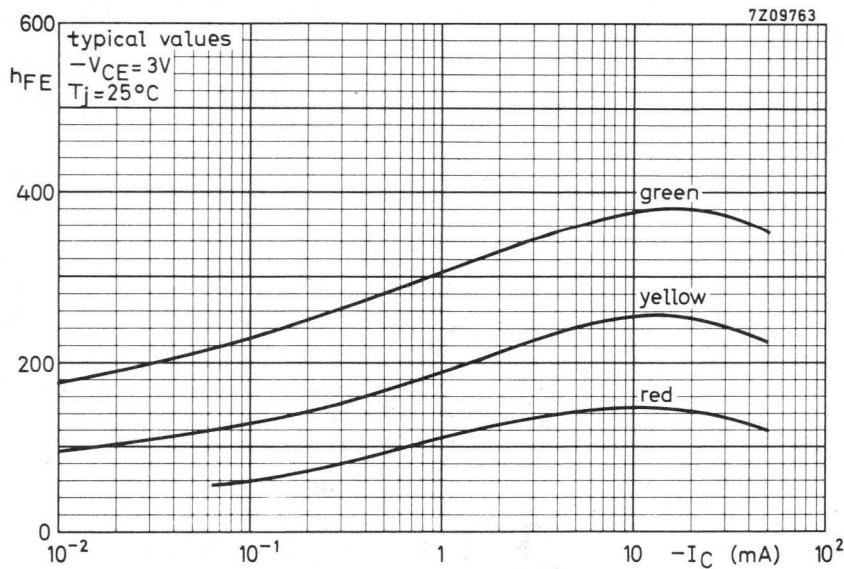
Noise figure $-I_C = 0.2 \text{ mA}; -V_{CE} = 5 \text{ V};$

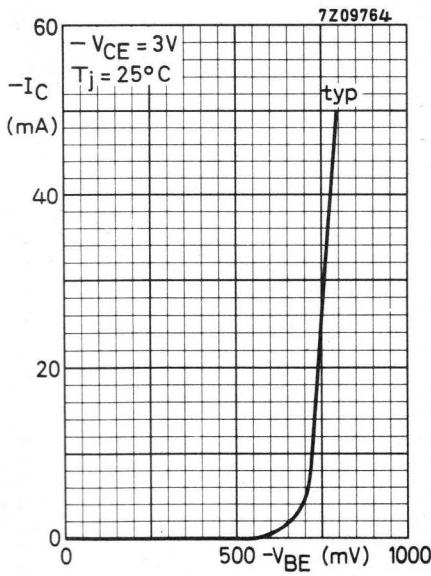
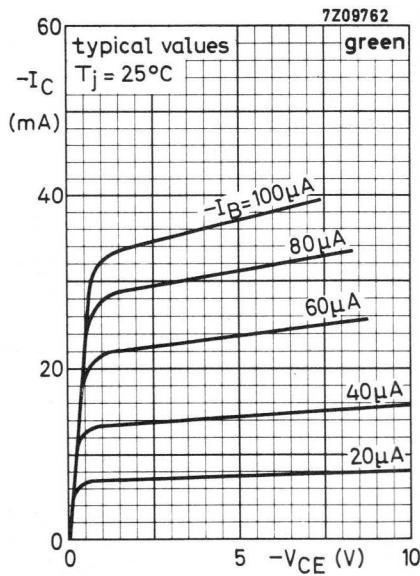
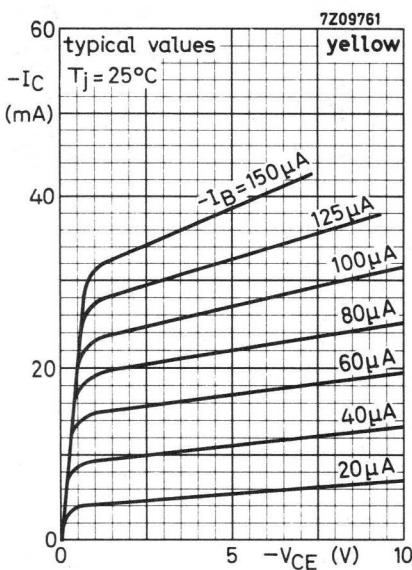
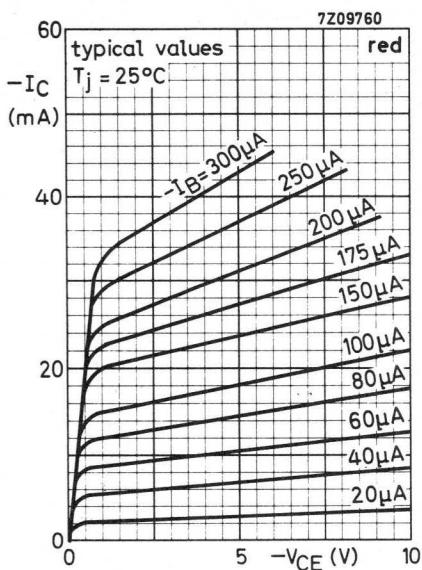
R _S = 2 kΩ	typ. 2	1.5	2 dB
Bandwidth: f = 30 Hz to 15 kHz	<	4	- dB

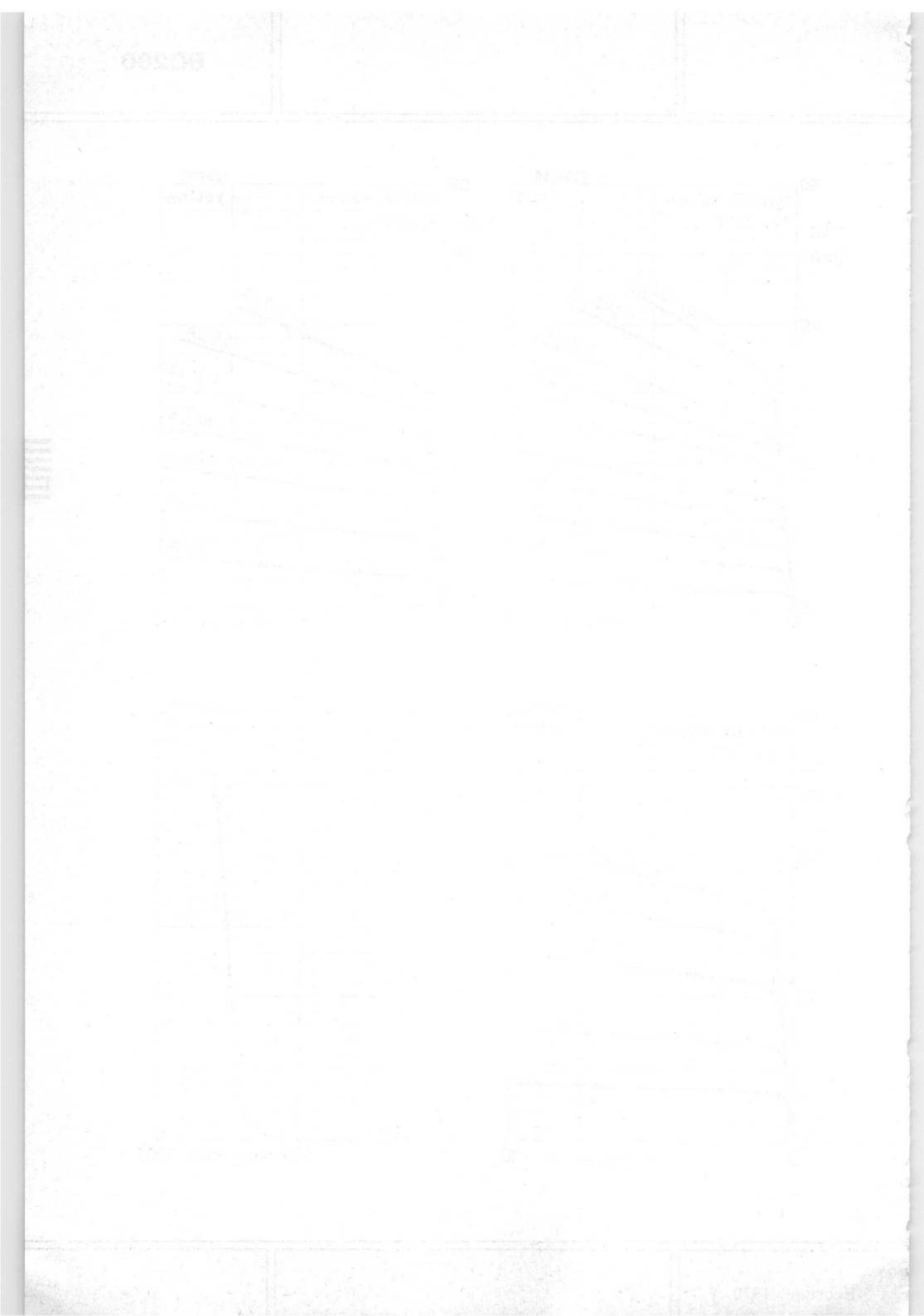
Bandwidth: f = 30 Hz to 15 kHz

F	typ. 2	1.5	2 dB
	<	4	- dB

7Z09763







A.F. SILICON PLANAR EPITAXIAL TRANSISTORS

N-P-N transistors in a plastic envelope.

The BC237 is primarily intended for use in driver stages of audio amplifiers and in signal processing circuits of television receivers.

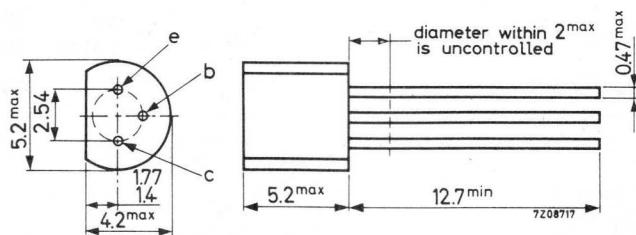
The BC238 is suitable for a multitude of low voltage applications e.g. driver stages or audio pre-amplifiers and in signal processing circuits of television receivers.

The BC239 is primarily intended for low noise input stages in tape recorders, hi-fi amplifiers and other audio frequency equipment.

QUICK REFERENCE DATA					
		BC237	BC238	BC239	
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	max. 50	30	30	V
Collector-emitter voltage (open base)	V_{CEO}	max. 45	20	20	V
Collector current (peak value)	I_{CM}	max. 200	200	200	mA
Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max. 300	300	300	mW
Junction temperature	T_j	max. 125	125	125	$^\circ\text{C}$
Small signal current gain at $T_j = 25^\circ\text{C}$ $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}; f = 1 \text{ kHz}$	h_{fe}	> 125 < 500	125 900	240 900	
Transition frequency at $f = 35 \text{ MHz}$ $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$	f_T	typ. 300	300	300	MHz
Noise figure at $R_S = 2 \text{ k}\Omega$ $I_C = 200 \mu\text{A}; V_{CE} = 5 \text{ V}$					
$f = 30 \text{ Hz to } 15 \text{ kHz}$	F	typ. <		1.4 4	dB dB
$f = 1 \text{ kHz}; B = 200 \text{ Hz}$	F	typ. 2	2	1.2	dB

MECHANICAL DATA

Dimensions in mm



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

<u>Voltages</u>		BC237	BC238	BC239
Collector-base voltage (open emitter)	V_{CBO}	max. 50	30	30 V
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	max. 50	30	30 V
Collector-emitter voltage (open base)	V_{CEO}	max. 45	20	20 V
Emitter-base voltage (open collector)	V_{EBO}	max. 6	5	5 V

Currents

Collector current (d.c.)	I_C	max.	100	mA
Collector current (peak value)	I_{CM}	max.	200	mA
Emitter current (peak value)	$-I_{EM}$	max.	200	mA
Base current (peak value)	I_{BM}	max.	200	mA

Power dissipation

Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max.	300	mW
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Temperatures

Storage temperature	T_{stg}	-65 to +125	$^\circ\text{C}$
Junction temperature	T_j	max.	125 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to ambient in free air	$R_{th \ j-a}$	=	0.33	$^\circ\text{C}/\text{mW}$
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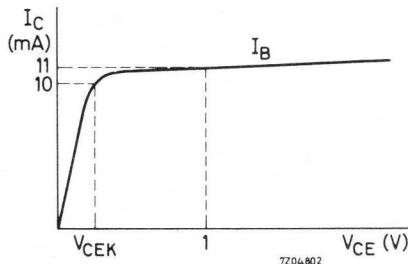
CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current

$I_E = 0$; $V_{CB} = 20$ V; $T_j = 125^\circ\text{C}$	I_{CBO}	<	15	μA
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Base-emitter voltage ¹⁾

$I_C = 2$ mA; $V_{CE} = 5$ V	V_{BE}	typ.	620	mV
$I_C = 10$ mA; $V_{CE} = 5$ V	V_{BE}	<	770	mV

1) V_{BE} decreases by about 2 mV/ $^\circ\text{C}$ with increasing temperature.

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedSaturation voltages ¹⁾ $I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$ V_{CEsat} typ. 90 mV
 $< 250 \text{ mV}$ V_{BEsat} typ. 700 mV $I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$ V_{CEsat} typ. 200 mV
 $< 600 \text{ mV}$ V_{BEsat} typ. 900 mVKnee voltage $I_C = 10 \text{ mA}; I_B = \text{value for which}$ $I_C = 11 \text{ mA at } V_{CE} = 1 \text{ V}$ V_{CEK} typ. 330 mV
 $< 600 \text{ mV}$ Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 10 \text{ V}$ C_C typ. 2.5 pF
 $< 4.5 \text{ pF}$ Emitter capacitance at $f = 1 \text{ MHz}$ $I_C = I_e = 0; V_{EB} = 0.5 \text{ V}$ C_e typ. 9 pFTransition frequency at $f = 35 \text{ MHz}$ $I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$ f_T typ. 300 MHzSmall signal current gain at $f = 1 \text{ kHz}$ $I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$ $\frac{\text{BC237}}{\text{BC238}}$ | $\frac{\text{BC238}}{\text{BC239}}$

h_{fe}	$>$	125	125	240
	$<$	500	900	900

Noise figure at $R_S = 2 \text{ k}\Omega$ $I_C = 200 \mu\text{A}; V_{CE} = 5 \text{ V}$

F	typ.		1.4 dB
	$<$		4 dB

 $f = 30 \text{ Hz to } 15 \text{ kHz}$

F	typ.	2	2	1.2 dB
	$<$	10	10	4 dB

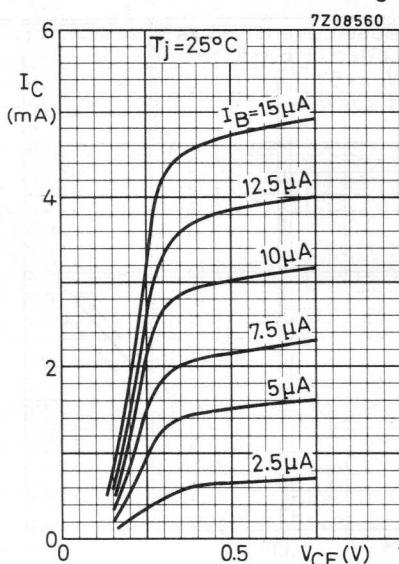
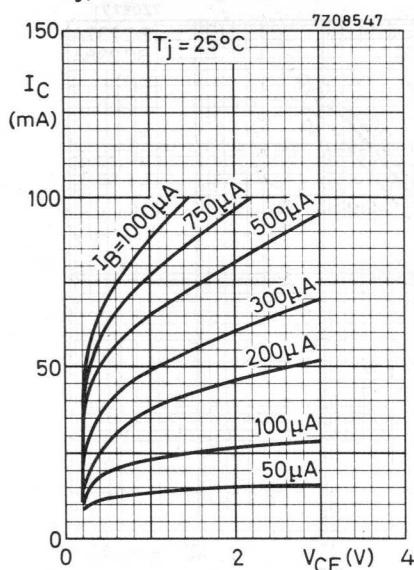
1) V_{BEsat} decreases by about 1.7 mV/ $^\circ\text{C}$ with increasing temperature.

CHARACTERISTICS (continued)

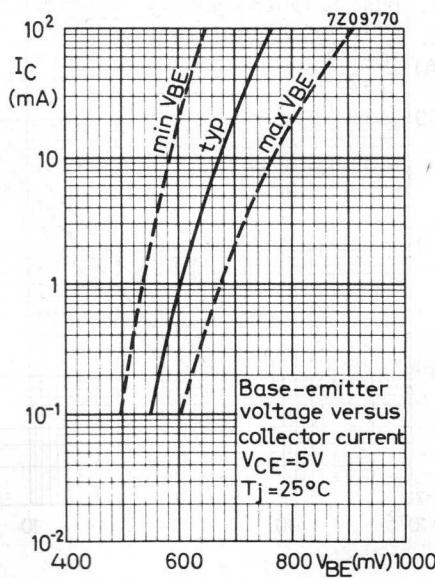
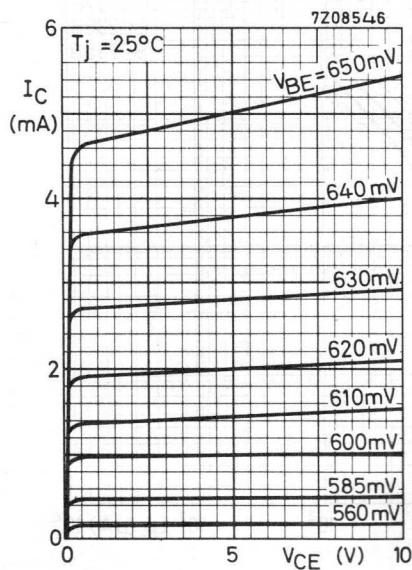
 $T_j = 25^\circ\text{C}$ unless otherwise specified

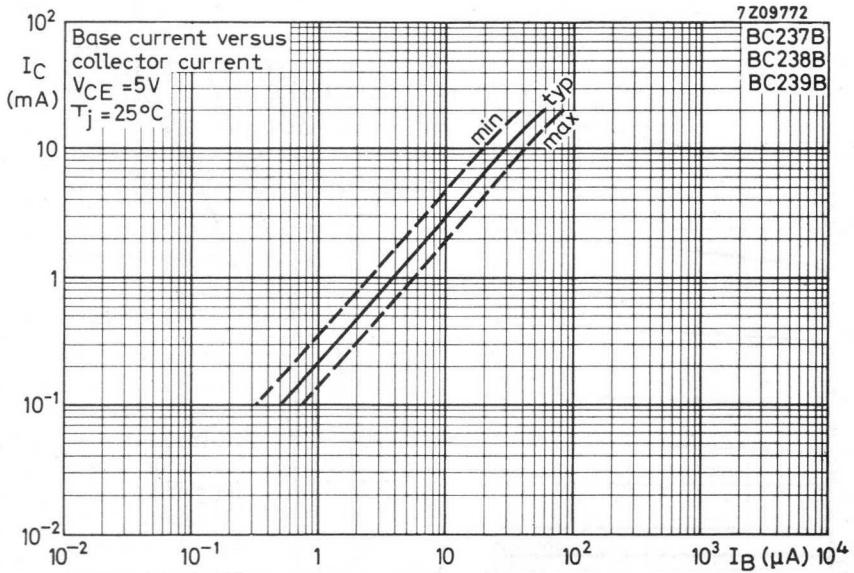
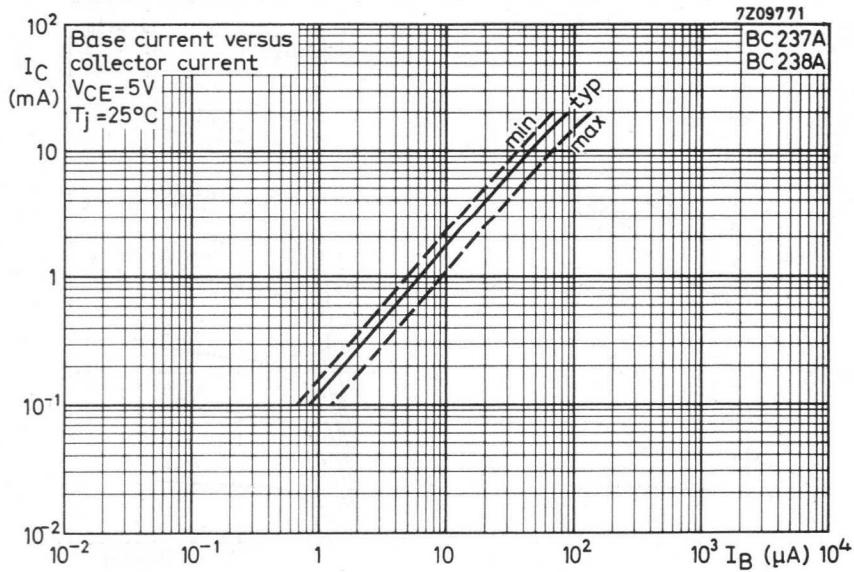
			BC237A BC238A	BC237B BC238B	BC238C BC239C
<u>D.C. current gain</u>					
$I_C = 10 \mu\text{A}; V_{CE} = 5 \text{ V}$	h_{FE}	typ. 90	150	270	
		> 110	200	420	
$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	h_{FE}	typ. 180	290	520	
		< 220	450	800	
<u>h parameters at $f = 1 \text{ kHz}$ (common emitter)</u>					
$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$					
Input impedance	h_{ie}	> 1.6 typ. 2.7 < 4.5	3.2 4.5 8.5	6 $\text{k}\Omega$ 8.7 $\text{k}\Omega$ 15 $\text{k}\Omega$	
Reverse voltage transfer ratio	h_{re}	typ. 1.5	2	3 10^{-4}	
		> 125	240	450	
Small signal current gain	h_{fe}	typ. 220	330	600	
		< 260	500	900	
Output admittance	h_{oe}	typ. 18	30	60 $\mu\Omega^{-1}$	
		< 30	60	110 $\mu\Omega^{-1}$	

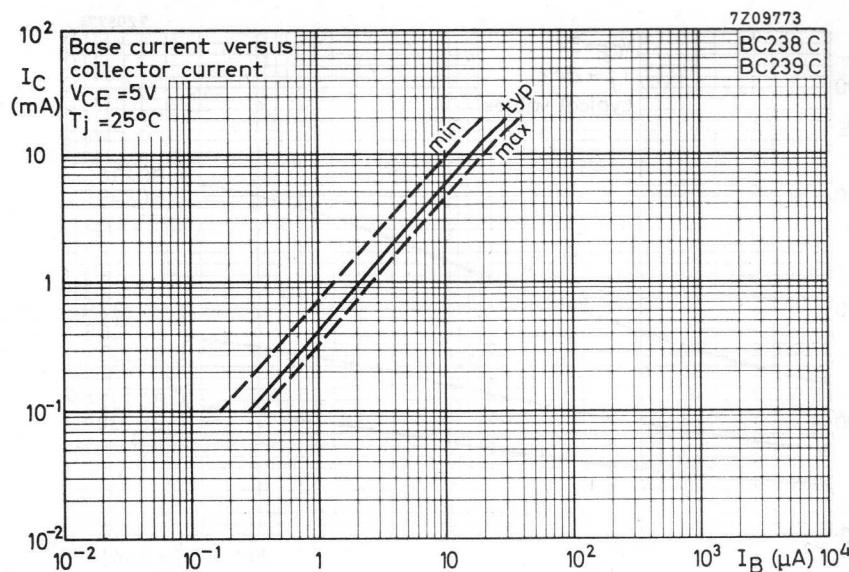
Typical behaviour of collector current versus collector-emitter voltage



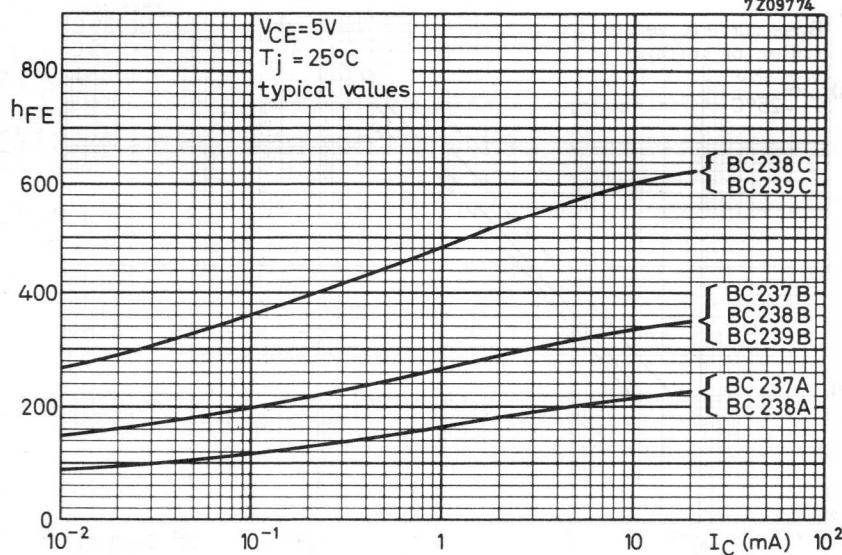
Typical behaviour of collector current versus collector-emitter voltage



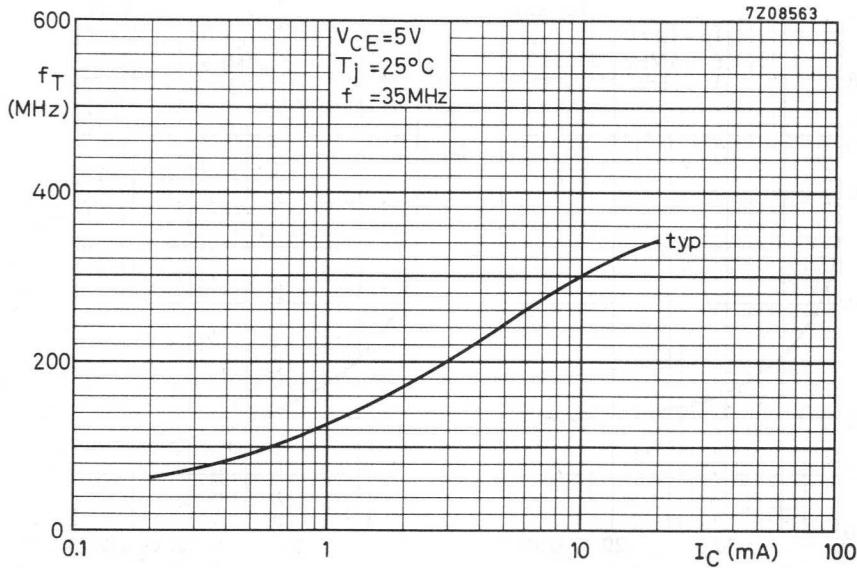




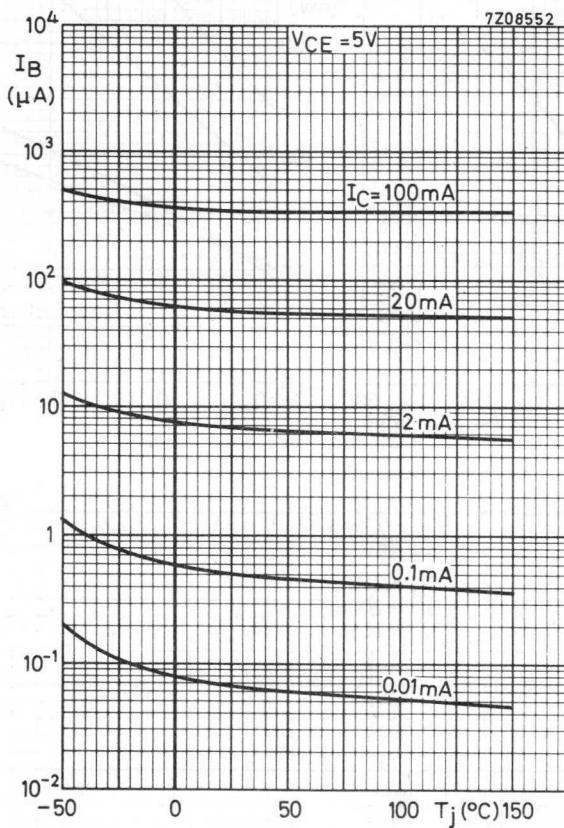
7 Z09774

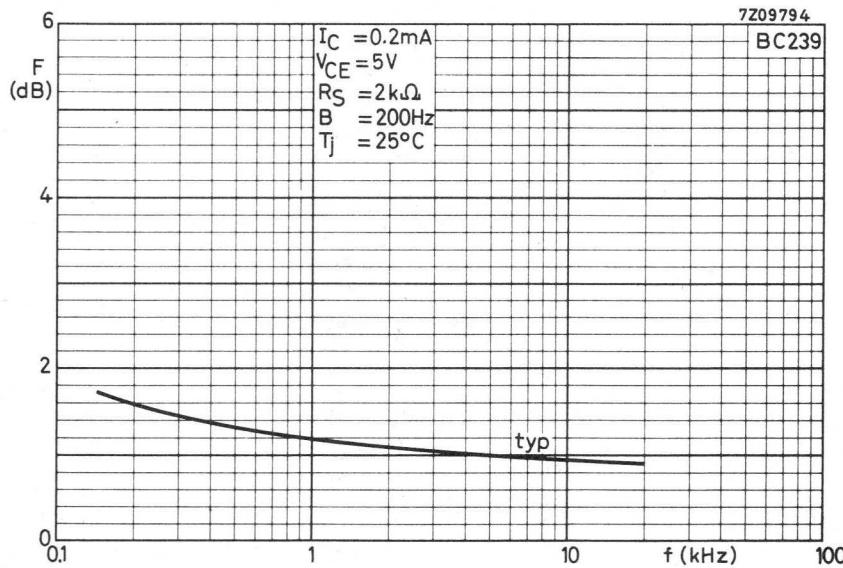
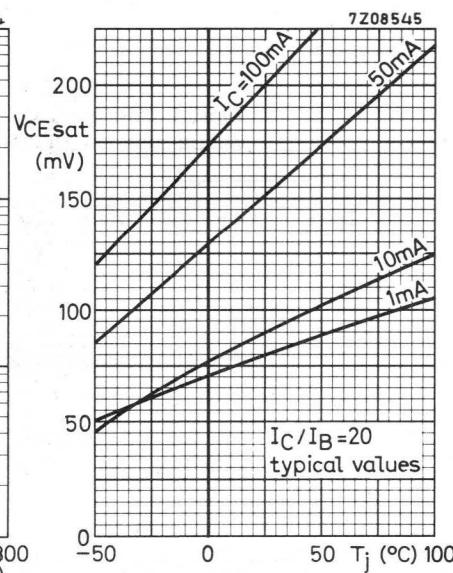
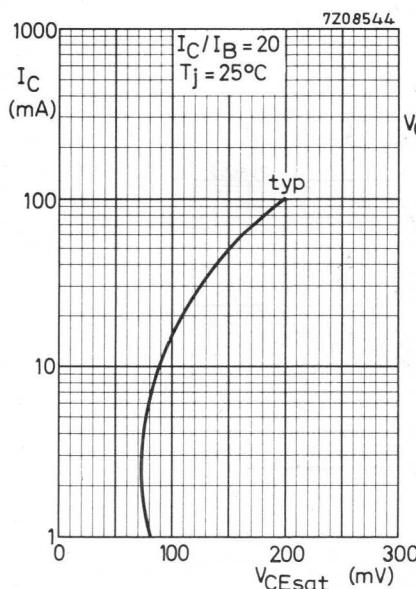


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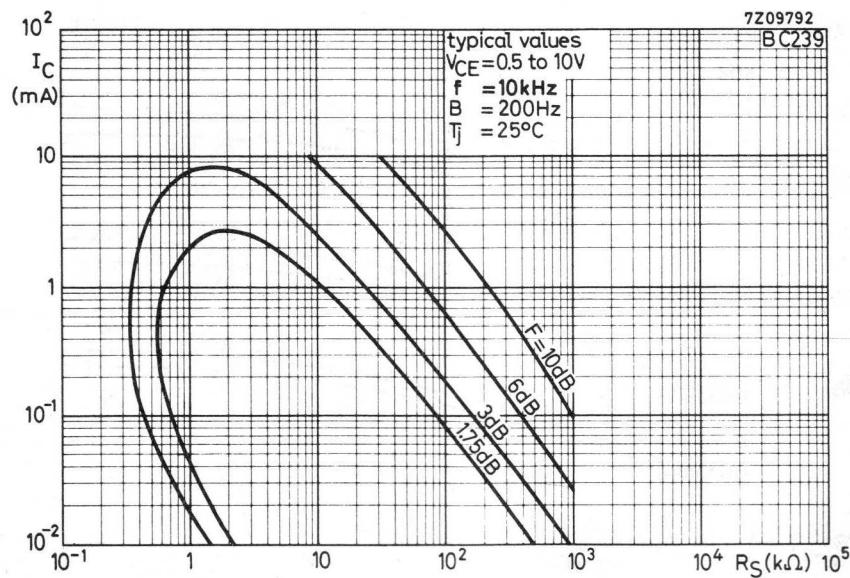
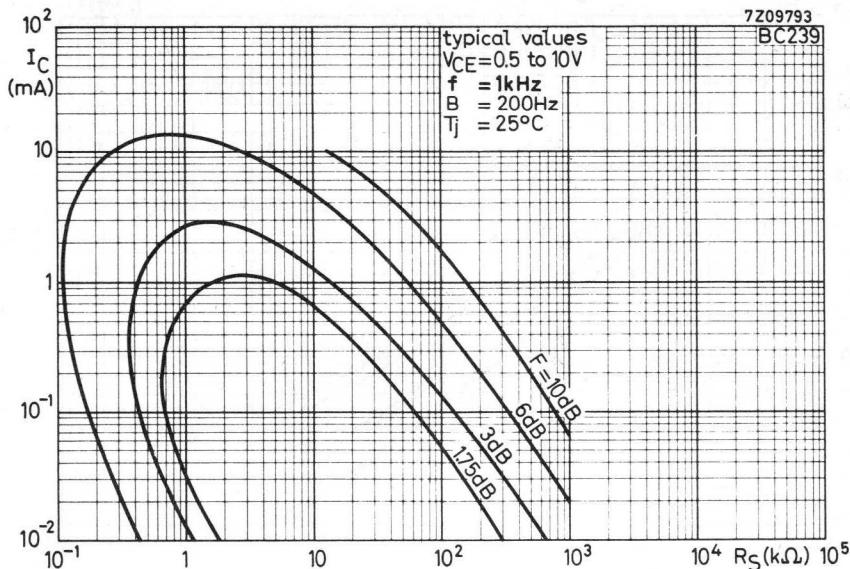


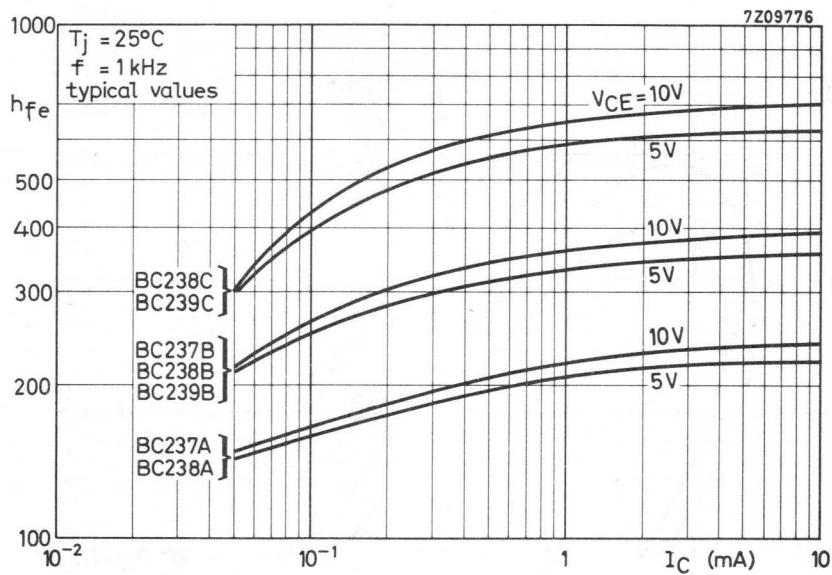
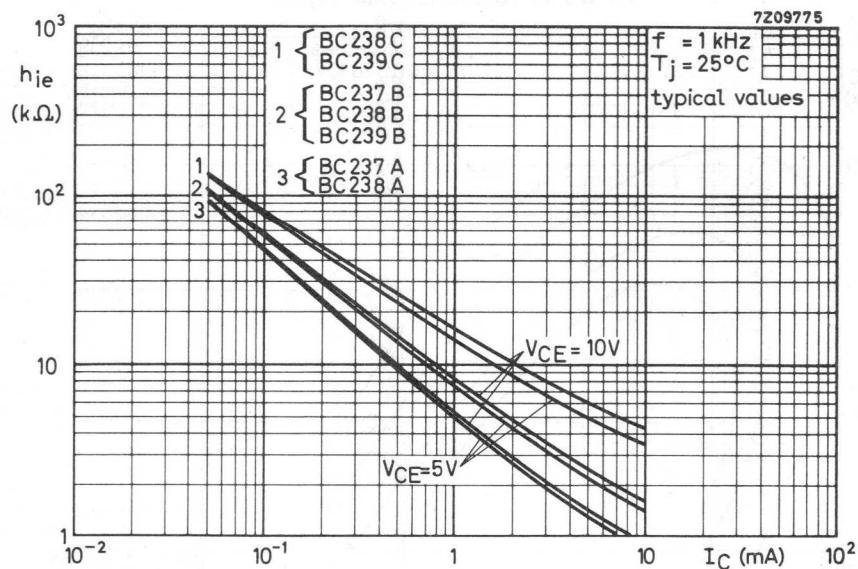
Typical behaviour of base current
versus junction temperature

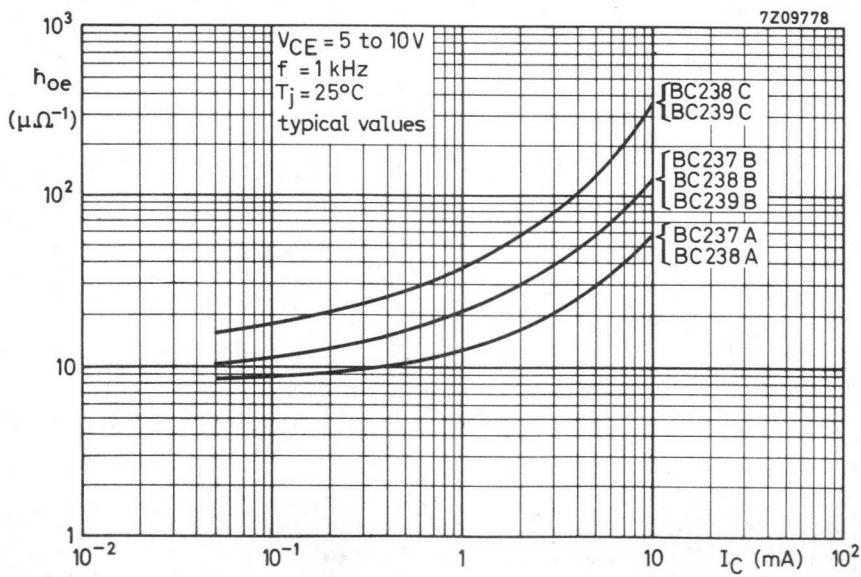
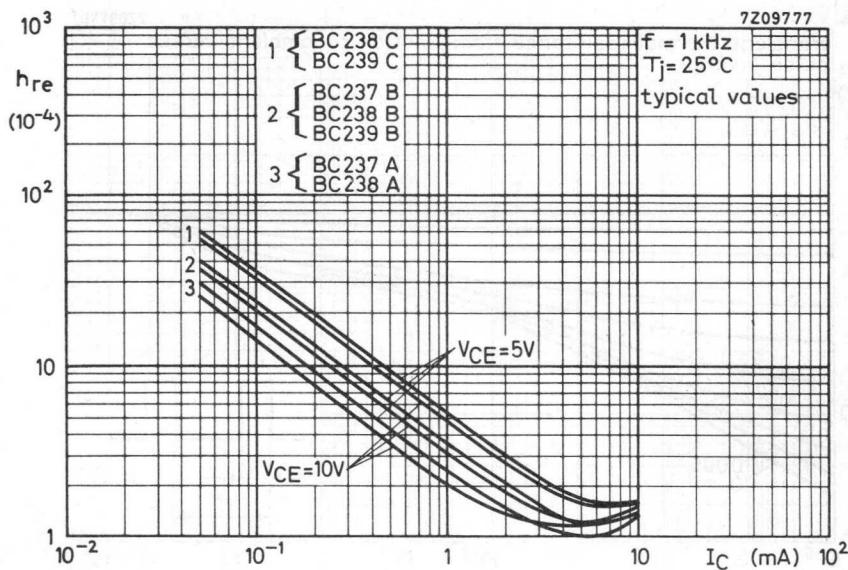


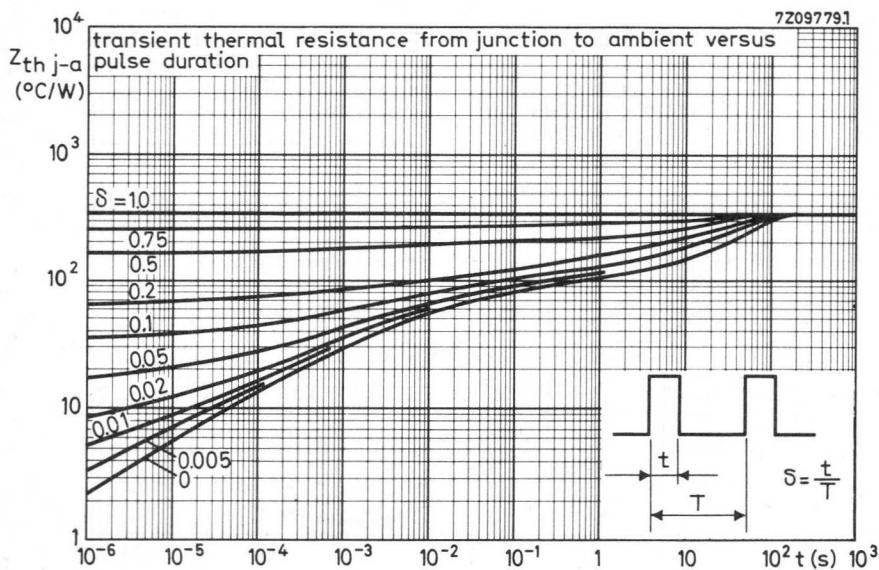


Curves of constant noise figure









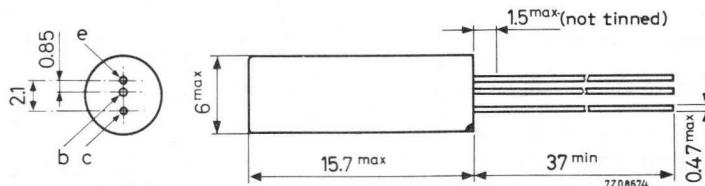
P-N-P SILICON TRANSISTOR

P-N-P alloy transistor in a metal envelope. It is intended for medium voltage and current industrial applications.

QUICK REFERENCE DATA					
		BCY10	BCY11	BCY12	V
Collector-base voltage (open emitter)	$-V_{CBO}$	max.	32	60	32
Collector current (peak value)	$-I_{CM}$	max.		500	mA
Total power dissipation up to $T_{amb} = 25^{\circ}\text{C}$ with cooling fin on a heatsink	P_{tot}	max.		415	mW
Junction temperature	T_j	max.		150	$^{\circ}\text{C}$
D.C. current gain at $T_j = 25^{\circ}\text{C}$ $-I_C = 150 \text{ mA}; -V_{CE} = 1 \text{ V}$	h_{FE}	typ.	15	15	25
Transition frequency $-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$	f_T	typ.	1.5	1.5	2.0 MHz

MECHANICAL DATA

Dimensions in mm



The coloured dot indicates the collector side

Accessories available: 56200; 56208; 56209; 56210; 56226; 56227.

RATINGS (Limiting values) ¹⁾

<u>Voltages</u>		BCY10	BCY11	BCY12
Collector-base voltage (open emitter)	-V _{CBO}	max. 32	60	32 V
Collector-emitter voltage ($V_{BE} = 0$)	-V _{CES}	max. 32	60	32 V
Emitter-base voltage (open collector)	-V _{EBO}	max. 12	12	12 V

Currents

Collector current (d.c. or average over any 20 ms period)	-I _C	max.	250	mA
Collector current (peak value)	-I _{CM}	max.	500	mA
Base current (d.c.)	-I _B	max.	125	mA
Emitter current (d.c. or average over any 20 ms period)	I _E	max.	250	mA
Emitter current (peak value)	I _{EM}	max.	500	mA

Power dissipation

Total power dissipation up to $T_{amb} = 25^{\circ}\text{C}$ with a cooling fin on 1.6 mm Al. heatsink of 7 cm x 7 cm	P _{tot}	max.	415	mW
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Temperatures

Storage temperature	T _{stg}	-55 to +150	$^{\circ}\text{C}$
Junction temperature	T _j	max.	150 $^{\circ}\text{C}$

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	=	0.4	$^{\circ}\text{C}/\text{mW}$
From junction to ambient with a cooling fin on a 1.6 mm Al. heatsink of 7 cm x 7 cm	R _{th j-a}	=	0.3	$^{\circ}\text{C}/\text{mW}$
From junction to case	R _{th j-c}	=	0.25	$^{\circ}\text{C}/\text{mW}$

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; -V_{CB} = 6 \text{ V}$
 $-I_{CBO}$ typ. 20 nA
 $<$ 100 nA
Emitter cut-off current $I_C = 0; -V_{EB} = 6 \text{ V}$
 $-I_{EBO}$ typ. 20 nA
 $<$ 100 nA
Base-emitter voltage at $-I_C = 150 \text{ mA}$ BCY10; BCY11 $-V_{CE} = 2 \text{ V}$
 $-V_{BE}$ typ. 1.0 V
 $<$ 1.6 V
BCY12 $-V_{CE} = 1 \text{ V}$ Saturation voltage $-I_C = 125 \text{ mA}; -I_B = 17 \text{ mA}$

	BCY10	BCY11	BCY12
$-V_{CEsat}$	typ. 250 $<$ -	250 -	250 mV 500 mV

D.C. current gain $-I_C = 30 \text{ mA}; -V_{CE} = 2 \text{ V}$
 h_{FE} > 12
typ. 24

 h_{FE} 12
24

 h_{FE} 40
 $-I_C = 150 \text{ mA}; -V_{CE} = 1 \text{ V}$
 h_{FE} > 10
typ. 15

 h_{FE} 10

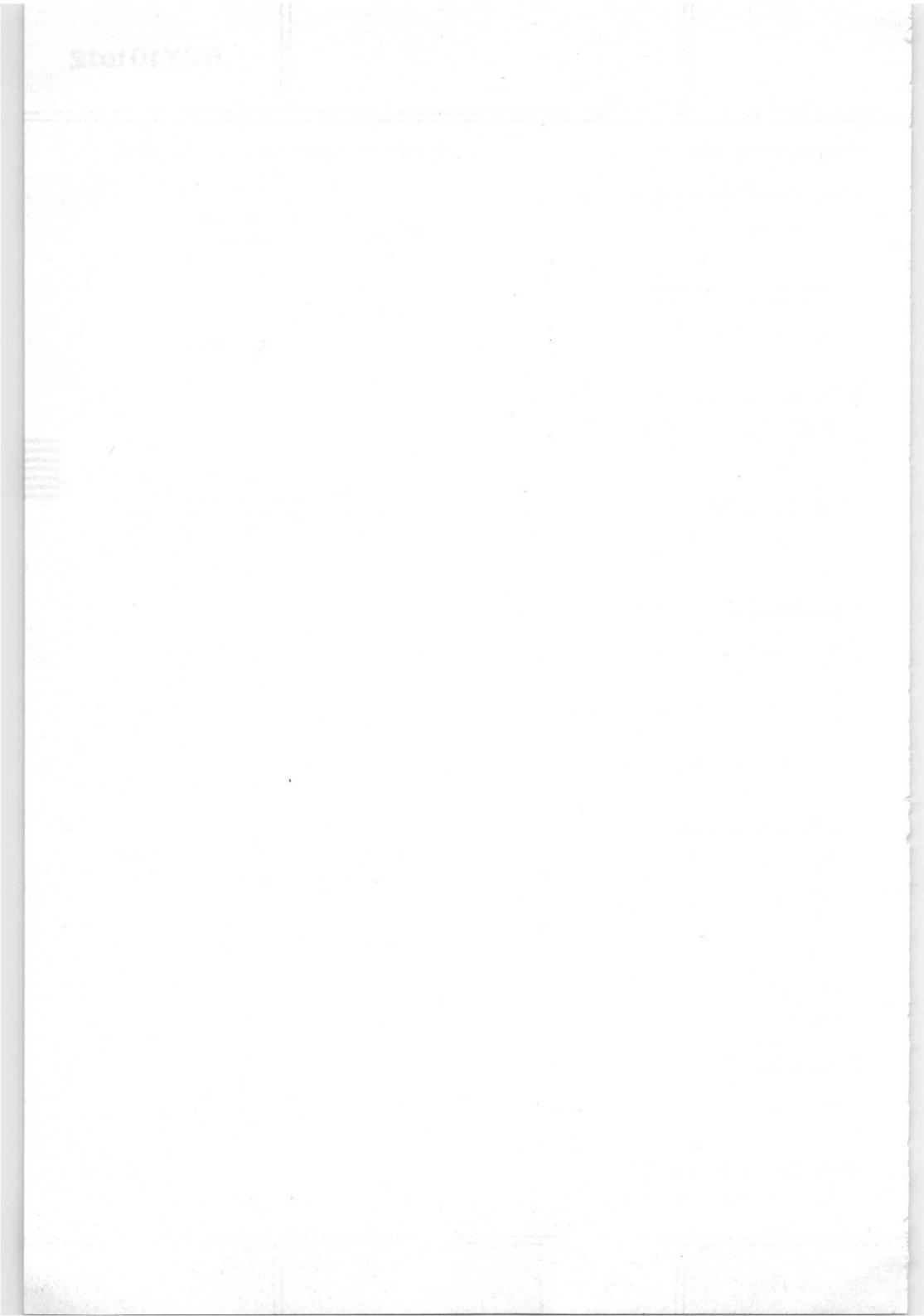
 h_{FE} 25
 $-I_C = 300 \text{ mA}; -V_{CE} = 6 \text{ V}$
 h_{FE} > -
typ. -

 h_{FE} -
-

 h_{FE} 15
Transition frequency $-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$
 f_T typ. 1.5

 f_T 1.5

 f_T 2.0 MHz
Collector-base capacitance $I_E = 0; -V_{CE} = 6 \text{ V}$ $C_{b'c}$ typ. 90 pFBase resistance $-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$ $r_{bb'}$ typ. 100 Ω Noise figure at $R_S = 500 \Omega$ $-I_C = 500 \mu\text{A}; -V_{CE} = 2 \text{ V}$
 F typ. 7 dB
 $<$ 20 dB
Small signal current gain $-I_C = 10 \text{ mA}; -V_{CE} = 6 \text{ V}$ h_{fe} typ. 40



P-N-P SILICON TRANSISTORS

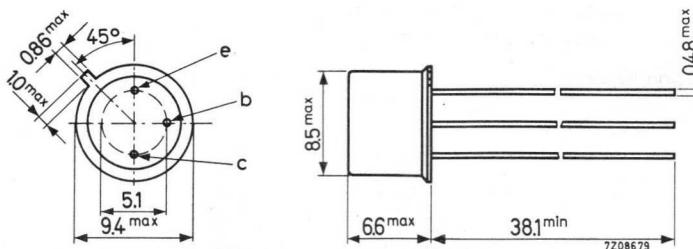
Silicon alloy p-n-p transistors in TO-5 metal case with insulated leads for relay switching, resistor logic circuits and general industrial applications.

QUICK REFERENCE DATA								
		BCY 30	BCY 31	BCY 32	BCY 33	BCY 34		
Collector-base voltage (open emitter)	-V _{CBO}	max.	64	64	64	32	32	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	50	50	50	25	25	V
Collector current (peak value)	-I _{CM}	max.	100	100	100	100	100	mA
Total power dissipation up to T _{case} = 62.5 °C	P _{tot}	max.	250	250	250	250	250	mW
Junction temperature	T _j	max.	150	150	150	150	150	°C
Small signal current gain f = 1 kHz; T _j = 25 °C -I _C = 1 mA; -V _{CE} = 6 V	h _{fe}	typ.	25	35	55	25	35	
Transition frequency -I _C = 1 mA; -V _{CE} = 6 V	f _T	typ.	1.2	1.7	2.5	1.5	2.4	MHz
Thermal resistance	R _{th j-a}	=	0.5	0.5	0.5	0.5	0.5	°C/mW

MECHANICAL DATA

Dimensions in mm

TO-5



Accessories available: 56218, 56245, 56265

RATINGS (Limiting values) ¹⁾Voltages

				BCY 30	BCY 31	BCY 32	BCY 33	BCY 34	
Collector-base voltage (open emitter)	-VCBO	max.	64	64	64	32	32	32	V
Collector-emitter voltage (open base)	-VCEO	max.	50	50	50	25	25	25	V
Collector-emitter voltage (cut-off; see page 9)	-VCEX	max.	64	64	64	32	32	32	V
Emitter-base voltage (open collector)	-VETO	max.	45	45	32	16	16	16	V

Currents

Collector current (d.c. or average over any 20 ms period)	-IC	max.	50	mA
Collector current (peak value)	-ICM	max.	100	mA
Base current (d.c. or average over any 20 ms period)	-IB	max.	15	mA
Base current (peak value)	-IBM	max.	50	mA

Power dissipation

Total power dissipation up to T _{case} = 62.5 °C	P _{tot}	max.	250	mW
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Temperatures

Storage temperature	T _{stg}	-55 to +150	°C
Junction temperature	T _j	max.	150 °C

THERMAL RESISTANCE

From junction to ambient in free air without cooling clip	R _{th j-a}	=	0.5	°C/mW
From junction to case	R _{th j-c}	=	0.35	°C/mW

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICST_{amb} = 25 °C unless otherwise specifiedCollector cut-off currentI_E = 0; -V_{CB} = 6 V-I_{CBO} typ. < 1.0 nA
50 nAEmitter cut-off currentI_C = 0; -V_{EB} = 6 V-I_{EBO} typ. < 1.0 nA
50 nAI_C = 0; -V_{EB} = 6 V; T_j = 100 °C-I_{EBO} typ. < 0.1 μA
2.5 μASaturation voltages-I_C = 20 mA; -I_B = 3 mA-V_{CESat} typ. < 160 mV
550 mV-V_{BESat} typ. < 0.8 V
1.25 VCollector capacitanceI_E = I_e = 0; -V_{CB} = 6 VC_c > 15 pF
typ. 28 pF
< 60 pFNoise figure at f = 1 kHzI_E = 500 μA; -V_{CE} = 2 V; R_S = 500 ΩF typ. < 8.0 dB
20 dBD.C. current gain-I_C = 20 mA; -V_{CE} = 4.5 V

	BCY 30	BCY 31	BCY 32	BCY 33	BCY 34
>	10	15	20	10	15
h _{FE} typ.	18	28	35	18	28
<	35	60	70	35	60

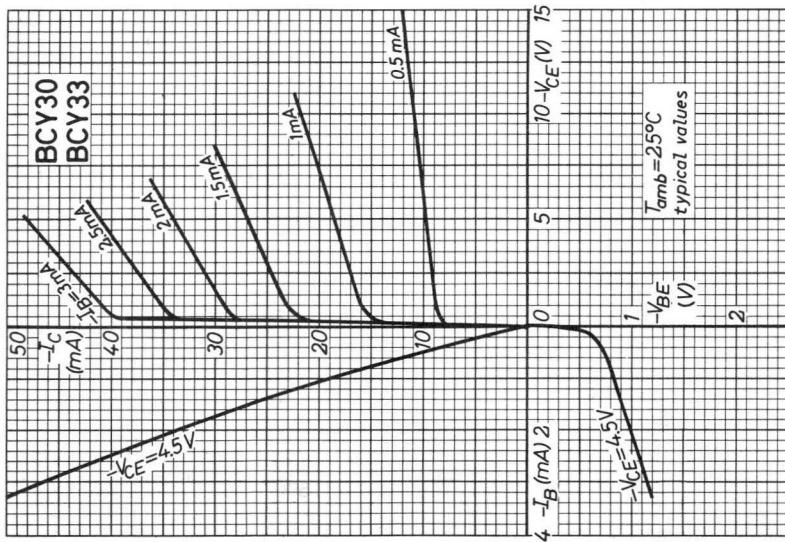
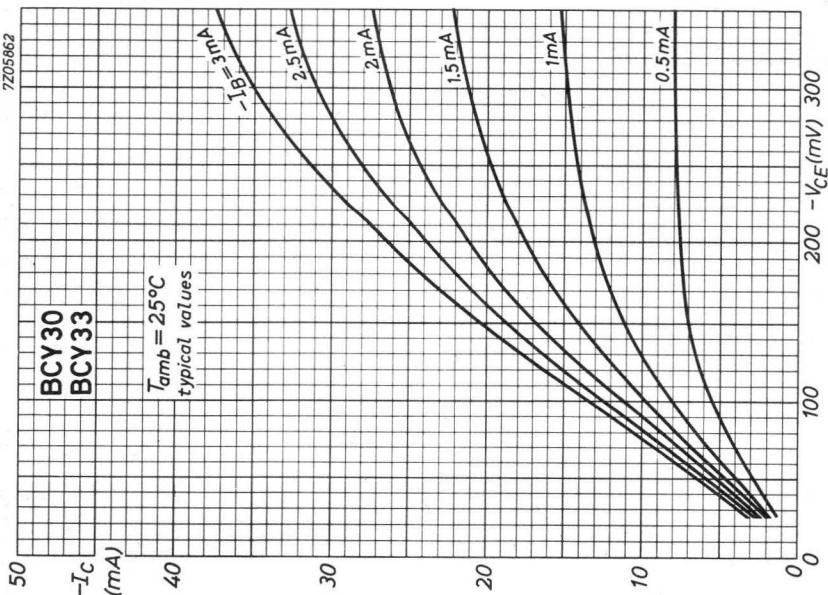
	BCY 30	BCY 31	BCY 32	BCY 33	BCY 34
>	15	25	35	15	25
h _{fe} typ.	25	35	55	25	35
<	35	60	80	35	60

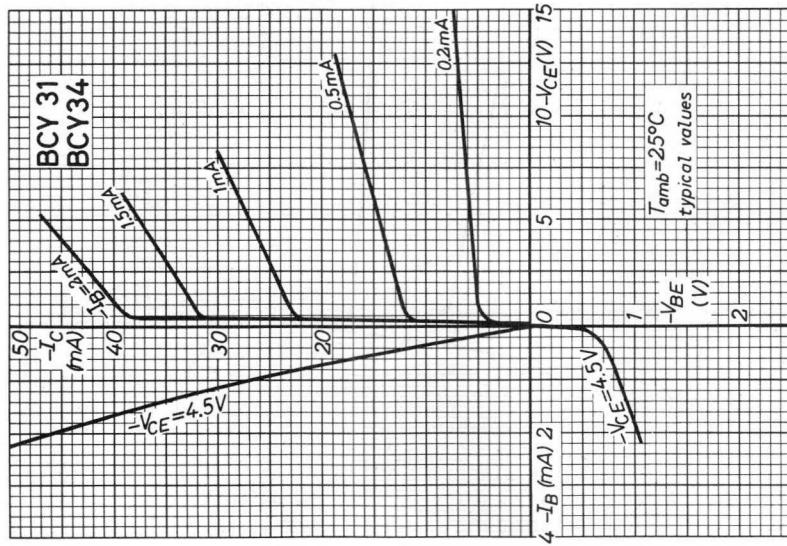
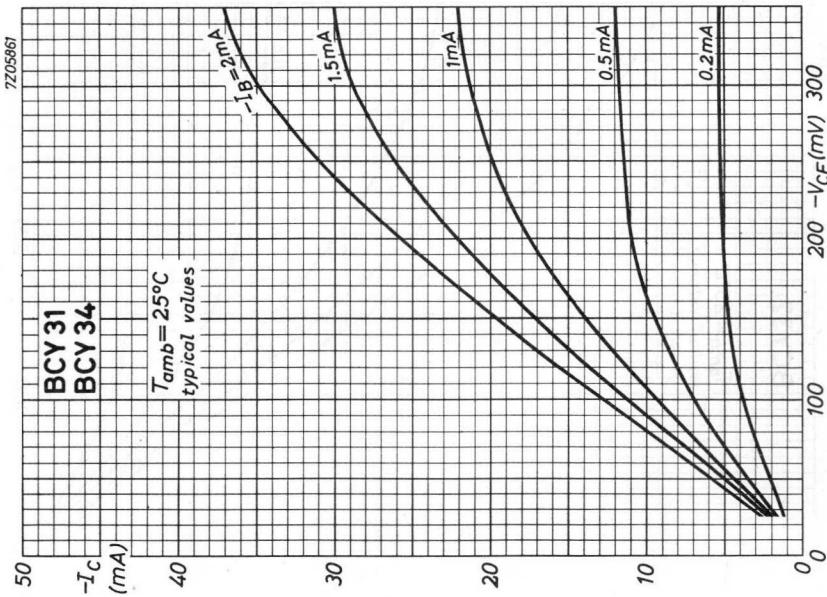
Small signal current gain-I_C = 1 mA; -V_{CE} = 6 V
f = 1 kHz

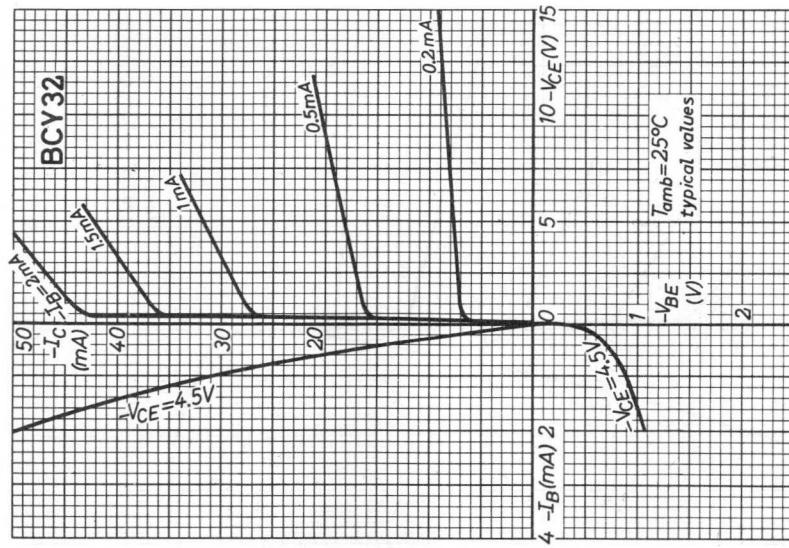
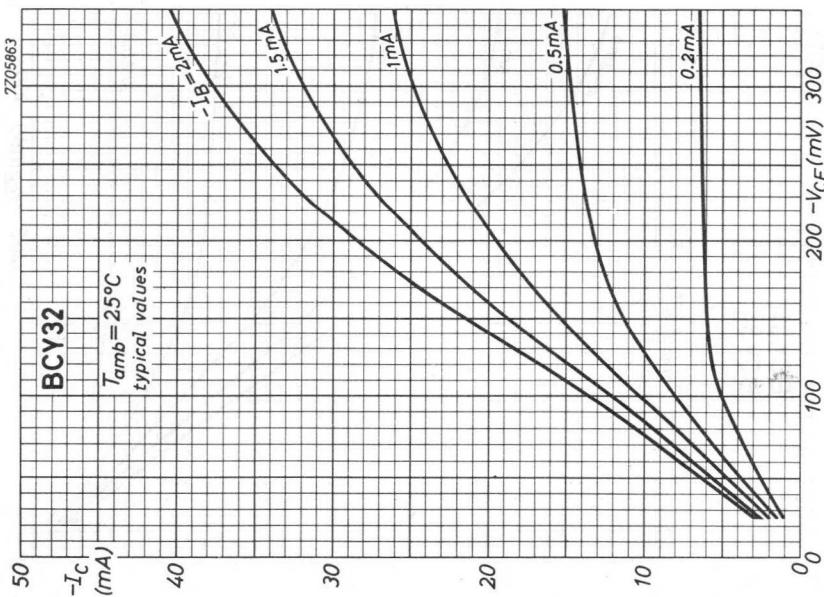
	BCY 30	BCY 31	BCY 32	BCY 33	BCY 34
>	15	25	35	15	25
h _{fe} typ.	25	35	55	25	35
<	35	60	80	35	60

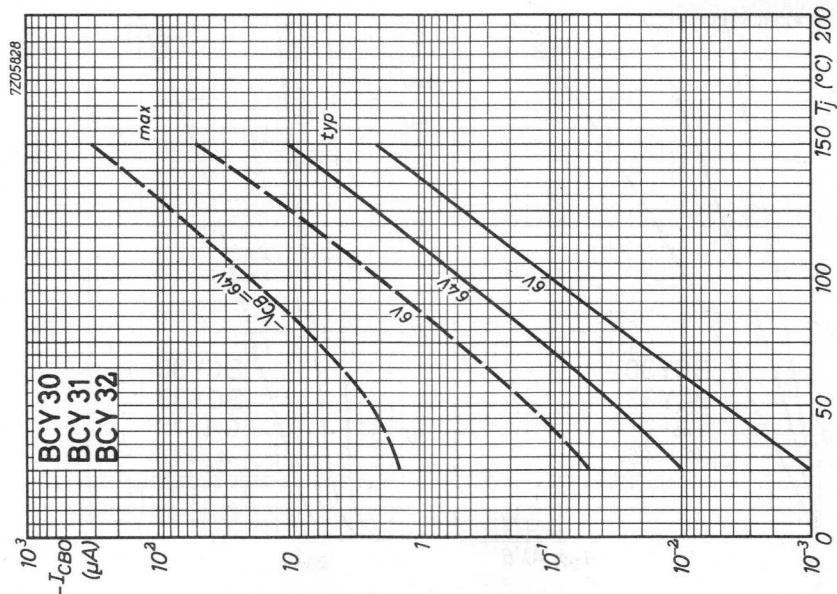
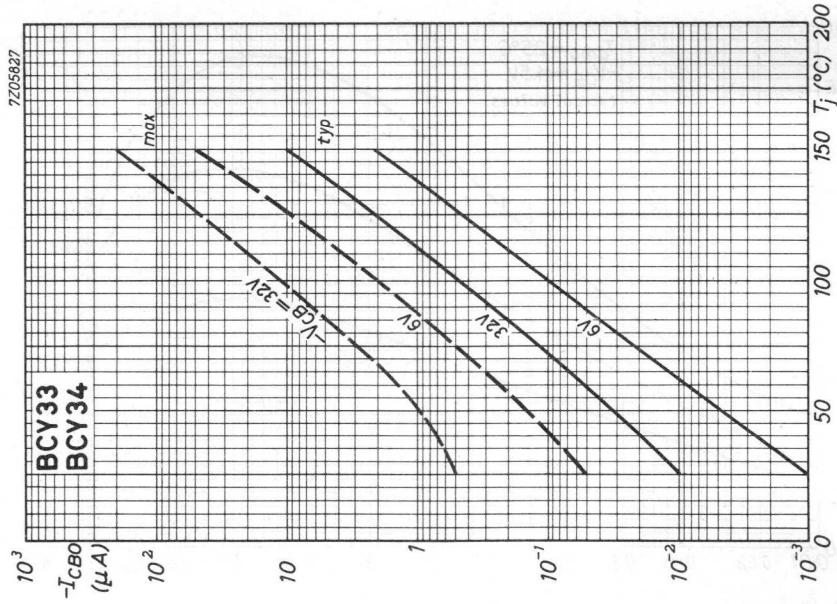
Feedback impedance-I_C = 1 mA; -V_{CE} = 6 V
f = 1 kHz|z_{rb}| typ. 160 Ω
500 ΩTransition frequency-I_C = 1 mA; -V_{CE} = 6 Vf_T typ. 0.25 MHz
1.2 MHz

BCY30to34

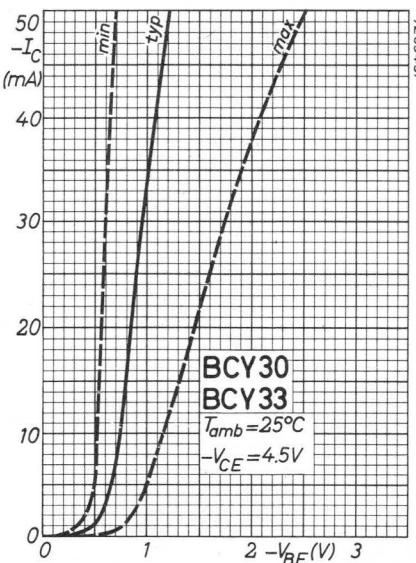
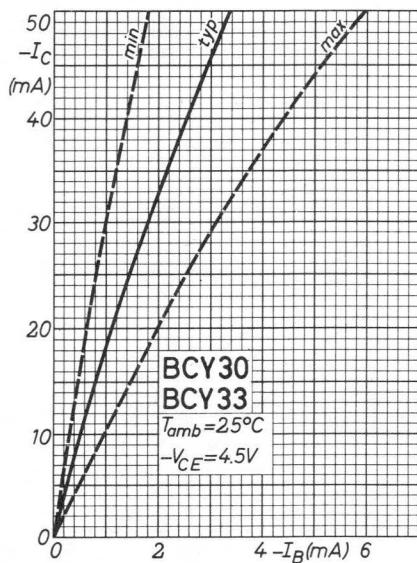
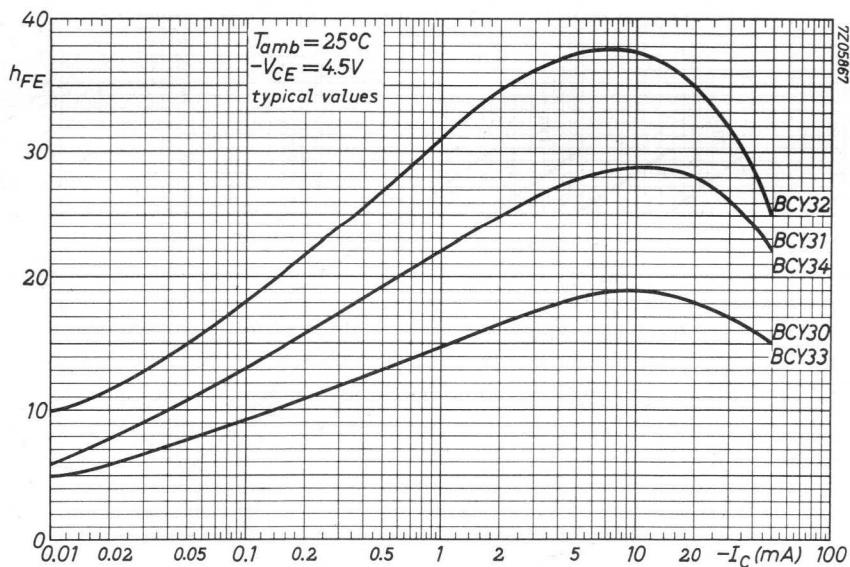


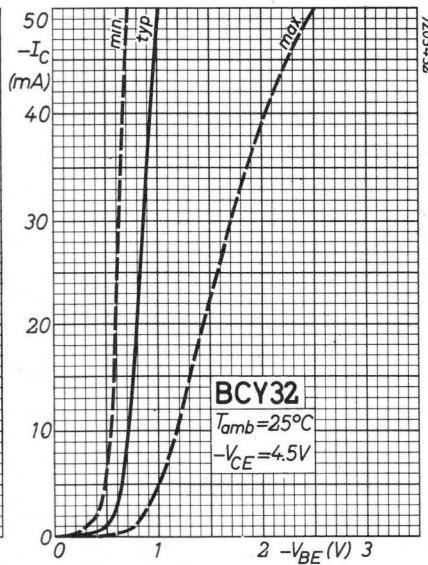
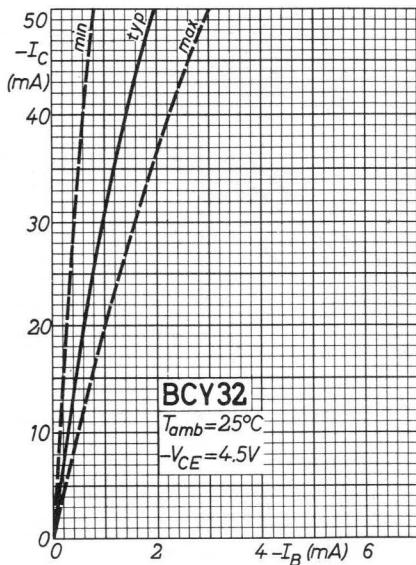
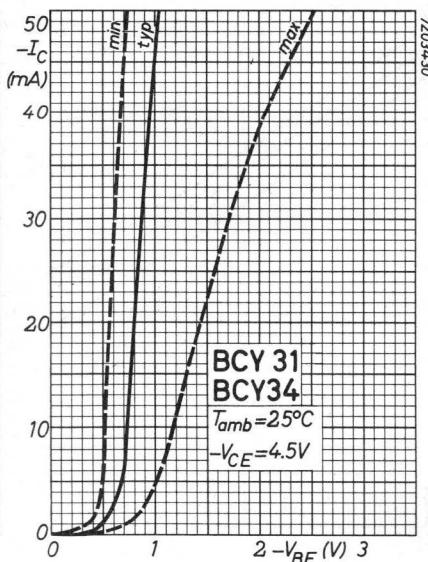
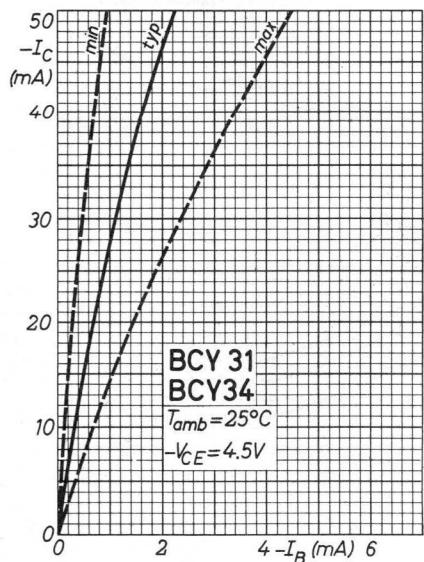


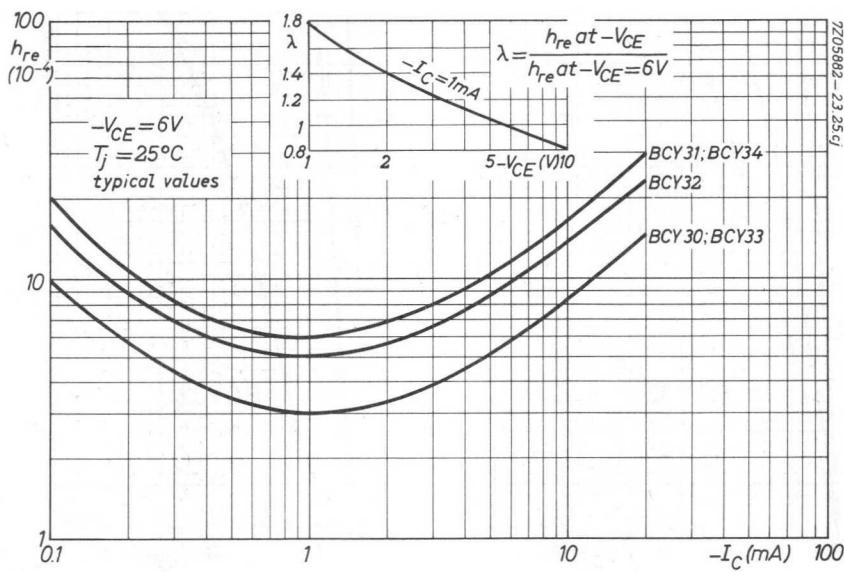
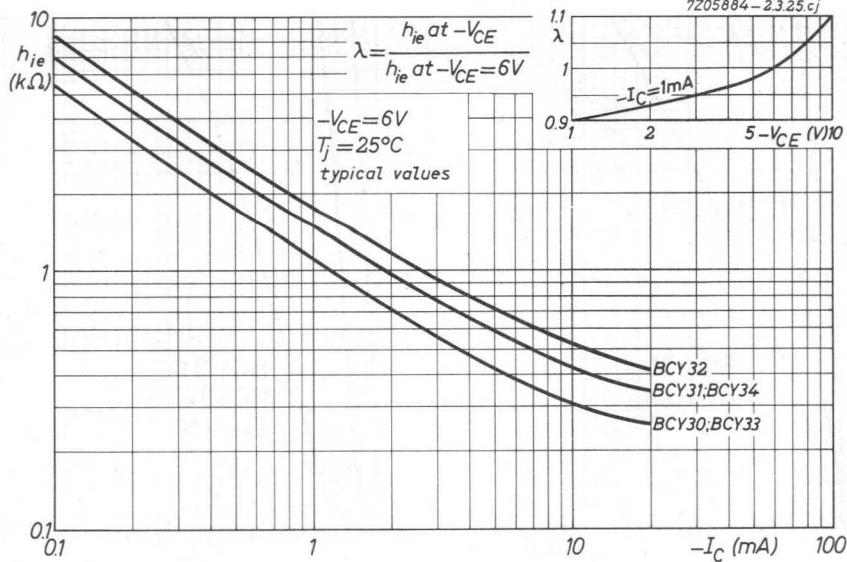


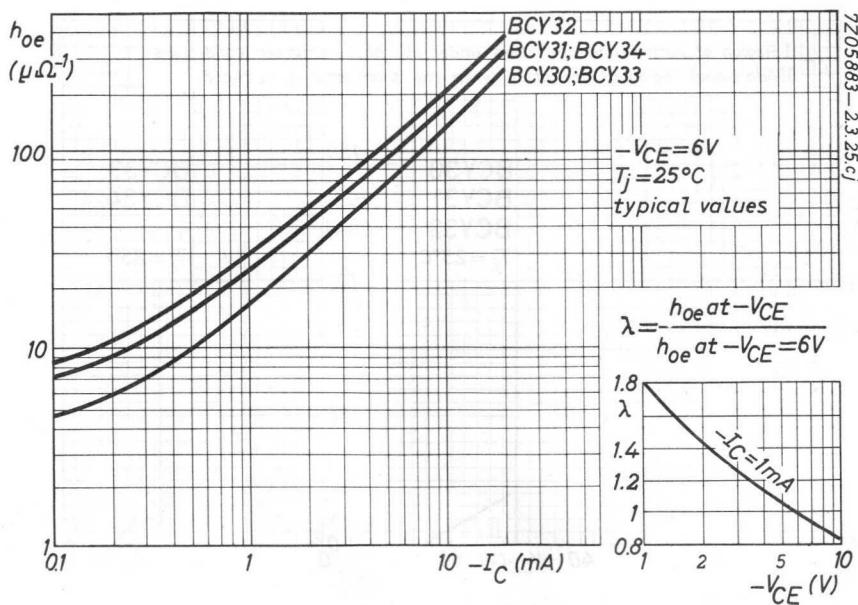
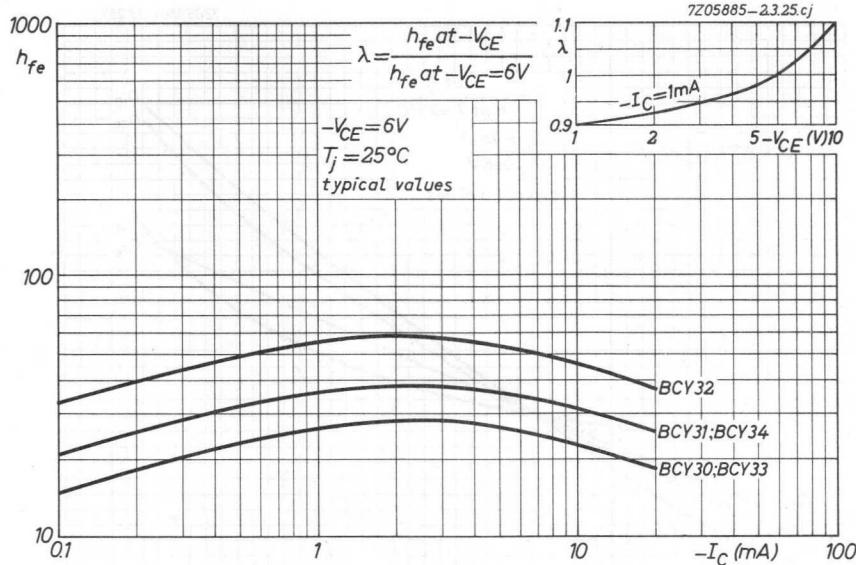


BCY30to34

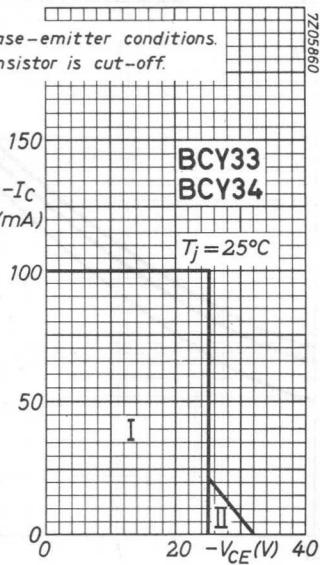
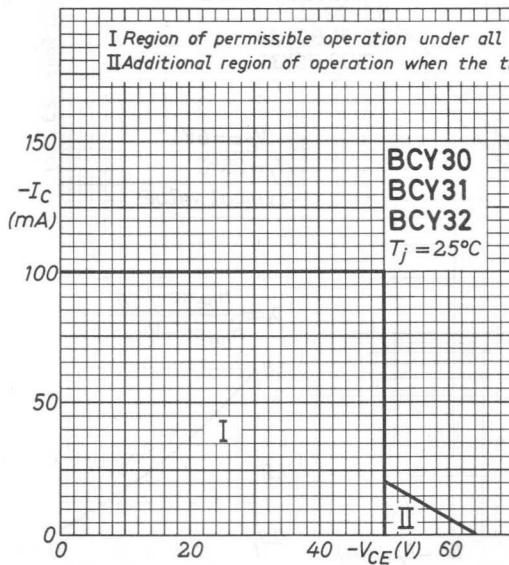
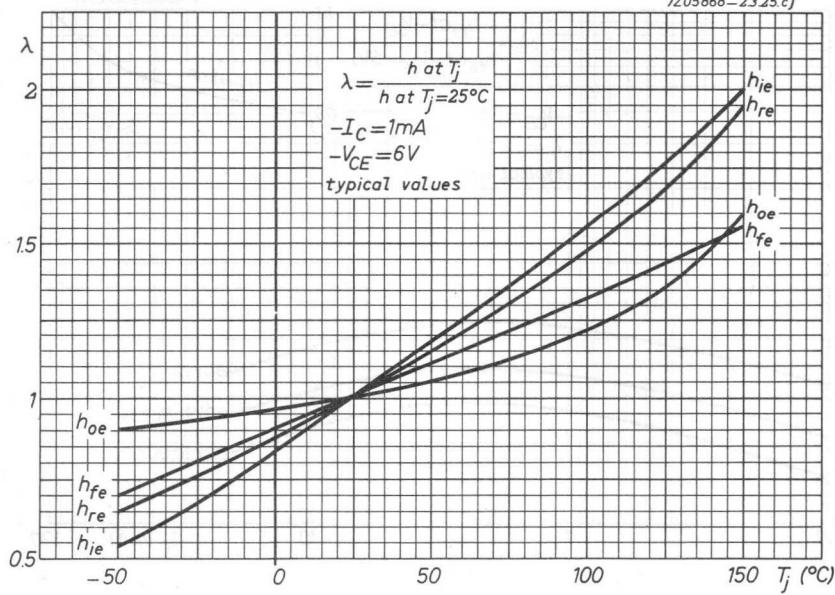








7Z05868-23.25.cj



P-N-P SILICON TRANSISTORS

P-N-P alloy transistors in a TO-5 metal envelope with the base connected to the case. They are intended for relay switching, resistor logic circuits and general industrial applications.

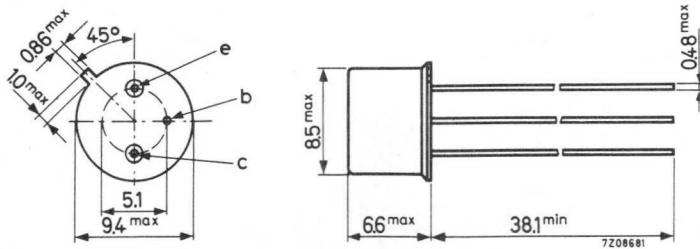
QUICK REFERENCE DATA					
		BCY 38	BCY 39	BCY 40	BCY 54
Collector-base voltage (open emitter)	$-V_{CBO}$	max. 32	64	32	50 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max. 24	60	24	50 V
Collector current (peak value)	$-I_{CM}$	max. 500	500	500	500 mA
Total power dissipation up to $T_{amb} = 25^{\circ}\text{C}$	P_{tot}	max. 410	410	410	410 mW
Junction temperature	T_j	max. 150	150	150	150 $^{\circ}\text{C}$
D.C. current gain at $T_{amb} = 25^{\circ}\text{C}$ $-I_C = 150 \text{ mA}; -V_{CE} = 1 \text{ V}$	h_{FE}	> 10 < 30	10 50	10 120	15 70
Transition frequency $-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$	f_T	typ. 1.5	1.5	2.5	2.0 MHz

MECHANICAL DATA

Dimensions in mm

TO-5

Base connected to case



Accessories available: 56218, 56245, 56265

BCY38 to 40**BCY54****RATINGS (Limiting values)¹⁾**Voltages

			BCY 38	BCY 39	BCY 40	BCY 54	V
Collector-base voltage (open emitter)	-V _{CBO}	max.	32	64	32	50	
Collector-emitter voltage (open base)	-V _{CCEO}	max.	24	60	24	50	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	12	12	12	12	V

Currents

Collector current (d.c. or average over any 20 ms period)	-I _C	max.	250	mA
Collector current (peak value)	-I _{CM}	max.	500	mA
Base current (d.c.)	-I _B	max.	125	mA
Base current	-I _{BM}	max.	125	mA

Power dissipation

Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max.	410	mW
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Temperatures

Storage temperature	T _{stg}	-55 to +150	°C
Junction temperature	T _j	max.	150 °C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	=	0.3	°C/mW
From junction to case	R _{th j-c}	=	0.12	°C/mW

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_{amb} = 25^{\circ}\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; -V_{CB} = 6 \text{ V}$ $-I_{CBO}$ typ. 1 nA
< 100 nA $I_E = 0; -V_{CB} = 6 \text{ V}; T_j = 100^{\circ}\text{C}$ $-I_{CBO}$ typ. 0.1 μA
< 2.5 μA Emitter cut-off current $I_C = 0; -V_{EB} = 6 \text{ V}$ $-I_{EBO}$ typ. 1 nA
< 100 nA $I_C = 0; -V_{EB} = 6 \text{ V}; T_j = 100^{\circ}\text{C}$ $-I_{EBO}$ typ. 0.1 μA
< 2.5 μA Base current $V_{CB} = 0; I_E = 150 \text{ mA}$ $-I_B$

	BCY38	BCY39	BCY40	BCY54
>	5	3	1.25	2 mA
<	14	14	9	12 mA

Base-emitter voltage $-I_C = 150 \text{ mA}; -V_{CE} = 1 \text{ V}$ $-V_{BE}$ typ. 1.5
< 1.9 $-V_{BE}$ typ. 1.5
< 1.9 $-V_{BE}$ typ. 1.4
< 1.9 $-V_{BE}$ typ. 1.4
< 1.9Saturation voltages $-I_C = 150 \text{ mA}; -I_B = 15 \text{ mA}$ $-V_{CEsat}$ typ. 580
< 1100 $-V_{CEsat}$ typ. 460
< 1100 $-V_{CEsat}$ typ. 440
< 1100 $-V_{CEsat}$ typ. 440 mV
< 1100 mVD.C. current gain $-I_C = 30 \text{ mA}; -V_{CE} = 1 \text{ V}$ h_{FE} > 12
typ. 20
< - h_{FE} > 12
typ. 30
< - h_{FE} > 22
typ. 35
< - h_{FE} > 20
typ. 35
< 100 $-I_C = 150 \text{ mA}; -V_{CE} = 1 \text{ V}$ h_{FE} > 10
typ. 13
< 30 h_{FE} > 10
typ. 19
< 50 h_{FE} > 15
typ. 23
< 120 h_{FE} > 12
typ. 23
< 70 $-I_C = 300 \text{ mA}; -V_{CE} = 6 \text{ V}^1$ h_{FE} > -
typ. 10 h_{FE} > -
typ. 15 h_{FE} > 10
typ. 18 h_{FE} > -
typ. 18¹⁾ Measured under pulsed conditions to prevent excessive dissipation.

BCY38 to 40**BCY54****CHARACTERISTICS (continued)** $T_{amb} = 25^{\circ}\text{C}$ unless otherwise specifiedCollector capacitance at $f = 0.5 \text{ MHz}$ $I_E = I_e = 0; -V_{CB} = 6 \text{ V}$ C_C

BCY38 | BCY39 | BCY40 | BCY54

typ. 60

60

60

60

pF

< 150

150

150

150

pF

Transition frequency $-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$ f_T

> 0.45

0.45

0.85

0.45

MHz

typ. 1.5

1.5

2.5

2.0

MHz

Feedback impedance at $f = 0.5 \text{ MHz}$ $-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$ $|z_{rbl}|$

typ. 100

110

140

130

 Ω

< 250

250

250

250

 Ω Noise figure at $f = 1 \text{ kHz}$ $-I_C = 500 \mu\text{A}; -V_{CE} = 2 \text{ V}$ F

typ. 8

8

8

8

dB

 $R_S = 500 \Omega$

< 20

20

20

20

dB

Small signal current gain at $f = 1 \text{ kHz}$ $-I_C = 10 \text{ mA}; -V_{CE} = 6 \text{ V}$ h_{fe}

> 15

15

30

20

typ. 27

35

50

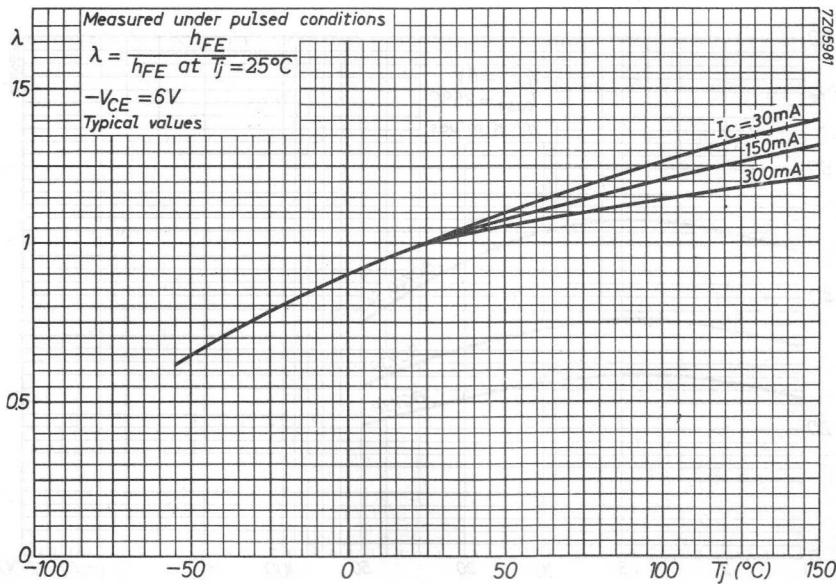
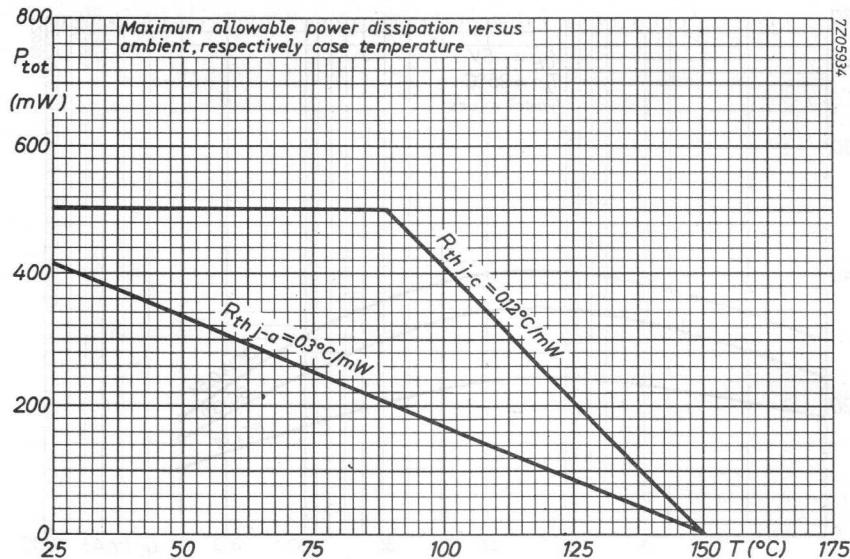
50

< 100

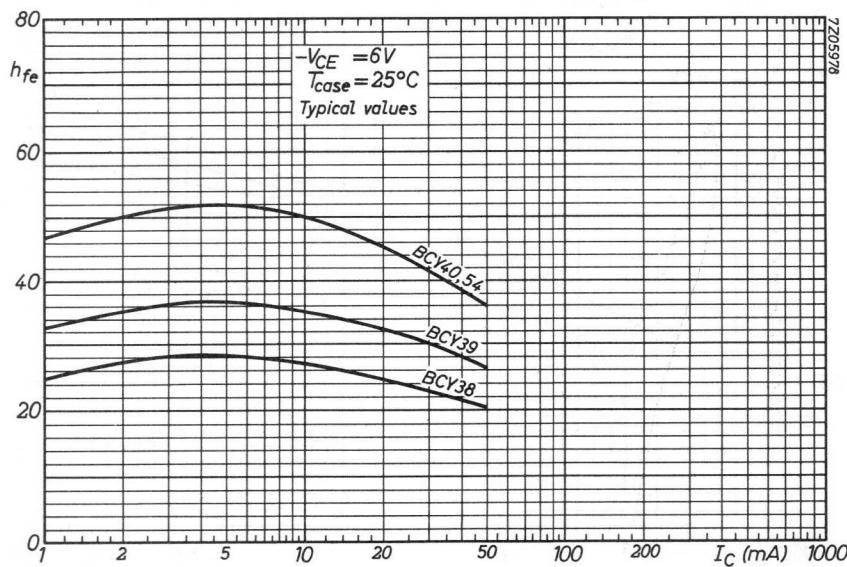
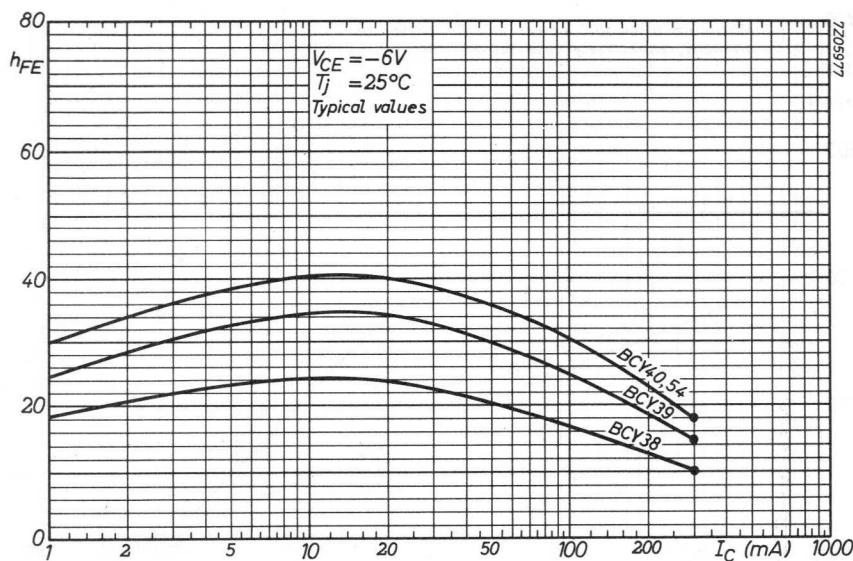
100

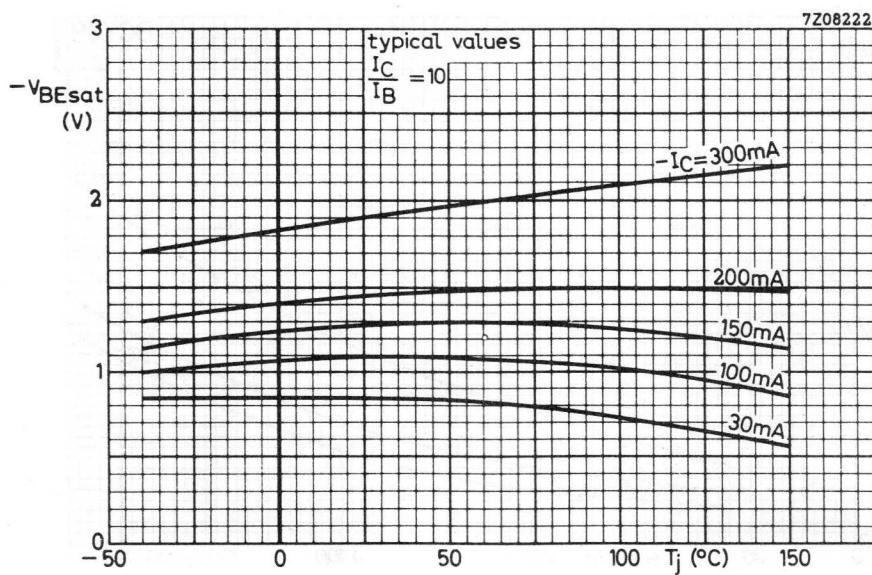
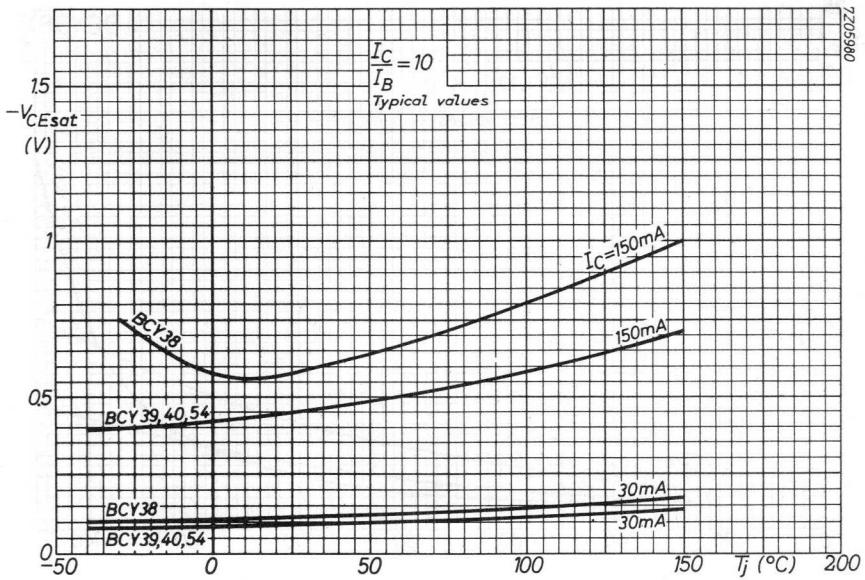
160

120

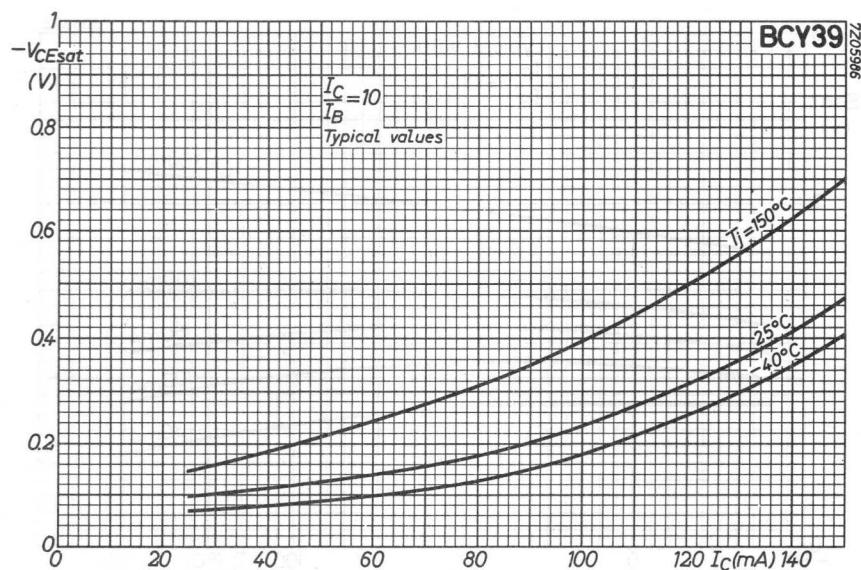
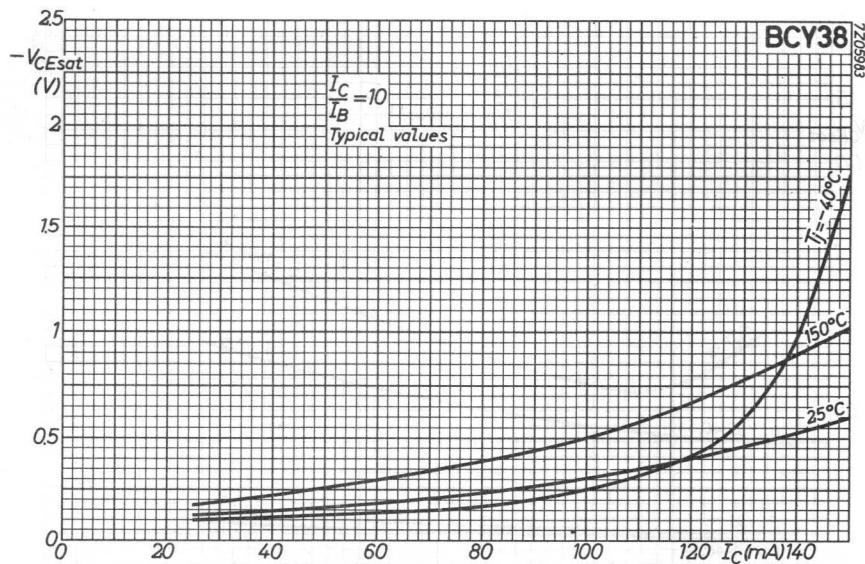


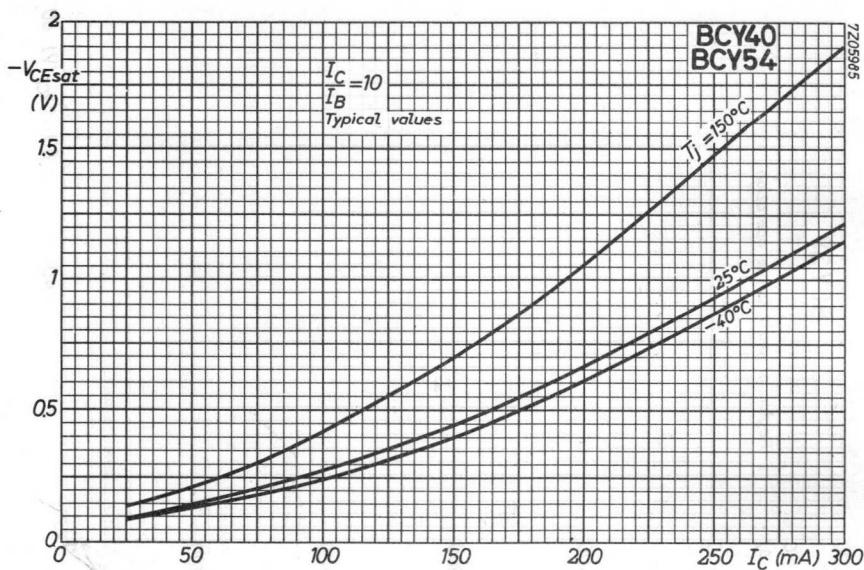
BCY38 to 40
BCY54



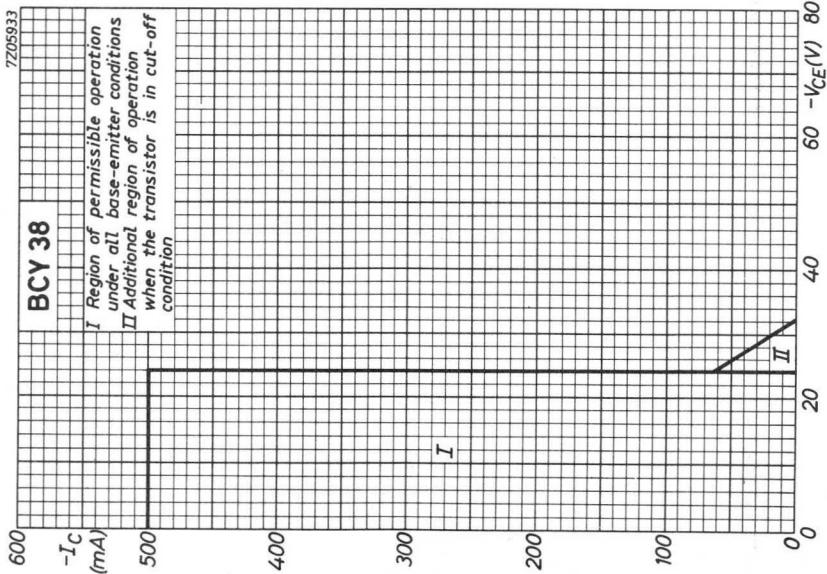
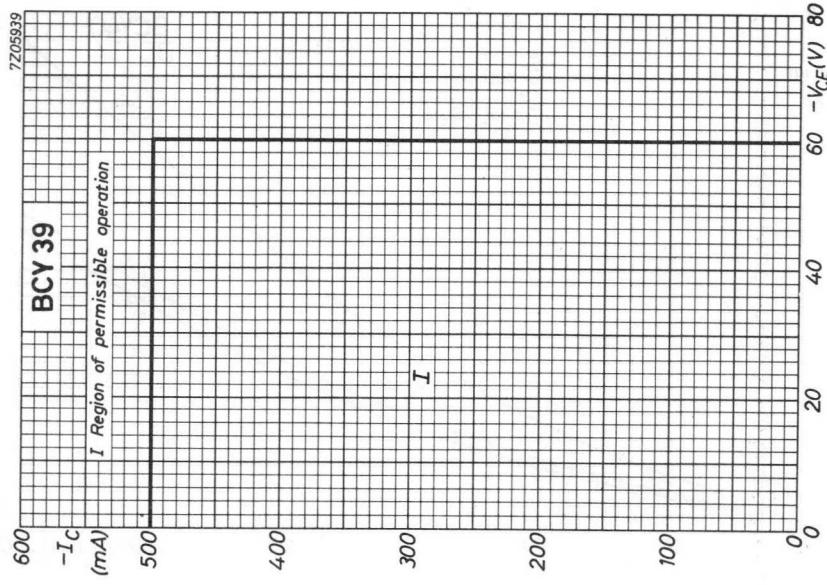


BCY38 to 40
BCY54



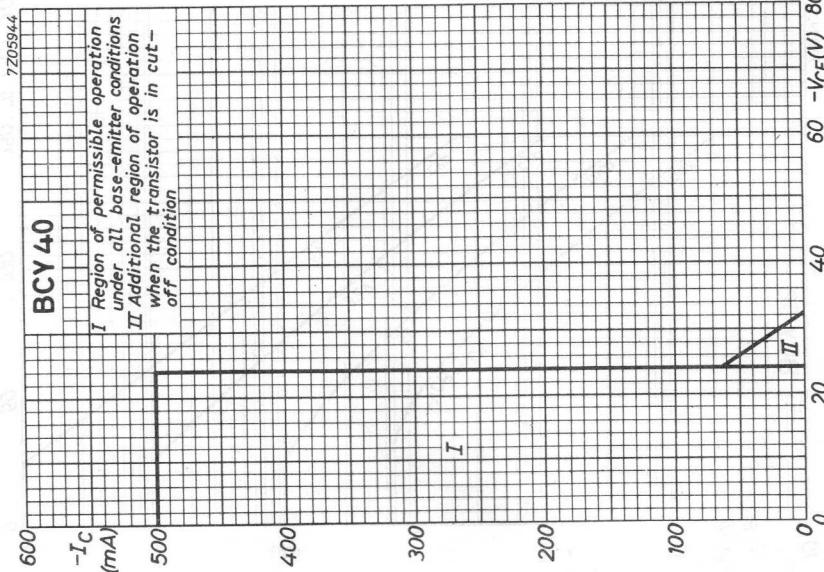
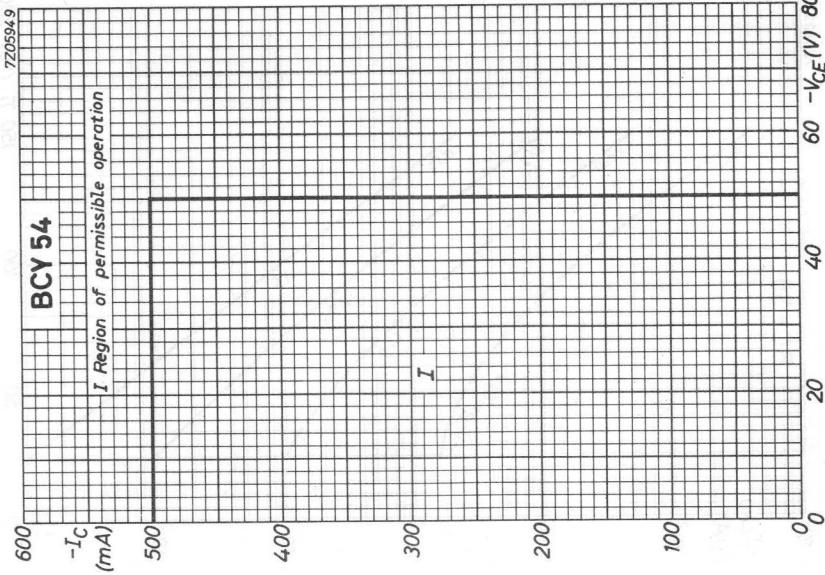


BCY38 to 40
BCY54

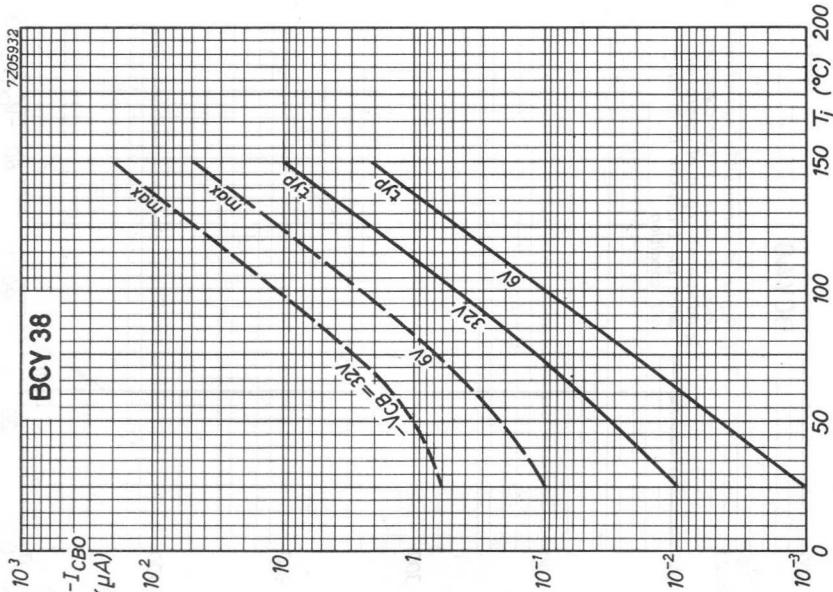
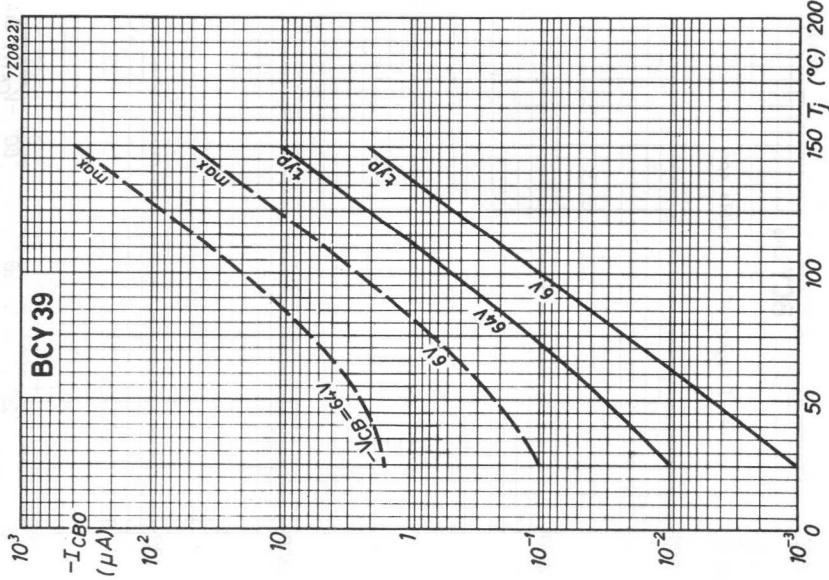


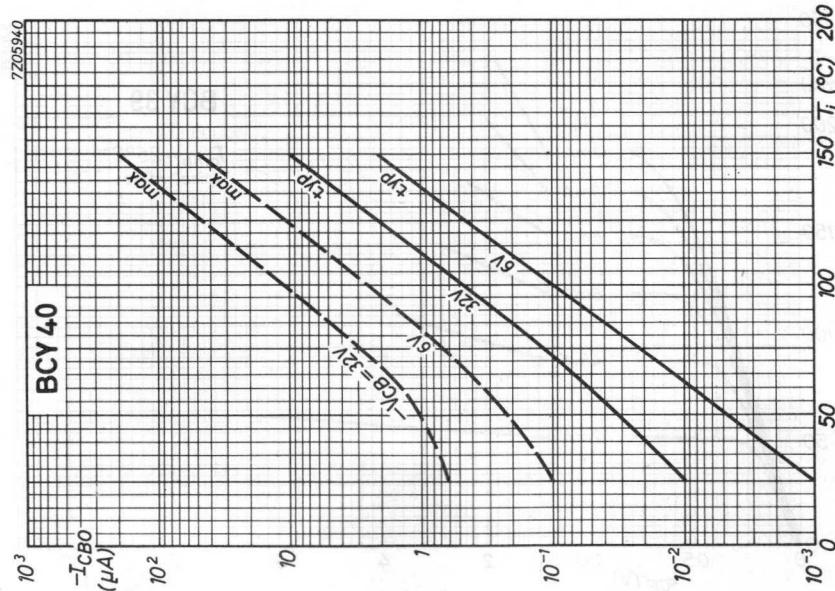
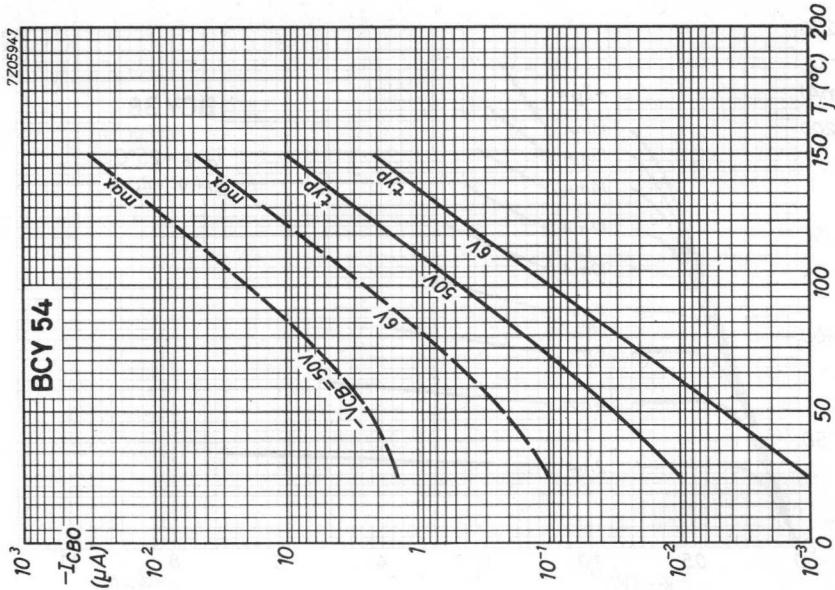
BCY38 to 40

BCY54

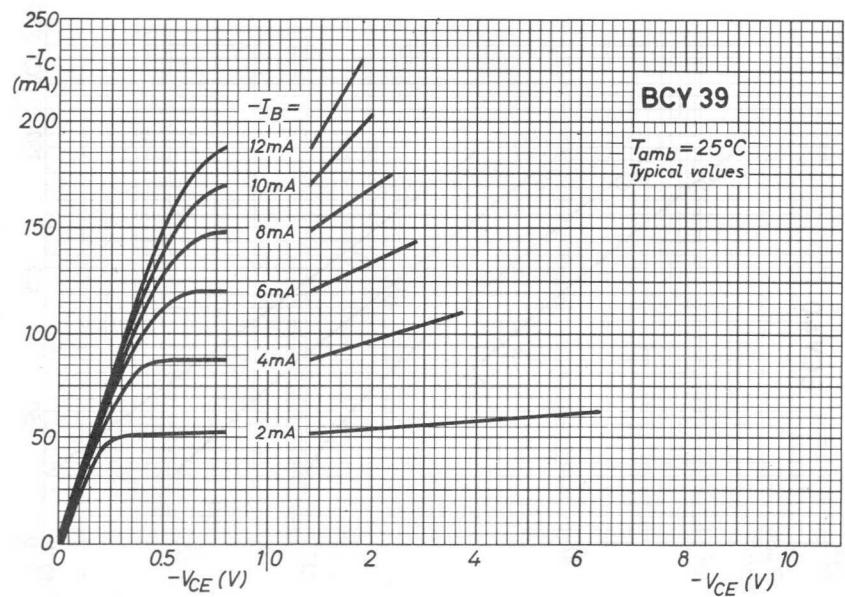
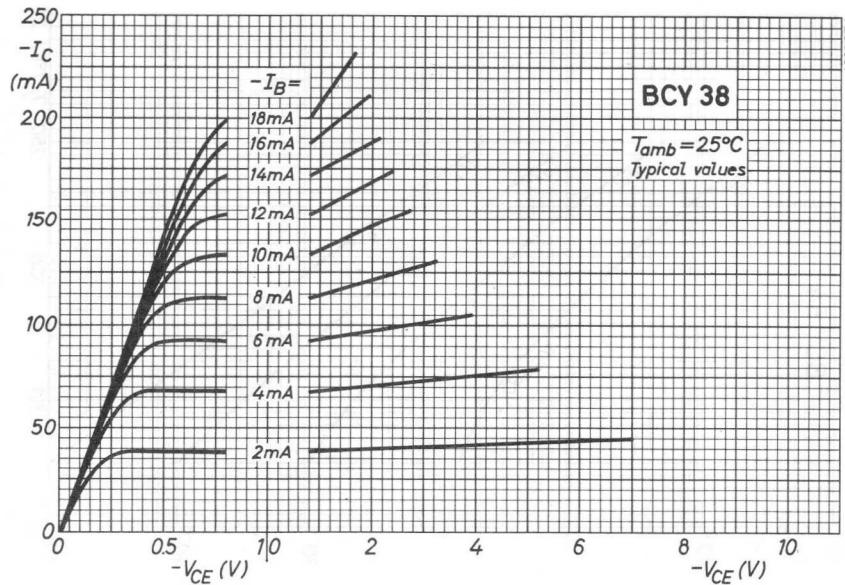


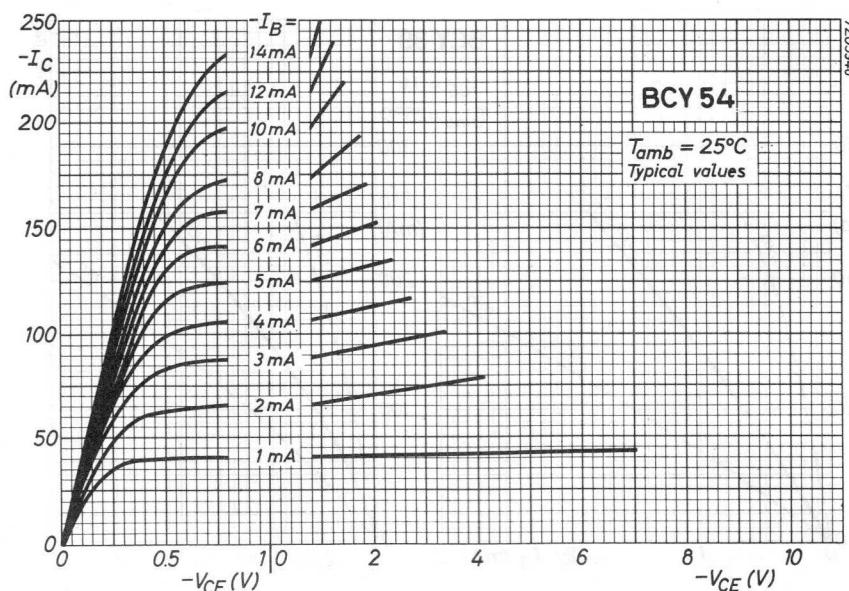
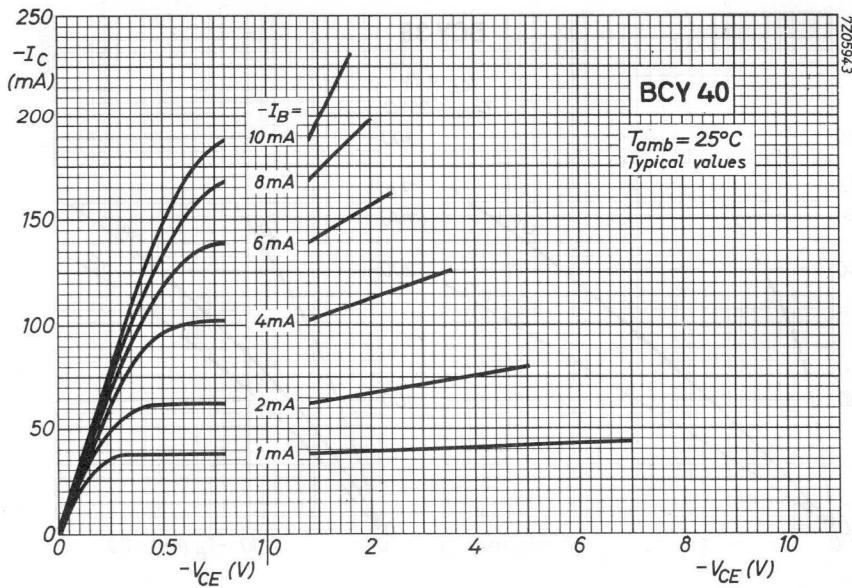
BCY38 to 40
BCY54





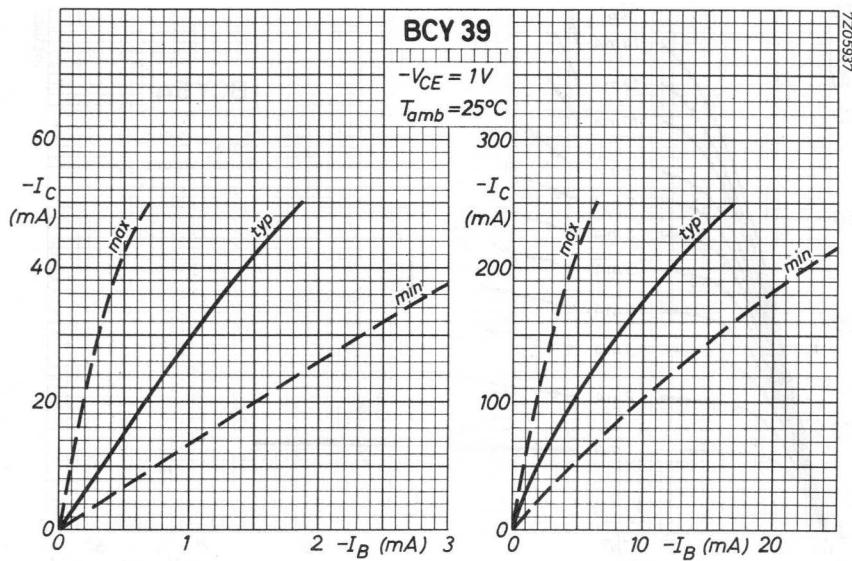
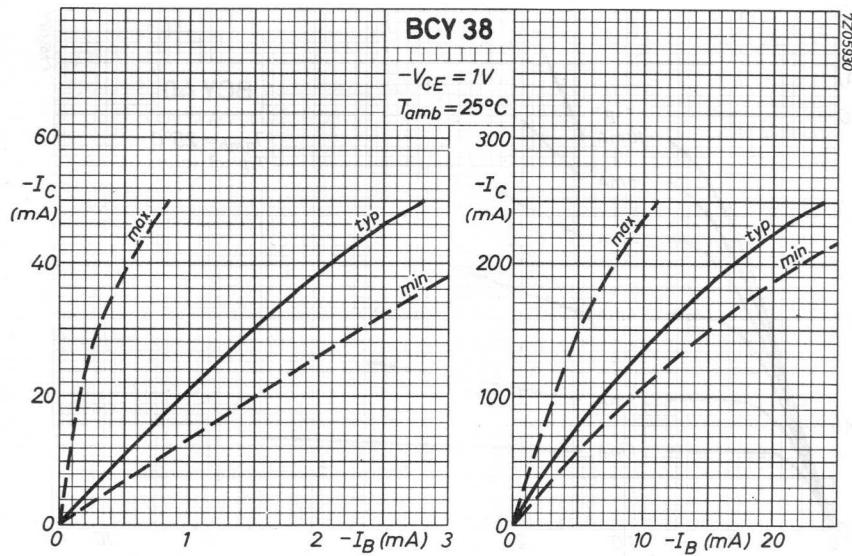
BCY38 to 40
BCY54

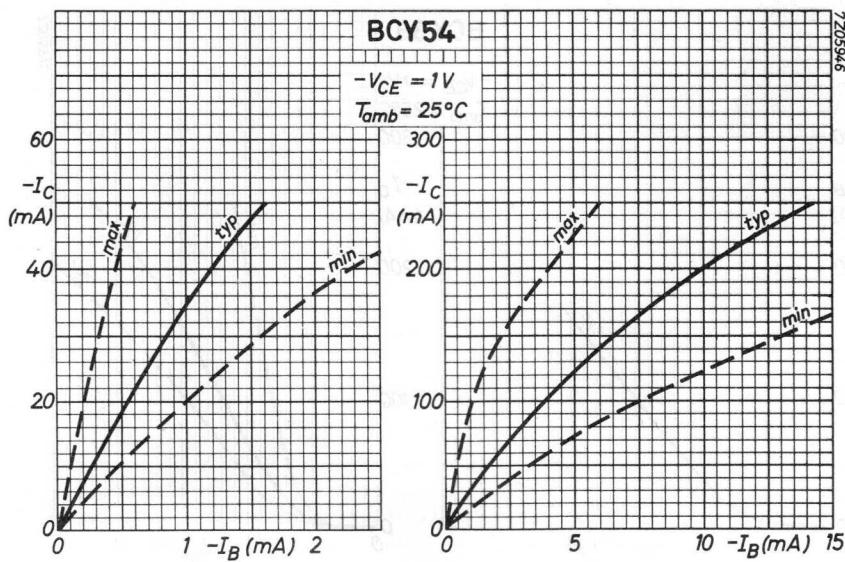
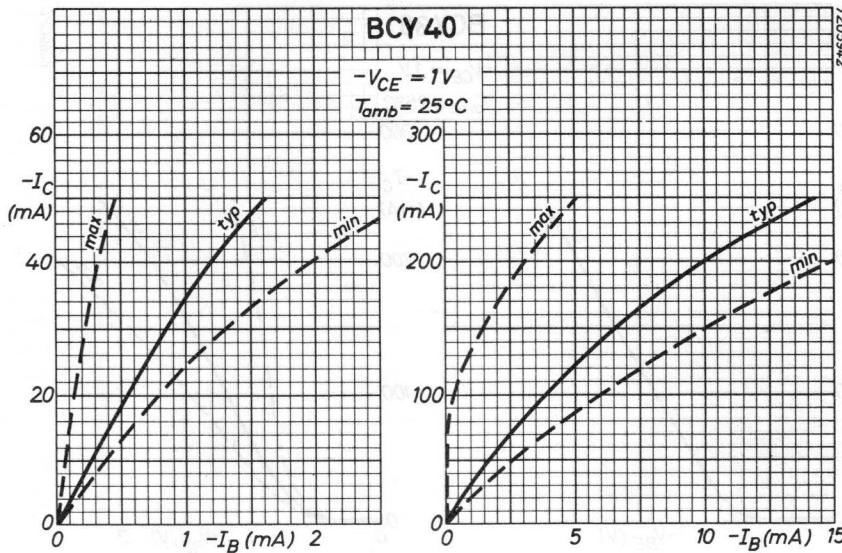




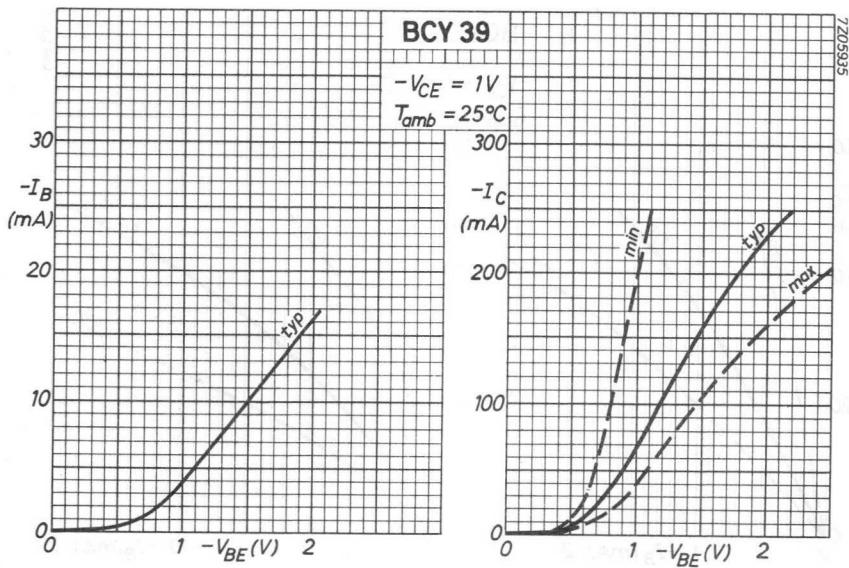
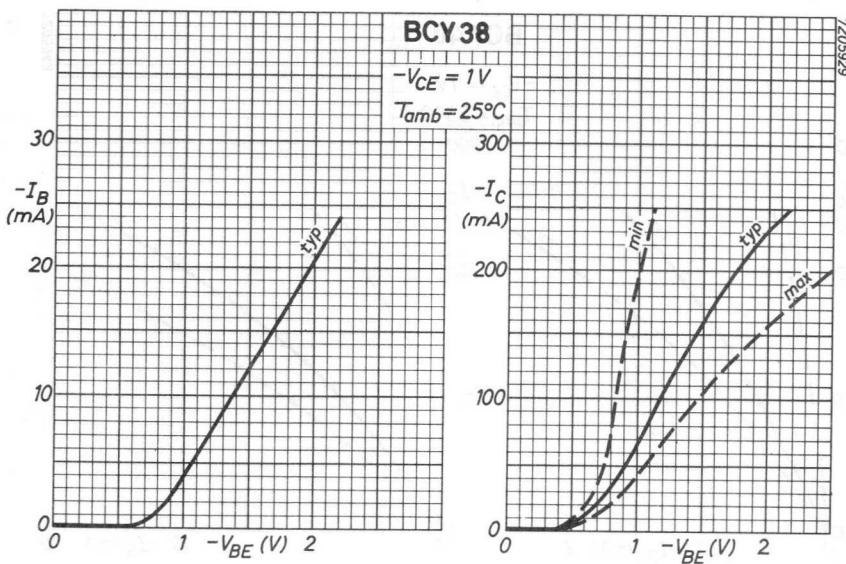
BCY38 to 40

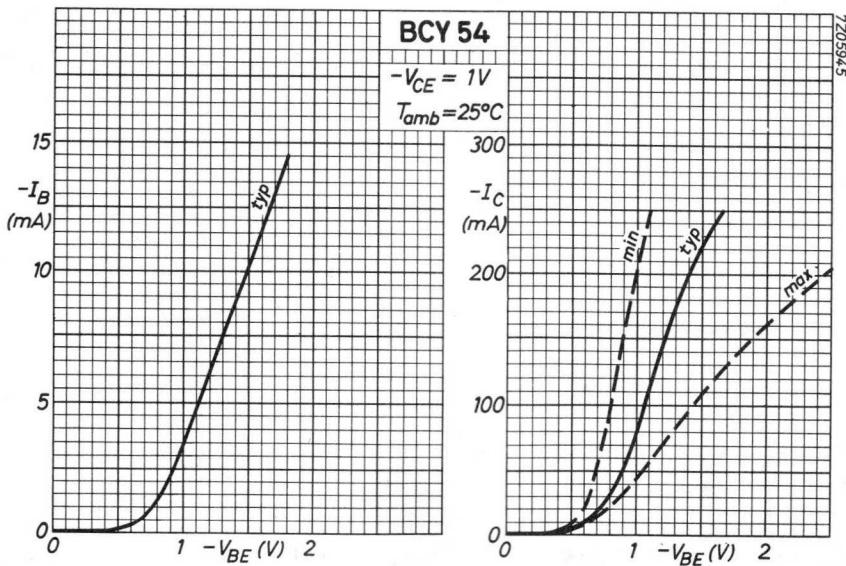
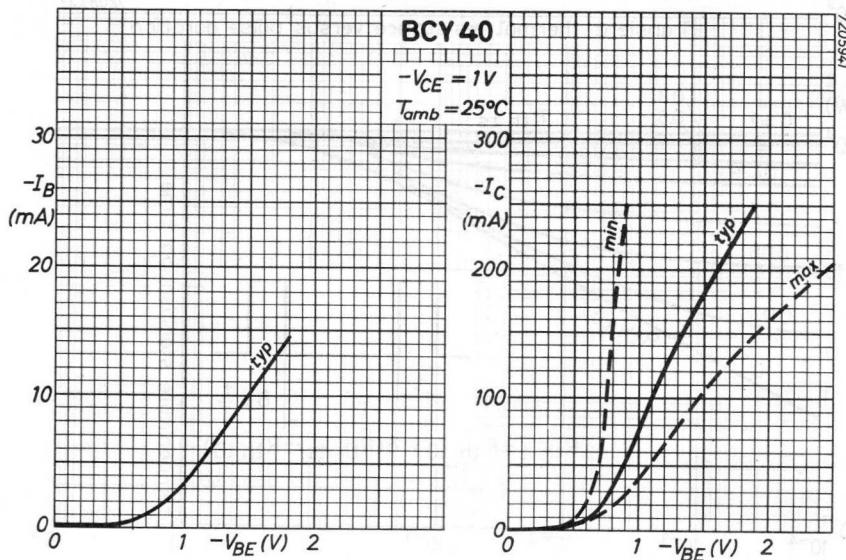
BCY54

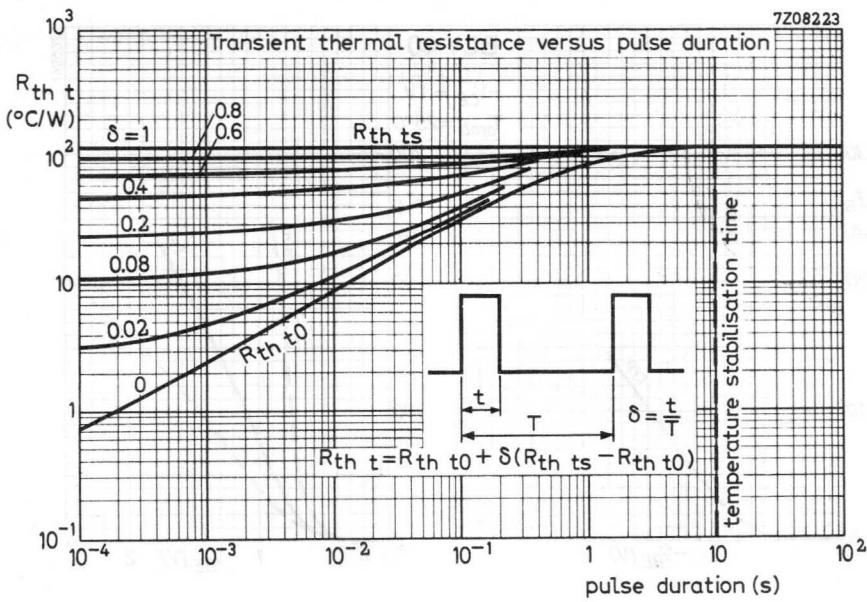




BCY38 to 40
BCY54







N-P-N SILICON PLANAR LOW-LEVEL DUAL TRANSISTORS FOR DIFFERENTIAL AMPLIFIERS

Two special matched transistors in a TO-18 metal envelope, housed together in an aluminium cube.

The BCY55 is intended for very low level, low noise and low drift differential amplifiers.

QUICK REFERENCE DATA

Equivalent differential voltage change
referred to the input

$$|I_{1E} + I_{2E}| \leq 200 \mu\text{A}$$

$$V_{1C-1E} = V_{2C-2E} \leq 20 \text{ V}$$

$$|V_{1B-1E} - V_{2B-2E}| \leq 100 \mu\text{V}$$

T_{amb}: -20 to +90 °C

$$\left| \frac{\Delta V}{\Delta T} \right| \text{ typ.} \quad 1 \mu\text{V}/^\circ\text{C}$$

$$3 \mu\text{V}/^\circ\text{C}$$

Equivalent differential current change
referred to the input

$$I_{1C} + I_{2C} = 100 \mu\text{A}$$

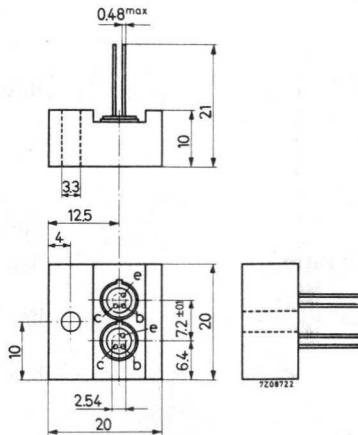
T_{amb}: -20 to +90 °C

$$\left| \frac{\Delta I}{\Delta T} \right| \text{ typ.} \quad 0.5 \text{ nA}/^\circ\text{C}$$

$$1.5 \text{ nA}/^\circ\text{C}$$

MECHANICAL DATA

Dimensions in mm



CHARACTERISTICS of the individual transistors $T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0$; $V_{CB} = 45 \text{ V}$
 $I_E = 0$; $V_{CB} = 20 \text{ V}$; $T_{\text{amb}} = 90^\circ\text{C}$

$I_{CBO} < 10 \text{ nA}$
 $I_{CBO} < 5 \text{ nA}$

Emitter cut-off current

$I_C = 0$; $V_{EB} = 5 \text{ V}$

$I_{EBO} < 10 \text{ nA}$

Emitter-base voltage

$-I_E = 0.5 \text{ mA}$; $V_{CB} = 5 \text{ V}$

$-V_{EB} \text{ from } 600 \text{ to } 800 \text{ mV}$

Saturation voltages

$I_C = 10 \text{ mA}$; $I_B = 0.5 \text{ mA}$

$V_{CEsat} < 1.0 \text{ V}$
 $V_{BESat} \text{ from } 0.6 \text{ to } 1.0 \text{ V}$

D.C. current gain

$I_C = 10 \mu\text{A}$; $V_{CE} = 5 \text{ V}$

$h_{FE} \text{ from } 100 \text{ to } 300$

$I_C = 10 \text{ mA}$; $V_{CE} = 5 \text{ V}$

$h_{FE} \text{ from } 200 \text{ to } 600$

Collector capacitance at $f = 1 \text{ MHz}$

$I_E = I_e = 0$; $V_{CB} = 5 \text{ V}$

$C_C < 8 \text{ pF}$

Transition frequency

$I_C = 0.5 \text{ mA}$; $V_{CE} = 5 \text{ V}$

$f_T > 50 \text{ MHz}$
typ. 80 MHz

Cut-off frequency

$I_C = 0.5 \text{ mA}$; $V_{CE} = 5 \text{ V}$

$f_{hfe} > 100 \text{ kHz}$

h parameters at $f = 1 \text{ kHz}$

$I_C = 1 \text{ mA}$; $V_{CE} = 5 \text{ V}$

$h_{ie} \text{ typ. } 10.0 \text{ k}\Omega$

Input impedance

$h_{re} \text{ typ. } 5.5 \text{ } 10^{-4}$

Reverse voltage transfer ratio

$h_{fe} \text{ typ. } 350$

Small signal current gain

$h_{oe} \text{ typ. } 150 \text{ to } 600$

Output admittance

$h_{oe} \text{ typ. } 25 \text{ } \mu\Omega^{-1}$

Noise figure

$I_C = 10 \mu\text{A}$; $V_{CE} = 5 \text{ V}$
 $R_S = 10 \text{ k}\Omega$; $B = 10 \text{ to } 15000 \text{ Hz}$

$F \text{ typ. } 2 \text{ dB}$
 $< 3 \text{ dB}$

CHARACTERISTICS of the complete deviceRatio of collector currents

$$V_{1B-1E} = V_{2B-2E}$$

Emitter currents of each transistor up to 100 μA

$$\frac{I_{1C}}{I_{2C}} \quad 0.85 \text{ to } 1$$

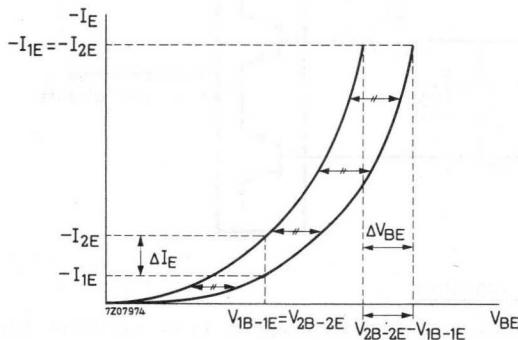
typ. 0.93

Difference of base-emitter voltages

$$-I_{1E} = -I_{2E} \text{ up to } 100 \mu A$$

T_{amb}: -20 to +90 °C

$$|V_{1B-1E} - V_{2B-2E}| \quad \text{typ. } 2 \text{ mV} \\ < 4 \text{ mV}$$

Illustration of matching characteristics:

$$\frac{I_{2E}}{I_{1E}} = \exp. \frac{q}{kT} \cdot \Delta V_{BE}$$

$$\frac{I_{2E}}{I_{1E}} \text{ measured at } \Delta V_{BE} = 0$$

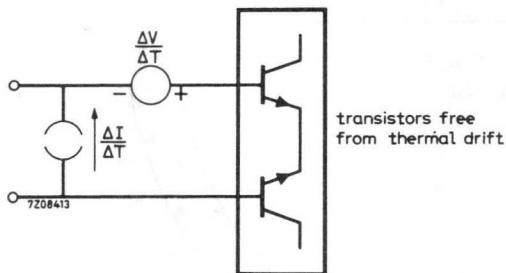
$$\Delta V_{BE} \text{ measured at } \frac{I_{2E}}{I_{1E}} = 1$$

CHARACTERISTICS of the complete device (continued)Equivalent circuit for drift

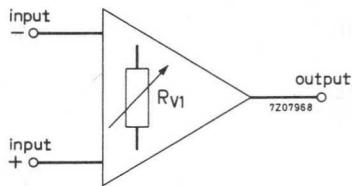
In the equivalent circuit the transistors are considered to be drift free.

All temperature coefficients are concentrated in the voltage source $\frac{\Delta V}{\Delta T}$ and in the current source $\frac{\Delta I}{\Delta T}$.

It should be noted that the differential current change given is only valid when the source resistances are almost equal; the differential voltage change only when the base-emitter voltages are almost equal.

Block symbol of test amplifier

The test amplifier, used in the tests on page 5, is described on pages 6 and 7. It is represented by the following amplifier symbol:



CHARACTERISTICS of the complete device (continued)Equivalent differential voltage change with temperature referred to the input.

$$|I_{1E} + I_{2E}| \leq 200 \mu\text{A}; V_{1C-1E} = V_{2C-2E} \leq 20 \text{ V}$$

$$|V_{1B-1E} - V_{2B-2E}| \leq 100 \mu\text{V}; T_j: -20 \text{ to } +90^\circ\text{C}$$

BCY55 unit (wires included) mounted in a small metal or plastic box for shielding against direct heat radiation.

$$\left| \frac{\Delta V}{\Delta T} \right| \quad \text{typ. } 1 \mu\text{V}/^\circ\text{C}$$

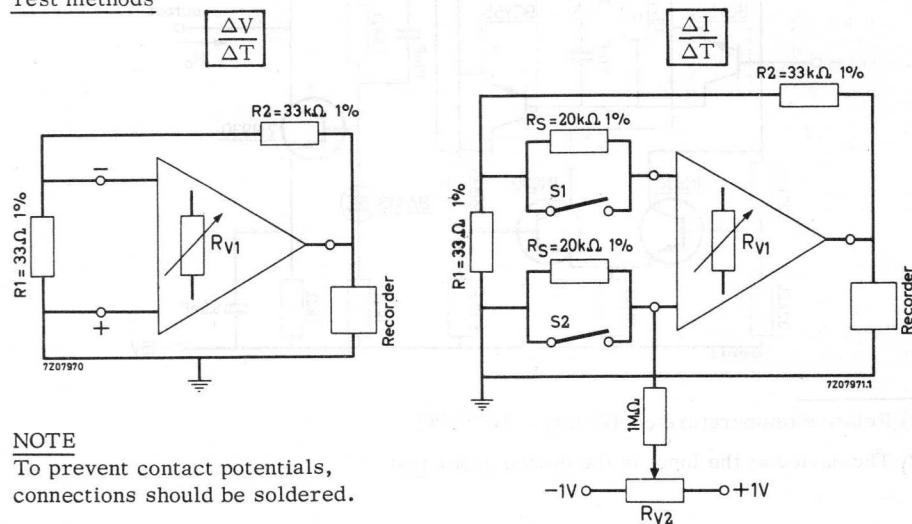
$$< \quad 3 \mu\text{V}/^\circ\text{C}$$

Equivalent differential current change with temperature referred to the input.

$$I_{1C} + I_{2C} = 100 \mu\text{A}$$

$$\left| \frac{\Delta I}{\Delta T} \right| \quad \text{typ. } 0.5 \text{ nA}/^\circ\text{C}$$

$$< \quad 1.5 \text{ nA}/^\circ\text{C}$$

Test methodsNOTE

To prevent contact potentials, connections should be soldered.

Amplification factor determined by feedback circuit: $\frac{R_2}{R_1} = 1000$

Output voltage against time is recorded.

The temperature of the amplifier is adjusted to T_1 between -20 and $+90^\circ\text{C}$. When it has stabilized, the output voltage is brought to zero ($|V_{T1}| < 100 \text{ mV}$)¹). The amplifier temperature is then adjusted to T_2 between -20 and $+90^\circ\text{C}$. When it has stabilized the output voltage can be read off.

Then: $\frac{\Delta V}{\Delta T} = \frac{V_{T2} - V_{T1}}{T_2 - T_1} \cdot \frac{R_1}{R_2}$ or $\frac{\Delta I}{\Delta T} = \frac{V_{T2} - V_{T1}}{T_2 - T_1} \cdot \frac{R_1}{R_2} \cdot \frac{1}{2R_S}$

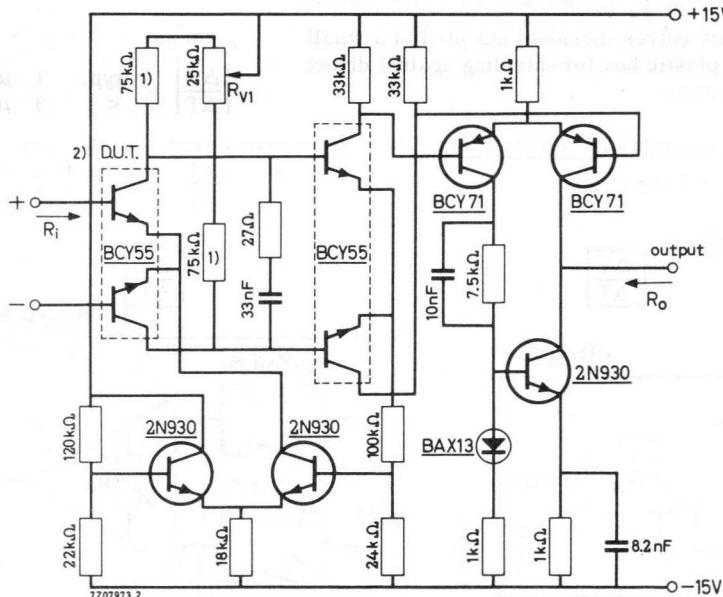
¹) For $\frac{\Delta V}{\Delta T}$: adjusted by R_V1

For $\frac{\Delta I}{\Delta T}$: first by R_V1 with $S1$ and $S2$ closed, then by R_V2 with the switches open.

BCY55

Differential test-amplifier

The test amplifier (including feedback resistors, source-resistors and biasing resistors) should be mounted in a small box to ensure a uniform temperature throughout.



1) Relative temperature coefficient $< 10^{-5} / ^\circ\text{C}$

2) The device at the input is the device under test

Performance of the test amplifierOpen loop voltage gain ($Z_L = 10 \text{ k}\Omega$) G_V typ. 10^5 VFrequency at which $G_V = 1$ f_1 typ. 10 MHz

Max. common mode input voltage range

 ± 10 V

Max. output current

 ± 2.5 mA

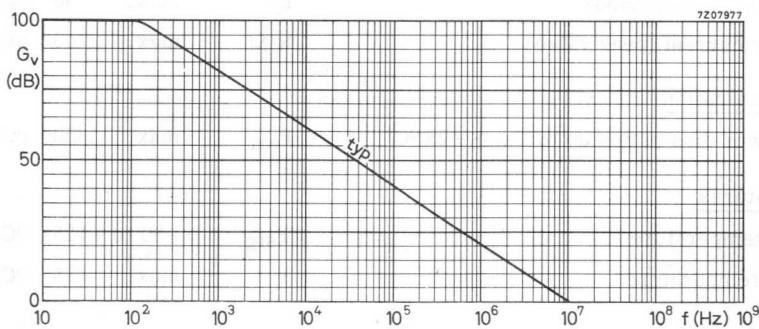
Max. output voltage

 ± 10 V

Input resistance

 $R_i \geq 100 \text{ k}\Omega$

Output resistance

 R_o typ. $20 \text{ k}\Omega$ 

RATINGS of the individual transistors (Limiting values) ¹⁾Voltages

Collector-base voltage (open emitter)	V _{CBO}	max.	45	V
Collector-emitter voltage (open base)	V _{CEO}	max.	45	V
Collector-emitter voltage with V _{BE} = 0	V _{CES}	max.	45	V
Emitter-base voltage (open collector)	V _{EBO}	max.	5	V

Currents

Collector currents (d.c. or average over any 50 ms period)	I _C	max.	30	mA
Collector current (peak value)	I _{CM}	max.	60	mA

Power dissipation

Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max.	300	mW
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Temperatures

Storage temperature	T _{stg}	-50 to +125	°C
Junction temperature	T _j	max.	125 °C

THERMAL RESISTANCE

From junction to ambient in free air R_{th j-a} = 0.33 °C/mW

(This value applies to one transistor at equal dissipation or difference in dissipation < 20% in both transistors of the unit)

1) Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

SILICON PLANAR EPITAXIAL TRANSISTORS

N-P-N transistor in a TO-18 metal envelope with the collector connected to the case.

They are intended for general purpose very high gain low level and low noise applications.

Moreover, they are also suitable for low speed switching applications.

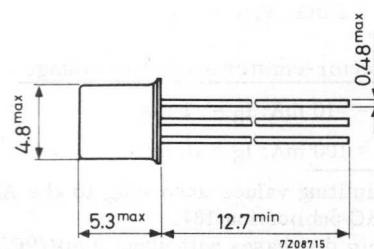
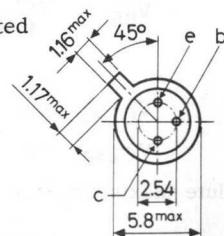
QUICK REFERENCE DATA

		BCY56	BCY57
Collector-base voltage (open emitter)	V _{CBO}	max. 45	25 V
Collector-emitter voltage (open base)	V _{CEO}	max. 45	20 V
Collector current (d.c.)	I _C	max. 100	100 mA
Total power dissipation up to T _{amb} = 25°C	P _{tot}	max. 300	300 mW
Junction temperature	T _j	max. 175	175 °C
D.C. current gain at T _j = 25°C			
I _C = 10 µA; V _{CE} = 5 V	h _{FE}	> 40	100
I _C = 2 mA; V _{CE} = 5 V	h _{FE}	100 to 450	200 to 800
Transition frequency	f _T	typ. 85	100 MHz
I _C = 0.5 mA; V _{CE} = 5 V			
Noise figure	F	typ. 1.5	1.5 dB
I _C = 200 µA; V _{CE} = 5 V		< 5	5 dB
R _S = 2 kΩ; f = 30 Hz to 15.7 kHz			

MECHANICAL DATA

Dimensions in mm

Collector connected
to case
TO-18



Accessories available: 56246, 56263.

RATINGS (Limiting values)¹⁾

Voltages

		BCY56	BCY57	V
Collector-base voltage (open emitter)	V _{CBO}	max.	45	25
Collector-emitter voltage (open base)	V _{CEO}	max.	45	20
Emitter-base voltage (open collector)	V _{EBO}	max.	5	5

Currents

Collector current (d.c.)	I _C	max.	100	mA
Collector current (peak value)	I _{CM}	max.	100	mA

Power dissipation

Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max.	300	mW
--	------------------	------	-----	----

Temperatures

Storage temperature	T _{stg}	-65 to +175	°C	
Junction temperature	T _j	max.	175	°C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	=	0.5	°C/mW
From junction to case	R _{th j-c}	=	0.2	°C/mW

CHARACTERISTICS T_j = 25 °C unless otherwise specified

Collector cut-off current

I _E = 0; V _{CB} = 20 V	I _{CBO}	<	100	nA
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Emitter cut-off current

I _C = 0; V _{EB} = 5 V	I _{EBO}	<	100	nA
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Base-emitter voltage²⁾

I _C = 2 mA; V _{CE} = 5 V	V _{BE}	typ.	650	mV
		600 to 700		mV

Collector-emitter saturation voltage

I _C = 10 mA; I _B = 1 mA	V _{CESat}	typ.	80	mV
I _C = 100 mA; I _B = 10 mA	V _{CESat}	typ.	200	mV

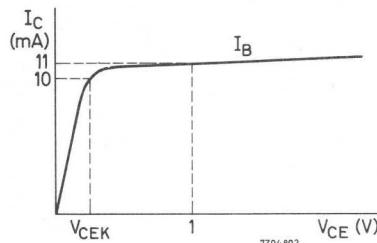
¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

²⁾ V_{BE} decreases with about 2 mV/°C at increasing temperature.

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedKnee voltage

$I_C = 10 \text{ mA}$; I_B = value for which
 $I_C = 11 \text{ mA}$ at $V_{CE} = 1 \text{ V}$

V_{CEK} typ. < 300 mV
 I_B typ. < 600 mV

D.C. current gain

$I_C = 10 \mu\text{A}$; $V_{CE} = 5 \text{ V}$

BCY56 | BCY57

h_{FE} > 40 100

$I_C = 2 \text{ mA}$; $V_{CE} = 5 \text{ V}$

h_{FE} typ. 200 400

$I_C = 10 \text{ mA}$; $V_{CE} = 5 \text{ V}$

h_{FE} 100 to 450 200 to 800

Transition frequency

$I_C = 0.5 \text{ mA}$; $V_{CE} = 5 \text{ V}$

f_T typ. 85 100 MHz

$I_C = 10 \text{ mA}$; $V_{CE} = 5 \text{ V}$

f_T typ. 250 350 MHz

h parameters at $f = 1 \text{ kHz}$

$I_C = 2 \text{ mA}$; $V_{CE} = 5 \text{ V}$

h_{ie} typ. 3.5 7.5 kΩ

Reverse voltage transfer

h_{re} typ. 1.75 3.5 10^{-4}

Small signal current gain

h_{fe} typ. 250 500

125 to 500 240 to 900

Output admittance

h_{oe} typ. 17.5 35 $\mu\Omega^{-1}$

Collector capacitance at $f = 1 \text{ MHz}$

$I_E = I_e = 0$; $V_{CB} = 5 \text{ V}$

C_c typ. 4.5 4.5 pF

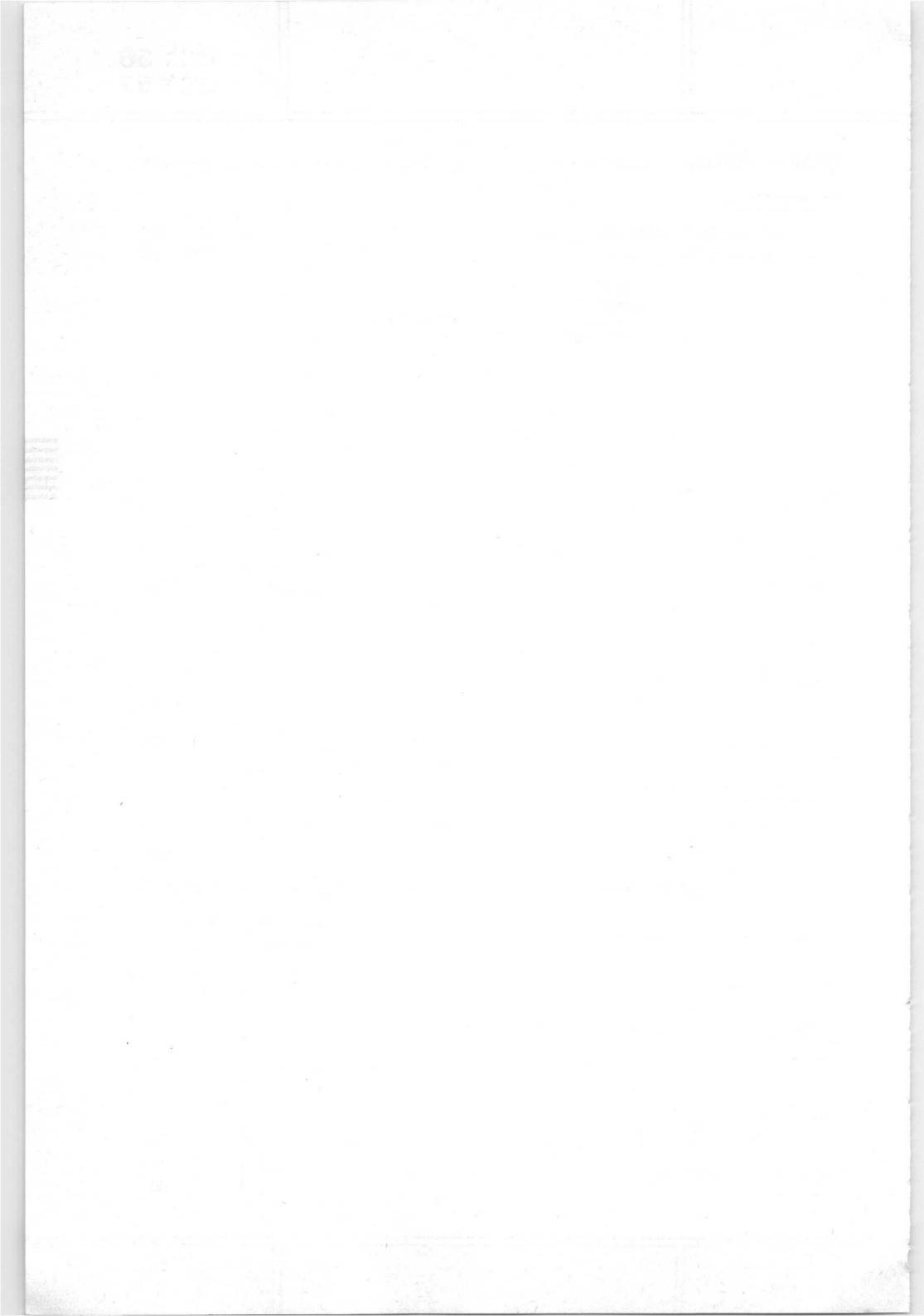
Noise figure

$I_C = 200 \mu\text{A}$; $V_{CE} = 5 \text{ V}$; $R_S = 2 \text{ k}\Omega$

F typ. 1.5 1.5 dB

$f = 30 \text{ Hz to } 15.7 \text{ kHz}$

< 5 5 dB



P-N-P SILICON PLANAR EPITAXIAL TRANSISTORS

P-N-P transistors in a TO-18 metal envelope intended for general purpose industrial applications.

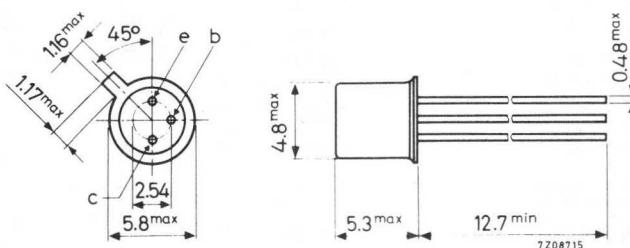
		QUICK REFERENCE DATA		
		BCY70	BCY71	BCY72
Collector-base voltage (open emitter)	-V _{CBO}	max. 50	45	25 V
Collector-emitter voltage (open base)	-V _{CEO}	max. 40	45	25 V
Collector current (peak value)	-I _{CM}	max. 200	200	200 mA
Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max. 350	350	350 mW
Junction temperature	T _j	max. 200	200	200 °C
D.C. current gain -I _C = 0.1 mA; -V _{CE} = 1.0 V	h _{FE}	> 40	80	
-I _C = 10 mA; -V _{CE} = 1.0 V	h _{FE}	> 50	100	50

MECHANICAL DATA

Dimensions in mm

Collector connected to case

TO-18



Accessories available: 56246, 56263

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages		BCY70	BCY71	BCY72
Collector-base voltage (open emitter)	-V _{CBO}	max.	50	45
Collector-emitter voltage (open base)	-V _{CEO}	max.	40	45
Emitter-base voltage (open collector)	-V _{EBO}	max.	5.0	5.0
Current				
Collector current (peak value)	-I _{CM}	max.	200	mA
Emitter current (peak value)	I _{EM}	max.	200	mA
Power dissipation				
Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max.	350	mW
Temperatures				
Storage temperature	T _{stg}	-65 to +200	°C	
Junction temperature	T _j	max.	+200	°C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	=	0.5	°C/mW
From junction to case	R _{th j-c}	=	0.15	°C/mW
CHARACTERISTICS	T _j = 25 °C unless otherwise specified			

Collector cut-off current		BCY70	BCY71	BCY72
I _E = 0; -V _{CB} = 20 V	-I _{CBO}	<		50 nA
I _E = 0; -V _{CB} = 20 V; T _j = 100 °C	-I _{CBO}	<		2 μA
I _E = 0; -V _{CB} = 25 V	-I _{CBO}	<		500 nA
I _E = 0; -V _{CB} = 40 V	-I _{CBO}	<	10	50 nA
I _E = 0; -V _{CB} = 40 V; T _j = 100 °C	-I _{CBO}	<	0.5	2 μA
I _E = 0; -V _{CB} = 45 V	-I _{CBO}	<		500 nA
I _E = 0; -V _{CB} = 50 V	-I _{CBO}	<	500	nA
-V _{CE} = 50 V; -V _{EB} = 3.0 V	-I _{CEX}	<	20	
Emitter cut-off current				
I _C = 0; -V _{EB} = 4.0 V	-I _{EBO}	<	10	10 nA
I _C = 0; -V _{EB} = 4.0 V; T _j = 100 °C	-I _{EBO}	<	2	2 μA
I _C = 0; -V _{EB} = 5.0 V	-I _{EBO}	<	500	500 nA
Saturation voltages				
-I _C = 10 mA; -I _B = 1.0 mA	-V _{CEsat}	<	0.25	0.25 V
	-V _{BEsat}	0.6 to 0.9	0.6 to 0.9	V
-I _C = 50 mA; -I _B = 5.0 mA	-V _{CEsat}	<	0.50	0.50 V
	-V _{BEsat}	<	1.2	1.2 V

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedD.C. current gain

			<u>BCY70</u>	<u>BCY71</u>	<u>BCY72</u>
$-I_C = 10 \mu\text{A}; -V_{CE} = 1.0 \text{ V}$	h_{FE}	>	40		
$-I_C = 0.1 \text{ mA}; -V_{CE} = 1.0 \text{ V}$	h_{FE}	>	40	80	
$-I_C = 1.0 \text{ mA}; -V_{CE} = 1.0 \text{ V}$	h_{FE}	>	45	90	40
$-I_C = 10 \text{ mA}; -V_{CE} = 1.0 \text{ V}$	h_{FE}	>	50	100	50
$-I_C = 50 \text{ mA}; -V_{CE} = 1.0 \text{ V}$	h_{FE}	>	15	600	

Collector capacitance at $f = 1 \text{ MHz}$

$I_E = I_e = 0; -V_{CB} = 10 \text{ V}$	C_C	<	6.0	6.0	6.0	pF
---	-------	---	-----	-----	-----	----

Emitter capacitance at $f = 1 \text{ MHz}$

$I_C = I_e = 0; -V_{EB} = 1.0 \text{ V}$	C_e	<	8.0	8.0	8.0	pF
--	-------	---	-----	-----	-----	----

Transition frequency at $T_{amb} = 25^\circ\text{C}$

$-I_C = 10 \text{ mA}; -V_{CE} = 20 \text{ V}; f = 100 \text{ MHz}$	f_T	>	250	200	200	MHz
$-I_C = 0.1 \text{ mA}; -V_{CE} = 20 \text{ V}; f = 10.7 \text{ MHz}$	f_T	>		15		MHz

Noise figure

$-I_C = 100 \mu\text{A}; -V_{CE} = 5 \text{ V}$ $f = 10 \text{ Hz to } 10 \text{ kHz}; R_S = 2 \text{ k}\Omega$	F	<	6	2	6	dB
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h parameters at $f = 1 \text{ kHz}$ (common emitter)

$-I_C = 1 \text{ mA}; -V_{CE} = 10 \text{ V}; T_{amb} = 25^\circ\text{C}$			<u>BCY71</u>		
Input impedance	h_{ie}		2 to 12	$\text{k}\Omega$	
Reverse voltage transfer ratio	h_{re}	<	20	10^{-4}	
Small signal current gain	h_{fe}		100 to 400		
Output admittance	h_{oe}		10 to 60	$\mu\Omega^{-1}$	

CHARACTERISTICS (continued)

SWITCHING CHARACTERISTICS of the BCY70 and BCY72

Turn on time when switched to $+V_{BE} = 2$ V to $-I_C = 10$ mA; $-I_B = 1$ mA

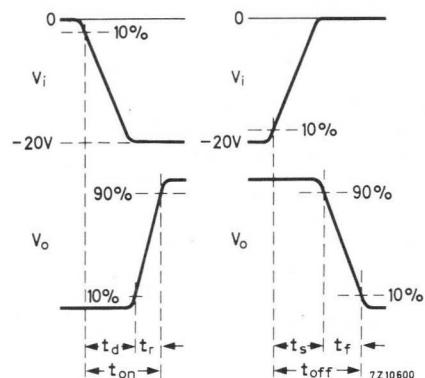
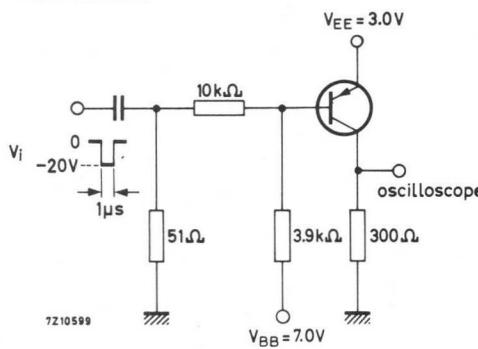
delay time	t_d	typ.	23	ns
	<		35	ns
rise time	t_r	typ.	25	ns
	<		35	ns
turn on time	t_{on}	typ.	48	ns
	<		65	ns

Turn off time when switched from

$-I_C = 10$ mA; $-I_B = 1$ mA to $+V_{BE} = 2$ V with $+I_{BM} = 1$ mA

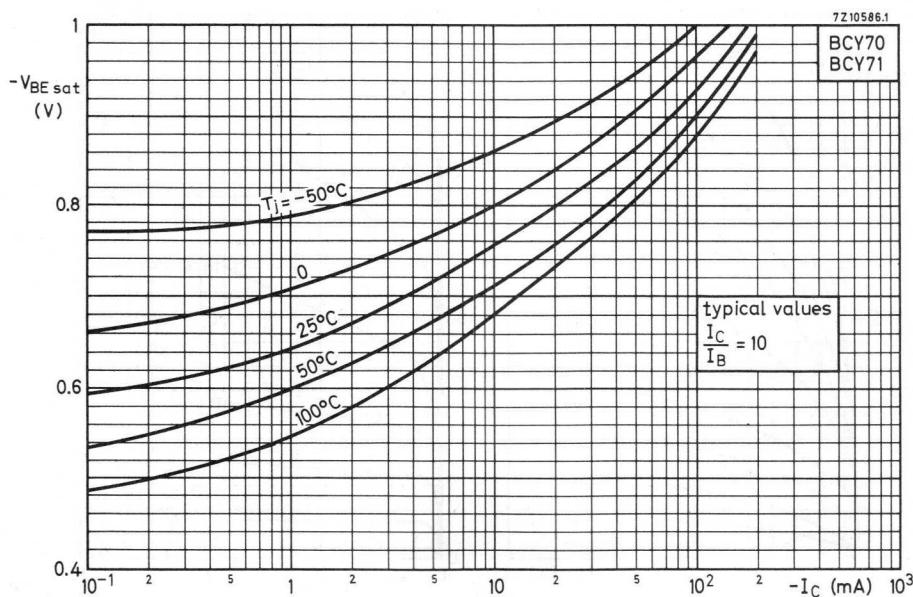
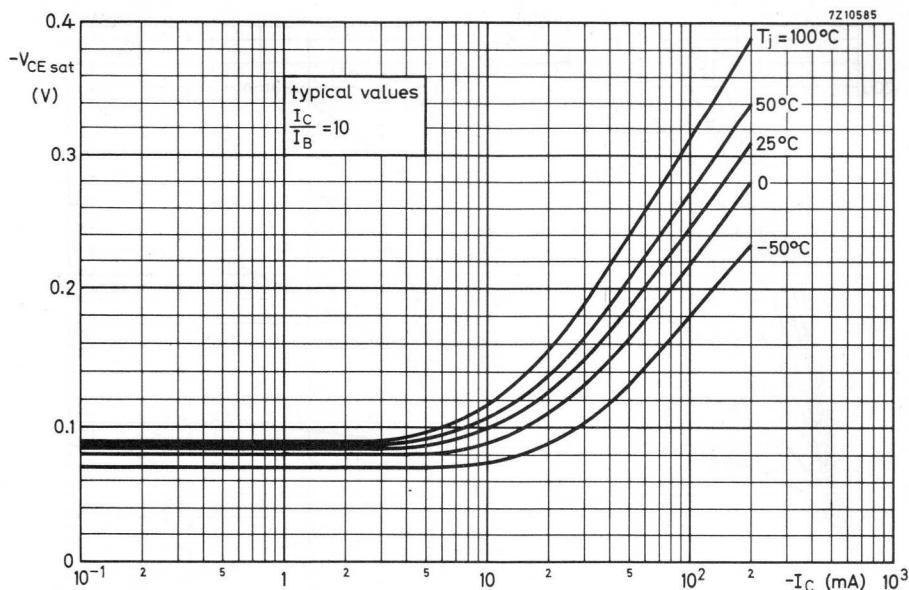
storage time	t_s	typ.	270	ns
	<		350	ns
fall time	t_f	typ.	50	ns
	<		80	ns
turn off time	t_{off}	typ.	320	ns
	<		420	ns

Test circuit:

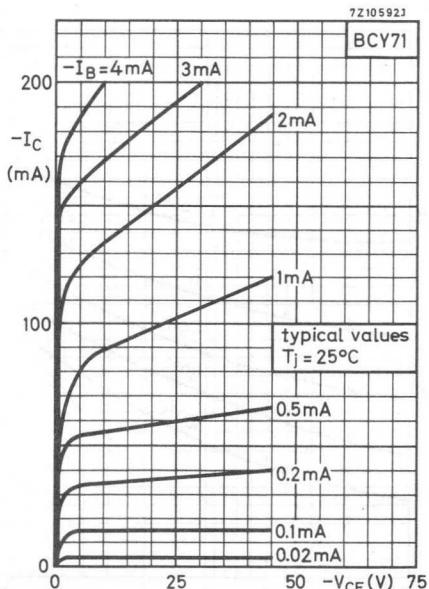
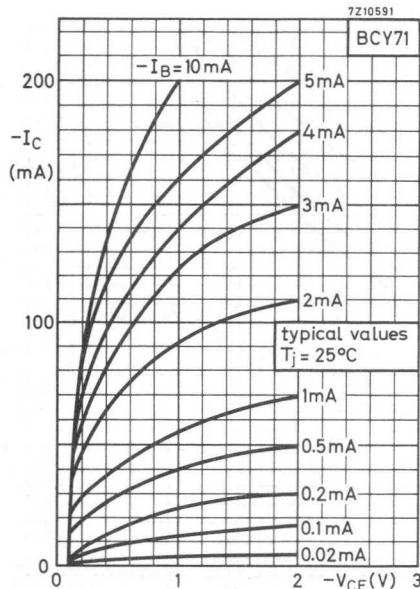
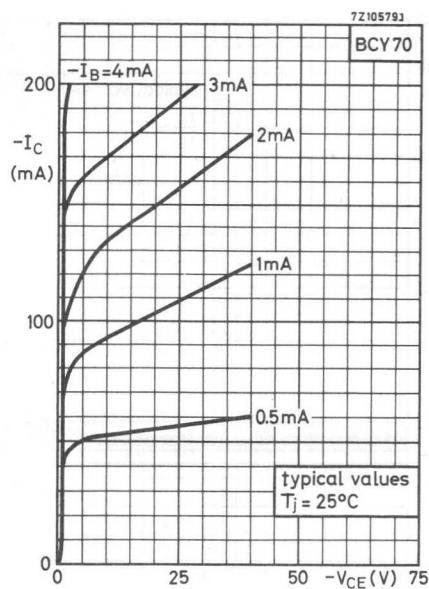
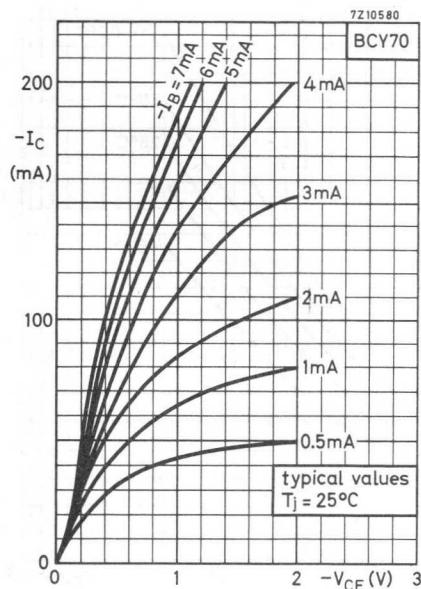


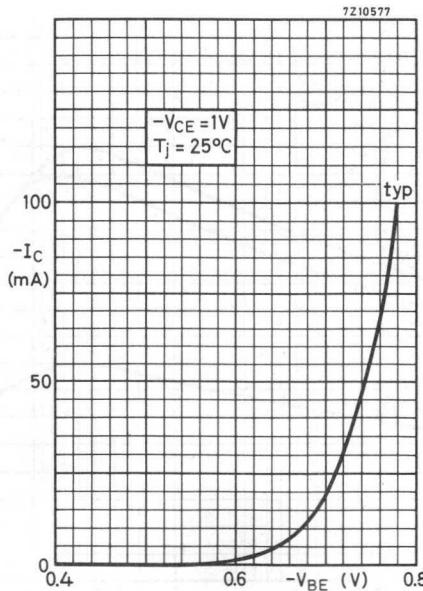
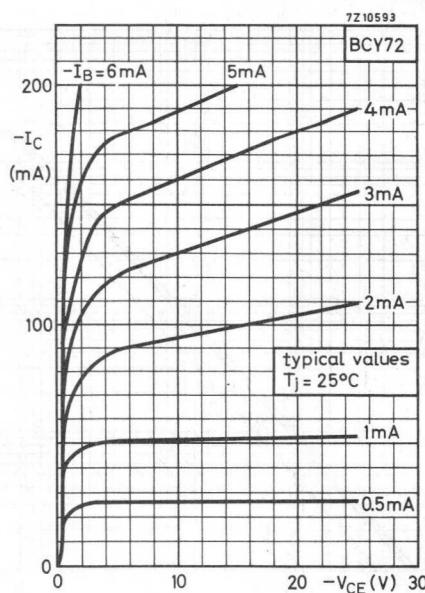
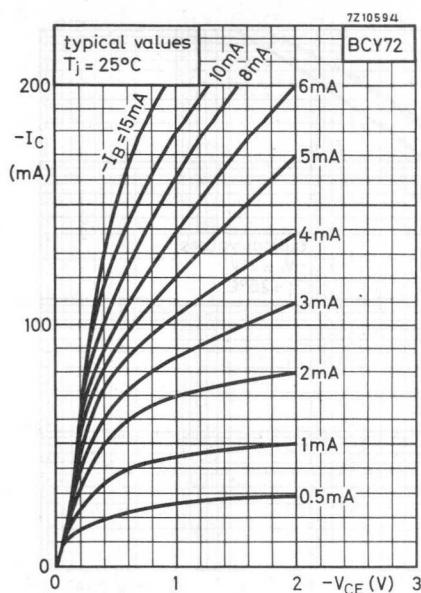
Note:

$+I_{BM}$ is the reverse current that can flow during switching off. The indicated $+I_{BM}$ is determined and limited by the applied cut-off voltage and series resistance.

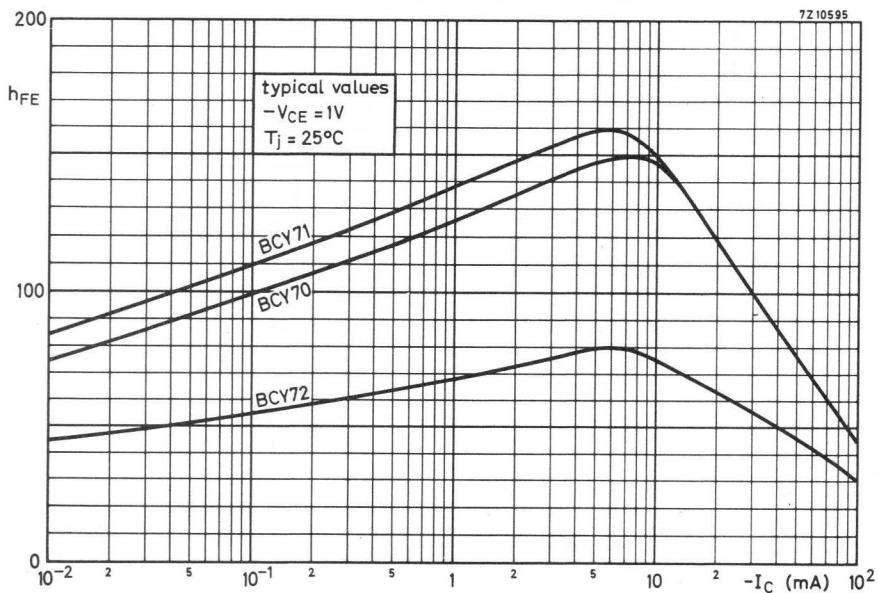
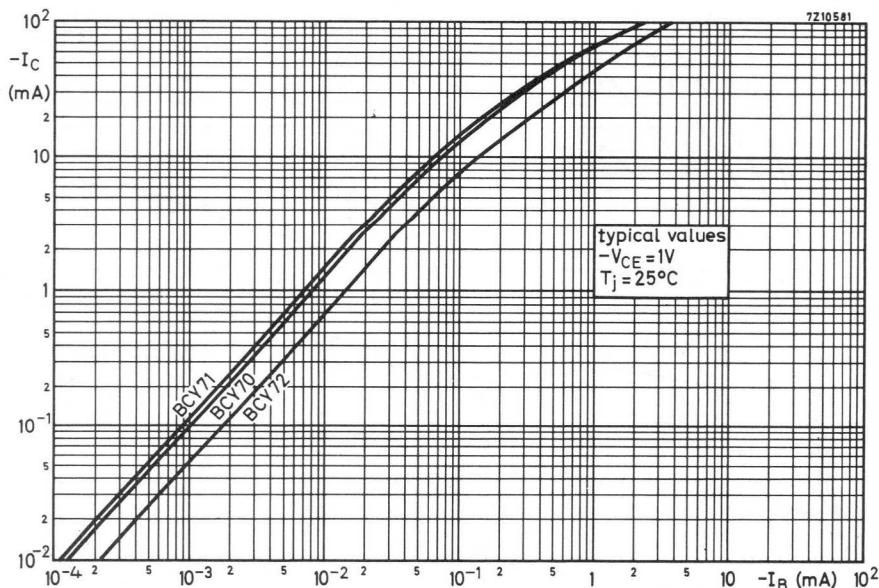


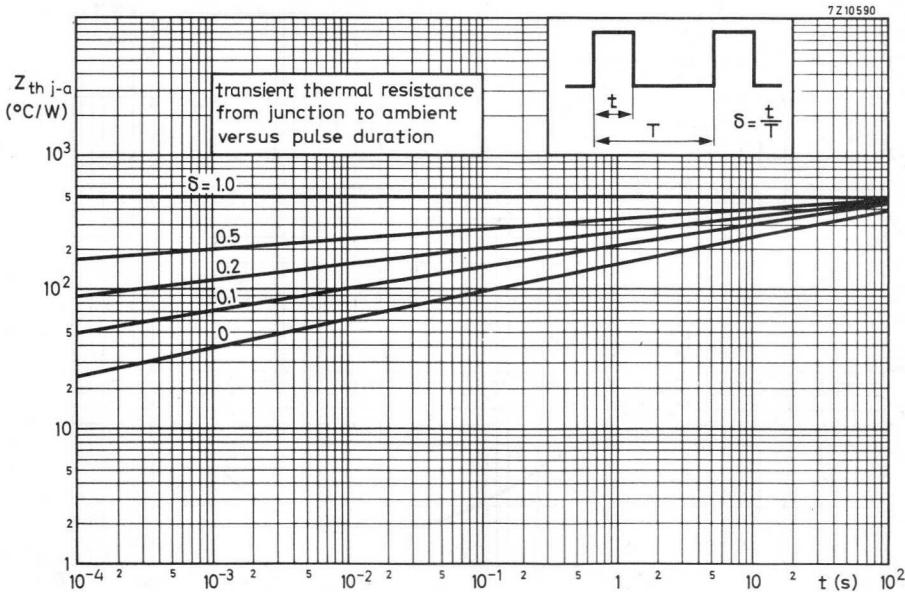
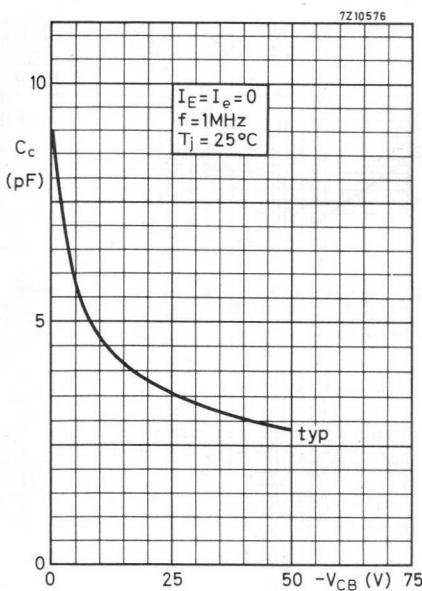
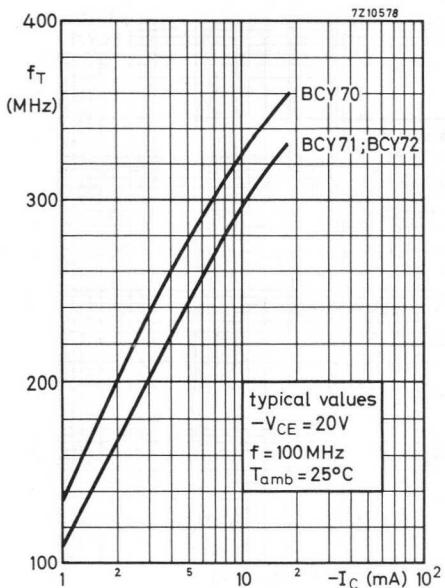
BCY70 to 72



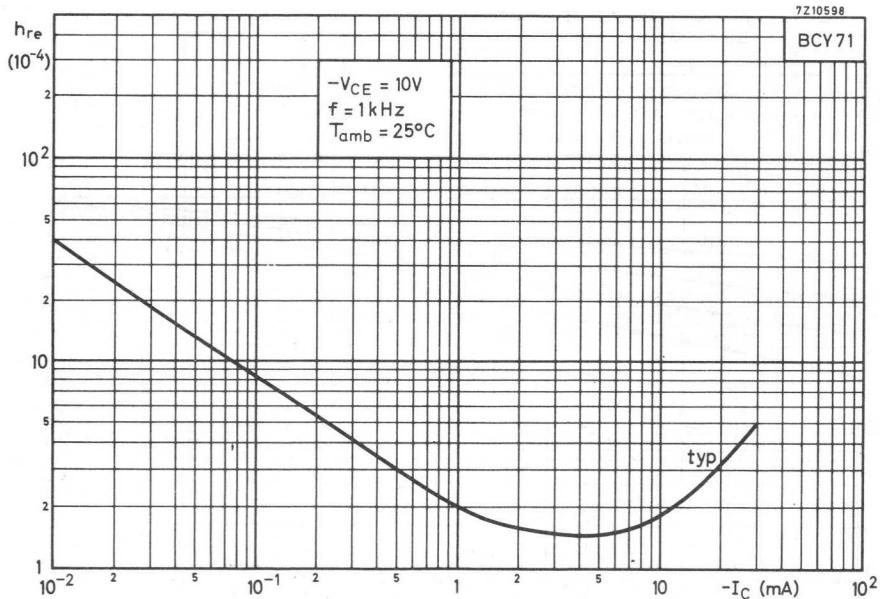
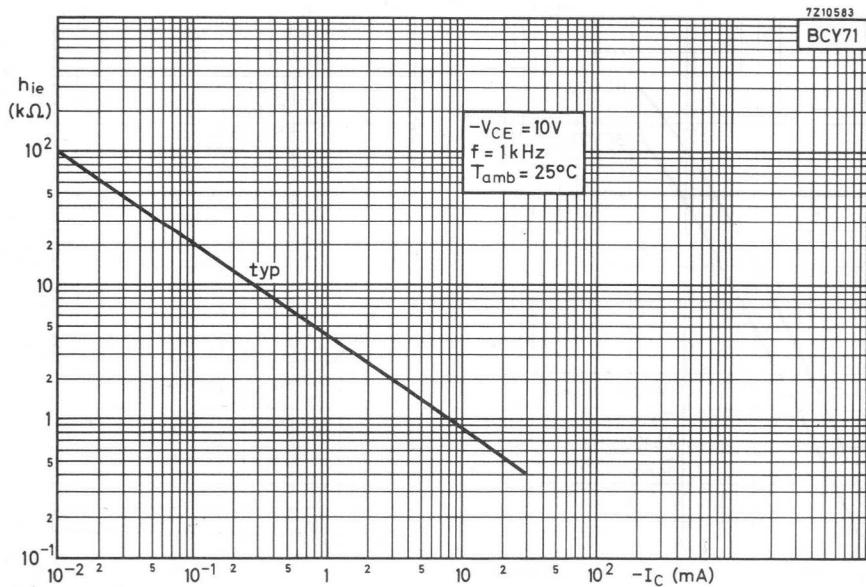


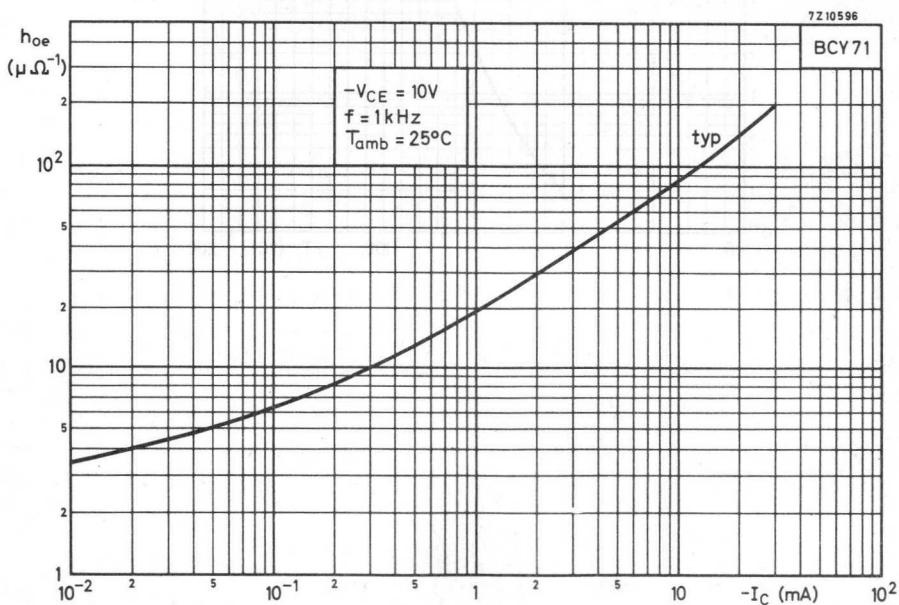
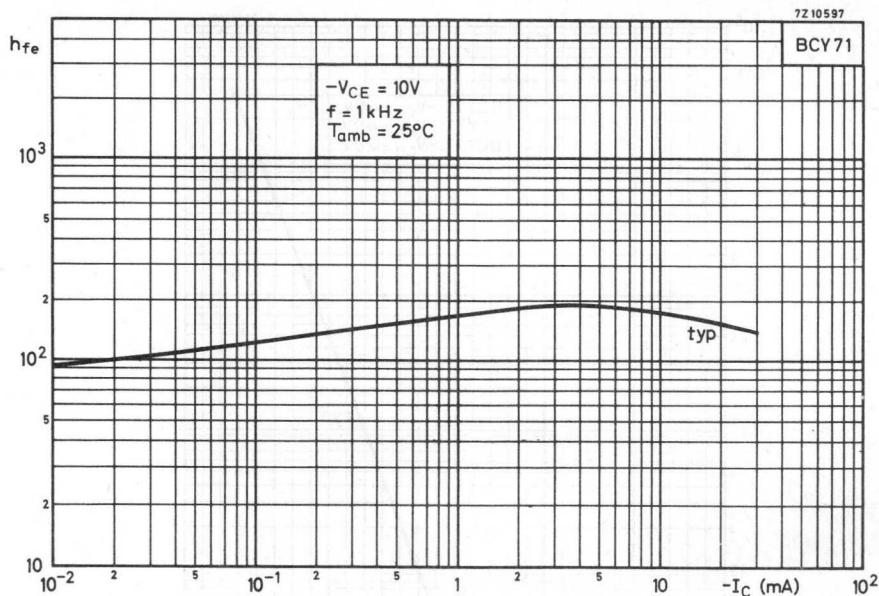
BCY70to72

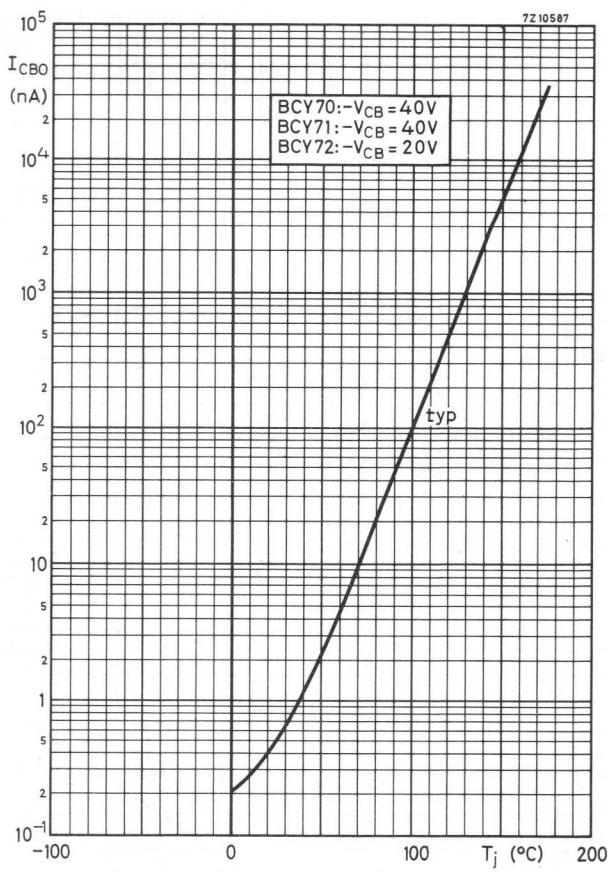


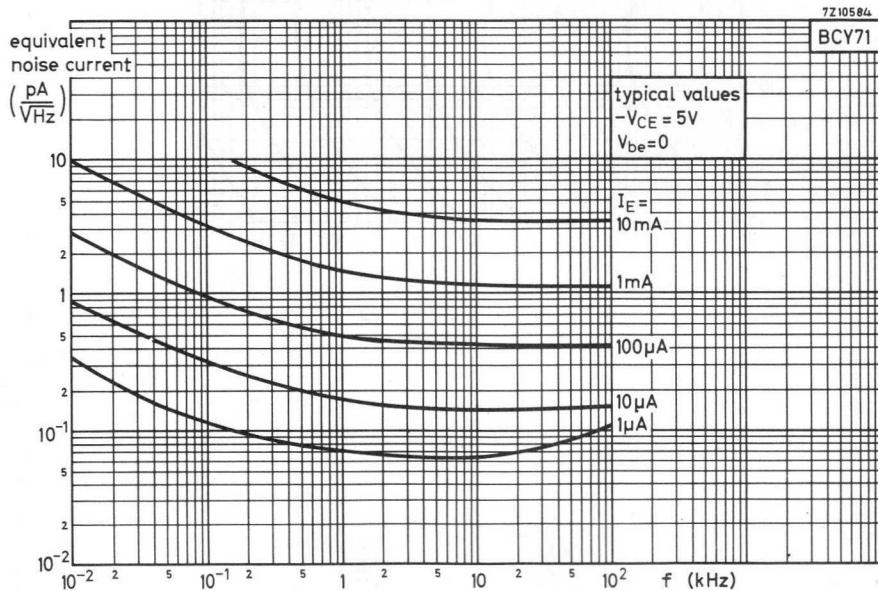
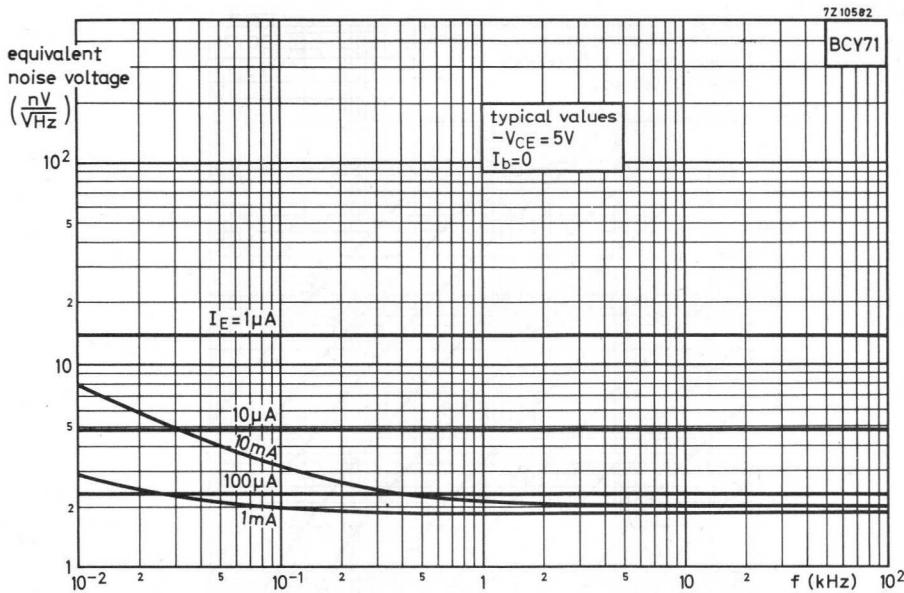


BCY70 to 72





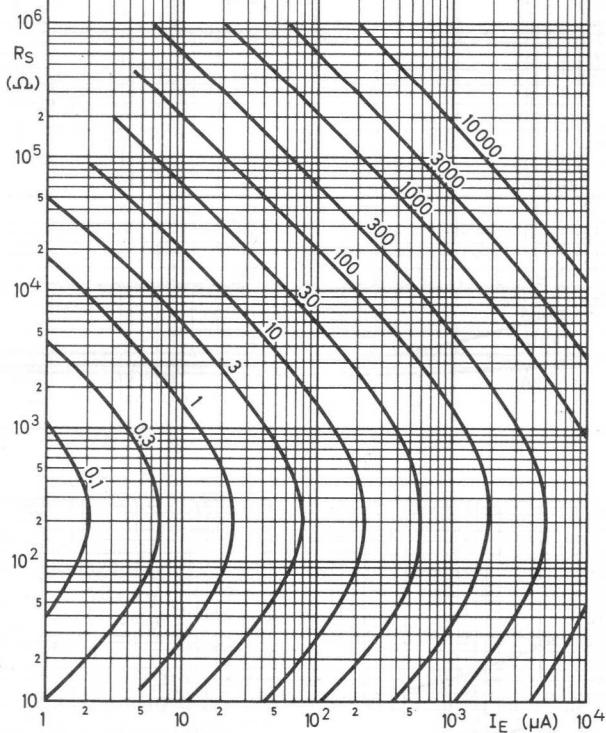


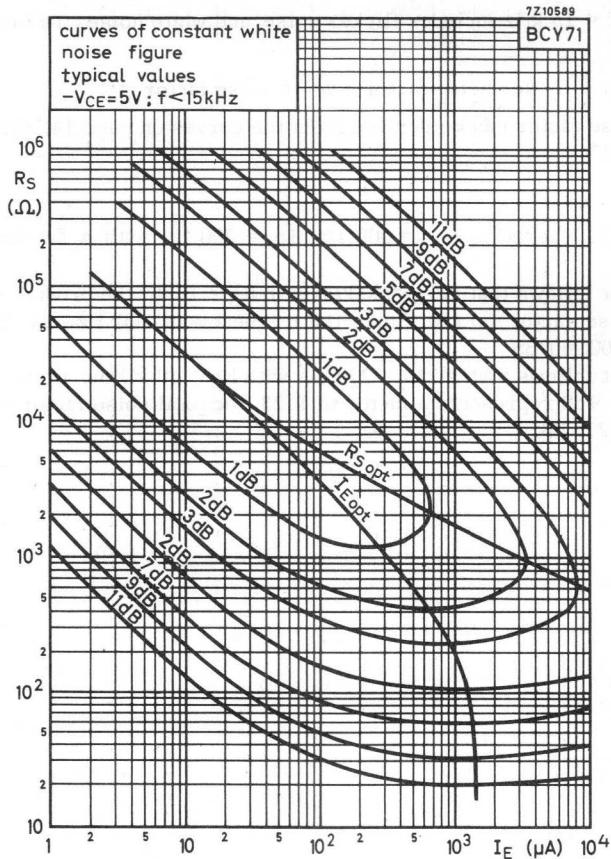


7210588

BCY71

curves of constant excess flicker
noise factor \times frequency
typical values
 $-V_{CE} = 5V$





Determination of total noise figure

Total noise at $f < 15$ kHz includes flicker noise and white noise. The relation is as follows:

$$\text{Noise factor} = 1 + \text{flicker noise factor} + \text{white noise factor}$$

The flicker noise factor can be derived from the curves on page 14, the white noise factor on page 15.

Example:

Assume a BCY71 operating at $f = 200$ Hz; $I_E = 200 \mu\text{A}$ with a source resistance $R_S = 10 \text{ k}\Omega$.

From page 14 it follows that at $I_E = 200 \mu\text{A}$ with $R_S = 10 \text{ k}\Omega$ the product of frequency and flicker noise factor is 110. Since the frequency is 200 Hz, the flicker noise factor is $110/200 = 0.55$

From page 15 it follows that at $I_E = 200 \mu\text{A}$ with $R_S = 10 \text{ k}\Omega$ the white noise figure 0.9 dB. Since 0.9 dB represents a factor of 1.23, the total noise factor = $0.55 + 1.23 = 1.78$, that is 2.5 dB.

N-P-N SILICON PLANAR DUAL TRANSISTORS FOR DIFFERENTIAL AMPLIFIERS

Matched dual n-p-n transistors in a TO-71 metal envelope with all leads insulated from the case. They are primarily intended for differential amplifier applications in general industrial service; e.g. instrumentation and control.

The product is divided in three types according to their matching accuracy.

The BCY87 and BCY88 are intended for applications in prestages of differential amplifiers where low offset, drift and noise are of prime importance. The BCY89 is for second stages, long tail pairs and more general purposes.

QUICK REFERENCE DATA

Ratings

Collector-base voltage (open emitter)	V _{CBO}	max.	45	V
Collector-emitter voltage (open base)	V _{CEO}	max.	40	V
Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max.	150	mW
Junction temperature	T _j	max.	175	°C

Characteristics of the complete device with collector-base voltage of 10 V and sum of emitter currents from 10 to 100 µA.

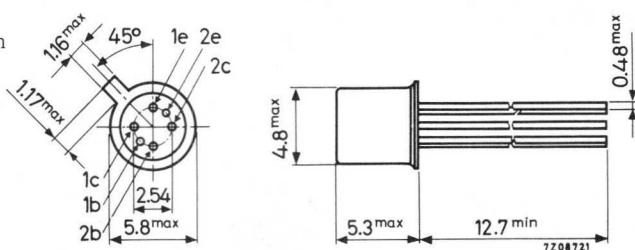
		BCY87	BCY88	BCY89
Ratio of collector currents at V _{1B-1E} = V _{2B-2E}	I _{1C} /I _{2C}	0.9-1.11	0.8-1.25	0.67-1.5
Base current difference at V _{1B-1E} = V _{2B-2E}	I _{1B} -I _{2B}	< 25	80	300 nA
Equivalent differential voltage change with temperature	$\left \frac{\Delta V}{\Delta T} \right l$	< 3	6	10 µV/°C
Equivalent differential current change with temperature	$\left \frac{\Delta I}{\Delta T} \right l$	< 0.5	2	10 nA/°C

MECHANICAL DATA

TO-71

All leads insulated from
the case

Accessories available:
56263



1) T_{amb} = -20 to +90 °C

Dimensions in mm

BCY87 to 89

RATINGS see page 7

CHARACTERISTICS of the individual transistors

T_{amb} = 25 °C unless otherwise specified

		BCY87	BCY88	BCY89
<u>Collector cut-off currents</u>				
I _E = 0; V _{CB} = 20 V; T _{amb} = 90 °C	I _{CBO}	< 5	20	- nA
I _E = 0; V _{CB} = 20 V	I _{CBO}	< -	-	10 nA
<u>D.C. current gain</u>				
I _C = 5 μA; V _{CB} = 10 V	h _{FE}	> 80	-	-
I _C = 50 μA; V _{CB} = 10 V	h _{FE}	> 100 < 450	100 450	100 450
I _C = 500 μA; V _{CB} = 10 V	h _{FE}	> - < -	120 600	-
I _C = 10 mA; V _{CB} = 10 V	h _{FE}	> - < -	-	100 600
<u>Transition frequency</u>				
-I _E = 50 μA; V _{CB} = 10 V	f _T	> 10	10	10 MHz
-I _E = 500 μA; V _{CB} = 10 V	f _T	> 50	50	50 MHz
<u>Collector capacitance at f = 1 MHz</u>				
I _E = I _e = 0; V _{CB} = 10 V	C _c	< 3.5	3.5	3.5 pF
<u>Noise figures</u>				
I _C = 50 μA; V _{CE} = 5 V; R _S = 10 kΩ Bandwidth 10 Hz to 15 kHz	F	< 3	4	4 dB
1 kHz spot noise figure I _C = 50 μA; V _{CE} = 5 V; R _S = opt. Bandwidth = 200 Hz	F	< 4	5	5 dB

CHARACTERISTICS of the complete device.

These characteristics are valid under the following conditions:

- Collector-base voltage of both transistors not exceeding 10 V ($V_{1C-1B} = V_{2C-2B} \leq 10$ V)
- Sum of the emitter currents from 10 to 100 μ A
 $-(I_{1E} + I_{2E}) = 10$ to 100 μ A

MATCHING CHARACTERISTICS

Ratio of collector currents

$$V_{1B-1E} = V_{2B-2E}$$

$$I_{1C}/I_{2C}$$

BCY87

BCY88

BCY89

Difference between base-emitter voltages

$$I_{1C} = I_{2C}$$

$$|V_{1B-1E} - V_{2B-2E}| < 3$$

6

10 mV

Difference between base currents

$$V_{1B-1E} = V_{2B-2E}$$

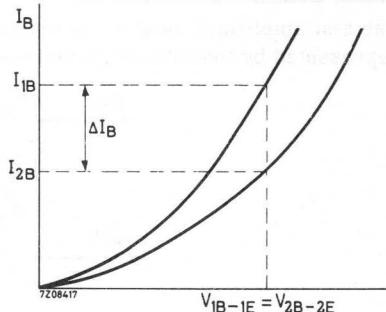
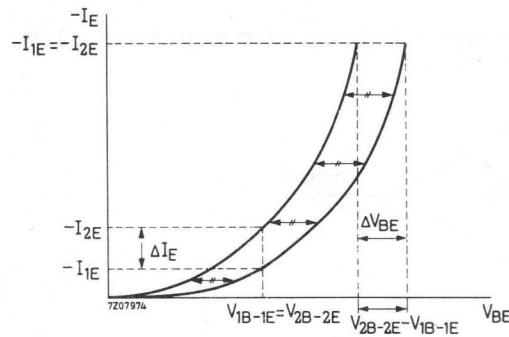
$$|I_{1B} - I_{2B}|$$

< 25

80

300 nA

Illustration of matching characteristics:



$$\frac{I_{2E}}{I_{1E}} = \exp. \frac{q}{KT} \cdot \Delta V_{BE}$$

$$\frac{I_{2E}}{I_{1E}} \text{ measured at } \Delta V_{BE} = 0$$

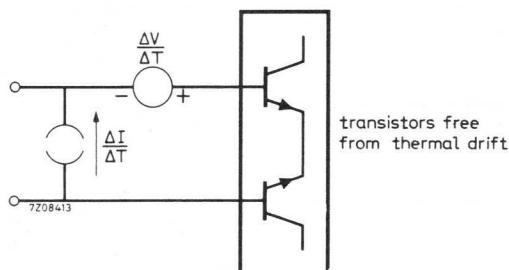
$$\Delta V_{BE} \text{ measured at } \frac{I_{2E}}{I_{1E}} = 1$$

CHARACTERISTICS of the complete device (continued)

Equivalent circuit for drift

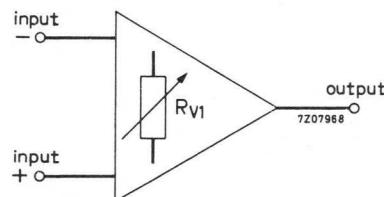
In the equivalent circuit the transistors are considered to be drift free.
All temperature coefficients are concentrated in the voltage source $\frac{\Delta V}{\Delta T}$ and in the current source $\frac{\Delta I}{\Delta T}$

It should be noted that the differential current change given is only valid when the source resistances are almost equal; the differential voltage change only when the base-emitter voltages are almost equal.



Block symbol of test amplifier

The test amplifier, used in the tests on page 5, is described on pages 6 and 7. It is represented by the following amplifier symbol:



CHARACTERISTICS of the complete device (continued)Equivalent differential voltage change with temperatureT_{amb} = -20 to +90 °C

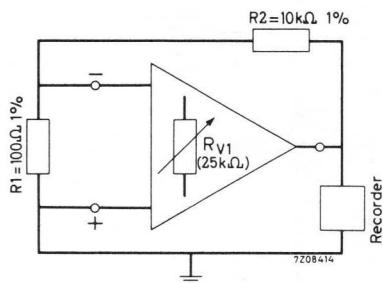
	BCY87	BCY88	BCY89
$\left \frac{\Delta V}{\Delta T} \right $ typ.	1 < 3	2 6	4 10 $\mu\text{V}/^\circ\text{C}$ $\mu\text{V}/^\circ\text{C}$

Equivalent differential current change with temperatureT_{amb} = -20 to +90 °C

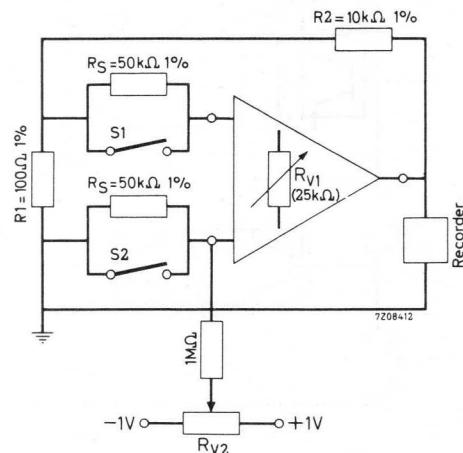
$\left \frac{\Delta I}{\Delta T} \right $	< 0.5	2	10 nA/°C
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Test methods

$$\frac{\Delta V}{\Delta T}$$



$$\frac{\Delta I}{\Delta T}$$

NOTE

To prevent contact potentials,
connections should be soldered.

Amplification factor determined by feedback circuit: $\frac{R_2}{R_1} = 100$

Output voltage against time is recorded.

The temperature of the amplifier is adjusted to T₁ between -20 and +90 °C. When it has stabilized, the output voltage is brought to zero ($|V_{T1}| < 1 \text{ mV}$). The amplifier temperature is then adjusted to T₂ between -20 and +90 °C. When it has stabilized the output voltage can be read off.

Then: $\frac{\Delta V}{\Delta T} = \frac{V_{T2} - V_{T1}}{T_2 - T_1} \cdot \frac{R_1}{R_2}$ or $\frac{\Delta I}{\Delta T} = \frac{V_{T2} - V_{T1}}{T_2 - T_1} \cdot \frac{R_1}{R_2} \cdot \frac{1}{2R_S}$

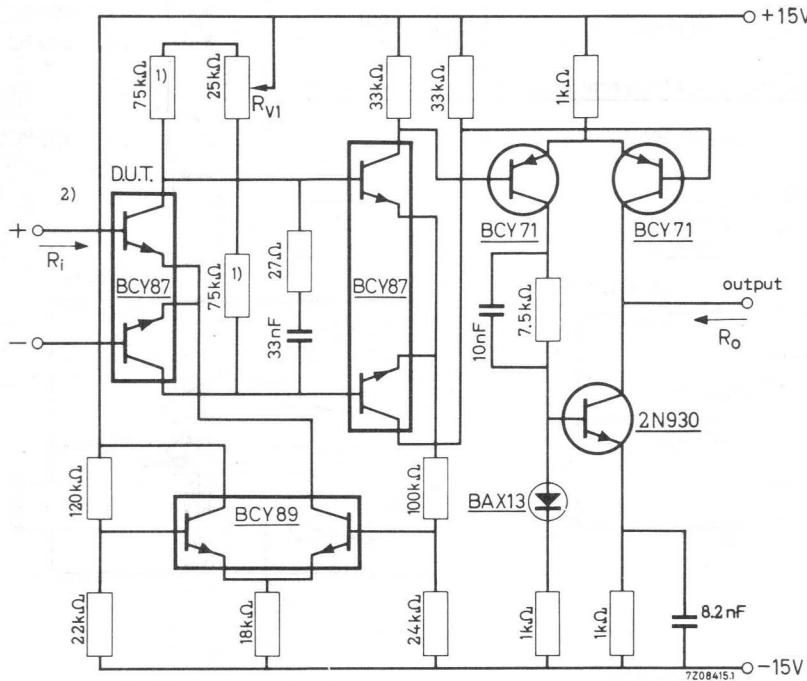
1) For $\frac{\Delta V}{\Delta T}$: adjusted by RV₁

For $\frac{\Delta I}{\Delta T}$: first by RV₁ with S1 and S2 closed, then by RV₂ with the switches open.

BCY87 to 89

Differential test-amplifier

The test amplifier (including feedback resistors, source-resistors and biasing resistors) should be mounted in a small box to ensure a uniform temperature throughout.

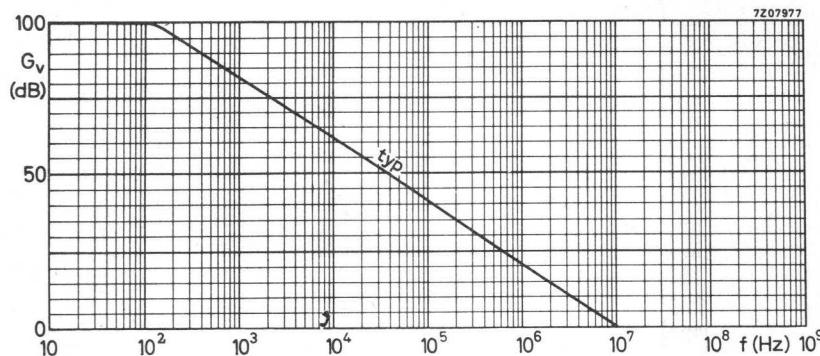


1) Relative temperature coefficient $< 10^{-5}/^{\circ}\text{C}$

2) The device at the input is the device under test

Performance of the test amplifier

Open loop voltage gain ($Z_L = 10 \text{ k}\Omega$)	G_V	typ.	10^5
Frequency at which $G_V = 1$	f_1	typ.	10 MHz
Max. common mode input voltage range			$\pm 10 \text{ V}$
Max. output current			$\pm 2.5 \text{ mA}$
Max. output voltage			$\pm 10 \text{ V}$
Input resistance	R_i		$100 \text{ k}\Omega$
Output resistance	R_o	typ.	$20 \text{ k}\Omega$
Common mode rejection ratio			10^5

RATINGS (Limiting values)¹⁾Voltages (each transistor)

Collector-base voltage (open emitter)	V_{CBO}	max.	45 V
Collector-emitter voltage (open base) $I_C = 10 \text{ mA}$	V_{CEO}	max.	40 V
Emitter-base voltage (open collector)	V_{EBO}	max.	5 V

Currents (each transistor)

Collector current (d.c.)	I_C	max.	30 mA
Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max.	150 mW

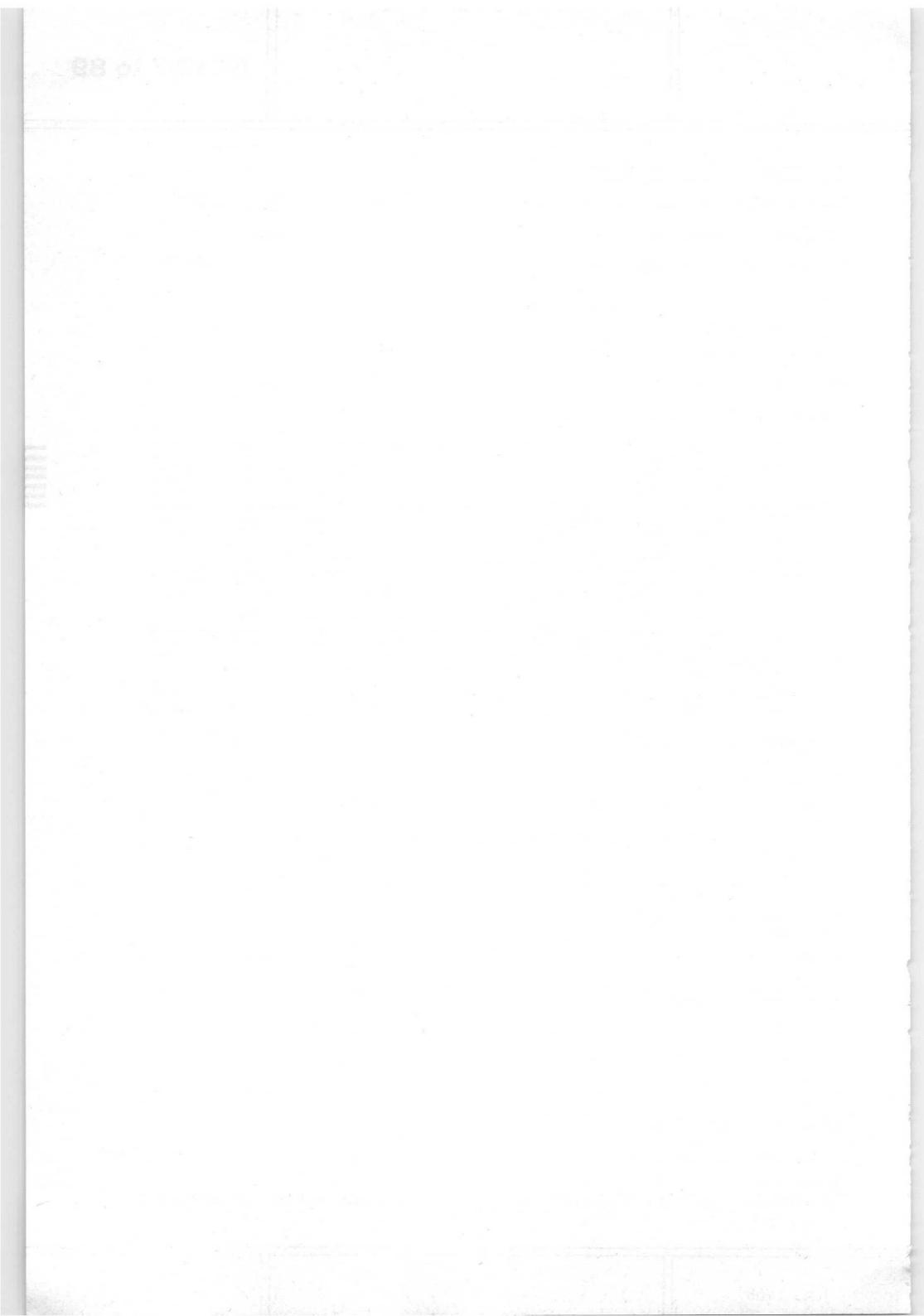
Temperatures

Storage temperature	T_{stg}	max.	175°C
Junction temperature	T_j	max.	175°C

THERMAL RESISTANCE

From junction to ambient $R_{th j-a} = 1^\circ\text{C}/\text{mW}$

1) Limiting values according to the Absolute Maximum System as defined in IEC publication 134.



P-N-P SILICON TRANSISTORS

P-N-P silicon transistors in an all-glass construction with external metal can. They are intended for use in audio amplifiers and general industrial applications.

RATINGS (Limiting values)

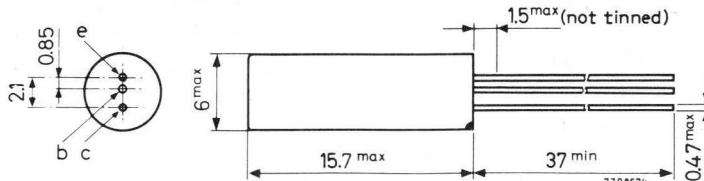
		BCZ10	BCZ11	BCZ12
Collector-base voltage (open emitter)	-V _{CBO}	max. 25	25	60 V
Collector-emitter voltage (open base)	-V _{CEO}	max. 25	25	60 V
Emitter-base voltage (open collector)	-V _{EBO}	max. 20	20	30 V
Collector current (d.c. or average over any 20 ms period)	-I _C	max.	50 mA	
Collector current (peak value)	-I _{CM}	max.	50 mA	
Base current (d.c. or average over any 20 ms period)	-I _B	max.	15 mA	
Base current (peak value)	-I _{BM}	max.	15 mA	
Total power dissipation up to T _{amb} = 25 °C in free air	P _{tot}	max.	250 mW	
Storage temperature	T _{stg}		-55 to +150	°C
Junction temperature	T _j	max.	150	°C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a} =	0.5 °C/mW
From junction to ambient with cooling fin 56210	R _{th j-a} =	0.42 °C/mW
From junction to case	R _{th j-c} =	0.35 °C/mW

MECHANICAL DATA

Dimensions in mm



The coloured dot indicates the collector

Accesssories available: 56200; 56208; 56209; 56210; 56226; 56227.

CHARACTERISTICS		$T_j = 25^\circ\text{C}$ unless otherwise specified							
			BCZ10		BCZ11		BCZ12		
<u>Collector cut-off current</u>		$I_E = 0; -V_{CB} = 10 \text{ V}$	-ICBO	typ. <	1 100	1 100	10 100	nA nA	
$I_E = 0; -V_{CB} = 10 \text{ V}; T_j = 100^\circ\text{C}$			-ICBO	typ. <	0.1 10	0.1 10	0.1 10	μA μA	
<u>Emitter cut-off current</u>		$I_C = 0; -V_{EB} = 10 \text{ V}$	-IEBO	typ. <	1 100	1 100	10 100	nA nA	
$I_C = 0; -V_{EB} = 10 \text{ V}; T_j = 100^\circ\text{C}$			-IEBO	typ. <	0.1 10	0.1 10	0.1 10	μA μA	
<u>Knee voltage</u>		$-I_C = 7 \text{ mA}; -I_B = 1 \text{ mA}$	-V _{CESat}	typ. <	130 320	100 320	130 320	mV mV	
<u>Collector-base capacitance</u>			$C_{b'c}$	typ. <	45 80	50 80	40 80	pF pF	
<u>Cut-off frequency</u>		$-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$	f_{hfb}	> typ. <	0.3 1.0 3.5	1.0 1.5 -	- 1.0 -	MHz MHz MHz	
<u>Base resistance</u>				$r_{bb'}$	typ. <	125 350	125 350	Ω Ω	
<u>Emitter resistance</u>		$-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$	$Re(h_{ib})$	typ.	-	-	25	Ω	
<u>Noise figure at $f = 1 \text{ kHz}$</u>									
$-I_C = 0.5 \text{ mA}; -V_{CE} = 2 \text{ V}$ $R_S = 500 \Omega$		$-I_C = 1 \text{ mA}; -V_{CE} = 6 \text{ V}$	F	typ.	8.0	6.0	8.0	dB	
<u>Small signal current gain at $f = 1 \text{ kHz}$</u>			h_{fe}	> typ. <	15 20 60	25 35 60	10 15 -		

GERMANIUM TRANSISTORS

P-N-P transistors in a metal envelope intended for a.f. medium power class A and B output stages.

Type 2-OC72 consists of two transistors OC72 selected for low distortion class B operation.

RATINGS (Limiting values)

Voltages

Collector-base voltage (open emitter)	$-V_{CBO}$	max.	32	V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	16	V
Collector-emitter voltage ($R_{BE} < 1 \text{ k}\Omega$)	$-VCER$	max.	32	V
Emitter-base voltage (open collector)	$-VEBO$	max.	10	V

Currents

Collector current (d.c. or average over any 20 ms period)	$-I_C$	max.	125	mA
Collector current (peak value)	$-ICM$	max.	250	mA
Emitter current (peak value)	I_EM	max.	250	mA
Base current (peak value)	$ IBM $	max.	125	mA

Power dissipation

Total power dissipation up to $T_{amb} = 25^\circ\text{C}$ with cooling fin 56200	P_{tot}	max.	165	mW
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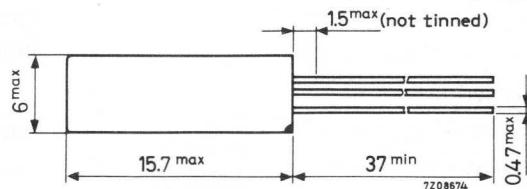
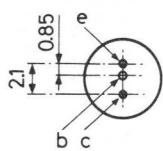
Temperatures

Storage temperature	T_{stg}	-55 to +75	$^\circ\text{C}$
Junction temperature: continuous	T_j	max.	75 $^\circ\text{C}$
incidentally	T_j	max.	90 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to ambient in free air	$R_{th j-a}$	=	0.4	$^\circ\text{C}/\text{mW}$
From junction to ambient with cooling fin 56200 on a heatsink 12.5 cm ²	$R_{th j-a}$	=	0.3	$^\circ\text{C}/\text{mW}$

MECHANICAL DATA



Dimensions in mm

The coloured dot indicates the collector

FOR REPLACEMENT THE SUCCESSOR TYPE
2-AC132 IS RECOMMENDED

CHARACTERISTICS

T_{amb} = 25 °C

Collector cut-off currents

I_E = 0; -V_{CB} = 10 V

-I_{CBO} typ. 4.5 μA
< 10 μA

I_B = 0; -V_{EB} = 6 V

-I_{CEO} typ. 125 μA
50 to 300 μA

Emitter cut-off current

I_C = 0; -V_{EB} = 10 V

-I_{EBO} typ. 4.5 μA
< 10 μA

Base-emitter voltage

-I_C = 1.5 mA; -V_{CE} = 6 V

-V_{BE} 130 to 170 mV

-I_C = 80 mA; -V_{CE} = 0.7 V

-V_{BE} < 450 mV

-I_C = 125 mA; -V_{CE} = 0.7 V

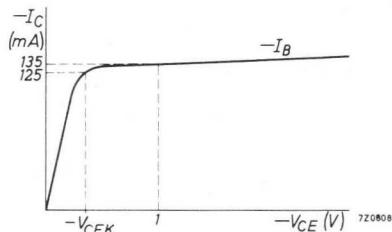
-V_{BE} < 700 mV

Knee voltage

-I_C = 125 mA; -I_B = value for which

-V_{CEK} < 400 mV

-I_C = 135 mA at -V_{CE} = 1 V



D.C. current gain

-I_C = 10 mA; -V_{CE} = 5.4 V

h_{FE} typ. 70
45 to 120

-I_C = 80 mA; -V_{CE} = 0.7 V

h_{FE} typ. 50
30 to 90

-I_C = 125 mA; -V_{CE} = 0.7 V

h_{FE} > 25

-I_C = 250 mA; -V_{CE} = 1 V

h_{FE} > 15

Cut-off frequencies

I_E = 10 mA; -V_{CB} = 6 V

f_{hf_b} > 350 kHz

-I_C = 10 mA; -V_{CE} = 6 V

f_{hf_e} > 8 kHz

Noise figure at f = 1 kHz

I_E = 0.5 mA; -V_{CE} = 2 V; R_S = 500 Ω

F < 15 dB

D.C. current gain ratio of matched pair 2-OC72

h_{FE1/h_{FE2}} typ. 1.15
1.0 to 1.3

GERMANIUM TRANSISTORS

P-N-P transistors in all-glass construction with metal cover. They are intended for class A and B output stages at battery voltages up to 9 V and power outputs up to 1 W. Type 2-OC74 consists of 2 transistors OC74 selected for low distortion class B operation with low spread in base-emitter voltages.

RATINGS (Limiting values)

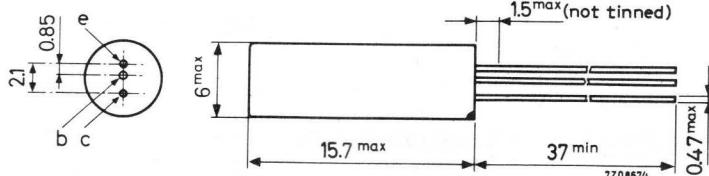
Collector-base voltage (open emitter)	$-V_{CBO}$	max.	20	V
Collector-emitter voltage ($R_{BE} < 500 \Omega$)	$-V_{CER}$	max.	20	V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	6	V
Collector current (d.c. or average over any 20 ms period)	$-I_C$	max.	300	mA
Emitter current (d.c. or average over any 20 ms period)	I_E	max.	310	mA
Total power dissipation up to $T_{amb} = 25^\circ\text{C}$ with cooling fin 56200 on heatsink $\geq 12.5 \text{ cm}^2$	P_{tot}	max.	550	mW
Storage temperature	T_{stg}	-55 to +75		$^\circ\text{C}$
Junction temperature: continuous incidentally	T_j	max.	75	$^\circ\text{C}$
	T_j	max.	90	$^\circ\text{C}$

THERMAL RESISTANCE

From junction to ambient in free air	$R_{th j-a}$	=	0.22	$^\circ\text{C}/\text{mW}$
From junction to ambient with cooling fin 56200 on heatsink $\geq 12.5 \text{ cm}^2$	$R_{th j-a}$	=	0.09	$^\circ\text{C}/\text{mW}$

MECHANICAL DATA

Dimensions in mm



The coloured dot indicates the collector

FOR REPLACEMENT THE SUCCESSOR TYPES AC128, AC188 ARE RECOMMENDED

CHARACTERISTICS

T_{amb} = 25 °C unless otherwise specified

Collector cut-off current

I_E = 0; -V_{CB} = 9 V -I_{CBO} < 20 μA

I_E = 0; -V_{CB} = 9 V; T_j = 60 °C -I_{CBO} < 330 μA

Emitter cut-off current

I_C = 0; -V_{EB} = 6 V -I_{EBO} < 20 μA

I_C = 0; -V_{EB} = 6 V; T_j = 60 °C -I_{EBO} < 300 μA

Base-emitter voltage ¹⁾

-I_C = 5 mA; -V_{C E} = 6 V -V_{BE} 135 to 175 mV

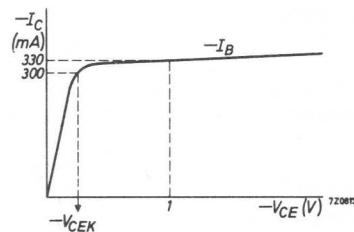
-I_C = 50 mA; -V_{C E} = 6 V -V_{BE} < 300 mV

-I_C = 300 mA; -V_{C E} = 1 V -V_{BE} < 700 mV

Knee voltage

-I_C = 300 mA; -I_B = value for which

-I_C = 330 mA at -V_{C E} = 1 V -V_{CEK} < 600 mV



D.C. current gain

-I_C = 5 mA; -V_{C E} = 6 V h_{FE} 40 to 200

-I_C = 50 mA; -V_{C E} = 6 V h_{FE} 60 to 150

-I_C = 300 mA; -V_{C E} = 1 V h_{FE} 40 to 100

Cut-off frequency

-I_C = 50 mA; -V_{C E} = 6 V f_{hfe} > 8 kHz

Noise figure at f = 1 kHz

I_E = 5 mA; -V_{CB} = 6 V F < 27 dB

D.C. current gain ratio of matched pair 2-OC74

-I_C = 50 mA; -V_{C E} = 6 V h_{FE1}/h_{FE2} typ. 1.15

< 1.3

-I_C = 300 mA; -V_{C E} = 1 V h_{FE1}/h_{FE2} typ. 1.15

< 1.3

1) -V_{BE} decreases by about 2.3 mV/°C with increasing temperature.

GERMANIUM P-N-P TRANSISTOR

Germanium transistor of the p-n-p type in all glass construction with metal envelope. It is meant for class A output and driver stages at battery voltages of up to 12 V.

RATINGS (Limiting values)

Collector-base voltage (open emitter)	$-V_{CBO}$	max.	26	V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	13	V
Collector current (d.c. and average)	$-I_C$	max.	300	mA
Total dissipation up to $T_{amb} = 25^\circ\text{C}$	P_{tot}	max.	550	mW
Junction temperature: continuous incidentally	T_j	max.	75	$^\circ\text{C}$
	T_j	max.	90	$^\circ\text{C}$

THERMAL RESISTANCE

$$\text{From junction to ambient} \quad R_{th j-a} = 0.22 \text{ } ^\circ\text{C/mW}$$

CHARACTERISTICS

D.C. current gain at $T_j = 25^\circ\text{C}$

$$-I_C = 5 \text{ mA; } -V_{CE} = 6 \text{ V} \quad h_{FE} \quad \text{typ.} \quad 50 \\ 25 \text{ to } 125$$

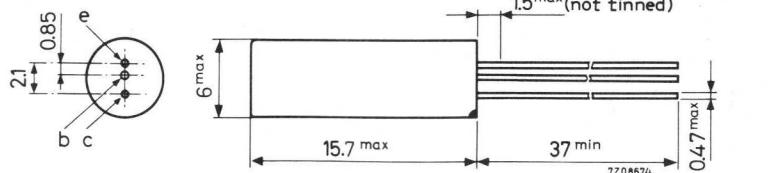
$$-I_C = 50 \text{ mA; } -V_{CE} = 6 \text{ V} \quad h_{FE} \quad \text{typ.} \quad 60 \\ 40 \text{ to } 100$$

$$-I_C = 300 \text{ mA; } -V_{CE} = 1 \text{ V} \quad h_{FE} \quad \text{typ.} \quad 40 \\ 25 \text{ to } 75$$

Cut-off frequency

$$-I_C = 50 \text{ mA; } -V_{CE} = 6 \text{ V} \quad f_{hfe} \quad \text{typ.} \quad 16 \text{ kHz} \\ > 8 \text{ kHz}$$

MECHANICAL DATA



The coloured dot indicates the collector.

FOR REPLACEMENT THE SUCCESSOR TYPES AC128, AC188 ARE RECOMMENDED

THE MANAGEMENT OF AN INVESTOR

INVESTMENT IN THE FUTURE
OF THE COMPANY

SILICON N-P-N PLANAR TRANSISTORS

N-P-N transistors in a TO-18 metal envelope with the collector connected to the case.

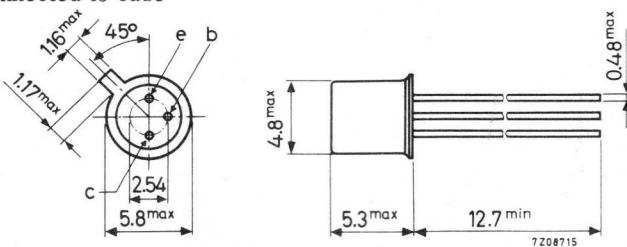
These devices are primarily intended for use in high performance, low level, low noise amplifier applications both for direct current and for frequencies of up to 100 MHz

QUICK REFERENCE DATA			
		2N929	2N930
Collector-base voltage (open emitter)	V _{CBO}	max. 45	45 V
Collector-emitter voltage (open base)	V _{CEO}	max. 45	45 V
Collector current (peak value)	I _{CM}	max. 60	60 mA
Total dissipation up to T _{amb} = 25 °C	P _{tot}	max. 300	300 mW
Junction temperature	T _j	max. 175	175 °C
D.C. current gain at T _j = 25 °C			
I _C = 10 µA; V _{CE} = 5 V	h _{FE}	40 to 120	100 to 300
I _C = 10 mA; V _{CE} = 5 V	h _{FE}	100 to 350	150 to 600
Transition frequency	f _T	typ. 80	80 MHz
I _C = 0.5 mA; V _{CE} = 5 V			
Noise figure (f = 10 Hz to 15 kHz)	F	typ. 2.5	2 dB
I _C = 10 µA; V _{CE} = 5 V; R _S = 10 kΩ		< 4	3 dB

MECHANICAL DATA

Dimensions in mm

Collector connected to case
TO-18



Accessories available: 56246, 56263.

RATINGS Limiting values in accordance with the Absolute Maximum System Voltages (IEC 134)

Collector-base voltage (open emitter)	V _{CBO}	max.	45	V
Collector-emitter voltage (open base)	V _{CEO}	max.	45	V
Collector-emitter voltage at V _{EB} = 0	V _{CES}	max.	45	V
Emitter-base voltage (open collector)	V _{EBO}	max.	5	V

Currents

Collector current (d.c. or average over any 50 ms period)	I _C	max.	30	mA
Collector current (peak value)	I _{CM}	max.	60	mA
Emitter current (d.c. or average over any 50 ms period)	-I _E	max.	35	mA
Emitter current (peak value)	-I _{EM}	max.	70	mA

Power dissipation

Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max.	300	mW
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Temperatures

Storage temperature	T _{stg}	-65 to +175	°C
Junction temperature	T _j	max.	175 °C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	=	0.5	°C/mW
From junction to case	R _{th j-c}	=	0.25	°C/mW

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current

$I_E = 0$; $V_{CB} = 45$ V
 $I_B = 0$; $V_{CE} = 5$ V
 $V_{EB} = 0$; $V_{CB} = 45$ V

$I_{CBO} < 10$ nA
 $I_{CEO} < 2$ nA
 $I_{CES} < 10$ nA

Emitter cut-off current $I_C = 0$; $V_{EB} = 5$ V $I_{EBO} < 10$ nAEmitter-base voltage $-I_E = 0.5$ mA; $V_{CB} = 5$ V $-V_{EB}$ 0.6 to 0.8 VSaturation voltages $I_C = 10$ mA; $I_B = 0.5$ mA $V_{CEsat} < 1$ V V_{BESat} 0.6 to 1 VD.C. current gain

$I_C = 10 \mu\text{A}$; $V_{CE} = 5$ V
 $I_C = 10 \mu\text{A}$; $V_{CE} = 5$ V; $T_j = -55^\circ\text{C}$
 $I_C = 500 \mu\text{A}$; $V_{CE} = 5$ V
 $I_C = 10$ mA; $V_{CE} = 5$ V

	2N929	2N930
h_{FE}	40 to 120	100 to 300
h_{FE}	> 10	> 20
h_{FE}	> 60	> 150
h_{FE}	100 to 350	150 to 600

Collector capacitance at $f = 1$ MHz $I_E = I_e = 0$; $V_{CB} = 5$ V $C_C < 8$ pFTransition frequency $I_C = 0.5$ mA; $V_{CE} = 5$ V $f_T > 50$ MHzCut-off frequency $I_C = 0.5$ mA; $V_{CE} = 5$ V $f_{hfe} > 200$ kHz

2N929
2N930**CHARACTERISTICS (continued)** $T_j = 25^{\circ}\text{C}$ unless otherwise specifiedNoise figure (f = 10 Hz to 15 kHz) $I_C = 10 \mu\text{A}; V_{CE} = 5 \text{ V}; R_S = 10 \text{ k}\Omega$

		2N929	2N930
F	typ. 2.5 < 4	2 dB	3 dB

h parameters at f = 1 kHz $I_C = 1 \text{ mA}; V_{CE} = 5 \text{ V}$

Input impedance

 h_{ie} typ. 5.0 $10.0 \text{ k}\Omega$

Reverse voltage transfer

 h_{re} typ. 2.5 $5.5 \cdot 10^{-4}$

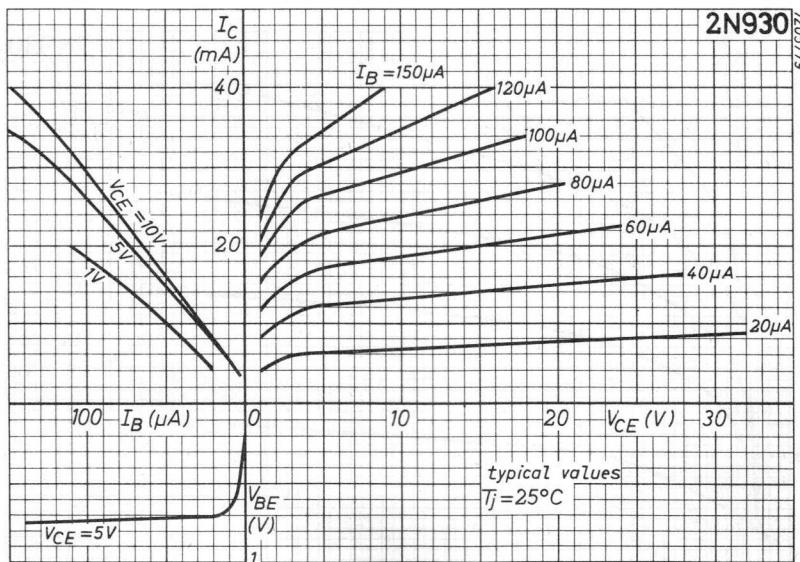
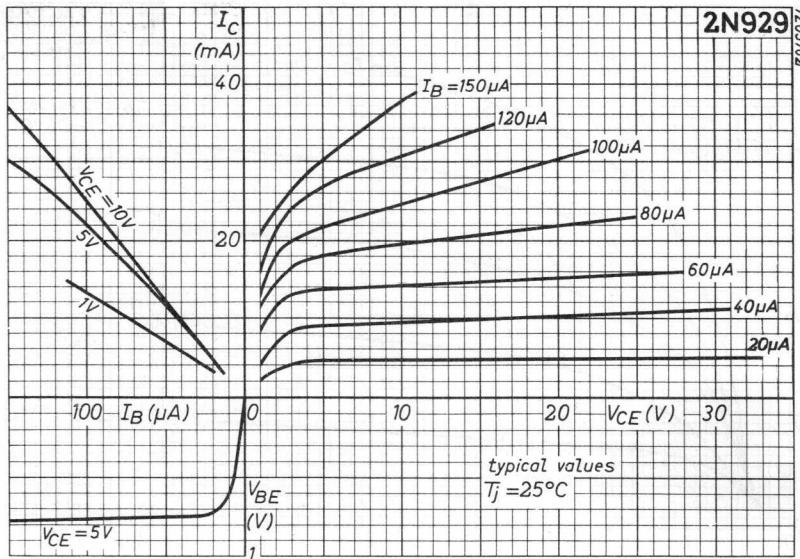
Small signal current gain

 h_{fe} typ. 200 350
60 to 350 150 to 600

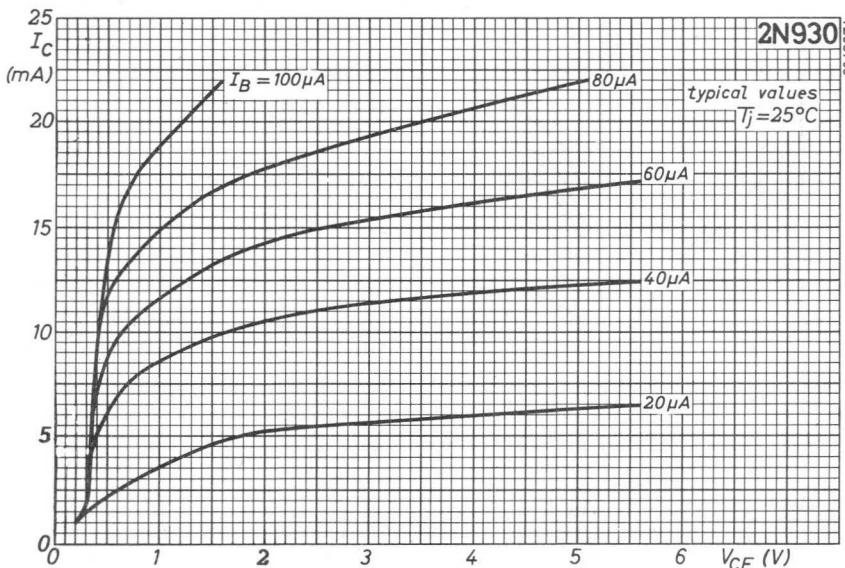
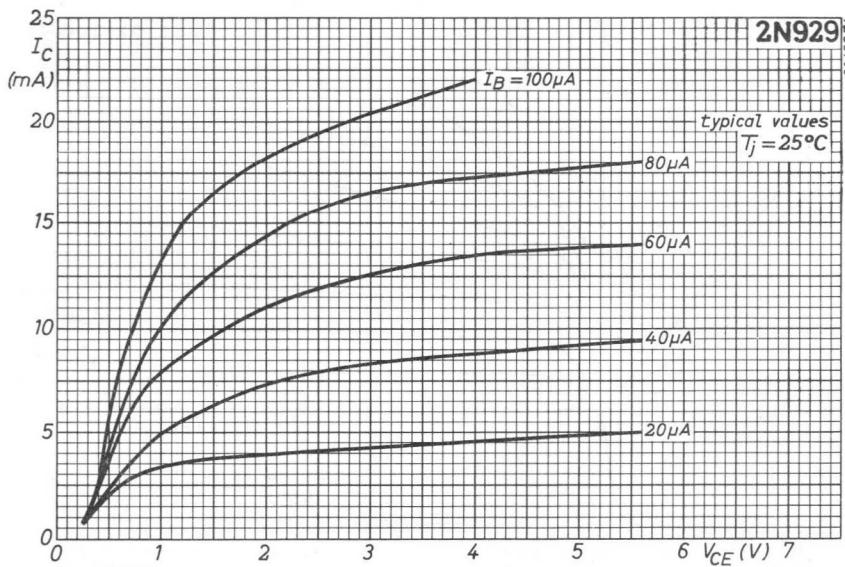
Output admittance

 h_{oe} typ. 14 $25 \mu\Omega^{-1}$

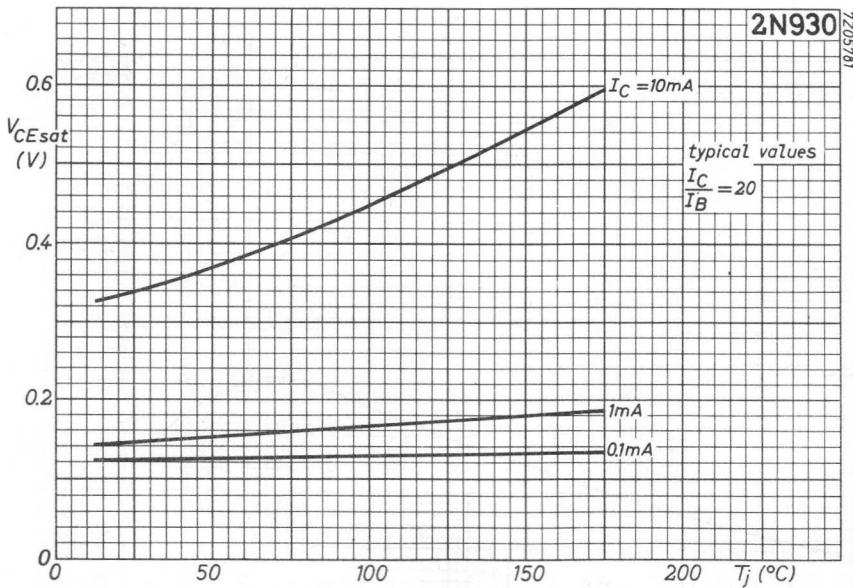
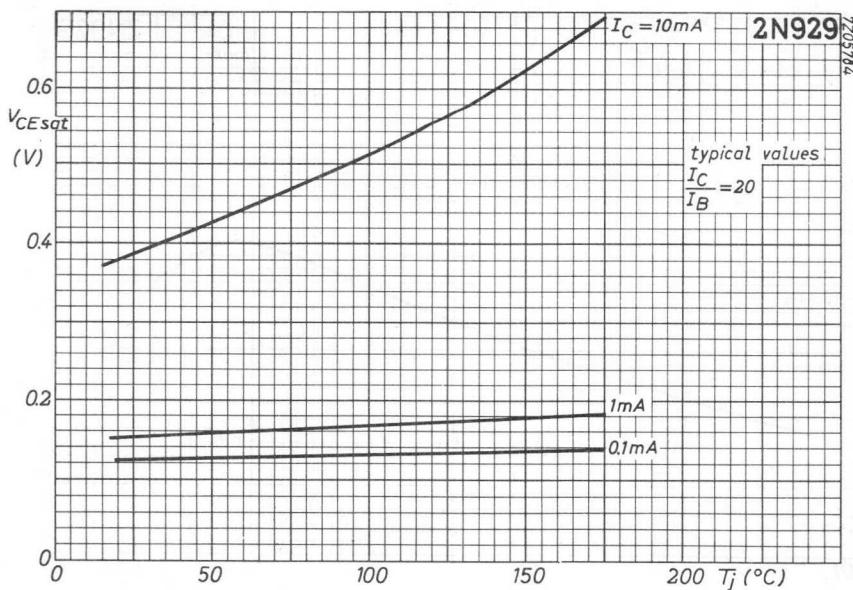
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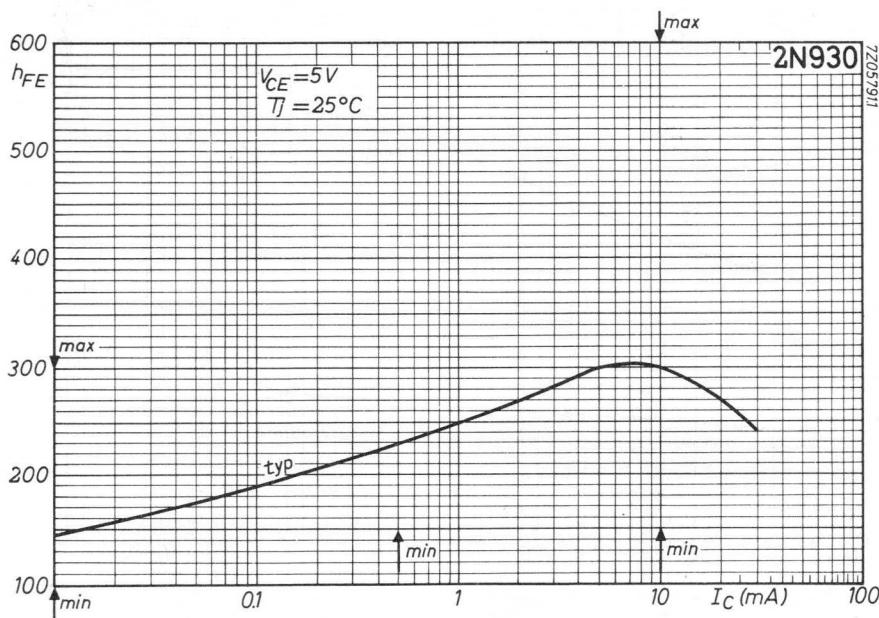
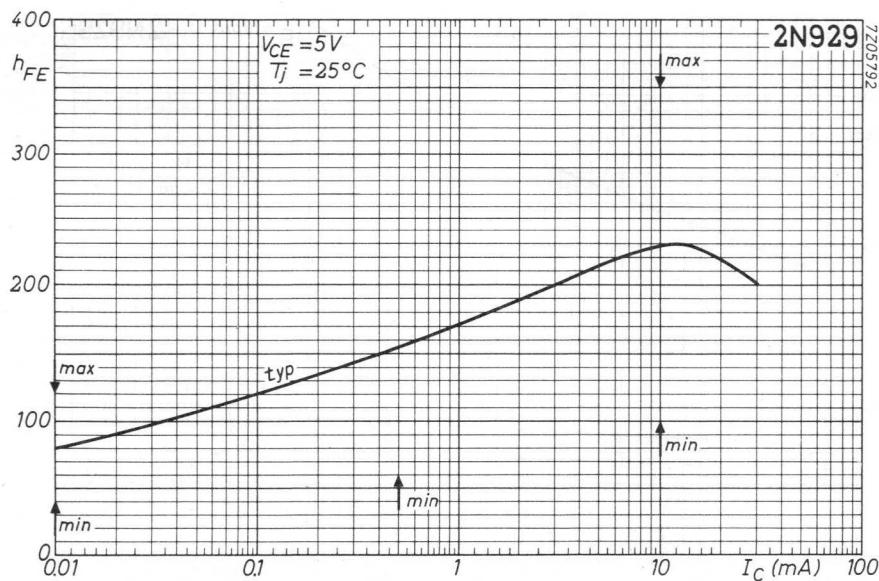
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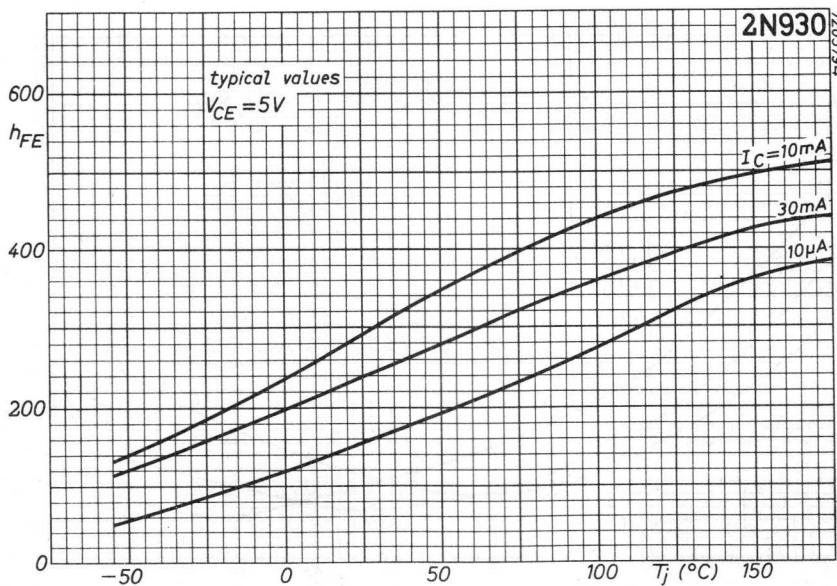
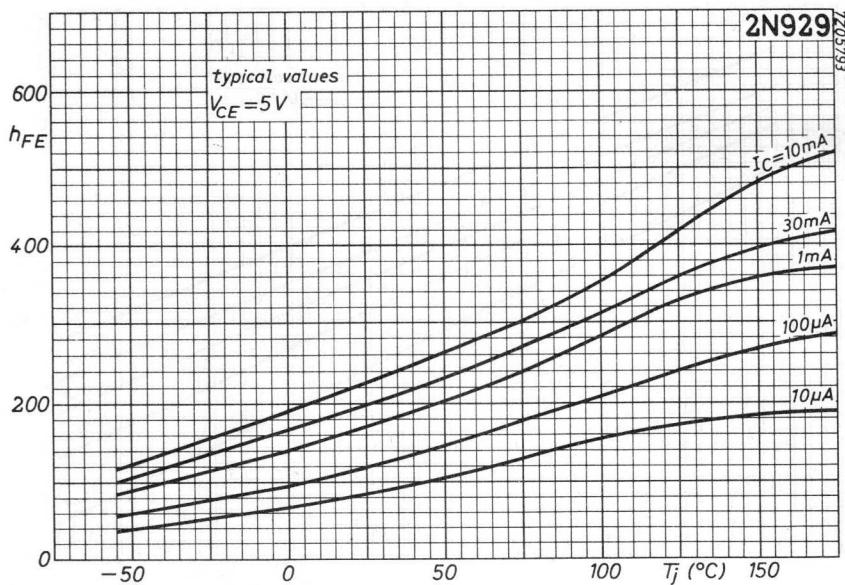


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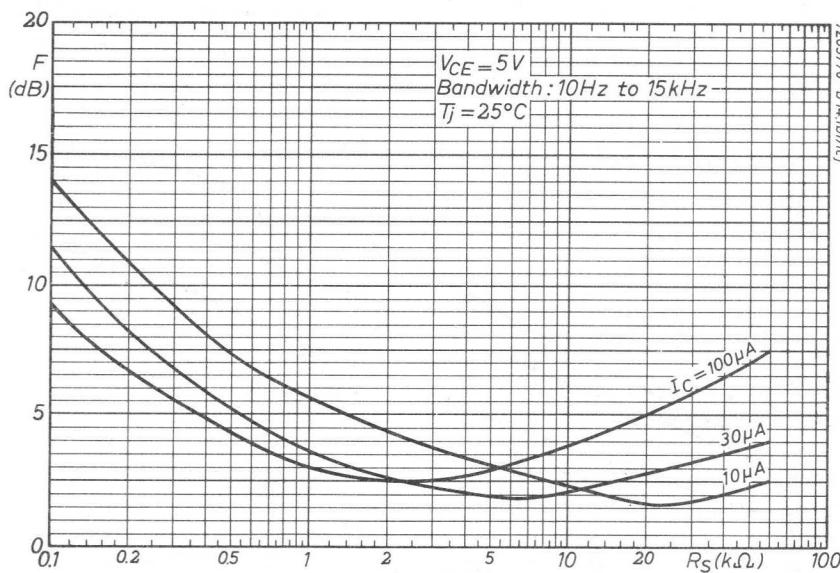
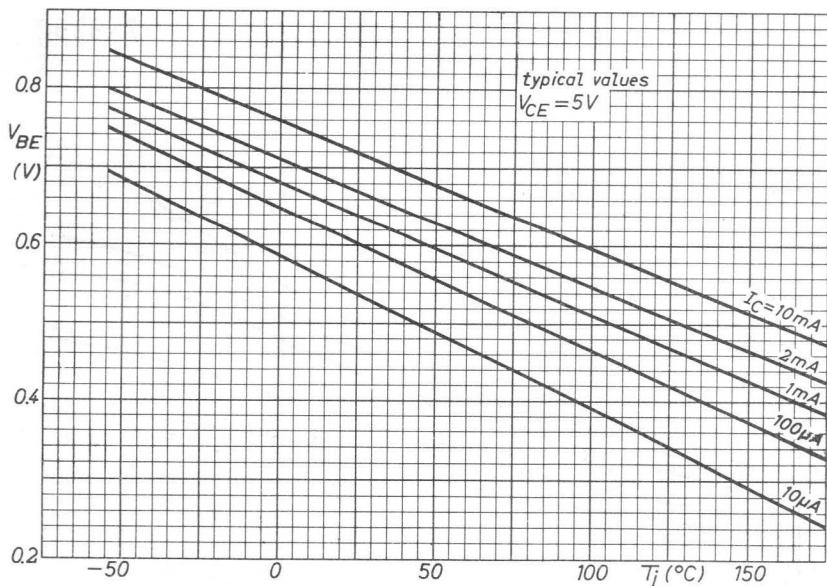


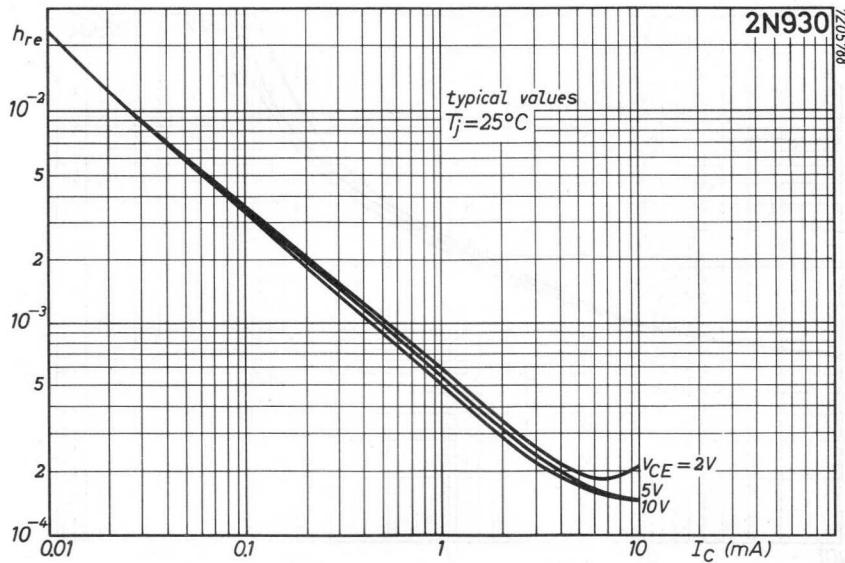
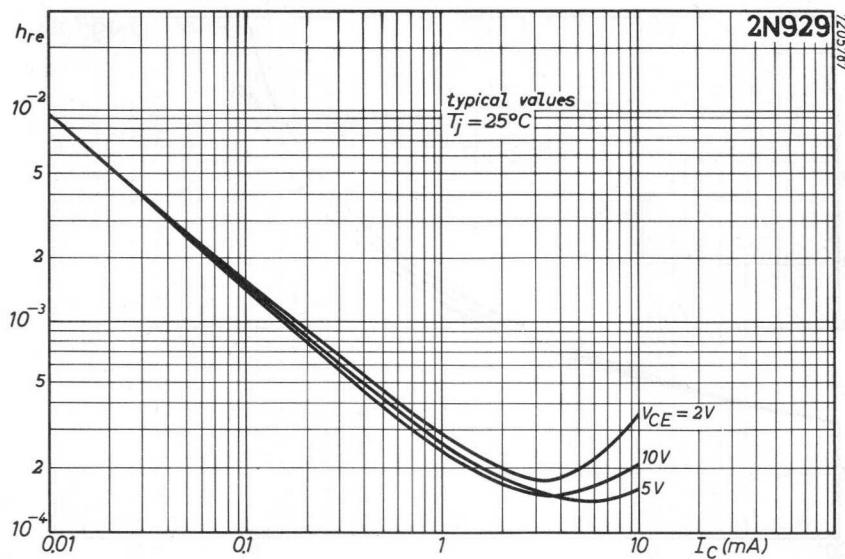
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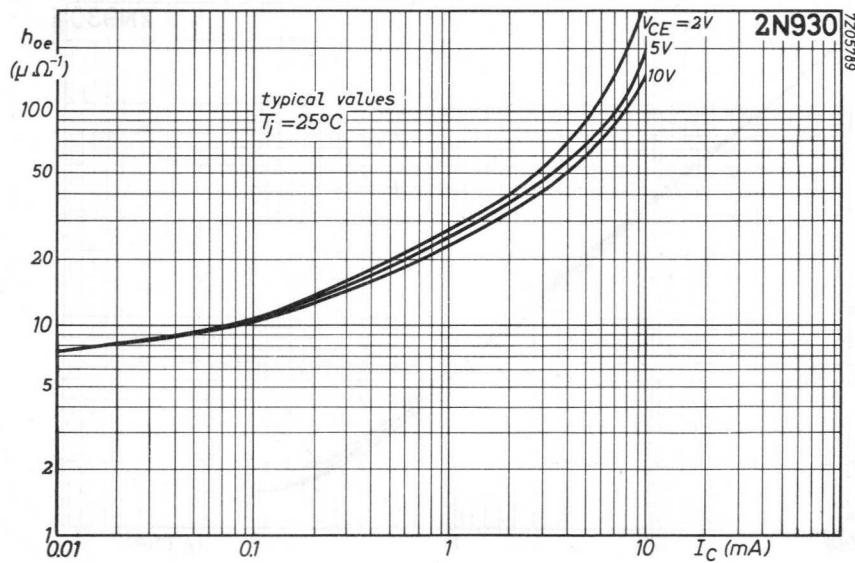
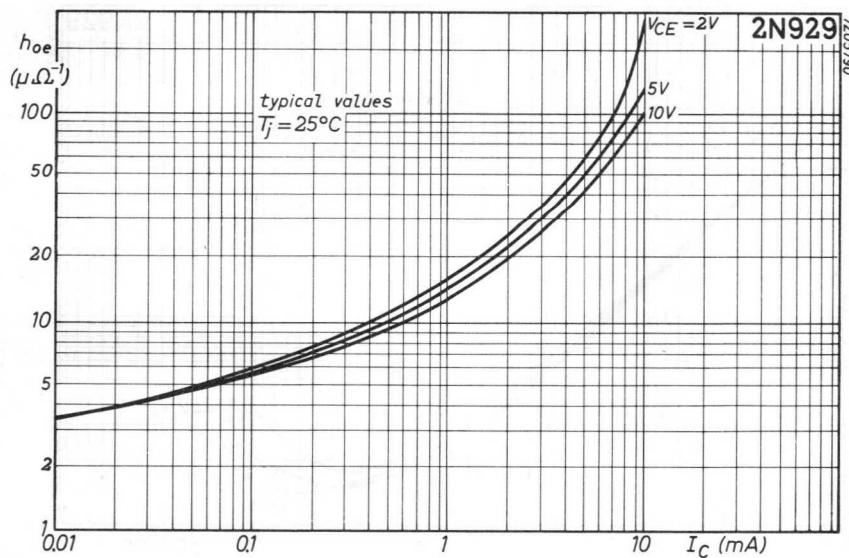


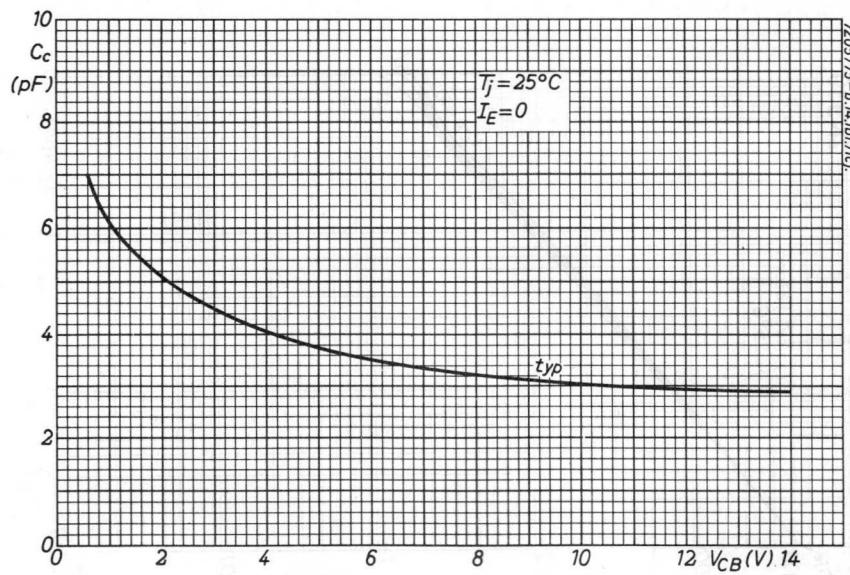
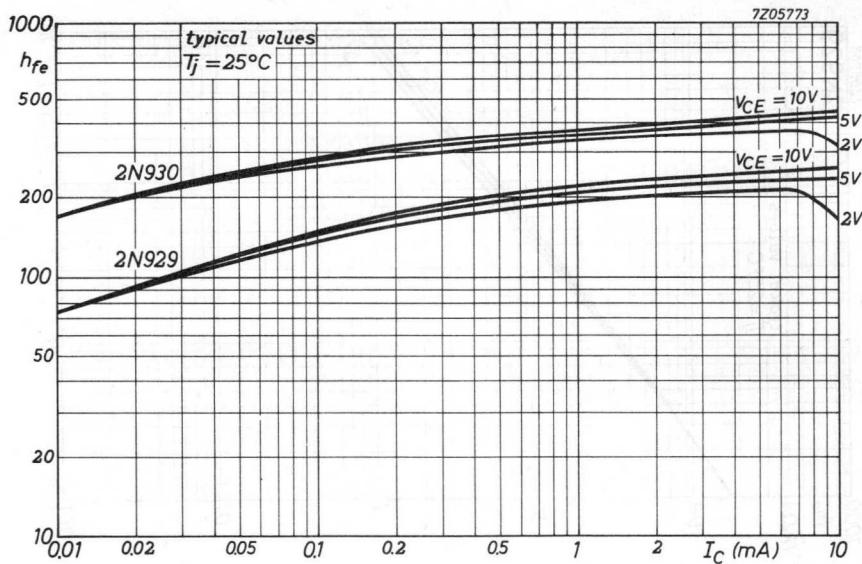
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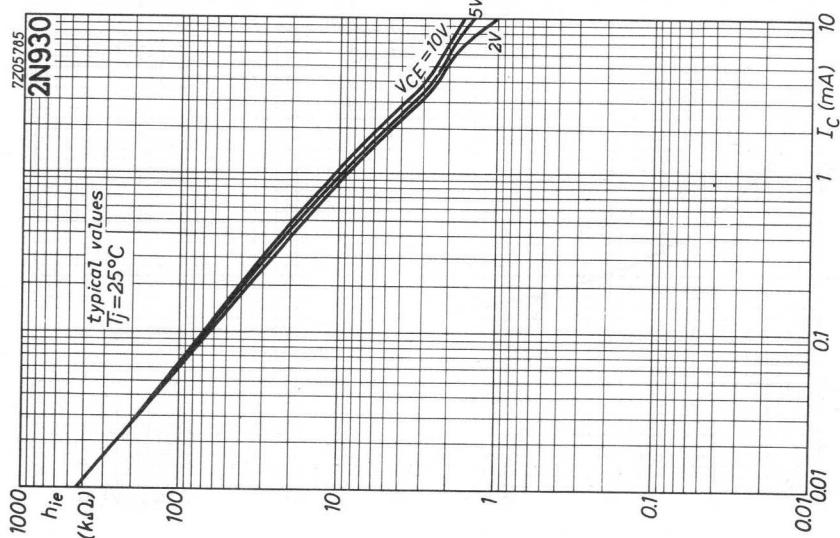
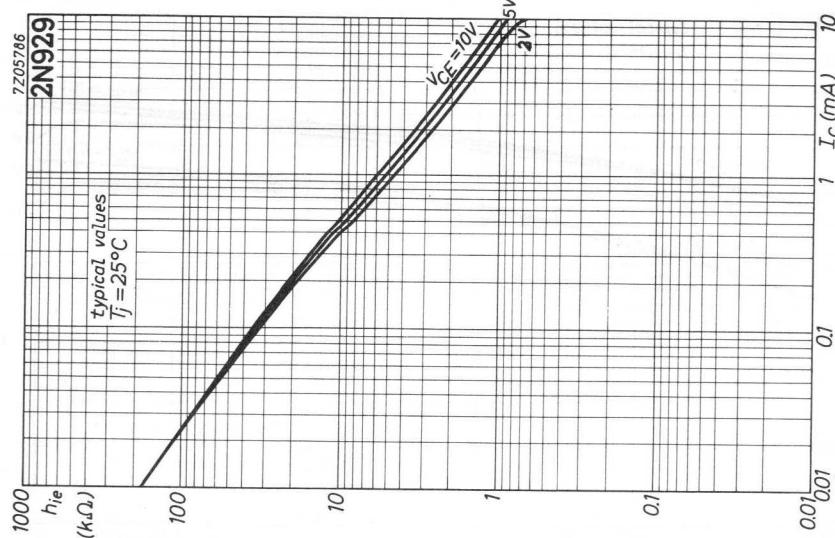


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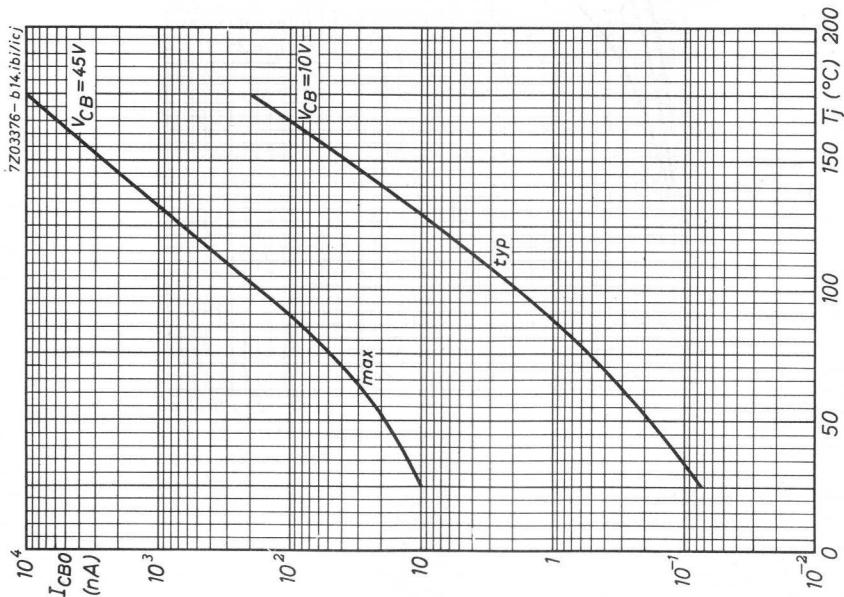
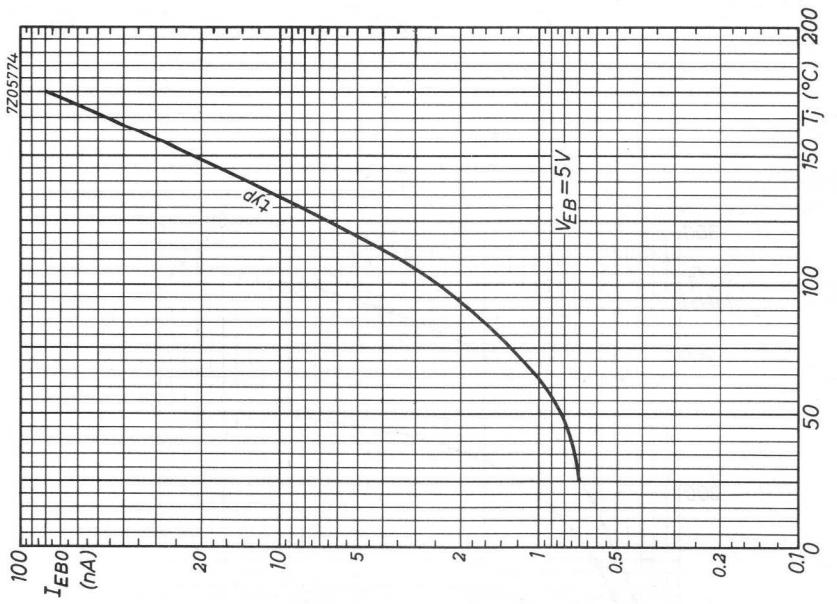




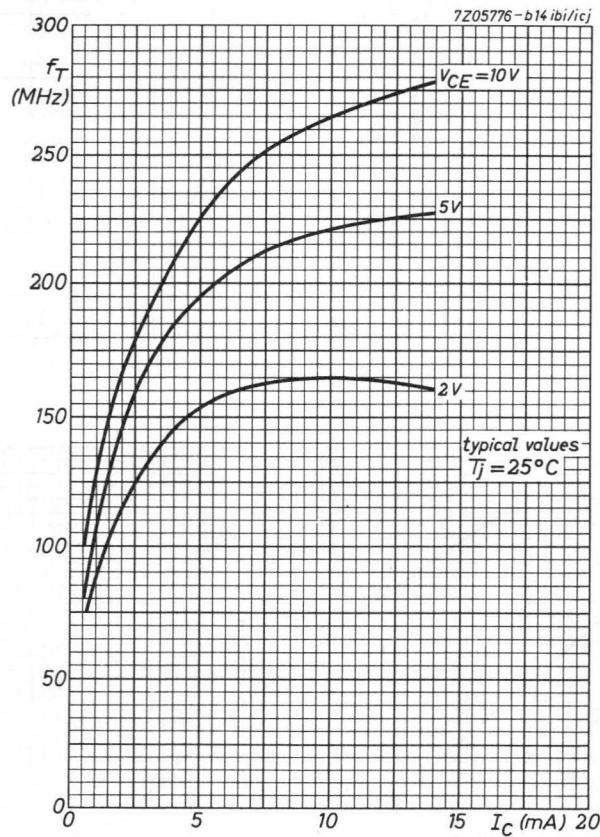
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2N929
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2 N 929
2 N 930



AUDIO FREQUENCY PACKAGE

The package 40809 comprises 4 transistors, intended for application in audio frequency d.c.-coupled amplifiers with complementary output stages with power outputs up to 1200 mW.

The matched pair AC127/AC128 (NPN/PNP, marked 3) consists of two transistors with high values of the d.c. amplification factor h_{FE} .

The AC128 (PNP, marked 2) should be used in the drive stage.

The AC127 (NPN, marked 1) is meant for use in the pre-amplifier stage.

APPLICATIONS

On the following pages four circuits are described in detail

QUICK REFERENCE DATA					
Circuit		I	II	III	IV
Supply voltage	V_S	6	6	9	9 V
Maximum output power ($d_{tot} = 10\%$)	$P_o \text{ max}$	350	700	650	1200 mW
Required input voltage ($P_o = 50 \text{ mW}$) ¹⁾					
without feedback	$V_i(\text{rms})$	1.8	2.1	1.0	1.2 mV
with 6 dB feedback	$V_i(\text{rms})$	3.5	5.0	2.5	2.0 mV

FOR DATA OF THE INDIVIDUAL TRANSISTORS
REFER TO THE DATA SHEETS OF THE AC127 AND THE AC128

1) Spread of input sensitivity < 3 dB

TYPICAL OPERATION CHARACTERISTICS (f = 1 kHz)

Circuit		I	II	III	IV	V
Supply voltage	V _S	6	6	9	9	V
Max. output power at d _{tot} = 10%	P _O max	350	700	650	1200	mW
Input voltage at P _O = 50 mW						
without feedback	V _i (rms)	1.8	2.1	1.0	1.2	mV
with 6 dB feedback	V _i (rms)	3.5	5.0	2.5	2.0	mV
Input voltage at P _O = max.						
without feedback	V _i (rms)	5.3	8.6	4.6	5.6	mV
with 6 dB feedback	V _i (rms)	10.7	20.7	10.4	10.2	mV
Zero signal collector currents ¹⁾						
of transistors 3	I _C	4	5	3	5	mA
Collector peak current at P _O max	I _{CM}	260	500	300	470	mA
Collector current of the driver						
transistor 2	-I _C	4.6	8.3	5.4	7.7	mA
Midtap voltage at B	V	3.3	3.6	4.9	4.9	V
Typical input resistance at A						
without feedback	R _i	3.8	6.0	3.3	2.8	kΩ
with 6 dB feedback	R _i	7.3	11.5	6.4	4.3	kΩ

Stable continuous operation is ensured up to T_{amb} = 45 °C, provided the output transistors are mounted as indicated in the following table

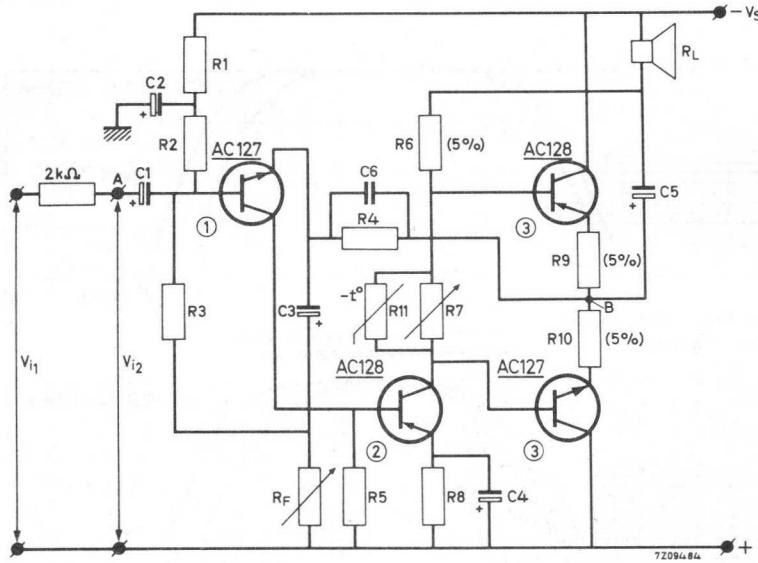
	I	II	III	IV
AC127	A	C	B	C
AC128	A	A	A	B

A = without cooling fin or heatsink in free air

B = with cooling fin (Type No.56227)

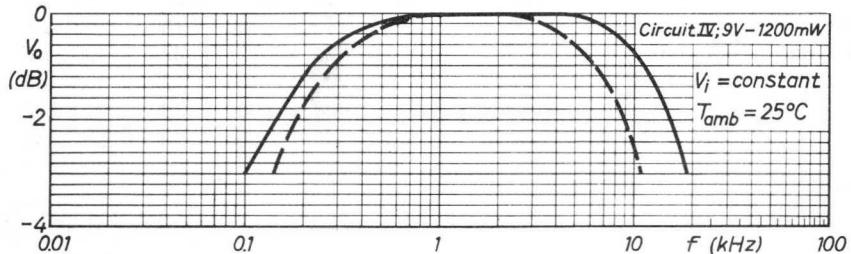
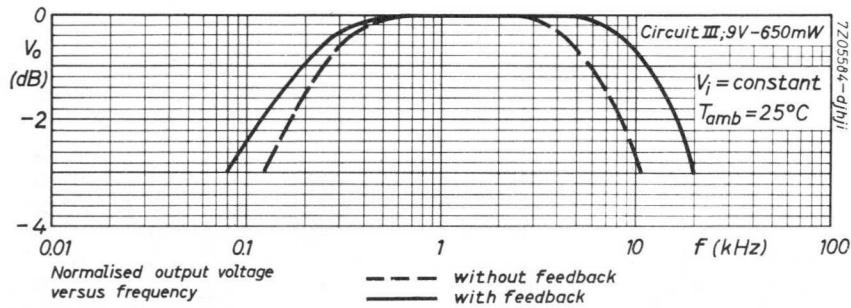
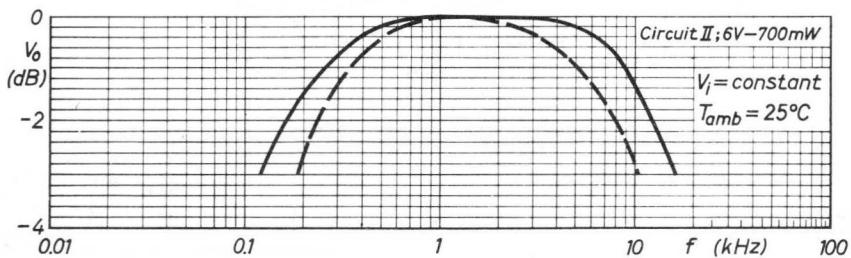
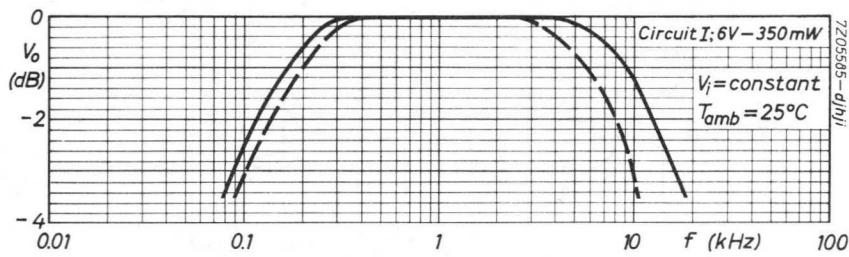
C = with cooling fin (Type No.56227) mounted on a 1.5 mm aluminium heatsink of at least 12.5 cm²

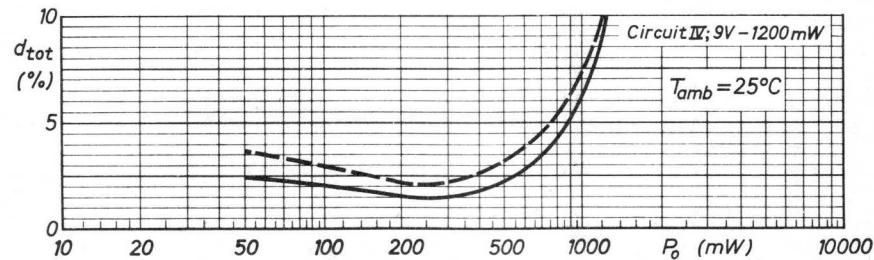
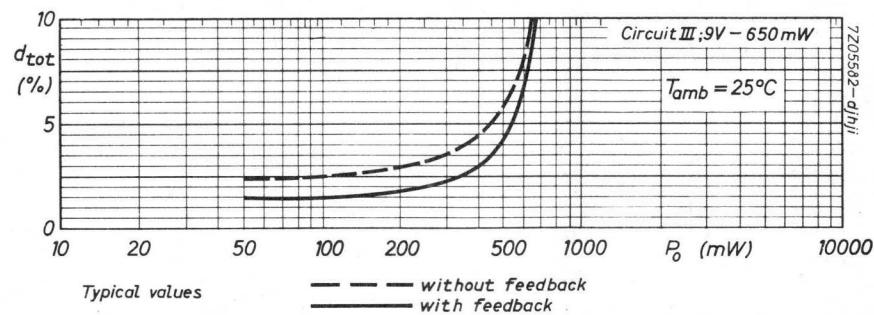
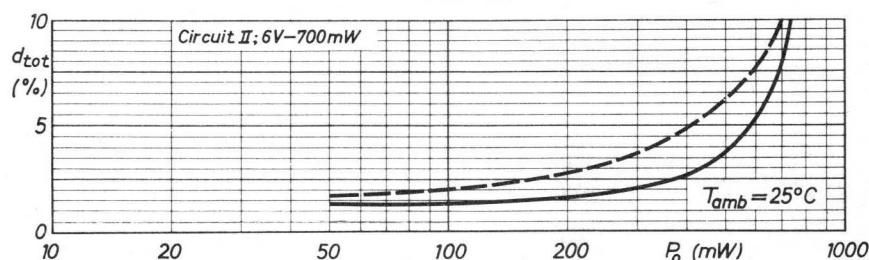
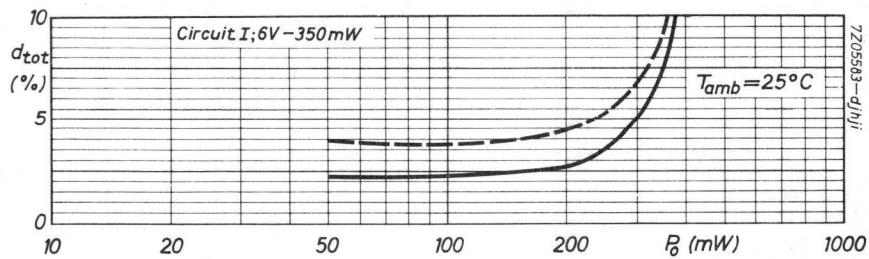
¹⁾ To be adjusted with R7



List of components

	Circuit	I	II	III	IV
R1		1.2	2.7	6.8	2.2 kΩ
R2		22	18	33	18 kΩ
R3		15	15	22	15 kΩ
R4		2.2	2.2	3.3	2.2 kΩ
R5		1.5	2.2	1.8	1.5 kΩ
R6 (5%)		560	270	750	510 Ω
R7		100	75	75	100 Ω
R8		68	75	100	39 Ω
R9 = R10 (5%)		1.5	0	2.4	0 Ω
R11 (NTC)		-	130	-	130 Ω
R _L		8	4	10	8 Ω
R _F		0	0	0	0
R _F		5.6	12	5.6	2.7 Ω
C1		6.4	6.4	6.4	6.4 μF
Tolerance of resistors: 10 % unless otherwise specified	C2	100	100	100	100 μF
	C3	320	125	320	400 μF
	C4	200	160	125	200 μF
	C5	400	1000	320	400 μF
	C6	-	3900	-	- pF





2000

AUDIO FREQUENCY PACKAGE

The package 40819 comprises 4 transistors, selected on h_{FE} to give a low quiescent current of the driver stage and a low gain spread.

The package contains:

AC187 - pre-amplifier transistor

AC188 - driver transistor

AC187/01 and AC188/01-complementary output transistors.

QUICK REFERENCE DATA

The transistors are coded in red with the numerals given below.

Type number	code numeral	h _{FE} at I _C = 500 mA V _{CE} = 1 V	envelope	function
AC187	1	100 to 200	TO-1	pre-amplifier
AC188	2	100 to 200	TO-1	driver
AC187/01	3	150 to 500	cooling block	output stage
AC188/01	3	150 to 500	cooling block	output stage

FOR DATA OF THE INDIVIDUAL TRANSISTORS

REFER TO THE DATA SHEETS OF THE AC187; AC187/01 and AC188; AC188/01

T_{amb} = 25 °C

APPLICATION INFORMATION

Package 40819 in a.f. amplifier

Circuit		I	II
Supply voltage	V _S	6	15 V
Max. output power at d _{tot} = 10 %	P _{omax}	1	3 W
Input voltage at P _O = 50 mW without feedback	V _{i(rms)}	0.7	mV
with feedback	V _{i(rms)}	10	1.2 mV
Input voltage at P _O = P _{omax} without feedback	V _{i(rms)}	5.5	mV
with feedback	V _{i(rms)}	41	10 mV
Zero signal collector current of transistors 3 (adjusted with R8)	I _C	5	5 mA
Collector current (peak value) at P _O = P _{omax} of transistors 3	I _{CM}	710	750 mA
Collector current of the driver transistor 2	-I _C	10	9 mA
Midtap voltage at point A	V	3.2	8 V
Typical input resistance at point B without feedback	R _i	7	kΩ
with feedback	R _i	8	11 kΩ

Notes

1. Stable continuous operation is ensured up to T_{amb} = 45 °C, provided the output transistors are mounted as specified below:

Circuit I:

For the AC187/01 and AC188/01 the Al. blackened heatsinks should have an area of approximately 5 cm² and a thickness of 1.5 mm.

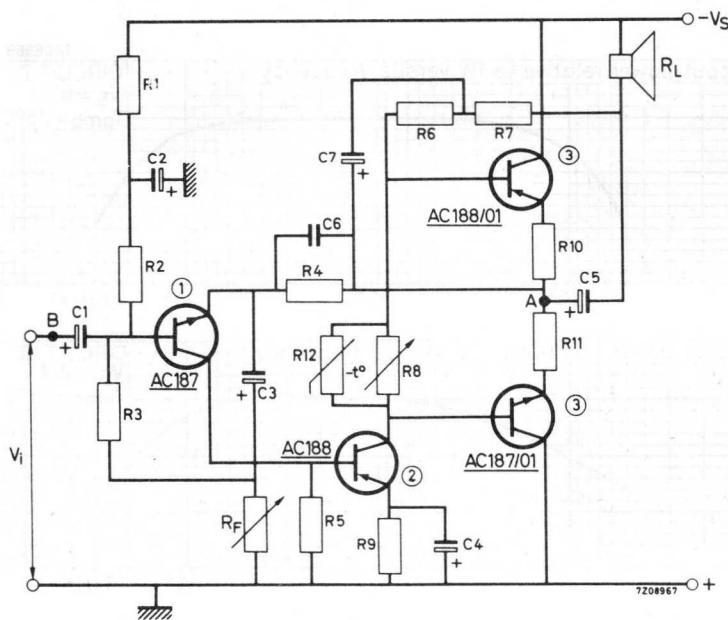
Circuit II:

For the AC187/01 the Al. blackened heatsink should have an area of approximately 65 cm² and a thickness of 1.5 mm.

For the AC188/01 the Al. blackened heatsink should have an area of approximately 20 cm² and a thickness of 1.5 mm.

2. Figures and curves are typical ones unless otherwise specified.

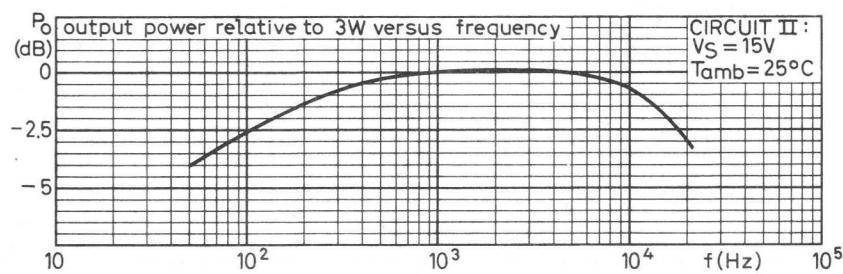
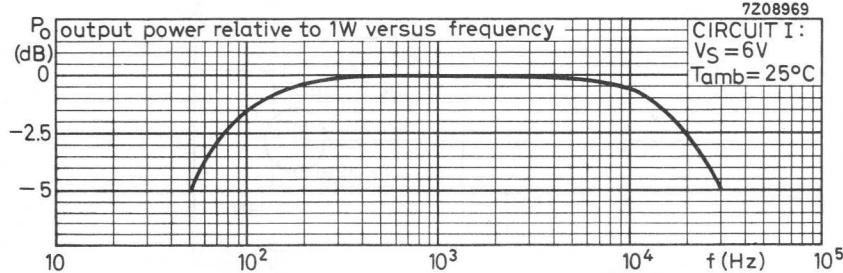
3. A.C. information is given at f = 1 kHz unless otherwise specified.

List of components 1)

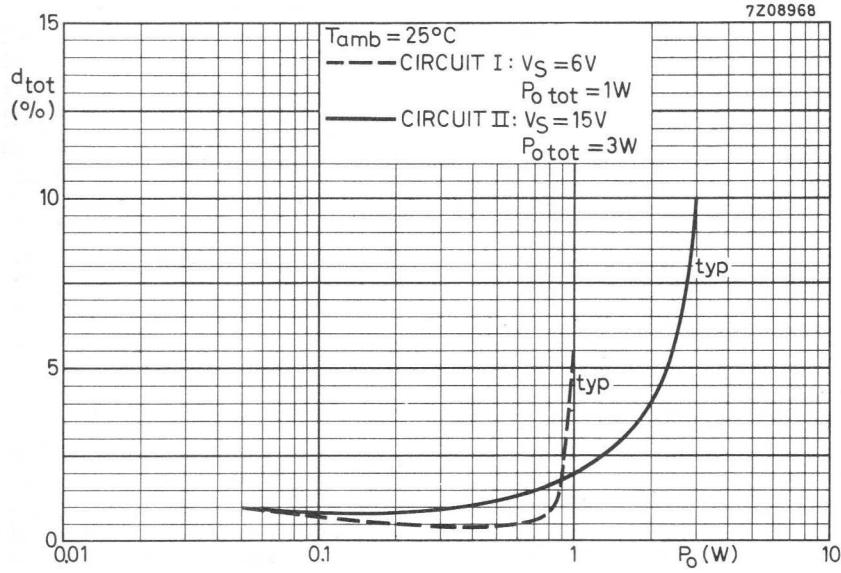
	Circuit	I	II
R1		5.6	2.7 kΩ
R2		10	47 kΩ
R3		12	47 kΩ
R4		2.2	1.8 kΩ
R5		820	820 Ω
R6		0	390 Ω
R7		270	390 Ω
R8		100	150 Ω
R9		0	12 Ω
R10 = R11		0	1 Ω
R12 (NTC)		130	50 Ω
R _L		4	8 Ω
R _F		0	0
without feedback			
R _F		36	1.5 Ω
C1		6.4	40 μF
C2		50	125 μF
C3		50	1000 μF
C4		0	64 μF
C5		1000	800 μF
C6		3300	4700 pF
C7		0	80 μF

1) Tolerance of the resistors is 5%

7208969



7Z08968



Low frequency power transistors



GERMANIUM ALLOYED POWER TRANSISTOR

P-N-P power transistor in a metal envelope with the collector connected to the mounting base.

It is primarily intended for use as matched pair 2-AD139 in low distortion class B push-pull output stages.

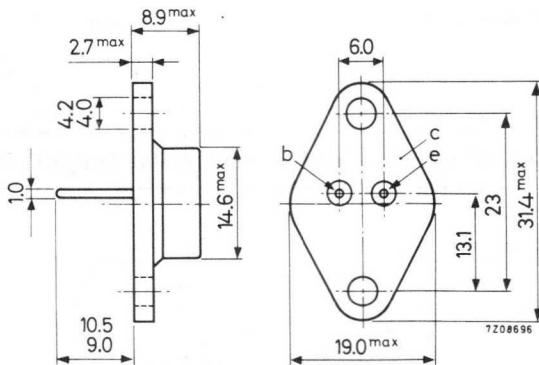
QUICK REFERENCE DATA

Collector-base voltage (open emitter)	$-V_{CBO}$	max. 32 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max. 16 V
Collector current (peak value)	$-I_{CM}$	max. 3 A
Total power dissipation up to $T_{mb} = 45^{\circ}\text{C}$	P_{tot}	max. 13 W
Junction temperature (incidentally)	T_j	max. 100 $^{\circ}\text{C}$
D.C. current gain at $T_j = 25^{\circ}\text{C}$		
$-I_C = 1.0 \text{ A}; V_{CB} = 0$	h_{FE}	30 to 110
Cut-off frequency		
$-I_C = 0.1 \text{ A}; -V_{CE} = 2 \text{ V}$	f_{hfe}	typ. 10 kHz

MECHANICAL DATA

Dimensions in mm

Collector connected to mounting base



Accessories available: 56203

RATINGS Limiting values in accordance with the Absolute Maximum System Voltages
(IEC134)

Collector-base voltage (open emitter)	-V _{CBO}	max.	32	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	16	V
Collector-emitter voltage with R _{BE} < 50 Ω	-V _{CER}	max.	32	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	10	V

Currents

Collector current (d.c. or average over any 50 ms period)	-I _C	max.	1	A
Collector current (peak value)	-I _{CM}	max.	3	A

Power dissipation

Total power dissipation up to T _{mb} = 45 °C	P _{tot}	max.	13	W
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Temperatures

Storage temperature	T _{stg}	-55 to +75	°C
Junction temperature: continuous	T _j	max.	90 °C
incidentally	T _j	max.	100 °C

THERMAL RESISTANCE

From junction to mounting base	R _{th j-mb}	=	4.0	°C/W
From mounting base to heatsink with mica washer	R _{th mb-h}	=	1.5	°C/W
without mica washer	R _{th mb-h}	=	0.5	°C/W

FOR NEW DESIGN THE SUCESSOR TYPE AD162 IS RECOMMENDED

GERMANIUM ALLOYED POWER TRANSISTORS

P-N-P power transistor in a metal envelope with the collector connected to the mounting base.

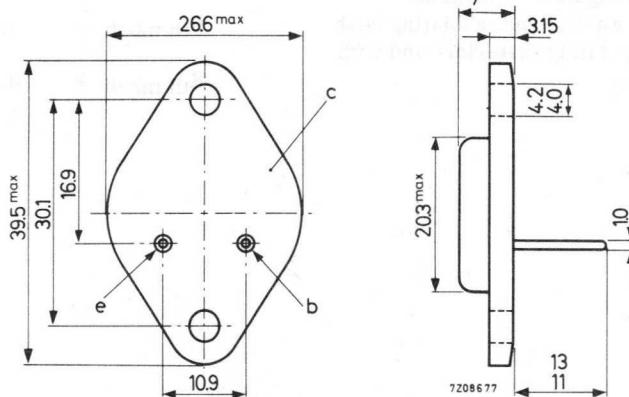
It is primarily intended for use as matched pair 2-AD149 in class B push-pull output stages with an output power of up to 20 W.

QUICK REFERENCE DATA			
Collector-base voltage (open emitter)	-V _{CBO}	max.	50 V
Collector-emitter voltage (open base)	-V _{CEO}	max.	30 V
Collector current (d.c.)	-I _C	max.	3.5 A
Total power dissipation up to T _{mb} = 45 °C	P _{tot}	max.	32.5 W
Junction temperature (incidentally)	T _j	max.	110 °C
D.C. current gain at T _j = 25 °C			
-I _C = 1 A; V _{CB} = 0 V	h _{FE}	30 to 100	
Cut-off frequency	f _{hfe}	typ.	10 kHz
-I _C = 0.5 A; -V _{CE} = 2 V			

MECHANICAL DATA

Dimensions in mm

Collector connected to mounting base



Accessories available: 56201

RATINGS (Limiting values) ¹⁾

Voltages

Collector-base voltage (open emitter)	-V _{CBO}	max.	50	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	30	V
Collector-emitter voltage with R _{BE} < 175 Ω	-V _{CER}	max.	50	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	20	V

Currents

Collector current (d.c.)	-I _C	max.	3.5	A
Base current (d.c.)	-I _B	max.	0.5	A

Power dissipation

Total power dissipation up to T _{mb} = 45 °C	P _{tot}	max.	32.5	W
---	------------------	------	------	---

Temperatures

Storage temperature	T _{stg}	-65 to +100	°C	
Junction temperature: continuous	T _j	max.	100	°C
incidentally	T _j	max.	110	°C

THERMAL RESISTANCE

From junction to mounting base	R _{th j-mb}	=	2	°C/W
From mounting base to heatsink with mica washer and insulating bush without insulating materials and with lead washer	R _{th mb-h}	=	0.5	°C/W
	R _{th mb-h}	=	0.2	°C/W

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; -V_{CB} = 50 \text{ V}$ $-I_{CBO} < 3 \text{ mA}$

$I_E = 0; -V_{CB} = 14 \text{ V}; T_j = 90^\circ\text{C}$ $-I_{CBO} < 5 \text{ mA}$

Emitter cut-off current

$I_C = 0; -V_{EB} = 20 \text{ V}$ $-I_{EBO} < 3 \text{ mA}$

Base-emitter voltage

$-I_C = 15 \text{ mA}; -V_{CE} = 14 \text{ V}$ $-V_{BE} = 135 \text{ to } 175 \text{ mV}$

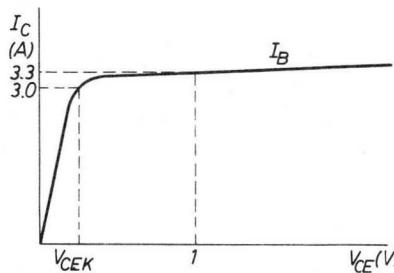
$-I_C = 200 \text{ mA}; -V_{CE} = 1 \text{ V}$ $-V_{BE} < 300 \text{ mV}$

$-I_C = 3.5 \text{ A}; -V_{CE} = 1 \text{ V}$ $-V_{BE} < 1200 \text{ mV}$

Knee voltage

$-I_C = 3 \text{ A}; -I_B = \text{value for which}$

$-I_C = 3.3 \text{ A at } -V_{CE} = 1 \text{ V}$ $-V_{CEK} < 0.7 \text{ V}$



D.C. current gain

$-I_C = 1 \text{ A}; V_{CB} = 0$ $h_{FE} = 30 \text{ to } 100$

$-I_C = 3 \text{ A}; V_{CB} = 0$ $h_{FE} = 20 \text{ to } 85$

Collector capacitance at $f = 450 \text{ kHz}$

$I_E = I_e = 0; -V_{CB} = 5 \text{ V}$ $C_C \text{ typ. } 220 \text{ pF}$

Emitter capacitance at $f = 450 \text{ kHz}$

$I_C = I_c = 0; -V_{EB} = 5 \text{ V}$ $C_e \text{ typ. } 140 \text{ pF}$

CHARACTERISTICS (continued) T_j = 25 °C unless otherwise specified

Transition frequency

$-I_C = 0.5 \text{ A}$; $-V_{CE} = 2 \text{ V}$ f_T $> 300 \text{ kHz}$
typ. 500 kHz

Cut-off frequency

$-I_C = 0.5 \text{ A}$; $-V_{CE} = 2 \text{ V}$ f_{hfe} $> 7 \text{ kHz}$
typ. 10 kHz

Feedback impedance at f = 450 kHz

$I_E = 1 \text{ mA}$; $-V_{CB} = 5 \text{ V}$ $|z_{rb}|$ typ. 30Ω

Small signal current gain linearity ¹⁾

(See page 10) λ_{3A} > 0.2
typ. 0.35

D.C. current gain ratio of

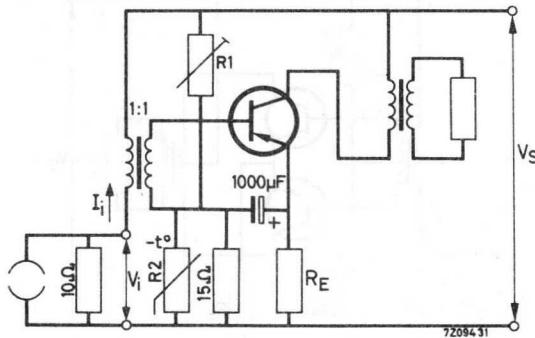
matched pair 2-AD149 $-I_C = 0.3 \text{ A}$ h_{FE1}/h_{FE2} typ. 1.1
 < 1.25

$-I_C = 3 \text{ A}$ h_{FE1}/h_{FE2} typ. 1.1
 < 1.25

¹⁾ $\lambda_{3A} = \frac{A_i \text{ at } -I_C = 3 \text{ A}}{A_{i \text{ max}}}$

APPLICATION INFORMATION

AD149 in a class A output amplifier.



Stable continuous operation is ensured at an ambient temperature up to 55 °C provided each transistor is mounted on a 1.5 mm copper heatsink of at least 18 cm x 18 cm (circuit I) or 15 cm x 15 cm (circuit II).

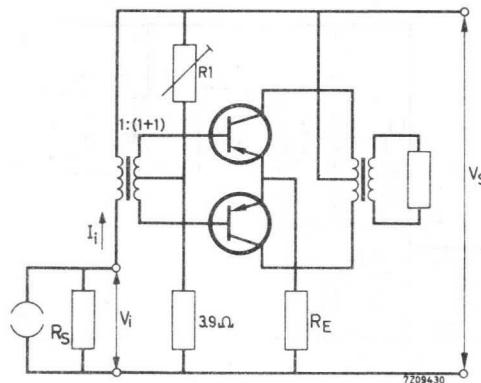
Characteristics

		I	II
Supply voltage	V _S	= 7 < 8	14 V 16 V
Collector current (zero signal)	-I _C	= 1.8	0.72 A
Bias resistor	R ₁	= 50	200 Ω
NTC resistor ¹⁾	R ₂	= 50	50 Ω
Emitter resistor	R _E	= 0.3	0.5 Ω
Collector resistance	R _C ~	= 4	23 Ω
Total power dissipation of the transistor	P _{tot}	< 4.3	4.1 W
Output power delivered to transformer	P _O	< 4	4 W
Input voltage (peak value) at P _O = 4 W	V _{IM}	typ. 0.48	0.40 V
Input current (peak value) at P _O = 4 W	I _{IM}	typ. 35	12 mA
Total distortion at P _O = 4 W	d _{tot}	typ. 9.5	7.5 %
Input current (peak value) at P _O = 50 mW	I _{IM}	typ. 2.5	1.0 mA
Total distortion at P _O = 50 mW	d _{tot}	typ. 2.5	1.5 %

¹⁾ NTC resistor should be mounted on the heatsink, close to the transistor.
Code number 2322 610 11509.

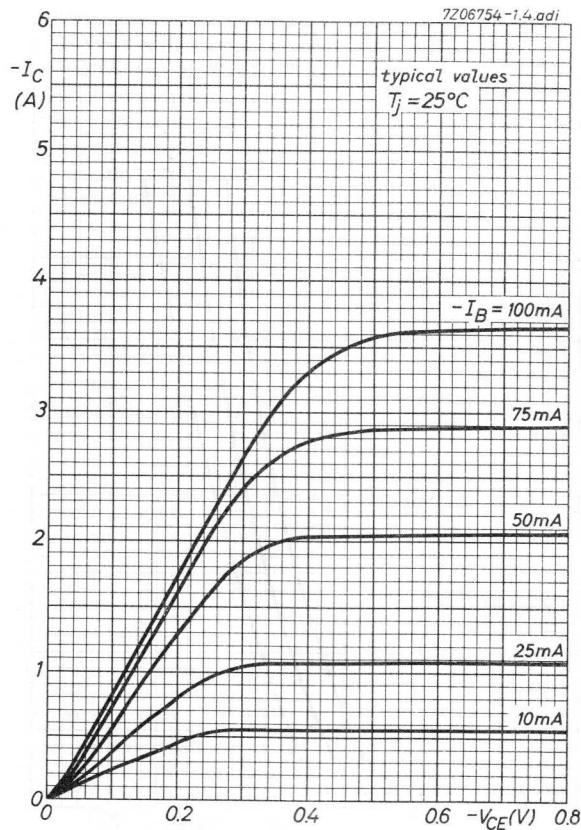
APPLICATION INFORMATION

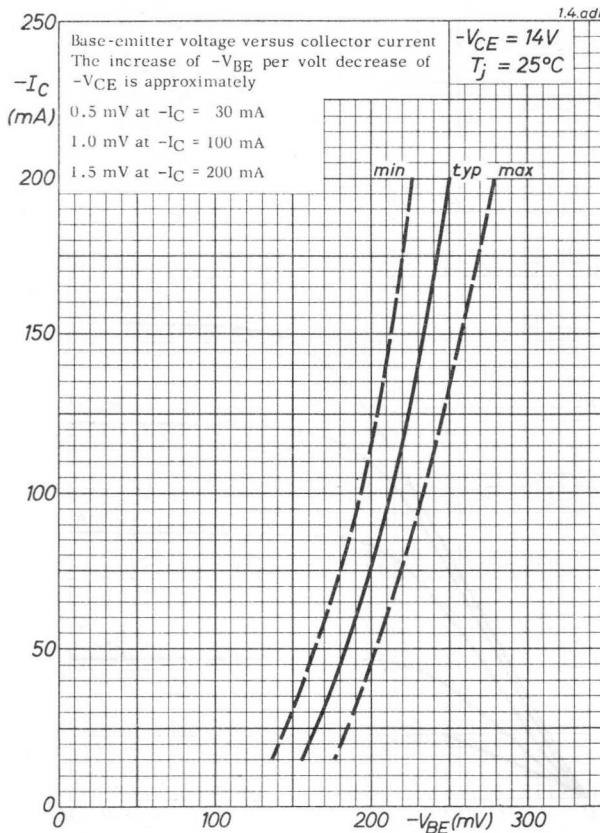
2-AD149 in a class B output amplifier.

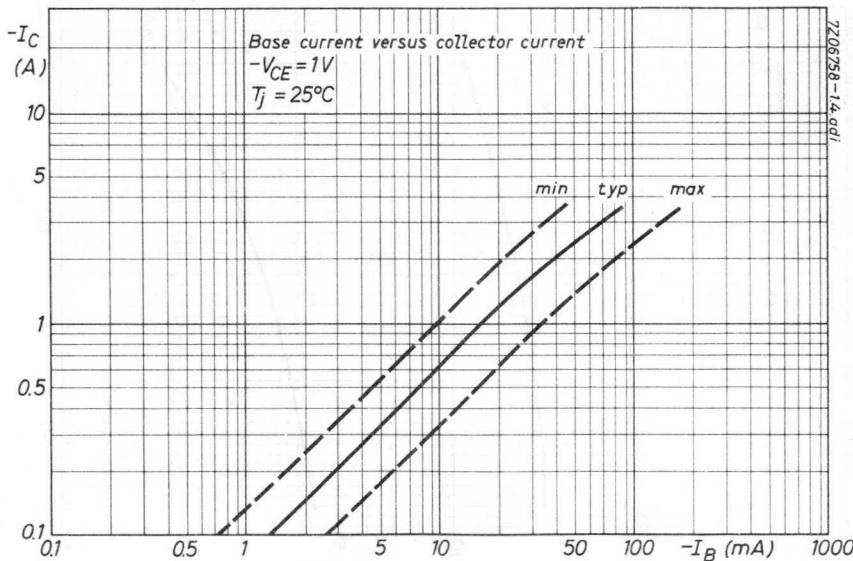
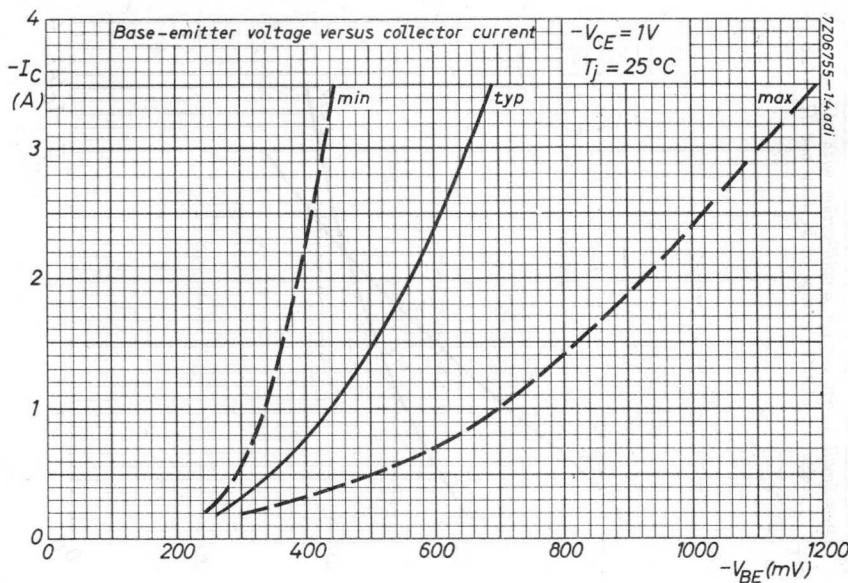


Stable continuous operation is ensured at an ambient temperature up to 55 °C provided each transistor is mounted on a 1.5 mm copper heatsink of at least 5 cm x 5 cm (circuit I) or 6 cm x 6 cm (circuit II).

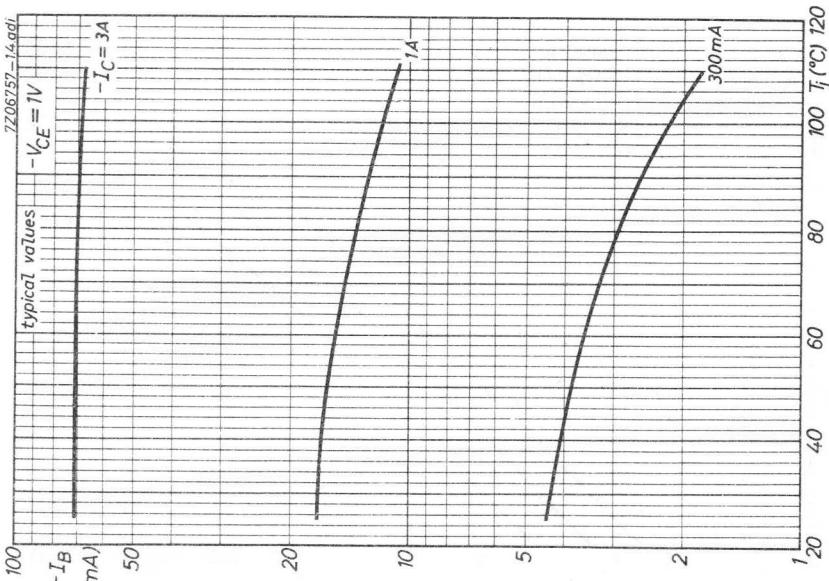
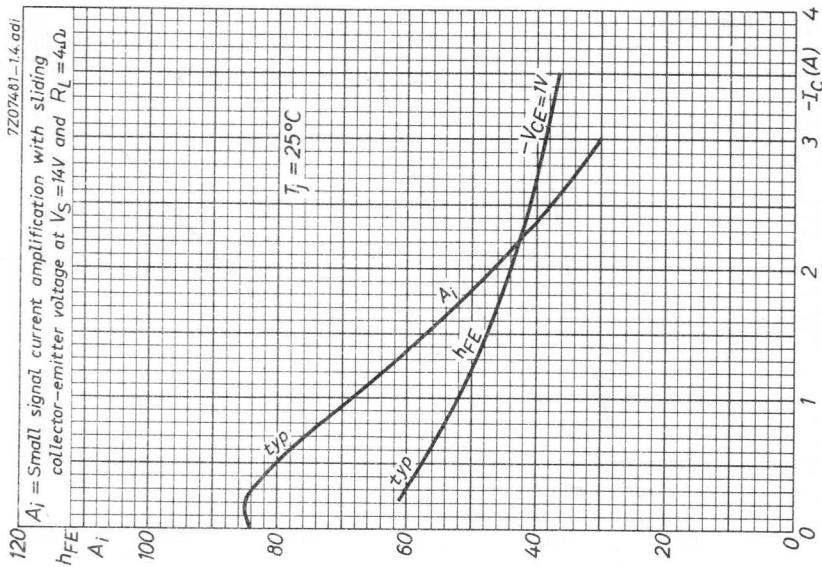
<u>Characteristics</u>		I	II
Supply voltage	V_S	= 7 < 8	14 V 16 V
Collector current (zero signal)	$-I_C$	= 60	60 mA
Bias resistor	R_1	= 200	350 Ω
Emitter resistor	R_E	= 0	0.47 Ω
Source resistance	R_S	= 450	370 Ω
Collector resistance	$R_{CC\sim}$	= 9	16 Ω
Total power dissipation of the transistors	P_{tot}	< 9.75	20 W
Output power delivered to transformer	P_o	< 9.75	17.9 W
Collector current (peak value) at P_o max	$-I_{CM}$	typ. 3	3 A
Collector current at P_o max	$-I_C$	typ. 0.95	0.95 A
Input voltage (peak value) at P_o max	V_{IM}	typ. 0.81	2.2 V
Input current (peak value) at P_o max	I_{IM}	typ. 75	75 mA
Total distortion at P_o max	d_{tot}	typ. 10	10 %
Input current (peak value) at $P_o = 50$ mW	I_{IM}	typ. 4	2.5 mA
Total distortion at $P_o = 50$ mW	d_{tot}	typ. 2.5	2 %







AD149
2 - AD149

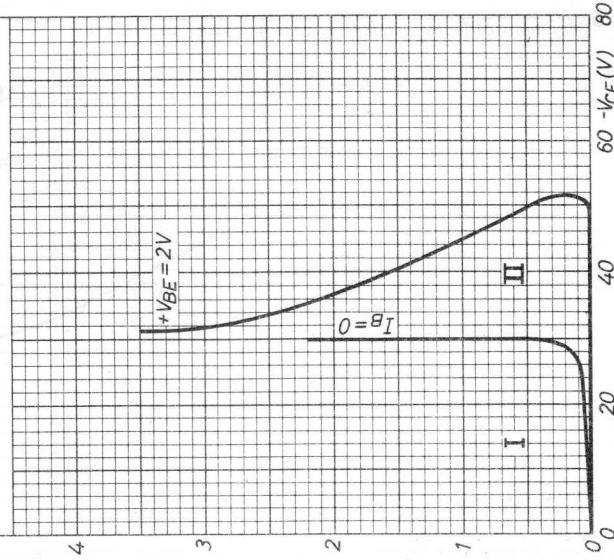


7Z02484-14.adi

6

$-I_C$
(A)
I = region of permissible operation under all base-emitter conditions
II = additional region of operation when the transistor is cut-off with $+V_{BE} < 2$ V

5
During switching-off, voltages higher than indicated by the minimum avalanche breakdown curves at $+V_{BE} = 2$ V are allowed,
provided the transient energy is less than 5 mWs.



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5

$-I_{CBO}$
(mA)

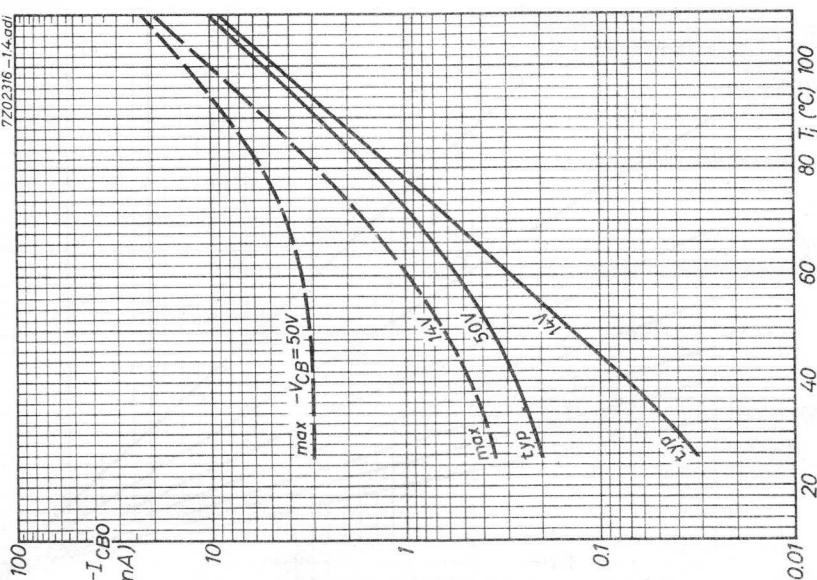
max $-V_{CB} = 50V$

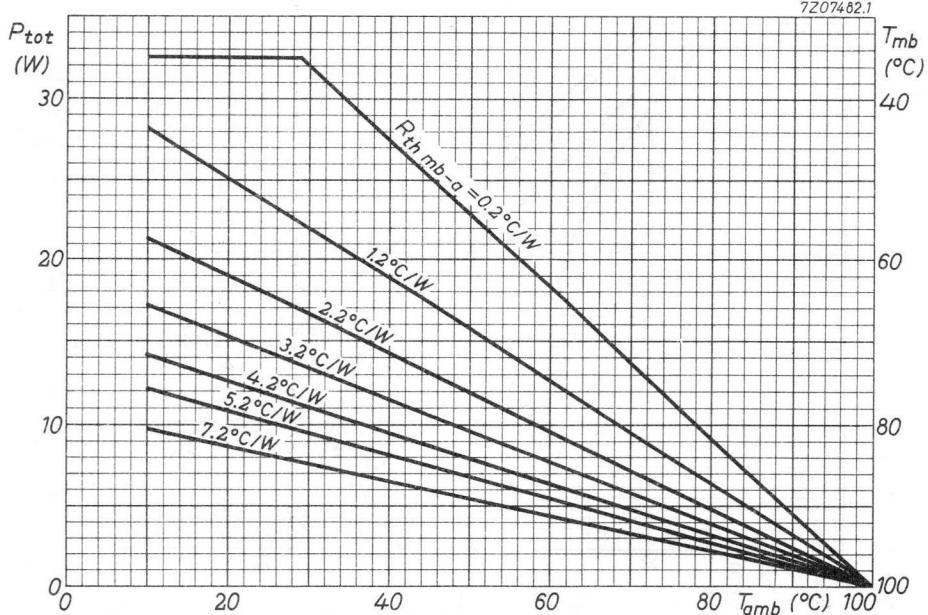
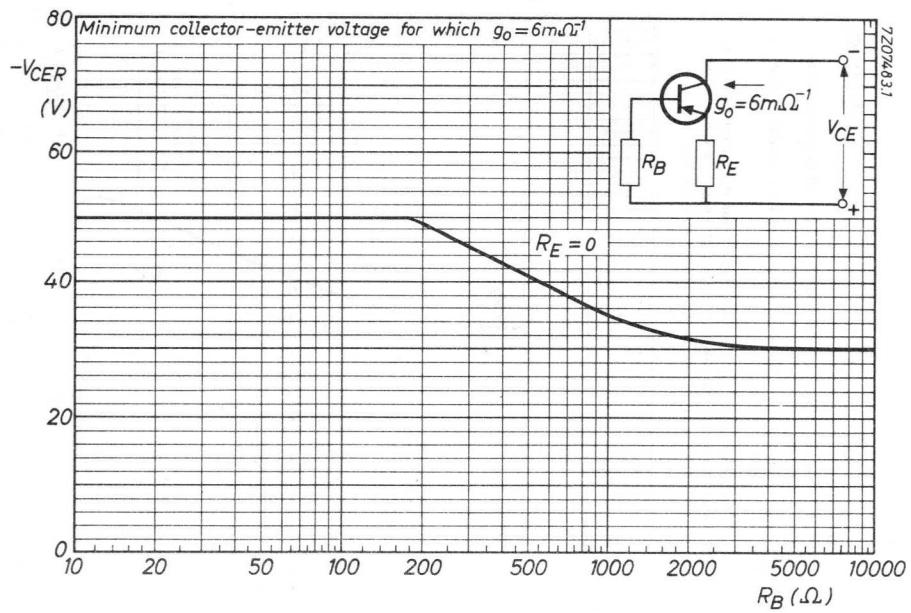
1

0.1

0.01

100 10 1 0.1





GERMANIUM ALLOYED POWER TRANSISTOR

N-P-N power transistor in a metal envelope with the collector connected to the mounting base.

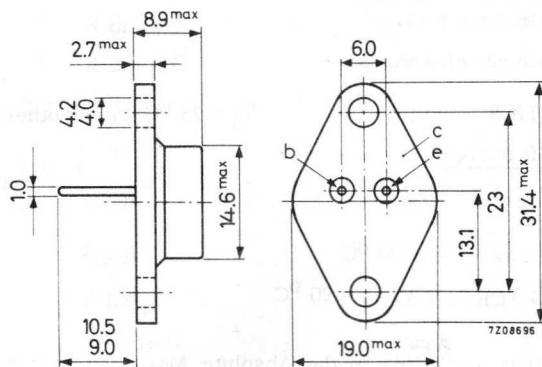
The AD161 is primarily intended for use together with the p-n-p power transistor AD162 as matched pair AD161/AD162 in 10 W complementary symmetry class B output stages of mains operated amplifiers and radio receivers.

QUICK REFERENCE DATA			
Collector-base voltage (open emitter)	V _{CBO}	max.	32 V
Collector-emitter voltage (open base)	V _{CEO}	max.	20 V
Collector current (peak value)	I _{CM}	max.	3 A
Total power dissipation up to T _{mb} = 75°C	P _{tot}	max.	4 W
Junction temperature (incidentally)	T _j	max.	100 °C
D.C. current gain at T _j = 25 °C			
I _C = 0.5 A; V _{CE} = 1 V	h _{FE}	80 to 320	
Cut-off frequency			
I _C = 0.3 A; V _{CE} = 2 V	f _{hfe}	typ.	35 kHz

MECHANICAL DATA

Dimensions in mm

Collector connected to mounting base



Accessories available: 56203

RATINGS (Limiting values) ¹⁾Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	32	V
Collector-emitter voltage (open base)	V_{CEO}	max.	20	V
Collector-emitter voltage with $-V_{BE} = 0.6$ V (See also page 4)	V_{CEX}	max.	32	V
Emitter-base voltage (open collector)	V_{EBO}	max.	10	V

Currents

Collector current (d.c. or average over any 50 ms period)	I_C	max.	1	A
Collector current (peak value)	I_{CM}	max.	3	A

Power dissipation

Total power dissipation up to $T_{mb} = 72$ °C	P_{tot}	max.	4	W
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Temperatures

Storage temperature	T_{stg}	-65 to +90	°C
Junction temperature: continuous	T_j	max.	90 °C
incidentally	T_j	max.	100 °C

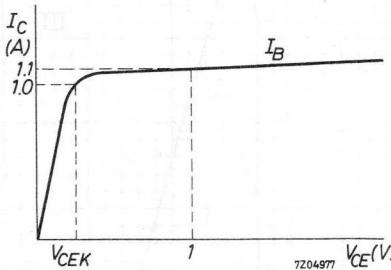
THERMAL RESISTANCE

From junction to mounting base	$R_{th\ j-mb}$	=	4.5	°C/W
From mounting base to heatsink with mica washer	$R_{th\ mb-h}$	=	1.5	°C/W
without mica washer	$R_{th\ mb-h}$	=	0.5	°C/W

CHARACTERISTICS $T_j = 25$ °C unless otherwise specifiedCollector cut-off current

$I_E = 0$; $V_{CB} = 32$ V	I_{CBO}	typ.	20	μA
$I_E = 0$; $V_{CB} = 32$ V; $T_j = 90$ °C	I_{CBO}	<	500	μA
$-V_{BE} = 0.6$ V; $V_{CE} = 32$ V; $T_j = 90$ °C	I_{CEX}	<	3	mA

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedEmitter cut-off current $I_C = 0; V_{EB} = 10 \text{ V}$ I_{EBO} typ. < 200 μA $I_C = 0; V_{EB} = 10 \text{ V}; T_j = 90^\circ\text{C}$ I_{EBO} < 2 mABase-emitter voltage¹⁾ $I_C = 5 \text{ mA}; V_{CE} = 10 \text{ V}$ V_{BE} 110 to 140 mV $I_C = 50 \text{ mA}; V_{CE} = 1 \text{ V}$ V_{BE} < 300 mV $I_C = 500 \text{ mA}; V_{CE} = 1 \text{ V}$ V_{BE} < 650 mV $I_C = 2 \text{ A}; V_{CE} = 1 \text{ V}$ V_{BE} < 1100 mVKnee voltage $I_C = 1 \text{ A}; I_B = \text{value for which}$ $I_C = 1.1 \text{ A at } V_{CE} = 1 \text{ V}$ V_{CEK} < 600 mVFloating voltage $I_E = 0; V_{CB} = 32 \text{ V}; T_j = 90^\circ\text{C}$ V_{EBf1} < 400 mVCollector capacitance at $f = 450 \text{ kHz}$ $I_E = I_e = 0; V_{CB} = 5 \text{ V}$ C_c typ. 150 pFD.C. current gain $I_C = 5 \text{ mA}; V_{CE} = 10 \text{ V}$ h_{FE} > 55 $I_C = 50 \text{ mA}; V_{CE} = 1 \text{ V}$ h_{FE} 74 to 300 $I_C = 500 \text{ mA}; V_{CE} = 1 \text{ V}$ h_{FE} typ. 150
80 to 320 $I_C = 2 \text{ A}; V_{CE} = 1 \text{ V}$ h_{FE} > 40¹⁾ V_{BE} decreases by about 2 mV/ $^\circ\text{C}$ with increasing temperature.

CHARACTERISTICS (continued) $T = T_j = 25^\circ\text{C}$ unless otherwise specified

Transition frequency

$I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V}$ f_T typ. 3 MHz

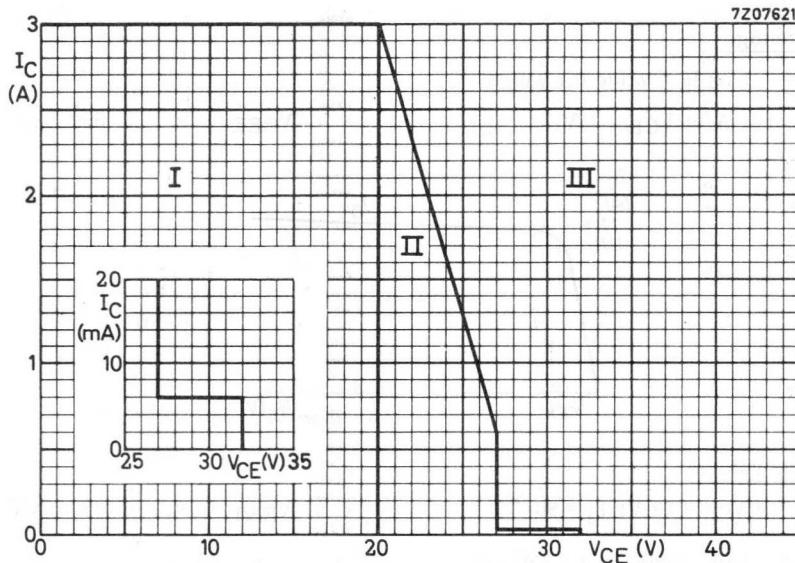
Cut-off frequency

$I_C = 300 \text{ mA}; V_{CE} = 2 \text{ V}$ f_{hfe} typ. > 20 kHz
typ. 35 kHz

D.C. current gain ratio

of matched pair AD161/AD162

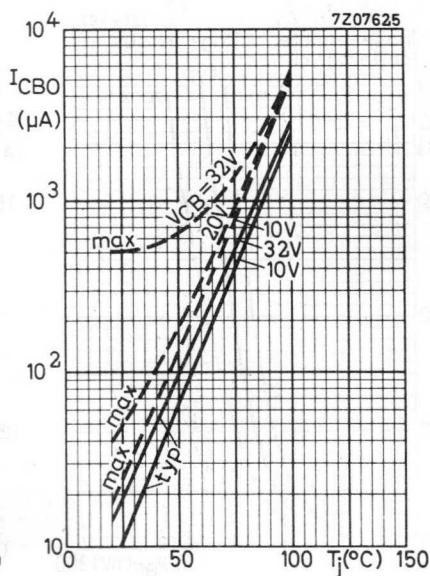
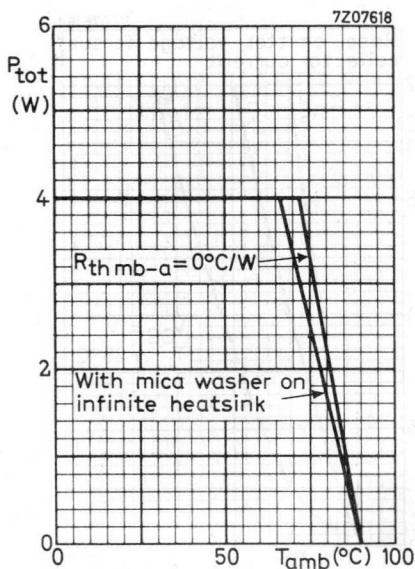
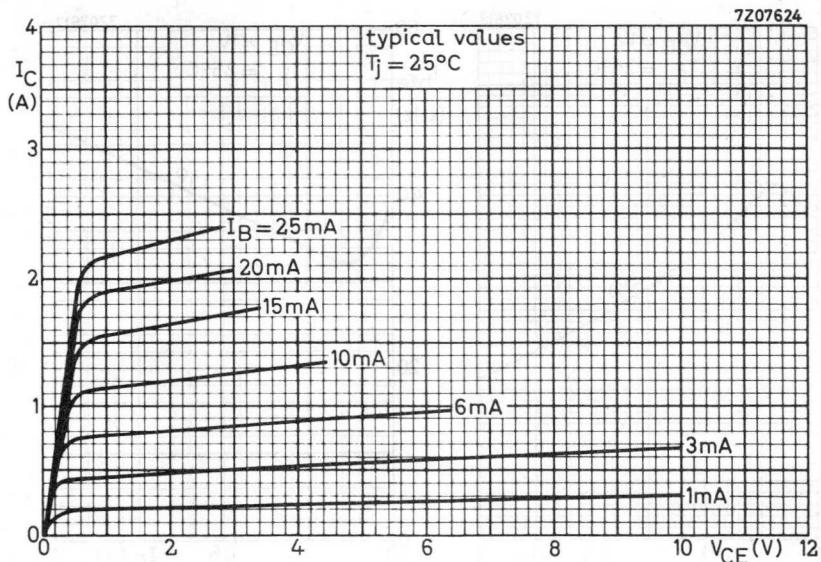
$|I_C| = 500 \text{ mA}; |V_{CE}| = 1 \text{ V}$ h_{FE1}/h_{FE2} typ. 1.1
< 1.25

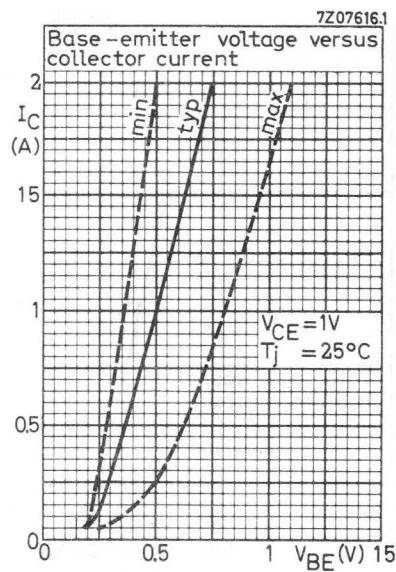
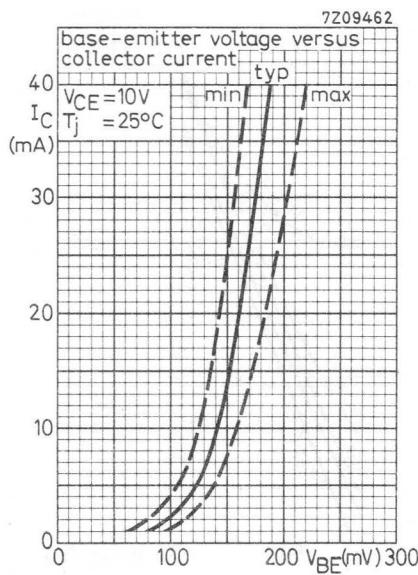
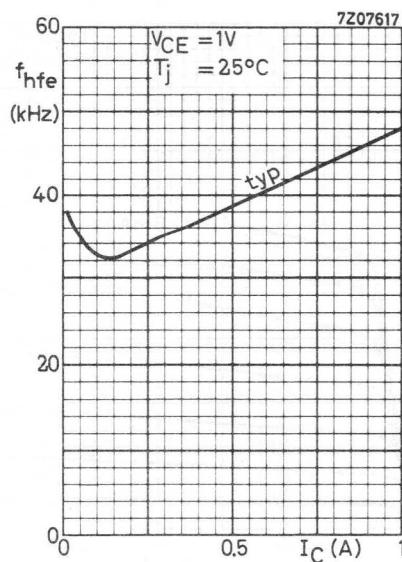
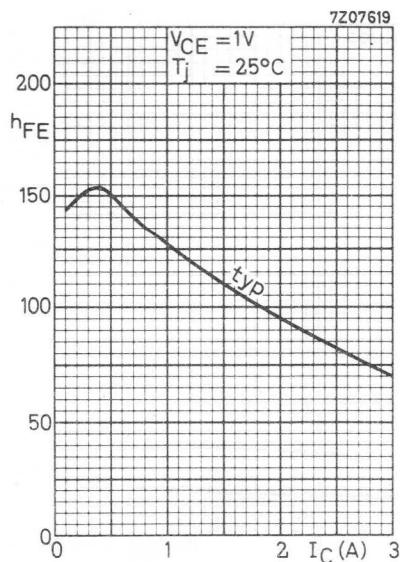


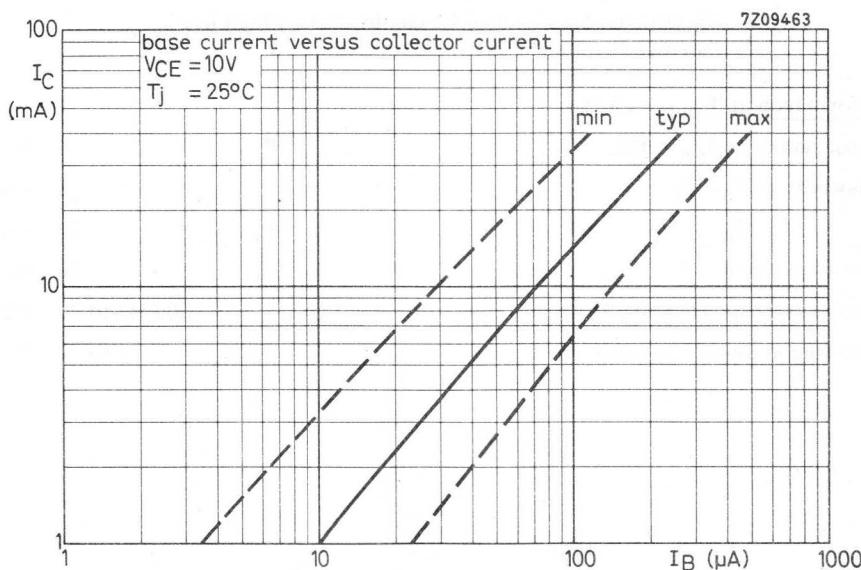
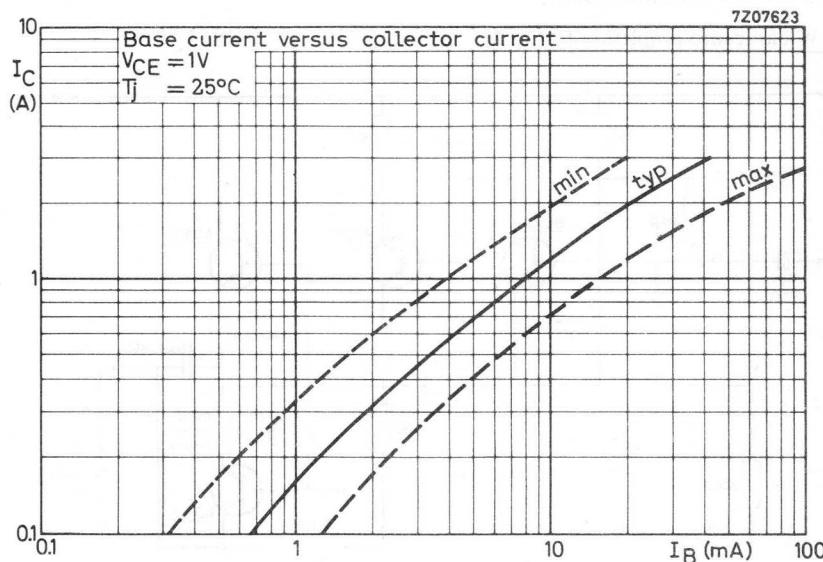
I = Region of permissible operation under all base-emitter conditions.

II = Additional region of operation when the transistor is cut-off with $-V_{BE} \geq -V_{BEf1}$.

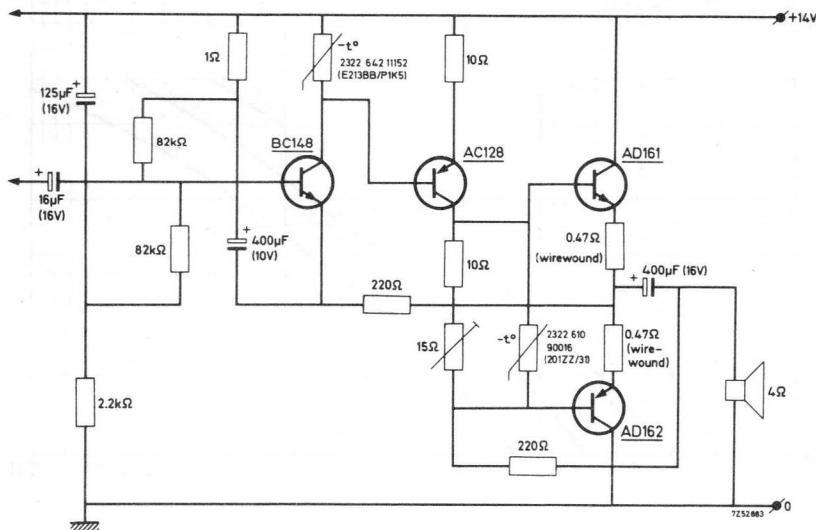
III = Outside regions I and II, the transistor can withstand transient energies of 1 mWs, provided it is cut-off with $-V_{BB} \leq 0.6 \text{ V}$; $R_i = 18 \Omega$.







APPLICATION INFORMATION

A. 4 W car radio amplifier for 12 V

All transistors mounted on one heatsink which has a thermal resistance of $R_{th\ h-a} \leq 5.5\ ^\circ\text{C}/\text{W}$

Performance at $T_{amb} = 25\ ^\circ\text{C}$

Output power at $d_{tot} = 10\%$

$P_o = 4\text{ W}$

Sensitivity at $P_o = 50\text{ mW}$

$V_i = 5\text{ mV}$

$P_o = 4\text{ W}$

$V_i = 48\text{ mV}$

Input impedance

$Z_i = 10\text{ k}\Omega$

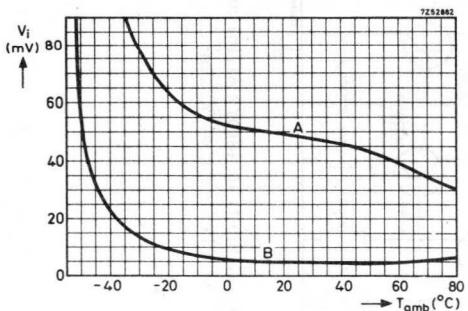
Frequency response (-3 dB)

200 Hz to 20 kHz

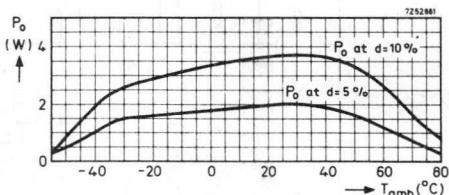
Operating ambient temperature

$T_{amb} = 20\text{ to }70\ ^\circ\text{C}$

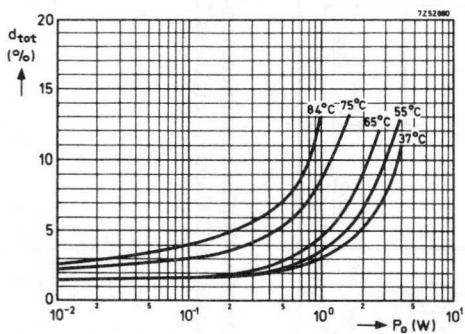
APPLICATION INFORMATION (continued)



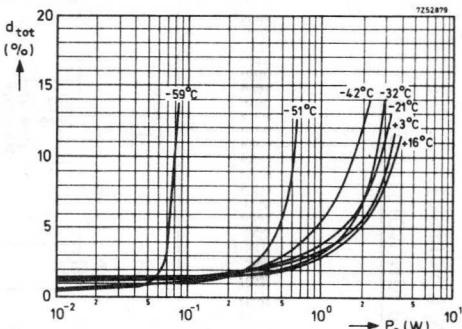
Input sensitivity at various ambient temperatures. Curve A for maximum output power at a distortion of 10%. Curve B for an output power of 50 mW.



The output power at two distortion levels as a function of the ambient temperature.

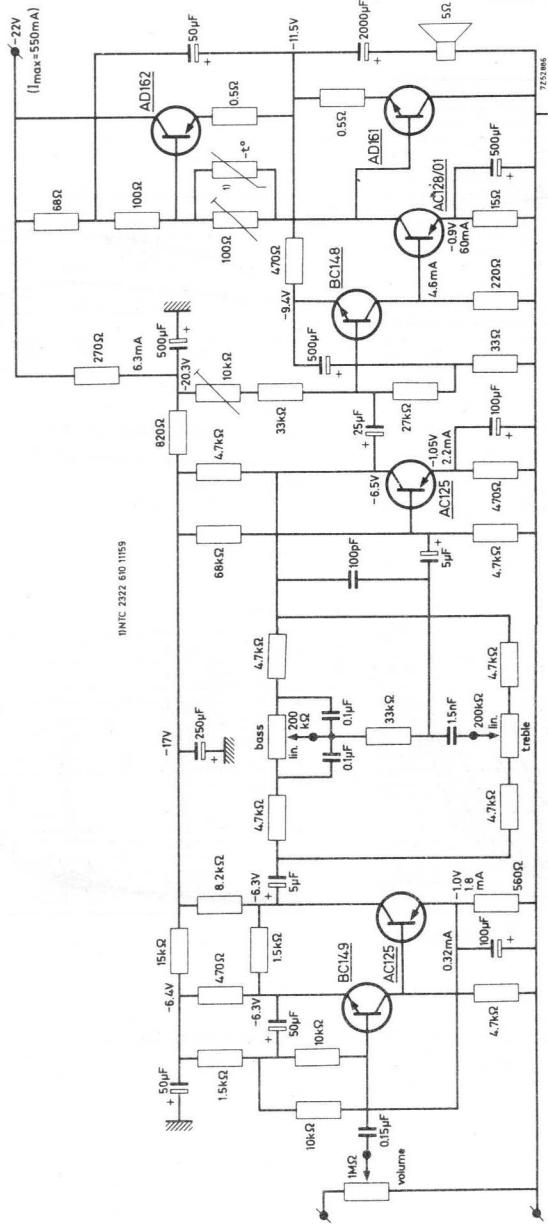


The distortion as a function of the output power at several ambient temperatures.



APPLICATION INFORMATION (continued)

B., 8 W amplifier with matched pair AD161/AD162



This amplifier can safely be employed up to an ambient temperature of 45°C, provided the transistors AD161 and AD162 are mounted on a common heatsink of 200 cm², thickness 2 mm and the AC128/01 on a heatsink of 50 cm².

APPLICATION INFORMATION (continued)

Performance

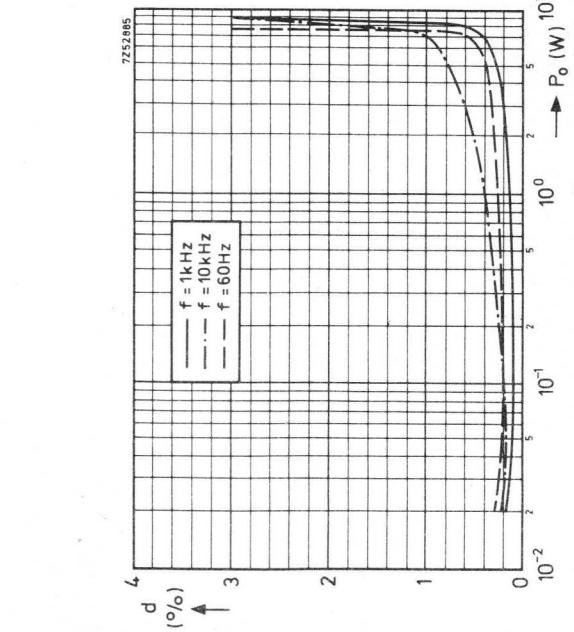
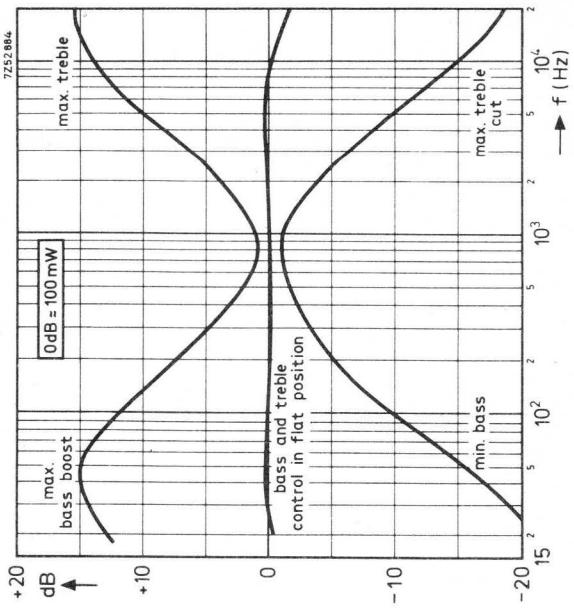
Output power at onset of clipping
 $d_{tot} = 0.6\%$; $f = 1$ kHz
 Sensitivity at $P_0 = 50$ mW

Input impedance

$$\begin{array}{rcl} P_0 & = & 8 \text{ W} \\ V_i & = & 8.7 \text{ mV} \\ V_i & = & 110 \text{ mV} \\ Z_i & = & 500 \text{ k}\Omega \end{array}$$

Signal-noise ratio at $P_o = 8.7$ W
power supply unstabilized
stabilized

Frequency response (-3 dB)
Bass control at 45 Hz
Treble control at 20 kHz



The distortion as function of the output power at three different frequencies.

Control facilities of the 8 W amplifier.

tarde caro & rörgå

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GERMANIUM ALLOYED POWER TRANSISTOR

P-N-P power transistor in a metal envelope with the collector connected to the mounting base.

It is primarily intended for use as matched pair 2-AD162 in class B push-pull output stages and together with the n-p-n power transistor AD161 as matched pair AD161/AD162 in 10 W complementary symmetry class B output stages of mains operated amplifiers and radio receivers.

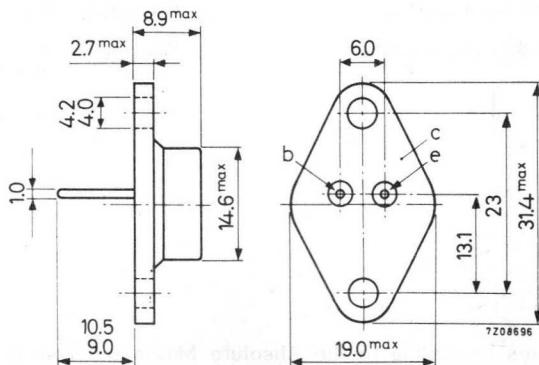
QUICK REFERENCE DATA

Collector-base voltage (open emitter)	$-V_{CBO}$	max.	32	V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	20	V
Collector current (peak value)	$-I_{CM}$	max.	3	A
Total power dissipation up to $T_{mb} = 63^\circ\text{C}$	P_{tot}	max.	6	W
Junction temperature (incidentally)	T_j	max.	100	$^\circ\text{C}$
D.C. current gain at $T_j = 25^\circ\text{C}$				
$-I_C = 0.5 \text{ A}; -V_{CE} = 1 \text{ V}$	h_{FE}		80 to 320	
Cut-off frequency				
$-I_C = 0.3 \text{ A}; -V_{CE} = 2 \text{ V}$	f_{hfe}	typ.	15	kHz

MECHANICAL DATA

Dimensions in mm

Collector connected to mounting base



Accessories available: 56203

RATINGS (Limiting values)¹⁾Voltages

Collector-base voltage (open emitter)	-V _{CBO}	max.	32	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	20	V
Collector-emitter voltage with +V _{BE} = 0.6 V (See also page 4)	-V _{CEx}	max.	32	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	10	V

Currents

Collector current (d.c. or average over any 50 ms period)	-I _C	max.	1	A
Collector current (peak value)	-I _{CM}	max.	3	A

Power dissipation

Total power dissipation up to T _{mb} = 63 °C	P _{tot}	max.	6	W
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Temperatures

Storage temperature	T _{stg}	-65 to +90	°C
Junction temperature: continuous	T _j	max.	90 °C
incidentally	T _j	max.	100 °C

THERMAL RESISTANCE

From junction to mounting base	R _{th j-mb}	=	4.5	°C/W
From mounting base to heatsink with mica washer	R _{th mb-h}	=	1.5	°C/W
without mica washer	R _{th mb-h}	=	0.5	°C/W

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current

$I_E = 0; -V_{CB} = 32 \text{ V}$	$-I_{CBO}$	typ.	15	μA
$I_E = 0; -V_{CB} = 32 \text{ V}; T_j = 90^\circ\text{C}$	$-I_{CBO}$	<	200	μA
$+V_{BE} = 0.6 \text{ V}; -V_{CE} = 32 \text{ V}; T_j = 90^\circ\text{C}$	$-I_{CEX}$	<	2	mA

Emitter cut-off current

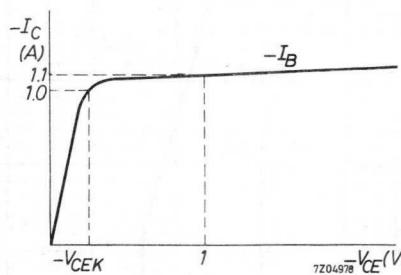
$I_C = 0; -V_{EB} = 10 \text{ V}$	$-I_{EBO}$	typ.	15	μA
$I_C = 0; -V_{EB} = 10 \text{ V}; T_j = 90^\circ\text{C}$	$-I_{EBO}$	<	200	μA

Base-emitter voltage ¹⁾

$-I_C = 5 \text{ mA}; -V_{CE} = 10 \text{ V}$	$-V_{BE}$	115 to 145	mV
$-I_C = 50 \text{ mA}; -V_{CE} = 1 \text{ V}$	$-V_{BE}$	<	300 mV
$-I_C = 500 \text{ mA}; -V_{CE} = 1 \text{ V}$	$-V_{BE}$	<	550 mV
$-I_C = 2 \text{ A}; -V_{CE} = 1 \text{ V}$	$-V_{BE}$	<	850 mV

Knee voltage

$-I_C = 1 \text{ A}; -I_B = \text{value for which}$	$-V_{CEK}$	<	400	mV
$-I_C = 1.1 \text{ A at } -V_{CE} = 1 \text{ V}$				

Floating voltage

$I_E = 0; -V_{CB} = 32 \text{ V}; T_j = 90^\circ\text{C}$	$-V_{EBfl}$	<	400	mV
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Collector capacitance at $f = 450 \text{ kHz}$

$I_E = I_e = 0; -V_{CB} = 5 \text{ V}$	C_c	typ.	115	pF
--	-------	------	-----	----

1) $-V_{BE}$ decreases by about 2 mV/ $^\circ\text{C}$ with increasing temperature.

CHARACTERISTICS (continued) $T_j = 25^\circ\text{C}$ unless otherwise specifiedD.C. current gain

$-I_C = 5 \text{ mA}; -V_{CE} = 10 \text{ V}$	h_{FE}	>	60
$-I_C = 50 \text{ mA}; -V_{CE} = 1 \text{ V}$	h_{FE}	74 to	300
$-I_C = 500 \text{ mA}; -V_{CE} = 1 \text{ V}$	h_{FE}	typ.	150
$-I_C = 2 \text{ A}; -V_{CE} = 1 \text{ V}$	h_{FE}	80 to	320

Transition frequency

$-I_C = 10 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_T	typ.	1.5 MHz
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Cut-off frequency

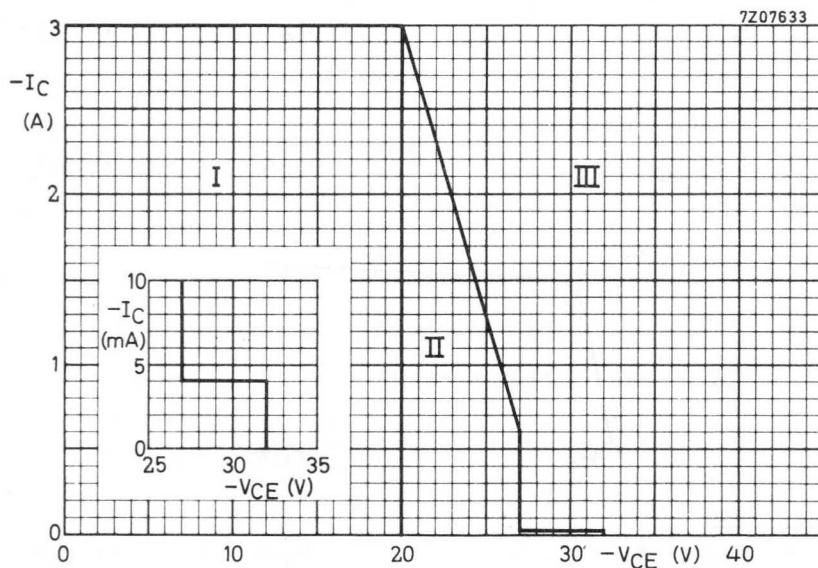
$-I_C = 300 \text{ mA}; -V_{CE} = 2 \text{ V}$	f_{hfe}	>	8 kHz
		typ.	15 kHz

D.C. current gain ratio of matched pair AD161/AD162

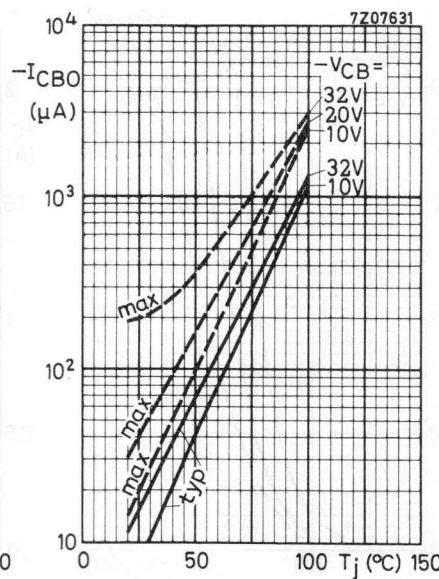
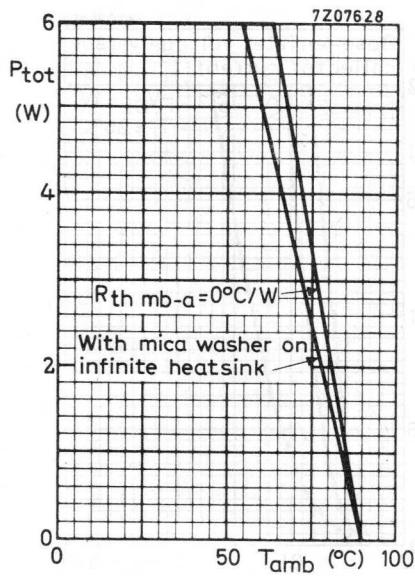
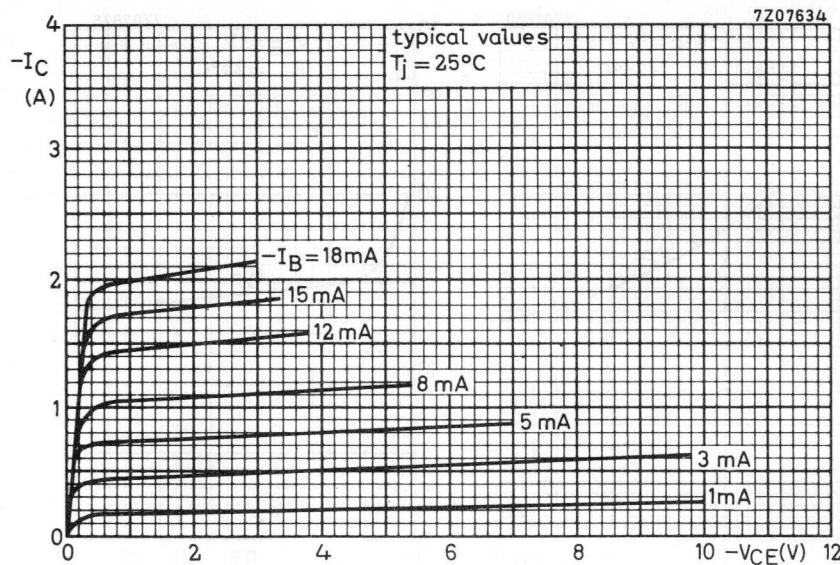
$ I_C = 500 \text{ mA}; V_{CE} = 1 \text{ V}$	h_{FE1}/h_{FE2}	typ.	1.1
		<	1.25

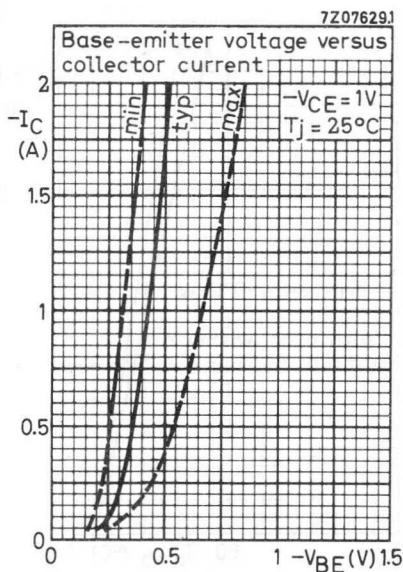
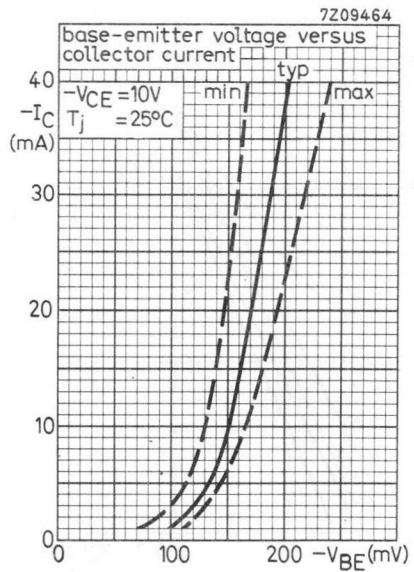
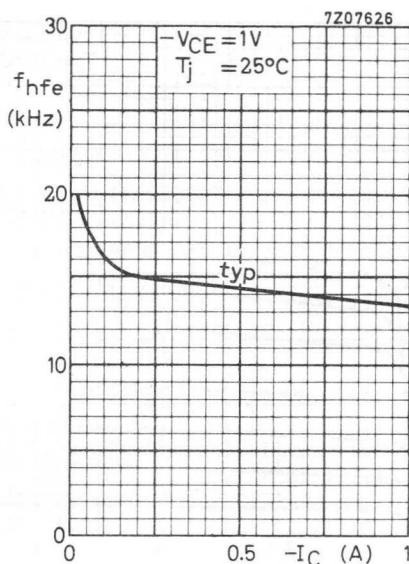
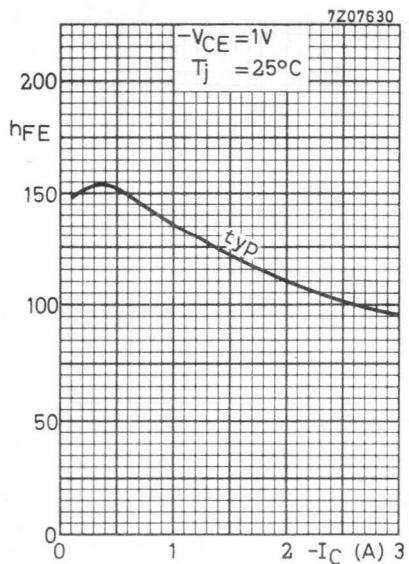
matched pair 2-AD162

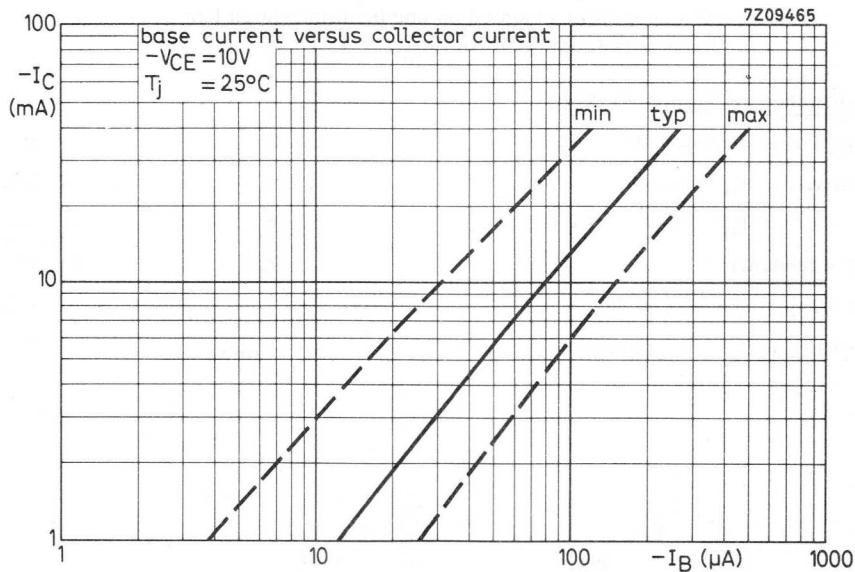
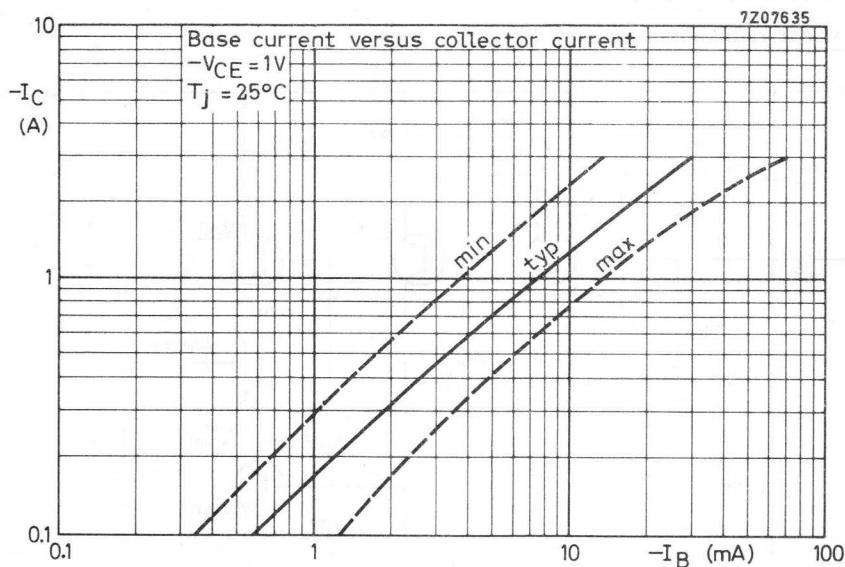
$-I_C = 50 \text{ mA}; -V_{CE} = 1 \text{ V}$	h_{FE1}/h_{FE2}	typ.	1.1
$-I_C = 500 \text{ mA}; -V_{CE} = 1 \text{ V}$		<	1.25



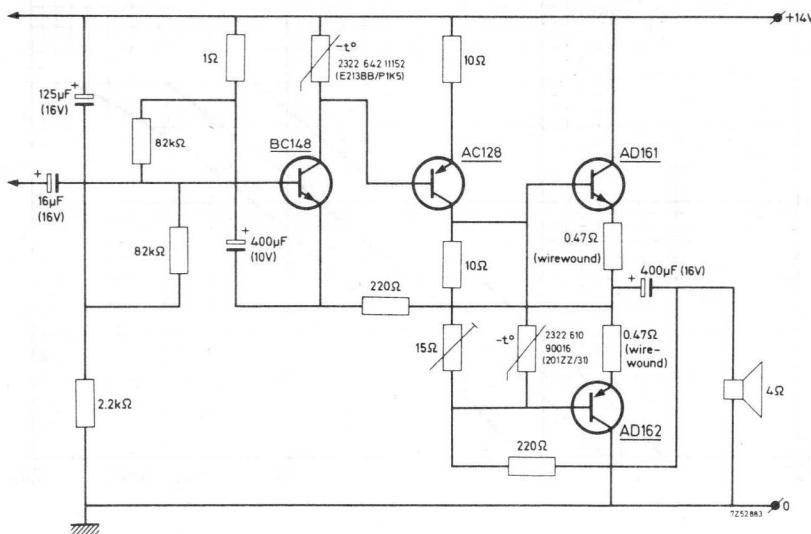
- I Region of permissible operation under all base-emitter conditions.
- II Additional region of operation when the transistor is cut-off with $V_{BE} \geq V_{BEfl}$.
- III Outside regions I and II, the transistor can withstand transient energies of 4.5 mWs, provided it is cut-off with $+V_{BB} < 0.6 \text{ V}$; $R_i = 18 \Omega$.







APPLICATION INFORMATION

A. 4 W car radio amplifier for 12 V

All transistors mounted on one heatsink which has a thermal resistance of $R_{th\ h-a} \leq 5.5\ ^\circ\text{C}/\text{W}$

Performance at $T_{amb} = 25\ ^\circ\text{C}$

Output power at $d_{tot} = 10\%$

$P_o = 4\text{ W}$

Sensitivity at $P_o = 50\text{ mW}$

$V_i = 5\text{ mV}$

$P_o = 4\text{ W}$

$V_i = 48\text{ mV}$

Input impedance

$Z_i = 10\text{ k}\Omega$

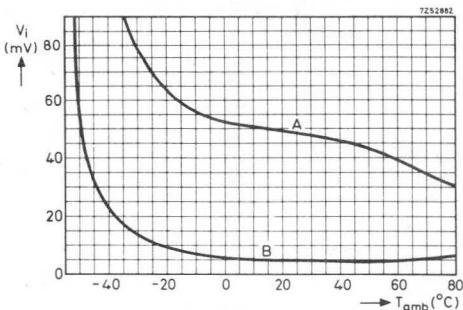
Frequency response (-3 dB)

200 Hz to 20 kHz

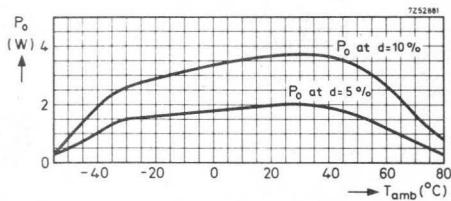
Operating ambient temperature

$T_{amb} = 20\text{ to }70\ ^\circ\text{C}$

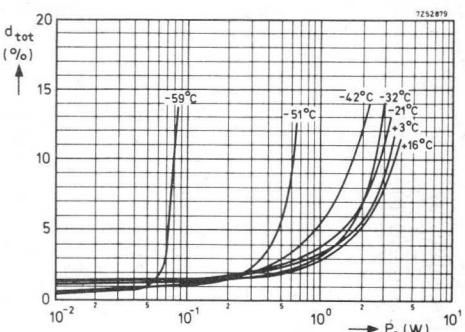
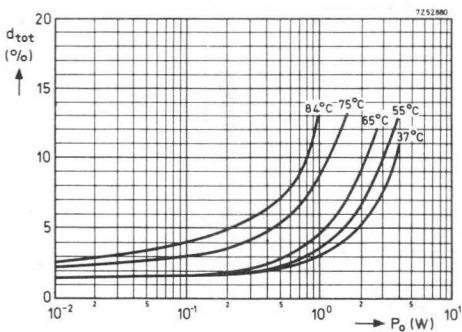
APPLICATION INFORMATION (continued)



Input sensitivity at various ambient temperatures. Curve A for maximum output power at a distortion of 10%. Curve B for an output power of 5 mW.



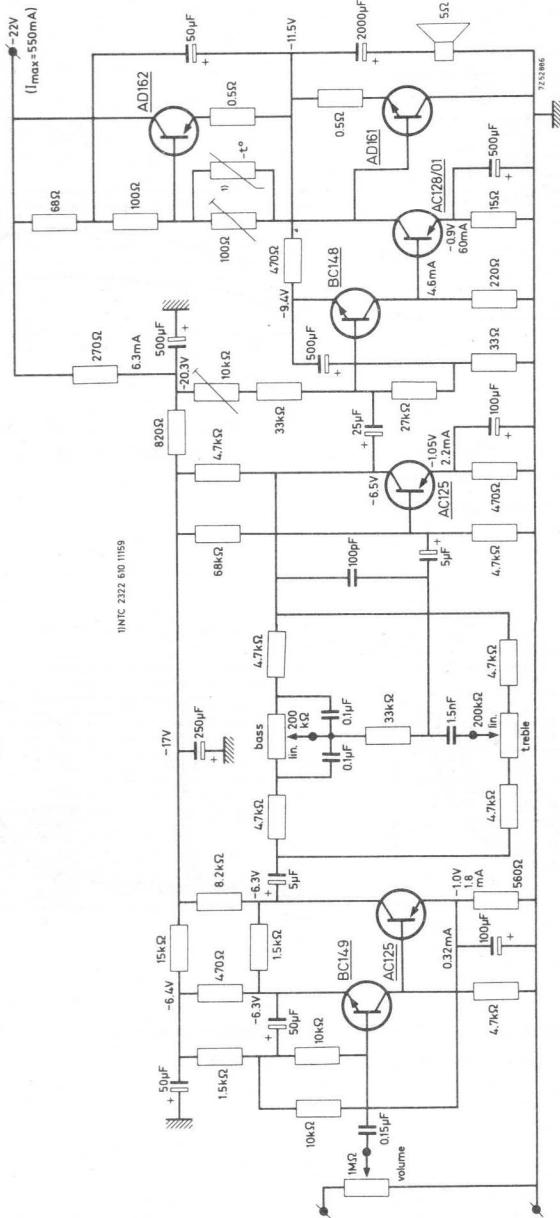
The output power at two distortion levels as a function of the ambient temperature.



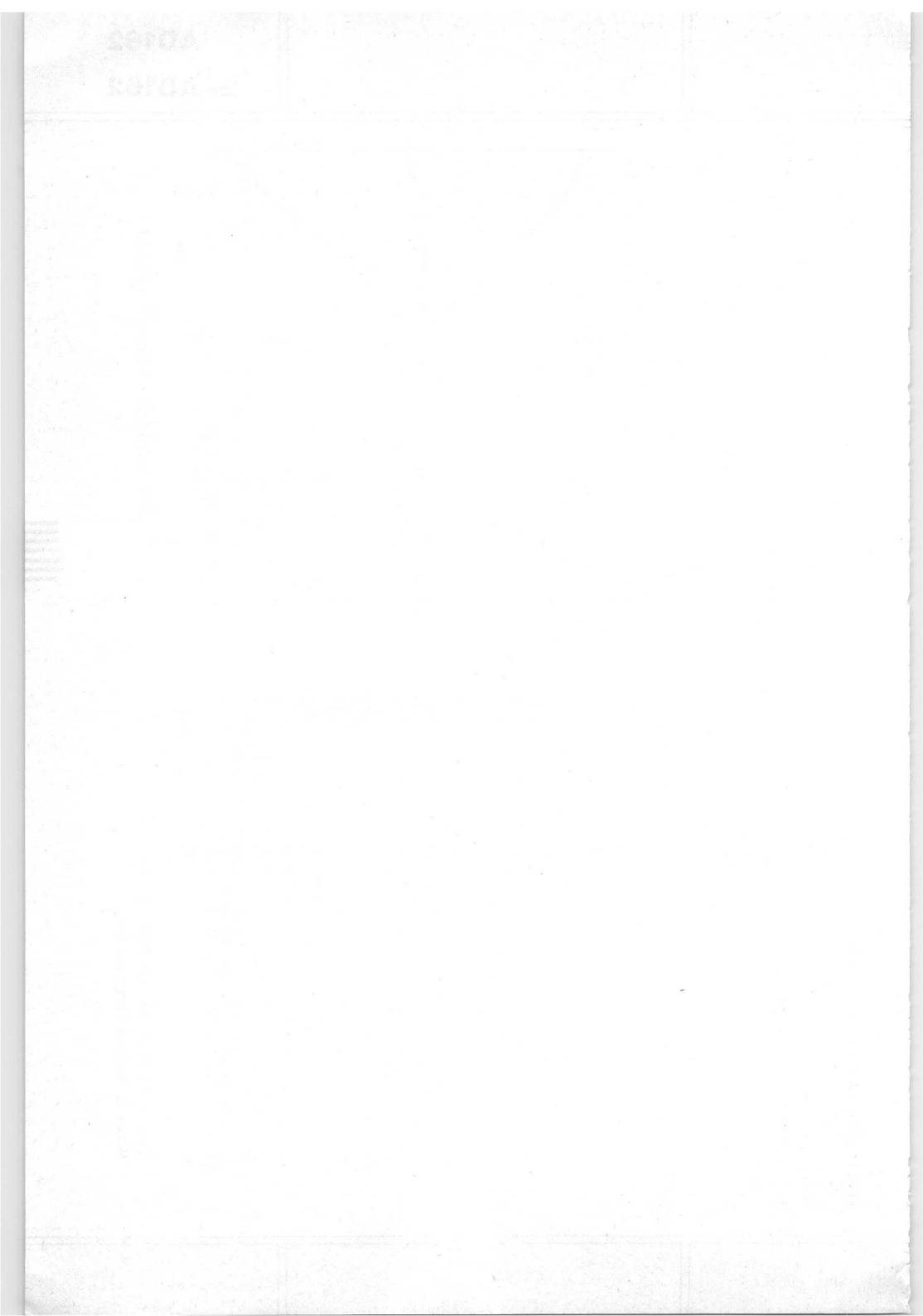
The distortion as a function of the output power at several ambient temperatures.

APPLICATION INFORMATION (continued)

B. 8 W amplifier with matched pair AD161/AD162



This amplifier can safely be employed up to an ambient temperature of 45°C, provided the transistors AD161 and AD162 are mounted on a common heatsink of 200 cm², thickness 2 mm and the AC128/01 on a heatsink of 50 cm².



P-N-P POWER TRANSISTOR

Germanium alloy transistor in a TO-36 metal envelope. The ADY26 is primarily intended for high power and high current application.

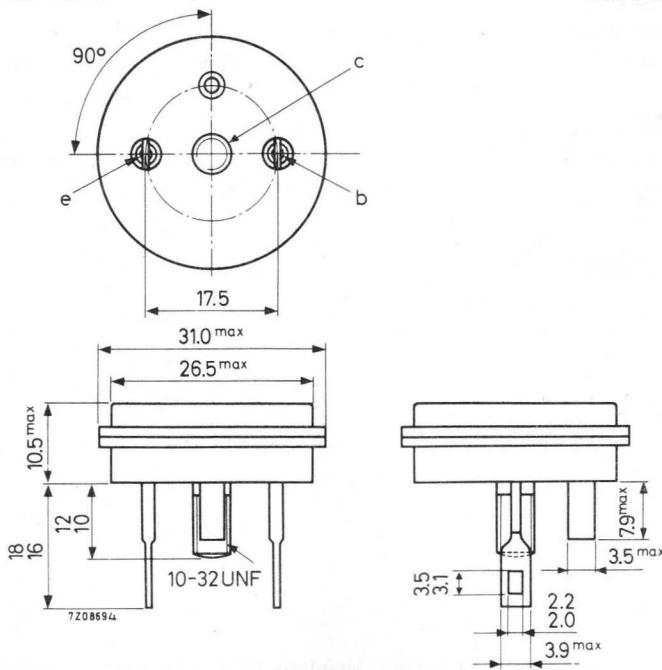
QUICK REFERENCE DATA

Collector-base voltage (open emitter)	-V _{CBO}	max.	80	V
Collector-emitter voltage (open base)	-V _{CEO}	max.	60	V
Emitter-base voltage (open collector)	-V _{EBO}	max.	40	V
Collector current (peak value)	-I _{CM}	max.	30	A
Total power dissipation up to T _{mb} = 30 °C	P _{tot}	max.	100	W
Junction temperature	T _j	max.	90	°C
D.C. current gain at T _j = 25 °C I _E = 25 A; V _{CB} = 0	h _{FE}	>	15	

MECHANICAL DATA

Dimensions in mm

TO-36



Diameter of hole in heatsink: max. 5.2 mm
Supplied with device: 56213

Torque on nut: min. 8 cm kg
max. 17 cm kg

RATINGS (Limiting values) ¹⁾Voltages

Collector-base voltage (open emitter)	$-V_{CBO}$	max.	80	V
Collector-emitter voltage (open base) see also page 10	$-V_{CEO}$	max.	60	V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	40	V

Currents

Collector current (averaged over any 20 ms period)	$-I_C$	max.	25	A
Collector current (peak value)	$-I_{CM}$	max.	30	A
Base current (averaged over any 20 ms period)	$-I_B$	max.	3	A
Base current (peak value)	$-I_{BM}$	max.	5	A

Power dissipation

Total power dissipation up to $T_{mb} = 30^\circ\text{C}$ see also page 11	P_{tot}	max.	100	W
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Temperatures

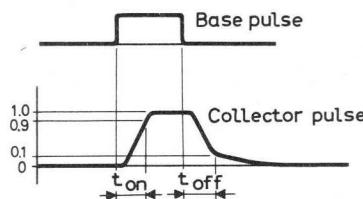
Storage temperature	T_{stg}	-55 to +90	$^\circ\text{C}$
Junction temperature	T_j	max.	90 $^\circ\text{C}$

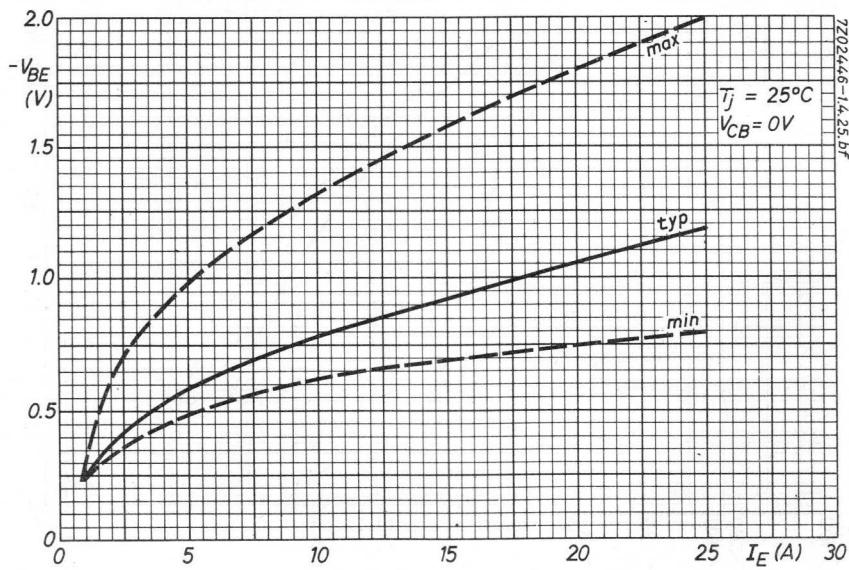
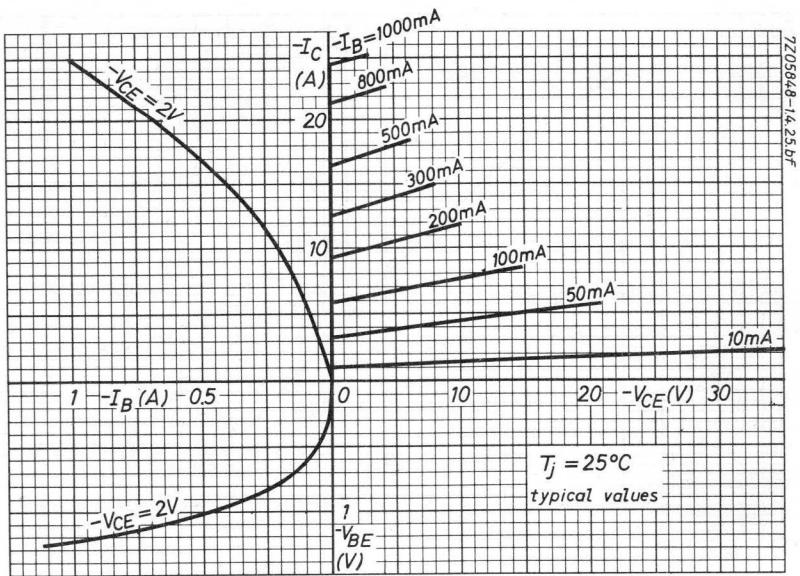
THERMAL RESISTANCE

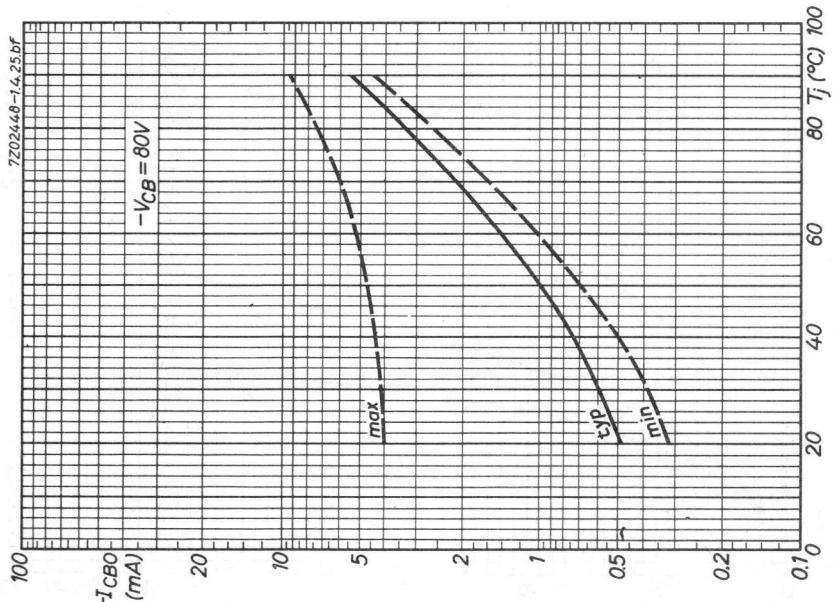
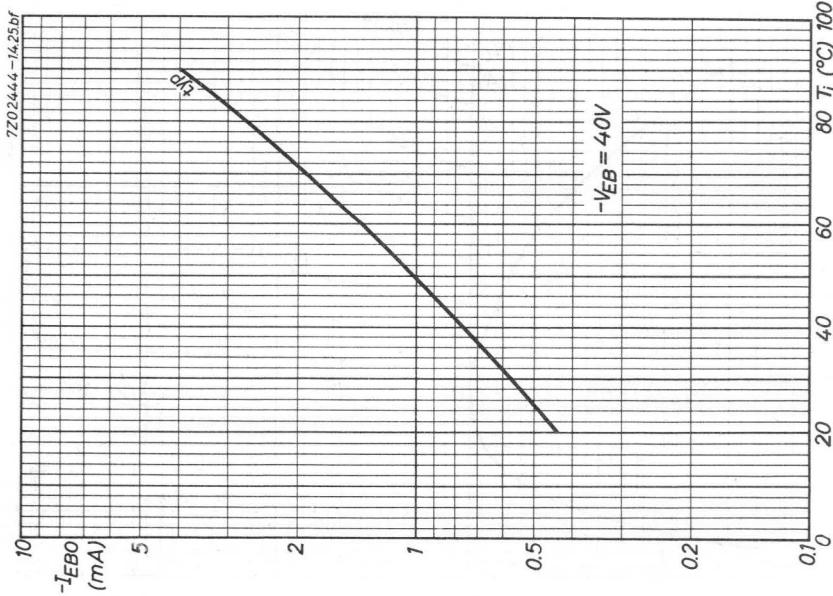
From junction to mounting base $R_{th\ j-mb} = 0.6 \ ^\circ\text{C/W}$

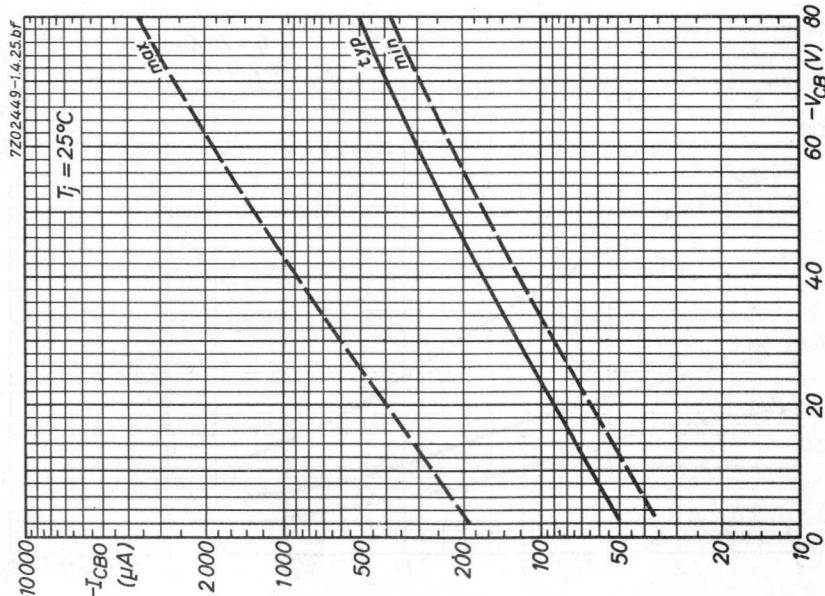
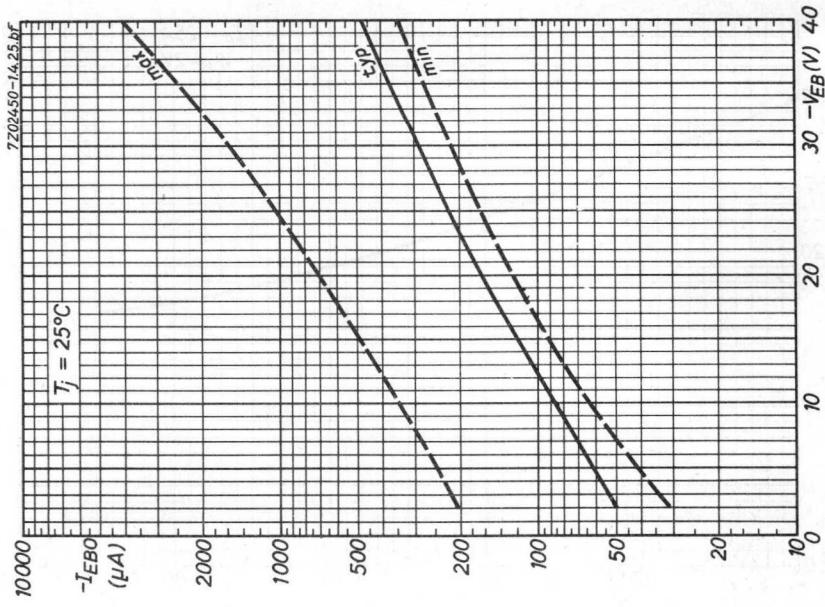
¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

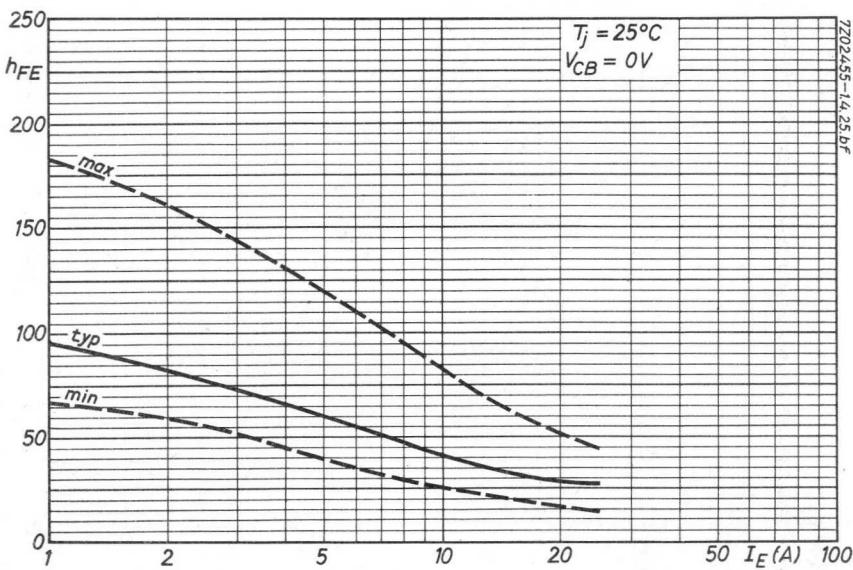
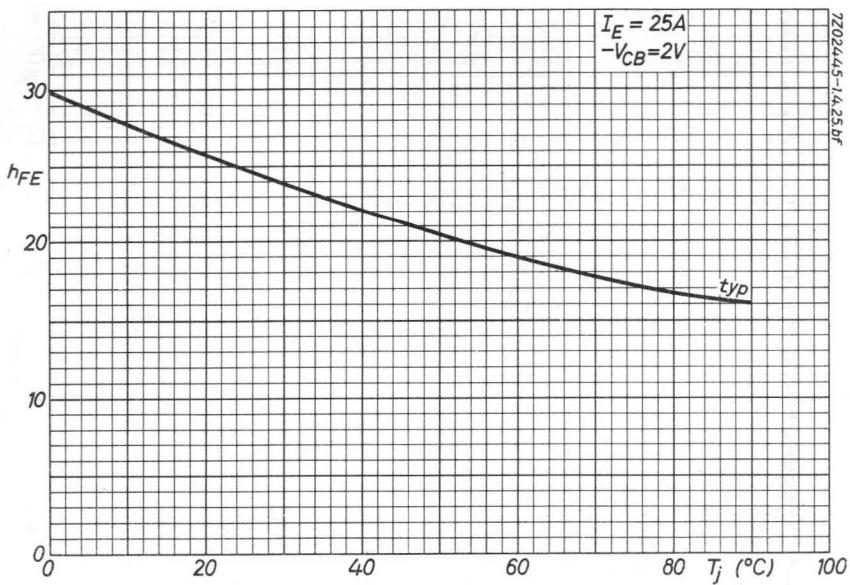
CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; -V_{CB} = 2 \text{ V}$ $-I_{CBO}$ typ. $50 \mu\text{A}$
 $< 200 \mu\text{A}$ $I_E = 0; -V_{CB} = 80 \text{ V}$ $-I_{CBO}$ typ. 0.5 mA
 $< 4 \text{ mA}$ Emitter cut-off current $I_C = 0; -V_{EB} = 2 \text{ V}$ $-I_{EBO}$ typ. $50 \mu\text{A}$
 $< 200 \mu\text{A}$ $I_C = 0; -V_{EB} = 40 \text{ V}$ $-I_{EBO}$ typ. 0.5 mA
 $< 4 \text{ mA}$ Currents at reverse biased emitter junction $+V_{BE} = 1 \text{ V}; -V_{CE} = 80 \text{ V}; T_j = 90^\circ\text{C}$ $-I_{CEX}$ typ. 3 mA Sustaining voltage $-I_C = 25 \text{ A}; +V_{BE} = 2 \text{ V}$ $-V_{CEXsust}$ $> 40 \text{ V}$ Base-emitter voltage $I_E = 5 \text{ A}; V_{CB} = 0$ $-V_{BE}$ typ. 0.6 V
 $< 1 \text{ V}$ $I_E = 25 \text{ A}; V_{CB} = 0$ ¹⁾ $-V_{BE}$ typ. 1.2 V
 $< 2 \text{ V}$ Saturation voltage ¹⁾ $-I_C = 25 \text{ A}; -I_B = 2.5 \text{ A}$ $-V_{CEsat}$ typ. 0.15 V
 $< 0.5 \text{ V}$ Emitter floating voltage $I_E = 0; -V_{CB} = 80 \text{ V}$ $-V_{EBfl}$ typ. 0.2 V
 $< 1.0 \text{ V}$ D.C. current gain $I_E = 5 \text{ A}; V_{CB} = 0$ hFE typ. 60
40 to 120 $I_E = 25 \text{ A}; V_{CB} = 0$ ¹⁾ hFE > 15
typ. 25 Collector capacitance $I_E = I_e = 0; -V_{CB} = 12 \text{ V}$ C_C typ. 350 pF ¹⁾ Measured under pulsed conditions to prevent excessive dissipation.

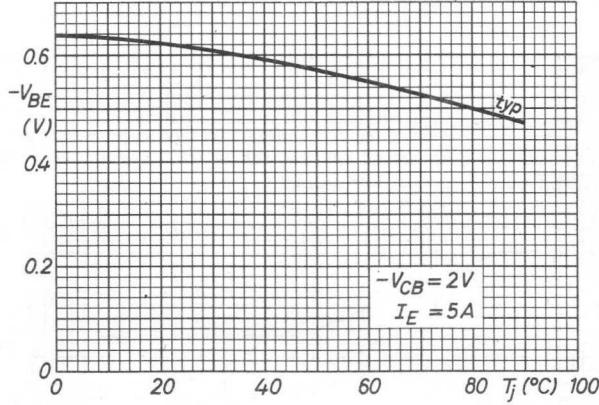
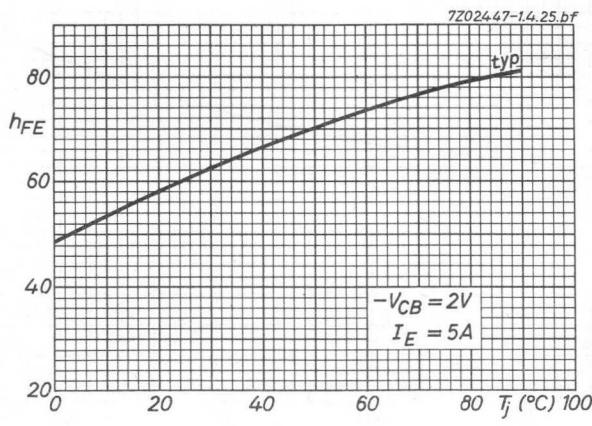
CHARACTERISTICS (continued) $T_j = 25^{\circ}\text{C}$ unless otherwise specifiedSmall signal current gain $-I_C = 1 \text{ A}; -V_{CE} = 12 \text{ V}; f = 100 \text{ kHz}$ $h_{fe} > 1.0$
typ. 1.7Turn on time $-I_C = 25 \text{ A}; -I_B = 2 \text{ A}; -V_{CC} = 18 \text{ V}$ t_{on} typ. 25 μs Turn off time $-I_C = 25 \text{ A}; V_{BEoff} = 6 \text{ V}; R_{BE} = 10 \Omega$ t_{off} typ. 75 μs 



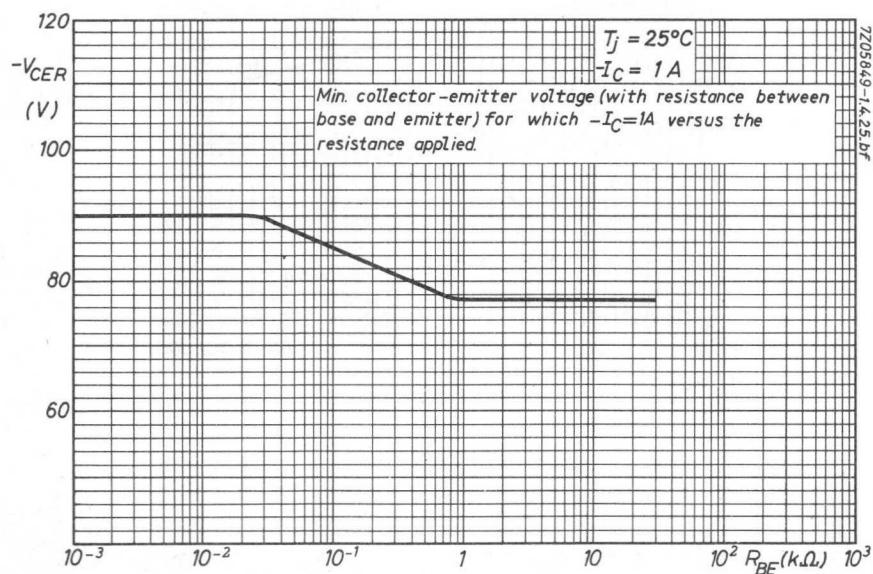
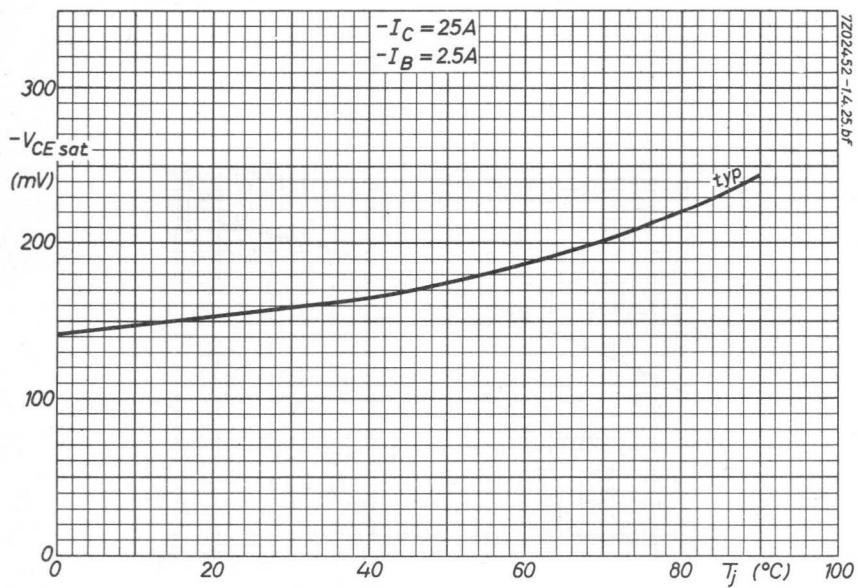


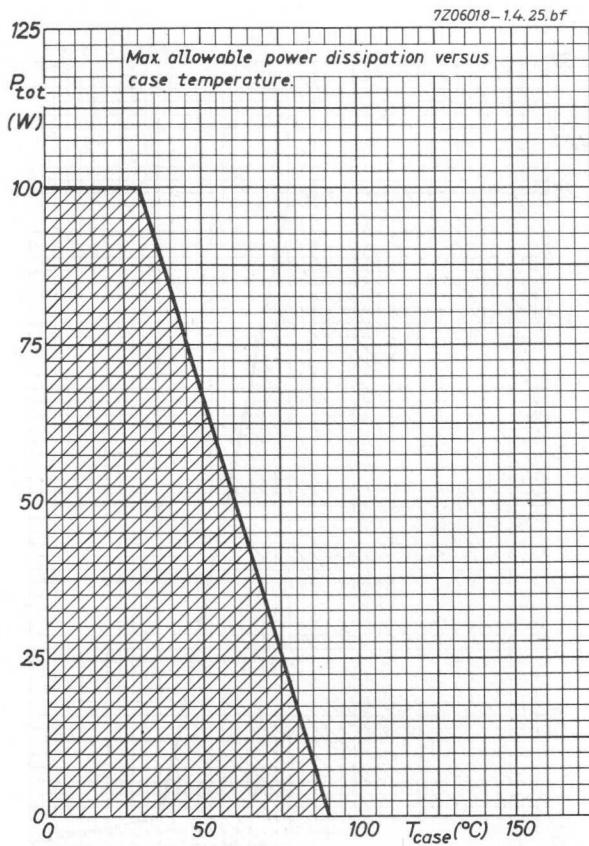


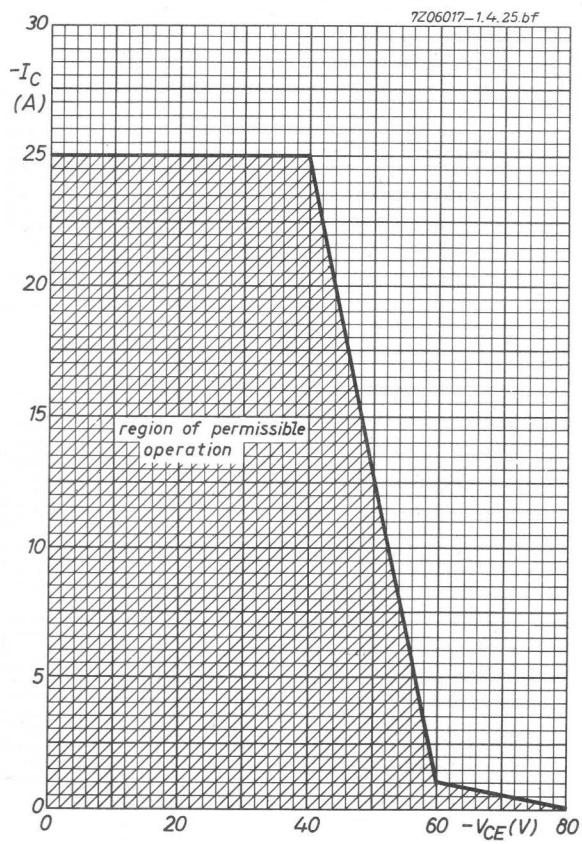




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GERMANIUM ALLOYED POWER TRANSISTORS

P-N-P transistors in a TO-36 metal envelope.

The ADZ11 and ADZ12 are primarily intended for use in a.f. applications.

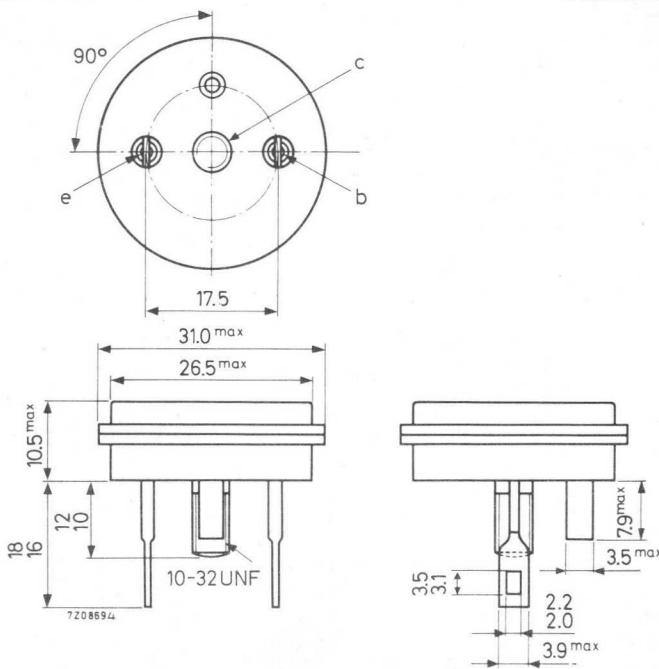
QUICK REFERENCE DATA

		ADZ11	ADZ12
Collector-base voltage (open-emitter)	-V _{CBO}	max. 50	80 V
Collector-emitter voltage (open base)	-V _{CEO}	max. 40	60 V
Collector current (peak value)	-I _{CM}	max. 20 A	
Total power dissipation up to T _{mb} = 55 °C	P _{tot}	max. 45 W	
Junction temperature	T _j	max. 90 °C	
D.C. current gain at T _j = 25 °C			
-I _C = 1.2 A; V _{CB} = 0	h _{FE}	40 to 120	
Cut-off frequency	f _{hfe}	> 80 kHz	
I _E = 1 A; -V _{CB} = 12 V	f _{hfe}	> 100 kHz	
	ADZ11		
	ADZ12		

MECHANICAL DATA

TO-36

Dimensions in mm



Diameter of hole in heatsink: max. 5.2 mm
 Supplied with device: 56213

Torque on nut: min. 8 cm kg
 max. 17 cm kg

RATINGS (Limiting values) 1)Voltages

		ADZ11	ADZ12
Collector-base voltage (open emitter)	-V _{CBO}	max. 50	80 V
Collector-emitter voltage (open base)	-V _{CEO}	max. 40	60 V
Emitter-base voltage (open collector)	-V _{EBO}	max. 30	50 V

Currents

Collector current (d.c.)	-I _C	max.	15 A
Collector current (peak value)	-I _{CM}	max.	20 A
Base current (d.c.)	-I _B	max.	2 A
Base current (peak value)	-I _{BM}	max.	4 A

Power dissipation

Total power dissipation up to T _{mb} = 55 °C	P _{tot}	max.	45 W
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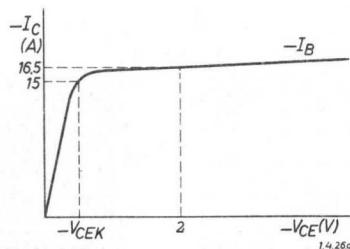
Temperatures

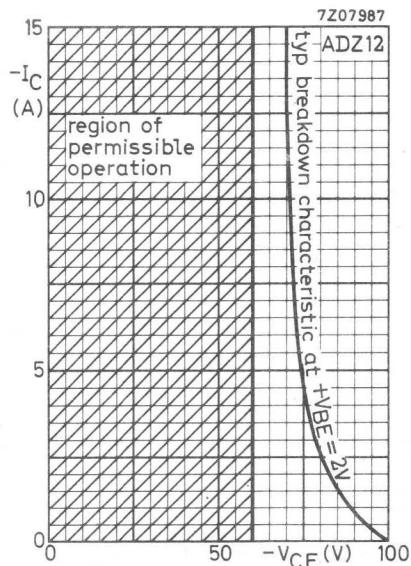
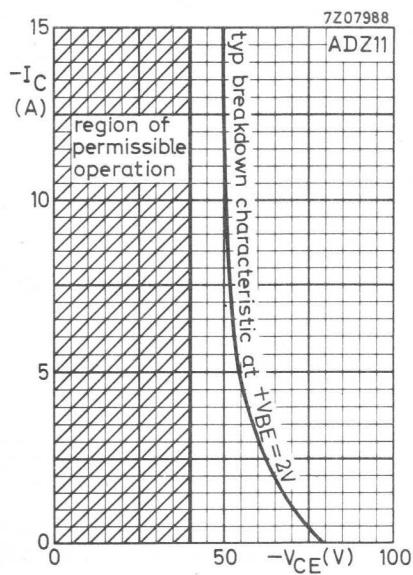
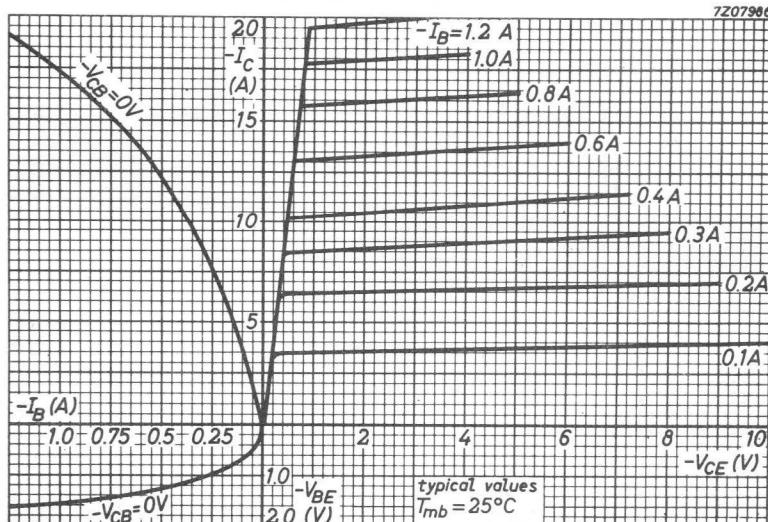
Storage temperature	T _{stg}	-55 to +75	°C
Junction temperature	T _j	max.	90 °C

THERMAL RESISTANCE

From junction to mounting base R_{th j-mb} = 0.8 °C/W

1) Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_{mb} = 25^{\circ}\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; -V_{CB} = 2 \text{ V}$ $-I_{CBO} < 0.2 \text{ mA}$ $I_E = 0; -V_{CB} = -V_{CBO\text{max}}$ $-I_{CBO} < 8 \text{ mA}$ Emitter cut-off current $I_C = 0; -V_{EB} = 2 \text{ V}$ $-I_{EBO} < 0.2 \text{ mA}$ $I_C = 0; -V_{EB} = -V_{EBO\text{max}}$ $-I_{EBO} < 8 \text{ mA}$ Emitter-base voltage $-I_C = 1.2 \text{ A}; V_{CB} = 0$ $V_{EB} < 0.7 \text{ V}$ $-I_C = 5 \text{ A}; V_{CB} = 0$ $V_{EB} < 1.2 \text{ V}$ $-I_C = 15 \text{ A}; V_{CB} = 0$ $V_{EB} < 2 \text{ V}$ Knee voltage $-I_C = 15 \text{ A}; -I_B = \text{value for which}$ $-I_C = 16.5 \text{ A at } -V_{CE} = 2 \text{ V}$ $-V_{CEK} < 1 \text{ V}$ Emitter floating voltage $I_E = 0; -V_{CB} = -V_{CBO\text{max}}$ $-V_{EBfl} < 1 \text{ V}$ D.C. current gain $-I_C = 1.2 \text{ A}; V_{CB} = 0$ $h_{FE} \text{ 40 to 120}$ $-I_C = 5 \text{ A}; V_{CB} = 0$ $h_{FE} > 25$ $-I_C = 15 \text{ A}; V_{CB} = 0$ $h_{FE} > 15$ Cut-off frequency $I_E = 1 \text{ A}; -V_{CB} = 12 \text{ V}$ ADZ11:
ADZ12: $f_{hfe} > 80 \text{ kHz}$
 $f_{hfe} > 100 \text{ kHz}$



POWER SWITCHING TRANSISTORS

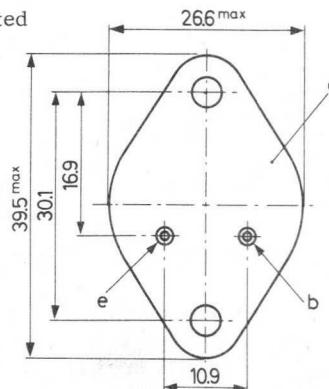
P-N-P germanium low spread medium gain power transistors in a TO-3 metal case for power switching at high currents.

QUICK REFERENCE DATA					
		ASZ 15	ASZ 16	ASZ 17	ASZ 18
Collector-base voltage (open emitter)	$-V_{CBO}$	max. 100	60	60	100 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max. 60	32	32	32 V
Total power dissipation up to $T_{mb} = 45^{\circ}\text{C}$	P_{tot}	max. 30	30	30	30 W
Junction temperature	T_j	max. 90	90	90	90 $^{\circ}\text{C}$
D.C. current gain at $T_j = 25^{\circ}\text{C}$					
$-I_C = 1 \text{ A}; -V_{CE} = 1 \text{ V}$	h_{FE}	> 20 < 55	45 130	25 75	30 110
$-I_C = 6 \text{ A}; -V_{CE} = 1 \text{ V}$	h_{FE}	> 15 < 30	35 80	20 45	20 65
Transition frequency					
$-I_C = 1 \text{ A}; -V_{CE} = 5 \text{ V}$	f_T	typ. 200	250	220	220 kHz

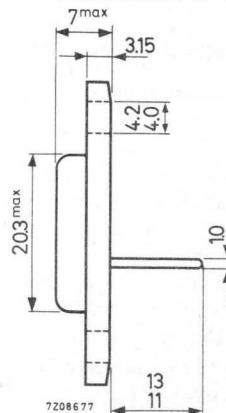
MECHANICAL DATA

TO-3

Collector connected
to mounting base



Dimensions in mm



Accessories available: 56201e

RATINGS (Limiting values)¹⁾

Voltages		ASZ 15	ASZ 16	ASZ 17	ASZ 18	
Collector-base voltage (open emitter) ²⁾	-V _{CBO}	max. 100	60	60	100	V
Collector-emitter voltage (open base) (see also pages 12 and 13)	-V _{CEO}	max. 60	32	32	32	V
Emitter-base voltage (open collector)	-V _{EBO}	max. 40	20	20	40	V
Currents						
Collector current (d.c.)	-I _C	max.		8	A	
Collector current (peak value)	-I _{CM}	max.		10	A	
Emitter current (d.c.)	I _E	max.		9	A	
Emitter current (peak value)	I _{EM}	max.		12	A	
Base current (d.c.)	-I _B	max.		1	A	
Base current (peak value)	-I _{BM}	max.		2	A	
Power dissipation (see also page 9)						
Total power dissipation up to T _{mb} = 45 °C	P _{tot}	max.		30	W	
Temperatures						
Storage temperature	T _{stg}		-65 to +90		°C	
Junction temperature: continuous incidentally	T _j	max.	90	°C		
	T _j	max.	100	°C		

THERMAL RESISTANCE

From junction to mounting base	R _{th j-mb}	=	1.5	°C/W
From mounting base to heatsink	R _{th mb-h}	=	0.2	°C/W
From mounting base to heatsink with lead washer and mica washer	R _{th mb-h}	=	0.5	°C/W

1) Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

2) When switched from a thermally stable on state with max. junction temperature to a not stabilized cut-off condition, -V_{CBO} max is allowed, provided T_{amb} < 55 °C and R_{th j-a} < 9 °C/W for ASZ16 and ASZ17
R_{th j-a} < 5 °C/W for ASZ15 and ASZ18

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector current

$I_E = 0; -V_{CB} = 0.5 \text{ V}$	$-I_{CBO}$	<	0.1	mA
$I_E = 0; -V_{CB} = -V_{CB\text{Omax}}$	$-I_{CBO}$	<	3.0	mA
$I_E = 0; -V_{CB} = -V_{CB\text{Omax}}; T_j = 100^\circ\text{C}$	$-I_{CBO}$	<	30	mA

Emitter current

$I_C = 0; -V_{EB} = -V_{EB\text{Omax}}$	$-I_{EBO}$	<	3.0	mA
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Base current

		ASZ15	ASZ16	ASZ17	ASZ18
$I_E = 1 \text{ A}; V_{CB} = 0$	$-I_B$	> 17.5 < 50	7.2 21.5	13 38	9 33 mA
$I_E = 6 \text{ A}; V_{CB} = 0$	$-I_B$	> 190 < 375	73 165	130 285	90 285 mA

Emitter-base voltage

$I_E = 6 \text{ A}; V_{CB} = 0$	V_{EB}	> 0.6 < 1.6	- 1.4	0.4 1.4	- 1.6 V
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Saturation voltages

$-I_C = 10 \text{ A}; -I_B = 1 \text{ A}$	$-V_{CE\text{sat}}$	< 0.4	0.4	0.4	0.4 V
	$-V_{BE\text{sat}}$	< 1.4	1.4	1.4	1.4 V

Emitter-base floating voltage

$I_E = 0; -V_{CB} = 60 \text{ V}$	$-V_{EB\text{fl}}$	< 0.5	-	-	0.5 V
$I_E = 0; -V_{CB} = 48 \text{ V}$	$-V_{EB\text{fl}}$	< -	0.5	0.5	- V

D.C. current gain

$-I_C = 1 \text{ A}; -V_{CE} = 1 \text{ V}$	h_{FE}	> 20 < 55	45 130	25 75	30 110
$-I_C = 6 \text{ A}; -V_{CE} = 1 \text{ V}$	h_{FE}	> 15 < 30	35 80	20 45	20 65

Transition frequency

$-I_C = 1 \text{ A}; -V_{CE} = 5 \text{ V}$	f_T	typ. 200	250	220	220 kHz
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Collector capacitance ($f = 500 \text{ kHz}$)

$I_E = I_e = 0; -V_{CB} = 5 \text{ V}$	C_C	typ. 190	190	190	190 pF
--	-------	----------	-----	-----	--------

Emitter capacitance ($f = 500 \text{ kHz}$)

$I_C = I_e = 0; -V_{EB} = 5 \text{ V}$	C_e	typ. 150	150	150	150 pF
--	-------	----------	-----	-----	--------

CHARACTERISTICS (continued)

$T_j = 25^\circ\text{C}$ unless otherwise specified

D.C. current gain ratio of matched pairs

$$-I_C = 0.3 \text{ A}$$

$$h_{FE1}/h_{FE2} < 1.25$$

$$-I_C = 6.0 \text{ A}$$

$$h_{FE1}/h_{FE2} < 1.25$$

Switching times

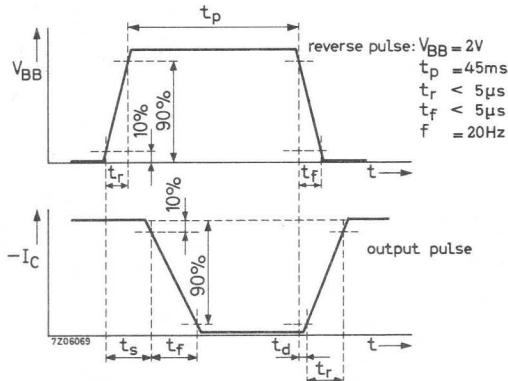
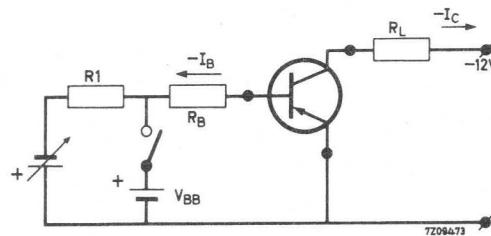
Circuit I: $R_B = 10 \Omega$; $R_1 = 220 \Omega$; $R_L = 12 \Omega$

ASZ15: $-I_B = 75 \text{ mA}$	$-I_C = 1 \text{ A}$	delay time	$t_d < 2 \mu\text{s}$
ASZ16: $-I_B = 35 \text{ mA}$		rise time	$t_r < 25 \mu\text{s}$
ASZ17: $-I_B = 60 \text{ mA}$		storage time	$t_s < 10 \mu\text{s}$
ASZ18: $-I_B = 50 \text{ mA}$		fall time	$t_f < 20 \mu\text{s}$

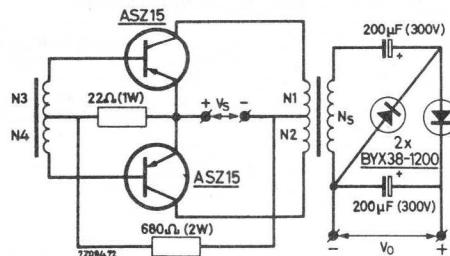
Circuit II: $R_B = 1 \Omega$; $R_1 = 13 \Omega$; $R_L = 1.2 \Omega$

ASZ15: $-I_B = 1.35 \text{ A}$	$-I_C = 10 \text{ A}$	delay time	$t_d < 1 \mu\text{s}$
ASZ16: $-I_B = 0.6 \text{ A}$		rise time	$t_r < 20 \mu\text{s}$
ASZ17: $-I_B = 1.0 \text{ A}$		storage time	$t_s < 15 \mu\text{s}$
ASZ18: $-I_B = 1.0 \text{ A}$		fall time	$t_f < 35 \mu\text{s}$

Test circuit:



APPLICATION INFORMATION

Typical operation in a d.c. to d.c. converter

The data below have been designed for continuous operation up to $T_{amb} = 55^{\circ}\text{C}$. Incidentally, operation up to $T_{amb} = 60^{\circ}\text{C}$ is permitted.

(Based on $R_{th\ j-a} = 15^{\circ}\text{C/W}$ per transistor)

$$V_S = 28 \text{ V}$$

Losses

$$\text{In transistors} : 2 \times 2 \text{ W}$$

$$I_S = 2.5 \text{ A}$$

$$\text{In diodes} : 2 \times 0.3 \text{ W}$$

$$P_S = 70 \text{ W}$$

$$\text{In biasing resistors} : 1.7 \text{ W}$$

$$V_O = 220 \text{ V}$$

$$\text{In transformer} : 3.7 \text{ W}$$

$$I_O = 270 \text{ mA}$$

$$P_O = 60 \text{ W}$$

$$\eta = 86 \% \text{}$$

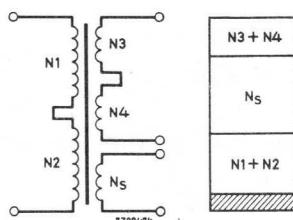
$$f = 450 \text{ Hz}$$

Transformer data

The transformer core consists of square loop material

(Telcon HCR alloy type 227)

Stacking height = 15 mm



$N_1 + N_2$ are bifilarly wound
 $N_3 + N_4$

$N_1 = N_2 = 46$ turns of enamelled copper wire,
 1 mm

$N_3 = N_4 = 5$ turns of enamelled copper wire,
 0.5 mm

$N_S = 190$ turns of enamelled copper wire,
 0.5 mm

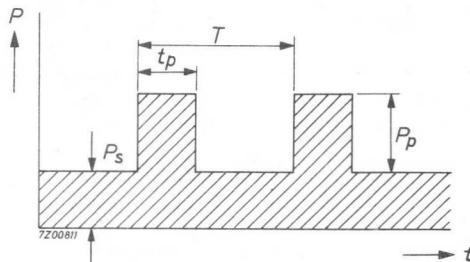
OPERATING NOTES

Determination of peak power ratings under fault conditions and/or surge operation shorter than the temperature stabilisation time

$$P_p = \frac{T_{j\ max} - T_{amb} - (R_{th\ j-mb} + R_{th\ mb-h} + R_{th\ h-a}) \cdot P_s}{R_{th\ t} + \delta \cdot R_{th\ h-a}}$$

For a pulse duration, longer than the temperature stabilisation time

$$P_p = \frac{T_{j\ max} - T_{amb}}{R_{th\ j-mb} + R_{th\ mb-h} + R_{th\ h-a}} - P_s$$



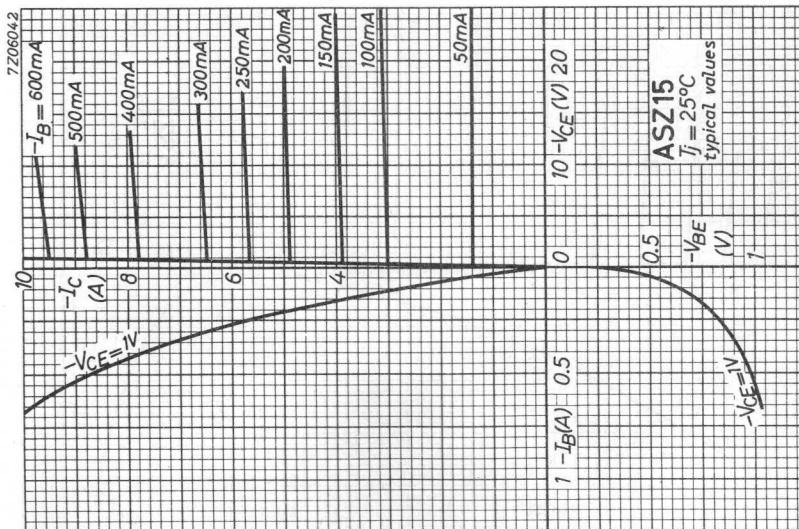
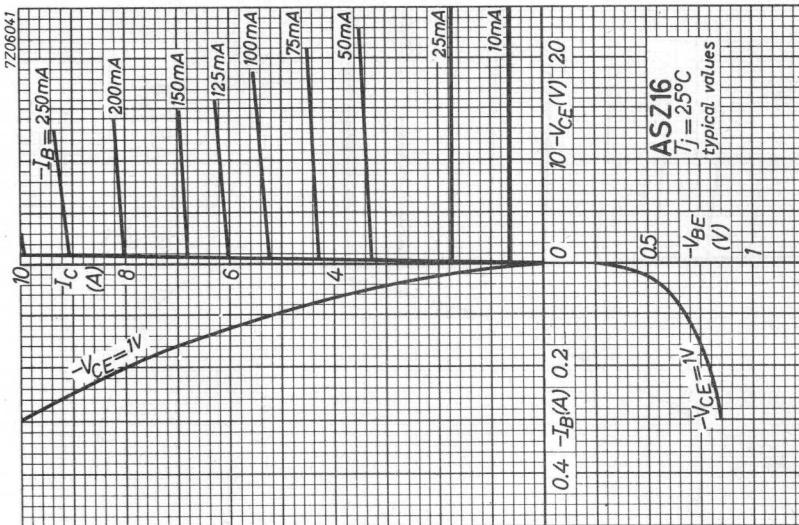
Where:

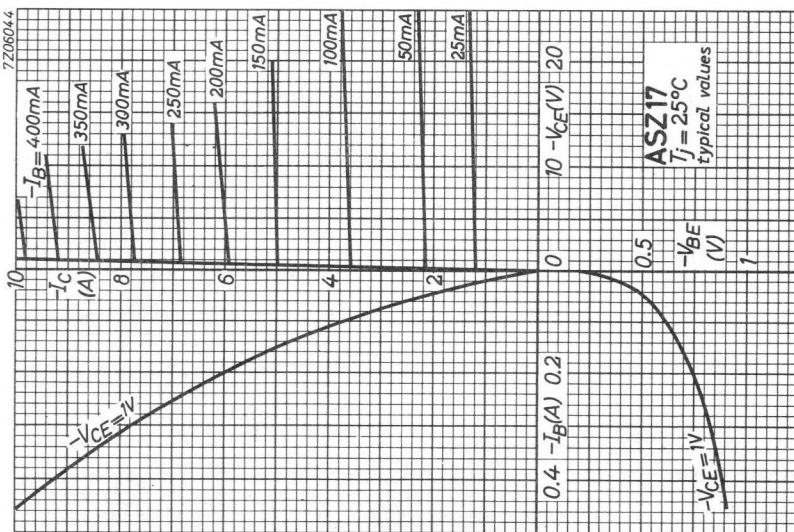
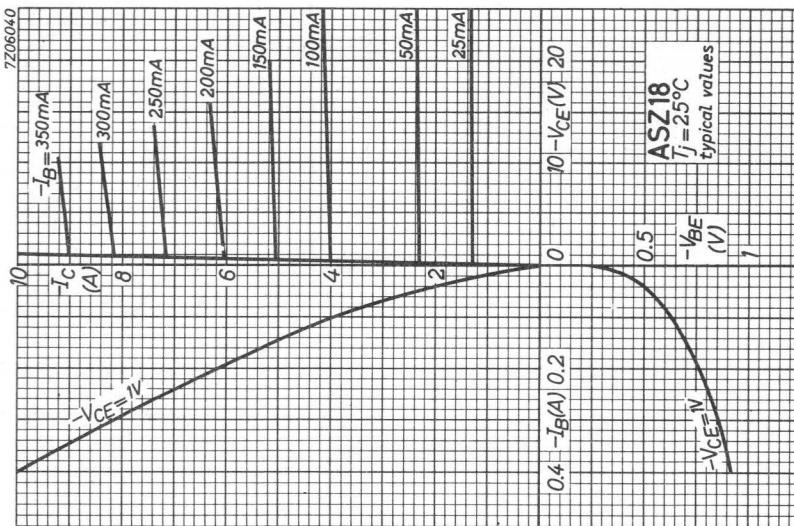
- t_p = pulse duration
 - T = pulse period
 - δ = duty cycle = t_p/T
 - P_s = steady state power dissipation
 - P_p = permissible pulse power dissipation over P_s
 - $R_{th\ j-mb}$ = thermal resistance from junction to mounting base
 - $R_{th\ mb-h}$ = thermal resistance from mounting base to heatsink
 - $R_{th\ h-a}$ = thermal resistance from heatsink to ambient
 - $R_{th\ t}$ = transient thermal resistance = $f(t, \delta)$; see page 14
(for durations longer than the temperature stabilisation time) $R_{th\ t} = R_{th\ j-h} = R_{th\ j-mb} + R_{th\ mb-h}$
 - $T_{j\ max}$ = maximum permissible junction temperature
 - T_{amb} = ambient temperature
- Temperature stabilisation time = 1 s (see page 14)

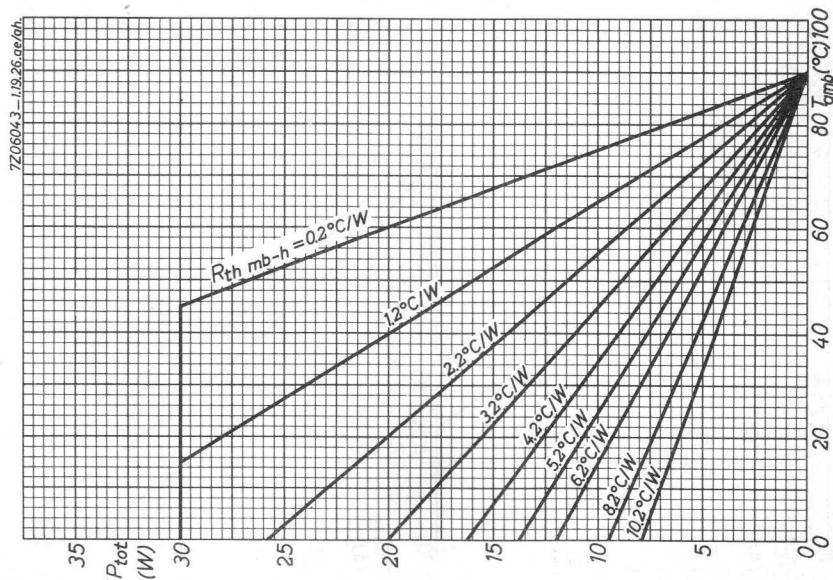
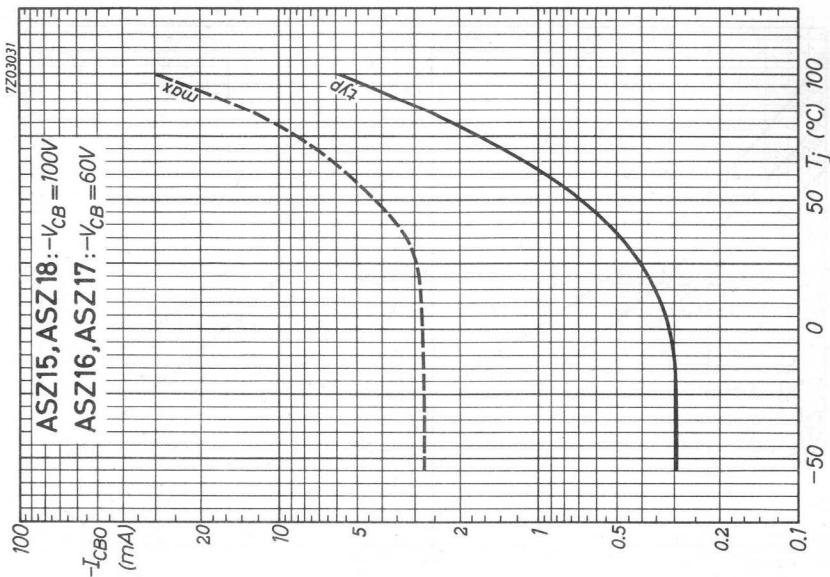
Example: $P_s = 5$ W, $t = 1$ ms, $\delta = 0.1$, $R_{th\ mb-h} = 0.5$ $^{\circ}\text{C}/\text{W}$,
 $R_{th\ h-a} = 4.25$ $^{\circ}\text{C}/\text{W}$ and $T_{amb} = 25$ $^{\circ}\text{C}$

From $t = 1$ ms and $\delta = 0.1$ it follows that $R_{th\ t} = 0.28$ $^{\circ}\text{C}/\text{W}$ (page 14)

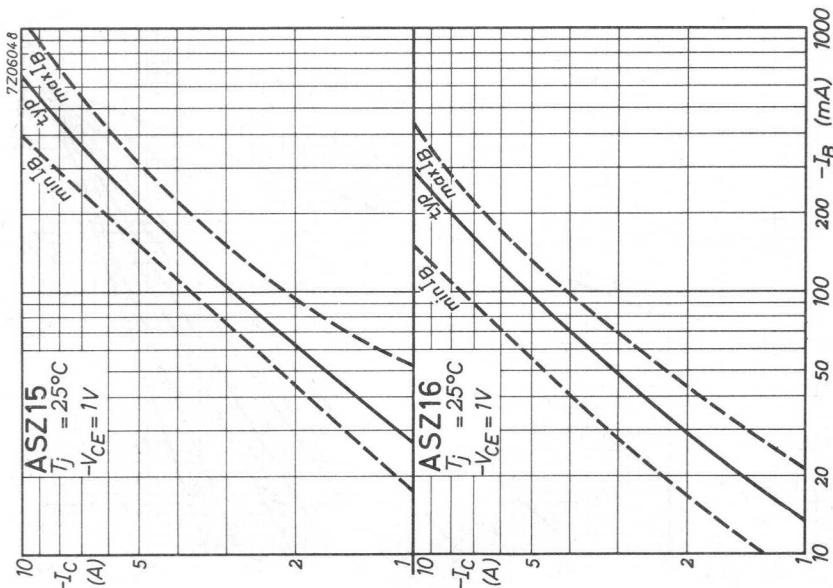
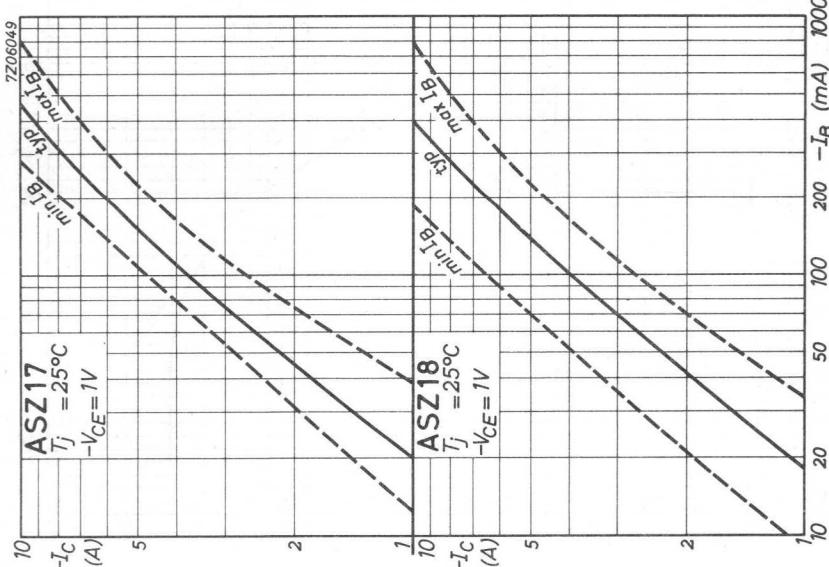
$$\text{Then } P_p = \frac{90 - 25 - (1.5 + 0.5 + 4.25) \times 5}{0.28 + 0.1 \times 4.25} \approx 47.5 \text{ W}$$

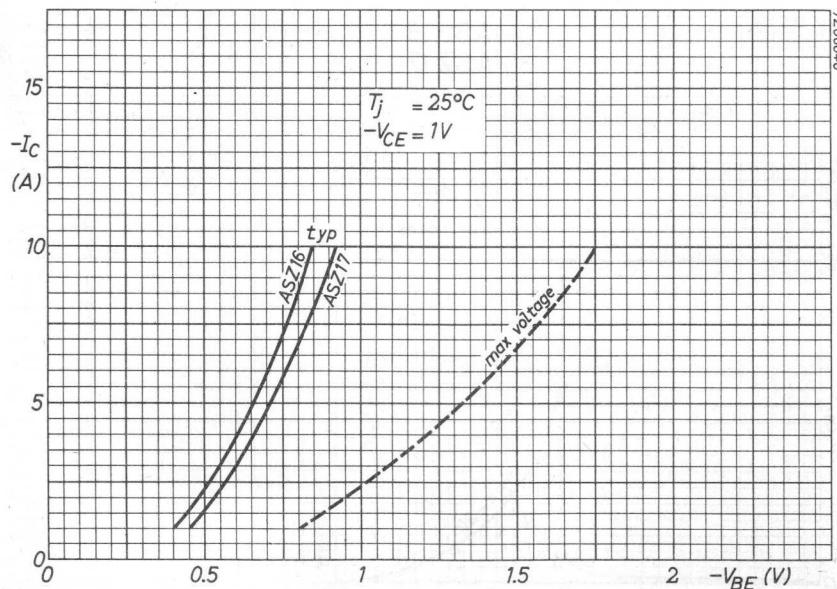
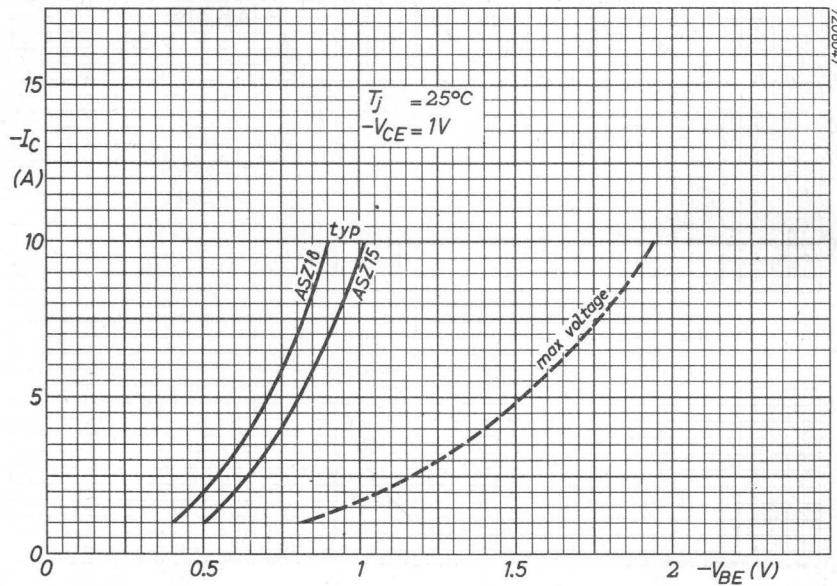






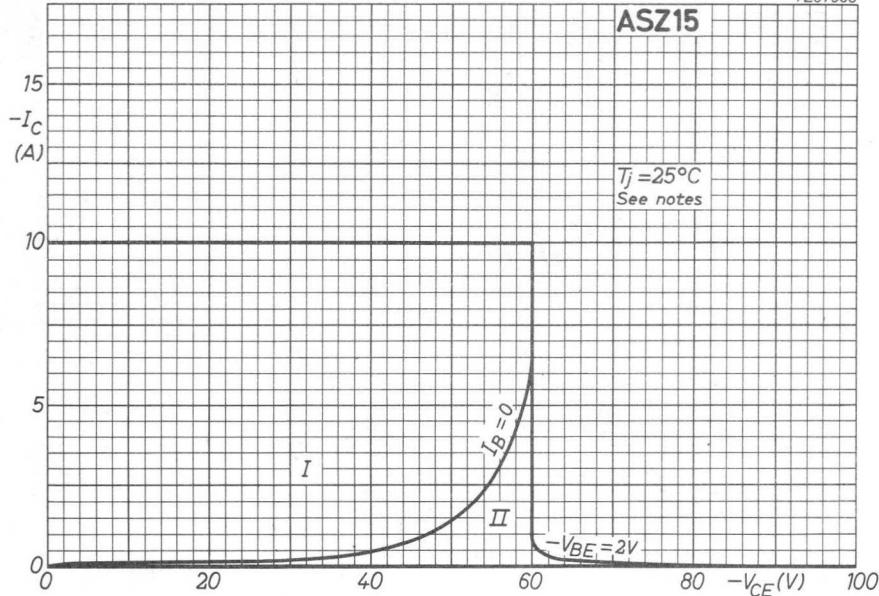
ASZ15 to 18



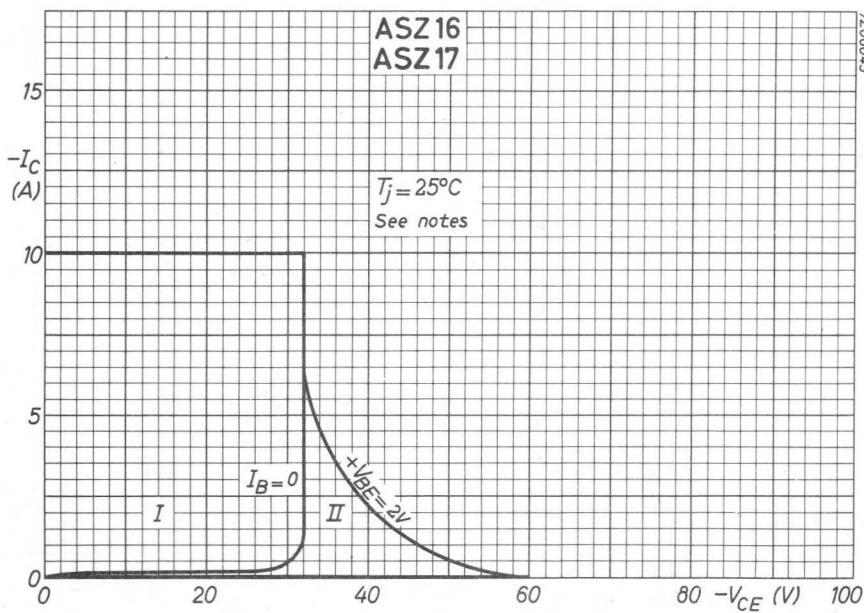


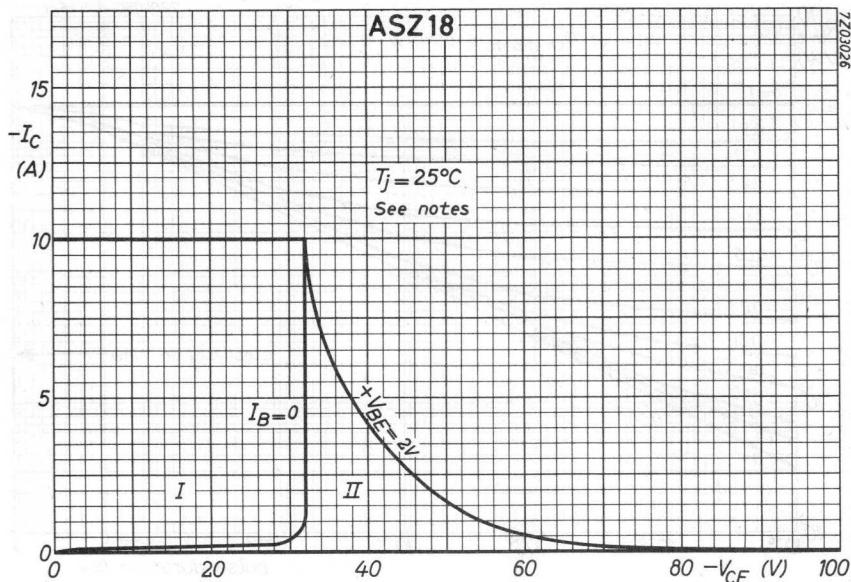
7Z07960

ASZ15



7Z08025

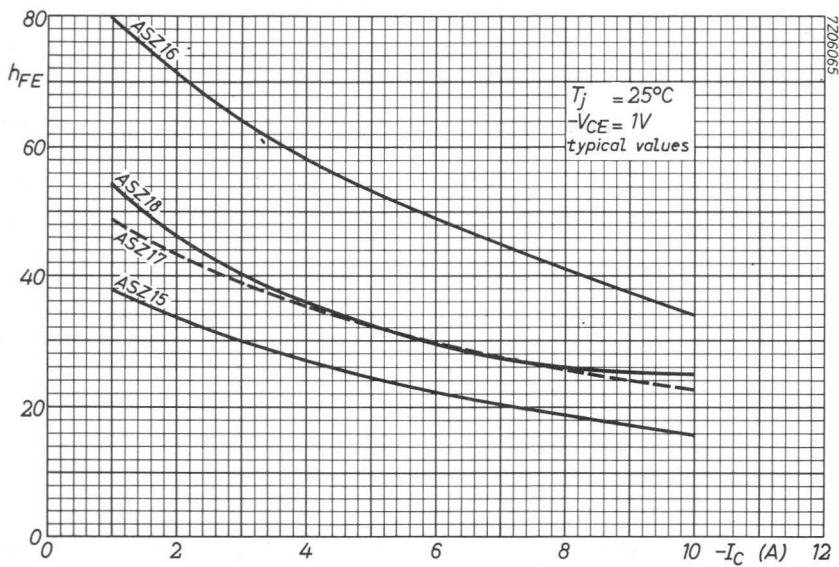
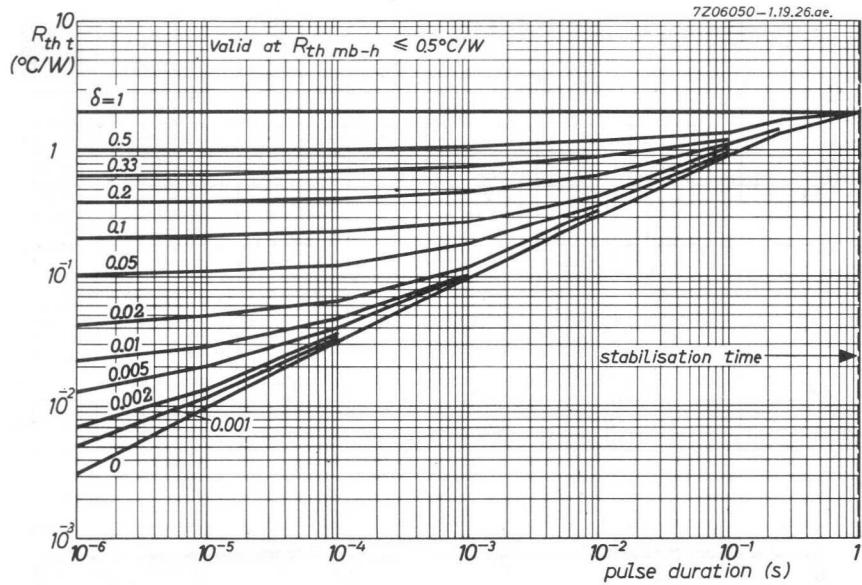
ASZ16
ASZ17

**NOTES**

I region of permissible operation under all base-emitter conditions

II additional region of operation when the transistor is cut-off with $+V_{BE} = 2$ V

During switching-off, voltages higher than indicated by the minimum avalanche breakdown curves at $+V_{BE} = 2$ V are allowed, provided the transient energy is less than 8 mWs.



POWER SWITCHING TRANSISTOR

P-N-P alloy diffused transistor for non-saturated switching.

RATINGS¹⁾

Voltages

Collector-base voltage (open emitter)	$-V_{CBO}$	max.	70	V
Collector-emitter voltage with $+V_{BE} > 0.2$ V	$-V_{CEX}$	max.	60	V

Currents

Collector current (d.c.)	$-I_C$	max.	700	mA
Emitter current (d.c.)	I_E	max.	750	mA
Reverse emitter current	$-I_E$	max.	50	mA
Base current (peak value)	$-I_{BM}$	max.	750	mA

Power dissipation

Total power dissipation up to $T_{mb} = 50$ °C	P_{tot}	max.	6	W
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Temperatures

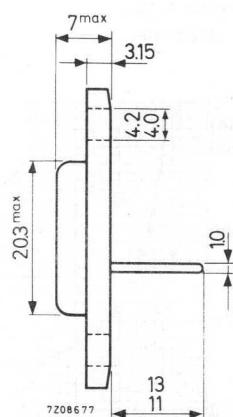
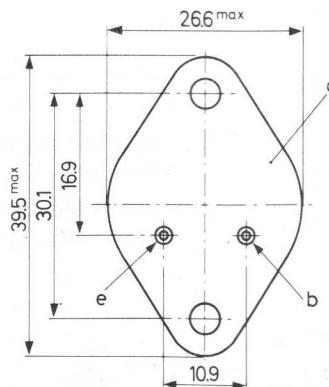
Storage temperature	T_{stg}	-55 to +75	°C
Junction temperature	T_j	max.	75 °C

THERMAL RESISTANCE

From junction to mounting base	$R_{th\ j-mb}$	=	4	°C/W
From mounting base to heatsink with lead washer and mica washer	$R_{th\ mb-h}$	=	0.5	°C/W

MECHANICAL DATA

Collector connected
to mounting base



¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off currents $I_E = 0; -V_{CB} = 60 \text{ V}; T_j = 75^\circ\text{C}$ $-I_{CBO} < 4.5 \text{ mA}$ $R_{BE} = 56 \Omega; -V_{CE} = 60 \text{ V}; T_{mb} = 60^\circ\text{C}$ $-I_{CER} < 2 \text{ mA}$ Currents at reverse biased emitter junction $+V_{BE} = 1 \text{ V}; -V_{CE} = 60 \text{ V}; T_{mb} = 60^\circ\text{C}$ $-I_{CEX} < 1 \text{ mA}$ $+I_{BEX} < 1 \text{ mA}$ Emitter-base voltage $I_E = 600 \text{ mA}; -V_{CB} = 10 \text{ V}; T_{mb} = 60^\circ\text{C}$ $V_{EB} > 0.1 \text{ V}$ $V_{EB} < 0.45 \text{ V}$ D.C. current gain $I_E = 600 \text{ mA}; -V_{CB} = 10 \text{ V}; T_{mb} = 25^\circ\text{C}$ $h_{FE} > 40$ $I_E = 600 \text{ mA}; -V_{CB} = 30 \text{ V}; T_j = 75^\circ\text{C}$ $h_{FE} > 100$ Collector capacitance $I_E = I_e = 0; -V_{CB} = 10 \text{ V}$ $C_C < 85 \text{ pF}$ $I_E = I_e = 0; -V_{CB} = 30 \text{ V}$ $C_C < 45 \text{ pF}$ Transition frequency $-I_C = 300 \text{ mA}; -V_{CE} = 10 \text{ V}$ $f_T > 60 \text{ MHz}$
typ. 120 MHzSwitching times

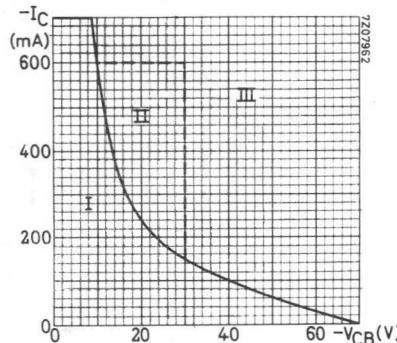
delay time

 $t_d < 0.2 \mu\text{s}$

rise time

 $t_r < 0.2 \mu\text{s}$

fall time

 $t_f < 0.2 \mu\text{s}$ I Region of permissible d.c. operation up to $T_j = 75^\circ\text{C}$ II Additional region of permissible pulse operation $t_p < 10 \mu\text{s}$; $\delta < 0.25$ III Permissible at switching off, provided $L < 250 \mu\text{H}$; $t_{off} < 15 \mu\text{s}$

HIGH VOLTAGE SILICON TRANSISTOR

N-P-N silicon planar transistor in a TO-39 metal envelope with the collector connected to the case.

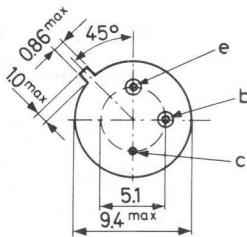
The transistor is intended for use in high voltage 2 W class A output stages of a.f. amplifiers, video amplifiers in colour television receivers including grid drive and in driver stages of high voltage line-deflection circuits.

QUICK REFERENCE DATA

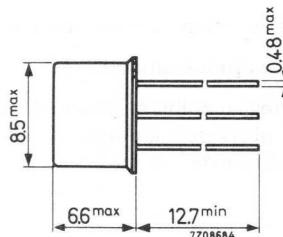
Collector-base voltage (open emitter)	V_{CBO}	max.	245	V
Collector-emitter voltage (open base)	V_{CEO}	max.	180	V
Collector current (peak value)	I_{CM}	max.	200	mA
Total power dissipation up to $T_{amb} = 50^{\circ}\text{C}$ (device mounted on a heatsink)	P_{tot}	max.	6	W
D.C. current gain at $T_j = 25^{\circ}\text{C}$ $I_C = 50 \text{ mA}; V_{CE} = 100 \text{ V}$	h_{FE}	> typ.	22 60	

MECHANICAL DATA

Collector connected
to case
TO-39



Dimensions in mm



Accessories available: 56218; 56245; 56265

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	245	V	1)
Collector-emitter voltage (open base) (See also page 4)	V_{CEO}	max.	180	V	
Collector-emitter voltage with $R_{BE} \leq 1 \text{ k}\Omega$	V_{CER}	max.	245	V	1)
Emitter-base voltage (open collector)	V_{EBO}	max.	5	V	

Currents

Collector current (d.c.)	I_C	max.	150	mA	
Collector current (peak value)	I_{CM}	max.	200	mA	

Power dissipation

Total power dissipation up to $T_{amb} = 50^\circ\text{C}$ mounted on a 1.5 mm Al. blackened heatsink of at least 30 cm^2 (See also page 4)	P_{tot}	max.	6	W	
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Temperatures

Storage temperature	T_{stg}	-55 to +200	$^\circ\text{C}$		
Junction temperature	T_j	max.	200	$^\circ\text{C}$	

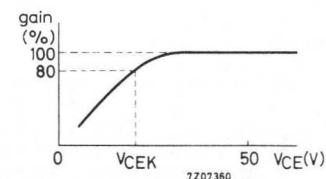
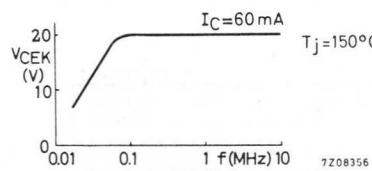
THERMAL RESISTANCE

From junction to ambient in free air	$R_{th j-a}$	=	200	$^\circ\text{C/W}$	
From junction to mounting base	$R_{th j-mb}$	=	12.5	$^\circ\text{C/W}$	
From junction to ambient mounted on a 1.5 mm blackened aluminium heatsink of at least 30 cm^2	$R_{th j-a}$	=	25	$^\circ\text{C/W}$	

1) During switching on, a supply voltage of 1.2 times the rated V_{CER} value is permitted. The current must be limited so that maximum dissipation and maximum junction temperature are not exceeded.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; V_{CB} = 200 \text{ V}; T_j = 200^\circ\text{C}$ I_{CBO} typ. $550 \mu\text{A}$ Emitter cut-off current $I_C = 0; V_{EB} = 5 \text{ V}$ I_{EBO} < $100 \mu\text{A}$ Base-emitter voltage 1) $I_C = 50 \text{ mA}; V_{CE} = 100 \text{ V}$ V_{BE} < 1 V Saturation voltage $I_C = 100 \text{ mA}; I_B = 10 \text{ mA}$ V_{CESat} typ. 6.5 V
< 9 V High frequency knee voltage at $T_j = 150^\circ\text{C}$ $I_C = 60 \text{ mA}$ V_{CEK} typ. 20 V

The high frequency knee voltage of a transistor is that value of the collector-emitter voltage at which the small signal gain, measured in a practical circuit, has dropped to 80% of the gain at $V_{CE} = 50 \text{ V}$. A further decrease of the collector-emitter voltage results in a rapid increase of the distortion of the signal.

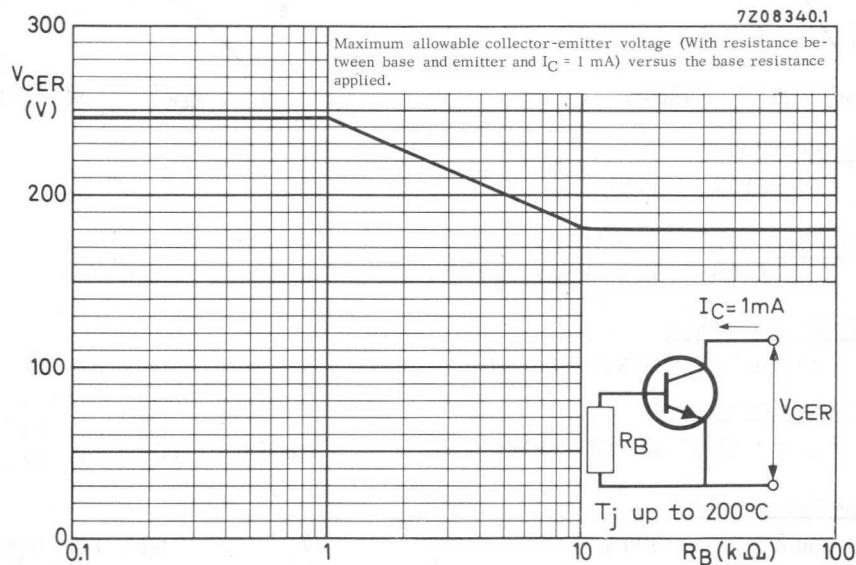
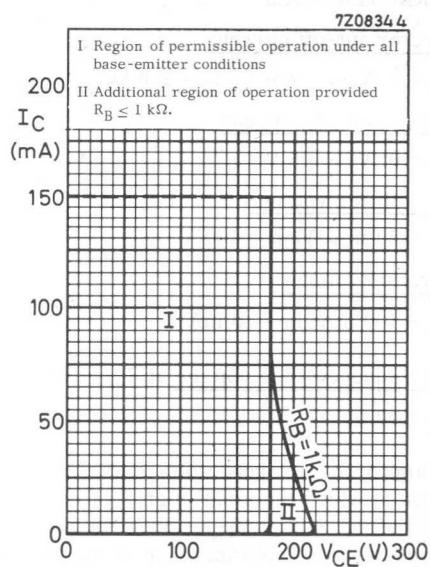
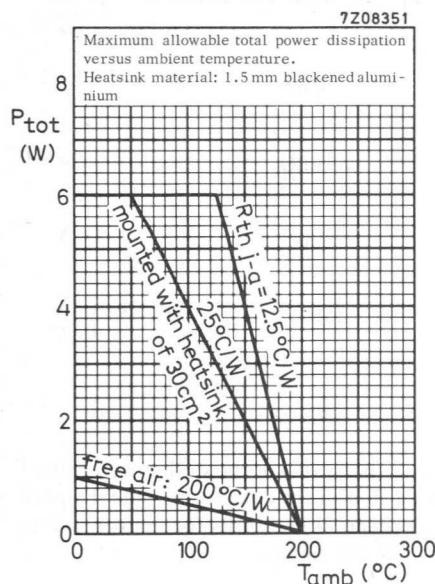
D.C. current gain $I_C = 50 \text{ mA}; V_{CE} = 100 \text{ V}$ h_{FE} > 22
typ. 60

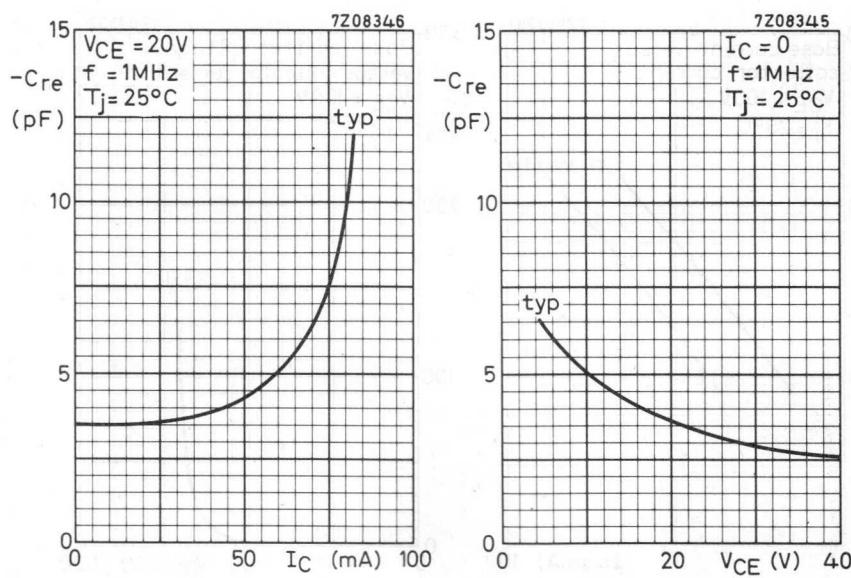
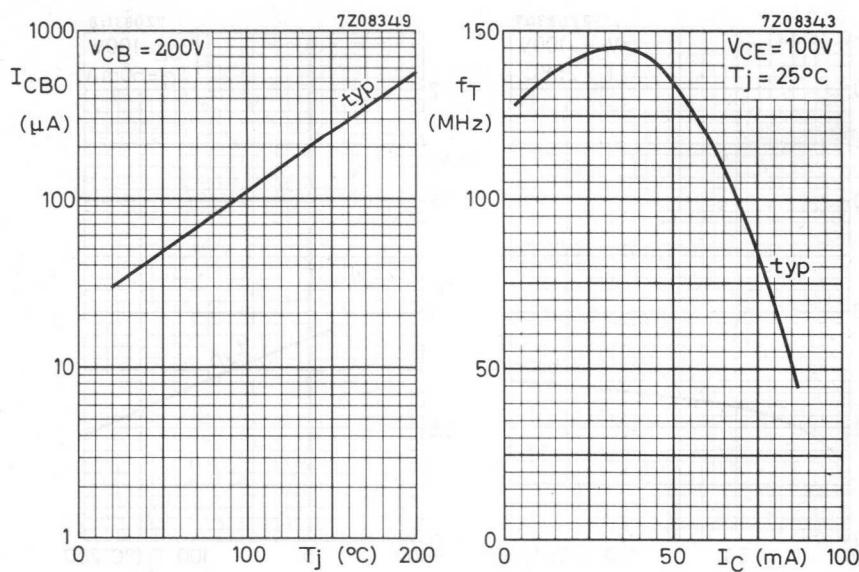
Ratio of h_{FE} at $I_C = 100 \text{ mA}; V_{CE} = 15 \text{ V}$
and at $I_C = 10 \text{ mA}; V_{CE} = 165 \text{ V}$

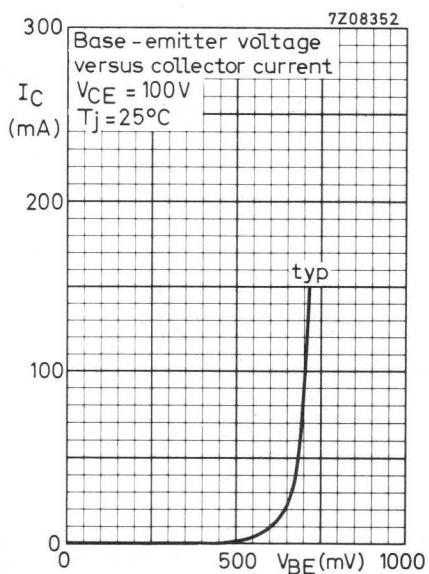
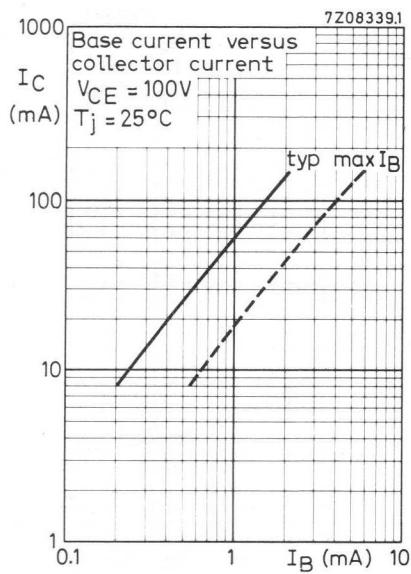
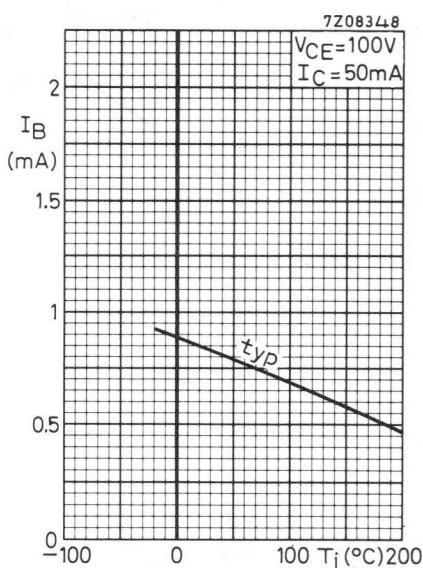
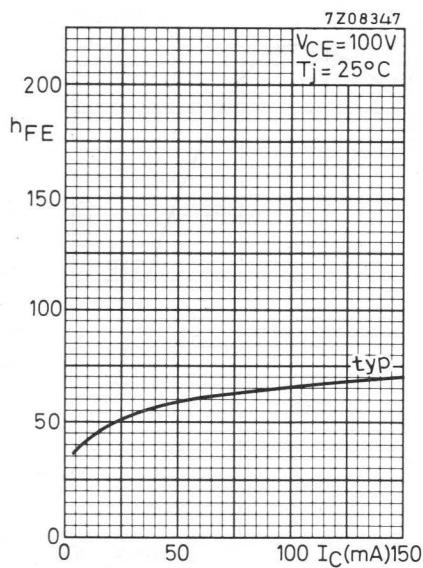
typ. 1.1

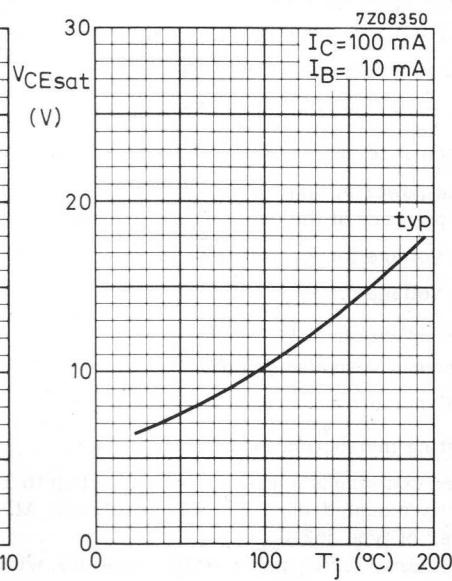
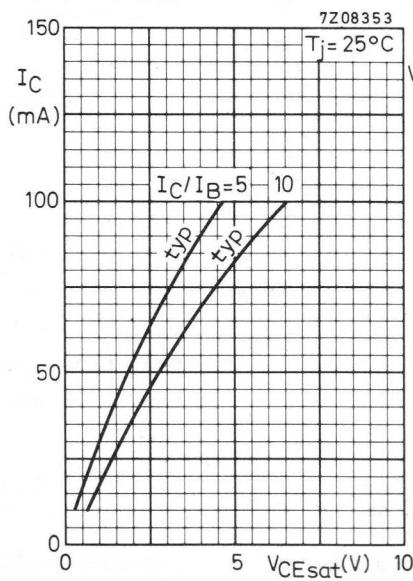
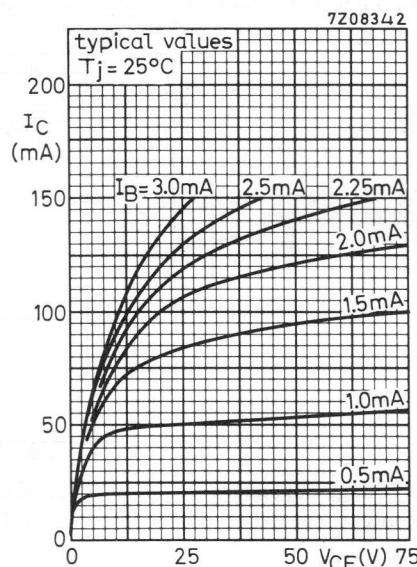
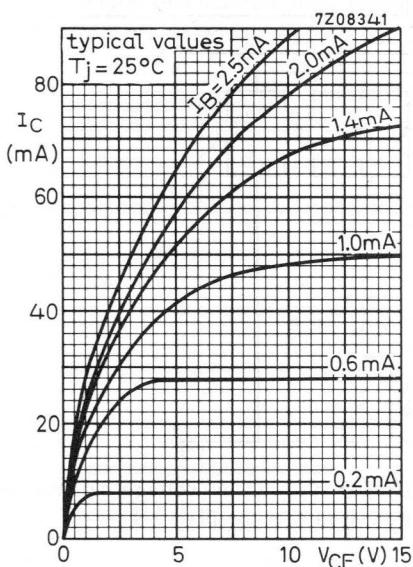
Feedback capacitance $I_C = 10 \text{ mA}; V_{CE} = 20 \text{ V}; f = 1.0 \text{ MHz}$ $-C_{re}$ typ. 3.5 pF Feedback time constant $-I_E = 10 \text{ mA}; V_{CB} = 10 \text{ V}; f = 10 \text{ MHz}$ $r_{bb'}C_{b'c}$ typ. 30 ps
< 100 ps Transition frequency $I_C = 30 \text{ mA}; V_{CE} = 100 \text{ V}$ f_T typ. 145 MHz

1) V_{BE} decreases by about $2 \text{ mV}/^\circ\text{C}$ with increasing temperature.

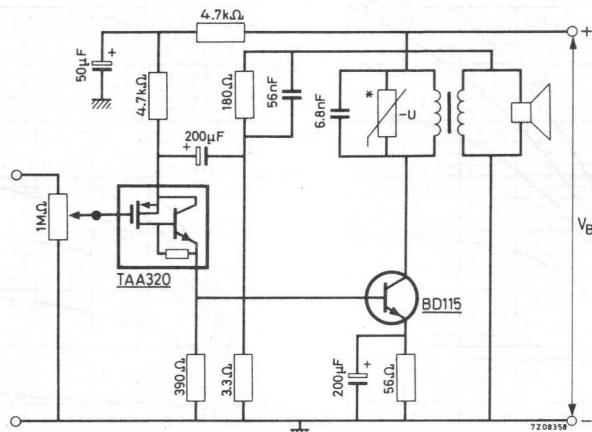








APPLICATION INFORMATION 2 W audio amplifier with TAA320 and BD115



(* The voltage dependent resistor (2322 552 03381) suppresses voltage transients that might otherwise exceed the safe operating limits of the BD115.)

Supply voltage	V_B	100	V
Collector current of BD115	I_C	typ.	50 mA
Drain current of TAA320	$-I_D$	typ.	9.5 mA
Primary d.c. resistance of output transformer		140	Ω
Primary inductance of output transformer		2.7	H
A.C. collector load for BD115		1.8	kΩ
Performance at $f = 1$ kHz; feedback = 16 dB			
Output power at $d_{tot} = 10\%$ (on primary of the output transformer)	P_O	typ.	2.6 W
Input voltage for $P_O = 50$ mW	$V_i(\text{rms})$	typ.	13.5 mV
Input voltage for $P_O = 2$ W	$V_i(\text{rms})$	typ.	86 mV
Total distortion at $P_O = 2$ W	d_{tot}	typ.	3.6 %
Frequency response (-3 dB)		60 Hz to 20	kHz
Signal-noise ratio at $P_O = 2$ W		typ.	73 dB

Mounting instruction for BD115

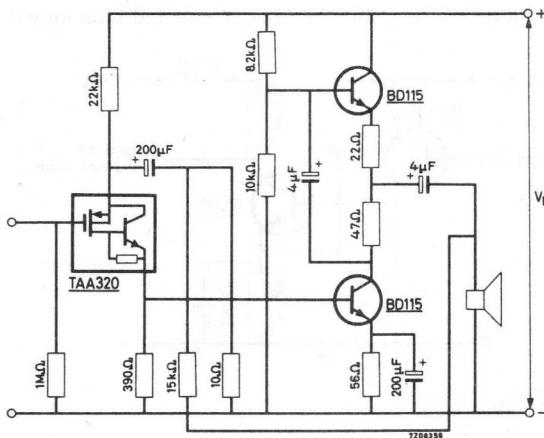
Proper continuous operation is ensured up to $T_{\text{amb}} = 50$ °C, provided the BD115 is directly mounted on a 1.5 mm blackened Al. heatsink of 30 cm^2 with a clamping washer of type 56218.

If the transistor is mounted on a heatsink with a mica washer, the heatsink should have an area of 50 cm^2 .

Recommended diameter of hole in heatsink: 7.7 mm.

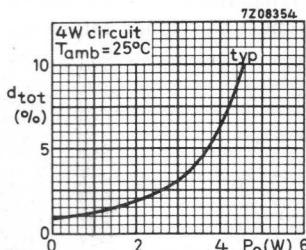
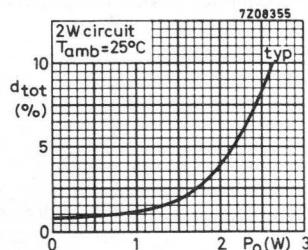
APPLICATION INFORMATION (continued)

4 W audio amplifier with TAA320 and 2 transistors of type BD115.



Supply voltage	V _B	200	V
Collector current of a BD115	I _C	typ.	52 mA
Drain current of TAA320	-I _D	typ.	8.6 mA
<hr/>			
Performance at f = 1 kHz; feedback = 12 dB	P _O	typ.	4.5 W
Output power at d _{tot} = 10%	V _{i(rms)}	typ.	7.5 mV
Input voltage for P _O = 50 mW	V _{i(rms)}	typ.	67 mV
Input voltage for P _O = 4 W	d _{tot}	typ.	6 %
Total distortion at P _O = 4 W			
Frequency response (-3 dB)			50 Hz to 20 kHz
Signal-noise ratio at P _O = 4 W		typ.	73 dB

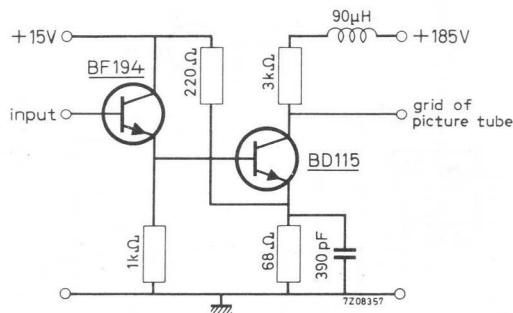
Mounting instruction for BD115 see page 8



APPLICATION INFORMATION (continued)

Grid-driver circuit for colour picture tubes.

Three identical circuits are used for the red, green and blue signal respectively.



Performance up to $T_{amb} = 55^{\circ}\text{C}$

Voltage gain	G_V	60
Output voltage (video information) (peak-peak)	V_o	120 V
	$V_o(p-p)$	150 V
Bandwidth (-3 dB)		> 4 MHz
Rise time	t_r	< 80 ns
Overshoot		< 5 %

Note

1. The maximum dissipation of the output transistor is 3.3 W.
In order not to exceed the junction temperature rating, the thermal resistance from junction to ambient should be: $R_{th\ j-a} < 45^{\circ}\text{C/W}$.
To ensure the above mentioned performance for bandwidth and transient response, the contribution of the heatsink to the total output capacitance of the device should not exceed 4 pF.
2. For grid drive of the picture tube, the sync pulses must be negative going.
To avoid driving the output transistor into the high frequency knee voltage, the sync pulses must be clipped before the output stage.

SILICON PLANAR EPITAXIAL POWER TRANSISTOR

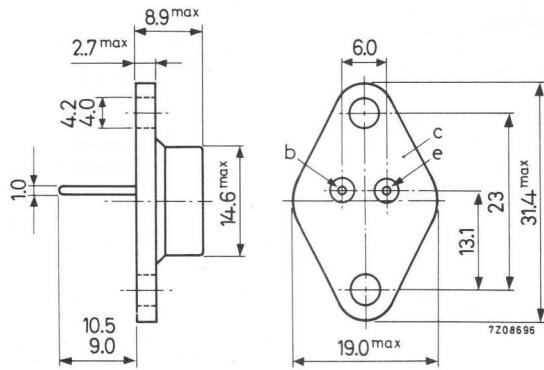
N-P-N silicon power transistor in a metal envelope with the collector connected to the case. It is primarily intended for quasi-complementary output stages up to 15 W in audio applications, such as hi-fi amplifiers.

QUICK REFERENCE DATA			
Collector-base voltage (open emitter)	V _{CBO}	max.	70 V
Collector-emitter voltage (open base)	V _{CEO}	max.	45 V
Collector current (peak value)	I _{CM}	max.	4.0 A
Total power dissipation up to T _{mb} = 62.5 °C	P _{tot}	max.	15 W
D.C. current gain I _C = 2 A; V _{CE} = 5 V	h _{FE}	> typ.	25 50
Transition frequency at f = 35 MHz I _C = 250 mA; V _{CE} = 5 V	f _T	typ.	120 MHz

MECHANICAL DATA

Dimensions in mm

Collector connected to the case



Accessories available: 56203

BD 124
2 - BD 124

RATINGS (Limiting values) 1)

Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	70	V
Collector-emitter voltage (open base) 2)	V_{CEO}	max.	45	V
Emitter-base voltage (open collector)	V_{EBO}	max.	6.0	V

Currents

Collector current (d.c. and average)	I_C	max.	2.0	A
Collector current (peak value)	I_{CM}	max.	4.0	A
Non repetitive peak overload current 3)				
at $V_{CE} = 7 \text{ V}$; $t = 1 \text{ ms}$	I_{CSM}	max.	5	A
$V_{CE} = 20 \text{ V}$; $t = 100 \mu\text{s}$	I_{CSM}	max.	5	A
$V_{CE} = 35 \text{ V}$; $t = 10 \mu\text{s}$	I_{CSM}	max.	4	A
Emitter current (peak value)	$-I_{EM}$	max.	4.0	A

Power dissipation

Total power dissipation up to $T_{mb} = 62.5 \text{ }^\circ\text{C}$ (see also page 4 and 5)	P_{tot}	max.	15	W
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Temperatures

Storage temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Junction temperature	T_j	max.	175 $^\circ\text{C}$

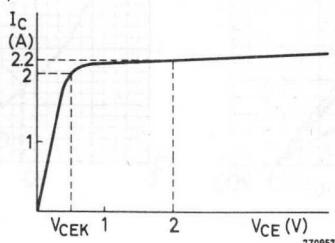
THERMAL RESISTANCE

From junction to mounting base	$R_{th j-mb}$	7.5	$^\circ\text{C}/\text{W}$
From mounting base to heatsink without accessory	$R_{th mb-h}$	0.5	$^\circ\text{C}/\text{W}$
with accessory 56203	$R_{th mb-h}$	1.5	$^\circ\text{C}/\text{W}$

1) Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

2) At $I_C = 200 \text{ mA}$.

3) Prior to non repetitive peak overload current: $T_j = 175 \text{ }^\circ\text{C}$

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; V_{CB} = 45 \text{ V}$ I_{CBO} typ. 0.5 μA
 $<$ 2 μA Emitter cut-off current $I_C = 0; V_{EB} = 5 \text{ V}$ I_{EBO} typ. 0.1 μA
 $<$ 2 μA Base-emitter voltage¹⁾ $I_C = 50 \text{ mA}; V_{CE} = 5 \text{ V}$ V_{BE} typ. 0.7 V $I_C = 2 \text{ A}; V_{CE} = 5 \text{ V}$ V_{BE} typ. 1.0 VKnee voltage $I_C = 2 \text{ A}; I_B = \text{value for which}$ V_{CEK} typ. 1.0 V
 $<$ 1.9 V $I_C = 2.2 \text{ A at } V_{CE} = 2 \text{ V}$ D.C. current gain $I_C = 50 \text{ mA}; V_{CE} = 5 \text{ V}$ h_{FE} > 25
typ. 60 $I_C = 0.5 \text{ A}; V_{CE} = 5 \text{ V}$ h_{FE} > 35
typ. 75 $I_C = 2 \text{ A}; V_{CE} = 5 \text{ V}$ h_{FE} > 25
typ. 50Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 10 \text{ V}$ C_C typ. 55 pFTransition frequency at $f = 35 \text{ MHz}$ $I_C = 250 \text{ mA}; V_{CE} = 5 \text{ V}$ f_T typ. 120 MHz**MATCHING CHARACTERISTICS**Base current difference $I_C = 0.5 \text{ A}; V_{CE} = 5 \text{ V}$ $|I_{B1}-I_{B2}| < 2 \text{ mA}$ Resulting ratio of d.c. current gain

for low gain devices

< 1.2

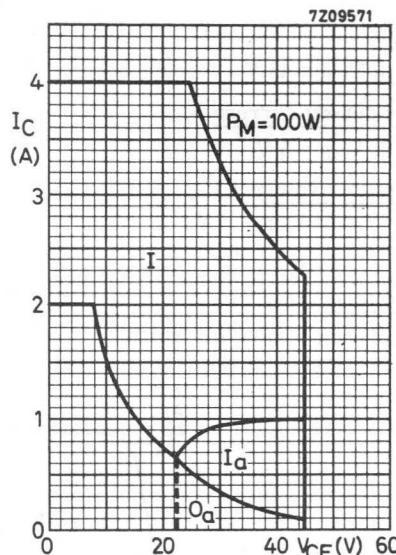
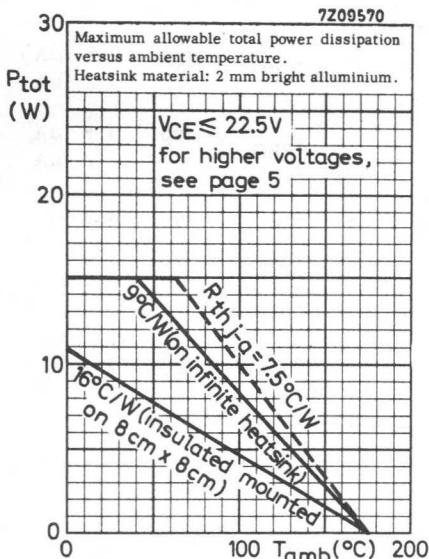
for typical gain devices

< 1.3

for high gain devices

< 1.5

1) V_{BE} decreases by about 1.6 mV/ $^\circ\text{C}$ with increasing temperature.



Region I: $\Delta T_{j-mb} = T_j \text{ peak} - T_{mb}$ max. $115\text{^{\circ}C}$

Make use of transient thermal resistance graph on page 5.

Regions O_a and I_a

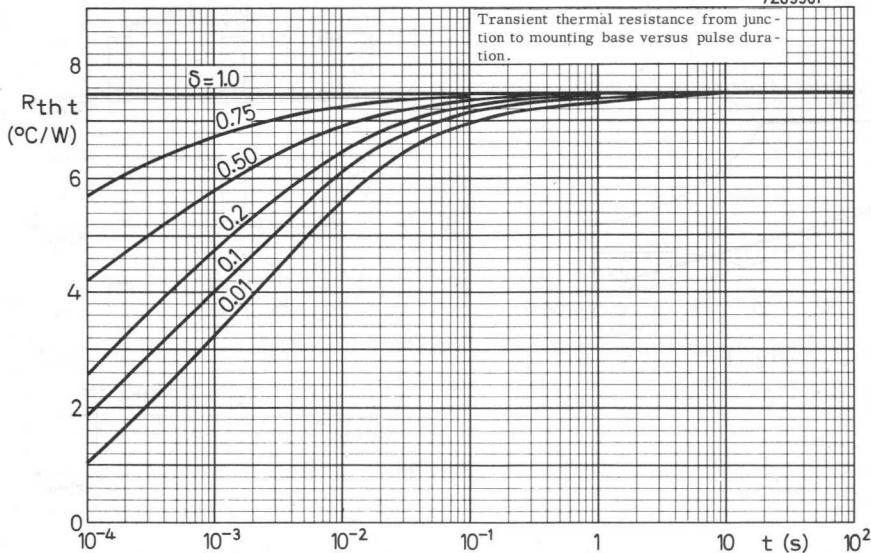
To prevent damage due to second breakdown effects, transistors may only be operated in these regions if the increased thermal resistance at higher voltages is taken into account.

Region O_a: The steady state value of the thermal resistance from junction to mounting base should be multiplied by factor M taken from lower graph left hand side on page 5.

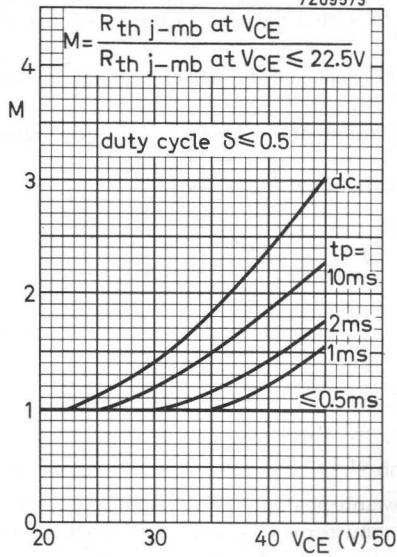
Region I_a : ΔT_{j-mb} max. $115\text{^{\circ}C}$

Dependent on voltage, pulse time and duty cycle, the transient thermal resistance value from junction to mounting base should be multiplied by factor M taken from lower graph left hand side on page 5.

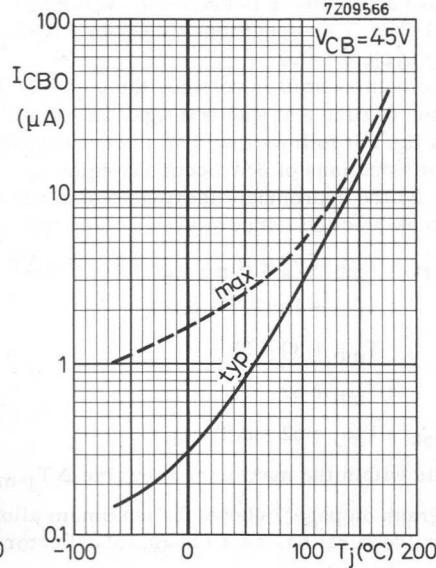
7Z09561



7Z09573



7Z09566



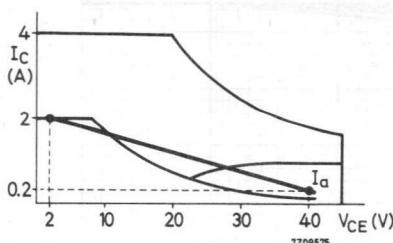


Fig. 1

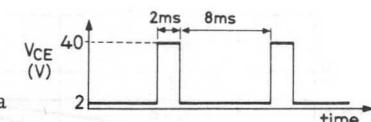


Fig. 2b

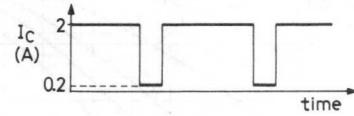


Fig. 2c

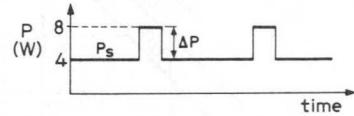


Fig. 2d

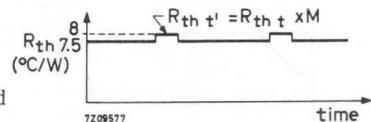


Fig. 2d

Calculation example

Suppose a transistor is used in a switching circuit with a resistive load (fig. 1) and is switched from conditions 2V-2A to 40V-0.2A with a pulse duration $t_p = 2 \text{ ms}$ and a duty cycle $\delta = 0.2$.

The collector-emitter voltage, the collector current and the power dissipation as a function of time are shown if figs. 2a, 2b and 2c.

From fig. 1 it follows that 4 W is continuously dissipated. This is plotted in fig. 2c. Peak dissipations of 8 W occur in region Ia.

In fig. 2d the appropriate thermal resistance values are indicated.

The peak junction temperature is given by:

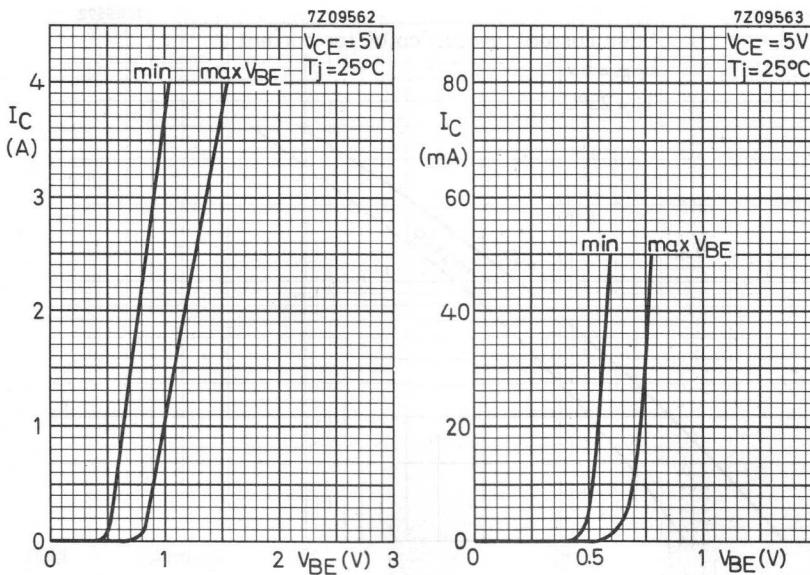
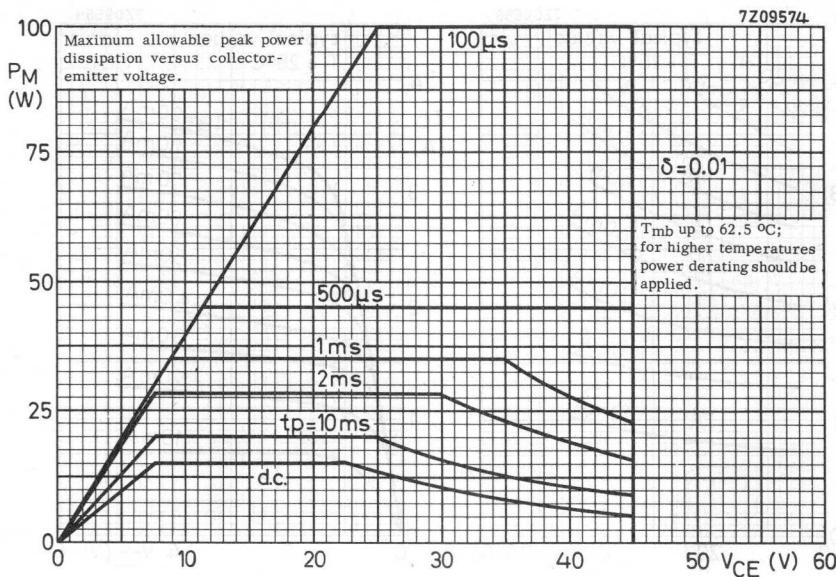
$$\begin{aligned} T_j \text{ peak} &= T_{mb} + P_s \times R_{th \ j-mb} + R_{th \ t'} \times \Delta P^{-1} \\ &= T_{mb} + 4 \times 7.5 + 8 \times 4 \\ &= T_{mb} + 30 + 32 \\ &= T_{mb} + 62 \end{aligned}$$

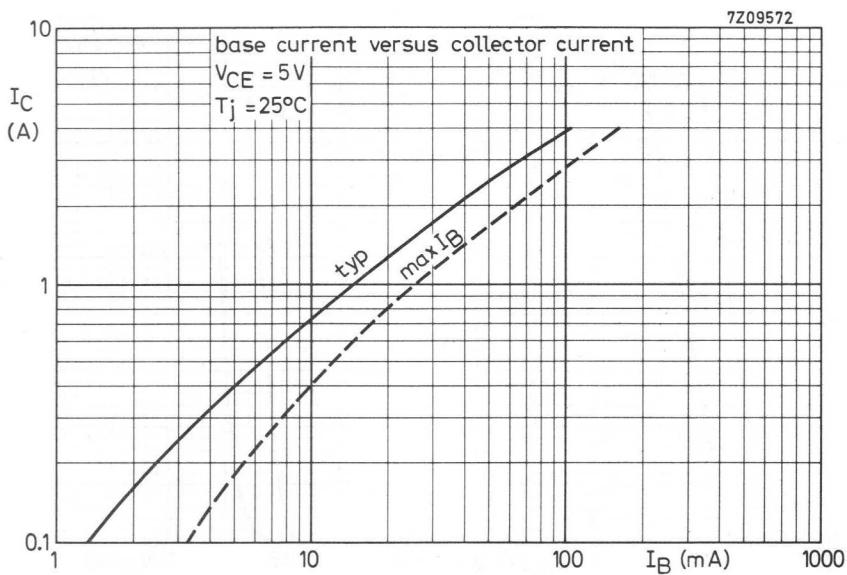
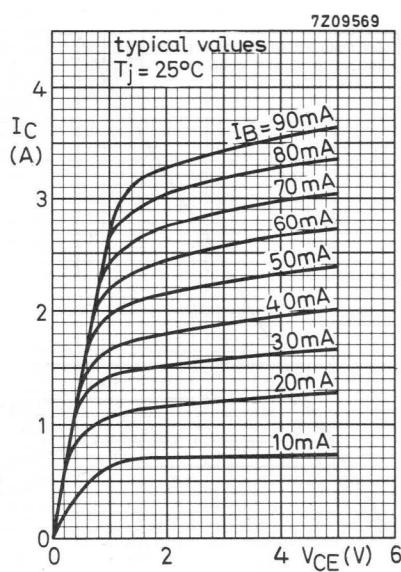
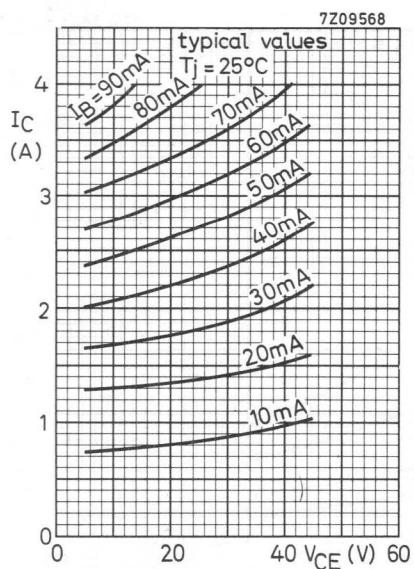
$$T_j \text{ peak} - T_{mb} = 62 = \Delta T_{j-mb}$$

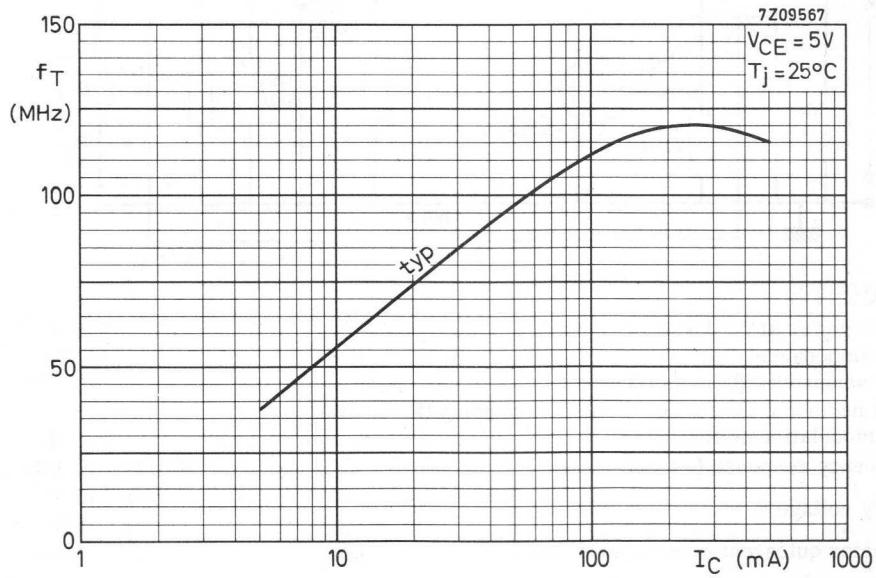
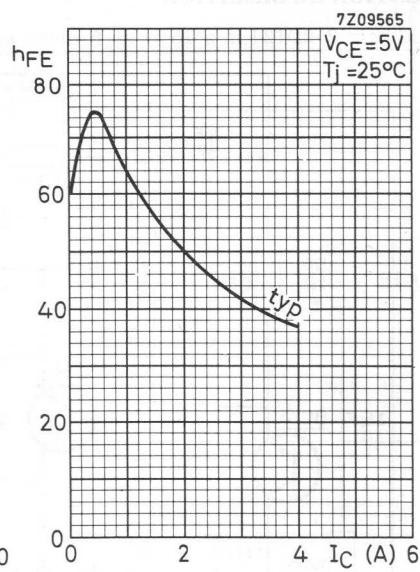
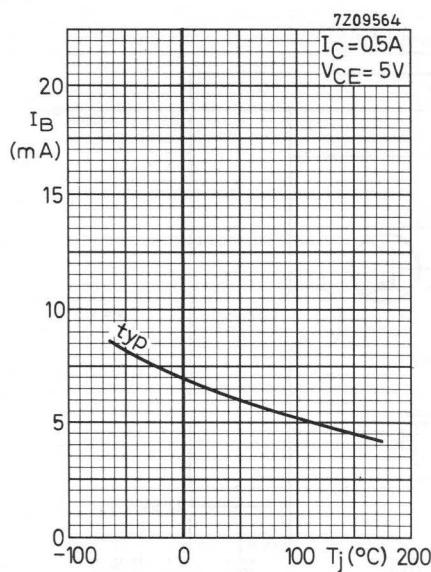
This is within the maximum allowable ΔT_{j-mb} of 115°C

The graph on page 7 shows the maximum allowable peak power dissipations for various pulse durations as a function of collector-emitter voltage for a duty cycle of 0.01.

1) $R_{th \ t'} = R_{th \ t} \times M$ (for $R_{th \ t}$ see page 5)





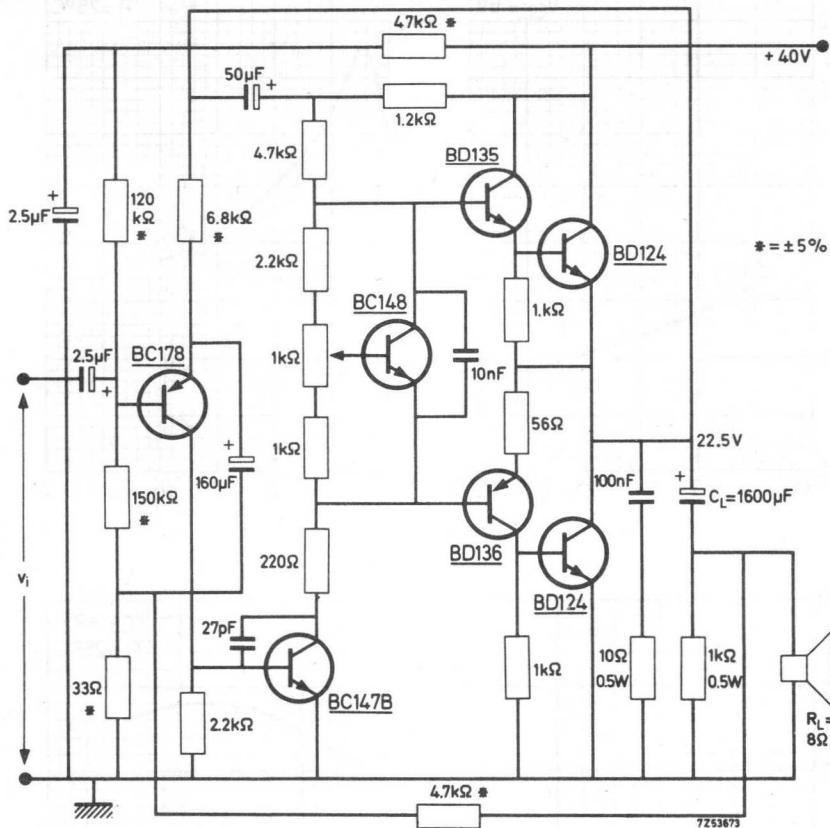


BD 124

2 - BD 124

APPLICATION INFORMATION

Matched pair 2-BD124 in a 15 W hi-fi audio amplifier.



Performance

Output power at $f = 1 \text{ kHz}$; $d_{\text{tot}} = 1\%$

15.8 W

Input impedance

100 kΩ

Input sensitivity ($P_o = 15 \text{ W}$)

140 mV

Total harmonic distortion at onset of clipping ($f = 1 \text{ kHz}$)

0.15 %

Intermodulation distortion

0.6 %

Frequency response (-1 dB)

20 Hz to 90 kHz

nom. 40 V

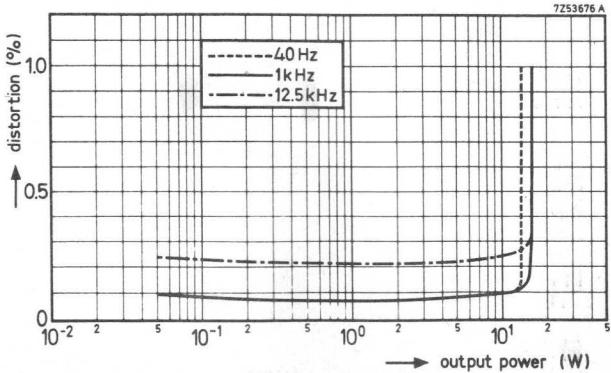
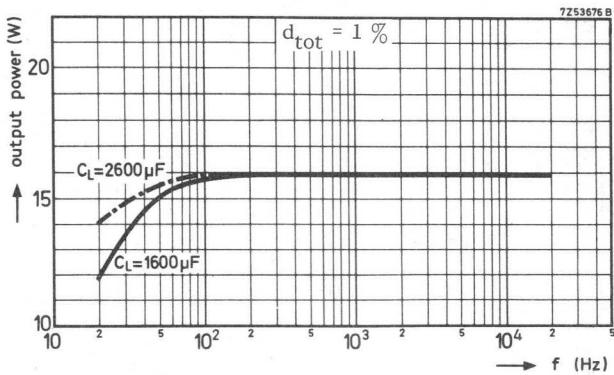
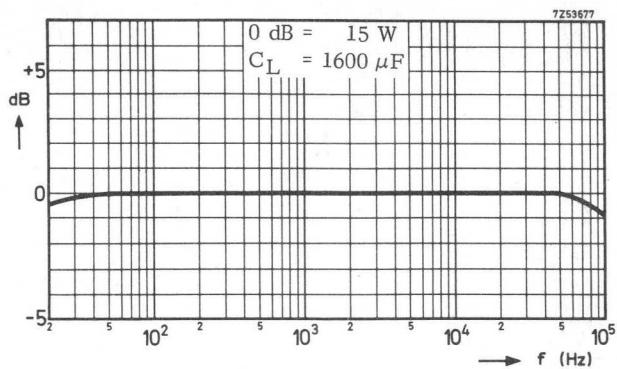
max. 45 V

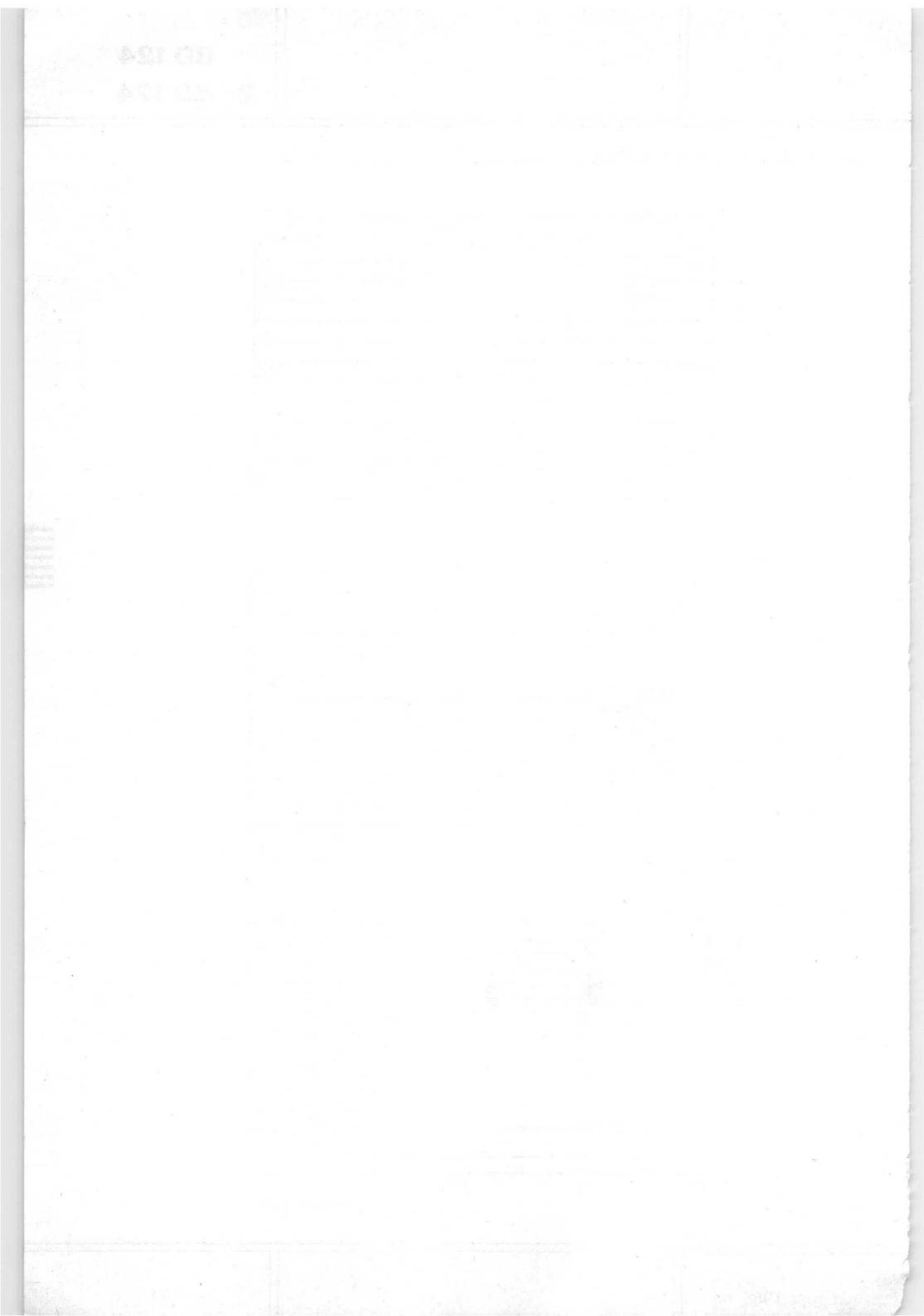
40 mA

Supply voltage

Collector quiescent current of BD124

APPLICATION INFORMATION (continued)





SILICON PLANAR EPITAXIAL TRANSISTORS

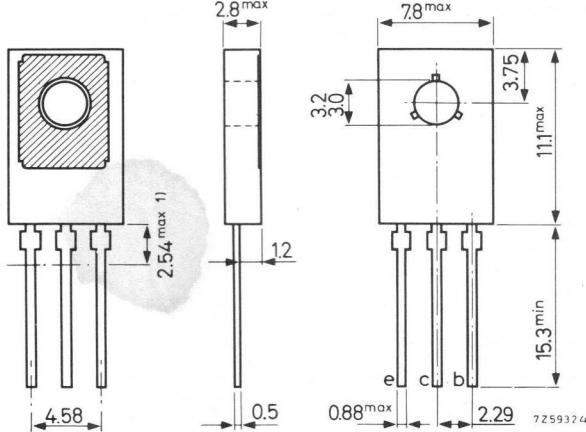
N-P-N transistors in a TO-126 plastic envelope; with their complements, the BD136 (for the BD135), the BD138 (for the BD137) and the BD140 (for the BD139), they are primarily intended for complementary driver stages in hi-fi amplifiers. They are also recommended as single drivers where voltage and dissipation are high. The devices are also suitable for television circuits.

QUICK REFERENCE DATA				
		BD135	BD137	BD139
Collector-base voltage (open emitter)	V_{CBO}	max. 45	60	- V
Collector-emitter voltage (open base)	V_{CEO}	max. 45	60	80 V
Collector-emitter voltage ($R_{BE} = 1\text{ k}\Omega$)	V_{CER}	max. -	-	100 V
Collector-current (peak value)	I_{CM}	max. 1.5	1.5	1.5 A
Total power dissipation up to $T_{mb} = 60^\circ\text{C}$	P_{tot}	max. 6.5	6.5	6.5 W
Junction temperature	T_j	max. 125	125	125 $^\circ\text{C}$
D.C. current gain $I_C = 150\text{ mA}; V_{CE} = 2\text{ V}$	h_{FE}	> 40	40	40
Transition frequency at $f = 35\text{ MHz}$ $I_C = 50\text{ mA}; V_{CE} = 5\text{ V}$	f_T	< 250	160	160
		typ. 250	250	250 MHz

MECHANICAL DATA

TO-126

Collector connected
to metal part of
mounting surface



Accessories available: 56302; 56303

Dimensions in mm
Torque on nut: min. 8 cm kg
max. 9 cm kg

¹) Within this region the cross-section of the leads is uncontrolled.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

			BD135	BD137	BD139	
Collector-base voltage (open emitter)	V_{CBO}	max.	45	60	-	V
Collector-emitter voltage (open base) ¹⁾	V_{CEO}	max.	45	60	80	V
Collector-emitter voltage ($R_{BE} = 1 \text{ k}\Omega$)	V_{CER}	max.	-	-	100	V
Emitter-base voltage (open collector)	V_{EBO}	max.	5	5	5	V

Currents

Collector current (d.c.)	I_C	max.	0.5	0.5	0.5	A
Collector current (peak value)	I_{CM}	max.	1.5	1.5	1.5	A

Power dissipation

Total power dissipation up to $T_{mb} = 60^\circ\text{C}$ P_{tot} max. 6.5 W
(see also pages 4, 5 and 6)

Temperatures

Storage temperature	T_{stg}	-55 to +125	$^\circ\text{C}$
Junction temperature	T_j	max.	125 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to ambient in free air	$R_{th j-a}$	100	$^\circ\text{C/W}$
From junction to mounting base	$R_{th j-mb}$	10	$^\circ\text{C/W}$
From mounting base to heatsink with mica washer 56302	$R_{th mb-h}$	6	$^\circ\text{C/W}$
without mica washer	$R_{th mb-h}$	1	$^\circ\text{C/W}$

¹⁾ At $I_C = 30 \text{ mA}$

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 30 \text{ V}$	I_{CBO}	<	100	nA
$I_E = 0; V_{CB} = 30 \text{ V}; T_j = 125^\circ\text{C}$	I_{CBO}	<	10	μA

Emitter cut-off current

$I_C = 0; V_{EB} = 5 \text{ V}$	I_{EBO}	<	10	μA
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Base emitter voltage

$I_C = 500 \text{ mA}; V_{CE} = 2 \text{ V}$	V_{BE}	<	1	V
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Saturation voltage

$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	V_{CESat}	<	0.5	V
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D.C. current gain

$I_C = 5 \text{ mA}; V_{CE} = 2 \text{ V}$	h_{FE}	>	25	25	25
$I_C = 150 \text{ mA}; V_{CE} = 2 \text{ V}$	h_{FE}	>	40	40	40
$I_C = 500 \text{ mA}; V_{CE} = 2 \text{ V}$	h_{FE}	<	250	160	160
		>	25	25	25

Transition frequency at $f = 35 \text{ MHz}$

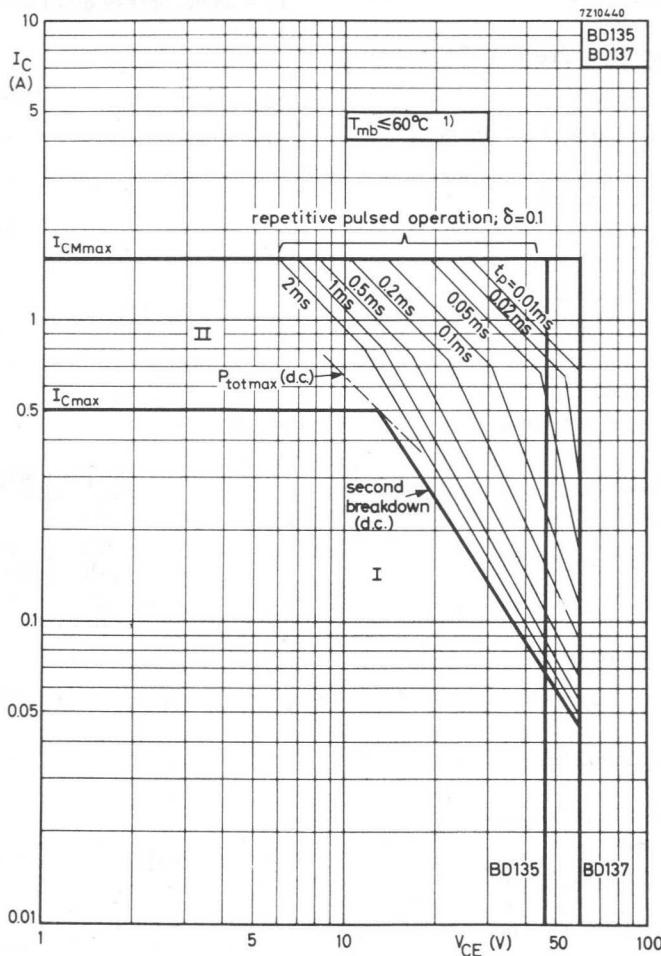
$I_C = 50 \text{ mA}; V_{CE} = 5 \text{ V}$	f_T	typ.	250	MHz
---	-------	------	-----	-----

D.C. current gain ratio of matched pairs

BD135/BD136; BD137/BD138

BD139/BD140

$ I_C = 150 \text{ mA}; V_{CE} = 2 \text{ V}$	h_{FE1}/h_{FE2}	typ.	1.3
		<	1.6



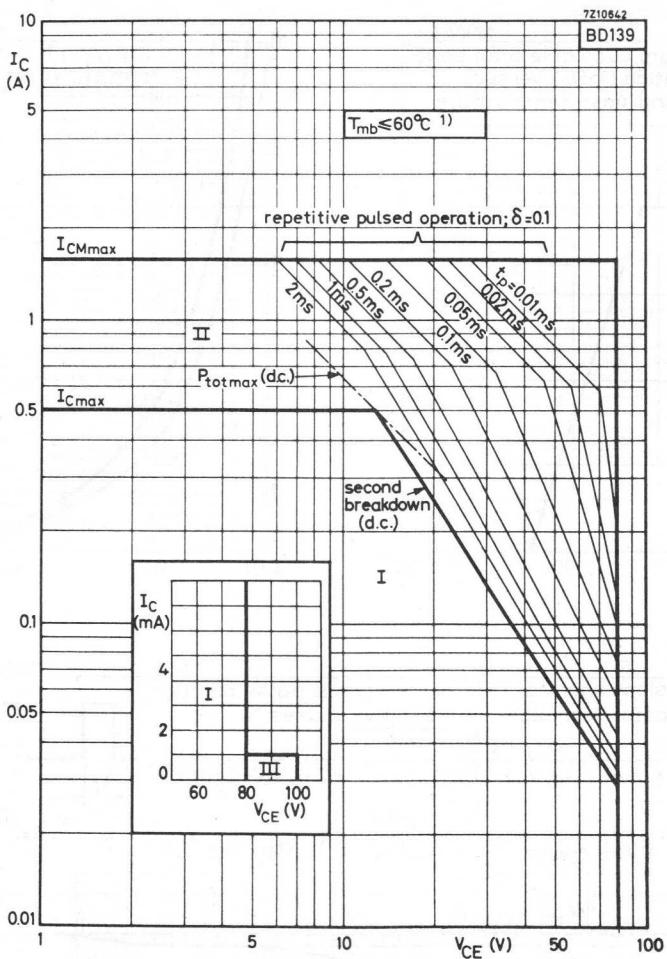
Safe Operating Area with the transistor forward biased

I Region of permissible d.c. operation

II Permissible extension for repetitive pulsed operation

1) To derate $P_{tot\ max}$ for higher temperatures see page 6.

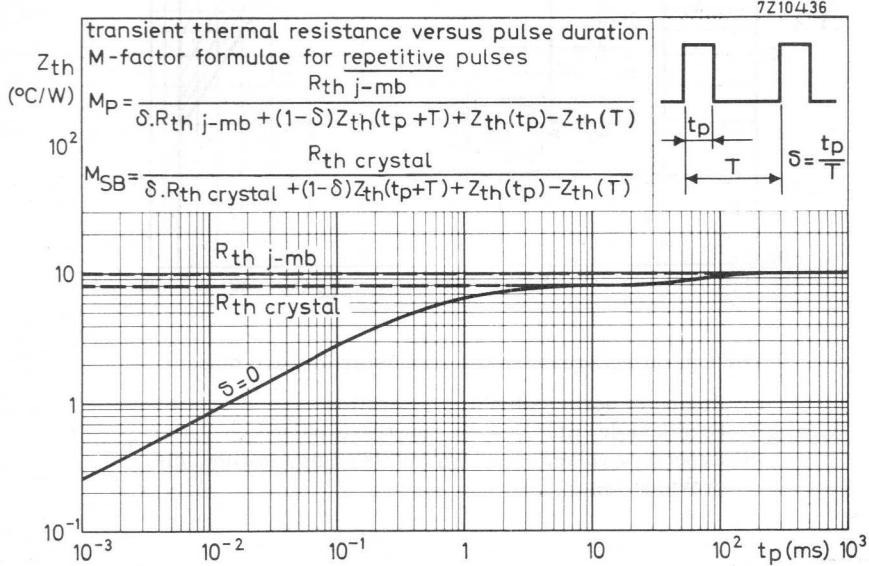
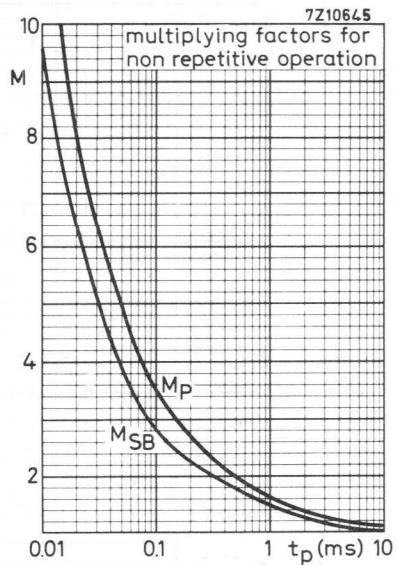
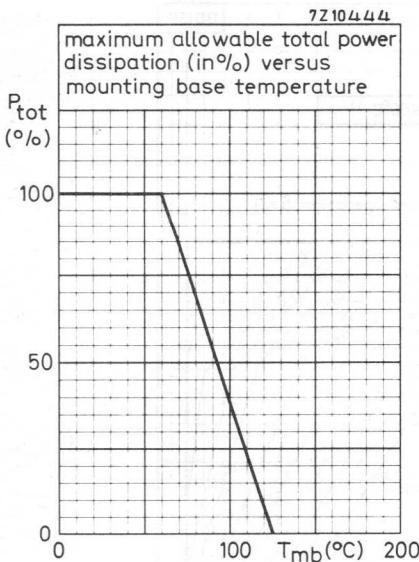
Ratings for second breakdown are independent of temperature.

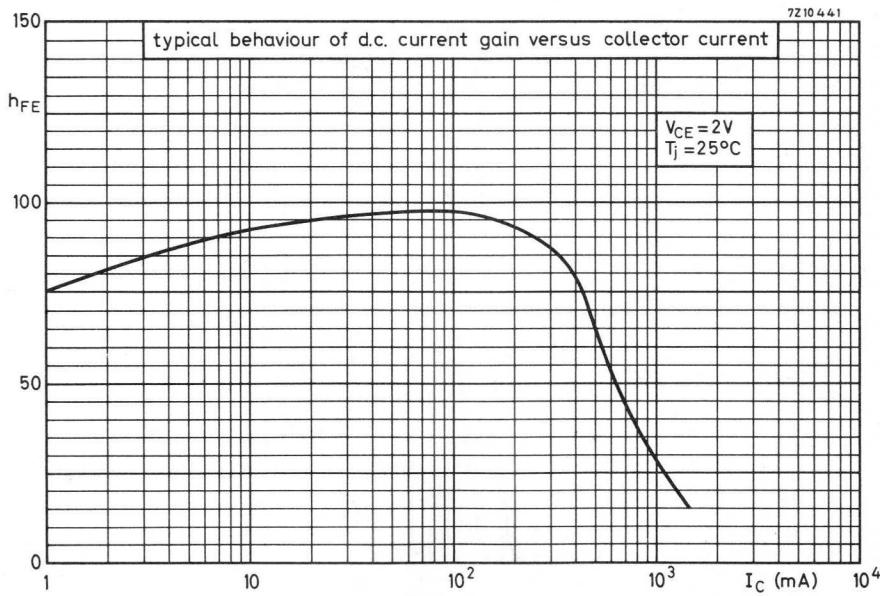
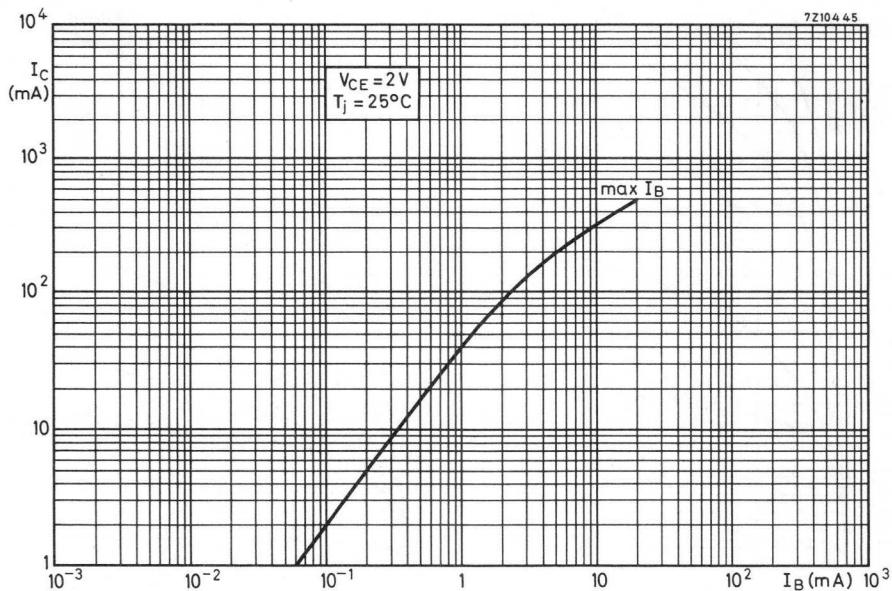


Safe Operating Area with the transistor forward biased

- I Region of permissible d.c. operation
- II Permissible extension for repetitive pulsed operation
- III Repetitive pulsed operation in this region is allowable, provided $RBE \leq 1\text{ k}\Omega$

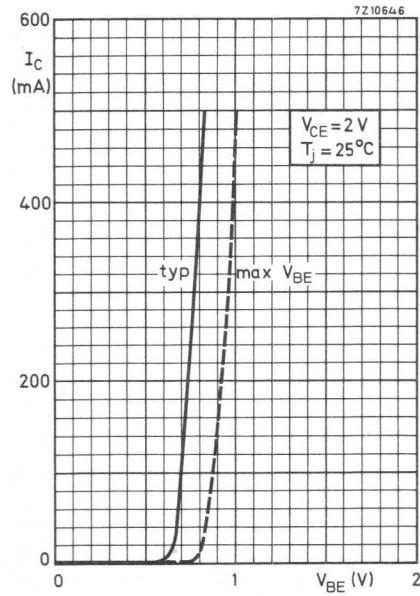
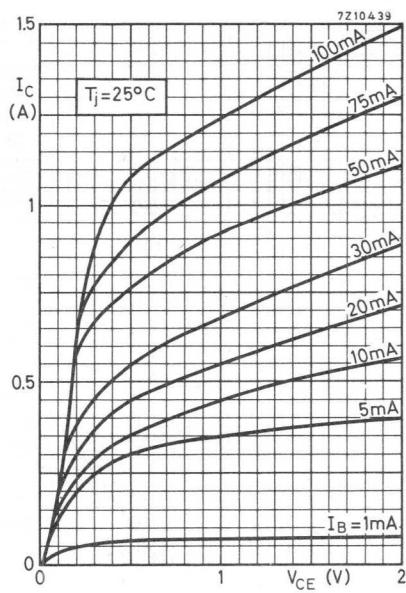
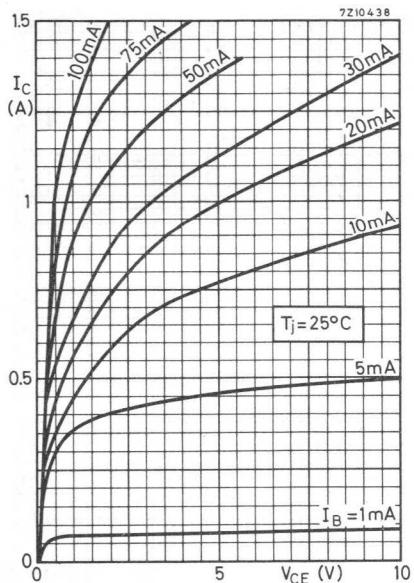
1) To derate P_{tot} max for higher temperatures see page 6.
Ratings for second breakdown are independent of temperature.

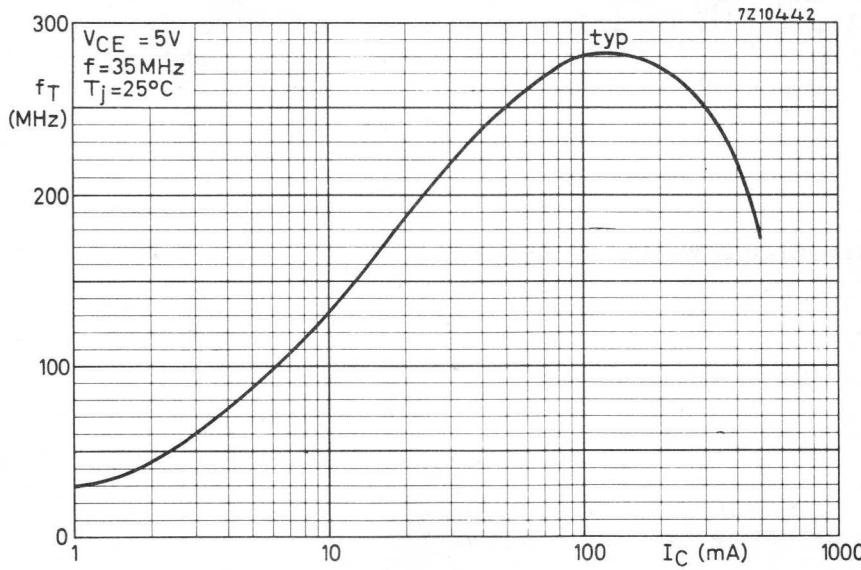
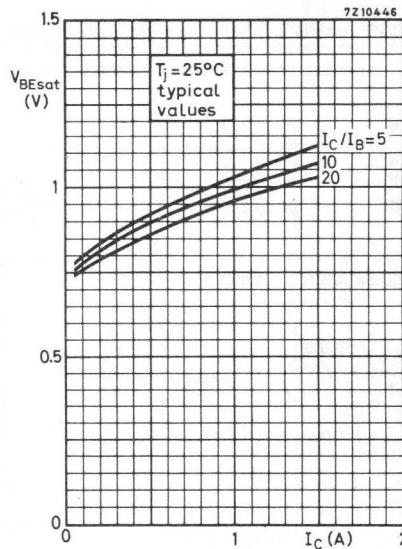
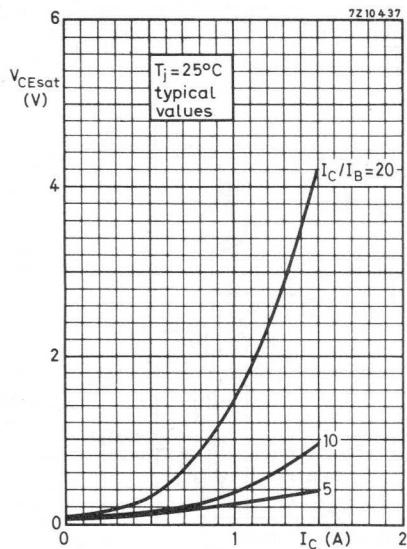




**BD135 BD137
BD139**

typical behaviour of collector current versus collector-emitter voltage



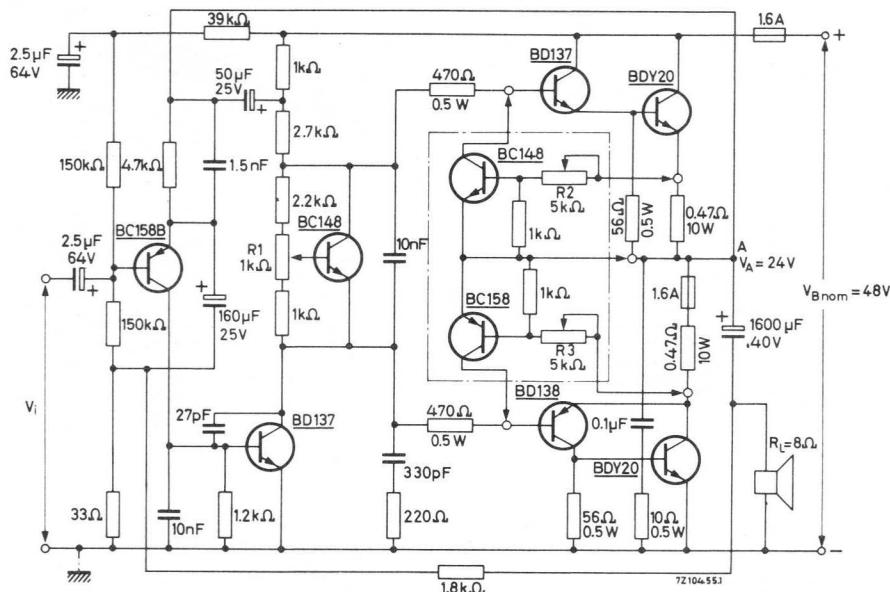


BD135 BD137 BD139

APPLICATION INFORMATION

25 W hi-fi amplifier with short circuit protection

(Broken line encloses short circuit protection)



All resistors 0.25 W unless otherwise stated.

APPLICATION INFORMATION (continued)Performance at $V_{Bnom} = 48 V$; $R_L = 8 \Omega$

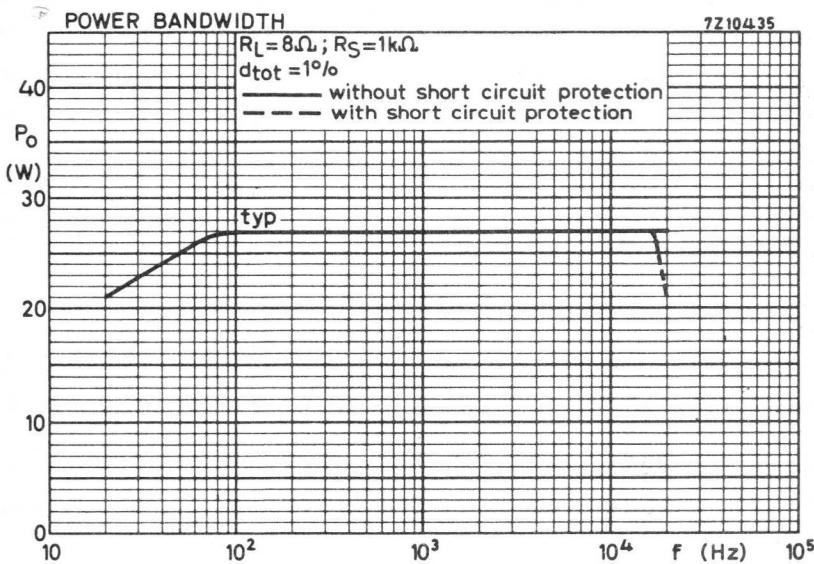
Collector quiescent current of BDY20	I_{cq}	typ.	40	mA
Total current drain at $f = 1 \text{ kHz}$; $P_o = 25 \text{ W}$	I_{tot}	typ.	830	mA
Input impedance	$ Z_i $	typ.	150	$\text{k}\Omega$
Output power at $f = 1 \text{ kHz}$; $d_{tot} = 1\%$	P_o	typ.	27	W
Input voltage for $P_o = 25 \text{ W}$	V_i	typ.	350	mV
Total harmonic distortion at $P_o = 25 \text{ W}$				
without protection circuit	d_{tot}	typ.	0.1	%
with protection circuit	d_{tot}	typ.	0.25	%
Intermodulation distortion at $P_o = 27 \text{ W}$				
$f_1 = 250 \text{ Hz}; f_2 = 8 \text{ kHz}$				
V_i at $f_1 : V_i$ at $f_2 = 4 : 1$				
without protection circuit	d_{im}	typ.	0.6	%
with protection circuit	d_{im}	typ.	1.2	%
Frequency response (-1 dB)			20 Hz to 35	kHz

Short circuit protection

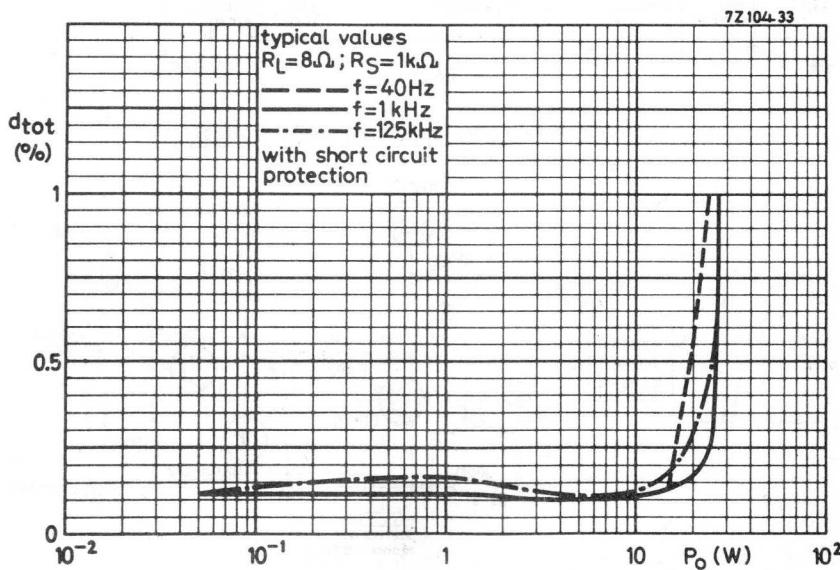
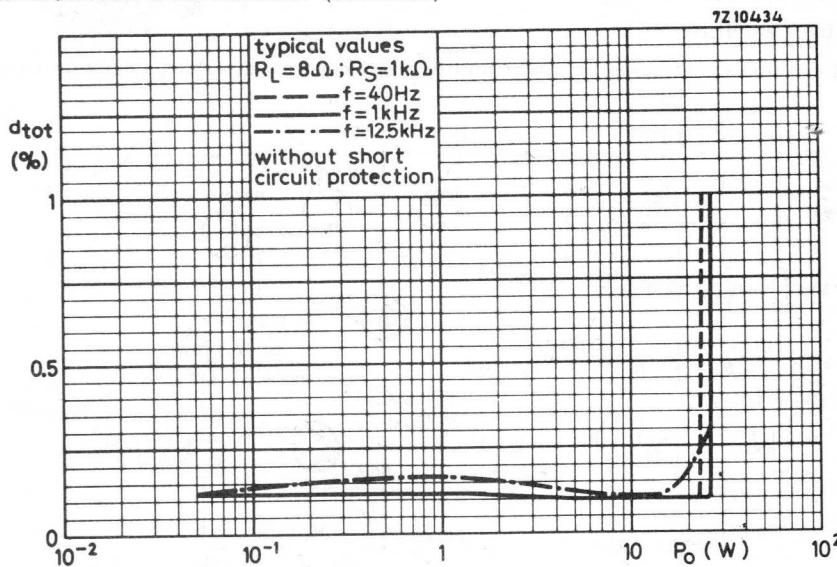
R_2 and R_3 to be adjusted so as to protect the output stage against current peaks higher than $I_{CM} = 4 \text{ A}$.

APPLICATION INFORMATION (continued)

25 W hi-fi amplifier (continued)



APPLICATION INFORMATION (continued)

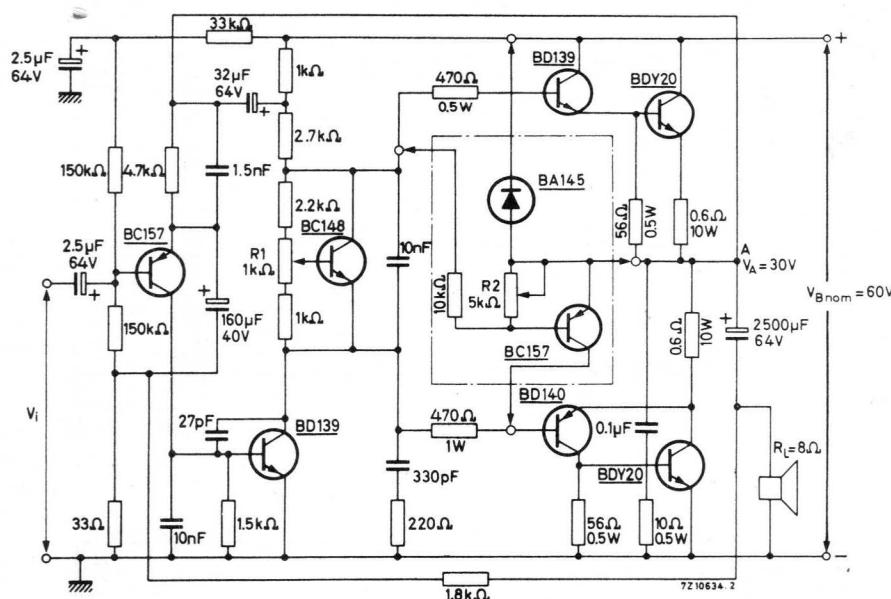


BD135 BD137 BD139

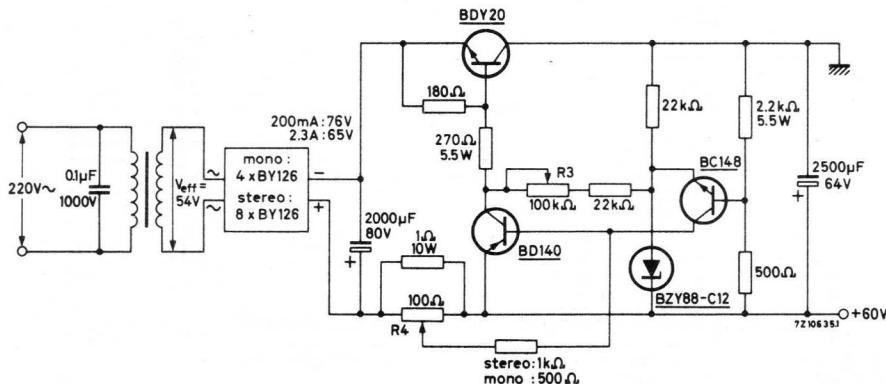
APPLICATION INFORMATION (continued)

40 W hi-fi amplifier

Together with regulated supply, part within broken lines provides short circuit protection



Short circuit protected power supply with regulated output voltage



All resistors 0.25 W unless otherwise stated.

APPLICATION INFORMATION (continued)

Performance at $V_B = 60$ V; $R_L = 8 \Omega$

Collector quiescent current of BDY20	I_{cq}	typ.	40	mA
Total current drain at $f = 1$ kHz; $P_O = 40$ W	I_{tot}	typ.	1.1	A
Input impedance	$ Z_i $	typ.	150	k Ω
Output power at $f = 1$ kHz; $d_{tot} = 1\%$	P_O	typ.	40	W
Input voltage for $P_O = 40$ W	V_i	typ.	440	mV
Total harmonic distortion at $P_O = 40$ W	d_{tot}	typ.	0.2	%
Intermodulation distortion at $P_O = P_{omax}$ $f_1 = 250$ Hz; $f_2 = 8$ kHz V_i at $f_1 : V_i$ at $f_2 = 4 : 1$	d_{im}	typ.	0.8	%
Frequency response (-1 dB)			10 Hz to 33	kHz

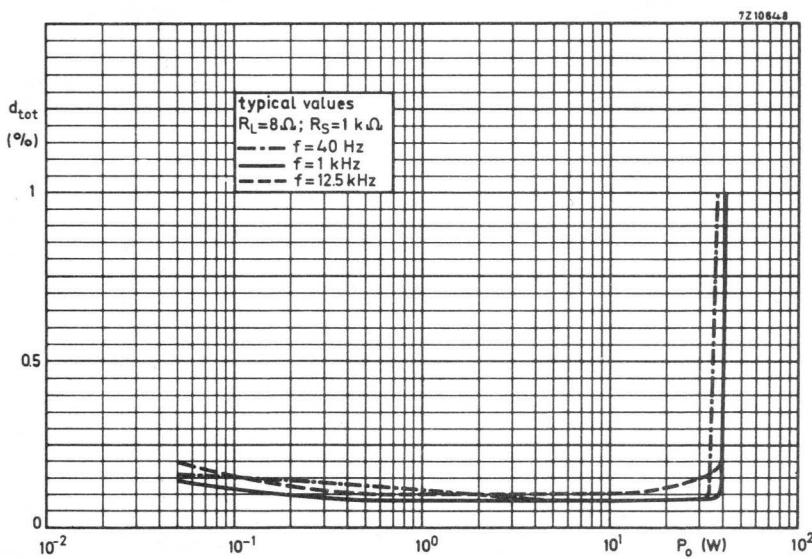
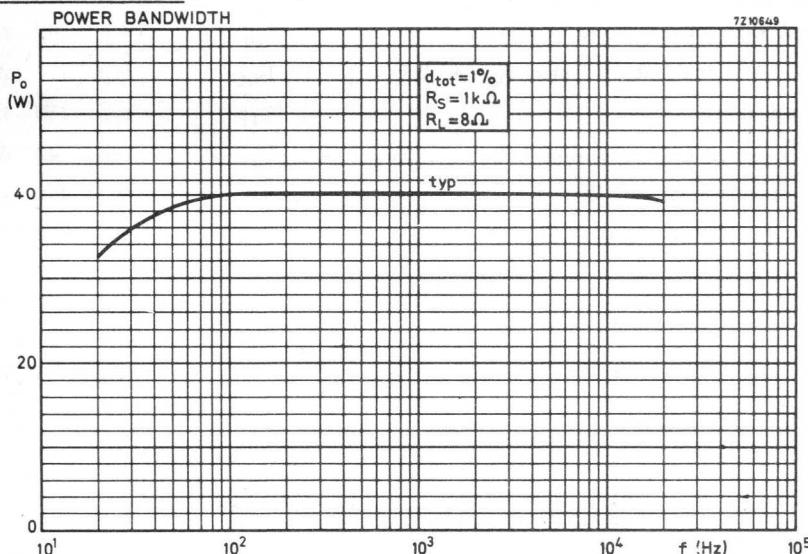
Short circuit protection

The average supply current is limited by R_4 (lower figure opposite)

to 1.3 A for mono where $R_L = 8 \Omega$
or 2.3 A for stereo

R_2 is then adjusted so that the peak collector current of the lower BDY20 in the 40 W circuit is limited to $I_{CM} = 4$ A (normal sine wave overdrive conditions; $R_L = 6 \Omega$).

APPLICATION INFORMATION (continued)
40 W hi-fi amplifier (continued)



SILICON PLANAR EPITAXIAL TRANSISTORS

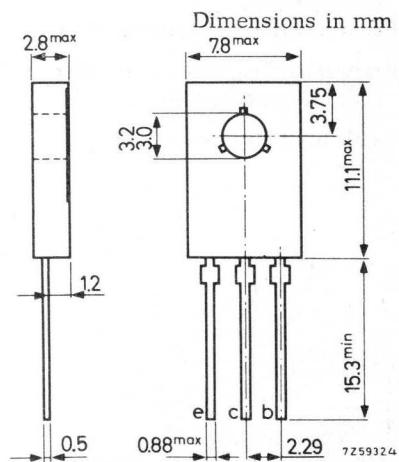
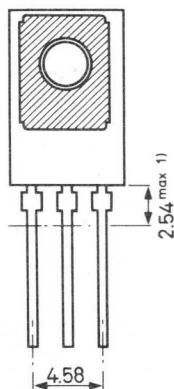
P-N-P transistors in a TO-126 plastic envelope; with their complements, the BD135 (for the BD136), the BD137 (for the BD138) and the BD139 (for the BD140), they are primarily intended for complementary driver stages in hi-fi amplifiers. They are also recommended as single drivers where voltage and dissipation are high. The devices are also suitable for television circuits.

QUICK REFERENCE DATA

		BD136	BD138	BD140
Collector-base voltage (open emitter)	-V _{CBO}	max. 45	60	- V
Collector-emitter voltage (open base)	-V _{CEO}	max. 45	60	80 V
Collector-emitter voltage ($R_{BE} = 1 \text{ k}\Omega$)	-V _{CER}	max. -	-	100 V
Collector-current (peak value)	-I _{CM}	max. 1.5	1.5	1.5 A
Total power dissipation up to $T_{mb} = 60^\circ\text{C}$	P _{tot}	max. 6.5	6.5	6.5 W
Junction temperature	T _j	max. 125	125	125 $^\circ\text{C}$
D.C. current gain $-I_C = 150 \text{ mA}; -V_{CE} = 2 \text{ V}$	h _{FE}	> 40 < 250	40 160	40 160
Transition frequency at $f = 35 \text{ MHz}$ $-I_C = 50 \text{ mA}; -V_{CE} = 5 \text{ V}$	f _T	typ. 75	75	75 MHz

MECHANICAL DATA

TO-126

Collector connected
to metal part of
mounting surface

Accessories available: 56302; 56303

Torque on nut: min. 8 cm kg
max. 9 cm kg

1) Within this region the cross-section of the leads is uncontrolled.

**BD136 BD138
BD140**

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

			BD136	BD138	BD140
Collector-base voltage (open emitter)	-V _{CBO}	max.	45	60	- V
Collector-emitter voltage (open base) ¹⁾	-V _{CEO}	max.	45	60	80 V
Collector-emitter voltage ($R_{BE} = 1 \text{ k}\Omega$)	-V _{CER}	max.	-	-	100 V
Emitter-base voltage (open collector)	-V _{EBO}	max.	5	5	5 V

Currents

Collector current (d.c.)	-I _C	max.	0.5	0.5	0.5 A
Collector current(peak value)	-I _{CM}	max.	1.5	1.5	1.5 A

Power dissipation

Total power dissipation up to $T_{mb} = 60^\circ\text{C}$ (see also pages 4, 5 and 6)	P _{tot}	max.	6.5	W
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Temperatures

Storage temperature	T _{stg}	-55 to + 125	°C
Junction temperature	T _j	max.	125 °C

THERMAL RESISTANCE

From junction to ambient in free air	R _{th j-a}	100	°C/W
From junction to mounting base	R _{th j-mb}	10	°C/W
From mounting base to heatsink with mica washer 56302	R _{th mb-h}	6	°C/W
without mica washer	R _{th mb-h}	1	°C/W

¹⁾ At -I_C = 30 mA

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; -V_{CB} = 30 \text{ V}$	$-I_{CBO}$	<	100	nA
$I_E = 0; -V_{CB} = 30 \text{ V}; T_j = 125^\circ\text{C}$	$-I_{CBO}$	<	10	μA

Emitter cut-off current

$I_C = 0; -V_{EB} = 5 \text{ V}$	$-I_{EBO}$	<	10	μA
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Base emitter voltage

$-I_C = 500 \text{ mA}; -V_{CE} = 2 \text{ V}$	$-V_{BEC}$	<	1	V
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Saturation voltage

$-I_C = 500 \text{ mA}; -I_B = 50 \text{ mA}$	$-V_{CEsat}$	<	0.5	V
---	--------------	---	-----	---

D.C. current gain

			BD136	BD138	BD140
$-I_C = 5 \text{ mA}; -V_{CE} = 2 \text{ V}$	h_{FE}	>	25	25	25
$-I_C = 150 \text{ mA}; -V_{CE} = 2 \text{ V}$	h_{FE}	>	40	40	40
$-I_C = 500 \text{ mA}; -V_{CE} = 2 \text{ V}$	h_{FE}	<	250	160	160
		>	25	25	25

Transition frequency at $f = 35 \text{ MHz}$

$-I_C = 50 \text{ mA}; -V_{CE} = 5 \text{ V}$	f_T	typ.	75	MHz
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D.C. current gain ratio of

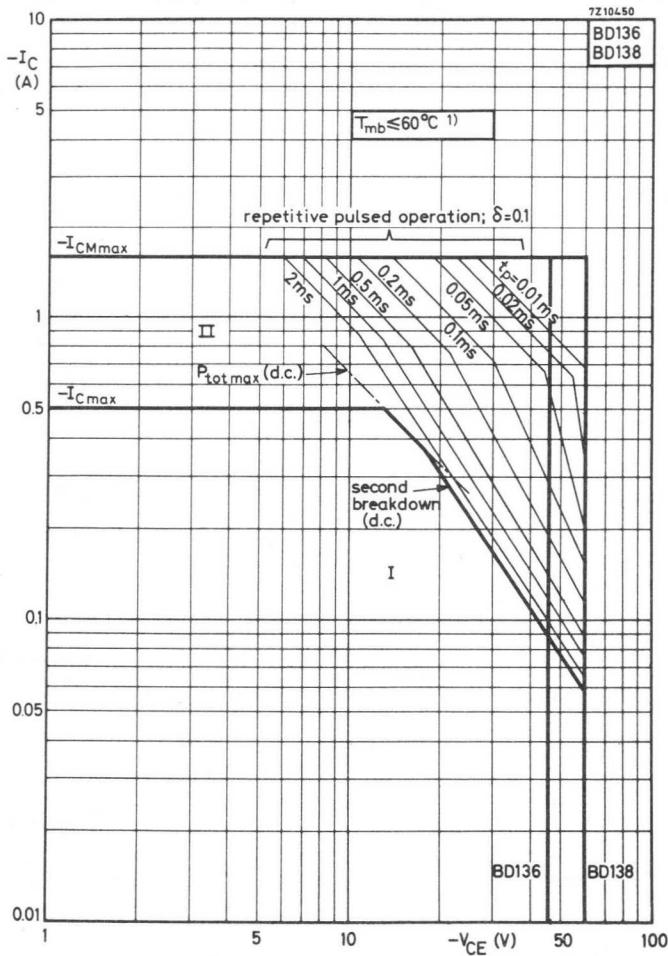
matched pairs

BD135/BD136; BD137/BD138

BD139/BD140

$ I_C = 150 \text{ mA}; V_{CE} = 2 \text{ V}$	h_{FE1}/h_{FE2}	typ.	1.3
		<	1.6

**BD136 BD138
BD140**



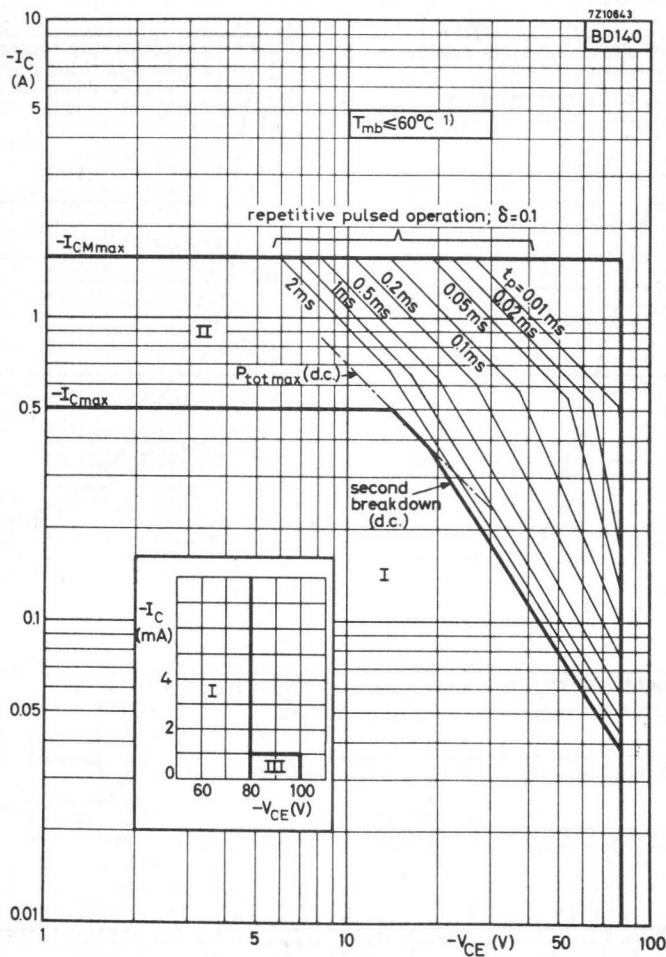
Safe Operating Area with the transistor forward biased

I Region of permissible d.c. operation

II Permissible extension for repetitive pulsed operation

1) To derate $P_{tot max}$ for higher temperatures see page 6.

Ratings for second breakdown are independent of temperature.

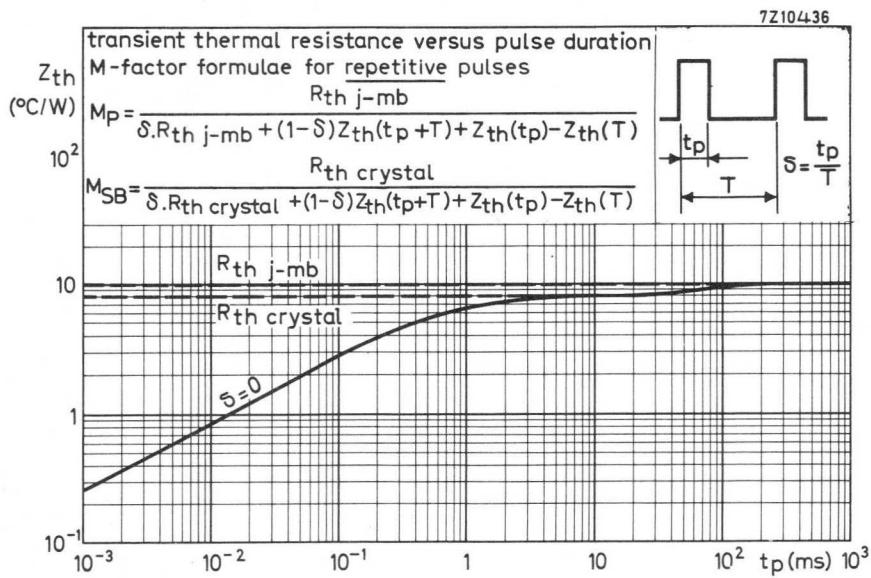
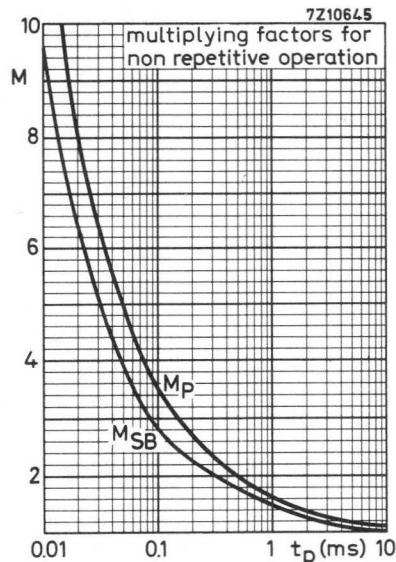
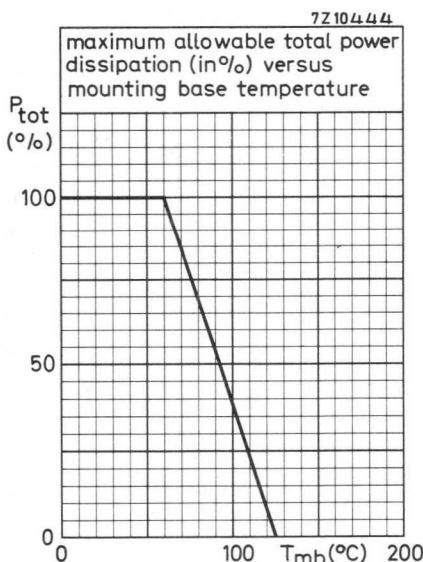


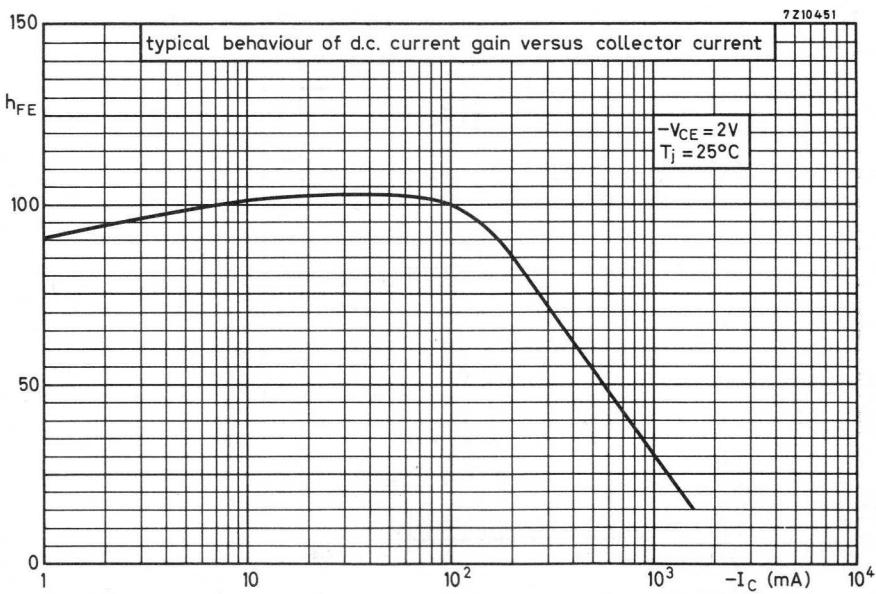
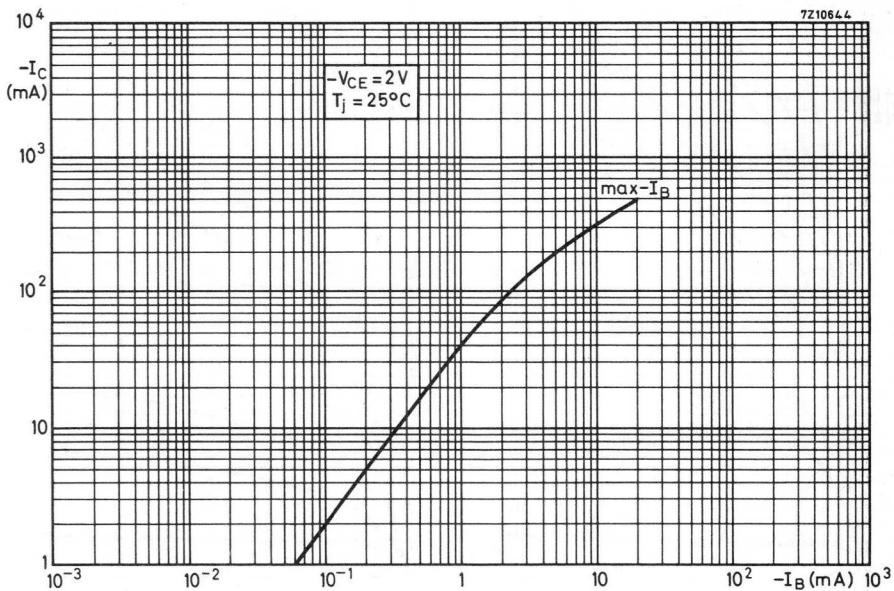
Safe Operating Area with the transistor forward biased

- I Region of permissible d.c. operation
- II Permissible extension for repetitive pulsed operation
- III Repetitive pulsed operation in this region is allowable, provided $R_{BE} \leq 1 \text{ k}\Omega$.

1) To derate $P_{tot max}$ for higher temperatures see page 6.

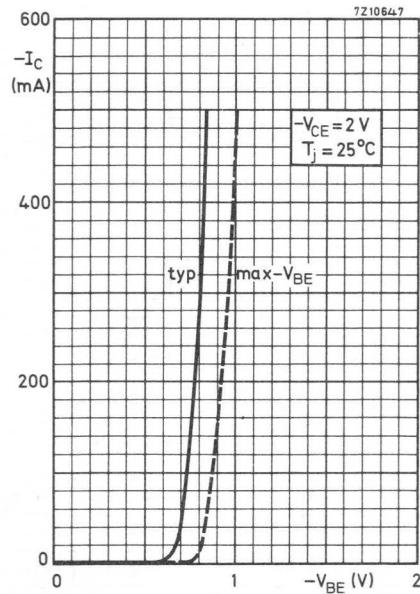
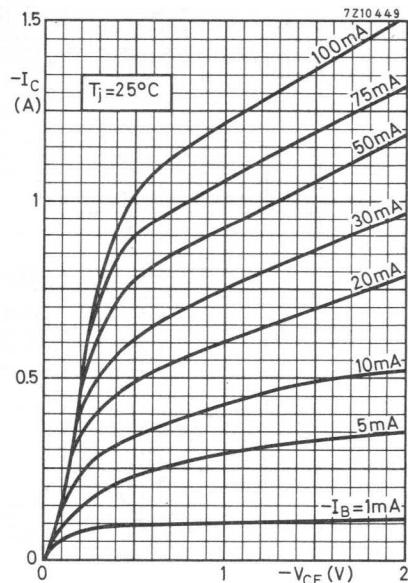
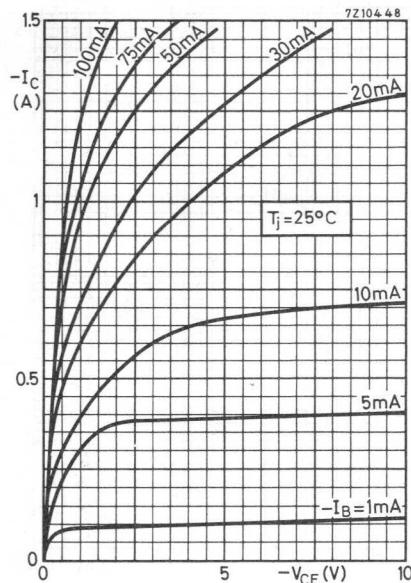
Ratings for second breakdown are independent of temperature.

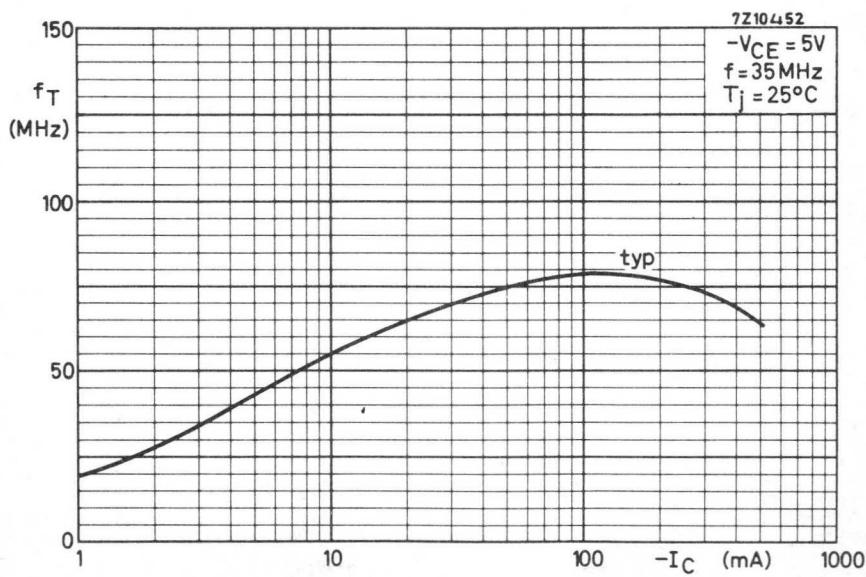
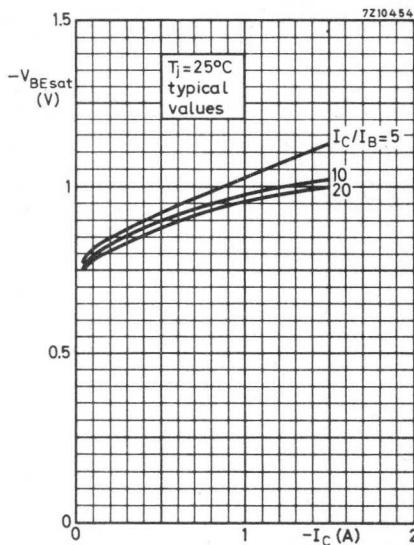
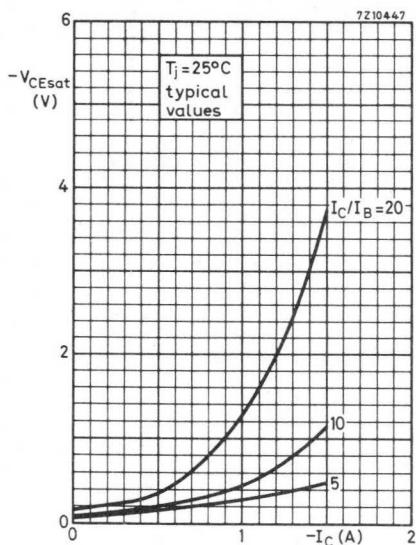




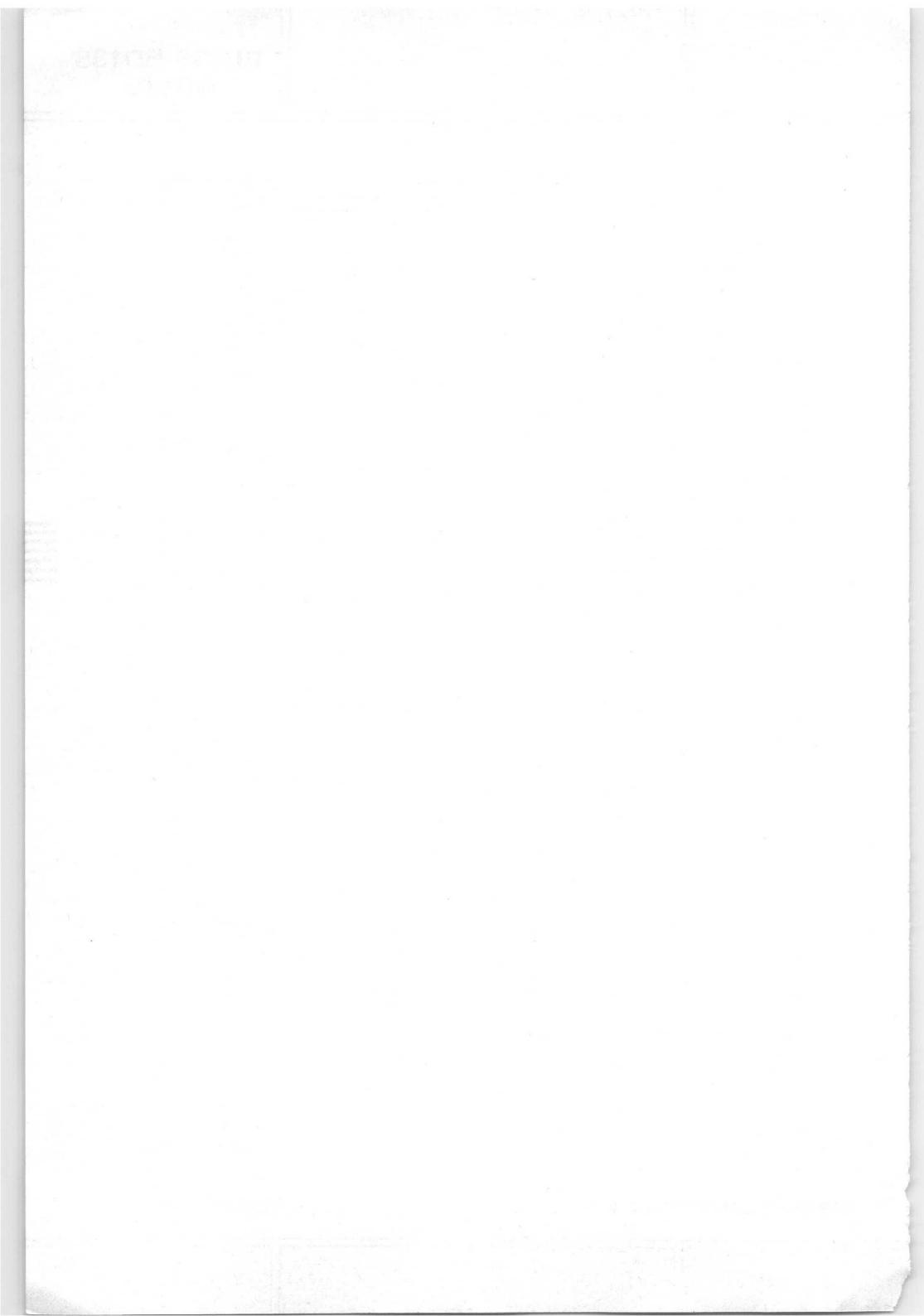
**BD136 BD138
BD140**

typical behaviour of collector current versus collector-emitter voltage





APPLICATION INFORMATION See BD135; BD137; BD139 pages 10 to 16



SILICON DIFFUSED POWER TRANSISTORS

N-P-N transistors in a TO-3 metal envelope with the collector connected to the case. The BDY10 and BDY11 are primarily intended for high and medium power audio frequency applications. Moreover they are extremely suitable for d.c. converters and solenoid drivers. These electrically robust transistors are, to a very high degree, free of second breakdown.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

	BDY10	BDY11
Collector-base voltage (open emitter)	V _{CBO}	max. 50 100 V
Collector-emitter voltage (open base)	V _{CEO}	max. 40 70 V
Collector-emitter voltage with V _{BE} = 0	V _{CES}	max. 50 100 V
Collector current (d.c.)	I _C	max. 2 A
Collector current (peak value)	I _{CM}	max. 4 A
Total power dissipation up to T _{amb} = 25 °C	P _{tot}	max. 125 W
Storage temperature	T _{stg}	-55 to + 175 °C
Junction temperature	T _j	max. 175 °C

THERMAL RESISTANCE

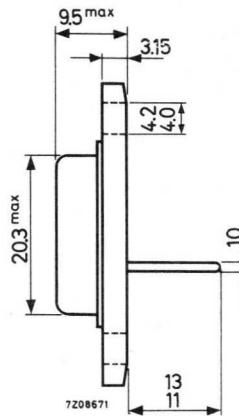
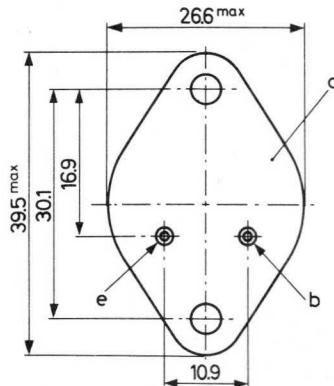
From junction to ambient in free air	R _{th} j-a	=	40 °C/W
From junction to mounting base	R _{th} j-mb	=	1 °C/W
From mounting base to heatsink	R _{th} mb-h	=	0.2 °C/W

MECHANICAL DATA

Dimensions in mm

Collector connected to case

TO-3



Accessories available: 56201e.

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 50 \text{ V}$	<u>BDY10</u>	I_{CBO}	typ.	10	μA
$I_E = 0; V_{CB} = 100 \text{ V}$	<u>BDY11</u>	I_{CBO}	typ.	4.5	μA
$I_E = 0; V_{CB} = V_{CB\text{Omax}}; T_j = 175^\circ\text{C}$		I_{CBO}	typ.	2	mA
$V_{EB} = 0; V_{CB} = V_{CB\text{Omax}}$		I_{CES}	<	1	mA

Emitter cut-off current

$I_C = 0; V_{EB} = 5 \text{ V}$		I_{EBO}	typ.	0.5	nA
$I_C = 0; V_{EB} = 5 \text{ V}; T_j = 175^\circ\text{C}$		I_{EBO}	typ.	65	μA

Base-emitter voltage

$I_C = 0.2 \text{ A}; V_{CE} = 2 \text{ V}$		V_{BE}	<	1.5	V
$I_C = 2 \text{ A}; V_{CE} = 2 \text{ V}$		V_{BE}	typ.	1.2	V

Saturation voltage

$I_C = 2 \text{ A}; I_B = 0.4 \text{ A}$		$V_{CE\text{sat}}$	<	0.7	V
--	--	--------------------	---	-----	------------

Emitter-base floating voltage

$I_E = 0; V_{CB} = V_{CB\text{Omax}}; T_j = 150^\circ\text{C}$		$V_{EB\text{fl}}$	<	1	V
--	--	-------------------	---	---	------------

D.C. current gain

$I_C = 0.2 \text{ A}; V_{CE} = 2 \text{ V}$		h_{FE}	>	20	
			typ.	100	
$I_C = 2 \text{ A}; V_{CE} = 2 \text{ V}$		h_{FE}	typ.	25	

$I_C = 4 \text{ A}; V_{CE} = 2 \text{ V}$		h_{FE}	typ.	10	
---	--	----------	------	----	--

Collector capacitance at $f = 1 \text{ MHz}$

$I_E = I_e = 0; V_{CB} = 20 \text{ V}$		C_C	typ.	350	pF
			<	500	pF

Transition frequency

$I_C = 0.2 \text{ A}; V_{CE} = 5 \text{ V}$		f_T	>	1	MHz
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SILICON DIFFUSED POWER TRANSISTORS

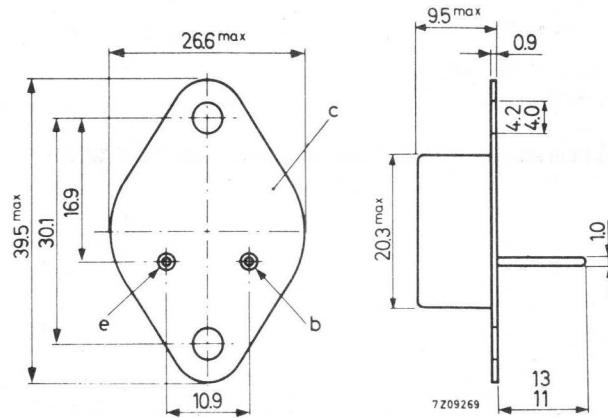
N-P-N transistor in a TO-3 metal envelope, intended for use in linear applications such as hi-fi amplifiers and signal processing circuits.

QUICK REFERENCE DATA		
Collector-base voltage (open emitter)	V_{CBO}	max. 100 V
Collector-emitter voltage (open base)	V_{CEO}	max. 60 V
Collector current (peak value)	I_{CM}	max. 15 A
Total power dissipation up to $T_{mb} = 25^\circ\text{C}$	P_{tot}	max. 115 W
Junction temperature	T_j	max. 200 $^\circ\text{C}$
D.C. current gain $I_C = 4 \text{ A}; V_{CE} = 4 \text{ V}$	h_{FE}	20 to 70
Transition frequency at $f = 1 \text{ MHz}$ $I_C = 1 \text{ A}; V_{CE} = 4 \text{ V}$	f_T	typ. 1 MHz

MECHANICAL DATA

Collector connected to envelope
TO-3

Dimensions in mm



Accessories available: 56201e (for insulated mounting on a 2 mm heatsink).

BDY20
2-BDY20

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	100	V
Collector-emitter voltage (open base)	V_{CEO}	max.	60	V ¹⁾
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	V_{CER}	max.	70	V ¹⁾
Emitter-base voltage (open collector)	V_{EBO}	max.	7	V

Currents

Collector current (d.c.)	I_C	max.	15	A
Collector current (peak value)	I_{CM}	max.	15	A
Emitter current (peak value)	$-I_{EM}$	max.	15	A

Power dissipation

Total power dissipation up to $T_{mb} = 25^\circ\text{C}$	P_{tot}	max.	115	W
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Temperatures

Storage temperature	T_{stg}	-65 to +200	$^\circ\text{C}$
Junction temperature	T_j	max.	200 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to ambient in free air	$R_{th j-a}$	=	40	$^\circ\text{C/W}$
From junction to mounting base	$R_{th j-mb}$	=	1.5	$^\circ\text{C/W}$
From mounting base to heatsink	$R_{th mb-h}$	=	0.5	$^\circ\text{C/W}$
From mounting base to heatsink with accessory 56201e	$R_{th mb-h}$	=	0.75	$^\circ\text{C/W}$

The appropriate heatsink(s) will be found in the section HEATSINKS.

¹⁾ $I_C = 0.2 \text{ A}$

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off currents

$I_E = 0; V_{CB} = 100 \text{ V}$	I_{CBO}	typ. 3 μA
$I_B = 0; V_{CE} = 30 \text{ V}$	I_{CEO}	< 5 mA
$-V_{BE} = 1.5 \text{ V}; V_{CE} = 100 \text{ V}$	I_{CEX}	typ. 0.7 mA
$-V_{BE} = 1.5 \text{ V}; V_{CE} = 100 \text{ V}; T_j = 150^\circ\text{C}$	I_{CEX}	typ. 4 μA
		< 5 mA
		typ. 0.3 mA
		< 10 mA

Emitter cut-off current

$I_C = 0; V_{EB} = 7 \text{ V}$	I_{EBO}	typ. 1 nA
		< 5 mA

Base-emitter voltage

$I_C = 4 \text{ A}; V_{CE} = 4 \text{ V}$	V_{BE}	typ. 1.1 V
		< 1.8 V

Collector-emitter saturation voltage

$I_C = 4 \text{ A}; I_B = 0.4 \text{ A}$	V_{CEsat}	typ. 0.4 V
		< 1.1 V

Knee voltage

$I_C = 10 \text{ A}; I_B = \text{value for which}$ $I_C = 11 \text{ A at } V_{CE} = 5 \text{ V}$	V_{CEK}	typ. 3.0 V
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D.C. current gain

$I_C = 4 \text{ A}; V_{CE} = 4 \text{ V}$	h_{FE}	20 to 70
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Collector capacitance at $f = 1 \text{ MHz}$

$I_E = I_e = 0; V_{CB} = 20 \text{ V}$	C_c	typ. 250 pF
--	-------	-------------

Transition frequency at $f = 1 \text{ MHz}$

$I_C = 1 \text{ A}; V_{CE} = 4 \text{ V}$	f_T	typ. 1 MHz
---	-------	------------

Cut-off frequency

$I_C = 1 \text{ A}; V_{CE} = 4 \text{ V}$	f_{hfe}	typ. 9 kHz
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D.C. current gain ratio of
matched pair 2-BDY20

$I_C = 0.4 \text{ A}; V_{CE} = 4 \text{ V}$	h_{FE1}/h_{FE2}	< 1.6
$I_C = 4 \text{ A}; V_{CE} = 4 \text{ V}$	h_{FE1}/h_{FE2}	< 1.3

BDY20
2-BDY20

CHARACTERISTICS (continued)

$T_j = 25^\circ\text{C}$ unless otherwise specified

Switching times

$$I_C = 4 \text{ A}; I_B = -I_{BM} = 400 \text{ mA}$$

Delay time

t_d typ. 0.4 μs

Rise time

t_r typ. 2 μs

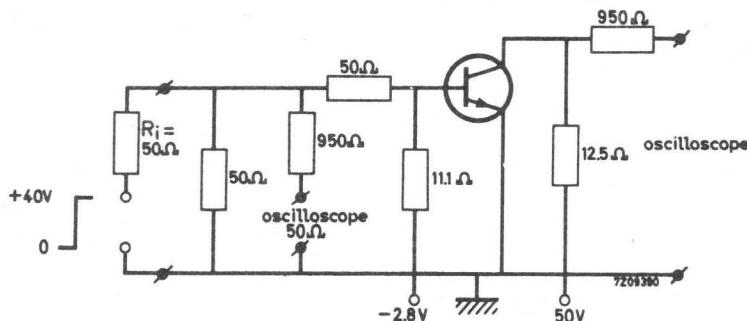
Storage time

t_s typ. 2 μs

Fall time

t_f typ. 2.5 μs

Test circuit:



Pulse generator:

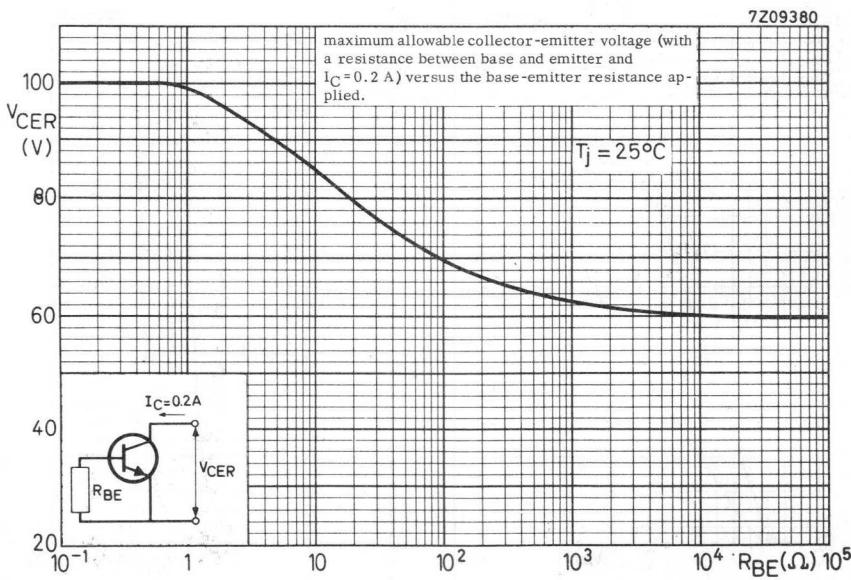
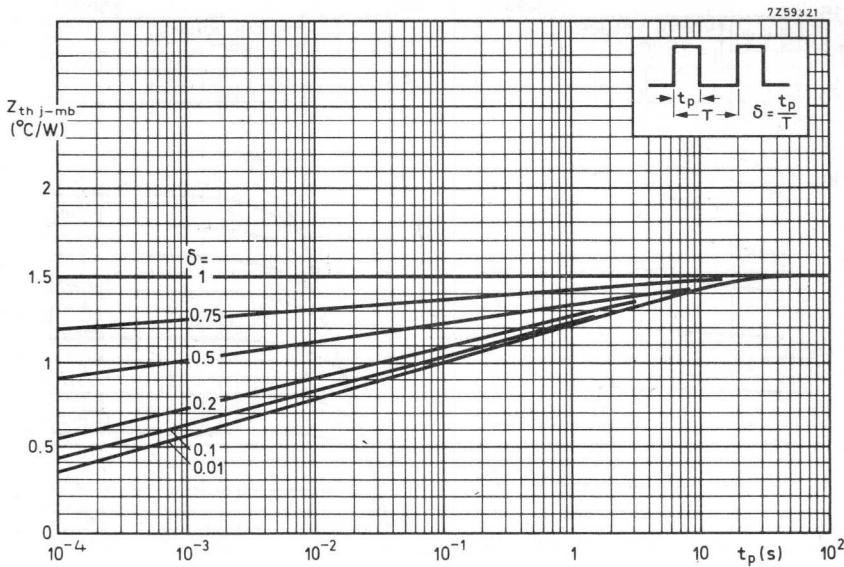
Pulse duration $t > 10 \mu\text{s}$

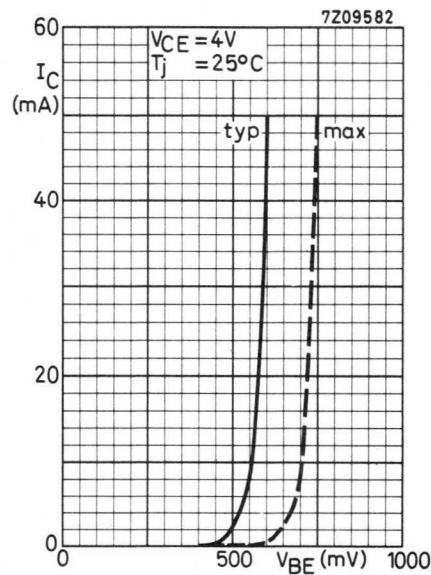
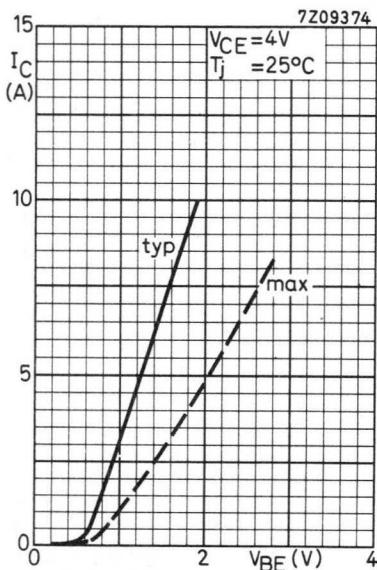
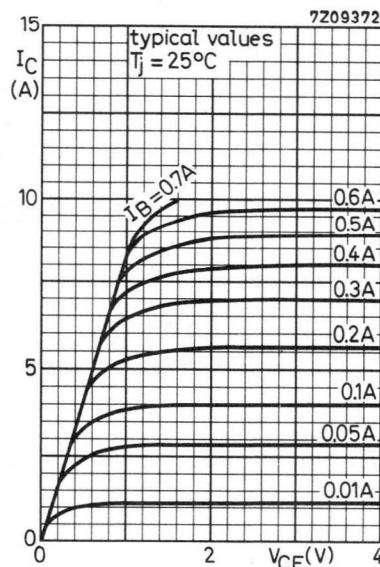
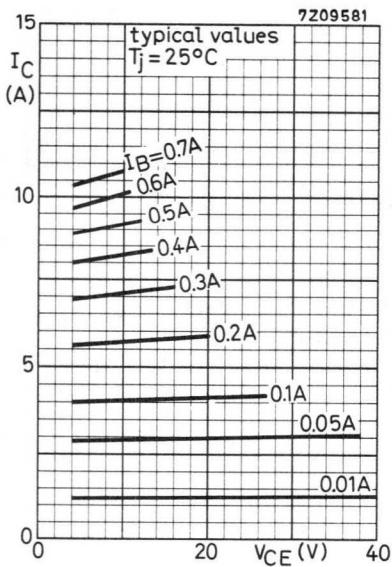
Oscilloscope:

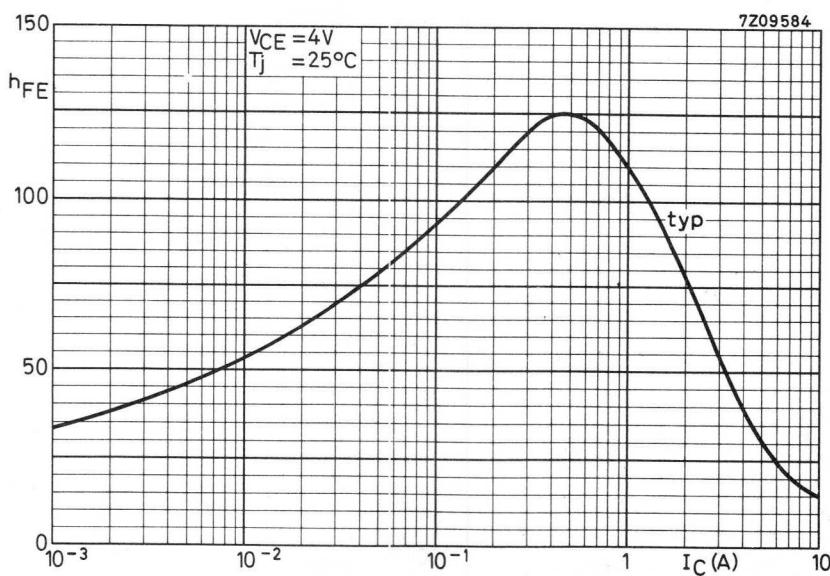
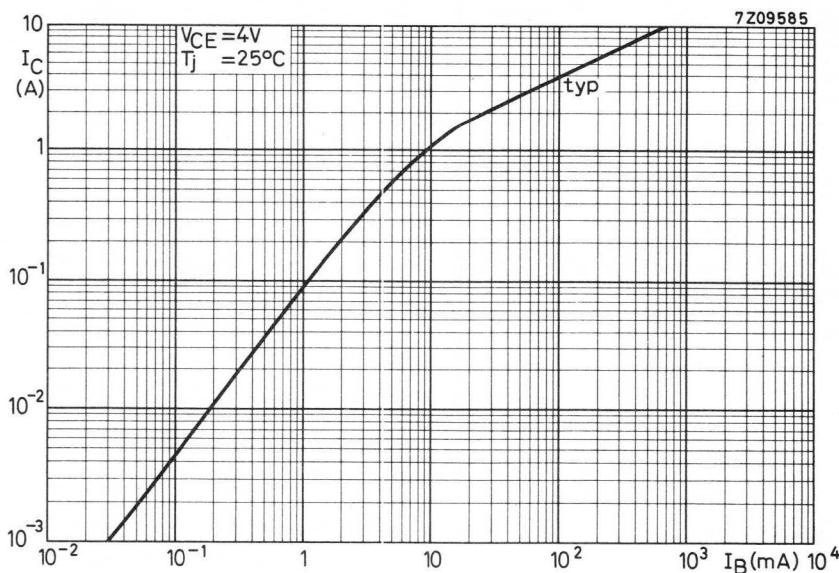
Rise time $t_r \leq 10 \text{ ns}$

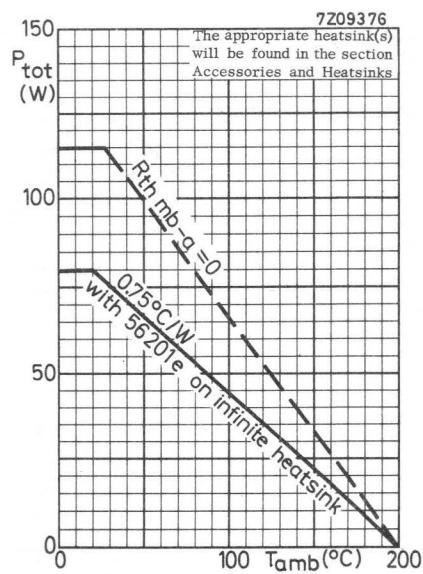
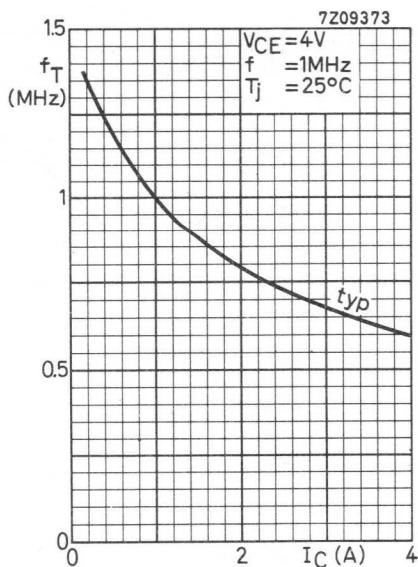
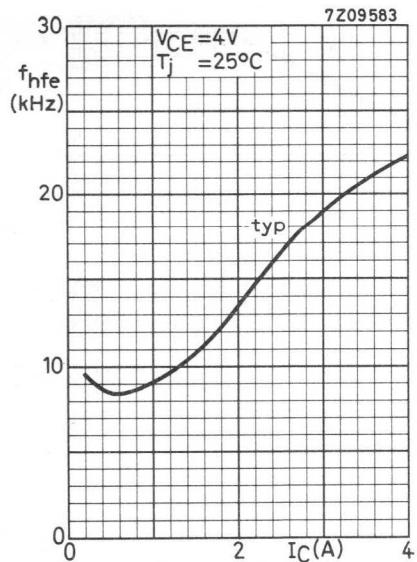
Rise time $t_r \leq 10 \text{ ns}$

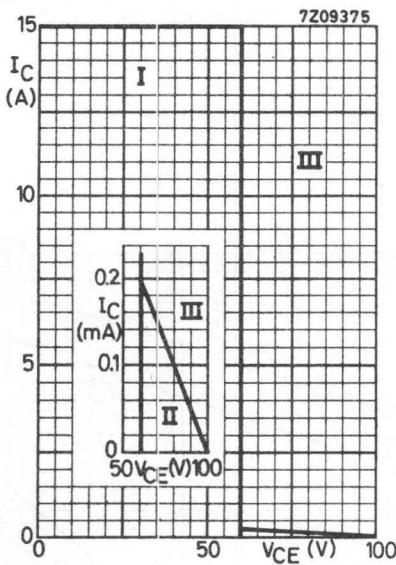
Input resistance $R_i = 50 \Omega$



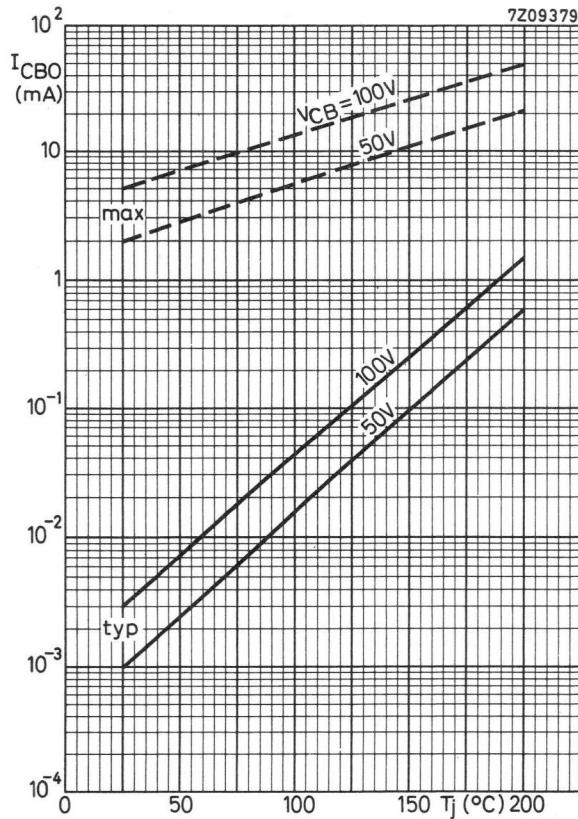








- I Region of permissible operation under all base-emitter conditions provided no limiting values are exceeded.
- II Additional region of operation when the transistor is cut-off with $-V_{BE} \leq 1.5$ V.
- III Operation during switching off is allowed, provided the transistor is cut-off with $-V_{BE} \leq 1.5$ V and the transient energy does not exceed 75 mWs.



SILICON DIFFUSED POWER TRANSISTORS

N-P-N transistor in a TO-3 metal envelope, intended for use in linear applications such as hi-fi amplifiers and signal processing circuits.

QUICK REFERENCE DATA

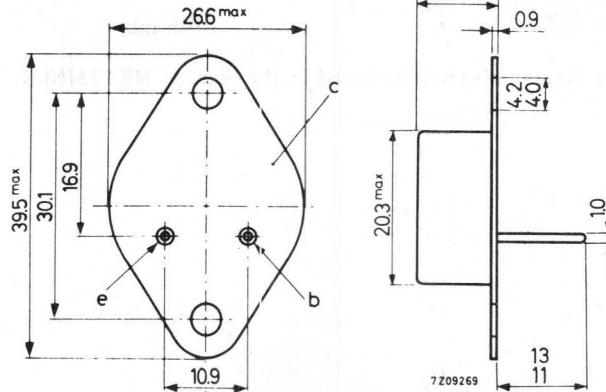
Collector-base voltage (open emitter)	V _{CBO}	max.	50	V
Collector-emitter voltage (open base)	V _{CEO}	max.	40	V
Collector current (peak value)	I _{CM}	max.	6	A
Total power dissipation up to T _{mb} = 25 °C	P _{tot}	max.	115	W
Junction temperature	T _j	max.	200	°C
D.C. current gain I _C = 2 A; V _{CE} = 4 V	h _{FE}	>	30	
Transition frequency at f = 1 MHz I _C = 1 A; V _{CE} = 4 V	f _T	typ.	1	MHz

MECHANICAL DATA

Collector connected to the envelope

TO-3

Dimensions in mm



Accessories available: 56201e (for insulated mounting on a 2 mm heatsink)

BDY38
2-BDY38

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	50	V
Collector-emitter voltage (open base)	V_{CEO}	max.	40	V ¹⁾
Emitter-base voltage (open collector)	V_{EBO}	max.	7	V

Currents

Collector current (d.c.)	I_C	max.	6	A
Collector current (peak value)	I_{CM}	max.	6	A
Emitter current (peak value)	$-I_{EM}$	max.	8	A

Power dissipation

Total power dissipation up to $T_{mb} = 25$ °C	P_{tot}	max.	115	W
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Temperatures

Storage temperature	T_{stg}	-65 to +200	°C
Junction temperature	T_j	max.	200 °C

THERMAL RESISTANCE

From junction to ambient in free air	$R_{th\ j-a}$	=	40	°C/W
From junction to mounting base	$R_{th\ j-mb}$	=	1.5	°C/W
From mounting base to heatsink	$R_{th\ mb-h}$	=	0.5	°C/W
From mounting base to heatsink with accessory 56201e	$R_{th\ mb-h}$	=	0.75	°C/W

The appropriate heatsink(s) will be found in the Section HEATSINKS.

1) $I_C = 0.2$ A.

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 50 \text{ V}$

I_{CBO} typ. < 3 μA
1 mA

$V_{BE} = 0; V_{CE} = 50 \text{ V}$

I_{CES} typ. < 3 μA
1 mA

Emitter cut-off current

$I_C = 0; V_{EB} = 7 \text{ V}$

I_{EBO} typ. < 1 nA
5 mA

Base-emitter voltage

$I_C = 2 \text{ A}; V_{CE} = 4 \text{ V}$

V_{BE} < 2 V

Collector-emitter saturation voltage

$I_C = 2 \text{ A}; I_B = 0.2 \text{ A}$

V_{CEsat} < 0.7 V

Knee voltage

$I_C = 6 \text{ A}; I_B = \text{value for which}$

$I_C = 6.6 \text{ A}$ and $V_{CE} = 2 \text{ V}$

V_{CEK} < 1.5 V

D.C. current gain

$I_C = 0.2 \text{ A}; V_{CE} = 4 \text{ V}$

h_{FE} > 30

$I_C = 2 \text{ A}; V_{CE} = 4 \text{ V}$

h_{FE} > 30

Collector capacitance at $f = 1 \text{ MHz}$

$I_E = I_e = 0; V_{CB} = 20 \text{ V}$

C_C typ. 250 pF

Transition frequency at $f = 1 \text{ MHz}$

$I_C = 1 \text{ A}; V_{CE} = 4 \text{ V}$

f_T typ. 1 MHz

Cut-off frequency

$I_C = 1 \text{ A}; V_{CE} = 4 \text{ V}$

f_{hfe} typ. 12 kHz

D.C. current gain ratio of

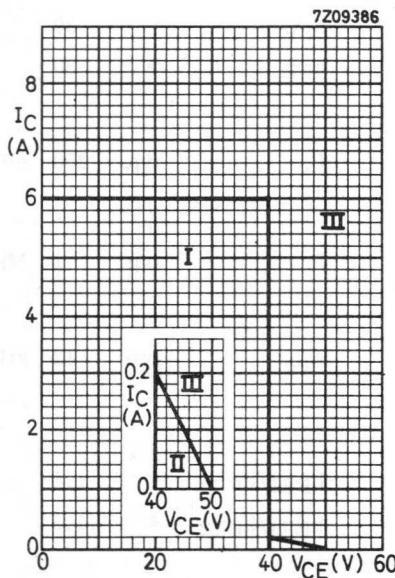
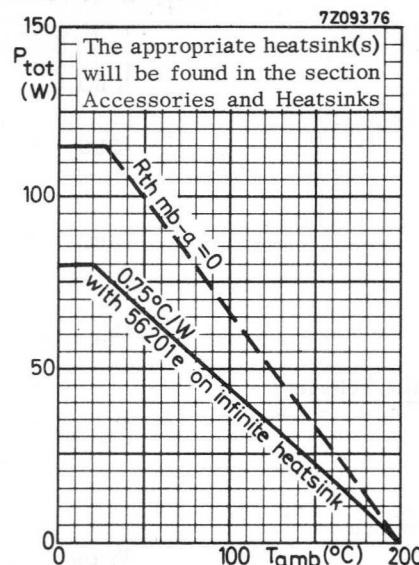
matched pair 2-BDY38

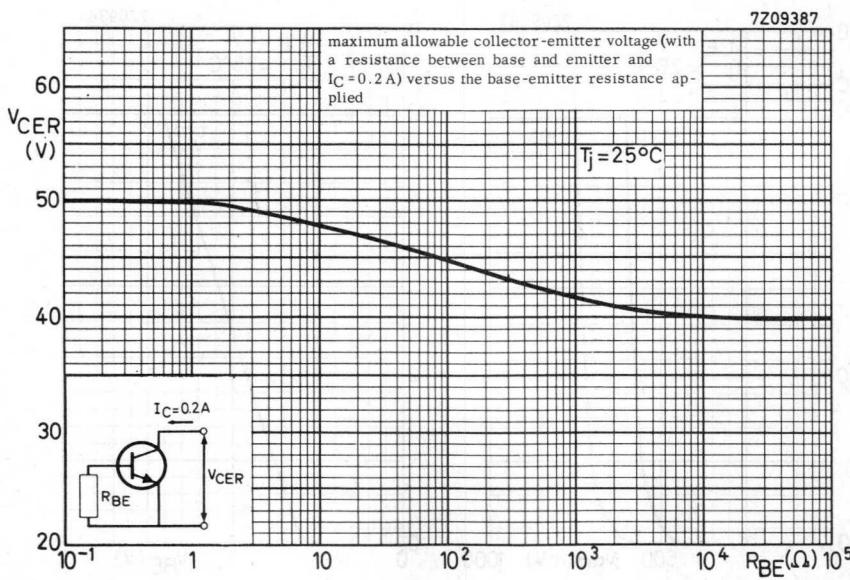
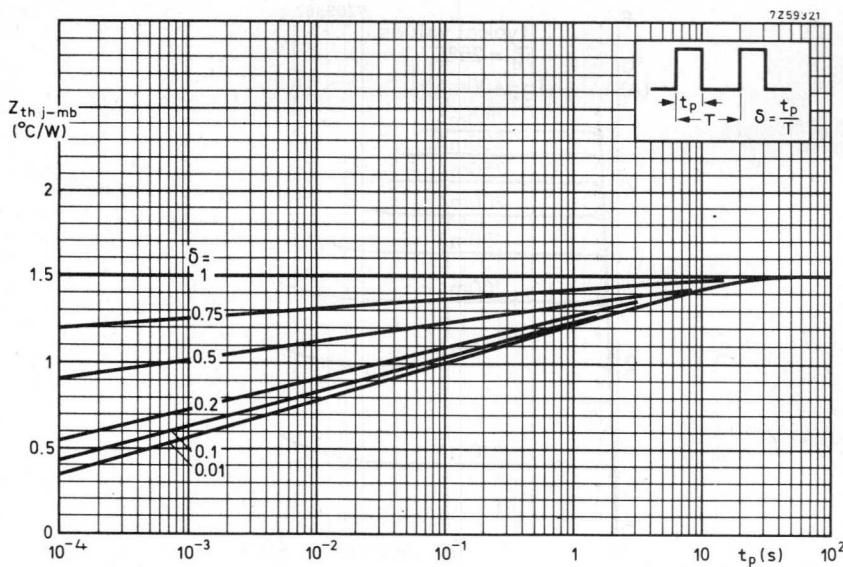
$I_C = 0.2 \text{ A}; V_{CE} = 4 \text{ V}$

h_{FE1}/h_{FE2} < 1.5

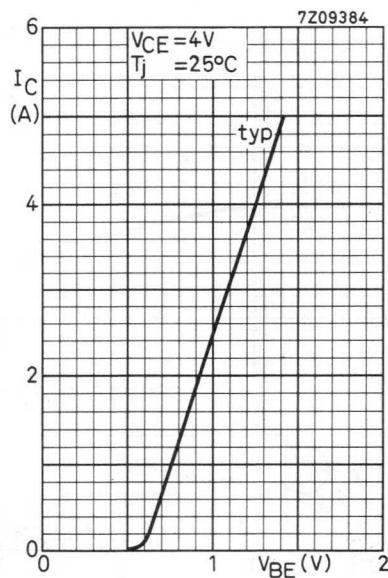
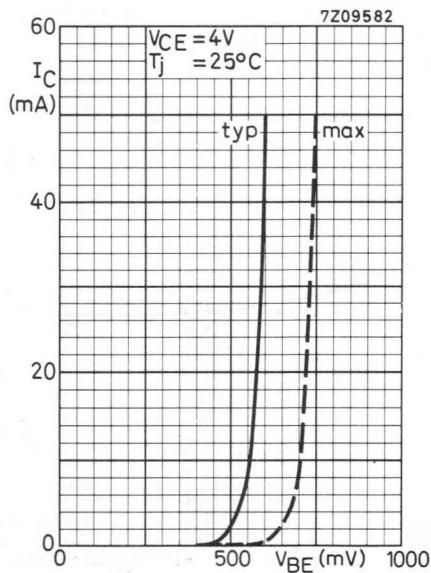
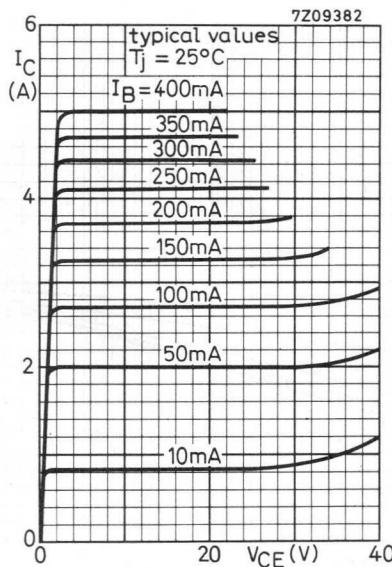
$I_C = 2 \text{ A}; V_{CE} = 4 \text{ V}$

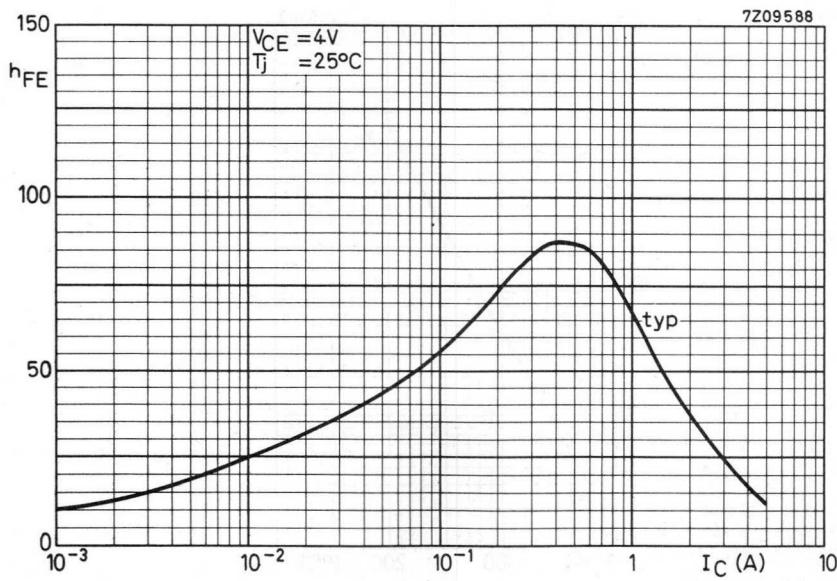
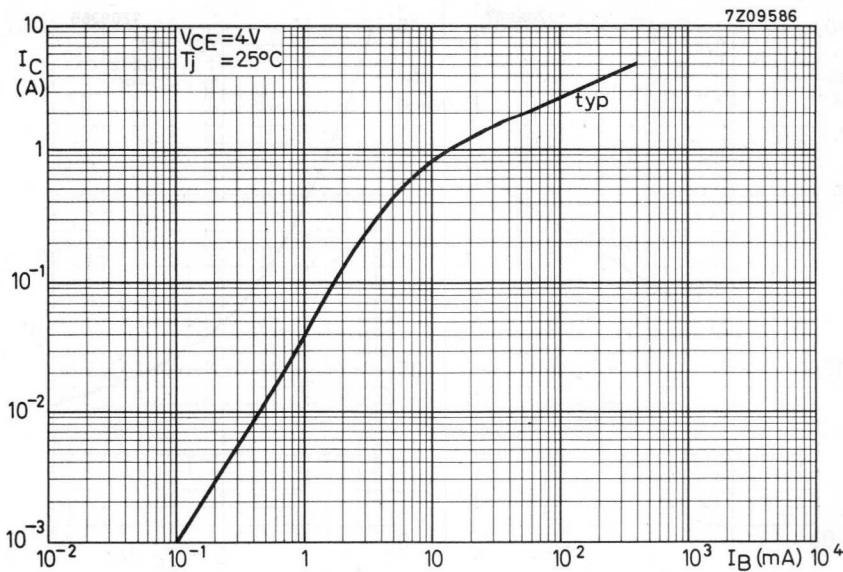
h_{FE1}/h_{FE2} < 1.2



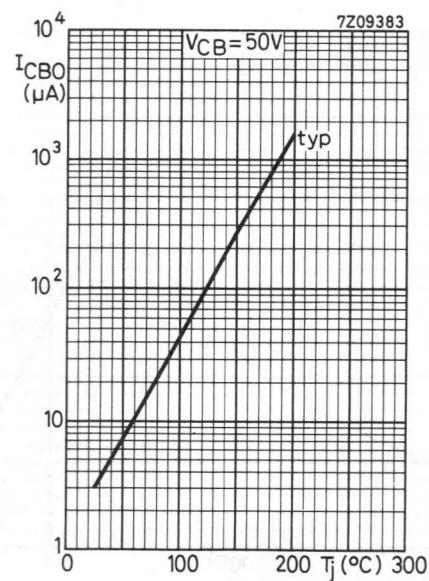
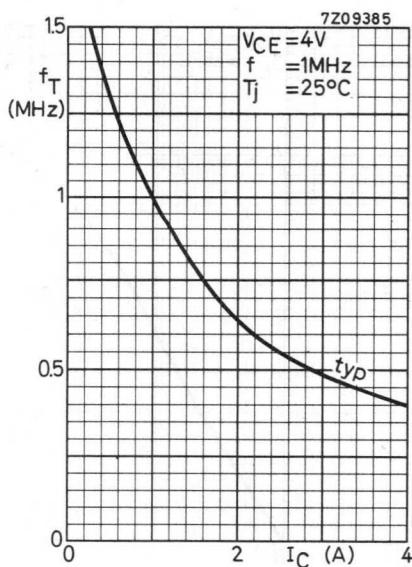
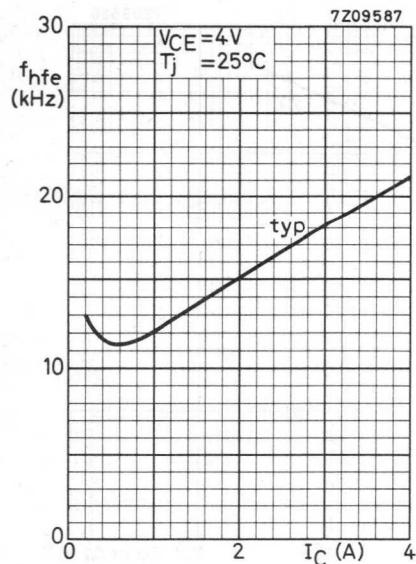


BDY38
2-BDY38





BDY38
2-BDY38



P-N-P POWER TRANSISTORS

High frequency power transistors in a metal envelope for use in high speed industrial switching applications.

The OC22 is intended for use in digital computers and high quality audio amplifiers.

The OC23 is intended for use as pulse generator for a ferrite store.

The OC24 is intended for use in digital computers, medium frequency transmitters and carrier telephony applications.

RATINGS (Limiting values) ¹⁾

		OC22	OC23	OC24
Collector-base voltage (open emitter)	-V _{CBO}	max. 32	40	V
Collector-emitter voltage (open base)	-V _{CEO}	max. 24	16	V
Collector current (peak value)	-I _{CM}	max. 2.0	A	
Total power dissipation up to T _{mb} = 25 °C	P _{tot}	max. 21.5	W	
Junction temperature	T _j	max. 90	°C	

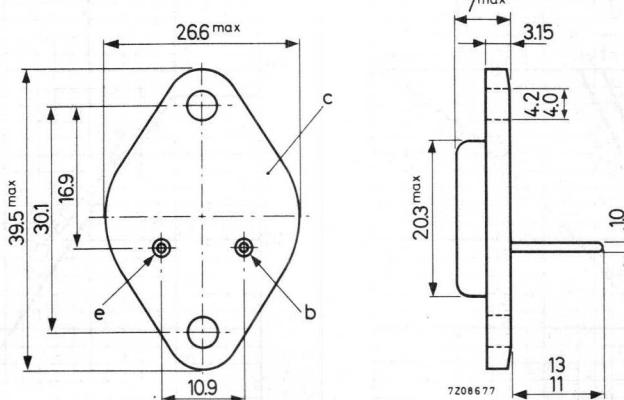
THERMAL RESISTANCE

From junction to mounting base	R _{th j-mb}	=	3.0	°C/W
From mounting base to heatsink without mica insulation	R _{th mb-h}	=	0.2	°C/W

MECHANICAL DATA

Collector connected to mounting base

Dimensions in mm



¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS

 $T_{mb} = 25^{\circ}\text{C}$ unless otherwise specifiedCollector cut-off current

$$I_E = 0; -V_{CB} = 10 \text{ V}$$

$-I_{CBO}$	typ. <	20 100	μA
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Base-emitter voltage

$$-I_C = 100 \text{ mA}; -V_{CE} = 2 \text{ V}$$

$-V_{BE}$	typ.	0.25	V
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$$-I_C = 1 \text{ A}; -V_{CE} = 2 \text{ V}$$

$-V_{BE}$	typ.	0.8	V
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D.C. current gain

$$-I_C = 100 \text{ mA}; -V_{CE} = 2 \text{ V}$$

h_{FE}	typ.	170	V
----------	------	-----	---

$$-I_C = 1 \text{ A}; -V_{CE} = 2 \text{ V}$$

h_{FE}	>	50	V
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h_{FE}	typ.	125	V
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Cut-off frequency

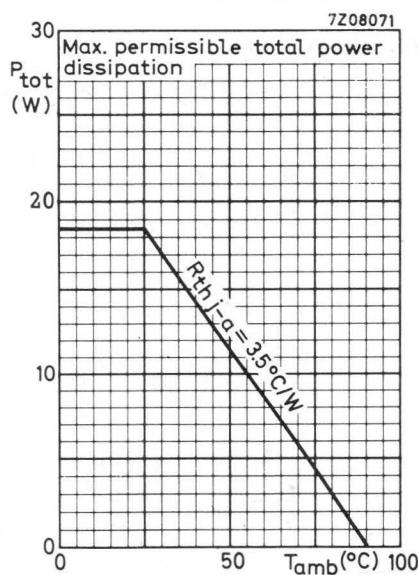
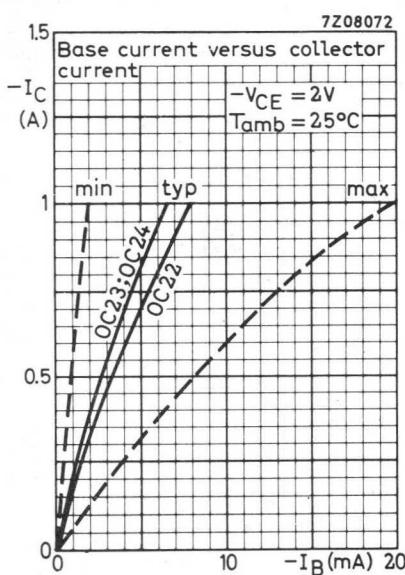
$$-I_C = 400 \text{ mA}; -V_{CE} = 2 \text{ V}$$

f_{hfb}	typ.	2.5	MHz
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Small signal current gain

$$-I_C = 400 \text{ mA}; -V_{CE} = 2 \text{ V}$$

h_{fe}	typ.	180
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GERMANIUM POWER TRANSISTOR

P-N-P alloy transistor in a TO-36 metal envelope with the collector connected to the mounting base.

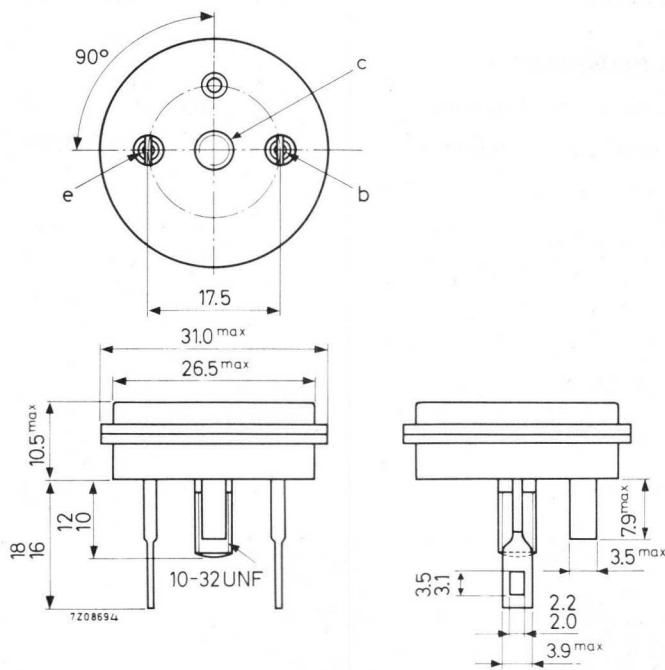
QUICK REFERENCE DATA

Collector-base voltage ($+V_{BE} = 1.5$ V)	$-V_{CBX}$	max. 80 V
Emitter-base voltage (open collector)	$-V_{EBO}$	max. 60 V
Emitter current (d.c.)	I_E	max. 15 A
Total power dissipation up to $T_{mb} = 25$ °C	P_{rot}	max. 150 W
Junction temperature	T_j	max. 100 °C
D.C. current gain at $T_j = 25$ °C	h_{FE}	> 25
$-I_C = 5$ A; $-V_{CE} = 2$ V		
Cut-off frequency $-I_C = 5$ A; $-V_{CE} = 6$ V	f_{hfe}	typ. 10 kHz

MECHANICAL DATA

TO-36

Dimensions in mm



Diameter of hole in heatsink: max. 5.2 mm
Supplied with device: 56213

Torque on nut: min. 8 cm kg
max. 17 cm kg

RATINGS (Limiting values) 1)Voltages

Collector-base voltage ($+V_{BE} = 1.5$ V)	$-V_{CBX}$	max.	80	V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	60	V

Currents

Emitter current (d.c.)	I_E	max.	15	A
Base current (d.c.)	$-I_B$	max.	4	A

Power dissipation

Total power dissipation up to $T_{mb} = 25$ °C	P_{tot}	max.	150	W
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Temperatures

Storage temperature	T_{stg}	-65 to +100	°C
Junction temperature	T_j	max.	100 °C

THERMAL RESISTANCE

From junction to mounting base	$R_{th\ j-mb}$	=	0.5	°C/W
Thermal capacity (1 to 10 ms)			0.075	Ws/°C

1) Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_{amb} = 25^{\circ}\text{C}$ unless otherwise specifiedCollector cut-off current

$I_E = 0; -V_{CB} = 2 \text{ V}$	$-I_{CBO}$	typ.	100	μA
$I_E = 0; -V_{CB} = 80 \text{ V}$	$-I_{CBO}$	typ.	2	mA
$I_E = 0; -V_{CB} = 80 \text{ V}; T_j = 70^{\circ}\text{C}$	$-I_{CBO}$	<	15	mA

Emitter cut-off current

$I_C = 0; -V_{EB} = 60 \text{ V}$	$-I_{EBO}$	typ.	1	mA
		<	8	mA

Breakdown voltages

$-I_C = 1 \text{ A}; I_B = 0$	$-V_{(BR)CEO}$	>	55	V
$-I_C = 300 \text{ mA}; V_{BE} = 0$	$-V_{(BR)CES}$	>	70	V

Base-emitter voltage

$-I_C = 5 \text{ A}; -V_{CE} = 2 \text{ V}$	$-V_{BE}$	typ.	0.65	V
		<	0.9	V

Saturation voltages

$-I_C = 12 \text{ A}; -I_B = 2 \text{ A}$	$-V_{CEsat}$	typ.	0.3	V
		<	0.9	V

Emitter-base floating voltage

$I_E = 0; -V_{CB} = 80 \text{ V}$	$-V_{EBfl}$	<	1	V
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D.C. current gain

$-I_C = 5 \text{ A}; -V_{CE} = 2 \text{ V}$	h_{FE}	25 to 50
$-I_C = 12 \text{ A}; -V_{CE} = 2 \text{ V}$	h_{FE}	typ. 20

Cut-off frequency

$-I_C = 5 \text{ A}; -V_{CE} = 6 \text{ V}$	f_{hfe}	typ.	10	kHz
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Rise time

$-I_C = 12 \text{ A}; -I_B = 2 \text{ A}; -V_{CE} = 12 \text{ V}$	t_r	typ.	15	μs
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Fall time

$I_C = 0; +V_{BE} = 6 \text{ V}; R_{BE} = 10 \Omega$	t_f	typ.	15	μs
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STIMSON

GERMANIUM POWER TRANSISTOR

P-N-P alloy transistor in a TO-36 metal envelope with the collector connected to the mounting base.

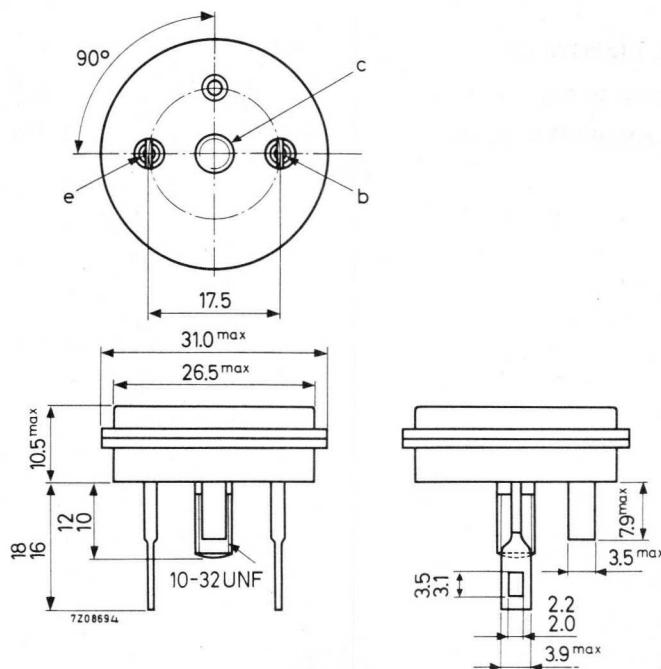
QUICK REFERENCE DATA

Collector-base voltage ($+V_{BE} = 1.5$ V)	$-V_{CBX}$	max. 40	V
Emitter-base voltage (open collector)	$-V_{EBO}$	max. 20	V
Emitter current (d.c.)	I_E	max. 15	A
Total power dissipation up to $T_{mb} = 25^\circ\text{C}$	P_{tot}	max. 150	W
Junction temperature	T_j	max. 100	$^\circ\text{C}$
D.C. current gain at $T_j = 25^\circ\text{C}$	h_{FE}	>	35
$-I_C = 5$ A; $-V_{CE} = 2$ V	f_{hfe}	typ.	10 kHz
Cut-off frequency $-I_C = 5$ A; $-V_{CE} = 6$ V			

MECHANICAL DATA

TO-36

Dimensions in mm



Diameter of hole in heatsink: max. 5.2 mm
Supplied with device: 56213

Torque on nut: min. 8 cm kg
max. 17 cm kg

RATINGS (Limiting values)¹⁾VoltagesCollector-base voltage ($+V_{BE} = 1.5$ V) $-V_{CBX}$ max. 40 VEmitter-base voltage (open collector) $-V_{EBO}$ max. 20 VCurrentsEmitter current (d.c.) I_E max. 15 ABase current (d.c.) $-I_B$ max. 4 APower dissipationTotal power dissipation up to $T_{mb} = 25$ °C P_{tot} max. 150 WTemperaturesStorage temperature T_{stg} -65 to +100 °CJunction temperature T_j max. 100 °C**THERMAL RESISTANCE**From junction to mounting base $R_{th\ j\ -mb}$ = 0.5 °C/W

Thermal capacity (1 to 10 ms) 0.075 Ws/°C

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; -V_{CB} = 2 \text{ V}$ $-I_{CBO}$ typ. 100 μA $I_E = 0; -V_{CB} = 40 \text{ V}$ $-I_{CBO}$ typ. 2 mA

< 8 mA

Emitter cut-off current $I_C = 0; -V_{EB} = 20 \text{ V}$ $-I_{EBO}$ typ. 1 mA

< 8 mA

Breakdown voltages $-I_C = 300 \text{ mA}; I_B = 0$ $-V_{BR}(\text{CEO})$ typ. 40 V $-I_C = 300 \text{ mA}; V_{BE} = 0$ $-V_{BR}(\text{CES})$ > 40 VBase-emitter voltage $-I_C = 5 \text{ A}; -V_{CE} = 2 \text{ V}$ $-V_{BE}$ typ. 0.65 VSaturation voltages $-I_C = 12 \text{ A}; -I_B = 2 \text{ A}$ $-V_{CE\text{sat}}$ typ. 0.3 VPunch through voltage V_{pt} > 40 VEmitter-base floating voltage $I_E = 0; -V_{CB} = 40 \text{ V}$ $-V_{EB\text{fl}}$ < 1 VD.C. current gain $-I_C = 5; -V_{CE} = 2 \text{ V}$ h_{FE} 35 to 70 $-I_C = 12; -V_{CE} = 2 \text{ V}$ h_{FE} typ. 25Cut-off frequency $-I_C = 5 \text{ A}; -V_{CE} = 6 \text{ V}$ f_{hfe} typ. 10 kHzRise time $-I_C = 12 \text{ A}; -I_B = 2 \text{ A}; -V_{CE} = 12 \text{ V}$ t_r typ. 15 μs Fall time $I_C = 0; +V_{BE} = 6 \text{ V}; R_{BE} = 10 \Omega$ t_f typ. 15 μs

GERMANIUM POWER TRANSISTOR

P-N-P alloy transistor in a TO-36 metal envelope with the collector connected to the mounting base.

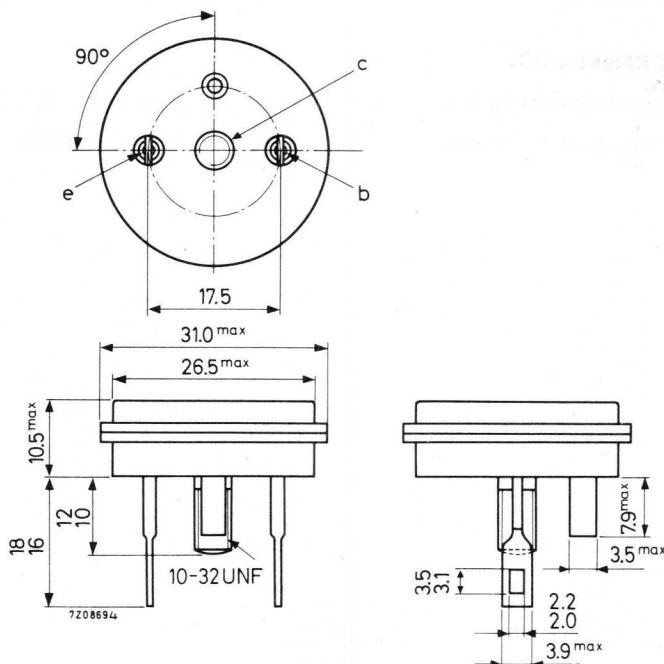
QUICK REFERENCE DATA

Collector-base voltage ($+V_{BE} = 1.5$ V)	$-V_{CBX}$	max.	40	V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	20	V
Emitter current (d.c.)	I_E	max.	15	A
Total power dissipation up to $T_{mb} = 25$ °C	P_{tot}	max.	150	W
Junction temperature	T_j	max.	100	°C
D.C. current gain at $T_j = 25$ °C	h_{FE}	>	20	
$-I_C = 5$ A; $-V_{CE} = 2$ V				
Cut-off frequency $-I_C = 5$ A; $-V_{CE} = 6$ V	f_{hfe}	typ.	10	kHz

MECHANICAL DATA

TO-36

Dimensions in mm



Diameter of hole in heatsink: max. 5.2 mm
Supplied with device: 56213

Torque on nut: min. 8 cm kg
max. 17 cm kg

RATINGS (Limiting values)¹⁾Voltages

Collector-base voltage ($+V_{BE} = 1.5$ V)	$-V_{CBX}$	max.	40	V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	20	V

Currents

Emitter current (d.c.)	I_E	max.	15	A
Base current (d.c.)	$-I_B$	max.	4	A

Power dissipation

Total power dissipation up to $T_{mb} = 25$ °C	P_{tot}	max.	150	W
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Temperatures

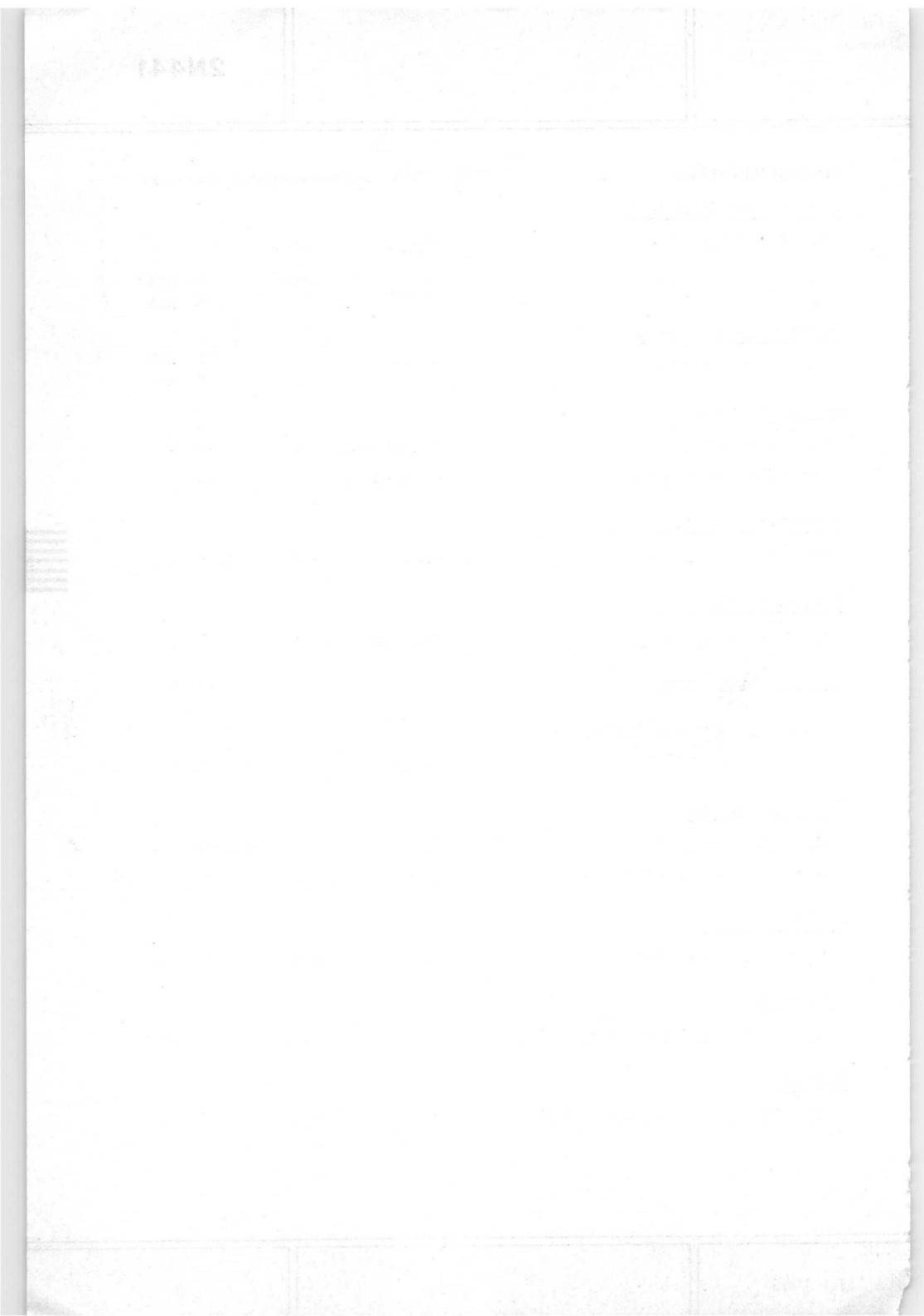
Storage temperature	T_{stg}	-65 to +100	°C
Junction temperature	T_j	max.	100 °C

THERMAL RESISTANCE

From junction to mounting base	$R_{th\ j-mb}$	=	0.5	°C/W
Thermal capacity (1 to 10 ms)			0.075	Ws/°C

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; -V_{CB} = 2 \text{ V}$ $-I_{CBO}$ typ. $100 \mu\text{A}$ $I_E = 0; -V_{CB} = 40 \text{ V}$ $-I_{CBO}$ typ. $< 2 \text{ mA}$
 $< 8 \text{ mA}$ Emitter cut-off current $I_C = 0; -V_{EB} = 20 \text{ V}$ $-I_{EBO}$ typ. $< 1 \text{ mA}$
 $< 8 \text{ mA}$ Breakdown voltages $-I_C = 300 \text{ mA}; I_B = 0$ $-V_{BR}(\text{CEO})$ typ. 40 V $-I_C = 300 \text{ mA}; V_{BE} = 0$ $-V_{BR}(\text{CES})$ > 40 V Base-emitter voltage $-I_C = 5 \text{ A}; -V_{CE} = 2 \text{ V}$ $-V_{BE}$ typ. 0.65 V Saturation voltages $-I_C = 12 \text{ A}; -I_B = 2 \text{ A}$ $-V_{CE\text{sat}}$ typ. 0.3 V Punch through voltage V_{pt} > 40 V Emitter-base floating voltage $I_E = 0; -V_{CB} = 40 \text{ V}$ $-V_{EB\text{fl}}$ < 1 V D.C. current gain $-I_C = 5 \text{ A}; -V_{CE} = 2 \text{ V}$ h_{FE} 20 to 40 $-I_C = 12 \text{ A}; -V_{CE} = 2 \text{ V}$ h_{FE} typ. 20Cut-off frequency $-I_C = 5 \text{ A}; -V_{CE} = 6 \text{ V}$ f_{hfe} typ. 10 kHz Rise time $-I_C = 12 \text{ A}; -I_B = 2 \text{ A}; -V_{CE} = 12 \text{ V}$ t_r typ. $15 \mu\text{s}$ Fall time $I_C = 0; +V_{BE} = 6 \text{ V}; R_{BE} = 10 \Omega$ t_f typ. $15 \mu\text{s}$



GERMANIUM POWER TRANSISTOR

P-N-P alloy transistor in a TO-36 metal envelope with the collector connected to the mounting base.

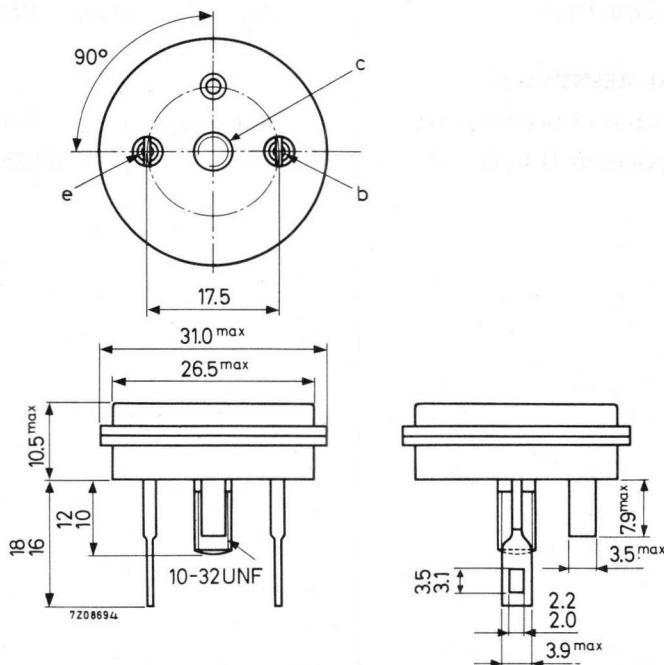
QUICK REFERENCE DATA

Collector-base voltage ($+V_{BE} = 1.5$ V)	$-V_{CBX}$	max. 100 V
Emitter-base voltage (open collector)	$-V_{EBO}$	max. 80 V
Emitter current (d.c.)	I_E	max. 15 A
Total power dissipation up to $T_{mb} = 25$ °C	P_{tot}	max. 150 W
Junction temperature	T_j	max. 100 °C
D.C. current gain at $T_j = 25$ °C $-I_C = 5$ A; $-V_{CE} = 2$ V	h_{FE}	> 25
Cut-off frequency $-I_C = 5$ A; $-V_{CE} = 6$ V	f_{hfe}	typ. 10 kHz

MECHANICAL DATA

TO-36

Dimensions in mm



Diameter of hole in heatsink: max. 5.2 mm
Supplied with device: 56213

Torque on nut: min. 8 cm kg
max. 17 cm kg

RATINGS (Limiting values) ¹⁾VoltagesCollector-base voltage ($+V_{BE} = 1.5$ V) $-V_{CBX}$ max. 100 VEmitter-base voltage (open collector) $-V_{EBO}$ max. 80 VCurrentsEmitter current (d.c.) I_E max. 15 ABase current (d.c.) $-I_B$ max. 4 APower dissipationTotal power dissipation up to $T_{mb} = 25$ °C P_{tot} max. 150 WTemperaturesStorage temperature T_{stg} -65 to +100 °CJunction temperature T_j max. 100 °C**THERMAL RESISTANCE**From junction to mounting base $R_{th\ j-mb}$ = 0.5 °C/W

Thermal capacity (1 to 10 ms) 0.075 Ws/°C

¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current

$I_E = 0; -V_{CB} = 2 \text{ V}$	$-I_{CBO}$	typ.	100	μA
$I_E = 0; -V_{CB} = 100 \text{ V}$	$-I_{CBO}$	<	8	mA
$I_E = 0; -V_{CB} = 100 \text{ V}; T_j = 70^\circ\text{C}$	$-I_{CBO}$	<	15	mA

Emitter cut-off current

$I_C = 0; -V_{EB} = 80 \text{ V}$	$-I_{EBO}$	typ.	1	mA
		<	8	mA

Breakdown voltages

$-I_C = 1 \text{ A}; I_B = 0$	$-V_{BR(\text{CEO})}$	>	65	V
$-I_C = 300 \text{ mA}; V_{BE} = 0$	$-V_{BR(\text{CES})}$	>	80	V

Base-emitter voltage

$-I_C = 5 \text{ A}; -V_{CE} = 2 \text{ V}$	$-V_{BE}$	typ.	0.65	V
		<	0.9	V

Saturation voltages

$-I_C = 12 \text{ A}; -I_B = 2 \text{ A}$	$-V_{CE\text{sat}}$	typ.	0.3	V
		<	0.7	V

Emitter-base floating voltage

$I_E = 0; -V_{CB} = 100 \text{ V}$	$-V_{EB\text{fl}}$	<	1	V
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D.C. current gain

$-I_C = 5 \text{ A}; -V_{CE} = 2 \text{ V}$	h_{FE}	25 to	50	
$-I_C = 12 \text{ A}; -V_{CE} = 2 \text{ V}$	h_{FE}	typ.	20	

Cut-off frequency

$-I_C = 5 \text{ A}; -V_{CE} = 6 \text{ V}$	f_{hfe}	typ.	10	kHz
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Rise time

$-I_C = 12 \text{ A}; -I_B = 2 \text{ A}; -V_{CE} = 12 \text{ V}$	t_r	typ.	15	μs
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Fall time

$I_C = 0; +V_{BE} = 6 \text{ V}; R_{BE} = 10 \Omega$	t_f	typ.	15	μs
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SA 800

1970-1971 - 1972-1973

INTERVIEW

QUESTION

ANSWER

INTERVIEW

ANSWER

SILICON DIFFUSED POWER TRANSISTOR

N-P-N transistor in a TO-3 metal envelope, intended for use in linear applications such as hi-fi amplifiers and signal processing circuits.
Matched pairs are available.

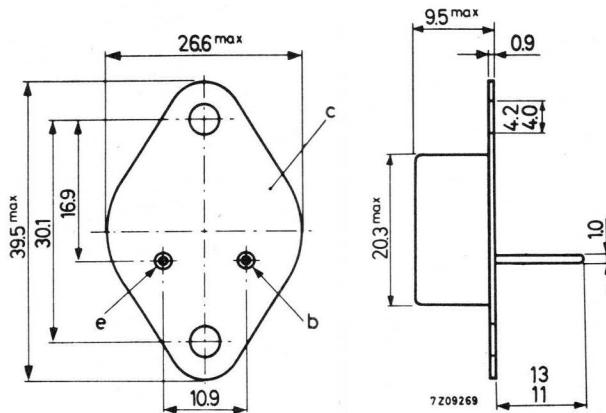
QUICK REFERENCE DATA

Collector-base voltage (open emitter)	V_{CBO}	max. 100 V
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	V_{CER}	max. 70 V
Collector current (d.c.)	I_C	max. 15 A
Total power dissipation up to $T_{mb} = 25^\circ\text{C}$	P_{tot}	max. 115 W
Junction temperature	T_j	max. 200 $^\circ\text{C}$
D.C. current gain $I_C = 4 \text{ A}; V_{CE} = 4 \text{ V}$	h_{FE}	20 to 70
Transition frequency at $f = 1 \text{ MHz}$ $I_C = 1 \text{ A}; V_{CE} = 4 \text{ V}$	f_T	> 0.8 MHz

MECHANICAL DATA

Dimensions in mm

Collector connected to envelope
TO-3



Accessories available: 56201e (for insulated mounting on a 2 mm heatsink)

RATINGS (Limiting values) ¹⁾Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	100	V
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	V_{CER}	max.	70	V
Emitter-base voltage (open collector)	V_{EBO}	max.	7	V

Currents

Collector current (d.c.)	I_C	max.	15	A
Base current (d.c.)	I_B	max.	7	A

Power dissipation

Total power dissipation up to $T_{mb} = 25^\circ\text{C}$	P_{tot}	max.	115	W
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Temperatures

Storage temperature	T_{stg}	-65 to +200	$^\circ\text{C}$
Junction temperature	T_j	max.	200 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to mounting base	$R_{th j-mb}$	=	1.5	$^\circ\text{C/W}$
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¹⁾ Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off currents

$I_B = 0$; $V_{CE} = 30\text{ V}$	I_{CEO}	<	1 mA
$-V_{BE} = 1.5\text{ V}$; $V_{CE} = 100\text{ V}$	I_{CEX}	<	5 mA
$-V_{BE} = 1.5\text{ V}$; $V_{CE} = 100\text{ V}$; $T_j = 150^\circ\text{C}$	I_{CEX}	<	10 mA

Emitter cut-off current

$I_C = 0$; $V_{EB} = 7\text{ V}$	I_{EBO}	<	5 mA
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Base-emitter voltage

$I_C = 4\text{ A}$; $V_{CE} = 4\text{ V}$	V_{BE}	<	1.8 V
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Collector-emitter saturation voltages

$I_C = 4\text{ A}$; $I_B = 0.4\text{ A}$	V_{CEsat}	<	1.1 V
$I_C = 10\text{ A}$; $I_B = 3.3\text{ A}$	V_{CEsat}	<	4 V

Sustaining voltages

$I_C = 0.2\text{ A}$; $I_B = 0$	$V_{CEO}sust$	>	60 V
$I_C = 0.2\text{ A}$; $R_{BE} = 100\Omega$	$V_{CER}sust$	>	70 V

D.C. current gain

$I_C = 4\text{ A}$; $V_{CE} = 4\text{ V}$	h_{FE}	20 to 70
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Transition frequency at $f = 1\text{ MHz}$

$I_C = 1\text{ A}$; $V_{CE} = 4\text{ V}$	f_T	>	0.8 MHz
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Small signal current gain at $f = 1\text{ kHz}$

$I_C = 1\text{ A}$; $V_{CE} = 4\text{ V}$	h_{fe}	>	15
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SILICON DIFFUSED POWER TRANSISTORS

N-P-N transistors in a TO-3 metal envelope, intended for use in a wide variety of linear power applications in audio amplifiers, converters, voltage regulators, power supplies, etc.

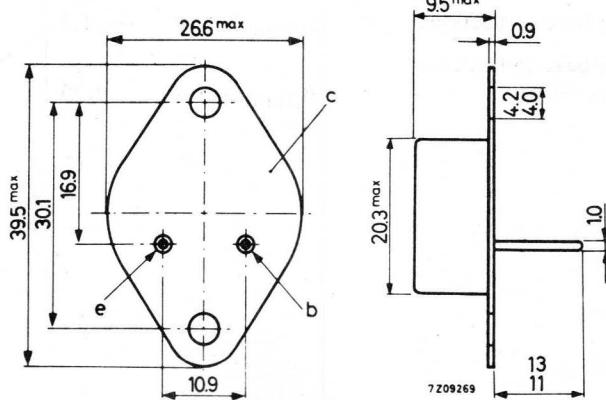
QUICK REFERENCE DATA

		2N3442	2N4347
Collector-base voltage (open emitter)	V _{CBO}	max. 160	140 V
Collector-emitter voltage (open base)	V _{CEO}	max. 140	120 V
Collector current (d.c.)	I _C	max. 10	5 A
Total power dissipation up to T _{mb} = 25°C	P _{tot}	max. 117	100 W
Junction temperature	T _j	max. 200	200 °C
D.C. current gain I _C = 3 A; V _{CE} = 4 V I _C = 4 A; V _{CE} = 4 V	h _{FE}	20 to 70	20 to 70

MECHANICAL DATA

Dimensions in mm

Collector connected to envelope
TO-3



Accessories supplied on request: 56201e

2N3442
2N4347

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

			2N3442	2N4347
Collector-base voltage (open emitter)	V_{CBO}	max.	160	140 V
Collector-emitter voltage (open base)	V_{CEO}	max.	140	120 V
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	V_{CER}	max.	150	130 V
Emitter-base voltage (open collector)	V_{EBO}	max.	7	7 V

Currents

Collector current (d.c.)	I_C	max.	10	5 A
Collector current (peak value)	I_{CM}	max.	15	10 A
Base current (d.c.)	I_B	max.	7	3 A

Power dissipation

Total power dissipation up to $T_{mb} = 25^\circ\text{C}$	P_{tot}	max.	117	100 W
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Temperatures

Storage temperature	T_{stg}	-65 to +200	-65 to +200	$^\circ\text{C}$
Junction temperature	T_j	max.	200	$^\circ\text{C}$

THERMAL RESISTANCE

From junction to mounting base	$R_{th j-mb}$	=	1.5	$1.75 \ ^\circ\text{C/W}$
From mounting base to heatsink	$R_{th mb-h}$	=	0.5	$0.5 \ ^\circ\text{C/W}$
From mounting base to heatsink with accessory 56201e	$R_{th mb-h}$	=	0.75	$0.75 \ ^\circ\text{C/W}$

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off currents

			2N3442	2N4347
$I_E = 0; V_{CB} = 140 \text{ V}$	I_{CBO}	typ. <	50 1	50 1
$-V_{BE} = 1.5 \text{ V}; V_{CE} = 140 \text{ V}$	I_{CEX}	typ. <	5 1	5 1
$-V_{BE} = 1.5 \text{ V}; V_{CE} = 140 \text{ V}; T_{mb} = 150^\circ\text{C}$	I_{CEX}	typ. <	0.1 10	mA mA
$-V_{BE} = 1.5 \text{ V}; V_{CE} = 120 \text{ V}$	I_{CEX}	typ. <	1 2	5 2
$-V_{BE} = 1.5 \text{ V}; V_{CE} = 120 \text{ V}; T_{mb} = 150^\circ\text{C}$	I_{CEX}	typ. <		0.1 10

Emitter cut-off current

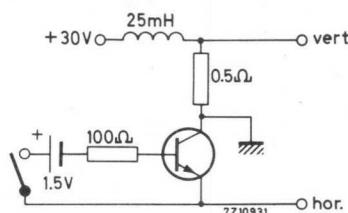
$I_C = 0; V_{EB} = 7 \text{ V}$	I_{EBO}	typ. <	1 5	1 5	μA mA
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Collector-emitter breakdown voltage

$I_C = 0.1 \text{ A}; R_{BE} = 100 \Omega$	$V_{(BR)CER}$	>	150	130	V
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Collector-emitter sustaining voltages

$I_B = 0; I_C = 0.2 \text{ to } 3.0 \text{ A}$	$V_{CEO(\text{sust})}$	>	140	120	V
$-V_{BE} = 1.5 \text{ V}; I_C = 0.1 \text{ to } 1.5 \text{ A}$	$V_{CEX(\text{sust})}$	>	160	140	V



Base-emitter voltage ¹⁾

			2N3442	2N4347
$I_C = 2 \text{ A}; V_{CE} = 4 \text{ V}$	V_{BE}	typ. <	0.95 2.0	V V
$I_C = 3 \text{ A}; V_{CE} = 4 \text{ V}$	V_{BE}	typ. <	1.15 1.7	V V
$I_C = 5 \text{ A}; V_{CE} = 4 \text{ V}$	V_{BE}	typ. <		1.55 4.0
$I_C = 10 \text{ A}; V_{CE} = 4 \text{ V}$	V_{BE}	typ. <	2.8 5.7	V V

¹⁾ $t_p = 10 \text{ ms}$

2N3442
2N4347

CHARACTERISTICS (continued)

$T_j = 25^\circ\text{C}$ unless otherwise specified

Saturation voltages ¹⁾

$I_C = 2 \text{ A}; I_B = 0.2 \text{ A}$
 $I_C = 3 \text{ A}; I_B = 0.3 \text{ A}$
 $I_C = 5 \text{ A}; I_B = 1.0 \text{ A}$
 $I_C = 10 \text{ A}; I_B = 2.0 \text{ A}$

	2N3442	2N4347
V_{CEsat}	<	1 V
V_{CEsat}	<	1 V
V_{CEsat}	<	5 V
V_{CEsat}	<	5 V

D.C. current gain ¹⁾

$I_C = 2 \text{ A}; V_{CE} = 4 \text{ V}$

h_{FE}	typ.	35
		20 to 70

$I_C = 3 \text{ A}; V_{CE} = 4 \text{ V}$

h_{FE}	typ.	25
		20 to 70

$I_C = 5 \text{ A}; V_{CE} = 4 \text{ V}$

h_{FE}	typ.	15
	>	7.5

$I_C = 10 \text{ A}; V_{CE} = 4 \text{ V}$

h_{FE}	typ.	10
	>	7.5

Small signal current gain

$I_C = 2 \text{ A}; V_{CE} = 4 \text{ V}$

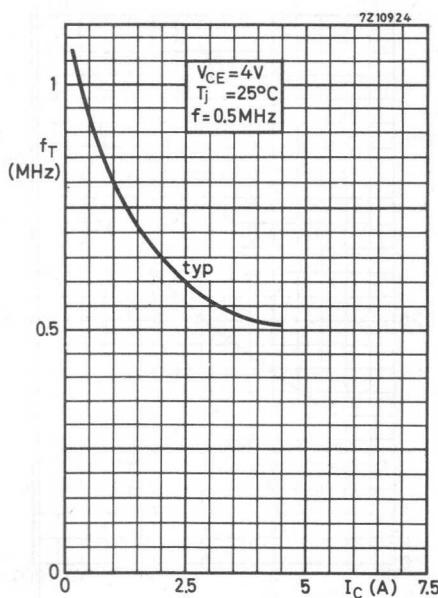
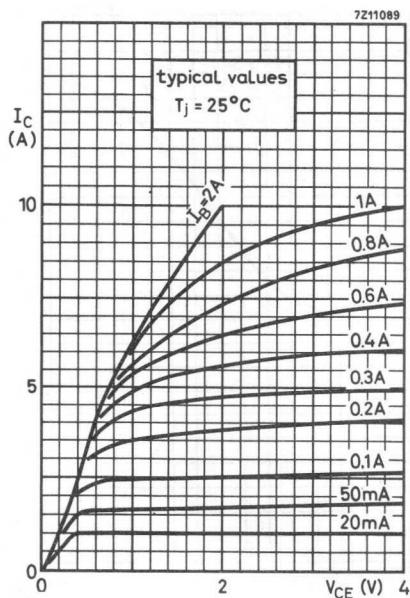
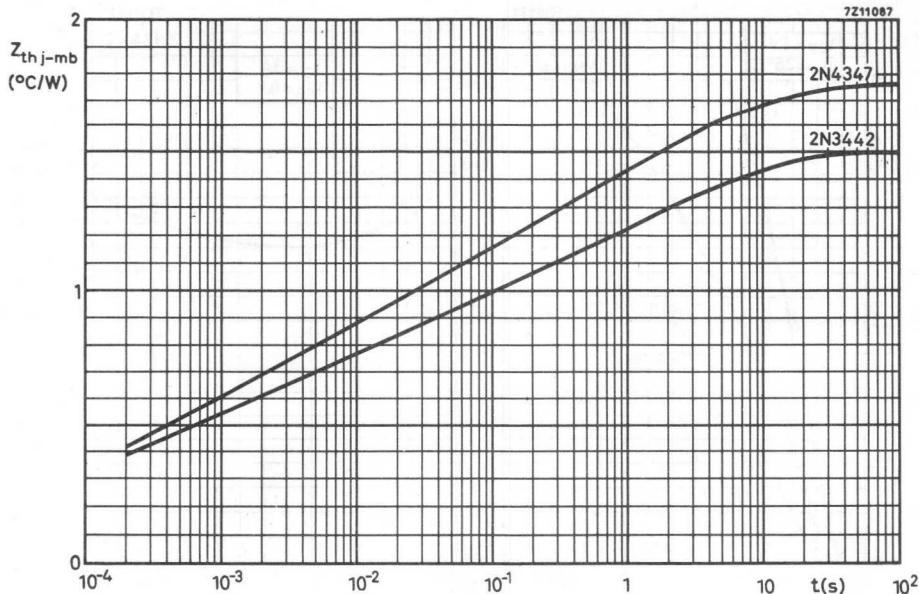
h_{fe}	typ.	9.5
	>	2

$f = 1 \text{ kHz}$

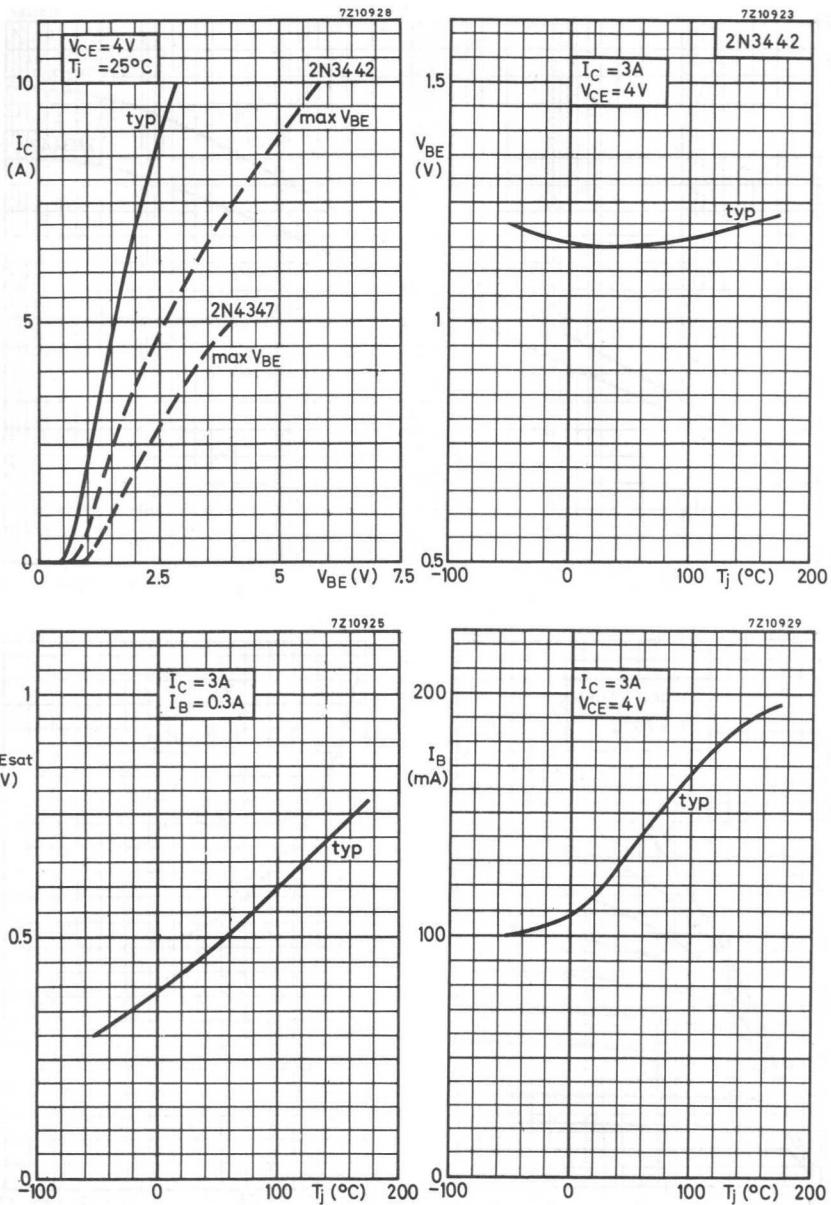
h_{fe}	typ.	18
		12 to 72

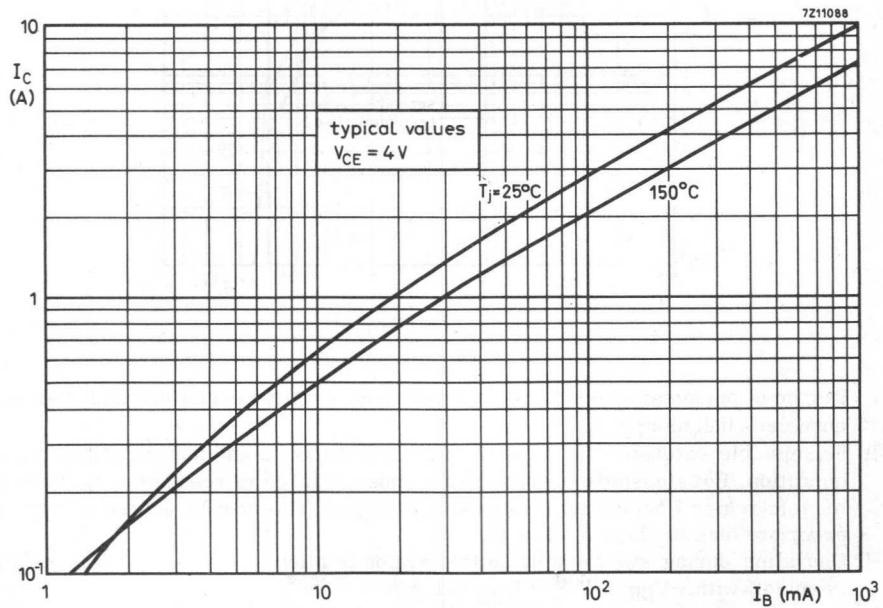
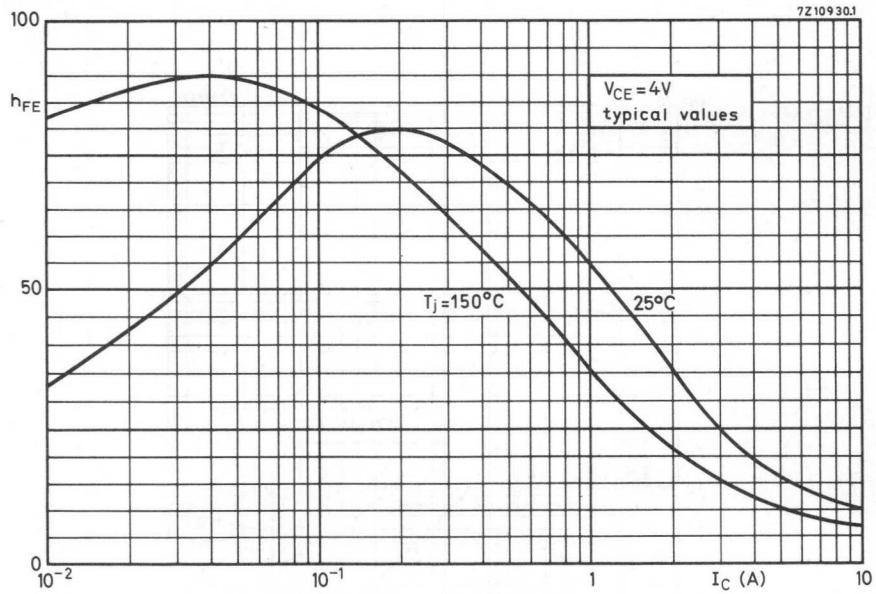
¹⁾ $t_p = 10 \text{ ms}$

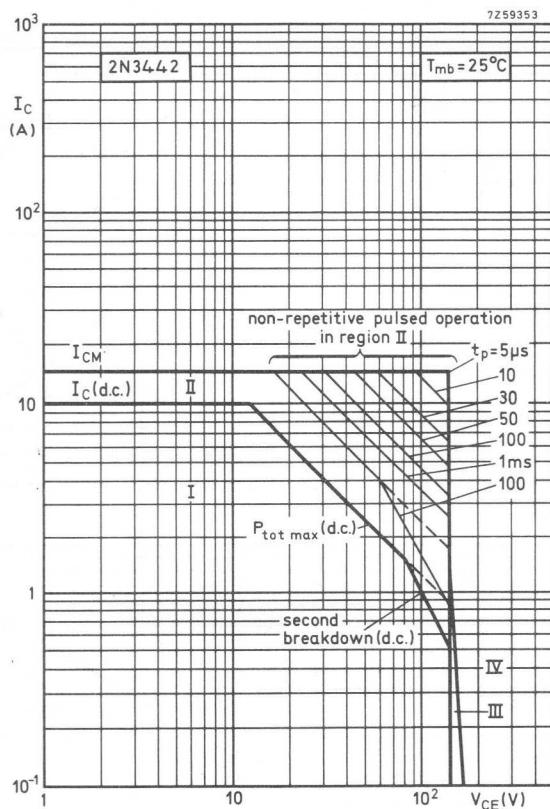
2N3442
2N4347



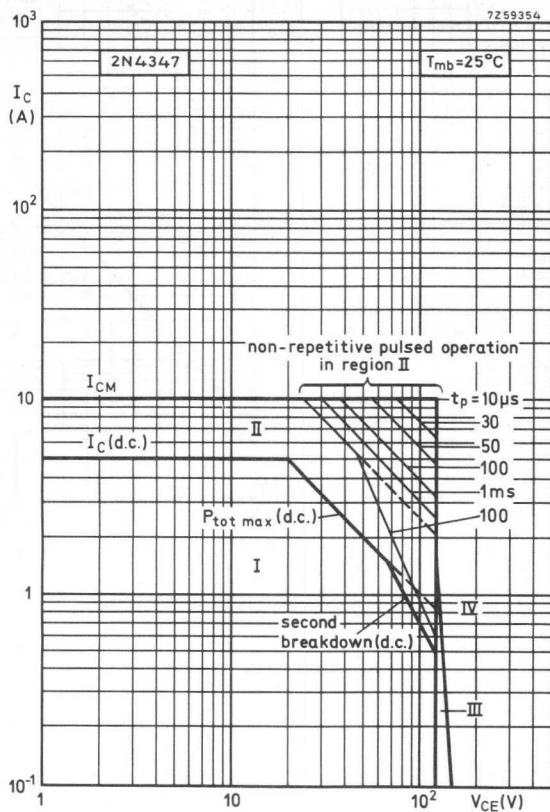
2N3442
2N4347





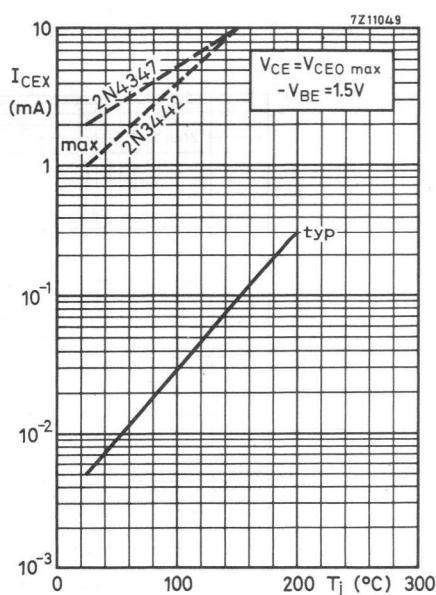
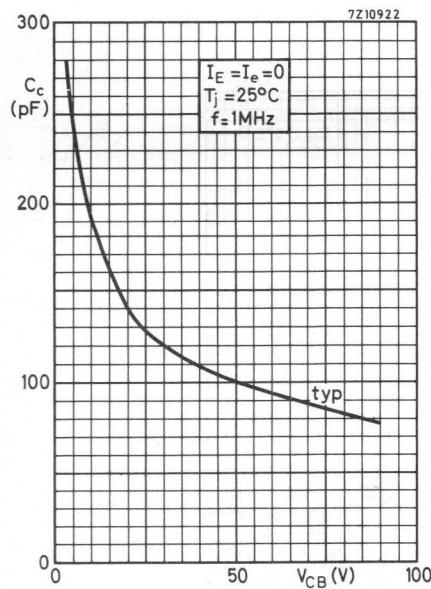


- I Region of permissible operation under all base-emitter conditions and at all frequencies, including d.c.
- II Permissible extension for repetitive pulsed operation and non-repetitive pulsed operation. For sinusoidal operation care must be taken to reduce the d.c. adjustment to region I before removing the a.c. signal. This may be achieved by an appropriate bias in class A, B or C.
- III Operation during switching off in this region is allowed, provided the transistor is cut-off with $-V_{BE} \leq 1.5\text{ V}$; $I_{CM} < 1.5\text{ A}$.
- IV Operation during switching off is allowed provided the transistor is cut-off with $-V_{BE} \leq 1.5\text{ V}$ and the transient energy does not exceed 30 mW.



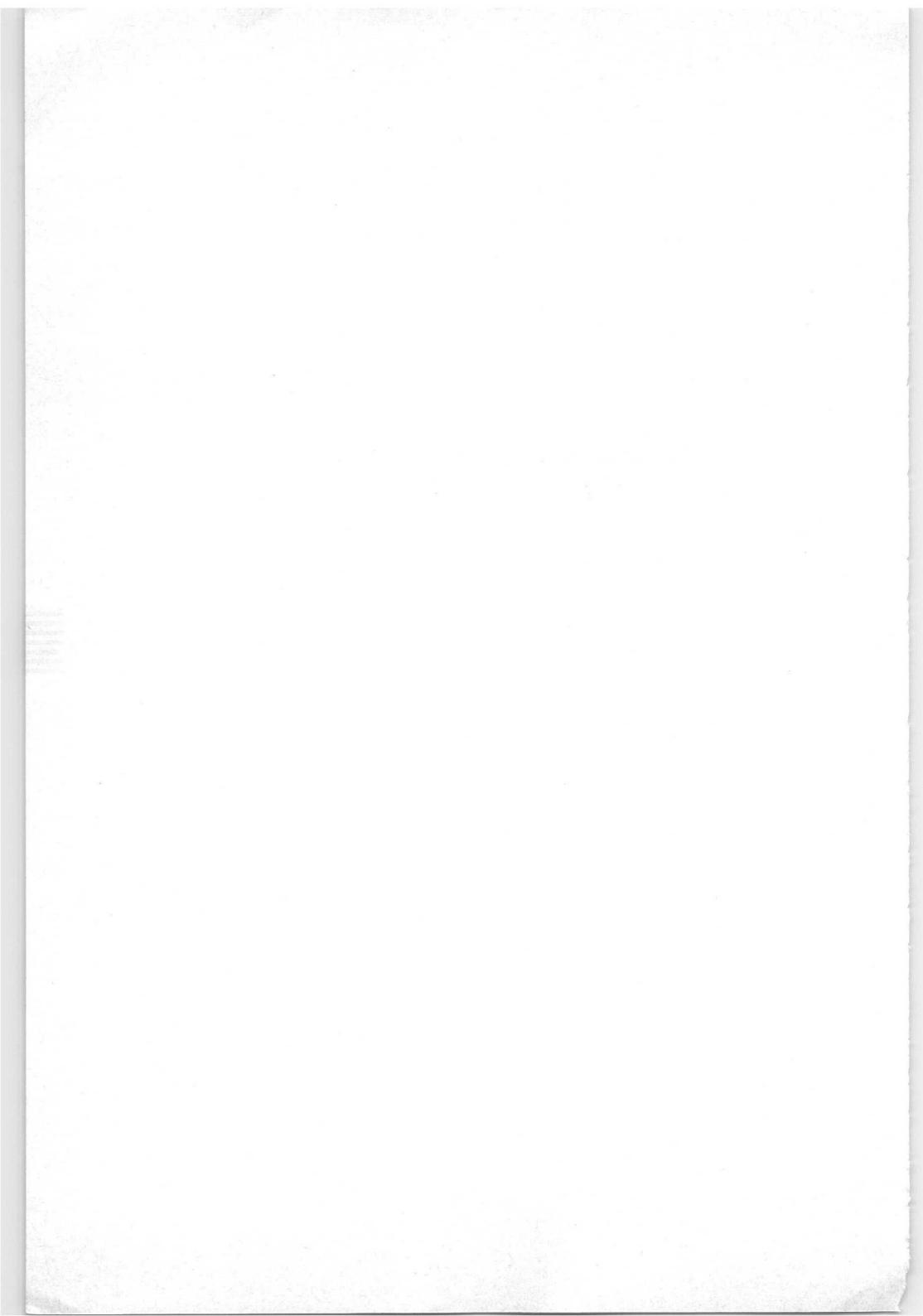
- I Region of permissible operation under all base-emitter conditions and at all frequencies, including d.c.
- II Permissible extension for repetitive pulsed operation and **non-repetitive** pulsed operation. For sinusoidal operation care must be taken to reduce the d.c. adjustment to region I before removing the a.c. signal. This may be achieved by an appropriate bias in class A, B or C.
- III Operation during switching off in this region is allowed, provided the transistor is cut-off with $-V_{BE} \leq 1.5\text{ V}$; $I_{CM} < 1.5\text{ A}$.
- IV Operation during switching off is allowed provided the transistor is cut-off with $-V_{BE} \leq 1.5\text{ V}$ and the transient energy does not exceed 30 mWs.

2N3442
2N4347



Deflection transistors





HIGH VOLTAGE SILICON POWER TRANSISTOR

N-P-N transistor in a TO-3 metal envelope with the collector connected to the case. It is intended for use in vertical deflection circuits of television receivers.

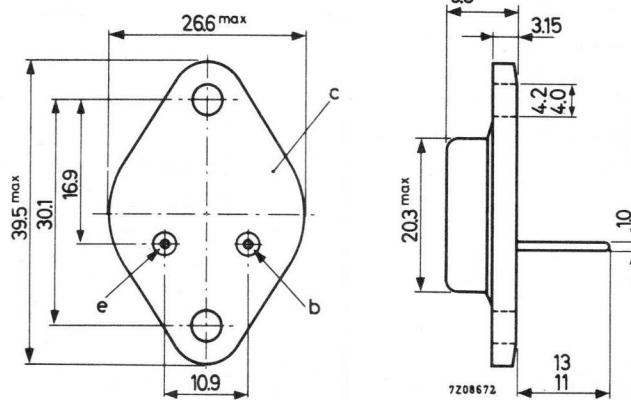
QUICK REFERENCE DATA

Collector-base voltage (open emitter) (peak value)	V_{CBOM}	max. 800	V
Collector-emitter voltage ($R_{BE} \leq 500 \Omega$) (peak value)	V_{CERM}	max. 800	V
Collector current (peak value)	I_{CM}	max. 250	mA
Total power dissipation up to $T_{mb} = 95^\circ\text{C}$	P_{tot}	max. 8	W
Junction temperature	T_j	max. 135	$^\circ\text{C}$
Transition frequency at $f = 5 \text{ MHz}$ $I_C = 50 \text{ mA}; V_{CE} = 5 \text{ V}$	f_T	typ. 12	MHz

MECHANICAL DATA

Dimensions in mm

Collector connected to case
TO-3



Accessories available: 56201e

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter) (peak value)	V_{CBOM}	max.	800	V
→ Collector-base voltage (open emitter) (d.c.)	V_{CBO}	max.	250	V
Collector-emitter voltage ($R_{BE} \leq 500 \Omega$) (peak value)	V_{CERM}	max.	800	V
→ Collector-emitter voltage ($R_{BE} \leq 500 \Omega$) (d.c.)	V_{CER}	max.	250	V
Emitter-base voltage (open collector)	V_{EBO}	max.	5	V

Currents

Collector current (d.c.)	I_C	max.	250	mA
Collector current (peak value)	I_{CM}	max.	250	mA
Emitter current (d.c.)	$-I_E$	max.	250	mA
Emitter current (peak value)	$-I_{EM}$	max.	250	mA

Power dissipation

Total power dissipation up to $T_{mb} = 95^\circ\text{C}$	P_{tot}	max.	8	W
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Temperatures

Storage temperature	T_{stg}	-65 to +135	$^\circ\text{C}$
Junction temperature	T_j	max.	135 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to mounting base	$R_{th j-mb}$	=	5	$^\circ\text{C/W}$
From mounting base to heatsink with accessory 56201e	$R_{th mb-h}$	=	0.75	$^\circ\text{C/W}$
with lead washer only	$R_{th mb-h}$	=	0.5	$^\circ\text{C/W}$

SILICON PLANAR TRANSISTOR

N-P-N transistor in a TO-39 metal envelope with the collector connected to the case. The BFW45 is primarily intended for the output stage of the horizontal deflection amplifier in wide band oscilloscopes.

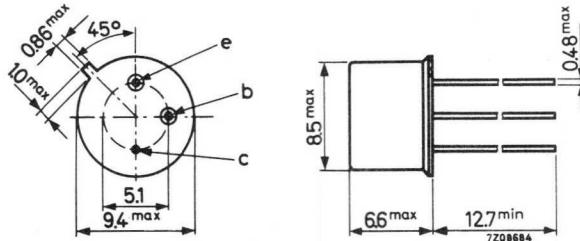
QUICK REFERENCE DATA		
Collector-base voltage (open emitter)	V _{CBO}	max. 165 V
Collector-emitter voltage (open base)	V _{CEO}	max. 130 V
Collector current (peak value)	I _{CM}	max. 100 mA
Total power dissipation up to T _{mb} = 150 °C	P _{tot}	max. 2.5 W
Junction temperature	T _j	max. 200 °C
D.C. current gain I _C = 50 mA; V _{CE} = 20 V	h _{FE}	20 to 120
Transition frequency at f = 100 MHz I _C = 10 mA; V _{CE} = 10 V	f _T	> 80 MHz typ. 120 MHz
Feedback capacitance at f = 1 MHz I _C = 10 mA; V _{CE} = 20 V	-C _{re}	< 3.5 pF

MECHANICAL DATA

Dimensions in mm

TO-39

Collector connected to case



Accessories available: 56218, 56245, 56265 (see page 8)

RATINGS (Limiting values) 1)Voltages

Collector-base voltage (open emitter)	V_{CBO}	max.	165	V
Collector-emitter voltage (open base)	V_{CEO}	max.	130	V
Emitter-base voltage (open collector)	V_{EBO}	max.	5	V

Currents

Collector current (d.c.)	I_C	max.	50	mA
Collector current (peak value)	I_{CM}	max.	100	mA

Power dissipation

Total power dissipation up to $T_{amb} = 40^{\circ}\text{C}$	P_{tot}	max.	0.8	W
$T_{mb} = 150^{\circ}\text{C}$	P_{tot}	max.	2.5	W

Temperatures

Storage temperature	T_{stg}	-55 to +200	$^{\circ}\text{C}$
Junction temperature	T_j	max.	200 $^{\circ}\text{C}$

THERMAL RESISTANCE

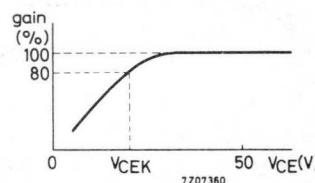
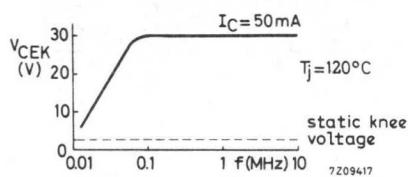
From junction to ambient in free air	$R_{th j-a}$	=	200	$^{\circ}\text{C/W}$
From junction to mounting base	$R_{th j-mb}$	=	20	$^{\circ}\text{C/W}^2$)
From junction to case	$R_{th j-c}$	=	25	$^{\circ}\text{C/W}^2$)

1) Limiting values according to the Absolute Maximum System as defined in IEC publication 134.

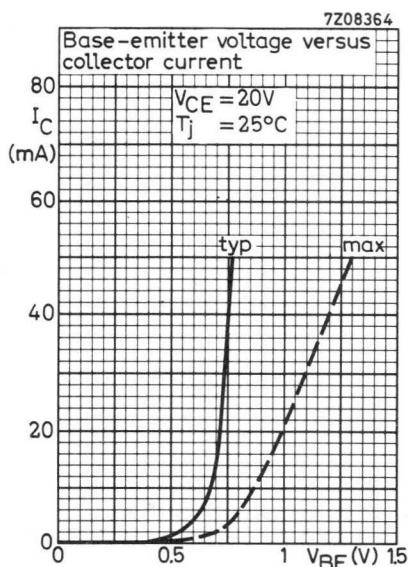
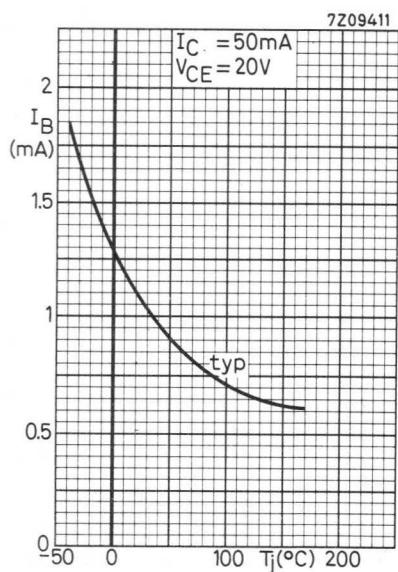
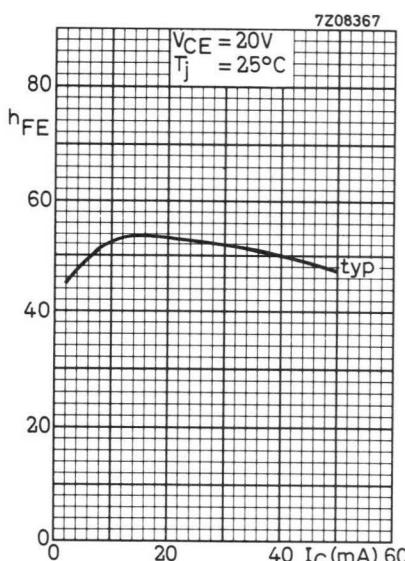
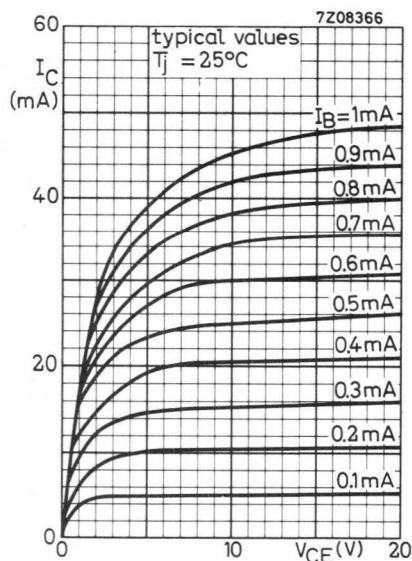
2) See also page 8.

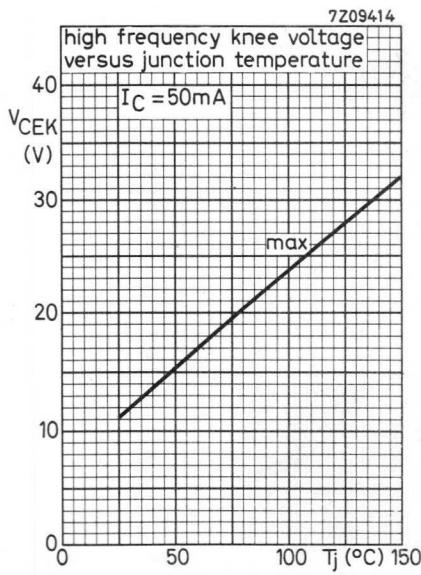
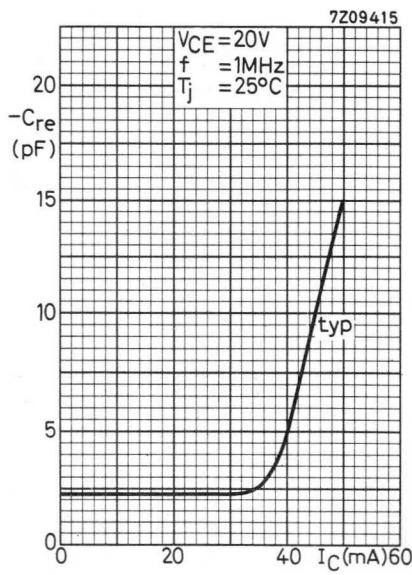
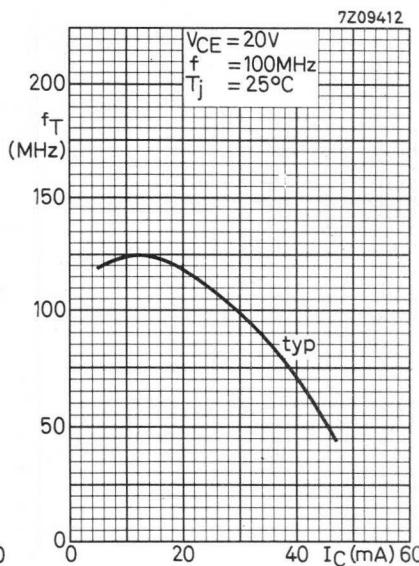
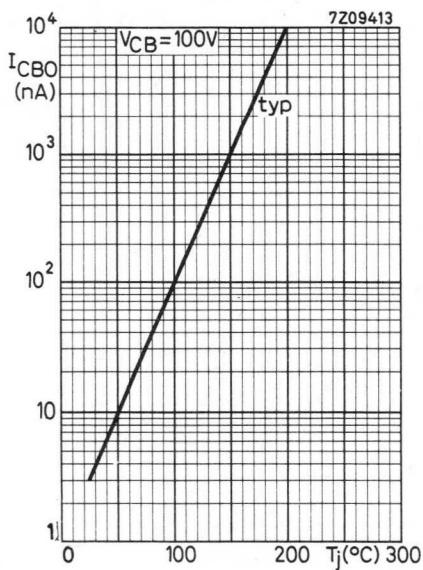
CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedCollector cut-off current $I_E = 0; V_{CB} = 100 \text{ V}$ $I_{CBO} < 100 \text{ nA}$ $I_E = 0; V_{CB} = 100 \text{ V}; T_j = 150^\circ\text{C}$ $I_{CBO} < 10 \mu\text{A}$ Base-emitter voltage¹⁾ $I_C = 50 \text{ mA}; V_{CE} = 20 \text{ V}$ $V_{BE} < 1.3 \text{ V}$ High frequency knee voltage at $T_j = 120^\circ\text{C}$ $I_C = 50 \text{ mA}$ $V_{CEK} < 27 \text{ V}$

The high frequency knee voltage of a transistor is that value of the collector-emitter voltage at which the small signal gain, measured in a practical circuit, has dropped to 80% of the gain at $V_{CE} = 50 \text{ V}$. A further decrease of the collector-emitter voltage results in a rapid increase of the distortion of the signal.

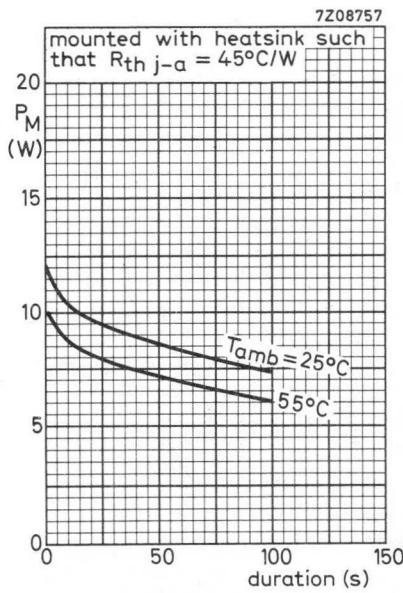
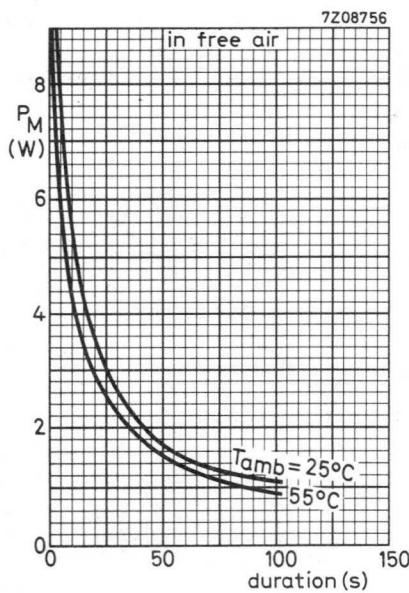
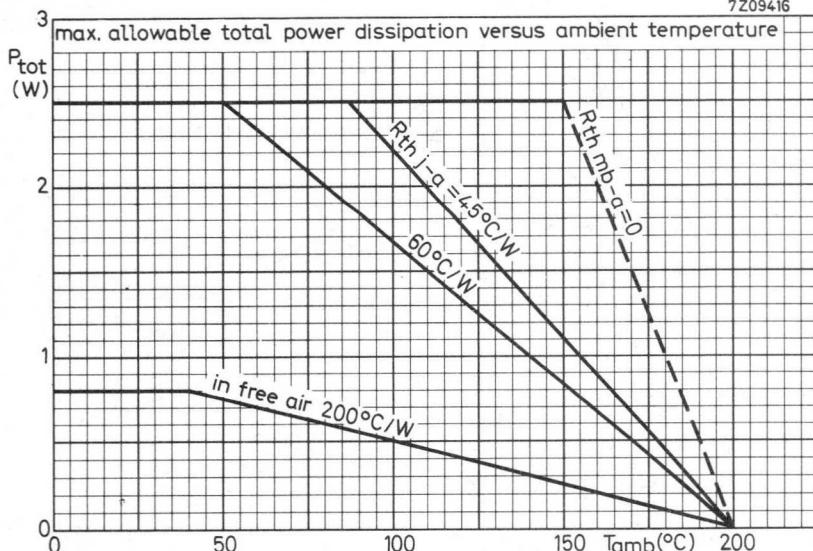
Collector-emitter saturation voltage $I_C = 10 \text{ mA}; I_B = 1 \text{ mA}$ $V_{CEsat} < 3 \text{ V}$ $I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$ $V_{CEsat} < 10 \text{ V}$ D.C. current gain $I_C = 50 \text{ mA}; V_{CE} = 20 \text{ V}$ $h_{FE} \text{ 20 to } 120$ Feedback capacitance at $f = 1 \text{ MHz}$ $I_C = 10 \text{ mA}; V_{CE} = 20 \text{ V}$ $-C_{re} < 3.5 \text{ pF}$ Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 20 \text{ V}$ $C_c < 6 \text{ pF}$ Transition frequency at $f = 100 \text{ MHz}$ $I_C = 10 \text{ mA}; V_{CE} = 10 \text{ V}$ $f_T > 80 \text{ MHz}$
typ. 120 MHz

¹⁾ V_{BE} decreases by about $1.6 \text{ mV}/^\circ\text{C}$ with increasing temperature.





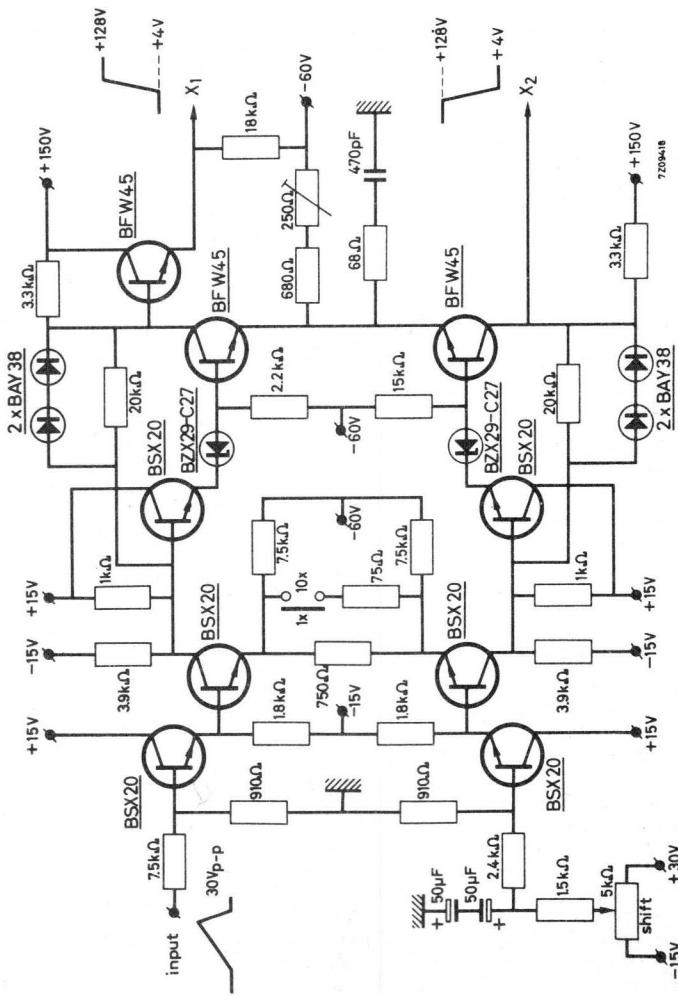
7209416



maximum allowable peak power dissipation versus duration

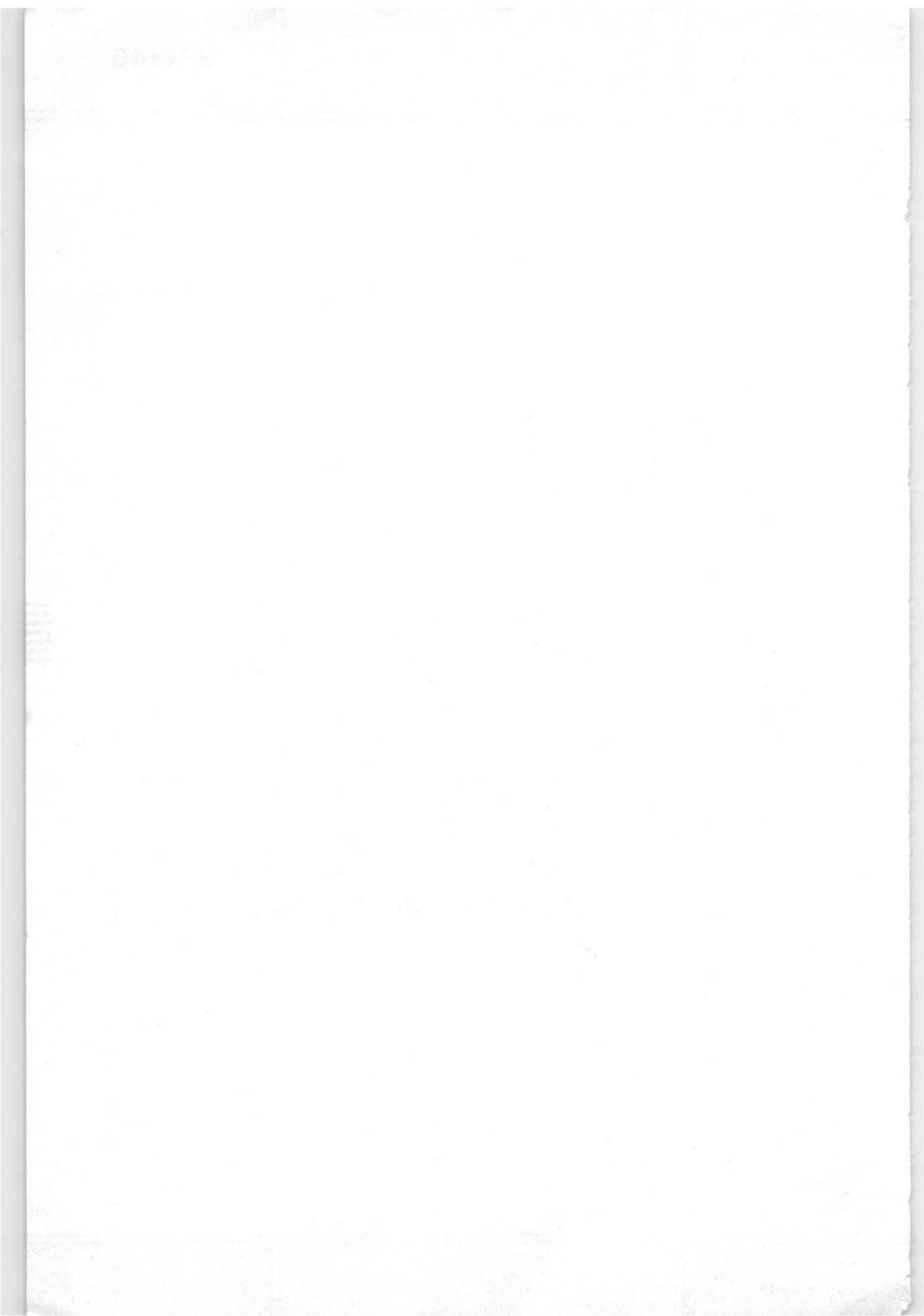
APPLICATION INFORMATION

Horizontal deflection amplifier for wide band oscilloscopes.



Total effective plate capacitance of the tube: 10 pF
 Horizontal sensitivity of the tube: 18 V/cm
 Performance

Maximum sweep rate of the amplifier: 5 ns/cm
 7209418



HIGH VOLTAGE SILICON POWER TRANSISTOR

N-P-N transistor in a metal envelope intended for use in horizontal deflection circuits of television receivers.

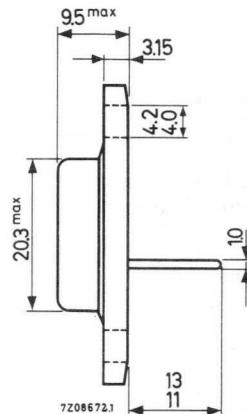
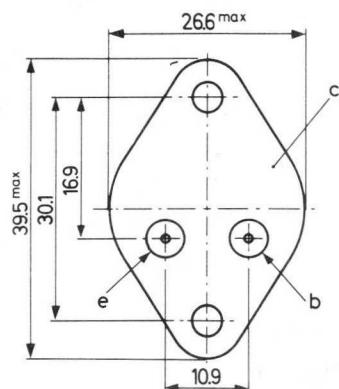
QUICK REFERENCE DATA

Collector-base voltage (peak value)	V_{CBOM}	max.	1500	V
Collector-emitter voltage (peak value) $R_{BE} \leq 100 \Omega$	V_{CERM}	max.	1500	V
Collector current (peak value)	I_{CM}	max.	2.5	A
Total power dissipation up to $T_{mb} = 90^\circ\text{C}$	P_{tot}	max.	10	W
Collector-emitter saturation voltage $I_C = 2.5 \text{ A}; I_B = 1.5 \text{ A}$	V_{CEsat}	<	5	V
Fall time (with stabilized power supply) $I_{CMnom} = 2.0 \text{ A}; I_B(\text{end})_{nom} = 1.5 \text{ A}$	t_f	typ.	0.75	μs

MECHANICAL DATA

Dimensions in mm

Collector connected to case



Accessories available: 56201e

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter) V_{CBO} max. 750 V

Collector-base voltage (open emitter) peak value V_{CBOM} max. 1500 V

Collector-emitter voltage

$R_{BE} \leq 100 \Omega$ V_{CER} max. 750 V

Collector-emitter voltage (peak value)

$R_{BE} \leq 100 \Omega$, see also safe operation area

→ $I_C = 7.5 \text{ mA}$ V_{CERM} max. 1500 V

Currents

Emitter current (d.c. and peak value) $-I_E, -I_{EM}$ max. 4.0 A

Collector current (d.c. and peak value) I_C, I_{CM} max. 2.5 A

Base current (peak value) I_{BM} max. 2.5 A

Reverse base current (d.c. or average over any 20 ms period) $-I_{BAV}$ max. 100 mA

Reverse base current (peak value) $-I_{BM}$ max. 1.5 A¹⁾

Power dissipation

Total power dissipation up to $T_{mb} = 90^\circ\text{C}$ P_{tot} max. 10 W

Temperatures

Storage temperature T_{stg} -65 to +115 °C

Junction temperature T_j max. 115 °C

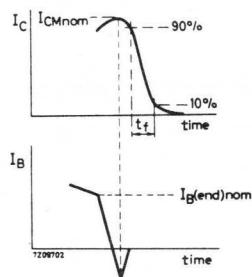
THERMAL RESISTANCE

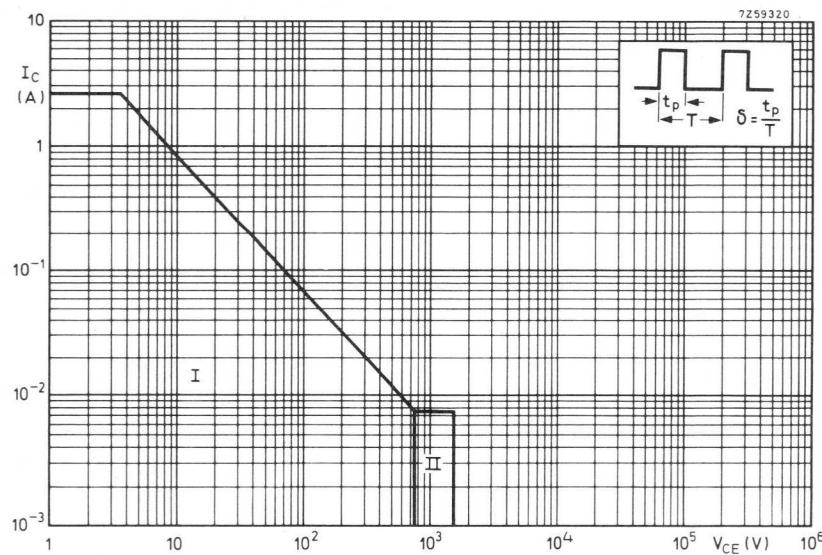
From junction to mounting base $R_{th j-mb}$ 2.5 °C/W

From mounting base to heatsink with mica washer and lead washer (56201e) $R_{th mb-h}$ 0.75 °C/W

with lead washer only $R_{th mb-h}$ 0.5 °C/W

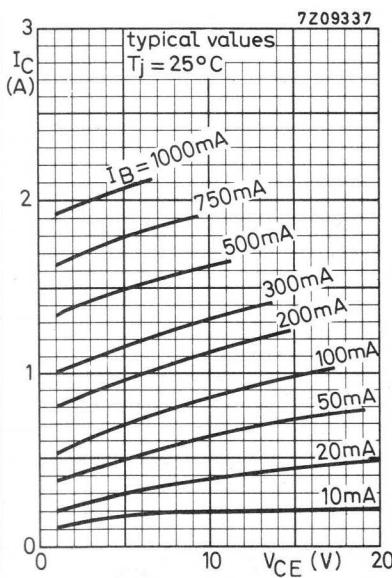
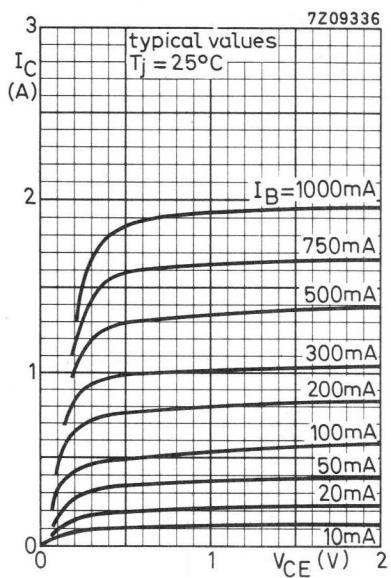
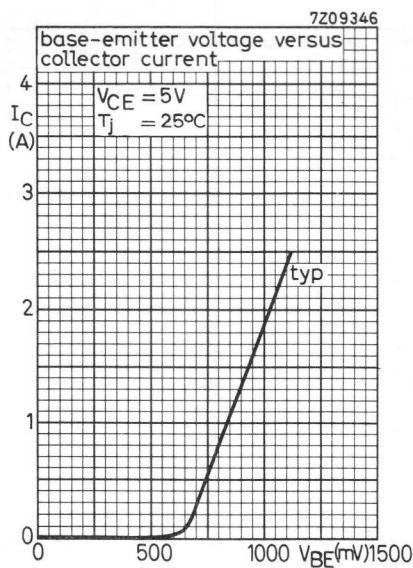
¹⁾ Turn off current; e.g. in horizontal deflection circuits.

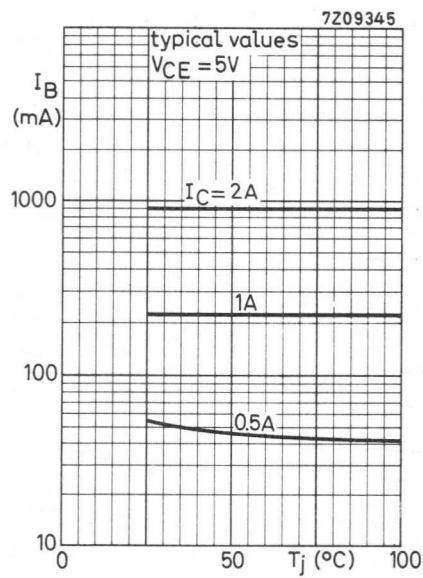
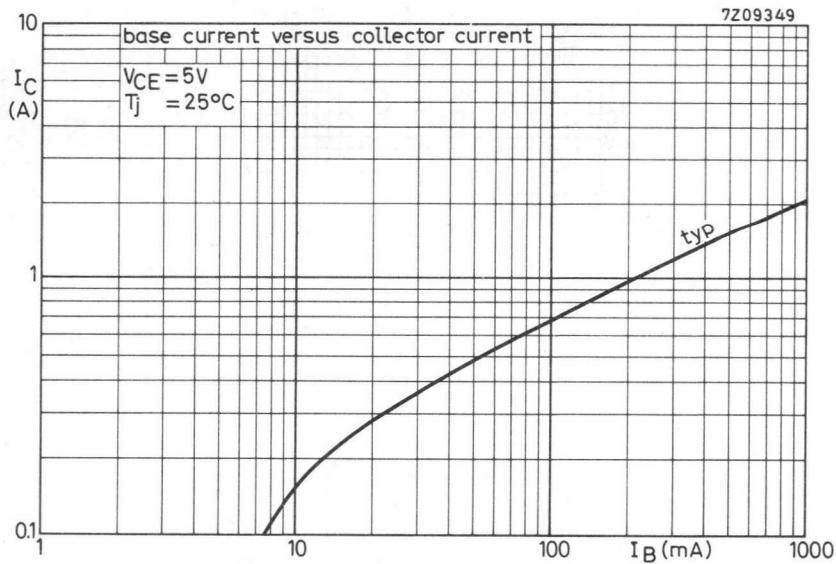
CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedEmitter-base voltage (open collector) $I_C = 0; I_E = 100 \text{ mA}$ $+V_{EBO} > 5 \text{ V}$ Saturation voltages $I_C = 2.5 \text{ A}; I_B = 1.5 \text{ A}$ $V_{CEsat} < 5 \text{ V}$
 $V_{BEsat} < 1.5 \text{ V}$ Transition frequency at $f = 5 \text{ MHz}$ $I_C = 0.1 \text{ A}; V_{CE} = 5 \text{ V}$ $f_T \text{ typ. } 7.5 \text{ MHz}$ Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 10 \text{ V}$ $C_C \text{ typ. } 65 \text{ pF}$ Fall time (with stabilized power supply) $I_{CMnom} = 2.0 \text{ A}; I_{B(end)nom} = 1.5 \text{ A}; L_B = 10 \mu\text{H}$ $t_f \text{ typ. } 0.75 \mu\text{s}$ 

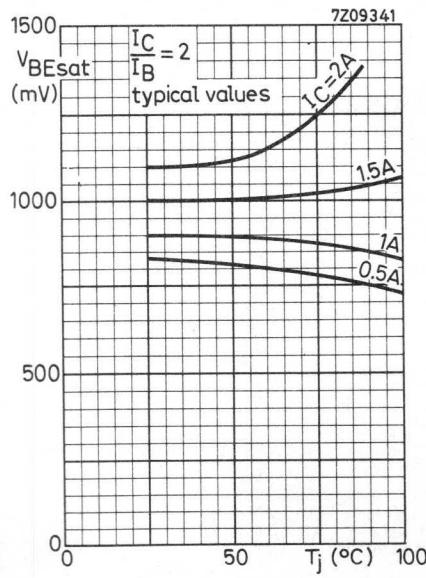
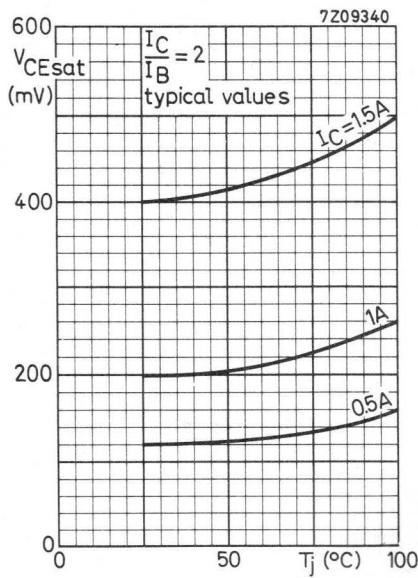
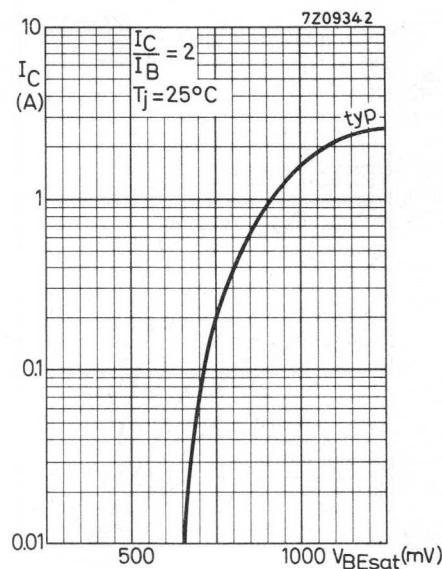
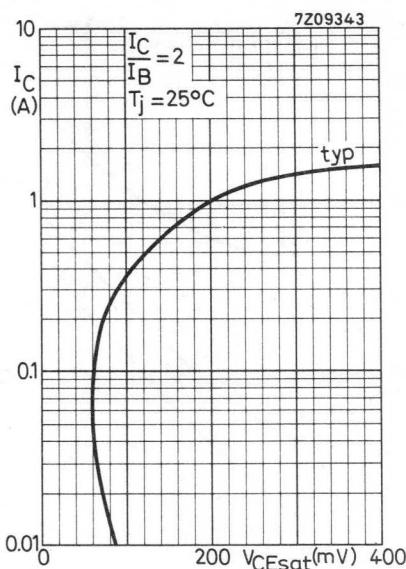


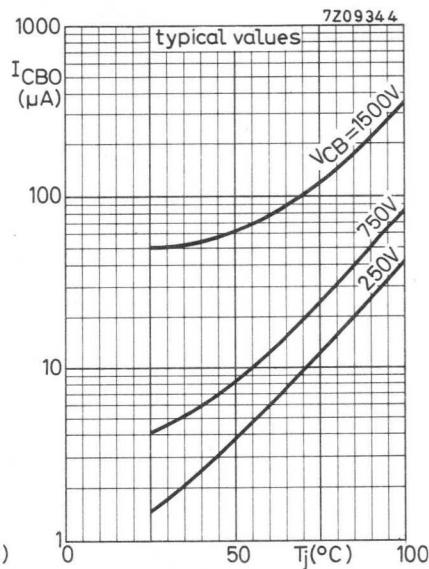
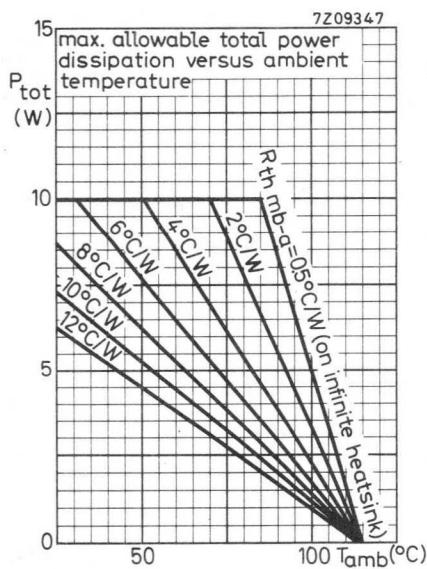
I Region of permissible operation under all base-emitter conditions.

II Additional region of permissible operation for repetitive pulse conditions, provided $R_{BE} \leq 100 \Omega$; $t_p \leq 20 \mu s$; $\delta \leq 0.25$.







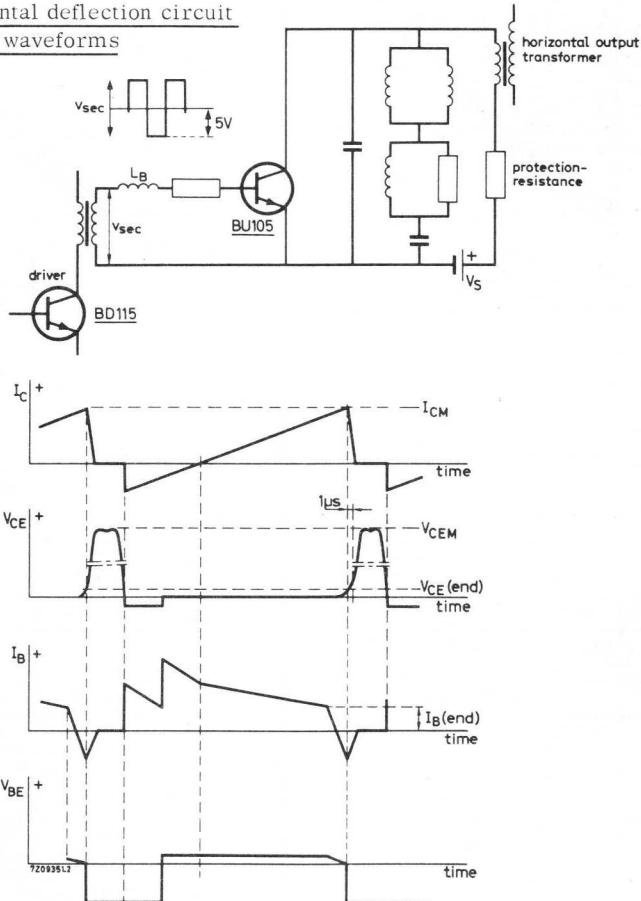


APPLICATION INFORMATION

Safety margins on I_{CM} and V_{CEM}

Because of component tolerances and supply voltage variations the values of I_{CM} and V_{CEM} encountered in a practical horizontal deflection output stage will usually differ from those of a nominal circuit under nominal conditions; the difference can be as much as 25% if a stabilized supply is used, or 35% for an unstabilized supply. For this reason, the nominal values of I_{CM} and V_{CEM} should be at least 25% (35% if the supply is unstabilized) below the absolute maximum ratings.

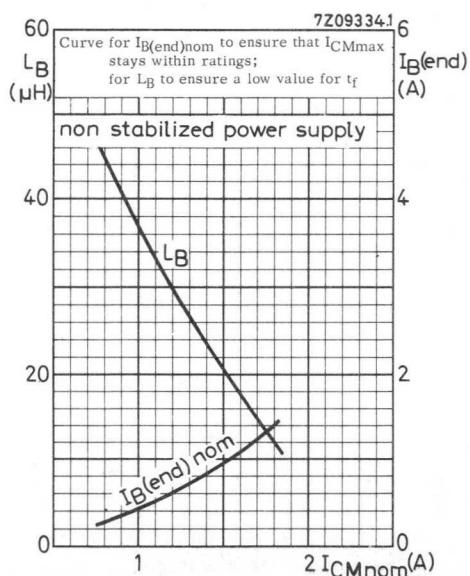
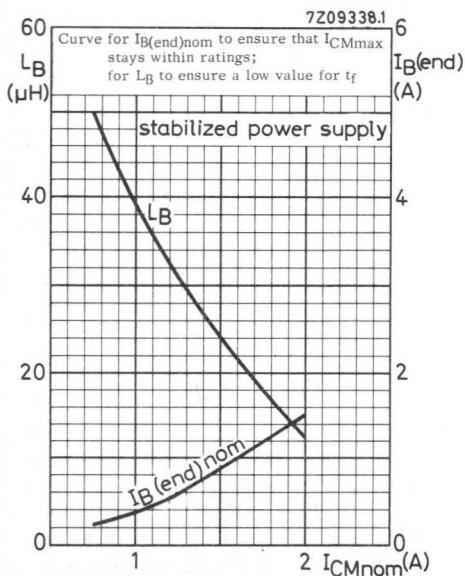
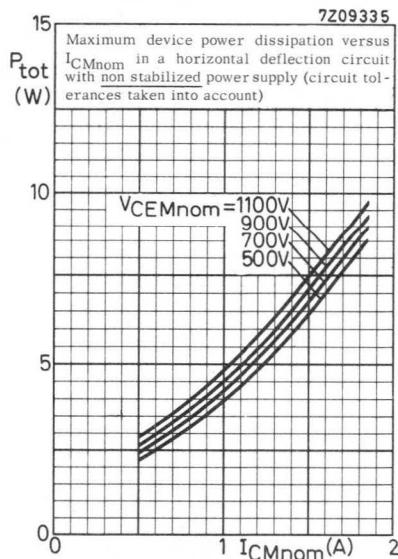
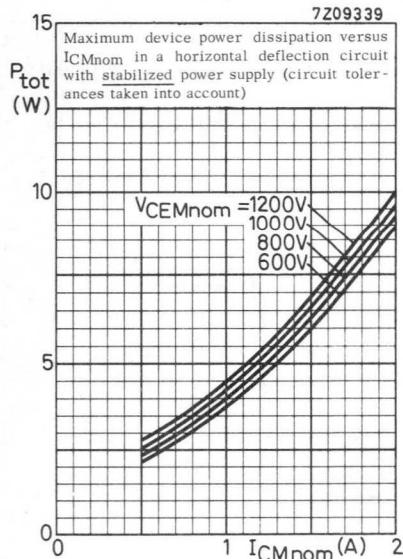
Simplified horizontal deflection circuit
with fundamental waveforms



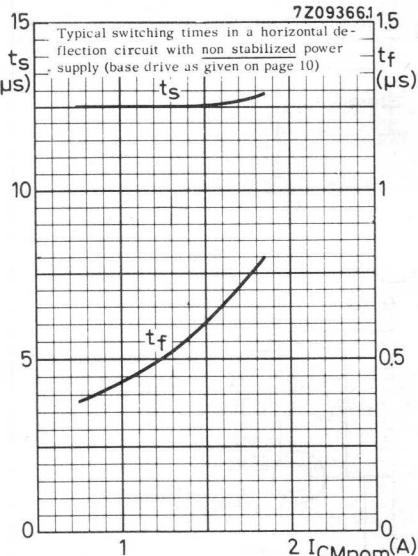
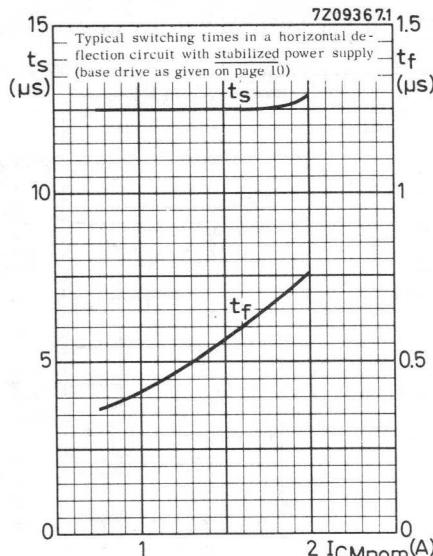
Remark:

1. The driver and output stage should operate in a non-simultaneous mode i.e. the driver transistor should be conductive during flyback and the first part of scan.
2. The reverse bias voltage for the output transistor should be in the order of 5 V with a duty cycle $\delta \approx 0.5$.

APPLICATION INFORMATION (continued)



APPLICATION INFORMATION (continued)

EXAMPLE

Assuming a practical horizontal deflection output stage with

$$I_{CMnom} = 1.8 \text{ A} \text{ and } V_{CEMnom} = 1000 \text{ V}$$

The following values will be derived from the curves:

a. Power dissipation

The maximum device power dissipation will be:

$$\text{with stabilized power supply : } P_{totmax} = 8.3 \text{ W}$$

$$\text{non stabilized power supply : } P_{totmax} = 9.2 \text{ W}$$

b. Maximum values (with safety margins as given on page 9)

$$\text{with stabilized power supply : } I_{CMmax} = 2.25 \text{ A; } V_{CEM} = 1250 \text{ V}$$

$$\text{non stabilized power supply : } I_{CMmax} = 2.4 \text{ A; } V_{CEM} = 1350 \text{ V}$$

c. Recommended nominal values are:

$$\text{with stabilized power supply : } I_B(\text{end})_{nom} = 1.82 \text{ A; } L_B = 17 \mu\text{H}$$

$$\text{non stabilized power supply : } I_B(\text{end})_{nom} = 1.4 \text{ A; } L_B = 12 \mu\text{H}$$

d. Switching times

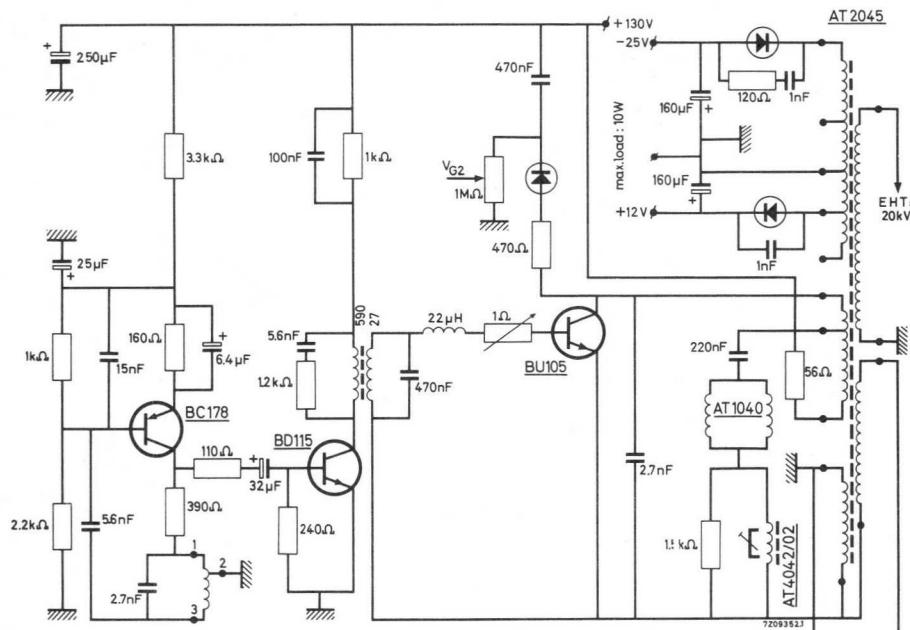
Typical values under nominal conditions are:

$$\text{with stabilized power supply : } t_f \text{ typ. } 0.7 \mu\text{s; } t_s \text{ typ. } 12.5 \mu\text{s}$$

$$\text{non stabilized power supply : } t_f \text{ typ. } 0.8 \mu\text{s; } t_s \text{ typ. } 13 \mu\text{s}$$

APPLICATION INFORMATION (continued)

Horizontal deflection circuit with BC178, BD115 and BU105 (stabilized power supply)



The BU105 in the circuit above has been designed for $I_{CMnom} = 1.6 \text{ A}$ with recommended inductance $L_B = 22 \mu\text{H}$ and $I_B(\text{end}) = 1.0 \text{ A}$.

Performance:

Collector current before switching (peak value)

 I_{CM} typ. 1.6 AStorage time at 90 % of I_{CM} t_s typ. 12.5 μs Fall time at 10 % of I_{CM} t_f typ. 0.6 μs Collector-emitter voltage at 1 μs before $i_C = I_{CM}$ $V_{CE}(\text{end})$ typ. 1.5 V

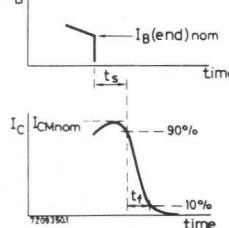
Collector-emitter voltage (peak value)

 V_{CEM} typ. 950 V

Fly-back ratio

typ. 18 %

Period-time

typ. 64 μs i_B 

see also page 9

HIGH VOLTAGE SILICON POWER TRANSISTOR

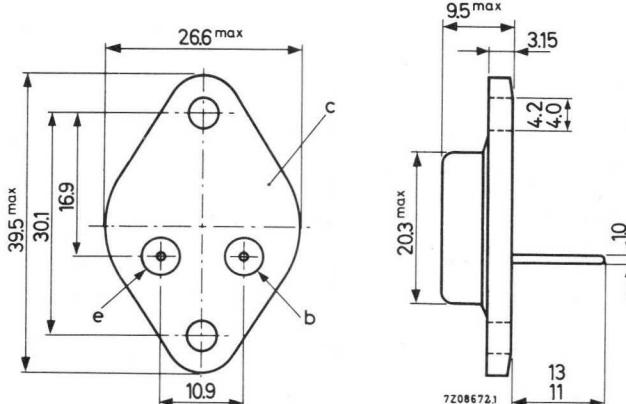
N-P-N transistor in a metal envelope intended for use in horizontal deflection circuits of colour television receivers.

QUICK REFERENCE DATA			
Collector-base voltage (peak value)	V _{CBOM}	max.	1500 V
Collector-emitter voltage (peak value) $R_{BE} \leq 100\Omega$	V _{CERM}	max.	1500 V
Collector current (peak value)	I _{CM}	max.	5.0 A
Total power dissipation up to $T_{mb} = 95^{\circ}\text{C}$	P _{tot}	max.	12.5 W
Collector-emitter saturation voltage $I_C = 4.5 \text{ A}; I_B = 2.0 \text{ A}$	V _{CESat}	<	5 V
Fall time when switched from $I_{CMnom} = 4.5 \text{ A}; I_{B(end)nom} = 1.8 \text{ A}; L_B = 10 \mu\text{H}$	t _f	typ.	0.7 μs

MECHANICAL DATA

Dimensions in mm

Collector connected to case



Accessories available: 56201e

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter) peak value	V_{CBOM}	max.	1500	V
Collector-emitter voltage ($R_{BE} \leq 100 \Omega$)	V_{CER}	max.	750	V
Collector-emitter voltage ($R_{BE} \leq 100 \Omega$) $I_C = 7.5 \text{ mA (peak value)}$	V_{CERM}	max.	1500	V
See also safe operation area				

Currents

Emitter current (d.c. and peak value)	$-I_E; -I_{EM}$	max.	7.0	A
Collector current (d.c. and peak value)	$I_C; I_{CM}$	max.	5.0	A
Reverse collector current (peak value)	$-I_{CM}$	max.	4.5	A
Base current (peak value)	I_{BM}	max.	4.0	A
Reverse base current (d.c. and average over any 20 ms period)	$-I_{BAV}$	max.	0.1	A
Reverse base current (peak value)	$-I_{BM}$	max.	2.5	A ¹⁾

Power dissipation

Total power dissipation up to $T_{mb} = 95^\circ\text{C}$	P_{tot}	max.	12.5	W
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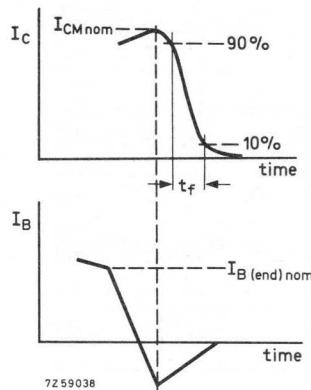
Temperatures

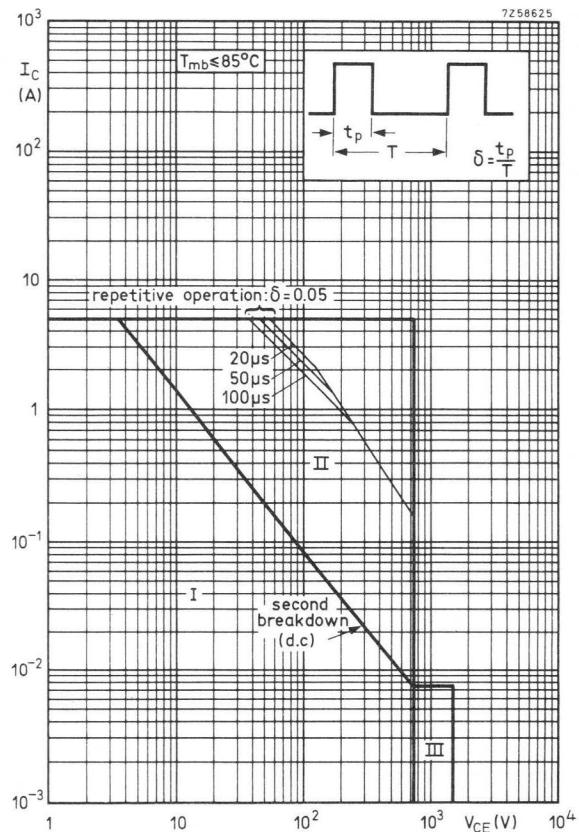
Storage temperature	T_{stg}	-65 to +115	$^\circ\text{C}$
Junction temperature	T_j	max.	115 $^\circ\text{C}$

THERMAL RESISTANCE

From junction to mounting base	$R_{th j-mb}$	=	1.6	$^\circ\text{C/W}$
From mounting base to heatsink with mica washer and lead washer (56201e)	$R_{th mb-h}$	=	0.75	$^\circ\text{C/W}$
with lead washer only	$R_{th mb-h}$	=	0.5	$^\circ\text{C/W}$

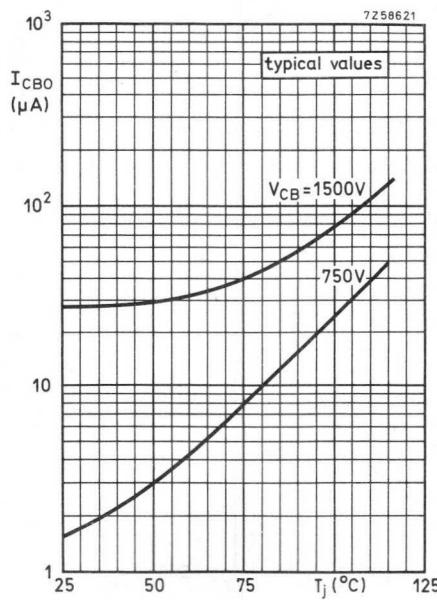
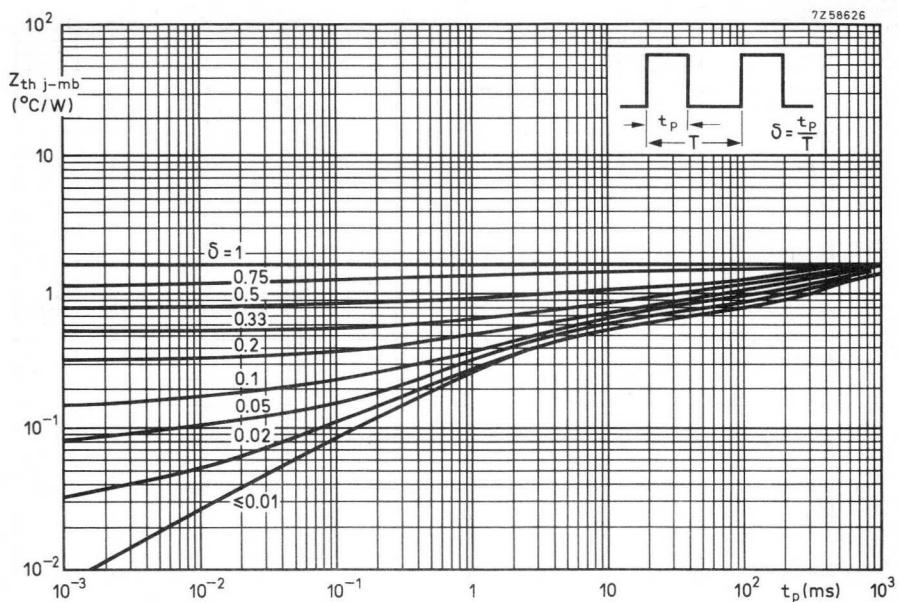
1) Turn off current; e.g. in horizontal deflection circuits.

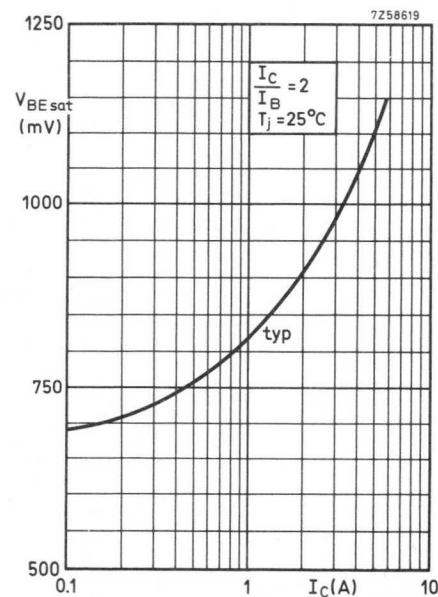
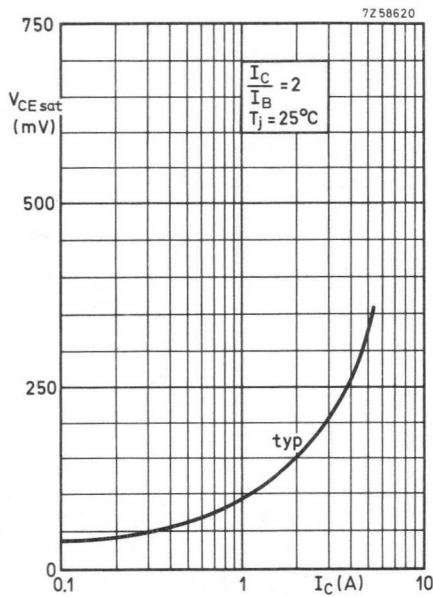
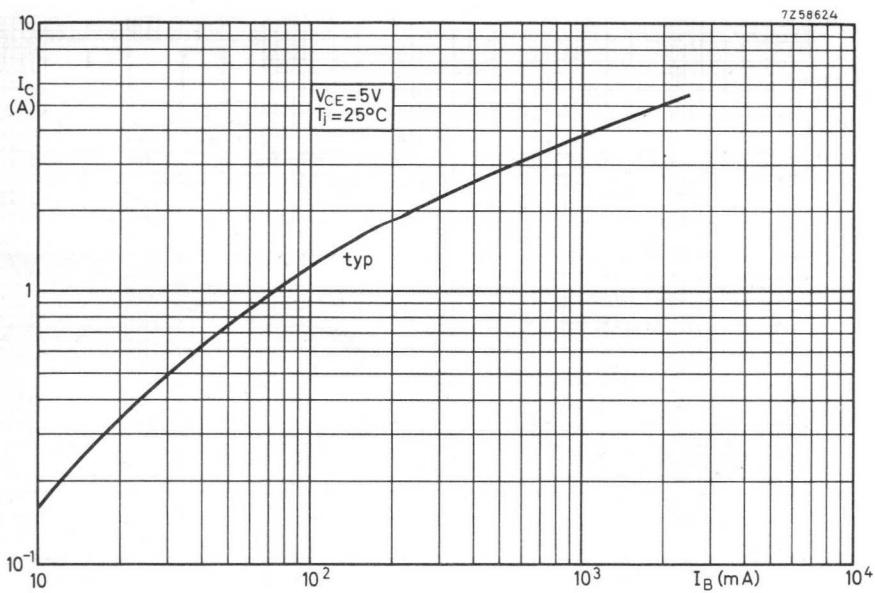
CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specifiedEmitter-base voltage (open collector) $I_C = 0; I_E = 100 \text{ mA}$ $+V_{EBO} > 5 \text{ V}$ Saturation voltages $I_C = 4.5 \text{ A}; I_B = 2.0 \text{ A}$ $V_{CEsat} < 5 \text{ V}$
 $V_{BEsat} < 1.5 \text{ V}$ Transition frequency at $f = 5 \text{ MHz}$ $I_C = 0.1 \text{ A}; V_{CE} = 5 \text{ V}$ $f_T \text{ typ. } 7 \text{ MHz}$ Collector capacitance at $f = 1 \text{ MHz}$ $I_E = I_e = 0; V_{CB} = 10 \text{ V}$ $C_c \text{ typ. } 125 \text{ pF}$ Fall time $I_{CMnom} = 4.5 \text{ A}; I_{B(end)nom} = 1.8 \text{ A}; L_B = 10 \mu\text{H}$ $t_f \text{ typ. } 0.7 \mu\text{s}$
 $< 1.0 \mu\text{s}$ 



Safe Operating Area with the transistor forward biased

- I Region of permissible d.c. operation
- II Permissible extension for repetitive pulsed operation
- III Repetitive pulsed operation in this region is allowable, provided
 $R_{BE} \leq 100 \Omega$; $t_p \leq 20 \mu s$; $\delta \leq 0.25$

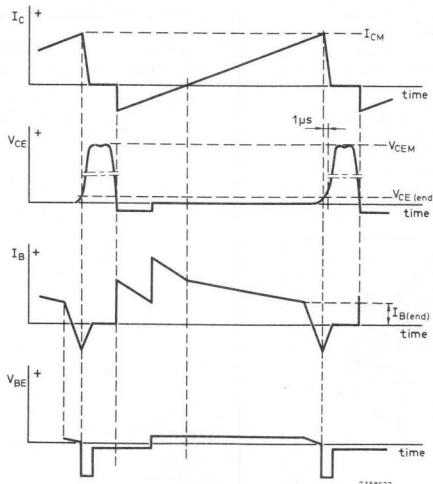
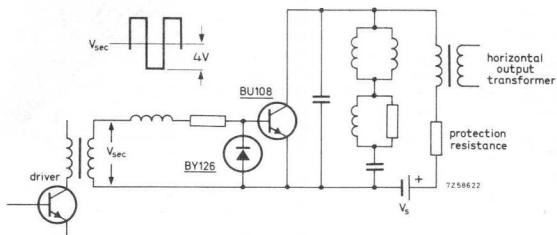




APPLICATION INFORMATION

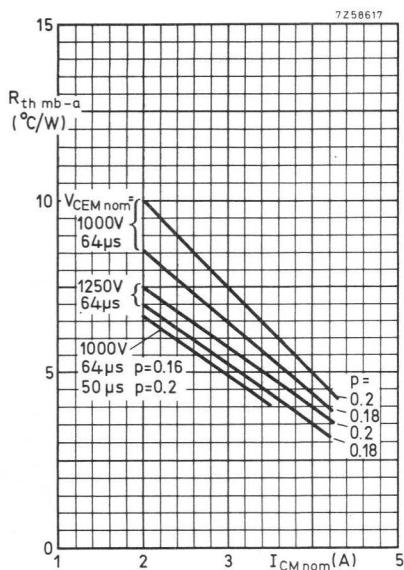
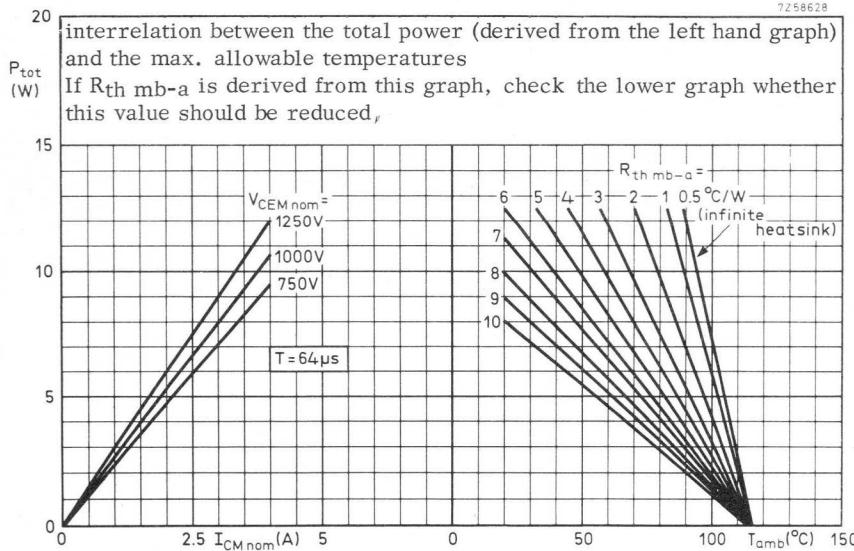
Safety margins on I_{CM} and V_{CEM}

Because of component tolerances and supply voltage variations the values of I_{CM} and V_{CEM} encountered in a practical horizontal deflection output stage will usually differ from those of a nominal circuit under nominal conditions; the difference, due to component tolerances and operational variations, can be as much as 20% if a stabilized supply is used. The operational variations considered, are deviations of the horizontal time-base frequency of $\pm 5\%$ with respect to the nominal value and EHT loading current up to an average of 1.5 mA. The allowance of 20% for V_{CEM} does not imply that the voltage rating for the final anode of the picture tube may be exceeded.

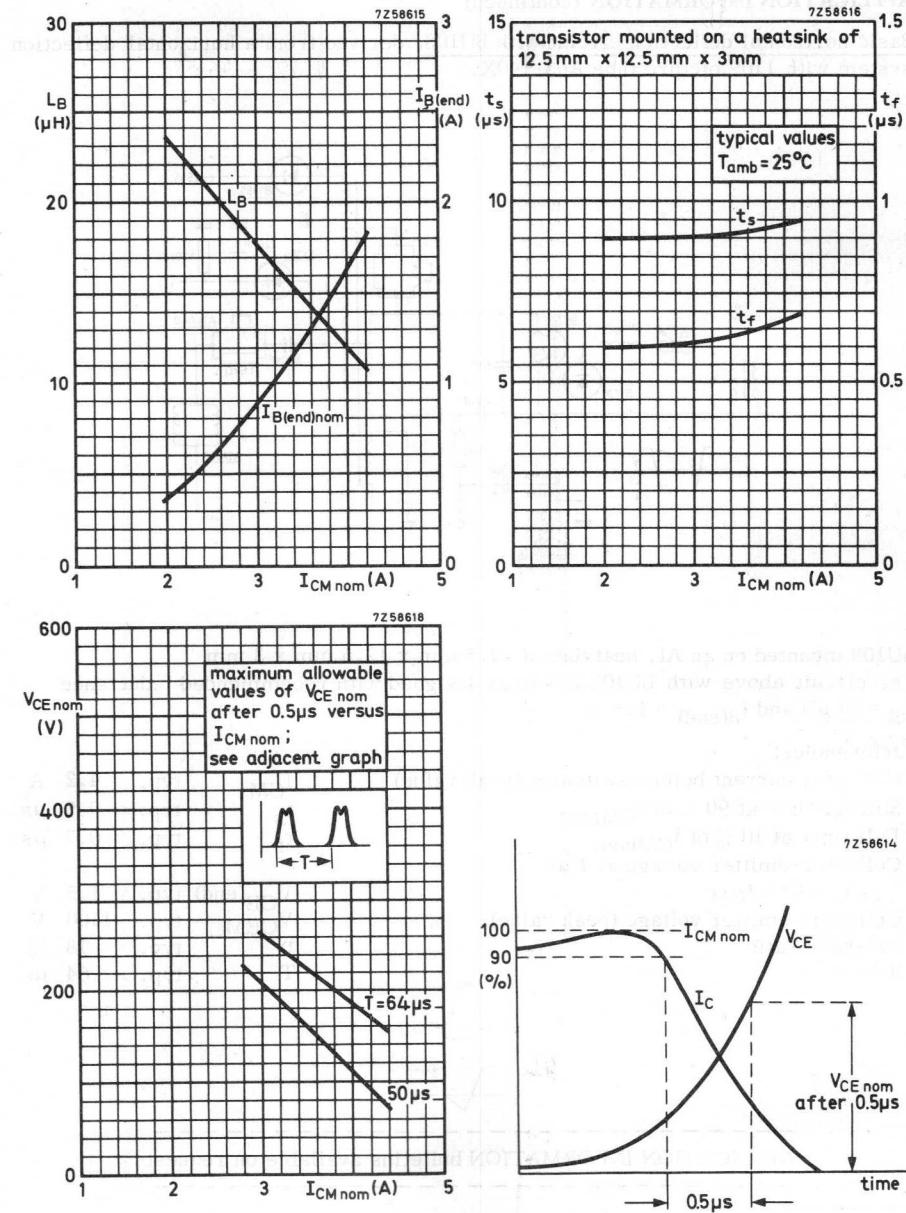
Simplified horizontal deflection circuit
with fundamental waveformsRemark:

1. The driver and output stage should operate in a non-simultaneous mode i.e. the driver transistor should be conductive during flyback and the first part of scan.

7258628

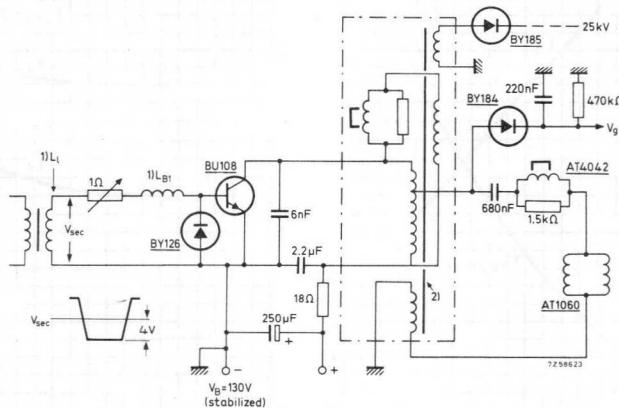


maximum allowable $R_{\text{th mb-a}}$ for various operating conditions. The values for $V_{\text{CEM nom}}$ and $I_{\text{CM nom}}$ referred to are normal operating conditions. The quantity 'p' denotes the ratio of the flyback pulse (t_p) over the period time (T).



APPLICATION INFORMATION (continued)

Basic horizontal deflection circuit with BU108, derived from a horizontal deflection system with 110° picture tube A65-140X.



BU108 mounted on an Al. heatsink of 12.5 mm x 12.5 mm x 3 mm
 The circuit above with BU108 has been designed with recommended inductance
 $L_B = 11 \mu\text{H}$ and $I_{B(\text{end})} = 1.8 \text{ A}$

Performance:

Collector current before switching (peak value)

I_{CM} typ. 4.2 A

Storage time at 90 % of I_{CMnom}

t_s typ. 9.5 μs

Fall time at 10 % of I_{CMnom}

t_f typ. 0.7 μs

Collector-emitter voltage at 1 μs

before $i_C = I_{CM}$ $V_{CE(\text{end})}$ typ. 1.5 V

Collector-emitter voltage (peak value)

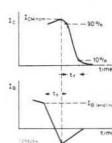
V_{CEM} typ. 1100 V

Fly-back ratio

p typ. 18 %

Period time

T typ. 64 μs



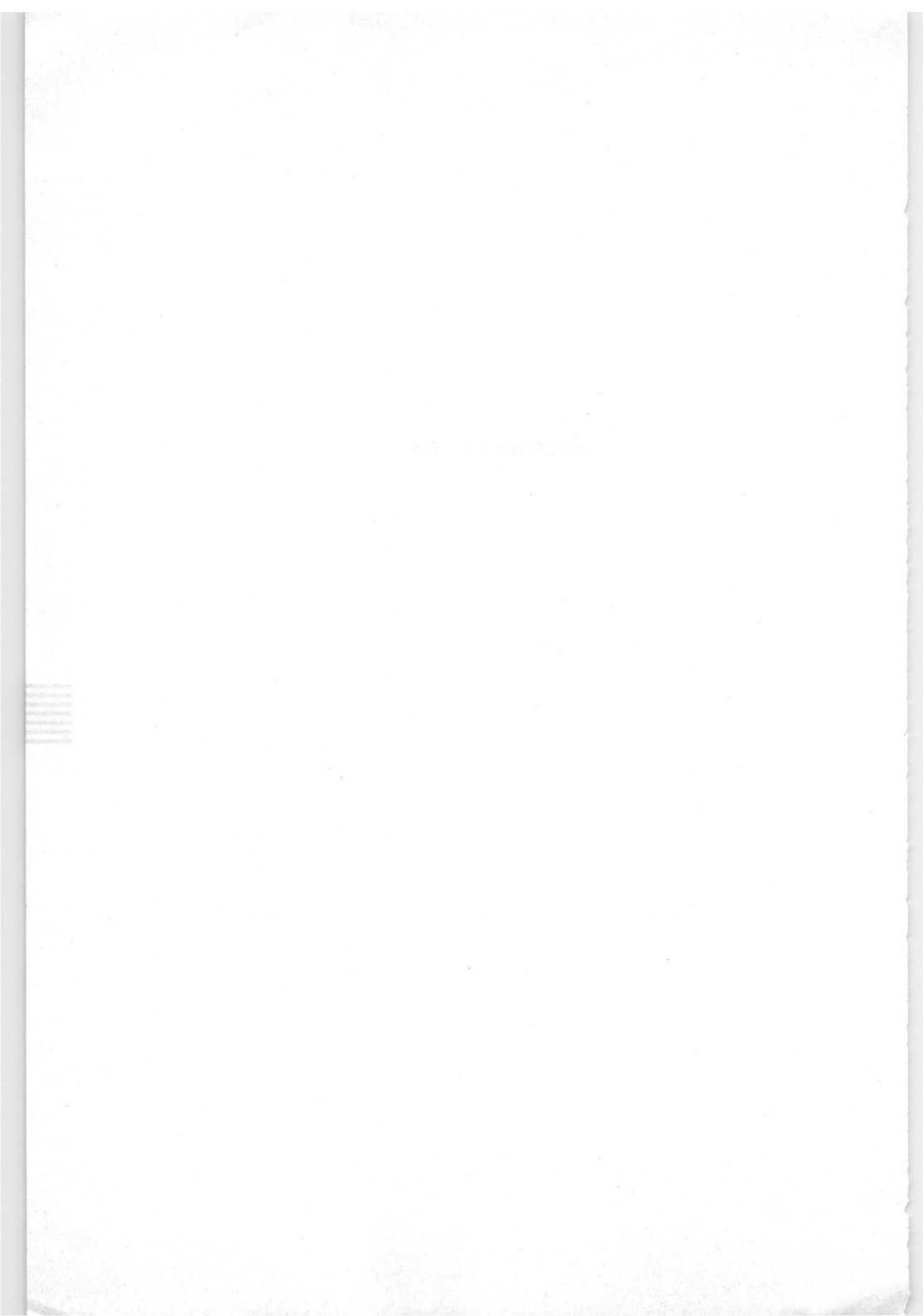
APPLICATION INFORMATION bulletins available on request

1) $L_B = L_1 + L_{B1}$ where L_1 = leakage inductance

2) horizontal output transformer with fifth harmonic tuning

Accessories





Introduction

All information on thermal resistances of the accessories combined with flat heat-sinks is valid for square heatsinks of 1.5 mm blackened aluminium.

For a few variations the thermal resistance may be derived as follows:

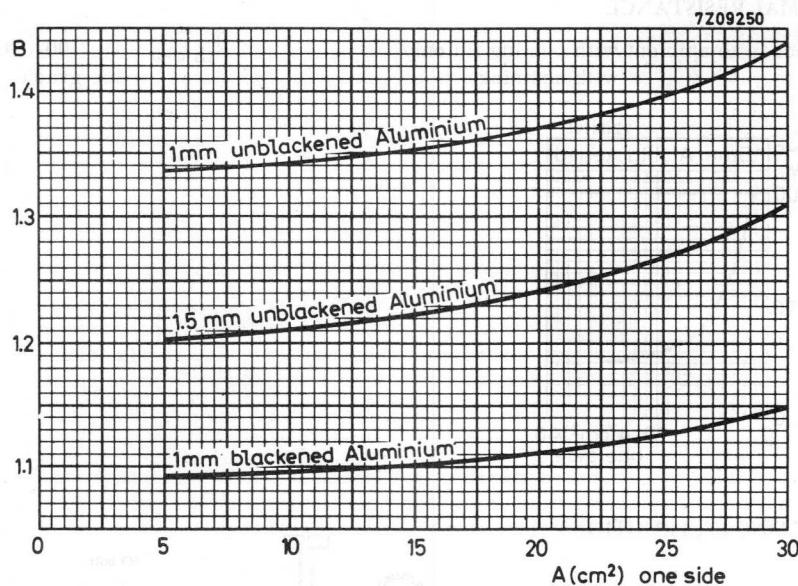
a. Rectangular heatsinks (sides a and 2a)

When mounted with long side horizontal, multiply by 0.95.

When mounted with short side horizontal, multiply by 1.10.

b. Unblackened or thicker heatsinks

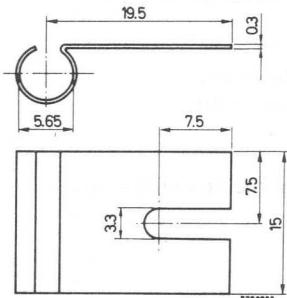
Multiply by the factor B given below as a function of the heatsink size A.



COOLING FIN

MECHANICAL DATA

Dimensions in mm

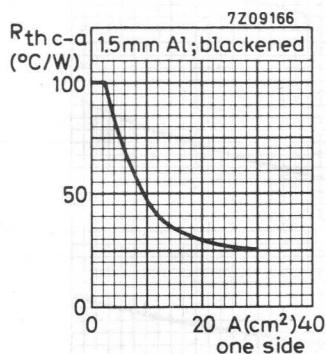


Fin material: brass, nickel plated

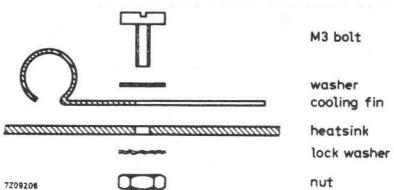
THERMAL RESISTANCE

From case to ambient with cooling fin only
with heatsink

$R_{th\ c-a} = 100 \text{ }^{\circ}\text{C/W}$
see graph



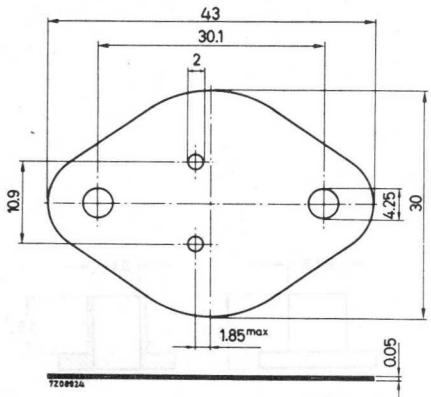
MOUNTING INSTRUCTIONS



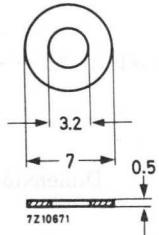
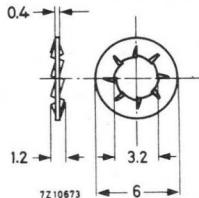
Torque on nut for good heat transfer: 5 cm kg

MOUNTING ACCESSORIES

MECHANICAL DATA



mica washer

3 plain washers
material: brass, nickel plated2 lock washers, internal teeth
material: steel, nickel plated

THERMAL RESISTANCE

From mounting base to heatsink with mica washer

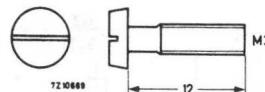
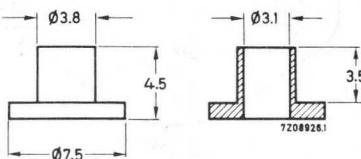
$$R_{th\ mb-h} = 1.0 \text{ } ^\circ\text{C/W}$$

TEMPERATURES

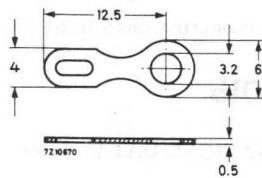
Maximum allowable temperature

$$T_{max} = 150 \text{ } ^\circ\text{C}$$

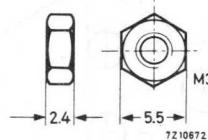
Dimensions in mm

2 cheese head screws, slotted
material: brass, nickel plated

2 insulating bushes



soldering tag

2 hexagon nuts
material: brass, nickel plated

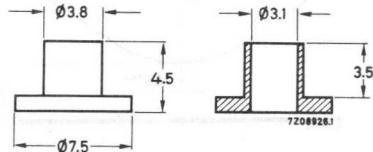
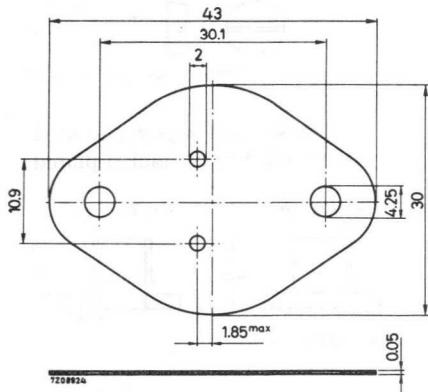
56201a

56201b

56201a MICA WASHER AND 2 INSULATING BUSHES

MECHANICAL DATA

Dimensions in mm



THERMAL RESISTANCE

From mounting base to heatsink

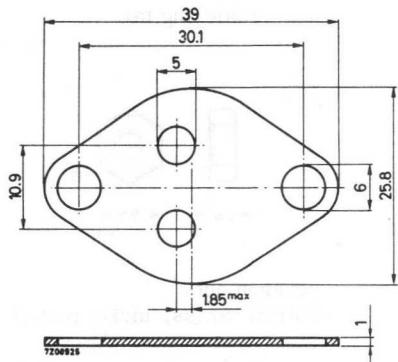
R_{th} mb-h = 1.0 $^{\circ}\text{C}/\text{W}$

56201b

LEAD WASHER

MECHANICAL DATA

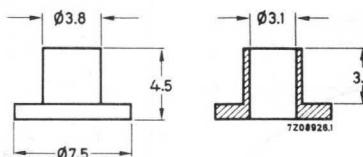
Dimensions in mm



56201c

INSULATING BUSH

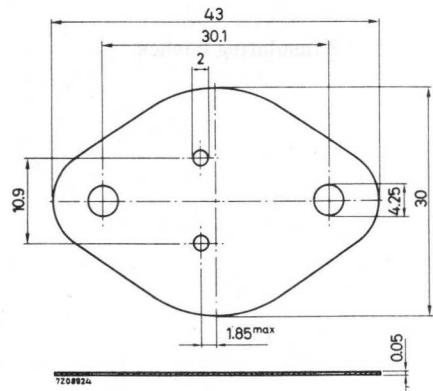
MECHANICAL DATA



56201d

MICA WASHER

MECHANICAL DATA



THERMAL RESISTANCE

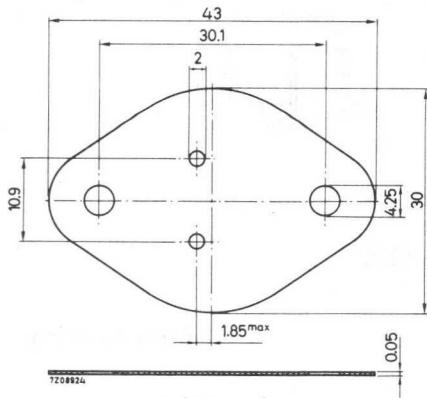
From mounting base to heatsink

$$R_{th} \text{ mb-h} = 1.0 \text{ } ^\circ\text{C/W}$$

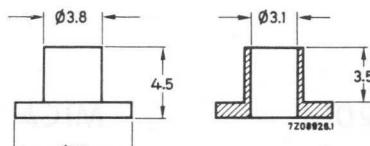
MOUNTING ACCESSORIES

MECHANICAL DATA

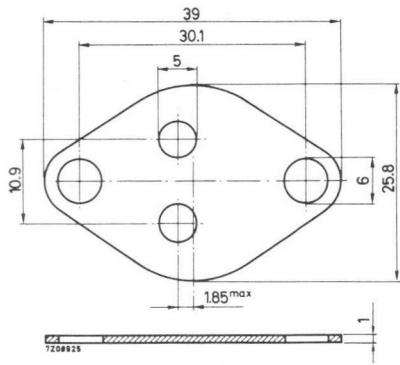
Dimensions in mm



mica washer



2 insulating bushes



lead washer

THERMAL RESISTANCE

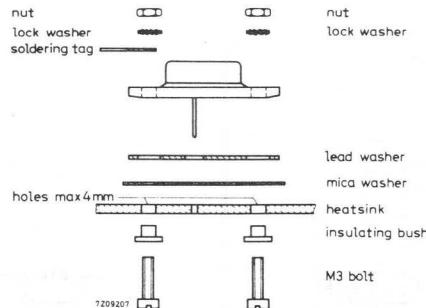
From mounting base to heatsink
with mica washer only
with mica washer and lead washer

$$\begin{aligned} R_{th\ mb-h} &= 1.0 \quad ^\circ\text{C/W} \\ R_{th\ mb-h} &= 0.75 \quad ^\circ\text{C/W} \end{aligned}$$

TEMPERATURE

Maximum allowable temperature

$$T_{max} = 150 \quad ^\circ\text{C}$$

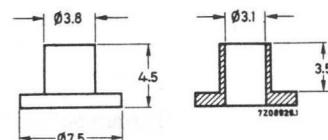
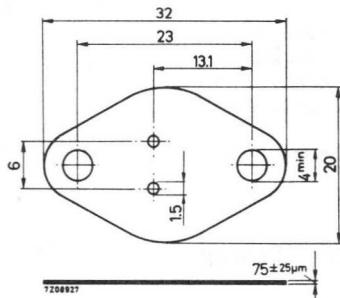
MOUNTING INSTRUCTIONS

Torque on nut for good heat transfer : 5 cm kg

MICA WASHER AND 2 INSULATING BUSHES

MECHANICAL DATA

Dimensions in mm



THERMAL RESISTANCE

From mounting base to heatsink

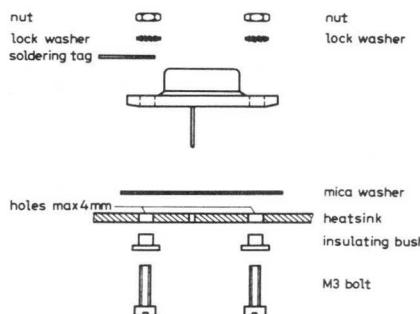
$$R_{\text{th}} \text{ mb-h} = 1.5 \text{ }^{\circ}\text{C/W}$$

TEMPERATURE

Maximum allowable temperature

$$T_{\text{max}} = 150 \text{ }^{\circ}\text{C}$$

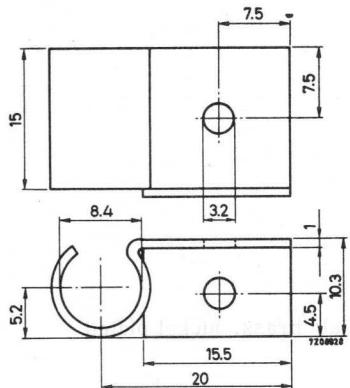
MOUNTING INSTRUCTIONS



Torque on nut for good heat transfer: 5 cm kg

COOLING FIN

MECHANICAL DATA



Dimensions in mm



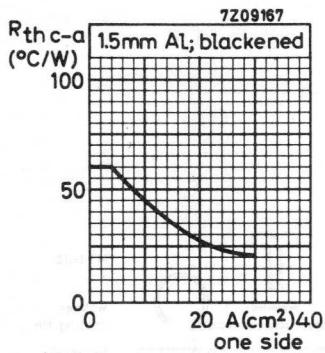
Fin material: aluminium, blackened

THERMAL RESISTANCE

From case to ambient with cooling fin only
with heatsink

$$R_{th\ c-a} = 60 \text{ } ^\circ\text{C/W}$$

see graph



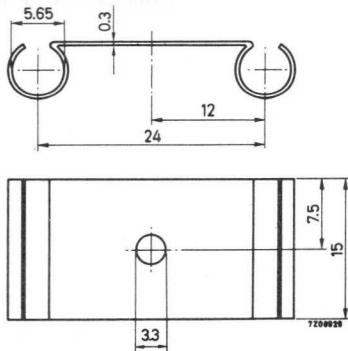
MOUNTING INSTRUCTIONS

Torque on M3 bolts for good heat transfer: 5 cm kg

COOLING FIN

MECHANICAL DATA

Dimensions in mm



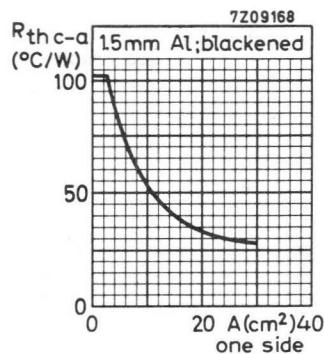
Fin material: brass, nickel plated

THERMAL RESISTANCE

From case to ambient with cooling fin only
with heatsink

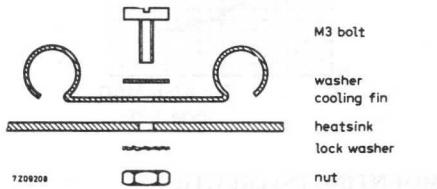
$$R_{th\ c-a} = 102 \text{ }^{\circ}\text{C/W}$$

see graph



R_{th} values apply to each transistor, provided the two transistors have been mounted so that the heat flow from each is equal.

MOUNTING INSTRUCTIONS

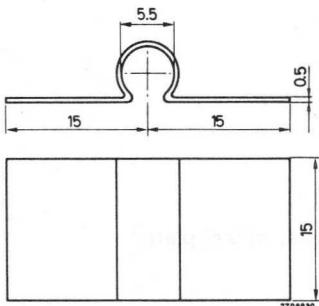


Torque on nut for good heat transfer: 5 cm kg

COOLING FIN

MECHANICAL DATA

Dimensions in mm



Fin material: brass, nickel plated

THERMAL RESISTANCE

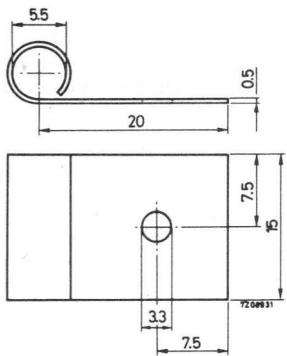
From case to ambient with cooling fin only

$$R_{th\ c-a} = 75 \text{ }^{\circ}\text{C/W}$$

COOLING FIN

MECHANICAL DATA

Dimensions in mm



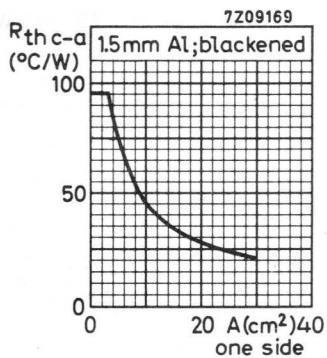
Fin material: brass, nickel plated

THERMAL RESISTANCE

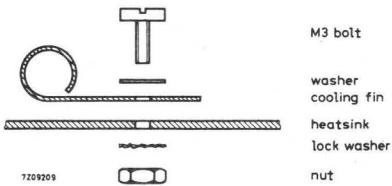
From case to ambient with cooling fin only
with heatsink

$$R_{th\ c-a} = 95 \text{ }^{\circ}\text{C/W}$$

see graph



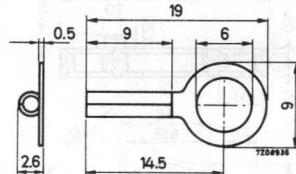
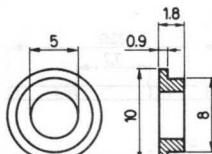
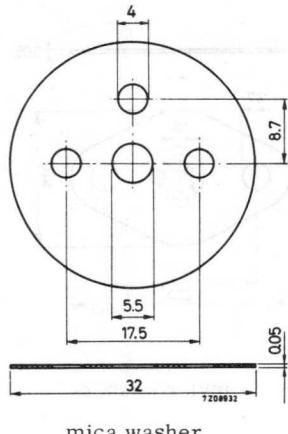
MOUNTING INSTRUCTIONS



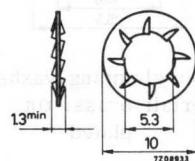
Torque on nut for good heat transfer: 5 cm kg

MOUNTING ACCESSORIES

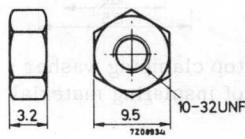
MECHANICAL DATA



material: brass, nickel plated



material: steel, nickel plated



material: brass, nickel plated

THERMAL RESISTANCE

From mounting base to heatsink

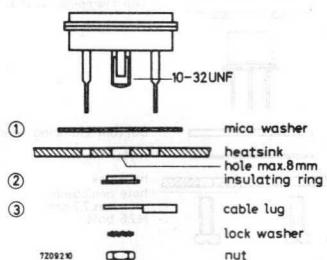
$$R_{th} \text{ mb-h} = 1 \text{ }^{\circ}\text{C/W}$$

TEMPERATURE

Maximum allowable temperature

$$T_{max} = 125 \text{ }^{\circ}\text{C}$$

MOUNTING INSTRUCTIONS



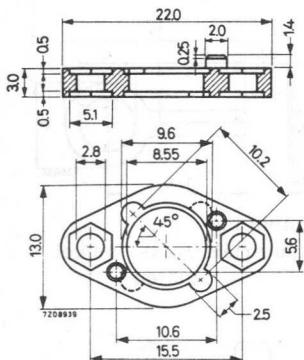
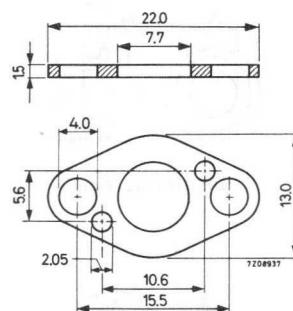
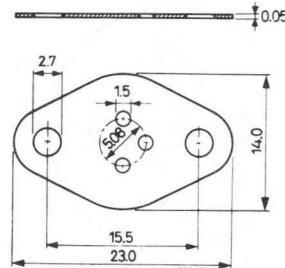
Torque on nut for good heat transfer: 20 cm

Non insulated mounting; without items 1, 2 and 3. (3 if necessary)

MOUNTING ACCESSORIES

MECHANICAL DATA

Dimensions in mm

top clamping washer
of insulating materialbottom clamping washer
material: brass, tin
plated

mylar washer

THERMAL RESISTANCE

From mounting base to heatsink non insulated mounting
insulated mounting

$$R_{th\ mb-h} = 3 \text{ } ^\circ\text{C/W}$$

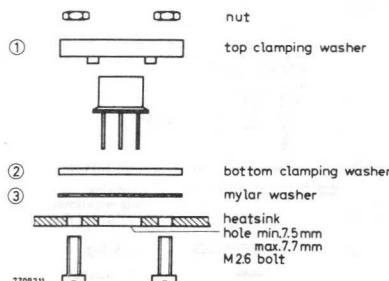
$$R_{th\ mb-h} = 6 \text{ } ^\circ\text{C/W}$$

TEMPERATURE

Maximum allowable temperature

$$T_{max} = 100 \text{ } ^\circ\text{C}$$

MOUNTING INSTRUCTIONS

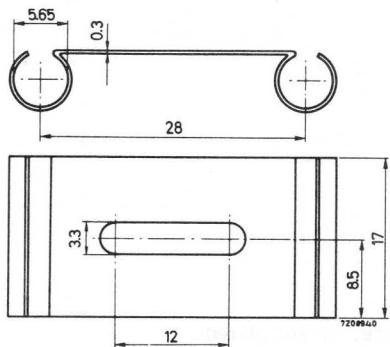


Non insulated mounting; without items 2 and 3. (Note: item 1 must than be mounted up-side down)

COOLING FIN

MECHANICAL DATA

Dimensions in mm



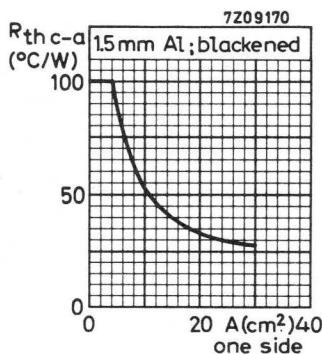
Fin material: brass, nickel plated

THERMAL RESISTANCE

From case to ambient with cooling fin only
with heatsink

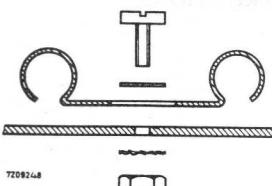
$$R_{th\ c-a} = 100 \text{ }^{\circ}\text{C/W}$$

see graph



R_{th} values apply to each transistor, provided the two transistors have been mounted so that the heat flow from each is equal.

MOUNTING INSTRUCTIONS

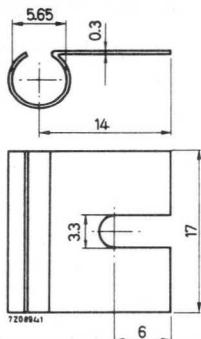


Torque on nut for good heat transfer: 5 cmkg

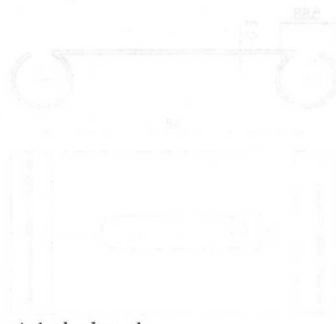
COOLING FIN

MECHANICAL DATA

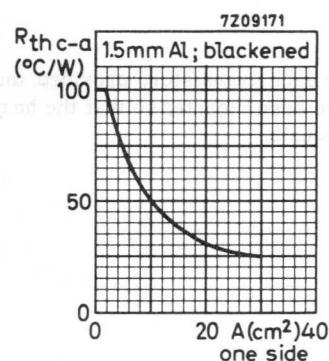
Dimensions in mm



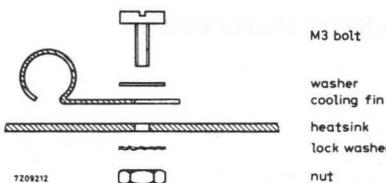
Fin material: brass, nickel plated



THERMAL RESISTANCE

From case to ambient with cooling fin only
with heatsink $R_{th\ c-a} = 100\ ^\circ\text{C/W}$
see graph

MOUNTING INSTRUCTIONS



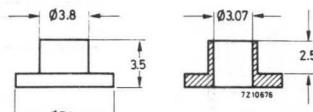
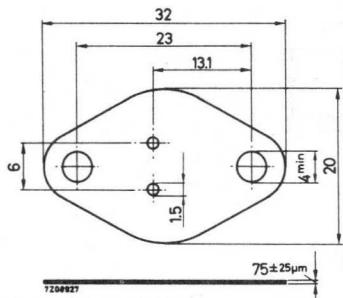
Torque on nut for good heat transfer: 5 cm kg

56239
56245 56246

MICA WASHER AND 2 INSULATING BUSHES

56239

MECHANICAL DATA



Dimensions in mm

THERMAL RESISTANCE

From mounting base to heatsink

R_{th} mb-h = 1.5 °C/W

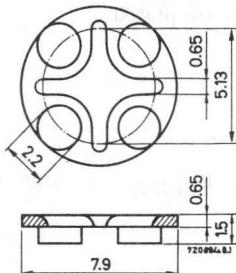
TEMPERATURE

Maximum allowable temperature

T_{max} = 150 °C

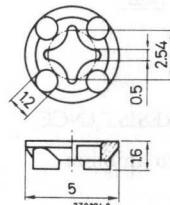
DISTANCE DISCS

56245



Insulating material

56246



Insulating material

TEMPERATURE

Maximum allowable temperature

T_{max} = 100 °C

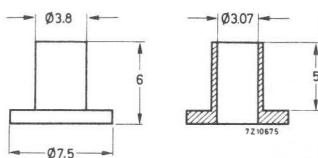
56261
56263

2 INSULATING BUSHES

56261

MECHANICAL DATA

Dimensions in mm

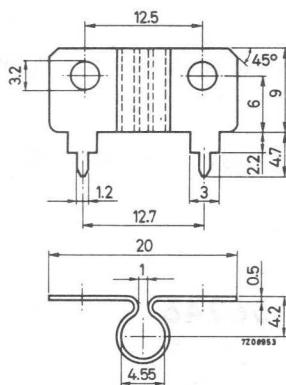


56263

COOLING FIN

MECHANICAL DATA

Dimensions in mm



Fin material: copper, tin plated

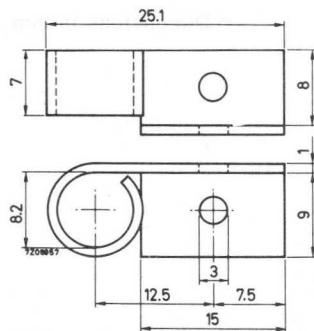
THERMAL RESISTANCE

From case to ambient

$R_{th\ c-a} = 100 \text{ } ^\circ\text{C/W}$

COOLING FIN

MECHANICAL DATA



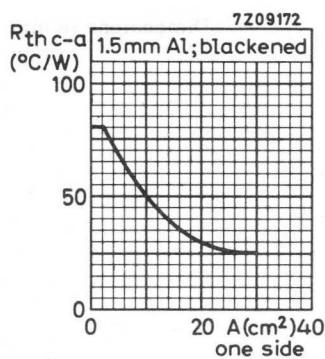
Dimensions in mm

Fin material: aluminium, blackened

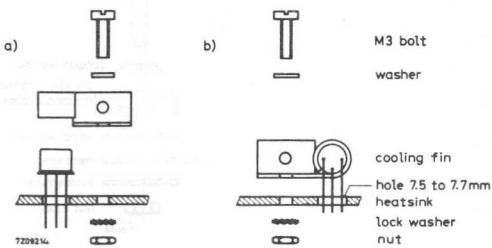
THERMAL RESISTANCE

From case to ambient with cooling fin only
with heatsink

$R_{th\ c-a}$ = 80 °C/W
see graph



MOUNTING INSTRUCTIONS



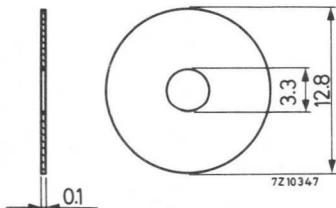
Torque on nut for good heat transfer: 5 cm kg

56302
56303

56302

MICA WASHER

MECHANICAL DATA



Dimensions in mm

THERMAL RESISTANCE

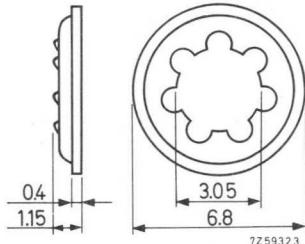
From mounting base to heatsink

$$R_{th \text{ mb-h}} = 6 \text{ }^{\circ}\text{C/W}$$

56303

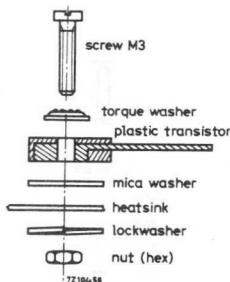
TORQUE WASHER

MECHANICAL DATA



Dimensions in mm

MOUNTING INSTRUCTIONS



Torque on nut: min. 8 cm kg
max. 9 cm kg

INDEX OF TYPE NUMBERS

The inclusion of a type number in this publication does not necessarily imply its availability.

Type No.	Part	Section	Type No.	Part	Section	Type No.	Part	Section
AC107	2	LF	AF127	3	HF	BAW56	4	Mm
AC125	2	LF	AF139	3	HF	BAW99	4	B
AC126	2	LF	AF178	3	HF	BAY66	4	Mw
AC127	2	LF	AF239	3	HF	BAY96	4	Mw
AC127/01	2	LF	AF239S	3	HF	BC107	2	LF
AC128	2	LF	AF240	3	HF	BC108	2	LF
AC128/01	2	LF	AF267	3	HF	BC109	2	LF
AC132	2	LF	AFY16	3	HF	BC146	2	LF
AC132/01	2	LF	AFY19	4	Tr	BC147	2	LF
AC172	2	LF	AFY40	3	HF	BC148	2	LF
AC187	2	LF	AFZ12	3	HF	BC149	2	LF
AC187/01	2	LF	ASY26	3	Sw	BC157	2	LF
AC188	2	LF	ASY27	3	Sw	BC158	2	LF
AC188/01	2	LF	ASY28	3	Sw	BC159	2	LF
AD139	2	P	ASY29	3	Sw	BC177	2	LF
AD149	2	P	ASY31	3	Sw	BC178	2	LF
AD161	2	P	ASY32	3	Sw	BC179	2	LF
AD162	2	P	ASY73	3	Sw	BC200	2	LF
ADY26	2	P	ASY74	3	Sw	BC237	2	LF
ADZ11	2	P	ASY75	3	Sw	BC238	2	LF
ADZ12	2	P	ASY76	3	Sw	BC239	2	LF
AF114	3	HF	ASY77	3	Sw	BCW29	4	Mm
AF115	3	HF	ASY80	3	Sw	BCW30	4	Mm
AF116	3	HF	ASZ15	2	P	BCW31	4	Mm
AF117	3	HF	ASZ16	2	P	BCW32	4	Mm
AF118	3	HF	ASZ17	2	P	BCW33	4	Mm
AF121	3	HF	ASZ18	2	P	BCY10	2	LF
AF124	3	HF	ASZ20	3	Sw	BCY11	2	LF
AF125	3	HF	ASZ21	3	Sw	BCY12	2	LF
AF126	3	HF	AUY10	2	P	BCY30	2	LF

B = Beam lead devices

Mw = Microwave devices

HF = High frequency transistors

P = Low frequency power transistors

LF = Low frequency transistors

Sw = Switching transistors

Mm = Microminiature devices for
thick- and thin-film circuits

Tr = Transmitting transistors

INDEX

CIRCUIT INDEX

Type No.	Part	Section	Type No.	Part	Section	Type No.	Part	Section
BCY31	2	LF	BD139	2	P	BFS18	4	Mm
BCY32	2	LF	BD140	2	P	BFS19	4	Mm
BCY33	2	LF	BD144	2	Defl	BFS20	4	Mm
BCY34	2	LF	BDY10	2	P	BFS21	4	FET
BCY38	2	LF	BDY11	2	P	BFS21	4	Dual
BCY39	2	LF	BDY20	2	P	BFS21A	4	FET
BCY40	2	LF	BDY38	2	P	BFS21A	4	Dual
BCY54	2	LF	BF115	3	HF	BFS22	4	Tr
BCY55	2	LF	BF167	3	HF	BFS23	4	Tr
BCY55	4	Dual	BF173	3	HF	BFS28	4	FET
BCY56	2	LF	BF177	3	HF	BFS92	3	HF
BCY57	2	LF	BF178	3	HF	BFS93	3	HF
BCY70	2	LF	BF179	3	HF	BFS94	3	HF
BCY71	2	LF	BF180	3	HF	BFS95	3	HF
BCY72	2	LF	BF181	3	HF	BFW10	4	FET
BCY87	2	LF	BF182	3	HF	BFW11	4	FET
BCY87	4	Dual	BF183	3	HF	BFW16A	3	HF
BCY88	2	LF	BF184	3	HF	BFW17A	3	HF
BCY88	4	Dual	BF185	3	HF	BFW30	3	HF
BCY89	2	LF	BF186	3	HF	BFW45	2	Defl
BCY89	4	Dual	BF194	3	HF	BFW61	4	FET
BCZ10	2	LF	BF195	3	HF	BFW92	3	HF
BCZ11	2	LF	BF196	3	HF	BFX44	3	HF
BCZ12	2	LF	BF197	3	HF	BFX89	3	HF
BD115	2	P	BF200	3	HF	BFY10	3	HF
BD124	2	P	BF254	3	HF	BFY11	3	HF
BD135	2	P	BF255	3	HF	BFY44	4	Tr
BD136	2	P	BFR63	3	HF	BFY50	3	HF
BD137	2	P	BFR64	3	HF	BFY51	3	HF
BD138	2	P	BFS17	4	Mm	BFY52	3	HF

Defl = Deflection transistors

Dual = Dual transistors

FET = Field effect transistors

HF = High frequency transistors

LF = Low frequency transistors

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Tr = Transmitting transistors

Type No.	Part	Section	Type No.	Part	Section	Type No.	Part	Section
BFY55	3	HF	BSW67	3	Sw	OC44	3	HF
BFY67	3	HF	BSW68	3	Sw	OC45	3	HF
BFY68	3	HF	BSW69	3	Sw	OC46	3	Sw
BFY70	4	Tr	BSX19	3	Sw	OC47	3	Sw
BFY90	3	HF	BSX20	3	Sw	OC72	2	LF
BLY14	4	Tr	BSX21	3	Sw	OC74	2	LF
BLY17	4	Tr	BSX44	3	Sw	OC76	3	Sw
BLY37	4	Tr	BSX59	3	Sw	OC77	3	Sw
BLY38	4	Tr	BSX60	3	Sw	OC79	2	LF
BLY53	4	Tr	BSX61	3	Sw	OC80	3	Sw
BLY76	4	Tr	BSY10	3	Sw	OC122	3	Sw
BLY87	4	Tr	BSY11	3	Sw	OC123	3	Sw
BLY88	4	Tr	BSY38	3	Sw	OC139	3	Sw
BLY89	4	Tr	BSY39	3	Sw	OC140	3	Sw
BLY91	4	Tr	BU105	2	Defl	OC141	3	Sw
BLY92	4	Tr	BU108	2	Defl	OCP70	4	Ph
BLY93	4	Tr	BXY27	4	Mw	ORP10	4	Ph
BPX25	4	Ph	BXY28	4	Mw	ORP13	4	Ph
BPX29	4	Ph	BXY29	4	Mw	ORP30N	4	Ph
BPY10	4	Ph	BXY32	4	Mw	ORP50	4	Ph
BPY68	4	Ph	CQY11B	4	Ph	ORP52	4	Ph
BPY77	4	Ph	CXY10	4	Mw	ORP60	4	Ph
BRY39	3	Sw	CXY11A	4	Mw	ORP61	4	Ph
BSV52	4	Mm	CXY11B	4	Mw	ORP62	4	Ph
BSV61	4	B	CXY11C	4	Mw	ORP63	4	Ph
BSV62	4	B	CXY12	4	Mw	ORP69	4	Ph
BSV63	4	B	OAP12	4	Ph	ORP90	4	Ph
BSV81	4	FET	OC22	2	P	R PY13	4	Ph
BSW41	3	Sw	OC23	2	P	R PY18	4	Ph
BSW66	3	Sw	OC24	2	P	R PY19	4	Ph

B = Beam lead devices

Defl = Deflection transistors

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INDEX

Type No.	Part	Section	Type No.	Part	Section	Type No.	Part	Section
R PY20	4	Ph	2N1613	3	HF	2N3442	2	P
R PY27	4	Ph	2N1711	3	HF	2N3553	4	Tr
R PY33	4	Ph	2N1893	3	HF	2N3570	3	HF
R PY41	4	Ph	2N2218	3	Sw	2N3571	3	HF
R PY43	4	Ph	2N2218A	3	Sw	2N3572	3	HF
R PY55	4	Ph	2N2219	3	Sw	2N3632	4	Tr
R PY58	4	Ph	2N2219A	3	Sw	2N3823	4	FET
2N174	2	P	2N2221	3	Sw	2N3866	4	Tr
2N277	2	P	2N2221A	3	Sw	2N3924	4	Tr
2N441	2	P	2N2222	3	Sw	2N3926	4	Tr
2N706A	3	Sw	2N2222A	3	Sw	2N3927	4	Tr
2N708	3	Sw	2N2297	3	HF	2N4347	2	P
2N709	3	Sw	2N2368	3	Sw	2N4427	4	Tr
2N743	3	Sw	2N2369	3	Sw	61SV	4	Ph
2N744	3	Sw	2N2369A	3	Sw	40809	2	LF
2N753	3	Sw	2N2475	3	Sw	40819	2	LF
2N914	3	Sw	2N2483	3	HF	40820	3	HF
2N929	2	LF	2N2484	3	HF	40822	3	HF
2N930	2	LF	2N2904	3	Sw	40829	3	HF
2N1100	2	P	2N2904A	3	Sw	56200	3	A
2N1131	3	Sw	2N2905	3	Sw	56201	3	A
2N1132	3	Sw	2N2905A	3	Sw	56201a	3	A
2N1302	3	Sw	2N2906	3	Sw	56201b	3	A
2N1303	3	Sw	2N2906A	3	Sw	56201c	3	A
2N1304	3	Sw	2N2907	3	Sw	56201d	3	A
2N1305	3	Sw	2N2907A	3	Sw	56201e	3	A
2N1306	3	Sw	2N3055	2	P	56203	3	A
2N1307	3	Sw	2N3133	3	Sw	56207	3	A
2N1308	3	Sw	2N3134	3	Sw	56208	3	A
2N1309	3	Sw	2N3375	4	Tr	56209	3	A

A = Accessories

FET = Field effect transistors

HF = High frequency transistors

LF = Low frequency transistors

P = Low frequency power transistors

Ph = Photo devices

Sw = Switching transistors

Tr = Transmitting transistors

Type No.	Part	Section
56210	3	A
56213	3	A
56218	3	A
56226	3	A
56227	3	A
56239	3	A
56245	3	A
56246	3	A
56261	3	A
56263	3	A
56265	3	A
56302	3	A
56303	3	A

A = Accessories

INDEX

NAME	ADDRESS	TELEGRAM
John Smith	123 Main Street	JOHNSMITH 123 MAIN ST
Jane Doe	456 Elm Street	JANEDOE 456 ELM ST
Bob Johnson	789 Oak Street	BOBJOHNSON 789 OAK ST
Susan Lee	234 Pine Street	SUSANLEE 234 PINE ST

19.00

anterior vena

posterior vena

posterior vena

posterior vena

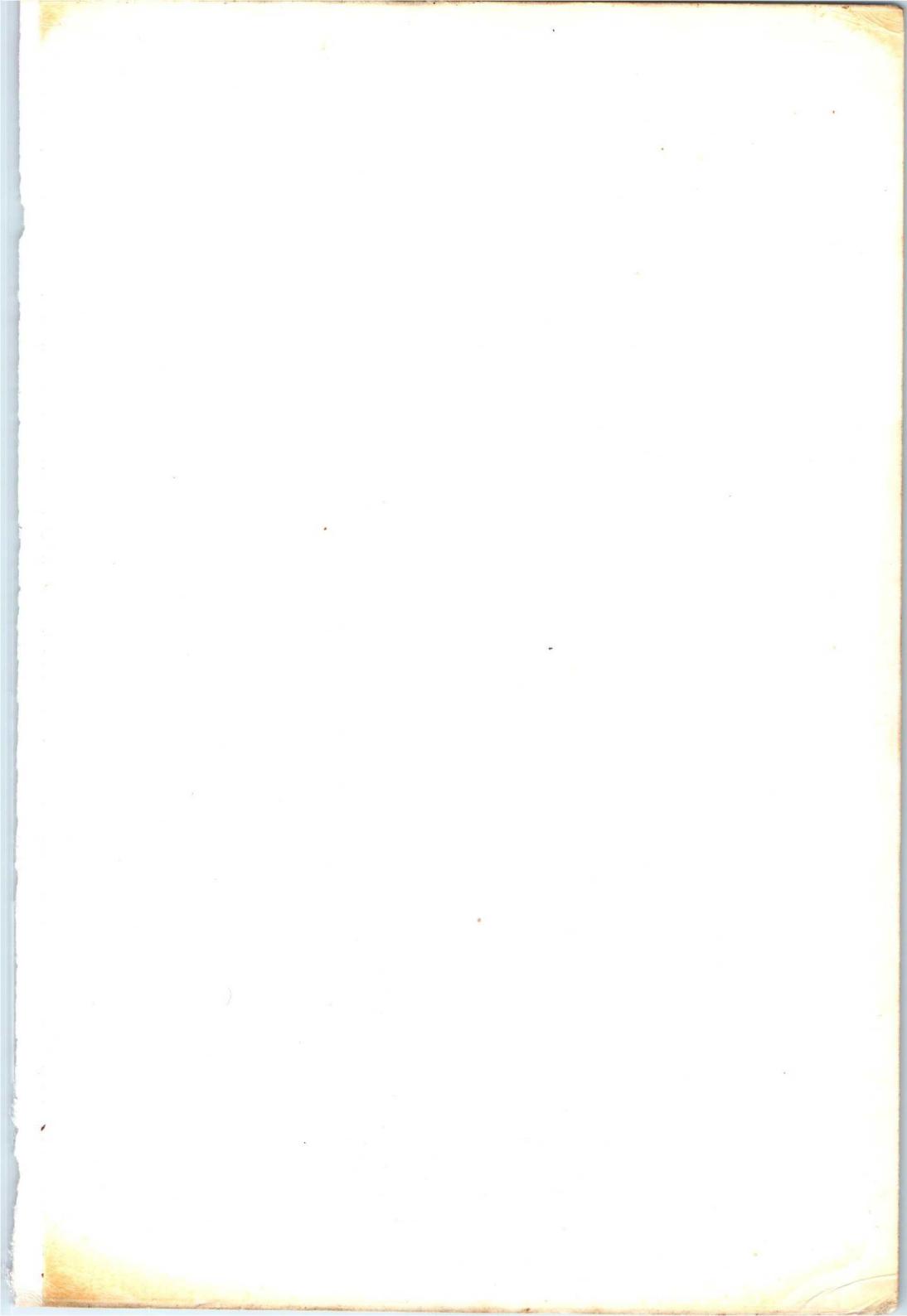
General

Low frequency transistors

Low frequency power transistors

Deflection transistors

Accessories



Printed in The Netherlands

9339 251 14501